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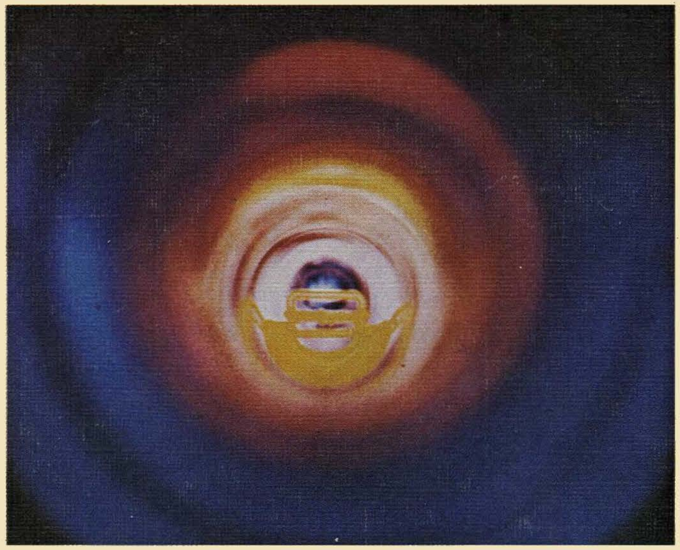

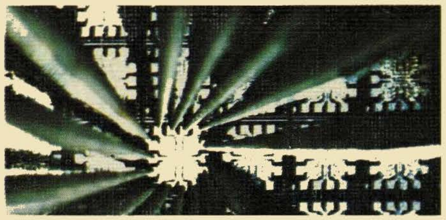

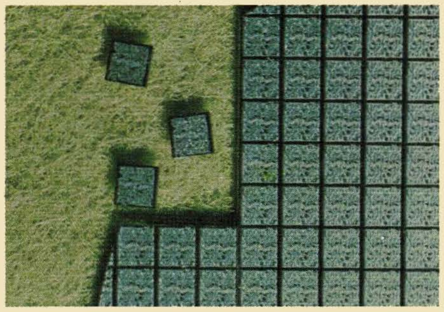

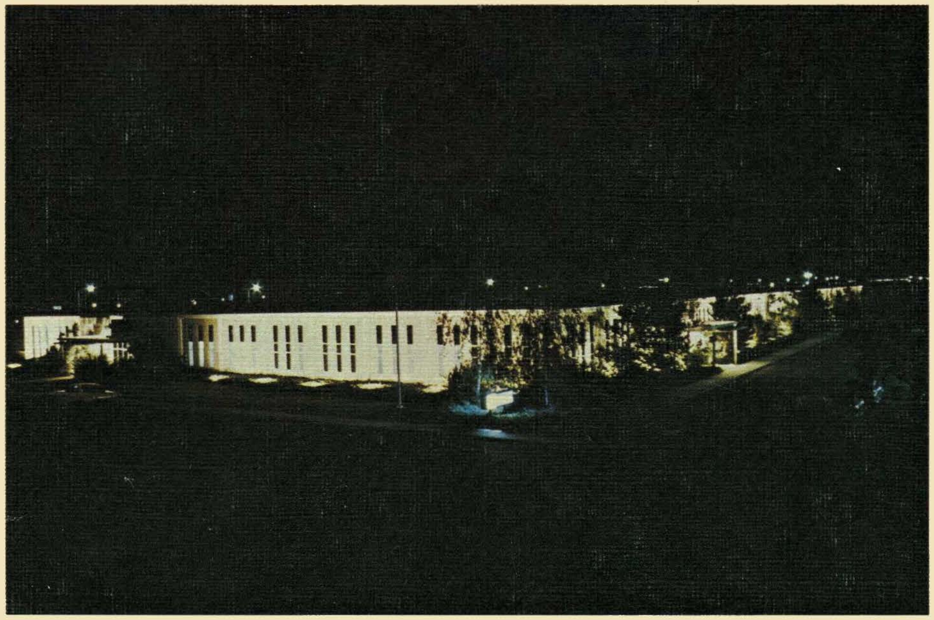

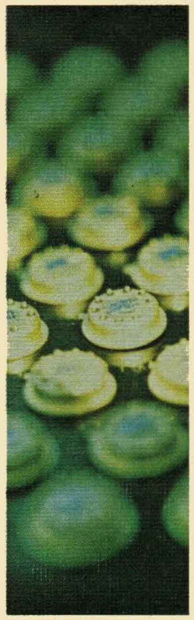

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DEFINITION OF SYMBOLS AND TERMS

*	Contact local representative for latest information
NPN	Silicon Planar Transistor, N-Polarity
PNP	Silicon Planar Transistor, P-Polarity
DNPN	Dual NPN Transistor
DPNP	Dual PNP Transistor
PFET	Silicon Planar Junction Field Effect Transistor, P-Channel
NFET	Silicon Planar Junction Field Effect Transistor, N-Channel
DNFET	Dual N-Channel Field Effect Transistor
DPFET	Dual P-Channel Field Effect Transistor
DMNPN	Dual Monolithic NPN Transistor
MDDNPN	Monolithic Dual Darlington NPN Transistor
MDPFET	Monolithic Dual P-Channel Field Effect Transistor
HNIL	High Noise Immunity Logic
TTL	Transistor-Transistor Logic
DTL	Diode Transistor Logic
ULP	Ultra Low Power

TRANSISTORS

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2N718	NPN	General Purpose	*
2N718A	NPN	General Purpose	*
JAN-2N718A	NPN	General Purpose	*
JAN-TX-2N718A	NPN	General Purpose	*
2N720	NPN	General Purpose	*
2N760	NPN	General Purpose	1101
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2N869	PNP	General Purpose	1601
2N910	NPN	General Purpose	*
JAN-2N910	NPN	General Purpose	*
2N911	NPN	General Purpose	*
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JAN-TX-2N929	NPN	General Purpose	1102
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JAN-TX-2N930	NPN	General Purpose	1102
2N930A	NPN	General Purpose	1102
2N930B	NPN	General Purpose	1102
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2N1613	NPN	General Purpose	*
JAN-2N1613	NPN	General Purpose	*
JAN-TX-2N1613	NPN	General Purpose	*
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JAN-2N2060	DNPN	General Purpose	*
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2N3352	DPNP	General Purpose	2601
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2N2499	PFET	Amplifier	*
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2N2607	PFET	Amplifier	3501
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2N2609	PFET	Amplifier	3501
JAN-2N2609	PFET	Amplifier	3501
2N2841	PFET	Amplifier	*
2N2842	PFET	Amplifier	*
2N2843	PFET	Amplifier	*
2N3066	NFET	Amplifier	*
2N3067	NFET	Amplifier	*
2N3068	NFET	Amplifier	*
2N3069	NFET	Amplifier	3101
2N3070	NFET	Amplifier	3101
2N3071	NFET	Amplifier	3101
2N3329	PFET	Amplifier	*
2N3330	PFET	Amplifier	*
2N3331	PFET	Amplifier	*
2N3365	NFET	Amplifier	*
2N3366	NFET	Amplifier	*
2N3367	NFET	Amplifier	*
2N3368	NFET	Amplifier	3101
2N3369	NFET	Amplifier	3101
2N3370	NFET	Amplifier	3101
2N3376	PFET	Amplifier	*
2N3380	PFET	Amplifier	*
2N3382	PFET	Amplifier	*
2N3386	PFET	Amplifier	*
2N3436	NFET	Amplifier	3102
2N3437	NFET	Amplifier	3102
2N3438	NFET	Amplifier	3102
2N3452	NFET	Amplifier	3103
2N3453	NFET	Amplifier	3103
2N3454	NFET	Amplifier	3103
2N3455	NFET	Amplifier	3103
2N3456	NFET	Amplifier	3103
2N3457	NFET	Amplifier	3103
2N3458	NFET	Amplifier	3102
2N3459	NFET	Amplifier	3102
2N3460	NFET	Amplifier	3102
2N3823	NFET	Amplifier	3104
2N3921	DNFET	Amplifier	4101
2N3922	DNFET	Amplifier	4101
2N3934	DNFET	Amplifier	4102
2N3935	DNFET	Amplifier	4102
2N3966	NFET	Amplifier	3105
2N3967	NFET	Amplifier	3105
2N3967A	NFET	Amplifier	3105
2N3968	NFET	Amplifier	3105
2N3968A	NFET	Amplifier	3105
2N3969	NFET	Amplifier	3105
2N3969A	NFET	Amplifier	3105
2N3970	NFET	Switch	3301
2N3971	NFET	Switch	3301
2N3972	NFET	Switch	3301
2N4066	MDPFET	Amplifier	4501
2N4067	MDPFET	Amplifier	4501
2N4082	DNFET	Amplifier	4102
2N4083	DNFET	Amplifier	4102
2N4084	DNFET	Amplifier	4101
2N4085	DNFET	Amplifier	4101
2N4091	NFET	Switch	3302
2N4092	NFET	Switch	3302
2N4093	NFET	Switch	3302
2N4139	NFET	Amplifier	3106
2N4223	NFET	Amplifier	3107
2N4224	NFET	Amplifier	3107
2N4302	NFET	Amplifier	3108
2N4303	NFET	Amplifier	3108
2N4304	NFET	Amplifier	3108
2N4391	NFET	Switch	*
2N4392	NFET	Switch	*
2N4393	NFET	Switch	*
2N4416	NFET	Amplifier	3109
2N4416A	NFET	Amplifier	3109
2N4856	NFET	Switch	3303
2N4857	NFET	Switch	3303
2N4858	NFET	Switch	3303
2N4859	NFET	Switch	3303
2N4860	NFET	Switch	3303
2N4861	NFET	Switch	3303
2N4881	NFET	Amplifier	3110
2N4882	NFET	Amplifier	3110
2N4883	NFET	Amplifier	3110
2N4884	NFET	Amplifier	3110
2N4885	NFET	Amplifier	3110
2N4886	NFET	Amplifier	3110
2N4977	NFET	Switch	3304
2N4978	NFET	Switch	3304
2N4979	NFET	Switch	3304
2N5018	PFET	Switch	3701
2N5019	PFET	Switch	3701
2N5078	NFET	Amplifier	3111
2N5163	NFET	Amplifier	3112
2N5277	NFET	Amplifier	3113
2N5278	NFET	Amplifier	3113
2N5391	NFET	Amplifier	3114
2N5392	NFET	Amplifier	3114
2N5393	NFET	Amplifier	3114
2N5394	NFET	Amplifier	3114
2N5395	NFET	Amplifier	3114
2N5396	NFET	Amplifier	3114
2N5505	MDPFET	Amplifier	4502
2N5506	MDPFET	Amplifier	4502
2N5507	MDPFET	Amplifier	4502

Device Part No.	Type	Description	Sheet No.
2N5508	MDPFET	Amplifier	4502
2N5509	MDPFET	Amplifier	4502
2N5510	MDPFET	Amplifier	4503
2N5511	MDPFET	Amplifier	4503
2N5512	MDPFET	Amplifier	4503
2N5513	MDPFET	Amplifier	4503
2N5514	MDPFET	Amplifier	4503
P1027	PFET	Amplifier	*
P1028	PFET	Amplifier	*
P1029	PFET	Amplifier	*
P1069E	PFET	Amplifier	3502
P1086E	PFET	Switch	3702
P1087E	PFET	Switch	3702
SU2078	DNFET	Amplifier	*
SU2079	DNFET	Amplifier	*
SU2080	DNFET	Amplifier	*
SU2081	DNFET	Amplifier	*
SU2098	DNFET	Amplifier	4103
SU2098A	DNFET	Amplifier	4104
SU2098B	DNFET	Amplifier	4104
SU2099	DNFET	Amplifier	4103
SU2099A	DNFET	Amplifier	4104
U1277	NFET	Amplifier	*
U1278	NFET	Amplifier	*
U1279	NFET	Amplifier	*
U1280	NFET	Amplifier	*
U1281	NFET	Amplifier	*
U1282	NFET	Amplifier	*
U1283	NFET	Amplifier	*
U1284	NFET	Amplifier	*
U1285	NFET	Amplifier	*
U1286	NFET	Amplifier	*
U1325	NFET	Amplifier	*
U1714	NFET	Amplifier	3115
U1715	NFET	Amplifier	3116
U1837E	NFET	Amplifier	3117
U1897E	NFET	Switch	3305
U1898E	NFET	Switch	3305
U1899E	NFET	Switch	3305
U1994E	NFET	Amplifier	3118
U2047E	NFET	Amplifier	3119

DIGITAL MICROCIRCUITS

Device Part No.	Type	Description	Sheet No.
301	HNIL	Dual 5 Input Buffer	5002
302	HNIL	Quad 2 Input Power Gate	5003
303	HNIL	Quad 2 Input Buffer	5004
311	HNIL	RST-JK Flip-Flop	5005
312	HNIL	Dual JK Flip-Flop	5006
321	HNIL	Quad 2 Input Gate	5007
322	HNIL	Dual 5 Input Gate	5008
323	HNIL	Quad 2 Input Gate	5009
324	HNIL	Quad 2 Input Gate	5010
325	HNIL	Dual 2, Dual 3 Input Gate	5011
326	HNIL	Dual 2, Dual 3 Input Gate	5012
331	HNIL	Dual 5 Input Expander	5013
341	HNIL	Dual Exclusive-Or	5014
342	HNIL	Dual One Shot	5015
361	HNIL	Dual Input Interface	5016
362	HNIL	Dual Output Interface	5017
370	HNIL	Quad D Flip-Flop	5018
371	HNIL	Decade Counter	5019
372	HNIL	Hexidecimal Counter	5019
380	HNIL	BCD to Decade Decoder	5020
500	TTL	Dual 4 Input Gate	5201
501	TTL	Quad 2 Input Gate	5202
503	TTL	Triple 3 Input Gate	5204
504	TTL	Dual 4 Input Gate	5202
505	TTL	Quad 2 Input Gate	5203
507	TTL	Triple 3 Input Gate	5504
508	TTL	Dual 4 Input Nand/Nor Gate	5505
509	TTL	JK Flip-Flop	5506
510	TTL	Dual 3 Input Gate	*
510	TTL	Dual 3 Input Gate	*
511	TTL	Dual 3 Input Gate	*
512	TTL	JK Flip-Flop	*
513	TTL	Dual 4 Input Gate	*
525	ULP	Quad 2 Input Gate	5212
526	ULP	Dual 4 Input Gate	5212
527	ULP	Dual 3 Input Gate	5212
528	ULP	Dual 3 Input Gate	5212
529	ULP	JK Flip-Flop	5212
530	TTL	Dual 4 Input Gate	5202
531	TTL	Quad 2 Input Gate	5203
533	TTL	Triple 3 Input Gate	5204
534	TTL	Dual 4 Input Gate	5202
535	TTL	Quad 2 Input Gate	5202
537	TTL	Triple 3 Input Gate	5204
538	TTL	Dual 4 Input Nand/Nor Gate	5205
539	TTL	JK Flip-Flop	5206
540	TTL	Dual 4 Input Buffer	5207
541	TTL	Dual 4 Input Buffer	5207
543	TTL	Dual 4 Input Gate	5208
544	TTL	Dual 4 Input Gate	5208
547	TTL	Dual 4 Input Power Gate	5209
548	TTL	Dual 4 Input Power Gate	5209
570	TTL	Dual 4 Input Gate	5202
571	TTL	Quad 2 Input Gate	5202
573	TTL	Triple 3 Input Gate	5204
574	TTL	Dual 4 Input Gate	5202
575	TTL	Quad 2 Input Gate	5203
577	TTL	Triple 3 Input Gate	5204
578	TTL	Dual 4 Input Nand/Nor Gate	5205
579	TTL	JK Flip-Flop	5206
580	TTL	Dual 4 Input Buffer	5210
583	TTL	Dual 4 Input Gate	5209
584	TTL	Dual 4 Input Gate	5209
587	TTL	Dual 4 Input Buffer	5210
6040	DTL	(LPDTML 9040)	5301
6041	DTL	(LPDTML 9041)	5301
6042	DTL	(LPDTML 9042)	5301
6044	DTL	(LPDTML 9044)	5301
6046	DTL	(LPDTML 9046)	5301
6047	DTL	(LPDTML 9047)	5301

LINEAR MICROCIRCUITS

709	Monolithic	Operational Amplifier	6001
710	Monolithic	Operational Amplifier	6002
711	Monolithic	Operational Amplifier	6003

Device Part No.	Type	Description	Sheet No.
741	Monolithic	Operational Amplifier	6004
747	Dual Operational Amplifier		6005
800	Monolithic	Operational Amplifier	6101
801	Monolithic	Operational Amplifier	6101
805	Monolithic	Operational Amplifier	6102
806	Monolithic	Operational Amplifier	6102
807	Monolithic	Operational Amplifier	6102
808	Monolithic	Operational Amplifier	6102
809	Monolithic	Operational Amplifier	6103
810	Dual Operational Amplifier		6104
811	Monolithic	Operational Amplifier	6105
813	Monolithic	Operational Amplifier	6106
819	Monolithic	Operational Amplifier	6107
831	Monolithic	Differential Amplifier	6108
841	Monolithic	Operational Amplifier	6109
901	Monolithic	Video Amplifier	6201
903	Monolithic	VHF Amplifier	6202

Device Part No.	Type	Description	Sheet No.
911	Monolithic	RF/IF Amplifier	6203
HYBRID MICROCIRCUITS			
2001	Hybrid	High Voltage/Current Driver	7001
2107	Hybrid	SPST FET Analog Switch	7101
2110	Hybrid	SPST FET Analog Switch	7101
2114	Hybrid	SPDT FET Analog Switch	7102
2126	Hybrid	SPDT FET Analog Switch	7103
2128	Hybrid	Quad SPST FET Analog Sw.	7104
2404	Hybrid	Operational Amplifier	7401
2405	Hybrid	Operational Amplifier	7401
2709	Hybrid	Operational Amplifier	*
2741	Hybrid	Operational Amplifier	7701
2802	Hybrid	Voltage Regulator	7801
2803	Hybrid	Voltage Regulator	7801
2809	Hybrid	Operational Amplifier	7802

PRODUCT SUMMARY CATEGORY INDEX

NPN GENERAL PURPOSE

TYPE NO.	V_{CER}* OR V_{CEO} V	V_{CBO} V	V_{EBO} V	h_{fe}* @ 1KHz OR h_{FE}		$V_{CE(sat)}$ V	$V_{BE(sat)}$ V	I_{EBO} nA	I_{CBO} nA	I_{CBO} 150°C µA	C_{ob} pf	C_{ib} pf	f_T MHz	NF db	PACKAGE	
	min	min	min	min	max	max	max	max	max	max	max	max	min	max	TYPE	BASE
2N718	*40	60	5	40	120	1.5	1.3		1.0K	100	35		50		TO-18	3L
2N718A	*50	75	7	40	120	1.5	1.3	10	10	10	25	80	70		TO-18	3L
2N720	*80	120	5	40	120	5.0	1.3		2.0K	200	20		50		TO-18	3L
2N760	45	45	8	*76	333	1.0	1.0		200	10	8		50		TO-18	3L
2N760A	60	60	8	*76	333	1.0	1.1		100	10	8		50		TO-18	3L
2N910	60	100	7	*80	200	0.4	0.8	25	25	15	15	85	60		TO-18	3L
2N911	60	100	7	*40	100	0.4	0.8	25	25	15	15	85	50		TO-18	3L
2N929	45		5	40	120	1.0		10			8		30	4	TO-18	3L
2N929A	45	60	6	40	120	0.5	0.9	2	2	2	6		45	4	TO-18	3L
2N930	45		5	100	300	1.0		10			8		30	4	TO-18	3L
2N930A	45	60	6	100	300	0.5	0.9	2	2	2	6		45	3	TO-18	3L
2N930B	45	60	6	100	300	0.5	0.9	2	2	2	6		45	3	TO-18	3L
2N1613	*50	75	7	40	120	1.5	1.3	10	10	10	25	80	60		TO-5	3L
2N1711	*50	75	7	100	300	1.5	1.3	5	10	10	25	80	70		TO-5	3L
2N2192	40	60	5	100		.35		50	10		20		50		TO-5	3L
2N2192A	40	60	5	100		.25		50	10		20		50		TO-5	3L
2N2192B	40	60	5	100		.18		50	10		20		50		TO-5	3L
2N2193	50	80	8	40		.35		50	10		20		50		TO-5	3L
2N2193A	50	80	8	40		.25		50	10		20		50		TO-5	3L
2N2193B	50	80	8	40		.18		50	10		20		50		TO-5	3L
2N2194	40	60	5	20		.35		50	10		20		50		TO-5	3L
2N2194A	40	60	5	20		.25		50	10		20		50		TO-5	3L
2N2194B	40	60	5	20		.18		50	10		20		50		TO-5	3L
2N2195	25	45	5	20		.35		100	100		20		50		TO-5	3L
2N2195A	25	45	5	20		.25		100	100		20		50		TO-5	3L
2N2195B	25	45	5	20		.18		100	100		20		50		TO-5	3L
2N2217	30	60	5	20		0.4		10	10		8		250		TO-5	3L
2N2218	30	60	5	40		0.4		10	10		8		250		TO-5	3L
2N2218A	40	75	6	40		0.3		10	10		8	25	250		TO-5	3L
2N2219	30	60	5	100		0.4		10	10		8		250		TO-5	3L
2N2219A	40	75	6	100		0.3		10	10		8	25	300		TO-5	3L
2N2220	30	60	5	20		0.4		10	10		8		250		TO-18	3L
2N2221	30	60	5	40		0.4		10	10		8		250		TO-18	3L
2N2221A	40	75	6	40		0.3		10	10		8	25	250		TO-18	3L
2N2222	30	60	5	100		0.4		10	10		8		250		TO-18	3L
2N2222A	40	75	6	100		0.3		10	10		8	25	300		TO-18	3L
2N2222B	40	75	6	100		0.2			10	10	8	25	300	4	TO-18	3L

NPN GENERAL PURPOSE (Cont.)

TYPE NO.	V_{CER}* OR V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{fe}* @ 1KHz OR h_{FE} min	max	$V_{CE(sat)}$ V max	$V_{BE(sat)}$ V max	I_{EBO} nA max	I_{CBO} nA max	I_{CBO} 150°C µA max	C_{ob} pf max	C_{ib} pf max	f_T MHz min	NF db max	PACKAGE TYPE	BASE
2N2243		120	7	40	120	0.35		50	10	15	15				TO-5	3L
2N2243A		120	7	40	120	0.25		50	10	15	15				TO-5	3L
2N2297	35	80	7	40	120		1.6	10	10	10	12		60		TO-5	3L
2N2483	60	60	6	40	120	0.35		10	10	10	6	6	60	4	TO-18	3L
2N2484	60	60	6	100	500	0.35		10	10	10	6	6	60	3	TO-18	3L
2N2484A	60	60	6	100	500	0.35	0.7	10	10	10	6	6	60	2	TO-18	3L
2N2509	80	125	7	25		1.0	0.9	2	5	10	6	10	45	7	TO-18	3L
2N2510	65	100	7	75		1.0	0.9	2	5	10	6	10	45	4	TO-18	3L
2N2511	50	80	7	120		1.0	0.9	2	5	10	6	10	45	4	TO-18	3L
2N2586	45	60	6	120	360	0.5	0.9	2	2		7		45	3	TO-18	3L
2N2865	13	25	3	20	200	0.4	1.0		10	1.0	2.5		600	4.5	TO-18	4L
2N3117	60	60	6	250	500	0.35		10	10	10	4.5	6	60	1.0	TO-18	3L
2N5079	30	60	5	100	300	0.2	1.0	10	10	10	7.0	30	400	4	TO-18	3L
2N5080	30	60	5	200	500	0.2	1.0	10	10	10	7.0	30	400	4	TO-18	3L
A1109		45	5	70		0.6	0.9		100		8.0		40		TO-18	3L
A1341		75	5	50		1.2	1.2		10		10		40		TO-5	3L

PNP GENERAL PURPOSE

TYPE NO.	V_{CER}* OR V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{fe}* @ 1KHz OR h_{FE} min	max	$V_{CE(sat)}$ V max	$V_{BE(sat)}$ V max	I_{EBO} nA max	I_{CBO} nA max	I_{CBO} 150°C µA max	C_{ob} pf max	C_{ib} pf max	f_T MHz min	NF db max	PACKAGE TYPE	BASE
2N869	18	25	5	20	120	1.0	1.0		10	25	9	11	100		TO-18	3L
2N995	15	20	4	35	140	0.2	0.95	10K	5.0	25	10	11	100		TO-18	3L
2N2601	60	60	6	12.5		0.5	0.9	5	25	25	6		20		TO-46	3L
2N2602	60	60	6	25		0.5	0.9	5	25	25	6		40		TO-46	3L
2N2603	60	60	6	50		0.7	0.9	5	25	25	6		60		TO-46	3L
2N2604	−45	−60	−6	40	120	0.5	0.9	−2	10		6		30	4	TO-46	3L
2N2605	−45	−60	−6	100	300	0.5	0.9	−2	10		6		30	3	TO-46	3L
2N2904	40	60	5	20		0.4	1.3		20	20	8	30	200		TO-5	3L
2N2904A	60	60	5	40		0.4	1.3		10	10	8	30	200		TO-5	3L
2N2905	40	60	5	35		0.4	1.3		20	20	8	30	200		TO-5	3L
2N2905A	60	60	5	75		0.4	1.3		10	10	8	30	200		TO-5	3L
2N2906	40	60	5	20		0.4	1.3		20	20	8	30	200		TO-18	3L
2N2906A	60	60	5	40		0.4	1.3		10	10	8	30	200		TO-18	3L
2N2907	40	60	5	35		0.4	1.3		20	20	8	30	200		TO-18	3L
2N2907A	60	60	5	75		0.4	1.3		10	10	8	30	200		TO-18	3L

NPN MEDIUM POWER TRANSISTORS

TYPE NO.	V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{FE} min	$V_{CE(sat)}$ V max	I_{CBO} nA max	I_{EBO} nA max	C_{ob} pf max	C_{ib} pf max	h_{fe} 1 KHz min	h_{ie} Ω max	f_t MHz min	t_r nsec min	t_s nsec max	t_f nsec max	PACKAGE TYPE	BASE
2N2192	40	60	5	100	0.35	10	50	20				50	70	150	50	TO-5	3L
2N2192A	40	60	5	100	0.25	10	50	20				50	70	150	50	TO-5	3L
2N2192B	40	60	5	100	0.18	10	50	20				50	70	150	50	TO-5	3L
2N2193	50	80	8	40	0.35	10	50	20				50	70	150	50	TO-5	3L
2N2193A	50	80	8	40	0.25	10	50	20				50	70	150	50	TO-5	3L
2N2193B	50	80	8	40	0.18	10	50	20				50	70	150	50	TO-5	3L
2N2194	40	60	5	20	0.35	10	50	20				50	70	150	50	TO-5	3L
2N2194A	40	60	5	20	0.25	10	50	20				50	70	150	50	TO-5	3L
2N2194B	40	60	5	20	0.18	10	50	20				50	70	150	50	TO-5	3L
2N2195	25	45	5	20	0.35	100	100	20				50				TO-5	3L
2N2195A	25	45	5	20	0.25	100	100	20				50				TO-5	3L
2N2195B	25	45	5	20	0.18	100	100	20				50				TO-5	3L
2N2217	30	60	5	20	0.4	10	10	8			60	250				TO-5	3L
2N2218	30	60	5	40	0.4	10	10	8			60	250				TO-5	3L
2N2218A	40	75	6	30	0.3	10	10	8	25	50		250				TO-5	3L
2N2219	30	60	5	100	0.4	10	10	8			60	250				TO-5	3L
2N2219A	40	75	6	100	0.3	10	10	8	25	75		300				TO-5	3L
2N2220	30	60	5	20	0.4	10	10	8			60	250				TO-18	3L
2N2221	30	60	5	40	0.4	10	10	8			60	250				TO-18	3L
2N2221A	40	75	6	40	0.3	10	10	8	25	50		250				TO-18	3L
2N2222	30	60	5	100	0.4	10	10	8			60	250				TO-18	3L
2N2222A	40	75	6	100	0.3	10	10	8	25	75		300				TO-18	3L
2N2222B	40	75	6	100	0.2	10	10	8	25	75		300				TO-18	3L
2N2243		120	7	40	0.35	10	50	15		2.5						TO-5	3L
2N2243A		120	7	40	0.25	10	50	15		2.5		$T_b = 2.1$ nsec				TO-5	3L
2N2297	35	80	7	40		10	10	12				60				TO-5	3L

PNP MEDIUM POWER TRANSISTORS

TYPE NO.	V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{FE} min	$V_{CE(sat)}$ V max	I_{CBO} nA max	I_{EBO} nA max	C_{ob} pf max	C_{ib} pf max	h_{fe} 1 KHz min	h_{ie} Ω max	f_t MHz min	t_r nsec min	t_s nsec max	t_f nsec max	PACKAGE TYPE	BASE
2N2904	40	60	5	20	0.4	20		8	30			200	40	80	30	TO-5	3L
2N2904A	60	60	5	40	0.4	10		8	30			200	40	80	30	TO-5	3L
2N2905	40	60	5	35	0.4	20		8	30			200	40	80	30	TO-5	3L
2N2905A	60	60	5	75	0.4	10		8	30			200	40	80	30	TO-5	3L
2N2906	40	60	5	20	0.4	20		8	30			200	40	80	30	TO-18	3L
2N2906A	60	60	5	40	0.4	10		8	30			200	40	80	30	TO-18	3L
2N2907	40	60	5	35	0.4	20		8	30			200	40	80	30	TO-18	3L
2N2907A	60	60	5	75	0.4	10		8	30			200	40	80	30	TO-18	3L

NPN SWITCHING TRANSISTORS

TYPE NO.	V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{FE} min	$V_{CE(sat)}$ V max	I_{CBO} nA max	C_{ob} pf max	C_{ib} pf max	f_t MHz min	t_r nsec max	t_s nsec max	t_f nsec max	PACKAGE TYPE	BASE
2N2192	40	60	5.0	100	0.35	10	20		50	70	150	50	TO-5	3L
2N2192A	40	60	5.0	100	0.25	10	20		50	70	150	50	TO-5	3L
2N2192B	40	60	5.0	100	0.18	10	20		50	70	150	50	TO-5	3L
2N2193	50	80	8.0	40	0.35	10	20		50	70	150	50	TO-5	3L
2N2193A	50	80	8.0	40	0.25	10	20		50	70	150	50	TO-5	3L
2N2193B	50	80	8.0	40	0.18	10	20		50	70	150	50	TO-5	3L
2N2194	40	60	5.0	20	0.35	10	20		50	70	150	50	TO-5	3L
2N2194A	40	60	5.0	20	0.25	10	20		50	70	150	50	TO-5	3L
2N2194B	40	60	5.0	20	0.18	10	20		50	70	150	50	TO-5	3L
2N2218A	40	75	6.0	40	0.30	10	8.0	25	250	25	225	60	TO-5	3L
2N2219A	40	75	6.0	100	0.30	10	8.0	25	300	25	225	60	TO-5	3L
2N2221A	40	75	6.0	40	0.30	10	8.0	25	250	25	225	60	TO-5	3L
2N2222A	40	75	6.0	100	0.30	10	8.0	25	300	25	225	60	TO-5	3L
2N2222B	40	75	6.0	100	0.20	10	8.0	25	300	25	225	60	TO-5	3L
2N2368	15	40	4.5	20	0.25	400	4.0		400	12 t_{on}	10	15 t_{off}	TO-18	3L
2N2369	15	40	4.5	40	0.25		4.0		500	12 t_{on}	13	18 t_{off}	TO-18	3L
2N2369A	15	40	4.5	40	0.20		4.0		500	12 t_{on}	13	18 t_{off}	TO-18	3L

PNP SWITCHING TRANSISTORS

2N2904	40	60	5.0	20	0.40	20	8.0	30	200	40	80	30	TO-5	3L
2N2904A	60	60	5.0	40	0.40	10	8.0	30	200	40	80	30	TO-5	3L
2N2905	40	60	5.0	35	0.40	20	8.0	30	200	40	80	30	TO-5	3L
2N2905A	60	60	5.0	75	0.40	10	8.0	30	200	40	80	30	TO-5	3L
2N2906	40	60	5.0	20	0.40	20	8.0	30	200	40	80	30	TO-18	3L
2N2906A	60	60	5.0	40	0.40	10	8.0	30	200	40	80	30	TO-18	3L
2N2907	40	60	5.0	35	0.40	20	8.0	30	200	40	80	30	TO-18	3L
2N2907A	60	60	5.0	75	0.40	10	8.0	30	200	40	80	30	TO-18	3L

NPN RF/IF TRANSISTORS

TYPE NO.	V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{FE} min	$V_{CE(sat)}$ V max	I_{EBO}* I_{CBO} nA max	I_{CBO} 150°C μA max	C_{ob} pf max	C_{ib} pf max	f_t MHz min	A_p db	P_o mW	PACKAGE TYPE	BASE
2N915	50	70	5.0	50	1.0	10	10	3.5	10	250			TO-18	3L
2N915A	50	70	5.0	50	0.20	2.0	3.0	3.0	5.0	500			TO-18	3L
2N916	25	45	5.0	50	0.50	10	10	6.0	10	300			TO-18	3L
2N916A	25	45	5.0	50	0.50	10	10	6.0	10	300			TO-18	3L
2N916B	30	60	5.0	50	0.20	2.0	3.0	3.0	5.0	500			TO-18	3L
2N917	15	30	3.0	20	0.50	1.0	0.1	3.0	1.6	500	9	10	TO-18	4L
2N918	15	30	3.0	20	0.40	10	1.0	3.0	2.0	600	15	30	TO-18	4L
2N2368	15	40	4.5	20	0.25	400	30	4.0		400			TO-18	3L
2N2369	15	40	4.5	40	0.25	400	30	4.0		500			TO-18	3L
2N2369A	15	40	4.5	40	0.20	400	30	4.0		500			TO-18	3L
2N2481	15	40	5.0	40	0.25		30	5.0	7.0	300			TO-18	3L
2N2616	15	30	3.0	20	0.40	1.0	1.0	2.8	2.0	600	15	30	TO-18	3L
2N2708	20	35	3.0	30		10	10	1.5		700	22		TO-18	4L
2N2729	15	30	3.0	20	0.40	1.0	1.0	2.8	2.0	600	15	30	TO-46	3L
2N2865	13	25	3.0	20	0.40	10	1.0	2.5		600	16.5	40	TO-18	4L
2N3289	15	30	3.0	10	0.40	10	3.0	1.5		300	17		TO-18	4L
2N3290	15	30	3.0	10	0.40	10	3.0	1.5		300	17		TO-18	4L
2N3291	25	25	3.0	10		100*		2.0		250	16		TO-18	4L
2N3292	25	25	3.0	10		100*		2.0		250	16		TO-18	4L
2N3293	20	20	3.0	10		100*		2.0		250			TO-18	4L
2N3294	20	20	3.0	10		100*		2.0		250	14		TO-18	4L
2N5079	30	60	5.0	100	0.20	10	10	7.0	30	400			TO-18	3L
2N5080	30	60	5.0	200	0.20	10	10	7.0	30	400			TO-18	3L

PNP RF/IF TRANSISTORS

2N869	18	25	5.0	20	1.0	10	25	9.0	11	100			TO-18	3L
2N995	15	20	4.0	35	0.20	5.0	25	10	11	100			TO-18	3L
2N2905A	60	60	5.0	75	0.40	10	10	8.0	30	200			TO-5	3L
2N2907A	60	60	5.0	75	0.40	10	10	8.0	30	200			TO-18	3L

NPN TRANSISTORS DUAL ASSEMBLIES

TYPE NO.	V_{CEO} V min	V_{CBO} V min	V_{EBO} V min	h_{FE} min	h_{FE} max	$\frac{h_{FE1}}{h_{FE2}}$ min	$\frac{h_{FE1}}{h_{FE2}}$ max	$V_{CE(sat)}$ V max	$V_{BE(sat)}$ V max	$V_{BE}(1\text{-}2)$ mV max	$\frac{\Delta V_{BE}(1\text{-}2)}{\Delta T}$ µV/°C max
2N998	60	100	15	1600	8000			1.2	1.8		
2N2060	60	100	7	40	120	0.9	1.0	1.2	0.9	5	10
2N2060A	60	100	7	40	120	0.9	1.0	0.6	0.9	3	5
2N2223	60	100	7	25	150	0.8	1.0	1.2	0.9	15	25
2N2223A	60	100	7	25	150	0.9	1.0	1.2	0.9	5	25
2N2453	30	60	7	150	600	0.9	1.0	1.0	0.9	3	10
2N2453A	50	80	7	150	600	0.9	1.0	1.0	0.9	3	5
2N2480	40	75	5	20		0.8	1.0	1.3	1.0	10	15
2N2639	45	45	5	65		0.9	1.0	1.0	1.0	5	10
2N2640	45	45	5	65		0.8	1.0	1.0	1.0	10	20
2N2641	45	45	5	65				1.0	1.0		
2N2642	45	45	5	130		0.9	1.0	1.0	1.0	5	10
2N2643	45	45	5	130		0.8	1.0	1.0	1.0	10	20
2N2644	45	45	5	130				1.0	1.0		
2N2720	60	80	6	35		0.9	1.0	1.0	0.85	5	10
2N2721	60	80	6	35		0.8	1.0	1.0	0.85	10	20
2N2722	45	45	5	100		0.9	1.0	1.0	0.85	5	10
2N2903	30	60	7	125	625	0.8	1.0	1.0	0.9	10	20
2N2903A	30	60	7	125	625	0.9	1.0	1.0	0.9	5	10
2N2913	45	45	6	150				0.35			
2N2914	45	45	6	300				0.35			
2N2915	45	45	6	150		0.9	1.0	0.35		3	10
2N2916	45	45	6	300		0.9	1.0	0.35		3	10
2N2917	45	45	6	150		0.8	1.0	0.35		5	20
2N2918	45	45	6	300		0.8	1.0	0.35		5	20
2N2919	60	60	6	150		0.9	1.0	0.35		3	10
2N2920	60	60	6	300		0.9	1.0	0.35		3	10
2N2972	45	45	6	150				0.35			
2N2973	45	45	6	300				0.35			
2N2974	45	45	6	150		0.9	1.0	0.35		3	10
2N2975	45	45	6	300		0.9	1.0	0.35		3	10
2N2976	45	45	6	150		0.8	1.0	0.35		5	20
2N2977	45	45	6	300		0.8	1.0	0.35		5	20
2N2978	60	60	6	150		0.9	1.0	0.35		3	10
2N2979	60	60	6	300		0.9	1.0	0.35		3	10
2N2980	60	100	7	40	120	0.9	1.0	1.2	0.9	3	10
2N3423	15	30	3	20	200	0.8	1.0	0.4	1.0	10	40
2N3424	15	30	3	20	200	0.9	1.0	0.4	1.0	5	20
2N3680	50	60	6	150	600	0.9	1.0	0.7	0.8	3	6
SA2253		40		25		0.7	1.0			20	30
SA2664	20	60	5	800		0.75	1.0	1.5	1.7	5	10

I_{EBO} nA max	I_{CBO} nA max	I_{CBO} 150°C μA max	C_{ob} pf max	C_{ib} pf max	f_T MHz min	REMARKS	PACKAGE TYPE	BASE	TYPE NO.
10	10	15	30	50		Darlington	TO-18	4L	2N998
2	2	10	15	85	60	Differential Amplifier	TO-5	6L	2N2060
2	2	10	15	85	60	Differential Amplifier	TO-5	6L	2N2060A
10	10	15	15	85	50	Differential Amplifier	TO-5	6L	2N2223
10	10	15	15	85	50	Differential Amplifier	TO-5	6L	2N2223A
2	5	10	8	10	60	Differential Amplifier	TO-5	6L	2N2453
2	5	10	4	10	60	Differential Amplifier	TO-5	6L	2N2453A
50	50	15	20		50	Differential Amplifier	TO-5	6L	2N2480
10	10	10	8		80	Differential Amplifier	TO-5	6L	2N2639
10	10	10	8		80	Differential Amplifier	TO-5	6L	2N2640
10	10	10	8		80	Dual Transistor	TO-5	6L	2N2641
10	10	10	8		80	Differential Amplifier	TO-5	6L	2N2642
10	10	10	8		80	Differential Amplifier	TO-5	6L	2N2643
10	10	10	8		80	Dual Transistor	TO-5	6L	2N2644
10	10	10	6		80	Differential Amplifier	TO-5	6L	2N2720
10	10	10	6		80	Differential Amplifier	TO-5	6L	2N2721
1	1	1	6		100	Differential Amplifier	TO-5	6L	2N2722
10	10	15	8	10	60	Differential Amplifier	TO-5	6L	2N2903
10	10	15	8	10	60	Differential Amplifier	TO-5	6L	2N2903A
2	10	10	6		60	Dual Transistor	TO-5	6L	2N2913
2	10	10	6		60	Dual Transistor	TO-5	6L	2N2914
2	10	10	6		60	Differential Amplifier	TO-5	6L	2N2915
2	10	10	6		60	Differential Amplifier	TO-5	6L	2N2916
2	10	10	6		60	Differential Amplifier	TO-5	6L	2N2917
2	10	10	6		60	Differential Amplifier	TO-5	6L	2N2918
2	2	10	6		60	Differential Amplifier	TO-5	6L	2N2919
2	2	10	6		60	Differential Amplifier	TO-5	6L	2N2920
2	10	10	6		60	Dual Transistor	TO-18	6L	2N2972
2	10	10	6		60	Dual Transistor	TO-18	6L	2N2973
2	10	10	6		60	Differential Amplifier	TO-18	6L	2N2974
2	10	10	6		60	Differential Amplifier	TO-18	6L	2N2975
2	10	10	6		60	Differential Amplifier	TO-18	6L	2N2976
2	10	10	6		60	Differential Amplifier	TO-18	6L	2N2977
2	2	10	6		60	Differential Amplifier	TO-18	6L	2N2978
2	2	10	6		60	Differential Amplifier	TO-18	6L	2N2979
2	2	10	8	30	60	Differential Amplifier	TO-18	6L	2N2980
10	10	1	1.7	2	600	Hf, low noise mtchd pr.	TO-5	6L	2N3423
10	10	1	1.7	2	600	Hf, low noise mtchd pr.	TO-5	6L	2N3424
10	10	10	6	6	60	Matched Pr.	TO-5	6L	2N3680
	50					Differential Amplifier	TO-5	6L	SA2253
10	10		7			Monolithic Dual Darlington	TO-5	8L	SA2664

PNP TRANSISTORS DUAL ASSEMBLIES

TYPE NO.	V_{CEO} V	V_{CBO} V	V_{EBO} V	h_{FE}		$\frac{h_{FE1}}{h_{FE2}}$		$V_{CE(sat)}$ V	$V_{BE(sat)}$ V	$V_{BE}(1-2)$ mV	$\frac{\Delta V_{BE}(1-2)}{\Delta T}$ μV/°C
	min	min	min	min	max	min	max	max	max	max	max
2N3347	45	60	6	60		0.9	1.0	0.5		5	10
2N3348	45	60	6	60		0.8	1.0	0.5		10	20
2N3349	45	60	6	60		0.6	1.0	0.5		20	40
2N3350	45	60	6	150		0.9	1.0	0.5		5	10
2N3351	45	60	6	150		0.8	1.0	0.5		10	20
2N3352	45	60	6	150		0.6	1.0	0.5		20	40
2N3800	60	60	5	100				0.2	0.7		
2N3801	60	60	5	225				0.2	0.7		
2N3802	60	60	5	100		0.8	1.0	0.2	0.7	5	20
2N3803	60	60	5	225		0.8	1.0	0.2	0.7	5	20
2N3804	60	60	5	100		0.9	1.0	0.2	0.7	3	10
2N3805	60	60	5	225		0.9	1.0	0.2	0.7	3	10
2N3806	60	60	5	100				0.2	0.7		
2N3807	60	60	5	225				0.2	0.7		
2N3808	60	60	5	100		0.8	1.0	0.2	0.7	5	20
2N3809	60	60	5	225		0.8	1.0	0.2	0.7	5	20
2N3810	60	60	5	100		0.9	1.0	0.2	0.7	3	10
2N3811	60	60	5	225		0.9	1.0	0.2	0.7	3	10
2N4015	60	60	5	135	350	0.9	1.0	0.25	1.0	5	20
2N4016	60	60	5	135	350	0.9	1.0	0.25	1.0	2.5	10
2N4017	80	80	6	100	500			0.25	0.9		
2N4018	60	60	6	100	600			0.25	0.9		
2N4019	45	45	6	250	600			0.25	0.9		

I_{EBO} nA max	I_{CBO} nA max	I_{CBO} 150°C µA max	C_{ob} pf max	C_{ib} pf max	f_T MHz min	REMARKS	PACKAGE		TYPE NO.
							TYPE	BASE	
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3347
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3348
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3349
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3350
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3351
2	10	10	6	8	60	Differential Amplifier	TO-5	6L	2N3352
20	10	10	4	8	100	Dual Transistor	TO-18	6L	2N3800
20	10	10	4	8	100	Dual Transistor	TO-18	6L	2N3801
20	10	10	4	8	100	Differential Amplifier	TO-18	6L	2N3802
20	10	10	4	8	100	Differential Amplifier	TO-18	6L	2N3803
20	10	10	4	8	100	Differential Amplifier	TO-18	6L	2N3804
20	10	10	4	8	100	Differential Amplifier	TO-18	6L	2N3805
20	10	10	4	8	100	Dual Transistor	TO-5	6L	2N3806
20	10	10	4	8	100	Dual Transistor	TO-5	6L	2N3807
20	10	10	4	8	100	Differential Transistor	TO-5	6L	2N3808
20	10	10	4	8	100	Differential Transistor	TO-5	6L	2N3809
20	10	10	4	8	100	Differential Transistor	TO-5	6L	2N3810
20	10	10	4	8	100	Differential Transistor	TO-5	6L	2N3811
100	10	10	8	25	200	Differential Transistor	TO-5	6L	2N4015
100	10	10	8	25	200	Differential Transistor	TO-5	6L	2N4016
10	10	10	6		40	Dual Transistor	TO-5	6L	2N4017
10	10	10	6		40	Dual Transistor	TO-5	6L	2N4018
10	10	10	6		50	Dual Transistor	TO-5	6L	2N4019

MILITARY TYPES

*JAN2N718A
MIL-S-19500/181C

JAN2N910
MIL-S-19500/274A

JAN2N916
MIL-S-19500/271A

*JAN2N918
MIL-S-19500/301A

*JAN2N929
MIL-S-19500/253B

*JAN2N230
MIL-S-19500/253B

*JAN2N1613
MIL-S-19500/181C

*JAN2N2060
MIL-S-19500/270B

*JAN2N2218
MIL-S-19500/251E

*JAN2N2218A
MIL-S-19500/251E

*JAN2N2219
MIL-S-19500/251E

*JAN2N2219A
MIL-S-19500/255E

*JAN2N2221
MIL-S-19500/255E

*JAN2N2221A
MIL-S-19500/255E

*JAN2N2222
MIL-S-19500/255E

*JAN2N2222A
MIL-S-19500/255E

JAN2N2606
MIL-S-19500/292

JAN2N2607
MIL-S-19500/294

JAN2N2608
MIL-S-19500/295

JAN2N2609
MIL-S-19500/296

JAN2N2708
MIL-S-19500/302

*JAN2N2904
MIL-S-19500/290B

*JAN2N2904A
MIL-S-19500/290B

*JAN2N2905
MIL-S-19500/290B

*JAN2N2905A
MIL-S-19500/290B

*JAN2N2906
MIL-S-19500/291B

*JAN2N2906A
MIL-S-19500/291B

JAN2N2907
MIL-S-19500/291B

*JAN2N2907A
MIL-S-19500/291B

*JAN2N2919
MIL-S-19500/355

*JAN2N2920
MIL-S-19500/355

*Also Available To
Jan TX specification

N-CHANNEL FIELD EFFECT TRANSISTORS GENERAL PURPOSE

	BV_{DGO}	I_{GSS}	I_{GSS} @ 150°C	I_{DSS}		gm		V_p	C_{rss}* or C_{DG}	C_{SG}	NF	PACKAGE	
	V	nA	µA	mA		µmhos		V	pf	pf	10 Hz		
TYPE NO.	min	max	max	min	max	min	max	max	max	max	max	TYPE	BASE
2N3066	50	1.0	1.0	0.8	4.0	400	1000	10.0	1.5	3.0		TO-18	3L
2N3067	50	1.0	1.0	0.2	1.0	300	1000	5.0	1.5	3.0		TO-18	3L
2N3068	50	1.0	1.0	0.05	0.25	200	1000	2.5	1.5	3.0		TO-18	3L
2N3069	50	1.0	1.0	2.0	10.0	1000	2500	10.0	2.5	5.0		TO-18	3L
2N3070	50	1.0	1.0	0.5	2.5	750	2500	5.0	2.5	5.0		TO-18	3L
2N3071	50	1.0	1.0	0.1	0.6	500	2500	2.5	2.5	5.0		TO-18	3L
2N3365	40	5.0	1.0(100°C)	0.8	4.0	400	2000	12.0	2.0	3.0		TO-18	3L
2N3366	40	5.0	1.0(100°C)	0.2	1.0	250	1000	7.0	2.0	3.0		TO-18	3L
2N3367	40	5.0	1.0(100°C)	0.05	0.25	100	1000	2.5	2.0	3.0		TO-18	3L
2N3368	40	5.0	1.5(100°C)	2.0	12.0	1000	4000	12.0	3.5	6.0		TO-18	3L
2N3369	40	5.0	1.5(100°C)	0.5	2.5	600	2500	7.0	3.5	6.0		TO-18	3L
2N3370	40	5.0	1.5(100°C)	0.1	0.6	300	2500	3.5	3.5	6.0		TO-18	3L
2N3436	50	0.5	1.0	3.0	15.0	2500	10K	10.0	5.0	5.0		TO-18	3L
2N3437	50	0.5	1.0	0.8	4.0	1500	6000	5.0	5.0	5.0		TO-18	3L
2N3438	50	0.5	1.0	0.2	1.0	800	4500	2.5	5.0	5.0		TO-18	3L
2N3452	50	0.1	0.4	0.8	4.0	200	1200	10.0	1.2	1.8		TO-18	4L
2N3453	50	0.1	0.4	0.2	1.0	150	900	5.0	1.2	1.8		TO-18	4L
2N3454	50	0.1	0.4	0.05	0.25	100	600	2.5	1.2	1.8		TO-18	4L
2N3455	50	0.04	0.15	0.8	4.0	400	1200	10.0	1.0	1.5		TO-18	4L
2N3456	50	0.04	0.15	0.2	1.0	300	900	5.0	1.0	1.5		TO-18	4L
2N3457	50	0.04	0.15	0.05	0.25	150	600	2.5	1.0	1.5		TO-18	4L
2N3458	50	0.25	0.5	3.0	15.0	2500	10K	8.0	5.0	5.0		TO-18	3L
2N3459	50	0.25	0.5	0.8	4.0	1500	6000	4.0	5.0	5.0		TO-18	3L
2N3460	50	0.25	0.5	0.2	1.0	800	4500	2.0	5.0	5.0		TO-18	3L
2N3967	30	0.1	0.2	2.5	10.0	1600	2400	5.0	1.3*			TO-18	4L
2N3967A	30	0.1	0.2	2.5	10.0	1600	2400	5.0	1.3*		4.0	TO-18	4L
2N3968	30	0.1	0.2	1.0	5.0	1400	2000	3.0	1.3*			TO-18	4L
2N3968A	30	0.1	0.2	1.0	5.0	1400	2000	3.0	1.3*		4.0	TO-18	4L
2N3969	30	0.1	0.2	0.4	2.0	950	1450	1.7	1.3*			TO-18	4L
2N3969A	30	0.1	0.2	0.4	2.0	950	1450	1.7	1.3*		4.0	TO-18	4L
2N4139	50	1.0	1.0	8.0	11.0	3500	7000	8.0	5.0	5.0		TO-18	3L
2N4302	30	1.0	0.1(85°C)	0.5	5.0	1000		4.0	3.0*		2.0	RO-97B	3L
2N4303	30	1.0	0.1(85°C)	4.0	10.0	2000		6.0	3.0*		2.0	RO-97B	3L
2N4304	30	1.0	0.1(85°C)	5.0	15.0	1000		10.0	3.0*		3.0	RO-97B	3L

LOW NOISE N CHANNEL

2N5391	70	0.1	0.2	0.5	1.5	1500	4500	2.0	5.0*		2.0	TO-18	3L
2N5392	70	0.1	0.2	1.0	3.0	2000	6000	2.5	5.0*		2.0	TO-18	3L
2N5393	70	0.1	0.2	2.5	4.5	3000	6500	3.0	5.0*		2.0	TO-18	3L
2N5394	70	0.1	0.2	4.0	6.0	4000	7000	4.0	5.0*		2.0	TO-18	3L
2N5395	70	0.1	0.2	5.5	8.0	4500	7000	4.0	5.0*		2.0	TO-18	3L
2N5396	70	0.1	0.2	7.5	10.0	4500	7500	5.0	5.0*		2.0	TO-18	3L

GENERAL PURPOSE P CHANNEL

TYPE NO.	BV_{DGO} V min	I_{GSS} nA max	I_{GSS} 150°C μA max	I_{DSS} mA min	max	gm μmhos min	max	V_p V max	C_{iss} pf max	PACKAGE TYPE	BASE
2N2499	20	10.0	10.0	5.0	15.0	2000	4000	8.0	32	TO-18	3L
2N2841	30	1.0	1.0	.025	.125	60		1.7	6	TO-18	3L
2N2842	30	3.0	3.0	.065	.325	180		1.7	10	TO-18	3L
2N2843	30	10.0	10.0	.2	1.0	540		1.7	17	TO-18	3L
2N3329	20	10.0	10.0	1.0	3.0	1000	2000	5.0	20	TO-18	4L
2N3330	20	10.0	10.0	2.0	6.0	1500	3000	6.0	20	TO-18	4L
2N3331	20	10.0	10.0	5.0	15.0	2000	4000	8.0	20	TO-18	4L
2N3376	30	3.0	3.0	0.6	6.0	800	2300	5.0	5	TO-18	4L
2N3380	30	3.0	3.0	3.0	20.0	1500	3000	9.5	5	TO-18	4L
2N3382	30	15.0	15.0	3.0	30.0	4500	12500	5.0	16	TO-18	4L
P1027	30	3.0	6.0	0.6	6.0	750	3500	3.0	20	TO-18	3L
P1028	30	3.0	6.0	2.0	20.0	2500	8000	5.0	30	TO-18	3L
P1029	30	3.0	6.0	5.0	50.0	5000		8.0	50	TO-18	3L

EPOXY ENCASED N CHANNEL

TYPE NO.	BV_{DGO} V min	I_{DGO}* or I_{GSS} nA max	I_{DSS} mA min	max	gm μmhos min	V_p V max	C_{DG}* or C_{rss} pf max	g_{os} μmhos max	R_{on} Ω max	PACKAGE TYPE	BASE
2N4302	30	1	0.5	5	1000	4	3	50		RO-97B	3L
2N4303	30	1	4.0	10	2000	6	3	50		RO-97B	3L
2N4304	30	1	5.0	15	1000	10	3	50		RO-97B	3L
U1837E	30	0.25	4.0	25	4500	8	2			RO-97B	3L
U1897E	40	0.2*	30.0			10	5*		30	RO-97B	3L
U1898E	40	0.2*	15			7	5*		50	RO-97B	3L
U1899E	40	0.2*	8			5	5*		80	RO-97B	3L

EPOXY ENCASED P CHANNEL

TYPE NO.	BV_{DGO} V min	I_{DGO}* or I_{GSS} nA max	I_{DSS} mA min	max	gm μmhos min	V_p V max	C_{DG}* or C_{rss} pf max	g_{os} μmhos max	R_{on} Ω max	PACKAGE TYPE	BASE
P1086E	30	2	10			10	8		75	RO-97B	3L
P1087E	30	2	5			5	8		150	RO-97B	3L

HIGH FREQUENCY N CHANNEL

TYPE NO.	BV_{DGO} V min	I_{GSS} nA max	I_{GSS} @ 150° μA max	I_{DSS} mA min	max	yfs μmhos min	max	V_p V max	C_{rss} pf max	Power Gain @ f = 200 MHz db min	PACKAGE TYPE	BASE
2N3823	30	0.50	0.50	4	20	3500	6500	8	2		TO-18	4L
2N4223	30	0.25	0.25	3	18	3000	7000	8	2	10	TO-18	4L
2N4224	30	0.50	0.50	2	20	2000	7500	8	2		TO-18	4L
2N5078	30	0.25	0.25	4	25	4500	10000	8	2	15	TO-18	4L
2N4416	30	0.10	0.20	5	15	4500	7500	6	0.8	18 (100MHz)	TO-18	4L
U1837E	30	0.25	0.02 (85°C)	4	25	4500	10000	8	2	15	RO-97B	3L

LOW CAPACITANCE N CHANNEL

TYPE NO.	BV_{DGO} V min	I_{GSS} nA max	I_{GSS} at 150°C μA max	I_{DSS} mA min	I_{DSS} mA max	g_m. μmhos min	g_m. μmhos max	V_p V max	C_{DG} pf max	C_{SG} pf max	NF 10 Hz db max	PACKAGE TYPE	PACKAGE BASE
2N3452	50	0.1	0.4	0.8	4.0	200	1200	10.0	1.2	1.8		TO-18	4L
2N3453	50	0.1	0.4	0.2	1.0	150	900	5.0	1.2	1.8		TO-18	4L
2N3454	50	0.1	0.4	0.05	0.25	100	600	2.5	1.2	1.8		TO-18	4L
2N3455	50	0.04	0.15	0.8	4.0	400	1200	10.0	1.0	1.5		TO-18	4L
2N3456	50	0.04	0.15	0.2	1.0	300	900	5.0	1.0	1.5		TO-18	4L
2N3457	50	0.04	0.15	0.05	0.25	150	600	2.5	1.0	1.5		TO-18	4L
2N3967	30	0.1	0.2	2.5	10.0	1600	2400	5.0	1.3*			TO-18	4L
2N3967A	30	0.1	0.2	2.5	10.0	1600	2400	5.0	1.3*		4	TO-18	4L
2N3968	30	0.1	0.2	1.0	5.0	1400	2000	3.0	1.3*			TO-18	4L
2N3968A	30	0.1	0.2	1.0	5.0	1400	2000	3.0	1.3*		4	TO-18	4L
2N3969	30	0.1	0.2	0.4	2.0	950	1450	1.7	1.3*			TO-18	4L
2N3969A	30	0.1	0.2	0.4	2.0	950	1450	1.7	1.3*		4	TO-18	4L
U1277	50	0.1	0.2	1.5	8.0	450	@ 1.5 mA	8.0	1.2	1.8		TO-18	4L
U1278	50	0.1	0.2	0.5	3.0	350	@ 0.5 mA	4.5	1.2	1.8		TO-18	4L
U1279	50	0.1	0.2	0.2	1.5	250	@ 0.2 mA	2.5	1.2	1.8		TO-18	4L
U1280	50	0.1	0.2	0.1	10.0	250		10.0	1.2	1.8		TO-18	4L
U1285	30	5.0		0.1		200	1200	8.0	2.0	3.0		TO-18	4L
U1325	30	0.1	0.2	0.1	0.5	500		1.2	1.3	1.5		TO-18	4L

HIGH GAIN N CHANNEL

TYPE NO.	BV_{DGO} V min	I_{GSS} nA max	I_{GSS} at 150°C μA max	I_{DSS} mA min	I_{DSS} mA max	g_m. μmhos min	g_m. μmhos max	V_p V max	C_{DG} pf max	C_{SG} pf max	NF 10 Hz db max	PACKAGE TYPE	PACKAGE BASE
2N3436	50	0.5	1.0	3.0	15.0	2500	10000	10.0	5.0	5.0		TO-18	3L
2N3437	50	0.5	1.0	0.8	4.0	1500	6000	5.0	5.0	5.0		TO-18	3L
2N3438	50	0.5	1.0	0.2	1.0	800	4500	2.5	5.0	5.0		TO-18	3L
2N3458	50	0.25	0.5	3.0	15.0	2500	10000	8.0	5.0	5.0		TO-18	3L
2N3459	50	0.25	0.5	0.8	4.0	1500	6000	4.0	5.0	5.0		TO-18	3L
2N3460	50	0.25	0.5	0.2	1.0	800	4500	2.0	5.0	5.0		TO-18	3L
2N4139	50	1.0	1.0	8.0	11.0	3500	7000	8.0	5.0	5.0		TO-18	3L
U1281	50	0.5	1.0	8.0		3000		8.0	5.0	5.0		TO-18	3L
U1282	50	0.5	1.0	4.0	20.0	2500		4.5	5.0	5.0		TO-18	3L
U1283	50	0.5	1.0	1.0	10.0	1500		2.5	5.0	5.0		TO-18	3L
U1284	50	0.5	1.0	0.2	40.0	1000		10.0	5.0	5.0		TO-18	3L
U1286	30	10.0		0.2		1000	1000	8.0	8.0	8.0		TO-18	3L

LOW Ron P CHANNEL

TYPE NO.	BV_{DGO} V min	BV_{SGO} V min	R_{on} Ω max	I_{DSS} mA min	I_{DSS} mA max	I_{DGO} nA max	I_{GSS} *or $I_{D(off)}$ nA max	V_p V max	C_{is} pf max	t_d nSec max	t_r nSec max	t_{off} nSec max	PACKAGE TYPE	PACKAGE BASE
2N5018	30	30	75	10.0		2.0	10.0	10	45	15	20	50	TO-18	3L
2N5019	30	30	150	5.0		2.0	10.0	5	45	15	75	100	TO-18	3L
P1086E	30	30	75	10.0		2.0	10.0	10	45	15	20	50	RO-97B	3L
P1087E	30	30	150	5.0		2.0	10.0	5	45	15	75	100	RO-97B	3L

LOW Ron N CHANNEL

TYPE NO.	BV_{DGO} V min	BV_{SGO} V min	R_{on} Ω max	I_{DSS} mA min	I_{DSS} mA max	I_{GSS} *or I_{DGO} nA max	$I_{D(off)}$ nA max	V_p V max	C_{is} pf max	t_d nSec max	t_r nSec max	t_{off} nSec max	PACKAGE TYPE	PACKAGE BASE
2N3966	30	30	220	2.0		0.1	1.0	6	6	20	100	100	TO-18	4L
2N3970	40	40	30	50.0	150	0.25	0.25	10	16	10	15	60	TO-18	3L
2N3971	40	40	60	25.0	75	0.25	0.25	5	16	15	15	60	TO-18	3L
2N3972	40	40	100	5.0	30	0.25	0.25	3	16	40	40	100	TO-18	3L
2N4091	40	40	30	30.0		0.2	0.2	10	16	15	10	40	TO-18	3L
2N4092	40	40	50	15.0		0.2	0.2	7	16	15	20	60	TO-18	3L
2N4093	40	40	80	8.0		0.2	0.2	5	16	20	40	80	TO-18	3L
2N4391	40	40	30	50.0	150	0.1	0.1*	10	14		5	20	TO-18	3L
2N4392	40	40	60	25.0	75	0.1	0.1*	5	14		5	35	TO-18	3L
2N4393	40	40	100	5.0	30	0.1	0.1*	3	14		5	50	TO-18	3L
2N4856	40	40	25	50.0		0.25	0.25*	10	18	6	3	25	TO-18	3L
2N4857	40	40	40	20.0	100	0.25	0.25*	6	18	6	4	50	TO-18	3L
2N4858	40	40	60	8.0	80	0.25	0.25*	4	18	10	10	100	TO-18	3L
2N4859	30	30	25	50.0		0.25	0.25*	10	18	6	3	25	TO-18	3L
2N4860	30	30	40	20.0	100	0.25	0.25*	6	18	6	4	50	TO-18	3L
2N4861	30	30	60	8.0	80	0.25	0.25*	4	18	10	10	100	TO-18	3L
2N4977	30	30	15	50.0		0.5	0.5	10	35	5	5	20	TO-18	3L
2N4978	30	30	20	15.0		0.5	0.5	8	35	5	10	40	TO-18	3L
2N4979	30	30	40	7.5		0.5	0.5	5	35	10	30	60	TO-18	3L
U1897E	40	40	30	30.0		0.2	0.2	10	16	15	10	40	RO-97B	3L
U1898E	40	40	50	15.0		0.2	0.2	7	16	15	20	60	RO-R7B	3L
U1899E	40	40	80	8.0		0.2	0.2	5	16	20	40	80	RO-97B	3L

HIGH VOLTAGE N CHANNEL

TYPE NO.	BV_{DGO} V min	I_{GSS} nA max	I_{GSS} @ 150°C µA max	I_{DSS} mA min	I_{DSS} mA max	g_m µmhos min	g_m µmhos max	V_p V max	C_{DG} pf max	C_{SG} pf max	PACKAGE TYPE	PACKAGE BASE
2N4881	300	2	4	0.4	2.0	350	1000	15	1.5	1.5	TO-5	3L
2N4882	300	2	4	1.5	7.5	600	1500	15	1.5	1.5	TO-5	3L
2N4883	200	1	2	0.4	2.0	350	1000	10	1.5	1.5	TO-5	3L
2N4884	200	1	2	1.5	7.5	600	1500	10	1.5	1.5	TO-5	3L
2N4885	125	1	2	0.4	2.0	350	1000	10	1.5	1.5	TO-5	3L
2N4886	125	1	2	1.5	7.5	600	1500	10	1.5	1.5	TO-5	3L
2N5277	150	5	5	2.5	12.5	2000	5000	7.0	5.0	5.0	TO-5	3L
2N5278	150	5	5	10.0	25.0	3000	6000	10	5.0	5.0	TO-5	3L
U1715	200	5		10.0	50.0	$R_{ON} = 400\Omega$ max		15	4.0	4.0	TO-5	3L

ULTRA LOW LEAKAGE N CHANNEL

U1714	25	.005		0.5	5.0	400		5	1.2	1.2	TO-18	3L

SMALL SIGNAL P CHANNEL

	BV$_{DGO}$	I$_{GSS}$	I$_{GSS}$ at 150°C	I$_{DSS}$		g$_m$	NF	V$_p$	C$_{iss}$	PACKAGE	
	V	na	mA	mA		μmhos	db	V	pf		
TYPE NO.	max	max	max	min	max	min	max	max	max	TYPE	BASE
2N2606	−30	1.0	1.0	−0.1	−0.5	110	3.0	4.0	6.0	TO-18	3L
2N2607	−30	3.0	3.0	−0.3	−1.5	330	3.0	4.0	17	TO-18	3L
2N2608	−30	10	10	−0.9	−4.5	1000	3.0	4.0	17	TO-18	3L
2N2609	−30	30	30	−2.0	−10	2500	3.0	4.0	30	TO-18	3L

See page 12 for a complete list of our military approved devices.

FIELD EFFECT TRANSISTORS DUAL ASSEMBLIES

	BV$_{DGO}$	V$_p$	g$_m$	$\frac{g_{m1}}{g_{m2}}$		I$_{DSS}$		V$_{GS(1-2)}$	$\frac{\Delta V_{GS(1-2)}}{\Delta T}$	I$_G$	I$_G$ 100°C	C$_{iss}$		PACKAGE	
	V	V	μmhos			mA		mV	μV/°C	nA	nA	pf			
TYPE NO.	min	max	min	min	max	min	max	max	max	max	max	max	REMARKS	TYPE	BASE
2N3921	50	3	1500	0.95	1	1	10	5	10	0.25	25	18	Matched Pair	TO-18	6L
2N3922	50	3	1500	0.95	1	1	10	5	25	0.25	25	18	Matched Pair	TO-18	6L
2N3934	50	3	300	0.95	1	0.25	1.3	5	10	0.1	10	7	Matched Pair	TO-18	6L
2N3935	50	3	300	0.95	1	0.25	1.3	5	25	0.1	10	7	Matched Pair	TO-18	6L
2N4082	50	3	300	0.95	1	0.25	1.3	15	10	0.1	10	7	Matched Pair	TO-18	6L
2N4083	50	3	300	0.95	1	0.25	1.3	15	25	0.1	10	7	Matched Pair	TO-18	6L
2N4084	50	3	1500	0.95	1	1	10	15	10	0.25	25	18	Matched Pair	TO-18	6L
2N4085	50	3	1500	0.95	1	1	10	15	25	0.25	25	18	Matched Pair	TO-18	6L
SU2078	50	4	300	0.9	1	0.25	2	15	35	0.25	25	7	Matched Pair	TO-18	6L
SU2079	50	4	300	0.9	1	0.25	2	15	60	0.25	25	7	Matched Pair	TO-18	6L
SU2080	50	4	1500	0.9	1	1	10	15	35	0.5	50	18	Matched Pair	TO-18	6L
SU2081	50	4	1500	0.9	1	1	10	15	60	0.5	50	18	Matched Pair	TO-18	6L
SU2098	30	4	1000	0.95	1	1	8	5	10	0.1	10	7	Matched Pair	TO-18	6L
SU2099	30	4	1000	0.95	1	1	8	5	25	0.1	10	7	Matched Pair	TO-18	6L
SU2098A	50	4	1500	0.95	1	1	8	5	10	0.05	5	6	Matched Pair	TO-18	6L
SU2098B	50	4	1500	0.95	1	1	8	5	5	0.05	5	6	Matched Pair	TO-18	6L
SU2099A	50	4	1500	0.95	1	1	8	5	25	0.05	5	6	Matched Pair	TO-18	6L
2N5045	50	4.5	1.5	0.95	1	0.5	8	5	67	0.25		8	Matched Pair	TO-18	6L
2N5046	50	4.5	1.5	0.90	1	0.5	8	10	133	0.25		8	Matched Pair	TO-18	6L
2N5047	50	4.5	1.5	0.80	1	0.5	8	15	200	0.25		8	Matched Pair	TO-18	6L
				MONOLITHIC P CHANNEL DUAL ASSEMBLIES											
2N5505	30	4	1000	0.95	1	0.8	7	5	10	0.2	25	16	Matched Pair	TO-18	6L
2N5506	30	4	1000	0.95	1	0.8	7	15	10	0.2	25	16	Matched Pair	TO-18	6L
2N5507	30	4	1000	0.95	1	0.8	7	5	15	0.2	25	16	Matched Pair	TO-18	6L
2N5508	30	4	1000	0.95	1	0.8	7	15	25	0.2	25	16	Matched Pair	TO-18	6L
2N5509	30	5	1000	0.90	1	0.25	5	25	50	0.2	25	16	Matched Pair	TO-18	6L
2N5510	30	4	500	0.95	1	0.25	5	5	10	0.2	25	16	Matched Pair	TO-18	6L
2N5511	30	4	500	0.95	1	0.25	5	15	10	0.2	25	16	Matched Pair	TO-18	6L
2N5512	30	4	500	0.95	1	0.25	5	5	25	0.2	25	16	Matched Pair	TO-18	6L
2N5513	30	4	500	0.95	1	0.25	5	15	25	0.2	25	16	Matched Pair	TO-18	6L
2N5514	30	5	500	0.90	1	0.25	5	25	50	0.2	25	16	Matched Pair	TO-18	6L

MILITARY GRADE OPERATIONAL AMPLIFIERS

Operating Temperature Range −55°C to +125°C

TYPE NO.	Power Supply ±V_{CC}	A_{VOL} kV/V		V_{OS} mV		V_{OS} $-T_A$ to $+T_A$ mV		V_{OS} Drift µV/°C		I_{BIAS} nA		I_{BIAS} (Note 2) nA		I_{OFF} nA		I_{OFF} (Note 2) nA		I_{OFF} Drift nA/°C	
		min	typ	typ	max	typ	max	typ	max	typ	max	typ	max	typ	max	typ	max	typ	max
709A	±15	25	45	0.5	1.0	1.0	2.0	3.0	10	100	200	250	750	10	50	50	250	1.0	3.3
709B	±15	25	45	1.0	5.0	2.0	6.0	3.0		200	500	500	1500	50	200	100	500	1.0	
741B	±15	50	200	1.0	5.0	2.0	6.0	3.0		200	500	500	1.5	30	200	75	500	1.0	
747B	±15	50	200	1.0	5.0	2.0	6.0	3.0		200	500	500	1.5	30	200	75	500	1.0	
748B	±15	50	200	1.0	5.0	2.0	6.0	3.0		200	500	500	1.5	30	200	75	500	1.0	
805B	±15	30	60	1.0	5.0	2.0	7.0	5.0	20	250	500	750	1500	10	50	25	250	0.1	1.0
807B	±15	30	60	0.1	2.5	1.0	3.0	3.0	10	250	500	750	1500	10	50	25	250	0.1	0.5
808A	±15	25	40	1.0	5.0	2.0		5.0	10	25	50	75	250	3	15	10		0.03	0.15
808B	±15	25	40	1.0	10	2.0		10.0	30	50	50	100	250	5	30	10		0.1	0.3
809B	±15	10	40	5.0	10	7.0		10.0	50	300	500	600	1500	50	100	50	250	1.0	3.0
819B	±6	5	10	5.0	10	7.0		70.0	100	300	500	1000		50	100	50		1.0	3.0
810B(Dual)	±15	10	40	1.0	5.0	3.0		5.0		200	500	500	1.5	30	200			1.0	
811B	±15	10	40	1.0	5.0	3.0		5.0		200	500	600	1.5	30	200			1.0	
841B*	±15	50	200	1.0	5.0	2.0	6.0	3.0		200	500	500	1.5	30	200	75	500	1.0	
2404B**	±15	31	100	3.0	10	5.0		5.0	25	.04	0.1	30	100	.015	0.05	15	50	.27	0.09
2405B**	±30	31	100	3.0	10	5.0		5.0	25	.04	0.1	30	100	.015	0.05	15	50	.27	0.09
2709B**	±15	17	45	3.0	10	6.0		15	33	.04	0.1	30	100	.015	0.05	15	50	.27	
2809B**	±15	10	30	5.0	10	9.0		25	50	.04	0.1	30	100	.015	0.05	15	50	.27	
2741B**	±15	31	50	3.0	5.0	2.0	5.0	11	27	.04	0.1	30	100	.015	0.05	15	50	.27	

INDUSTRIAL GRADE OPERATIONAL AMPLIFIERS

Operating Temperature Range 0°C to 100°C

709C	±15	15	45	2.0	7.5	2.0	10			300	1500	500	2000	100	500	200	750	1.0	
741C	±15	20	100	2.0	6.0		7.5	3.0		200	500	300	800	30	200	100	500	1.0	
747C	±15	20	100	2.0	6.0		7.5	3.0		200	500	300	800	30	200	100	500	1.0	
748C	±15	20	100	2.0	6.0		7.5	3.0		200	500	300	800	30	200	100	500	1.0	
805C	±15	10	60	3.0	10	5.0		5	30	250	1000	750		30	100	50		0.1	2.0
808C	±15	15	40	2.0	10	5.0		4	14	25	75	50	150	5	40	10	100	0.1	0.3
809C	±15	10	40	5.0	10	8.0		10	50	500	1000	1000		50		100		1.0	
841C*	±15	20	100	2.0	6.0		7.5	3.0		200	500	300	800	30	200	100	500	1.0	
810C(Dual)	±15	20	100	2.0	6.0	3.0		5.0		500	1000	1000		50	350	100		1.0	
811C	±15	10	40	1.0	10	3.0		5.0		500	1000	1000		50	350	100		1.0	
2741C**	±15	20	31	5.0	10	2.0	5.0	20	50	0.05	0.2	25		50	25	100	15	25	0.15

Note 1: 5 sec. maximum duration.

Note 2: At operating temperature extreme.

*High slew rate 741.

**Hybrid Circuit.

***Uncompensated 741.

Selection Guide

Z_{IN} KΩ		Z_{IN} (Note 2) KΩ		CMR Volts		CMRR DB		PSRR DB		Z_{OUT} Ω		V_{OUT} (Load) V_{pp}		P_{DISS} No Load mW		Short Circuit Protected	PKG
typ	min	typ	min	typ	min	typ	min	typ	min	typ	max	typ	min	typ	max		
400	350	100	40	±10	± 8	90	80	92	80	150		26 (2 K)	20	80	108	Note 1	E, H, N
400	150	100	40	±10	± 8	90	70	92	70	150		26 (2 K)	20	80	165	Note 1	E, H, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	50	85	Yes	E, H, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	E, H, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	E, H, N
1000	500	500	200	± 9	± 8	90	70	80	70	150	300	24 (1 K)	20	180	225	Yes	E, H
1000	500	750	300	± 9	± 8	90	80	80	70	150	300	24 (1 K)	20	180	225	Yes	E, H
2000	1000	1000		± 9	± 8	90	70	80	70	150	300	24 (1 K)	20	180	225	Yes	E, H
2000	1000	750		± 9	± 8	90	70	80	70	150	300	24 (1 K)	20	180	225	Yes	E, H
200	100	50		±13	±10	90	70	90	70	2500		24 (5 K)	20	100	150	Yes	E, H, N
200	50	20		± 5	± 4	90	70	90	60	1500		10 (5 K)	8	15	25	Yes	E, H, N
250	100	100		±13	±12	90	70	90	70	1500		24 (5 K)	20	160		Yes	H, N
250	100	100		±13	±12	90	70	90	70	1500		24 (5 K)	20	80		Yes	E, H, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	N
10^8	10^7	10^6		±10	± 8	90	74	90	74	600		22 (10 K)	20	40	55	Yes	G
10^8	10^7	10^5		±25	±16	90	74	90	74	600		50 (10 K)	40	80	110	Yes	G
10^8	10^7	10^6		±10	± 8	80	60	80	60	150		26 (2 K)	20	90	180	Note 1	G
10^8	10^7	10^6		±13	±10	80	60	80	60	2000		24 (5 K)	20	100	180	Yes	G
10^8	10^7	10^6		±13	±10	70	60	80	60	150		26 (2 K)	20	50	90	Yes	F, K

250	50	100	35	±10	± 8	90	65	92	74	150		26 (2 K)	20	80	200	Note 1	E, H, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	50		Yes	E, H, J
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	E, H, J, N
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	E, H, J, N
1000	100	500		± 9	± 8	90	70	80		150	300	24 (1 K)	20	180	225	Yes	E, H
750	2000	750		± 9	± 8	90	70	80	70	150	300	24 (1 K)	20	180	225	Yes	E, H
200	50	100		±13	±10	90	70	90	70	2000		24 (5 K)	20	80		Yes	E, J
1000	300	150		±13	±12	90	70	90	70	150		26 (2 K)	20	60	100	Yes	J, N
200	50	100		±13	±12	90	70	90	70	1500		24 (5 K)	20	160		Yes	H, J
200	50	100		±13	±12	90	70	90	70	1500		24 (5 K)	20	80		Yes	E, H, J
10^7	10^6	10^5		±13	±10	70	60	80	60	150		26 (2 K)	20	60	100	Yes	F, K

OTHER LINEAR CIRCUITS

DIFFERENTIAL AMPLIFIERS

Part No.	Description	Voltage Gain	Input Offset mV	CMRR db	Z_{in} kΩ	Drift μV/°C	BW −3 db kHz	Dissipation mW	Power Supply
739	Dual Preamplifier	20,000	1	80	150	10	20	180	±15 V
749	Dual Preamplifier	20,000	1	80	150	10	20	180	±15 V
831	Two Stage Differential Amplifier	2000	2.5	−100	40	2.0	400	100	±12 V
813	High Speed Version of 749								

Available in A, B and C Grades, E and H packages.

HIGH FREQUENCY AMPLIFIERS

Part No.	Circuit Description	Voltage Gain db	Band-Width MHz	Power Gain db at 200 MHz	Dissipation mW	Power Supply Voltage
901	Video Amplifier	24	60		144	+12
903	VHF Amplifier	15	110		96	+12 − 6
911	IF Amplifier	20	250	25	170	+24

The 901 and 903 are available in B and C Grade and E Package.

The 911 is available in B and C Grade, E and J Package.

DEFINITION OF TERMS

V_{OS} = Input Offset Voltage—That voltage which must be applied between the input terminals to obtain zero output voltage. The input offset voltage may also be defined for the case where two equal resistances are inserted in series with the input leads.

I_{OS} = Input Offset Current—The difference in the currents into the two input terminals with the output at zero volts.

Z_{in} = Input Resistance — The resistance looking into either input terminal with the other grounded.

I_{BIAS} = Input Bias Current—The average of the two input currents.

CMR = Common Mode Range—The range of voltage which, if exceeded on either input terminal, could cause the amplifier to cease functioning properly.

CMRR = Common Mode Rejection Ratio—The ratio of the input voltage range to the maximum change in input offset voltage over this range.

PSRR = Power Supply Rejection Ratio—The ratio of the change in input offset voltage to the change in supply voltage producing it.

A_{Vol} = Large-Signal Voltage Gain—The ratio of the maximum output voltage swing with load to the change in input voltage required to drive the output from zero to this voltage.

V_{out} = Output Voltage Swing — The peak output swing, referred to zero, that can be obtained without clipping.

Z_{out} = Output Resistance—The resistance seen looking into the output terminal with the output at null. This parameter is defined only under small signal conditions at frequencies above a few hundred cycles to eliminate the influence of drift and thermal feedback.

D_{iss} = Power Consumption — The DC power required to operate the amplifier with the output at zero and with no load current.

HIGH NOISE IMMUNITY LOGIC (HNIL)

SERIES 300

PART NO.	CIRCUIT DESCRIPTION	Noise Immunity Volts	FanOut	t_{pd} nsec	V_{CC} Volts	P_{Diss} mW
301	Dual 5 Input Buffer with Expanders—Active Pull-Up	5.0	36	80	12	300
302	Quad 2 Input Buffer with Open Collector "OR" able Output	5.0	36	80	12	300
303	Quad 2 Input "OR" able Buffer-Resistor Pull-Up	5.0	36	80	12	300
311	Master Slave Flip-Flop	5.0	5	120	12	180
312	Dual J-K Flip-Flop	5.0	5	120	12	280
321	Quad 2 Input Gate with Expanders	5.0	5	80	12	96
322	Dual 5 Input Gate with Expanders	5.0	5	80	12	48
323	Quad 2 Input "OR" able Gate with Expanders	5.0	5	100	12	80
324	Quad 2 Input Gate with Expanders—Resistor Pull-Up	5.0	5	80	12	96
325	Dual 2 - Dual 3 Input Gate—Resistor Pull-Up	5.0	5	80	12	96
326	Dual 2 - Dual 3 Input Gate—Resistor Pull-Up	5.0	5	80	12	96
331	Dual 5 Input Expander with Node Resistors	5.0		40	12	
341	Dual Exclusive-OR with Expanders	5.0	5	75	12	72
342	Dual One-Shot with Expandable Trigger	5.0	5	100	12	100
370	Quad "D" Flip-Flop	5.0	5	100	12	190
371	Decade Counter	5.0	5	150	12	280
372	4 Bit Binary	5.0	5	150	12	280
380	BCD to Decade Counter	5.0	5	200	12	200

Available in B and C grade in 16 lead dual-in ceramic package and in C grade dual-in line plastic package. Available in 15 Volt logic.

Available in B and C Grade in G, H and N Packages.

INTERFACE CIRCUITS

PART NO.	CIRCUIT DESCRIPTION	Noise Immunity Volts	Input Range Volts	Output Drive mA	Output Sink mA	t_{pd} nsec	P_{Diss} mW
361	Dual Input Interface Circuit with inverting and non-inverting inputs	5(1)	15	5	10	50	60
362	Dual Output Interface Circuit—Current sink and current drive inputs and inverting non-inverting options	5(1)	15	3	10	40	75

The 361 buffer and 362 receiver are compatible with all low level logic forms. They perform the level shifting function necessary for operation with 300 series logic or high level I/O equipment.

(1) Noise immunity with a 362 driving a 361.

Available in B and C Grade in G and H Package.

Available in C Grade in J Package.

TTL 500 SERIES

Operating Temperature −55°C to +125°C

Operating Voltage 4.0 to 5.5 Volts

	Low Power				Medium Power				High Power			
PRODUCT DESCRIPTION	P/N	t_{pd} nsec	FAN OUT	PD mW/gate	P/N	t_{pd} nsec	FAN OUT	PD mW/gate	P/N	t_{pd} nsec	FAN OUT	PD mW/gate
Dual 4 Input Gate▲	500	180	6	0.5	530	75	6	1.5	570	25	7	4.1
Quad 2 Input Gate▲	501	180	6	0.5	531	75	6	1.5	571	25	7	4.1
Triple 3 Input Gate▲	503	180	6	0.5	533	75	6	1.5	573	25	7	4.1
Dual 4 Input Gate■	504	140	6	0.7	534	60	6	2.0	574	25	7	5.0
Quad 2 Input Gate■	505	140	6	0.7	535	60	6	2.0	575	25	7	5.0
Triple 3 Input Gate■	507	140	6	0.7	537	60	6	2.0	577	25	7	5.0
Dual 4 NAND/NOR Gate†	508	200	6	1.4	538	100	6	3.8	578	35	7	8.9
JK Flip Flop	509	550	8	4.0	539	140	8	12.0	579	65	13	24.0
Dual 4 Input Buffer*▲					540	70	17	6.0				
Dual 4 Input Buffer*■					541	70	17	4.5				
Dual 4 Input Gate*▲					543	85	6	1.5	583	30	7	4.1
Dual 4 Input Power Gate*■					544	75	6	2.0	584	30	7	5.0
Dual 4 Input Pwr Gate & Lamp Dr.▲					547	60	45	7.5				
Dual 4 Input Pwr Gate & Lamp Dr.■					548	60	45	6.2				
Dual 4 Input Buffer*									580	45	33	17.0
Dual 4 Input Gate*									587	55	36	13.0

Ultra Low Power Logic

Operating Temperature −55°C to +125°C Voltage 4.5 to 5.5 Volts

When power consumption is the prime consideration the following Ultra Low Power TTL should be utilized.

Quad 2 Input Gate	525BH	2.0 μsec	8	250 μW
Dual 4 Input Gate*	526BH	1.5 μsec	8	250 μW
Dual 3 Input Gate*	527BH	1.5 μsec	8	250 μW
Dual 3 Input Gate	528BH	1.5 μsec	8	250 μW
JK Flip Flop	529BH	2.5 μsec	8	1.0 mW

▲No Pull Up Resistor

■With Pull Up Resistor

†With Inverter

*With Expander

Low Power Logic

Operating Temperature −55°C to +125°C Voltage 4.5 to 5.5 Volts

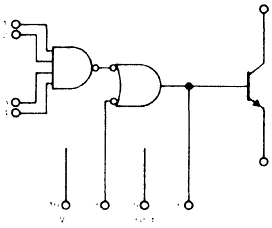
JK Flip Flop	6040BH (9040)	135 nsec	10	3.5 mW
Dual 3 Input Gate	6041BH (9041)	65 nsec	10	1.4 mW
Dual 3 Input Buffer with Expanders	6042BH (9042)	65 nsec	10	1.4 mW
Dual 4 Input Gate	6044BH (9044)	65 nsec	10	1.4 mW
Quad 2 Input Gate	6046BH (9046)	65 nsec	10	1.4 mW
Triple 3 Input Gate	6047BH (9047)	65 nsec	10	1.4 mW

HIGH VOLTAGE/CURRENT DRIVER

This circuit has been designed for use in latching relay, lamp, core, and line driver applications.

2001BE

$V_{OL} < 350$ mV
$I_L > 250$ mA
$LV_{CEO} > 40$ V
$V_{CC} = +5$ V
−55°C to +125°C
TO-5 (10 Leads)

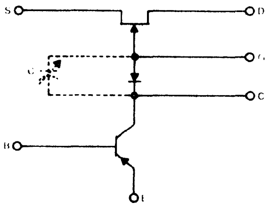


FET ANALOG SWITCHES

These circuits have been designed for use in multiplexing, sample and hold, and chopper applications.

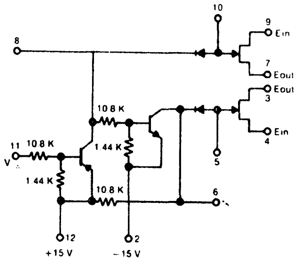
2107BE
2110BE

$R_{ON} < 50\Omega$ (2110)
$R_{ON} < 100\Omega$ (2107)
$I_{D(off)} < 1.0$ nA
$LV_{CEO} > 40$ V
−55°C to +125°C
TO-5 (6 Leads)



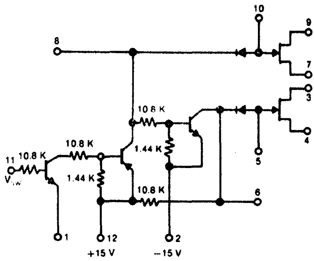
2114BF

$R_{ON} < 100\Omega$
$I_{D(off)} < 1.0$ nA
t_{on} and $t_{off} < 0.9$ μSec
$E_{out} = \pm 9$ V
−55°C to +125°C
TO-8 (12 Leads)



2126BG

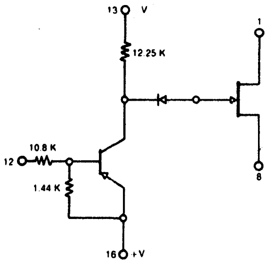
$R_{ON} < 65\Omega$
$I_{D(off)} < 1.0$ nA
t_{ON} and $t_{OFF} < 1.5$ μSec
$E_{out} = \pm 8$ V
−55°C to +125°C
TO-8 (12 Leads)

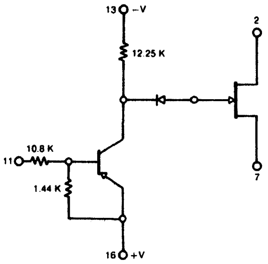


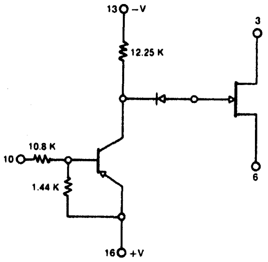
FET ANALOG SWITCHES (cont.)

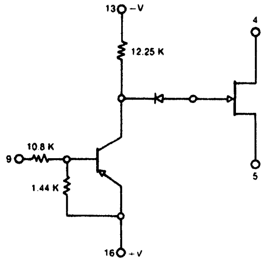
2128BG

$R_{ON} < 50\Omega$
$I_{D(off)} < 1.0$ nA
t_{ON} and $t_{OFF} < 1.0\ \mu$Sec
$E_{out} = \pm 5$ V
−55°C to +125°C
TO-8 (16 Leads)







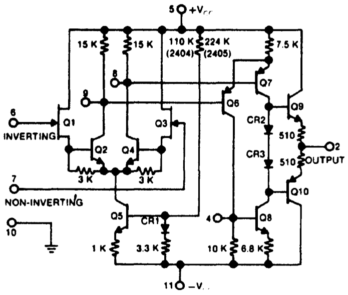


FET INPUT OPERATIONAL AMPLIFIERS

These circuits have been designed for use in active filter and high input impedance, low power, and high voltage applications.

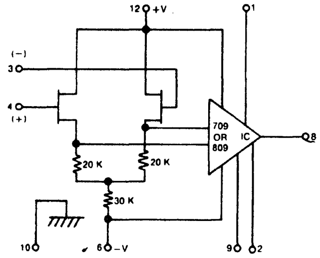
2404BG
2405BG

Power < 55 mW (2404)
Power < 110 mW (2405)
$V_{CC} = \pm 15$ V (2404)
$V_{CC} = \pm 30$ V (2405)
$E_{out} > \pm 10$ V (2404)
$E_{out} > \pm 20$ V (2405)
$I_{OFF} < 100$ pA
$Z_{IN} > 10^{10}\,\Omega$
−55°C to +125°C
TO-8 (12 Leads)



2709BG
2809BG

$V_{CC} = \pm 15$ V
$Z_{IN} > 10$ KMΩ
$I_{OFF} < 100$ pA
$E_{out} > \pm 10$ V
CMR > ±8 V
−55°C to +125°C
TO-8 (12 Leads)

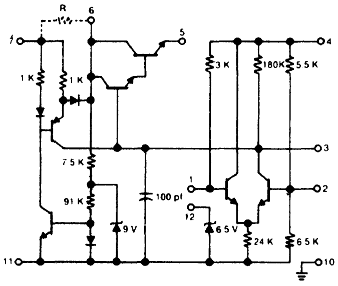


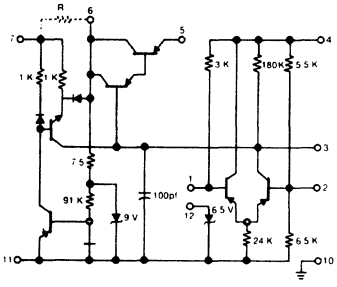
VOLTAGE REGULATORS

These circuits have been designed for use in power supply systems where a high degree of load and line regulation is required.

2802BG
2803BG

Output Range = 5 V to 40 V
Load Current > 100 mA
Load Regulation < 0.1%
Line Regulation < 0.01%/V
Temperature Stability < 0.5%
Ripple Rejection > −60 db
Output Impedance < 1.0Ω
−55°C to +125°C
TO-8 (12 Leads)





NPN TRANSISTOR
GENERAL PURPOSE

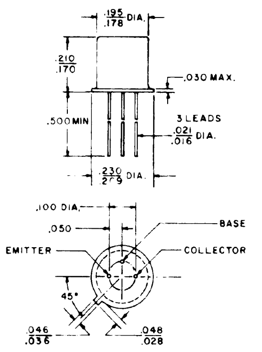
- HIGH CURRENT GAIN
- HIGH BREAKDOWN VOLTAGE
- LOW SATURATION VOLTAGE

JANUARY 1968

2N760
2N760A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}		
2N760		45	Volts
2N760A		60	
Collector-Emitter Voltage	V_{CEO}		
2N760		45	Volts
2N760A		60	
Emitter-Base Voltage	V_{EBO}	8.0	Volts
Total Device Dissipation	P_D		
@ $T_A = 25°C$		0.5	Watts
@ $T_C = 25°C$		1.5	
@ $T_C = 100°C$		0.86	
Derating Factor above 25°C			
@ $T_A = 25°C$		2.5	mW/°C
@ $T_C = 25°C$		8.5	



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}				
2N760		$I_C = 50\ \mu A, I_E = 0$	45		Volts
2N760A			60		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 100\ \mu A$	8.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*				
2N760		$I_C = 1.0$ mA, $I_B = 0$	45		Volts
2N760A			60		
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA	0.6	1.1	Volts
Collector-Base Cutoff Current	I_{CBO}				
2N760		$I_E = 0, V_{CB} = 30$ V		200	nA
2N760A				100	
2N760, 760A		$I_E = 0, V_{CB} = 30$ V, $T_A = 150°C$		10	μA
Small Signal Current Gain	h_{fe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1.0 kHz	76	333	
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = 5.0$ V f = 140 kHz		8.0	pf
Voltage Feedback Ratio	h_{rb}	$I_C = 1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz		10	X 10^{-4}
Alpha Cutoff Frequency	$f_{\alpha b}$	$I_E = 1.0$ mA, $V_{CB} = 5.0$ V	50		MHz

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

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NPN TRANSISTOR
GENERAL PURPOSE

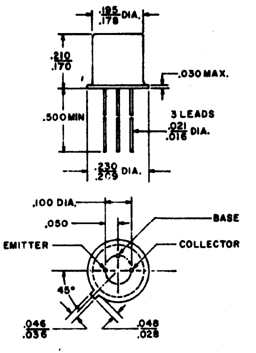
- **HIGH CURRENT GAIN**
- **HIGH BREAKDOWN VOLTAGE**
- **LOW NOISE**

JANUARY 1968

2N929, A
2N930, A, B

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}		Volts
2N929, 2N930		45	
2N929A, 2N930A, B		60	
Collector-Emitter Voltage	V_{CEO}	45	Volts
Emitter-Base Voltage	V_{EBO}		Volts
2N929, 2N930		5.0	
2N929A, 2N930A, B		6.0	
Collector Current	I_C	30	mA
Total Device Dissipation	P_D		Watt
@ $T_A = 25°C$		0.3	
@ $T_C = 25°C$		0.6	
Derating Factor above 25°C			mW/°C
@ $T_A = 25°C$		2.0	
@ $T_C = 25°C$		4.0	



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Emitter Breakdown Voltage	BV_{CEO}*	$I_C = 10$ mA, $I_B = 0$	45		Volts
Collector-Base Breakdown Voltage	BV_{CBO}				
2N929A, 2N930A, B		$I_C = 10\ \mu A$, $I_E = 0$	60		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 10$ mA, $I_B = 0$	45		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}				
2N929, 2N930		$I_E = 10\ \mu A$, $I_C = 0$	5.0		Volts
2N929A, 2N930A, B			6.0		
Base-Emitter Voltage	V_{BE}*				
2N929, 2N930		$I_C = 10$ mA, $I_B = 0.5$ mA	0.6	1.0	Volts
2N929A, 2N930A, B			0.7	0.9	
Collector Saturation Voltage	$V_{CE(sat)}$				
2N929, 2N930		$I_C = 10$ mA, $I_B = 0.5$ mA		1.0	Volts
2N929A, 2N930A, B				0.5	
Collector-Base Cutoff Current	I_{CBO}				
2N929, 2N930		$V_{CB} = 45$ V, $I_E = 0$		10	nA
2N929A, 2N930A, B				2.0	
Collector-Emitter Cutoff Current	I_{CES}				
2N929, 2N930		$V_{CE} = 45$ V, $V_{EB} = 0$		10	nA
2N929A, 2N930A, B				2.0	
2N929, 2N930		$V_{CE} = 45$ V, $V_{EB} = 0$, $T_A = 170°C$		10	µA
2N929A, 2N930A, B				2.0	
Emitter-Base Cutoff Current	I_{EBO}				
2N929, 2N930		$V_{EB} = 5$ V, $I_C = 0$		10	nA
2N929A, 2N930A, B				2.0	
DC Pulse Current Gain	h_{FE}*				
2N929A		$V_{CE} = 5$ V, $I_C = 1\ \mu A$	25		
2N930A, B			60		
2N929, A		$V_{CE} = 5$ V, $I_C = 10\ \mu A$	40	120	
2N930, A, B			100	300	
2N929		$V_{CE} = 5$ V, $I_C = 10\ \mu A$ $T_A = -55°C$	10		
2N929A			15		
2N930			20		
2N930A, B			30		
2N929, A		$V_{CE} = 5$ V, $I_C = 500\ \mu A$	60		
2N930, A, B			150		
2N929, A		$V_{CE} = 5$ V, $I_C = 10$ mA		350	
2N930, A, B				600	

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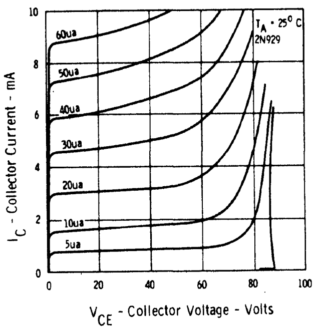
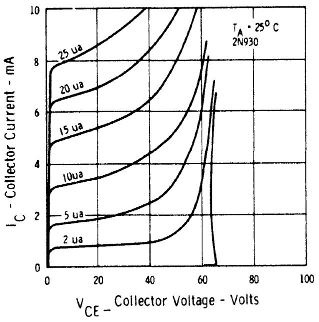
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
High-Frequency Current Gain	$\mid h_{fe} \mid$				
2N929, 2N930		$V_{CE} = 5.0$ V, $I_C = 500$ μA	1.0		
2N929A, 2N930A, B		f = 30 MHz	1.5		
Small-Signal Current Gain	h_{fe}				
2N929, A		$V_{CE} = 5.0$ V, $I_C = 1.0$ mA	60	350	
2N930, A, B		f = 1.0 kHz	150	600	
Output Capacitance	C_{ob}	$V_{CB} = 5.0$ V, $I_E = 0$, f = 1.0 MHz		8.0	pf
Voltage Feedback Ratio	h_{rb}	$V_{CB} = 5.0$ V, $I_E = 1.0$ mA, f = 1.0 kHz		600	$X10^{-6}$
Input Resistance	h_{ib}	$V_{CB} = 5.0$ V, $I_E = 1.0$ mA, f = 1.0 kHz	25	32	Ohms
Output Conductance	h_{ob}	$V_{CB} = 5.0$ V, $I_E = 1.0$ mA, f = 1.0 kHz		1.0	μmhos
Noise Figure	NF				
2N929, A		$V_{CE} = 5.0$ V, $I_C = 10$ μA, Rg = 10 kΩ		4.0	db
2N930, A, B		BW = 10 Hz to 15.7 kHz		3.0	
2N930B		$V_{CE} = 5.0$ V, $I_C = 10$ μA, Rg = 10 kΩ f = 1.0 kHz, BW = 200 Hz		3.0	
2N930B		$V_{CE} = 5.0$ V, $I_C = 10$ μA, Rg = 10 kΩ f = 100 Hz, BW = 20 Hz		5.0	
2N930B		$V_{CE} = 5.0$ V, $I_C = 10$ μA, Rg = 10 kΩ f = 10 Hz, BW = 5.0 Hz		6.0	

*** Pulse Test: Pulse Width ≤ 300 μsec; Duty Cycle ≤ 2%.**

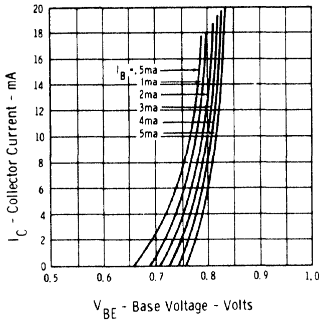
2N929 Collector Characteristics



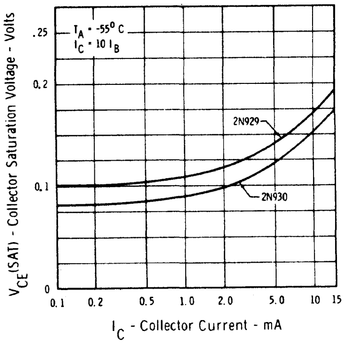
2N930 Collector Characteristics



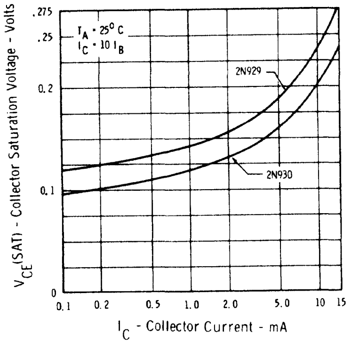
Typical Base Characteristics



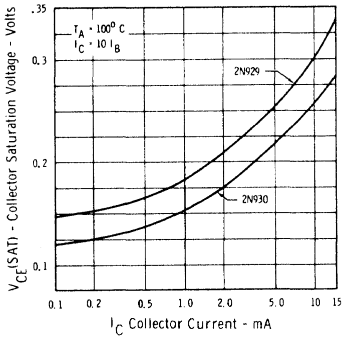
Collector Saturation Voltage
Versus Collector Current



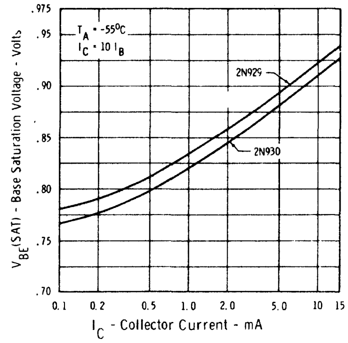
Collector Saturation Voltage
Versus Collector Current



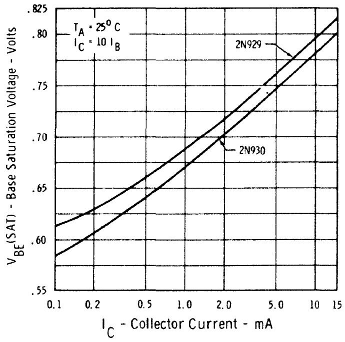
Collector Saturation Voltage
Versus Collector Current



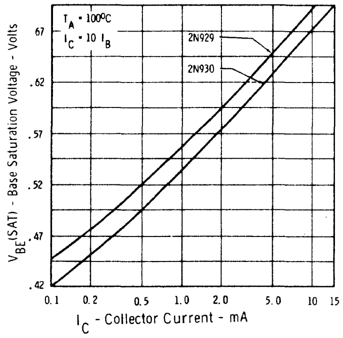
Base Saturation Voltage
vs. Collector Current



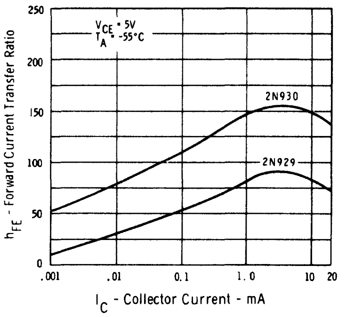
Base Saturation Voltage
vs. Collector Current



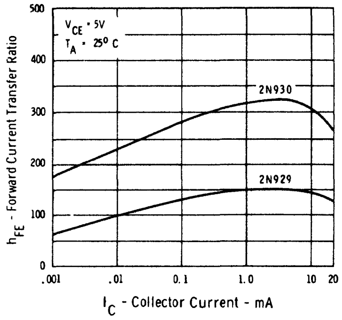
Base Saturation Voltage
vs. Collector Current



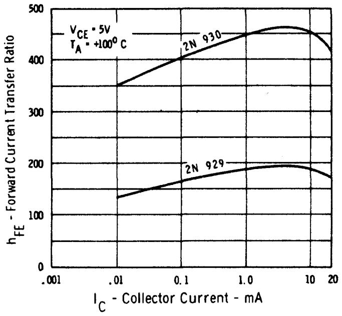
Pulsed DC Current Gain Versus Collector Current



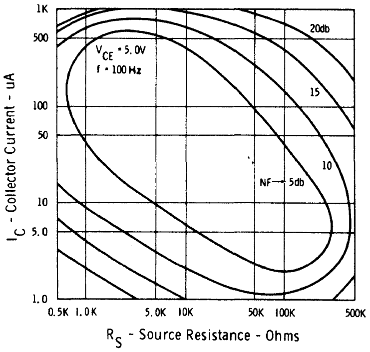
Pulsed DC Current Gain Versus Collector Current



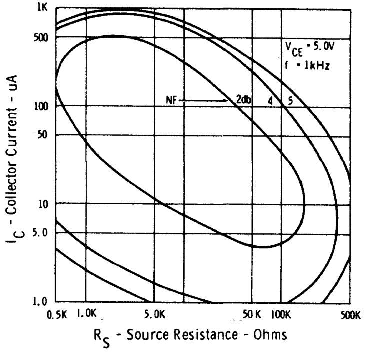
Pulsed DC Current Gain Versus Collector Current



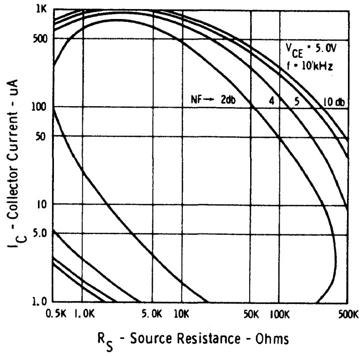
Noise Figure at 100 Hz



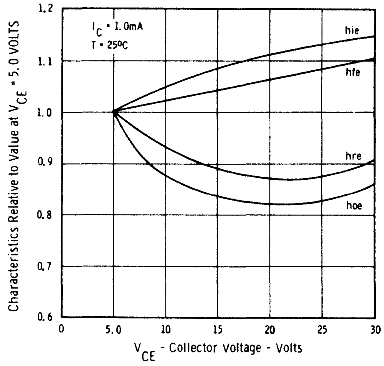
Noise Figure at 1 kHz



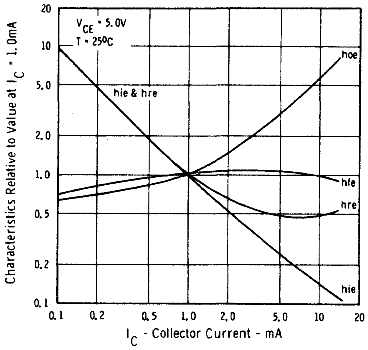
Noise Figure at 10 kHz



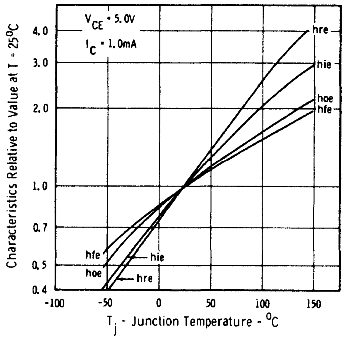
Typical Common Emitter Characteristics



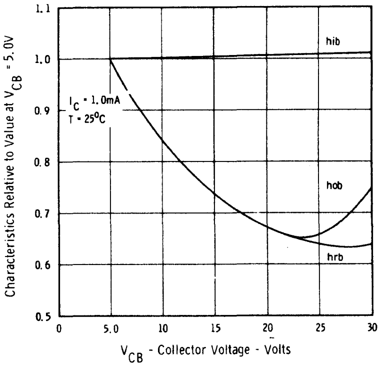
Typical Common Emitter Characteristics



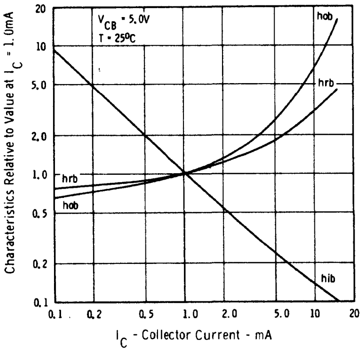
Typical Common Emitter Characteristics



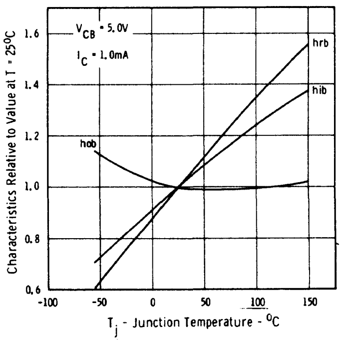
Typical Common Base Characteristics



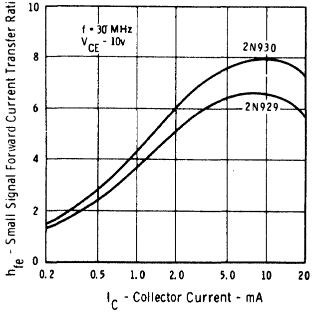
Typical Common Base Characteristics



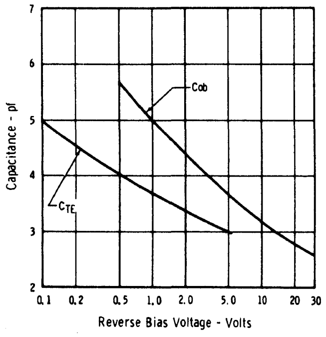
Typical Common Base Characteristics



Small Signal Current Gain at 30 MHz Versus Collector Current



Collector and Emitter Transition Capacitance Versus Reverse Bias Voltage



NPN TRANSISTOR
GENERAL PURPOSE

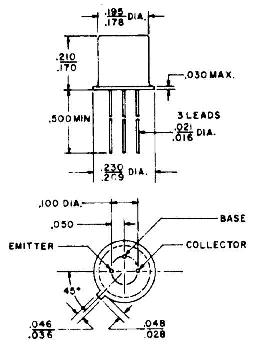
- **LOW NOISE**
- **LOW LEVEL AMPLIFIER**
- **HIGH CURRENT GAIN**

JANUARY 1968

2N2483
2N2484
2N2484A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	60	Volts
Collector-Emitter Voltage	V_{CEO}	60	Volts
Emitter-Base Voltage	V_{EBO}	6	Volts
Collector Current	I_C	50	mA
Total Device Dissipation	P_D		
@ $T_A = 25°C$		0.36	Watts
@ $T_C = 25°C$		1.2	
@ $T_C = 100°C$		0.68	
Derating Factor above 25°C			
@ $T_A = 25°C$		2.1	mW/°C
@ $T_C = 25°C$		6.9	
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	6		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 10\ mA, I_B = 0$	60		Volts
Emitter-Base On Voltage	$V_{BE(on)}$	$I_C = 100\ \mu A, V_{CE} = 5.0\ V$	0.5	0.7	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10\ mA, I_B = 0.5\ mA$		1.0	Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 1.0\ mA, I_B = 0.1\ mA$		0.35	Volts
2N2484A		$I_C = 10\ mA, I_B = 0.5\ mA$		1.0	
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 45\ V, I_E = 0$		0.010	μA
		$V_{CB} = 45\ V, I_E = 0, T_A = 150°C$		10	
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 5.0\ V, I_C = 0$		0.010	μA
DC Current Gain	h_{FE}				
2N2484, 84A		$I_C = 1.0\ \mu A, V_{CE} = 5.0\ V$	30		
2N2483		$I_C = 10\ \mu A, V_{CE} = 5.0\ V$	40	120	
2N2484, 84A			100	500	
2N2483		$I_C = 10\ \mu A, V_{CE} = 5.0\ V, -55°C$	10		
2N2484, 84A			20		
2N2483		$I_C = 100\ \mu A, V_{CE} = 5.0\ V$	75		
2N2484, 84A			175		
2N2483		$I_C = 500\ \mu A, V_{CE} = 5.0\ V$	100		
2N2484, 84A			200		
2N2483		$I_C = 1.0\ mA, V_{CE} = 5.0\ V$	175		
2N2484, 84A			250		
2N2483		$I_C = 10\ mA, V_{CE} = 5.0\ V^*$		500	
2N2484, 84A				800	
High-Frequency Current Gain	$\lvert h_{fe} \rvert$				
2N2483		$I_C = 50\ \mu A, V_{CE} = 5.0\ V, f = 5.0\ MHz$	2.4		
2N2484, 84A			3.0		
All Types		$I_C = 500\ \mu A, V_{CE} = 5.0\ V, f = 30MHz$	2.0		
Small Signal Current Gain	h_{fe}				
2N2483		$I_C = 1.0\ mA, V_{CE} = 5.0\ V, f = 1\ kHz$	80	450	
2N2484, 84A			150	900	
Output Capacitance	C_{ob}	$V_{CB} = 5.0\ V, I_E = 0, f = 140\ kHz$		6.0	pf

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{ib}	$V_{EB} = 0.5$ V, $I_C = 0$, f = 140 kHz		6.0	pf
Voltage Feedback Ratio	h_{re}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V, f = 1 kHz		800	$X10^{-6}$
Input Resistance	h_{ie}				
2N2483		$I_C = 1$ mA, $V_{CE} = 5$ V, f = 1 kHz	1.5	13	K ohms
2N2484, 84A			3.5	24	
Output Conductance	h_{oe}				
2N2483		$I_C = 1$ mA, $V_{CE} = 5$ V, f = 1 kHz		30	μmhos
2N2484, 84A				40	
Noise Figure	NF				
2N2483		$I_C = 10\ \mu$A, $V_{CE} = 5.0$ V, $R_S = 10$ kΩ		4	db
2N2484, 84A		Power Bandwidth of 15.7 kHz		3	
		3 db points at 10 Hz and 10 kHz			
2N2483		$I_C = 10\ \mu$A, $V_{CE} = 5.0$ V, f = 1 kHz		4	
2N2484, 84A		$R_S = 10$ kΩ, Power Bandwidth = 200 Hz		3	
2N2483		$I_C = 10\ \mu$A, $V_{CE} = 5.0$ V, f = 10 kHz		3	
2N2484, 84A		$R_S = 10$ kΩ, Power Bandwidth = 2 kHz		2	
2N2483		$I_C = 10\ \mu$A, $V_{CE} = 5.0$ V, f = 100 Hz		15	
2N2484		$R_S = 10$ kΩ, Power Bandwidth = 20 Hz		10	
2N2484A				5	
2N2484A		$I_C = 10\ \mu$A, $V_{CE} = 5.0$ V, f = 10 Hz		6	
		$R_S = 10$ kΩ, Power Bandwidth = 5 Hz			

* Pulse Test: Pulse Width $\leq 300\ \mu$sec, Duty Cycle $\leq 2\%$

NPN TRANSISTOR
GENERAL PURPOSE

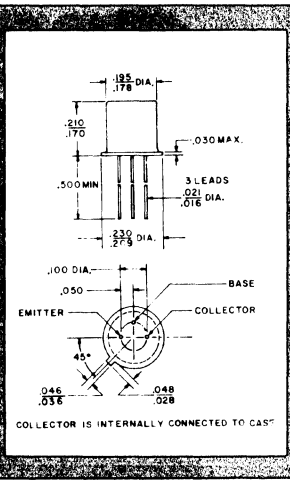
- HIGH BREAKDOWN VOLTAGE
- LOW NOISE
- LOW LEAKAGE

JANUARY 1968

2N2509
2N2510
2N2511

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING			UNIT
		2N2509	2N2510	2N2511	
Collector-Base Voltage	V_{CBO}	125	100	80	Volts
Collector-Emitter Voltage	V_{CEO}	80	65	50	Volts
Emitter-Base Voltage	V_{EBO}	7.0	7.0	7.0	Volts
Total Device Dissipation	P_D				
@ $T_A = 25°C$		0.36			Watts
@ $T_C = 25°C$		1.20			
@ $T_C = 100°C$		0.68			
Derating Factor Above 25°C @ $T_A = 25°C$		2.1			mW/°C
Storage Temperature	T_{stg}	−65 to +300			°C
Junction Temperature	T_J	+200			°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}				
2N2511		$I_C = 10\ \mu A,\ I_E = 0$	80		Volts
2N2510			100		
2N2509			125		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0,\ I_E = 0.1\ \mu A$	7.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*				
2N2511		$I_C = 10\ mA,\ I_B = 0$	50		Volts
2N2510			65		
2N2509			80		
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 5.0\ mA,\ I_B = 0.5\ mA$		1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 5.0\ mA,\ I_B = 0.5\ mA$		0.9	Volts
Collector-Base Cutoff Current	I_{CBO}				
2N2511		$I_E = 0,\ V_{CB} = 100\ V$		5.0	nA
2N2510		$I_E = 0,\ V_{CB} = 80\ V$		5.0	
2N2509		$I_E = 0,\ V_{CB} = 60\ V$		5.0	
2N2511		$I_E = 0,\ V_{CB} = 100\ V,\ T_A = 150°C$		10	μA
2N2510		$I_E = 0,\ V_{CB} = 80\ V,\ T_A = 150°C$		10	
2N2509		$I_E = 0,\ V_{CB} = 60\ V,\ T_A = 150°C$		10	
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0,\ V_{EB} = 5.0\ V$		2.0	nA
DC Current Gain	h_{FE}				
2N2511		$I_C = 1.0\ \mu A,\ V_{CE} = 5.0\ V$	80		
2N2511		$I_C = 10\ \mu A,\ V_{CE} = 5.0\ V$	120		
2N2510			75		
2N2509			40		
2N2511		$I_C = 10\ \mu A,\ V_{CE} = 5.0\ V$ $T_A = -55°C$	40		
2N2510			25		
2N2511		$I_C = 10\ mA,\ V_{CE} = 5.0\ V$	240	750	
2N2510			150	500	
2N2509			40		
2N2511		$I_C = 10\ mA,\ V_{CE} = 5.0\ V$ $T_A = -55°C$	100		
2N2510			60		
2N2509			20		

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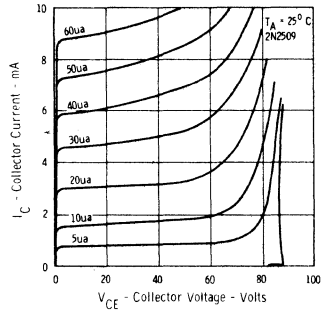
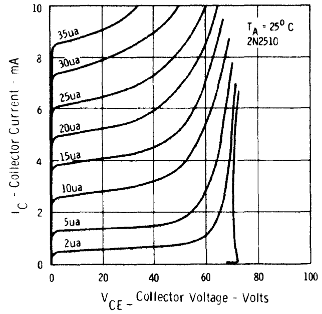
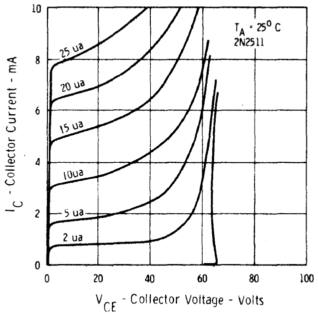
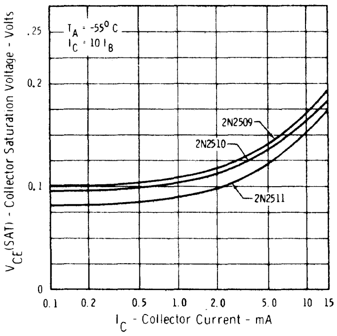
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 5.0$ mA, $V_{CE} = 10$ V f = 30 MHz	1.5		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0$ V f = 140 kHz		6.0	pf
Input Capacitance	C_{ib}	$I_C = 0$, $V_{BE} = 0.5$ V f = 140 kHz		10	pf
Noise Figure	NF	f = 1.0 kHz			
2N2511		Source resistance = 10 KΩ		4.0	db
2N2510		Equivalent noise power		4.0	
2N2509		bandwidth = 200 Hz			
		$I_C = 10$ μA, $V_{CE} = 5.0$ V		7.0	

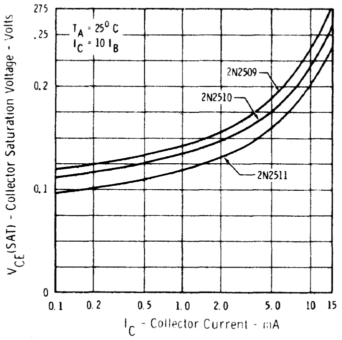
* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

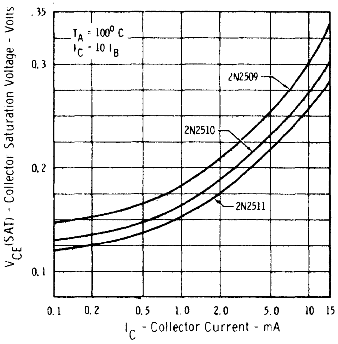

2N2509 Collector Characteristics

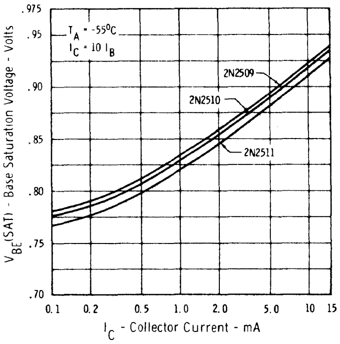

2N2510 Collector Characteristics

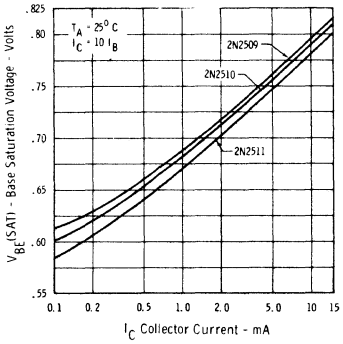

2N2511 Collector Characteristics

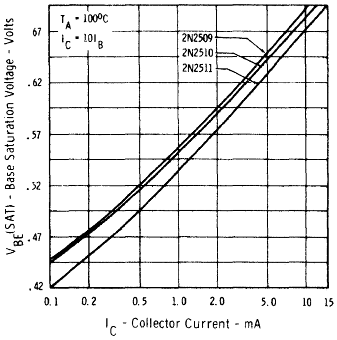

Collector Saturation Voltage
Versus Collector Current


Collector Saturation Voltage
Versus Collector Current

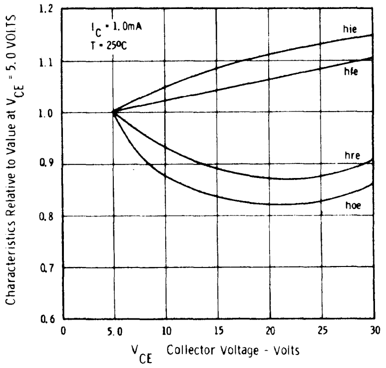

Collector Saturation Voltage
Versus Collector Current


Base Saturation Voltage
vs. Collector Current

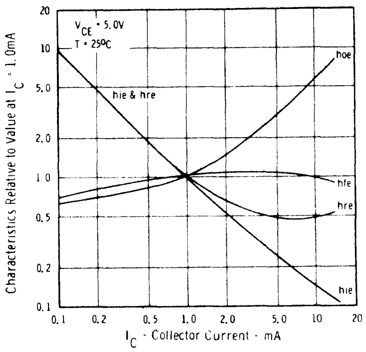

Base Saturation Voltage
vs. Collector Current


Base Saturation Voltage
vs. Collector Current

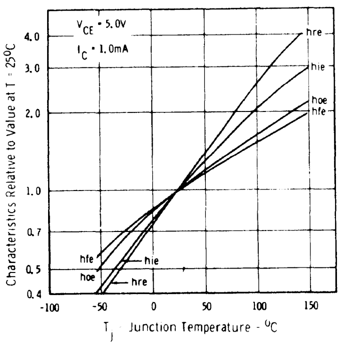
Typical Common Emitter Characteristics



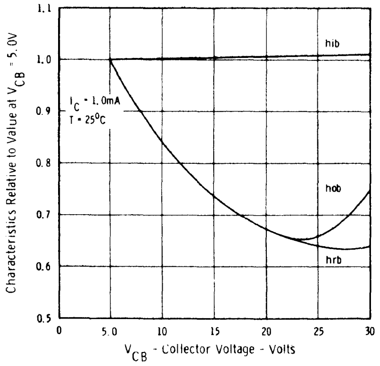
Typical Common Emitter Characteristics



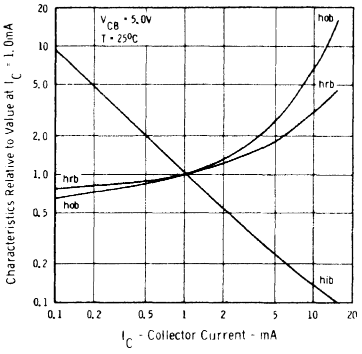
Typical Common Emitter Characteristics



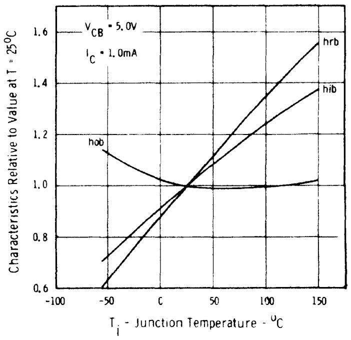
Typical Common Base Characteristics



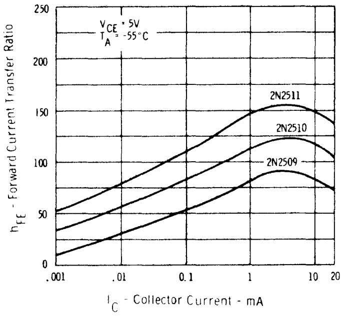
Typical Common Base Characteristics



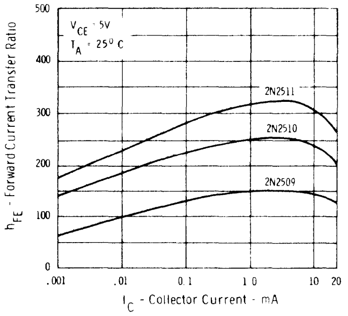
Typical Common Base Characteristics



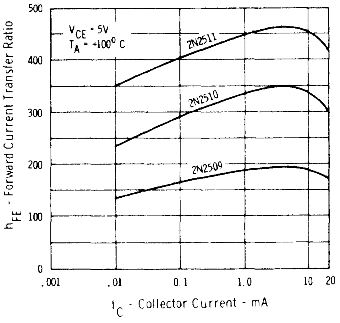
Pulsed DC Current Gain Versus Collector Current



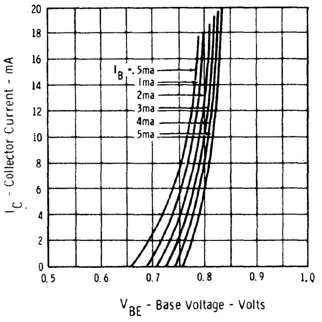
Pulsed DC Current Gain Versus Collector Current



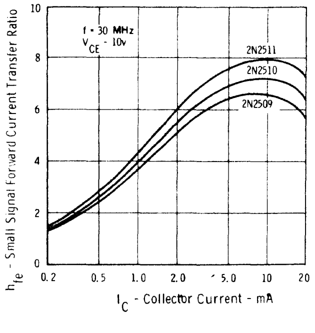
Pulsed DC Current Gain Versus Collector Current

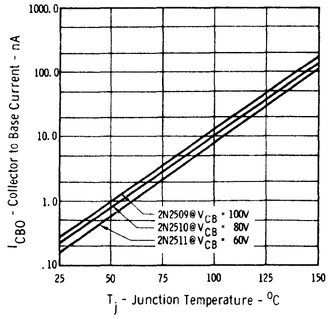


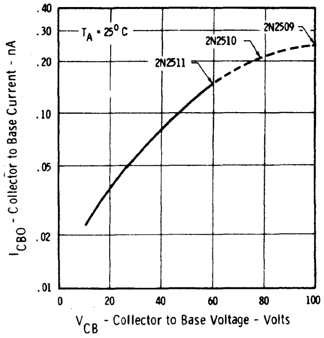
Typical Base Characteristics

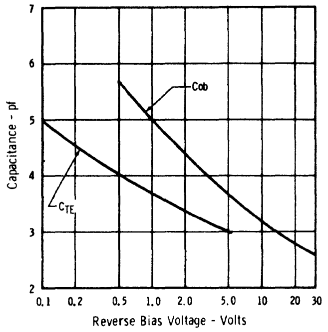


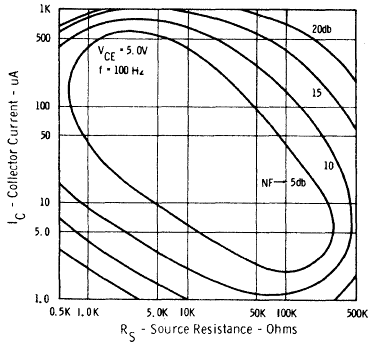
Small Signal Current Gain at 30 MHz Versus Collector Current

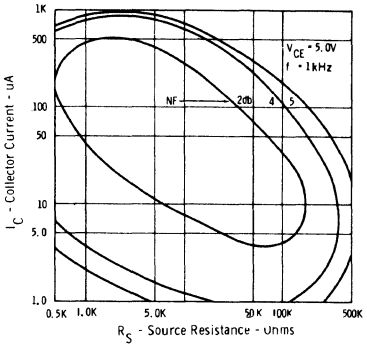


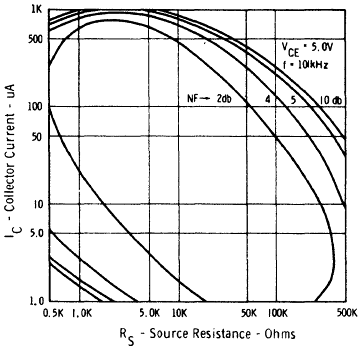

Collector - Base Diode Reverse Current versus Temperature


Collector - Base Diode Reverse Current Versus Voltage


Collector and Emitter Transition Capacitance Versus Reverse Bias Voltage


Noise Figure at 100 Hz


Noise Figure at 10 kHz


Noise Figure at 1 kHz

NPN TRANSISTOR
GENERAL PURPOSE

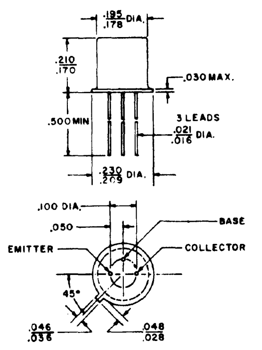
- LOW LEAKAGE
- HIGH CURRENT GAIN
- LOW NOISE

JANUARY 1968

2N2586

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	60	Volts
Collector-Emitter Voltage	V_{CEO}	45	Volts
Emitter-Base Voltage	V_{EBO}	6.0	Volts
Collector Current	I_C	30	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 0.3 0.6	Watts
Storage Temperature	T_{stg}	−65 to +300	°C
Junction Temperature	T_J	+175	°C
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.0 4.0	mW/°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$	60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	6.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 10$ mA, $I_B = 0$	45		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA		0.5	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA	0.7	0.9	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 45$ V		2.0	nA
Collector-Emitter Cutoff Current	I_{CEO}	$I_B = 0$, $V_{CE} = 5.0$ V		2.0	nA
Collector-Emitter Cutoff Current	I_{CES}	$V_{BE} = 0$, $V_{CE} = 45$ V		2.0	nA
		$V_{BE} = 0$, $V_{CE} = 45$ V, $T_A = 170°C$		10	μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 5.0$ V		2.0	nA
DC Current Gain	h_{FE}	$I_C = 1.0\ \mu A$, $V_{CE} = 5.0$ V	80		
		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V	120	360	
		$I_C = 500\ \mu A$, $V_{CE} = 5.0$ V	150		
		$I_C = 10$ mA, $V_{CE} = 5.0$ V		600	
		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$	40		
Small Signal Current Gain	h_{fe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz	150	600	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 0.5$ mA, $V_{CE} = 5.0$ V f = 30 MHz	1.5		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0$ V, f = 1 MHz		7.0	pf
Input Resistance	h_{ie}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz	4.5	18	KΩ
Output Conductance	h_{oe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz		100	μmhos
Low Frequency Noise Figure	NF	f = 1 kHz Source resistance = 10 kΩ $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		3.0	db
		f = 1 kHz Source resistance = 1 MΩ $I_C = 1.0\ \mu A$, $V_{CE} = 5.0$ V		3.5	
		f = 10 kHz Source resistance = 10 kΩ $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		2.0	
		f = 10 kHz Source resistance = 1 MΩ $I_C = 1.0\ \mu A$, $V_{CE} = 5.0$ V		2.0	

* Pulse width = 300 μsec; duty cycle = 1%.

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NPN TRANSISTOR
GENERAL PURPOSE

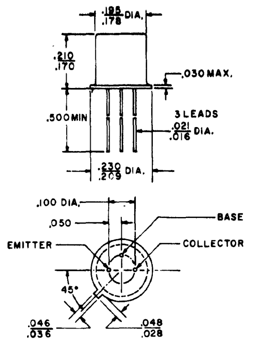
- **HIGH CURRENT GAIN**
- **LOW NOISE**
- **HIGH BREAKDOWN VOLTAGE**

JANUARY 1968

2N3117

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	60	Volts
Collector-Emitter Voltage	V_{CEO}	60	Volts
Emitter-Base Voltage	V_{EBO}	6.0	Volts
Collector Current	I_C	50	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.36 1.2 0.68	 Watts
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.06 6.85	 mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$	60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	6.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 10$ mA, $I_B = 0$	60		Volts
Nonsaturated Base Voltage	$V_{BE(on)}$	$I_C = 0.1$ mA, $V_{CE} = 5.0$ V		0.7	Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 1.0$ mA, $I_B = 0.1$ mA		0.35	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 45$ V $I_E = 0$, $V_{CB} = 45$ V $T_A = 150°C$		10 10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 5.0$ V		10	nA
DC Current Gain	h_{FE}	$I_C = 1.0\ \mu A$, $V_{CE} = 5.0$ V $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$	100 250 300 400 50	 500	
Small Signal Current Gain	h_{fe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1.0 kHz	400	900	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 0.5$ mA, $V_{CE} = 5.0$ V f = 30 MHz	2.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0$ V f = 140 kHz		4.5	pf
Input Capacitance	C_{ib}	$I_C = 0$, $V_{BE} = 5.0$ V f = 140 kHz		6.0	pf
Reverse Voltage Feedback Ratio	h_{re}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1.0 kHz		8.0	$X\ 10^{-4}$
Input Resistance	h_{ie}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1.0 kHz	10	24	K ohms
Output Conductance	h_{oe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1.0 kHz		40	μmhos
Noise Figure	NF	f = 100 Hz Source resistance = 10 kΩ Equivalent noise power bandwidth = 20 Hz $I_C = 30\ \mu A$, $V_{CE} = 5.0$ V		4.0	db

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Noise Figure	NF	f = 1 kHz Source resistance = 50 kΩ Equivalent noise power bandwidth = 200 cps I_C = 5.0 μA, V_{CE} = 5.0 V		1.0	db
		f = 10 kHz Source resistance = 50 kΩ Equivalent noise power bandwidth = 1000 Hz I_C = 5.0 μA, V_{CE} = 5.0 V		1.0	
		f = 10 Hz Source resistance = 10 kΩ Equivalent noise power bandwidth = 2.0 Hz I_C = 30 μA, V_{CE} = 5.0 V		15	

* Pulse Width = 300 μsec; duty Cycle = 1%.

NPN TRANSISTOR
MEDIUM POWER

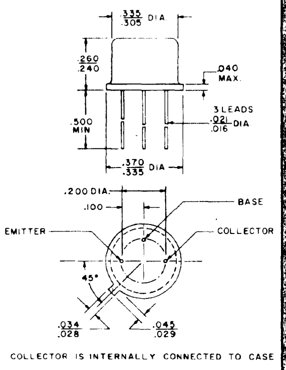
- HIGH CURRENT
- LOW SATURATION VOLTAGE
- HIGH CURRENT GAIN

JANUARY 1968

2N2192, A, B
2N2193, A, B
2N2194, A, B
2N2195, A, B

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	2N2192 2N2192A 2N2192B 2N2194 2N2194A 2N2194B	2N2193 2N2193A 2N2193B	2N2195 2N2195A 2N2195B	UNIT
Collector-Base Voltage	V_{CBO}	60	80	45	Volts
Collector-Emitter Voltage	V_{CEO}	40	50	25	Volts
Emitter-Base Voltage	V_{EBO}	5	8	5	Volts
Collector Current	I_C	1.0	1.0	1.0	Amp
Total Device Dissipation	P_D				
@ $T_A = 25°C$		0.8	0.8	0.6	Watt
@ $T_C = 25°C$		2.8	2.8	2.8	
@ $T_C = 100°C$		1.6	1.6	1.6	
Derating Factor Above 25°C					
@ $T_A = 25°C$		4.56	4.56	3.43	mW/°C
@ $T_C = 25°C$		16	16	16	
Storage Temperature	T_{stg}		−65 to +200		°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 100\ \mu A$, $I_E = 0$			
2N2192, A, B, 2N2194, A, B			60		Volts
2N2193, A, B			80		
2N2195, A, B			45		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 100\ \mu A$, $I_C = 0$			
2N2192, A, B, 2N2194, A, B			5		Volts
2N2193, A, B			8		
2N2195, A, B			5		
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 25$ mA (pulsed), $I_B = 0$			
2N2192, A, B, 2N2194, A, B			40		Volts
2N2193, A, B			50		
2N2195, A, B			25		
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 150$ mA, $I_B = 15$ mA			
2N2192 thru 2N2195				0.35	Volts
2N2192A thru 2N2195A				0.25	
2N2192B thru 2N2195B				0.18	
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 150$ mA, $I_B = 15$ mA		1.3	Volts
Collector-Base Cutoff Current	I_{CBO}				
2N2192, A, B, 2N2194, A, B		$V_{CB} = 30$ V, $I_E = 0$		.010	μA
2N2195, A, B				.100	
2N2192, A, B,		$V_{CB} = 30$ V, $I_E = 0$, $T_A = 150°C$		15	
2N2194, A, B				25	
2N2195, A, B				50	
2N2193, A, B		$V_{CB} = 60$ V, $I_E = 0$		.010	
2N2193, A, B		$V_{CB} = 60$ V, $I_E = 0$, $T_A = 150°C$		25	
Emitter-Base Cutoff Current	I_{EBO}				
2N2192, A, B, 2N2194, A, B		$V_{EB} = 3$ V, $I_C = 0$		.050	μA
2N2195, A, B				.100	
2N2193, A, B		$V_{EB} = 5$ V, $I_C = 0$		.050	

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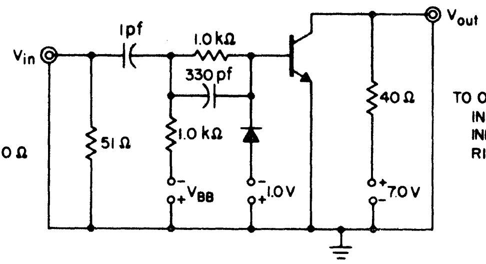
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
DC Pulse Current Gain	h_{FE}*				
2N2192, A, B, 2N2193, A, B		$I_C = 0.1$ mA, $V_{CE} = 10$ V	15		
2N2192, A, B,		$I_C = 10$ mA, $V_{CE} = 10$ V	75		
2N2193, A, B			30		
2N2194, A, B			15		
2N2192, A, B,		$I_C = 10$ mA, $V_{CE} = 10$ V, $T_A = -55°C$	35		
2N2193, A, B			20		
2N2192, A, B,		$I_C = 150$ mA, $V_{CE} = 10$ V	100	300	
2N2193, A, B			40	120	
2N2194, A, B			20	60	
2N2195, A, B			20		
2N2192, A, B,		$I_C = 150$ mA, $V_{CE} = 1.0$ V	70		
2N2193, A, B			30		
2N2194, A, B			15		
2N2195, A, B			10		
2N2192, A, B,		$I_C = 500$ mA, $V_{CE} = 10$ V	35		
2N2193, A, B			20		
2N2194, A, B			12		
2N2192, A, B, 2N2193, A, B		$I_C = 1.0$ A, $V_{CE} = 10$ V	15		
Rise Time	t_r	2N2192-94, 2N2192A-94A, 2N2192B-94B (See Figure 1)		70	nsec
Fall Time	t_f			50	nsec
Storage Time	t_s			150	nsec
High Frequency Current Gain	$\|h_{fe}\|$	$I_C = 50$ mA, $V_{CE} = 10$ V, f = 20 MHz	2.5		
Output Capacitance	C_{ob}	$V_{CB} = 10$ V, $I_E = 0$, f = 1.0 MHz		20	pf

* Pulse Test: Pulse Width ≤ 300 μsec; Duty Cycle ≤ 2%.

Figure 1

PULSE GENERATOR
RISE TIME (t_r) = 20 Nsec
FALL TIME (t_f) = 20 Nsec
SOURCE IMPEDANCE (Z_{out}) = 50 Ω
PULSE WIDTH (PW) = 10μsec



TO OSCILLOSCOPE
INPUT IMPEDANCE (R_{in}) = 10 mΩ
INPUT CAPACITANCE (C_{in}) = 11.5 pf
RISE TIME (t_r) ≤ 14 nsec

CIRCUIT CONDITIONS

	V_{IN}	V_{BB}
2N2192, A, B	7.5 V	7.5 V
2N2193, A, B & 2N2194, A, B	15.0 V	15.0 V

NPN TRANSISTOR
MEDIUM POWER

- LOW SATURATION VOLTAGE
- HIGH FREQUENCY
- LOW LEAKAGE

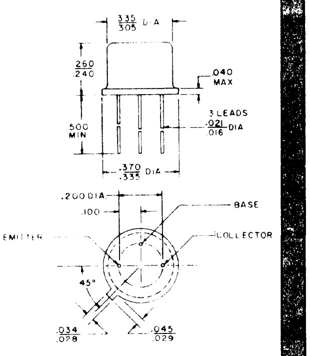
JANUARY 1968

2N2217
THRU
2N2222

MAXIMUM RATINGS

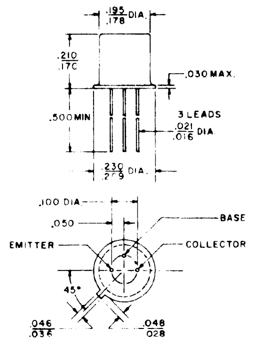
CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	60		Volts
Collector-Emitter Voltage	V_{CEO}	30		Volts
Emitter-Base Voltage	V_{EBO}	5.0		Volts
Total Device Dissipation	P_D	2N2217-19	2N2220-22	
@ $T_A = 25°C$		0.8	0.5	Watts
@ $T_C = 25°C$		3.0	1.8	
Derating Factor above 25°C				
@ $T_A = 25°C$		5.33	3.33	mW/°C
@ $T_C = 25°C$		20	12	
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	−65 to +175		°C

2N2217-19



COLLECTOR IS INTERNALLY CONNECTED TO CASE

2N2220-22



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	60		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 10\ mA, I_B = 0$	30		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	5.0		Volts
Collector Saturation Voltage	$V_{CE(sat)}{}^*$				
All Types		$I_C = 150\ mA, I_B = 15\ mA$		0.4	Volts
2N2218, 19, 21, 22		$I_C = 500\ mA, I_B = 50\ mA$		1.6	
Emitter-Base Voltage	$V_{BE}{}^*$				
All Types		$I_B = 15\ mA, I_C = 150\ mA$		1.3	Volts
2N2218, 19, 21, 22		$I_B = 50\ mA, I_C = 500\ mA$		2.6	
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = 50\ V$		10	nA
		$I_E = 0, V_{CB} = 50\ V, T_A = 150°C$		10	μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = 3.0\ V$		10	nA
DC Current Gain	h_{FE}				
2N2218, 21		$I_C = 0.1\ mA, V_{CE} = 10\ V$	20		
2N2219, 22			35		
2N2217, 20		$I_C = 1.0\ mA, V_{CE} = 10\ V$	12		
2N2218, 21			25		
2N2219, 22			50		
2N2217, 20		$I_C = 10\ mA, V_{CE} = 10\ V$	17		
2N2218, 21			35		
2N2219, 22			75		
DC Pulsed Current Gain	$h_{FE}{}^*$				
2N2217, 20		$I_C = 150\ mA, V_{CE} = 10\ V$	20	60	
2N2218, 21			40	120	
2N2219, 22			100	300	
2N2218, 21		$I_C = 500\ mA, V_{CE} = 10\ V$	20		
2N2219, 22			30		
2N2217, 20		$I_C = 150\ mA, V_{CE} = 1.0\ V$	10		
2N2218, 21			20		
2N2219, 22			50		
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 20\ mA, V_{CE} = 20\ V$ $f = 100\ MHz$	2.5		
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = 10\ V$ $f = 1.0\ MHz$		8.0	pf
Real Part of Input Impedance	$R_e(h_{ie})$	$I_C = 20\ mA, V_{CE} = 20\ V$ $f = 300\ MHz$		60	Ohms

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle ≤ 2%.

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NPN TRANSISTOR
MEDIUM POWER

- HIGH BREAKDOWN VOLTAGE
- HIGH CURRENT GAIN
- LOW SATURATION VOLTAGE

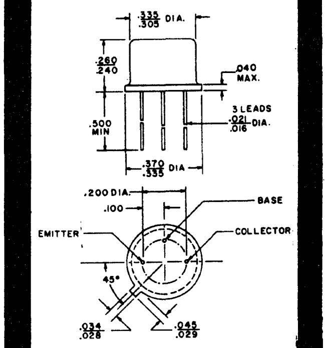
JANUARY 1968

2N2218A
2N2219A
2N2221A
2N2222A

MAXIMUM RATINGS

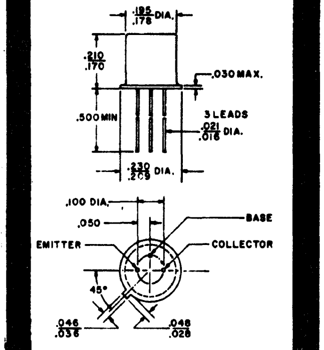
CHARACTERISTIC	SYMBOL	2N2218A 2N2219A	2N2221A 2N2222A	UNIT
Collector-Base Voltage	V_{CBO}	75	75	Volts
Collector-Emitter Voltage	V_{CEO}	40	40	Volts
Emitter-Base Voltage	V_{EBO}	6	6	Volts
Total Device Dissipation	P_D			
@ $T_A = 25°C$		0.8	0.5	Watts
@ $T_C = 25°C$		3.0	1.8	
Derating Factor Above 25°C				
@ $T_A = 25°C$		5.33	3.33	mW/°C
@ $T_C = 25°C$		20	12	
Storage Temperature Range	T_{stg}	−65 to +200		°C
Junction Temperature Range	T_J	−65 to +175		°C

2N2218A
2N2219A



COLLECTOR IS INTERNALLY CONNECTED TO CASE

2N2221A
2N2222A



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	75		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 10\ mA, I_B = 0$	40		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	6		Volts
Collector Saturation Voltage	$V_{CE(sat)}$*				
		$I_C = 150\ mA, I_B = 15\ mA$		0.3	Volts
		$I_C = 500\ mA, I_B = 50\ mA$		1.0	
Base Saturation Voltage	$V_{BE(sat)}$*				
		$I_C = 150\ mA, I_B = 15\ mA$	0.6	1.2	Volts
		$I_C = 500\ mA, I_B = 50\ mA$		2.0	
Collector-Base Cutoff Current	I_{CBO}				
		$V_{CB} = 60\ V, I_E = 0$		0.01	μA
		$V_{CB} = 60\ V, I_E = 0, T_A = 150°C$		10	
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 3\ V, I_C = 0$		10	nA
Base-Emitter Cutoff Current	I_{BEX}	$V_{CE} = 60\ V, V_{EB} = 3\ V$		20	nA
Collector-Emitter Cutoff Current	I_{CEX}	$V_{CE} = 60\ V, V_{EB} = 3\ V$		10	nA
DC Pulse Current Gain	h_{FE}*				
2N2218A, 2N2221A		$I_C = 0.1\ mA, V_{CE} = 10\ V$	20		
2N2219A, 2N2222A			35		
2N2218A, 2N2221A		$I_C = 1.0\ mA, V_{CE} = 10\ V$	25		
2N2219A, 2N2222A			50		
2N2218A, 2N2221A		$I_C = 10\ mA, V_{CE} = 10\ V$	35		
2N2219A, 2N2222A			75		
2N2218A, 2N2221A		$I_C = 10\ mA, V_{CE} = 10\ V$	15		
2N2219A, 2N2222A		$T_A = -55°C$	35		
2N2218A, 2N2221A		$I_C = 150\ mA, V_{CE} = 10\ V$	40	120	
2N2219A, 2N2222A			100	300	
2N2218A, 2N2221A		$I_C = 150\ mA, V_{CE} = 1.0\ V$	20		
2N2219A, 2N2222A			50		
2N2218A, 2N2221A		$I_C = 500\ mA, V_{CE} = 10\ V$	25		
2N2219A, 2N2222A			40		

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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Small Signal Current Gain	h_{fe}				
2N2218A, 2N2221A		$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	30	150	
2N2219A, 2N2222A			50	300	
2N2218A, 2N2221A		$I_C = 10$ mA, $V_{CE} = 10$ V, f = 1 kHz	50	300	
2N2219A, 2N2222A			75	375	
High Frequency Current Gain	h_{fe}				
2N2218A, 2N2221A		$I_C = 20$ mA, $V_{CE} = 20$ V, f = 100 MHz	2.5		
2N2219A, 2N2222A			3.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 10$ V, f = 100 kHz		8	pf
Input Capacitance	C_{ib}	$I_C = 0$, $V_{EB} = 0.5$ V, f = 1 kHz		25	pf
Voltage Feedback Ratio	h_{re}				
2N2218A, 2N2221A		$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz		5	$x10^{-4}$
2N2219A, 2N2222A				8	
2N2218A, 2N2221A		$I_C = 10$ mA, $V_{CE} = 10$ V, f = 1 kHz		2.5	
2N2219A, 2N2222A				4	
Input Resistance	h_{ie}				
2N2218A, 2N2221A		$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	1	3.5	K ohms
2N2219A, 2N2222A			2.0	8	
2N2218A, 2N2221A		$I_C = 10$ mA, $V_{CE} = 10$ V, f = 1 kHz	0.2	1.0	
2N2219A, 2N2222A			0.25	1.25	
Output Conductance	h_{oe}				
2N2218A, 2N2221A		$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	3	15	μmhos
2N2219A, 2N2222A			5	35	
2N2218A, 2N2221A		$I_C = 10$ mA, $V_{CE} = 10$ V, f = 1 kHz	10	100	
2N2219A, 2N2222A			25	200	
Collector-Base Time Constant	$r_b'C_c$	$I_C = 20$ mA, $V_{CE} = 20$ V, f = 31.8 MHz		150	psec
Noise Figure	NF				
2N2219A 2N2222A		$I_C = 100$ μA, $V_{CE} = 10$ V, Rg = 1 kΩ, f = 1 kHz		4	db

* Pulse Test: Pulse Width ≤ 300 μsec; Duty Cycle $\leq 2\%$.

NPN TRANSISTOR
MEDIUM POWER

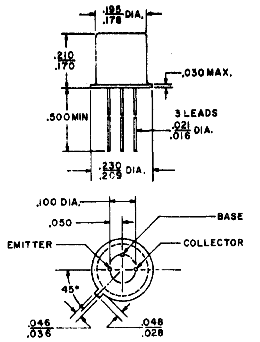
- **LOW NOISE**
- **HIGH BREAKDOWN VOLTAGE**
- **LOW SATURATION VOLTAGE**

JANUARY 1968

2N2222B

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	75	Volts
Collector-Emitter Voltage	V_{CEO}	6.0	Volts
Emitter-Base Voltage	V_{EBO}	40	Volts
Collector Current	I_C	1.0	A
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 0.5 1.8	Watts
Derating Factor Above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 3.3 12	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C
Lead Temperature, 1/16 inch from case, 10 second max.		230	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_E = 0, I_C = 10\ \mu A$	75		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 10\ mA, V_{BE} = 0$	40		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	6.0		Volts
Collector Saturation Voltage	$V_{CE(sat)}{}^*$	$I_C = 150\ mA, I_B = 15\ mA$ $I_C = 500\ mA, I_B = 50\ mA$ $I_C = 1.0\ mA, I_B = 100\ mA$		0.2 0.5 1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 150\ mA, I_B = 15\ mA$ $I_C = 500\ mA, I_B = 50\ mA$ $I_C = 1.0\ mA, I_B = 100\ mA$	0.6	1.0 1.3 1.6	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CE} = 60\ V, I_E = 0$ $V_{CB} = 60\ V, I_E = 0, T_A = 150°C$		10 10	nA µA
Collector-Emitter Reverse Current	I_{CEX}	$V_{CE} = 60\ V, V_{EB} = 3.0\ V$		10	nA
Base Leakage Current	I_{BL}	$V_{CE} = 60\ V, V_{EB} = 3.0\ V$		20	nA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 3.0\ V, I_C = 0$		10	nA
DC Current Gain	h_{FE}	$V_{CE} = 10\ V, I_C = 100\ \mu A$ $V_{CE} = 10\ V, I_C = 1.0\ mA$ $V_{CE} = 10\ V, I_C = 10\ mA$ $V_{CE} = 10\ V, I_C = 150\ mA$ $V_{CE} = 10\ V, I_C = 500\ mA$ $V_{CE} = 10\ V, I_C = 1.0\ A^*$ $V_{CE} = 1.0\ V, I_C = 150\ mA$ $V_{CE} = 10\ V, I_C = 10\ mA, T_A = -55°C$	35 50 75 100 40 15 50 35	 300	
Rise Time	t_r	See Figure 1		25	nsec
Turn-on Delay Time	t_d	See Figure 1		10	nsec
Fall Time	t_f	See Figure 2		60	nsec
Storage Time	t_s	See Figure 2		225	nsec
Action Region Time Constant	t_a	See Figure 1		2.5	nsec
Small Signal Current Gain	h_{fe}	$V_{CE} = 10\ V, I_C = 1.0\ mA$ $f = 1.0\ kHz$ $V_{CE} = 10\ V, I_C = 10\ mA$ $f = 1.0\ kHz$	50 75	300 375	

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$V_{CE} = 20$ V, $I_C = 20$ mA f = 100 MHz	3.0		
		$V_{CE} = 20$ V, $I_C = 50$ mA f = 100 MHz	4.0		
Output Capacitance	C_{ob}	$V_{CB} = 10$ V, $I_E = 0$ f = 100 kHz		8.0	pf
Input Capacitance	C_{ib}	$V_{EB} = 0.5$ V, $I_C = 0$ f = 100 kHz		25	pf
Input Resistance	h_{ie}	$V_{CE} = 10$ V, $I_C = 1.0$ mA f = 1.0 kHz	2.0	8.0	k ohms
		$V_{CE} = 10$ V, $I_C = 10$ mA f = 1.0 kHz	0.25	1.25	
Voltage Feedback Ratio	h_{re}	$V_{CE} = 10$ V, $I_C = 1.0$ mA f = 1.0 kHz		0.0008	
		$V_{CE} = 10$ V, $I_C = 10$ mA f = 1.0 kHz		0.0004	
Output Conductance	h_{oe}	$V_{CE} = 10$ V, $I_C = 1.0$ mA f = 1.0 kHz	5.0	35	μmhos
		$V_{CE} = 10$ V, $I_C = 10$ mA f = 1.0 kHz	25	200	
Collector-Base Time Constant	$r_b'C_c$	$V_{CE} = 20$ V, $I_C = 20$ mA f = 31.8 MHz		150	psec
Real Part Input Impedance	$R_{e(hie)}$	$V_{CE} = 20$ V, $I_C = 20$ mA f = 300 MHz		60	Ohms
Current Gain Bandwidth Product	f_t	$V_{CE} = 20$ V, $I_C = 20$ mA f = 100 MHz	300		MHz
Noise Figure	NF	$V_{CE} = 10$ V, $I_C = 100$ μA $R_G = 1.0$ kΩ. f = 1.0 kHz BW = 1.0 Hz		4.0	db

*Pulse Test: Pulse Width $\leqq$ 300 μsec; Duty Cycle $\leqq$ 2%.

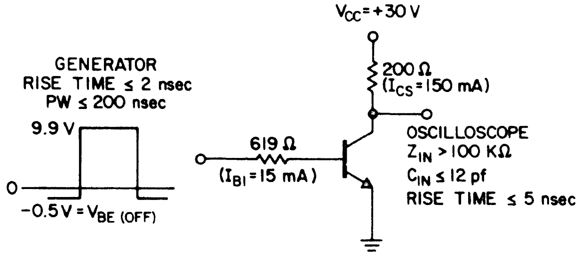


Figure 1 Equivalent Test Circuit for Measuring Delay and Rise Times

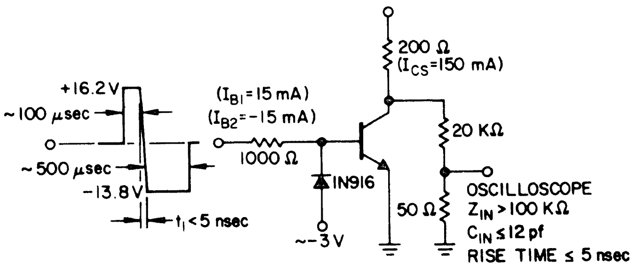


Figure 2 Equivalant Test Circuit for Measuring Storage Fall Time

NPN TRANSISTOR
MEDIUM POWER

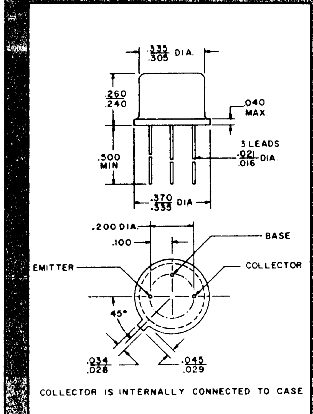
- HIGH BREAKDOWN VOLTAGE
- LOW SATURATION VOLTAGE
- FAST SWITCHING SPEEDS

JANUARY 1968

2N2243
2N2243A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	120	Volts
Collector-Emitter Voltage	V_{CEO}	80	Volts
Emitter-Base Voltage	V_{EBO}	7.0	Volts
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.8 2.8 1.6	 Watts
Derating Factor above 25°C @ $T_A = 25°C$		 4.6	 mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	−65 to +200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 100\ \mu A, I_E = 0$	120		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 100\ \mu A$	7.0		Volts
Collector Saturation Voltage 2N2243 2N2243A	$V_{CE(sat)}$	$I_B = 15$ mA, $I_C = 150$ mA		 0.35 0.25	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = 60$ V $I_E = 0, V_{CB} = 60$ V, $T_A = 150°C$		10 15	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = 5.0$ V		50	nA
DC Current Gain	h_{FE}	$I_C = 100\ \mu A, V_{CE} = 10$ V $I_C = 10$ mA, $V_{CE} = 10$ V $I_C = 10$ mA, $V_{CE} = 10$ V $T_A = -55°C$	15 30 20		
DC Pulsed Current Gain	$h_{FE}{}^*$	$I_C = 150$ mA, $V_{CE} = 10$ V $I_C = 500$ mA, $V_{CE} = 10$ V $I_C = 150$ mA, $V_{CE} = 1.0$ V	40 15 30	120	
Small Signal Current Gain	h_{fe}	$I_C = 50$ mA, $V_{CE} = 10$ V f = 1.0 kHz	2.5		
Output Capacitance	C_{ob}	$I_C = 100\ \mu A, I_E = 0$		15	pf
Stored-Charge Time Constant	T_b	See Figure 1		2.1	μsec

* Pulse Test: Pulse Width ≤ 300 μsec; Duty Cycle = 1%.

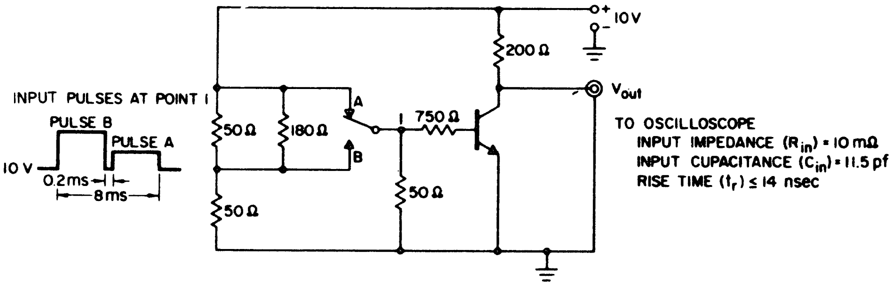


Figure 1

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NPN TRANSISTOR
MEDIUM POWER

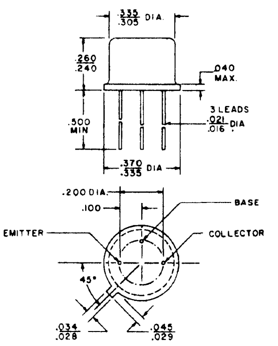
- LOW SATURATION VOLTAGE
- HIGH BREAKDOWN VOLTAGE
- HIGH COLLECTOR CURRENT

JANUARY 1968

2N2297

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	80	Volts
Collector-Emitter Voltage	V_{CEO}	35	Volts
Emitter-Base Voltage	V_{EBO}	7.0	Volts
Collector Current	I_C	1	Amp
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.8 5.0 2.8	Watts
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Lead Temperature, 1/16 inch from case, 10 sec. max.		+300	°C
Derating Factor above 25°C $T_A = 25°C$ $T_C = 25°C$		 4.06 2.86	mW/°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 100\ \mu A, I_E = 0$	80		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 100\ \mu A$	7.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 30$ mA, $I_B = 0$	35		Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 1000$ mA, $I_B = 100$ mA		1.6	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = 60$ V $I_E = 0, V_{CB} = 60$ V, $T_A = 150°C$		10 10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = 5.0$ V		10	nA
DC Pulsed Current Gain	h_{FE}*	$I_C = 150$ mA, $V_{CE} = 10$ V $I_C = 10$ mA, $V_{CE} = 10$ V $I_C = 1.0$ A, $V_{CE} = 10$ V	40 30 15	120	
High Frequency Current Gain	$\|h_{fe}\|$	$I_C = 50$ mA, $V_{CE} = 10$ V f = 20 MHz	3.0		
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = 10$ V f = 140 kHz		12	pf
Collector-Base Time Constant	$r_b'C_c$	$I_C = 10$ mA, $V_{CB} = 10$ V f = 4 MHz		800	psec

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle ≤ 1%.

NPN TRANSISTOR
MEDIUM POWER

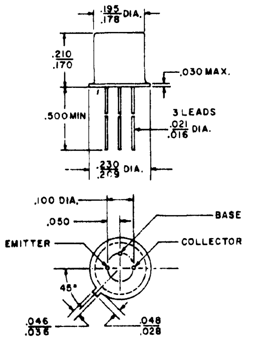
- **LOW NOISE**
- **LOW SATURATION VOLTAGE**
- **HIGH COLLECTOR CURRENT**

JANUARY 1968

2N5079
2N5080

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	60	Volts
Collector-Emitter Voltage	V_{CEO}	5	Volts
Emitter-Base Voltage	V_{EBO}	30	Volts
Collector Current	I_C	1.0	Amp
Base Current	I_B	200	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	1.8	Watts
Derating Factor above 25°C @ $T_A = 25°C$		10.3	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	60		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}*	$I_C = 10\ mA, I_B = 0$	30		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	5.0		Volts
Base Saturation Voltage	$V_{BE(sat)}$*	$I_C = 150\ mA, I_B = 15\ mA$ $I_C = 500\ mA, I_B = 50\ mA$ $I_C = 1.0\ A, I_B = 100\ mA$		1.0 1.3 1.6	Volts
Collector Saturation Voltage	$V_{CE(sat)}$*	$I_C = 150\ mA, I_B = 15\ mA$ $I_C = 500\ mA, I_B = 50\ mA$ $I_C = 1.0\ A, I_B = 100\ mA$		0.2 0.5 1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 50\ V, I_E = 0$ $V_{CB} = 50\ V, I_E = 0, T_A = 150°C$		10 10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 3.0\ V, I_C = 0$		10	nA
DC Current Gain	h_{FE}*				
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 0.1\ mA$	35 50		
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 1.0\ mA$	50 90		
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 10\ mA$	75 150		
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 150\ mA$	100 200	300 500	
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 500\ mA$	50 90		
2N5079 2N5080		$V_{CE} = 10\ V, I_C = 1.0\ A$	15 25		
High Frequency Current Gain	h_{fe}	$V_{CE} = 20\ V, I_C = 50\ mA$ $f = 100\ MHz$	4		
Output Capacitance	C_{ob}	$V_{CB} = 10\ V, I_E = 0$ $f = 1.0\ MHz$		7	pf
Input Capacitance	C_{ib}	$V_{EB} = 0.5\ V, I_C = 0$ $f = 1.0\ MHz$		30	pf
Noise Figure	NF	$V_{CE} = 5.0\ V, I_C = 200\ \mu A, R_S = 510\Omega$ $f = 1.0\ kHz, BW = 200\ Hz$		4.0	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

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NPN TRANSISTOR
RF/IF AMPLIFIER

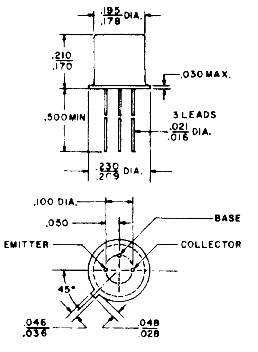
- HIGH FREQUENCY
- HIGH VOLTAGE
- HIGH CURRENT GAIN

JANUARY 1968

2N915
2N915A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	70	Volts
Collector-Emitter Voltage	V_{CEO}	50	Volts
Emitter-Base Voltage	V_{EBO}	5	Volts
Collector Current	I_C	Limited by Dissipation only	
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.36 1.2 0.68	 Watts
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.1 6.85	 mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage 2N915 2N915A	BV_{CBO}	 $I_C = 100\ \mu A, I_E = 0$ $I_C = 10\ \mu A, I_E = 0$	 70 70		 Volts Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	5		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 10$ mA, $I_B = 0$	50		Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1$ mA		0.9	Volts
Collector Saturation Voltage 2N915 2N915A	$V_{CE(sat)}$	 $I_C = 10$ mA, $I_B = 1$ mA		 1.0 0.2	 Volts
Collector-Base Cutoff Current 2N915 2N915A 2N915 2N915A	I_{CBO}	 $V_{CB} = 60$ V, $I_E = 0$ $V_{CB} = 60$ V, $I_E = 0$, $T_A = 150°C$		 10 2 30 3	 nA μA
DC Pulse Current Gain	$h_{FE}{}^*$	$I_C = 10$ mA, $V_{CE} = 5$ V	50	200	
DC Pulse Current Gain 2N915A Both Types Both Types Both Types Both Types	$h_{FE}{}^*$	 $I_C = 10\ \mu A$, $V_{CE} = 5$ V $I_C = 100\ \mu A$, $V_{CE} = 5$ V $I_C = 1.0$ mA, $V_{CE} = 5$ V $I_C = 10$ mA, $V_{CE} = 1$ V $I_C = 100$ mA, $V_{CE} = 1$ V	 50 50 50 50 15	 200 200 200 200	
Emitter-Base Cutoff Current 2N915A	I_{EBO}	 $V_{EB} = 3$ V, $I_C = 0$		 2	 nA
High Frequency Current Gain 2N915 2N915A	$\lvert h_{fe} \rvert$	 $V_{CE} = 15$ V, $I_C = 10$ mA f = 100 MHz	 2.5 6.0		
Small Signal Current Gain 2N915 2N915A	h_{fe}	 $V_{CE} = 5$ V, $I_C = 1$ mA f = 1 kHz	 40 50	 200 200	
Small Signal Current Gain	h_{fe}	$V_{CE} = 5$ V, $I_C = 5$ mA f = 1 kHz	50	250	

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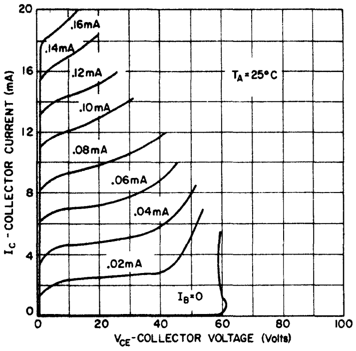
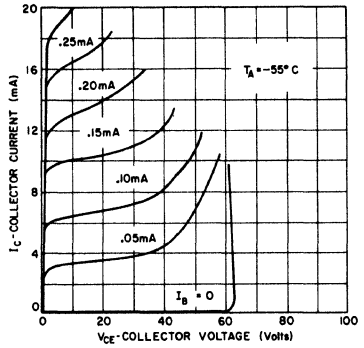
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Output Capacitance 2N915 2N915A	C_{ob}	$V_{CB} = 10$ V, $I_E = 0$		3.5 3.0	pf pf
Input Capacitance 2N915 2N915A	C_{ib}	$V_{EB} = 0.5$ V, $I_C = 0$		10 5	pf pf
Input Resistance	h_{ie}	$V_{CE} = 5$ V, $I_C = 5$ mA f = 1 kHz $V_{CE} = 5$ V, $I_C = 1$ mA f = 1 kHz		2000 6000	ohms ohms
Output Conductance	h_{oe}	$V_{CE} = 5$ V, $I_C = 5$ mA f = 1 kHz $V_{CE} = 5$ V, $I_C = 1$ mA f = 1 kHz		75 125	μmhos μmhos
Collector-Base Time Constant	$r_b'C_c$	$V_{CB} = 10$ V, $I_C = 10$ mA f = 40 MHz		300	psec
Noise Figure 2N915A	NF	$V_{CE} = 5$ V, $I_C = 10$ μA f = 1 kHz $R_S = 10$ kΩ BW = 200 Hz		4	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

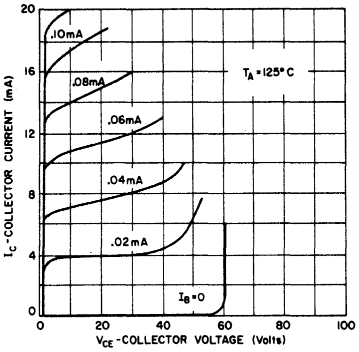
Collector Characteristics



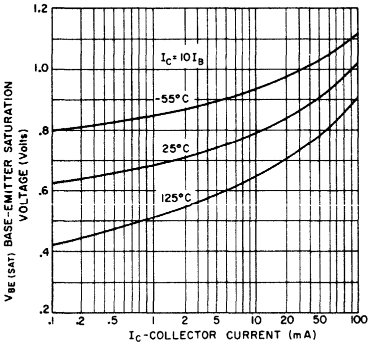
Collector Characteristics



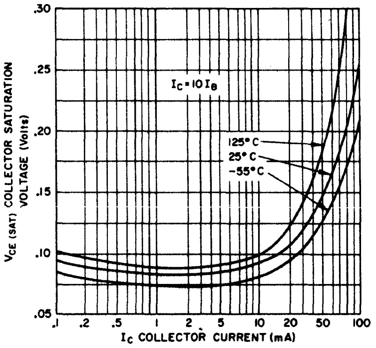
Collector Characteristics



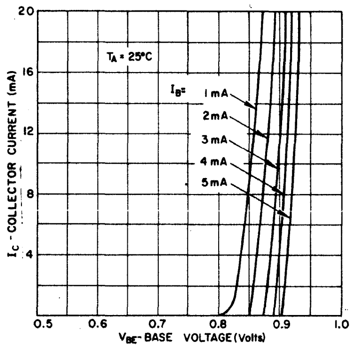
Base-Emitter Saturation Voltage
vs
Collector Current



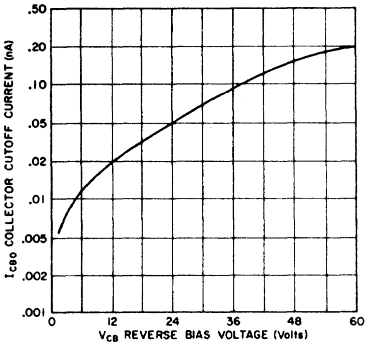
Collector Saturation Voltage
vs
Collector Current



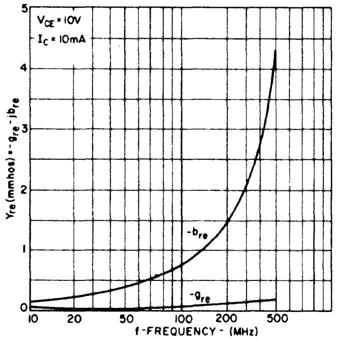
Typical Base Characteristics



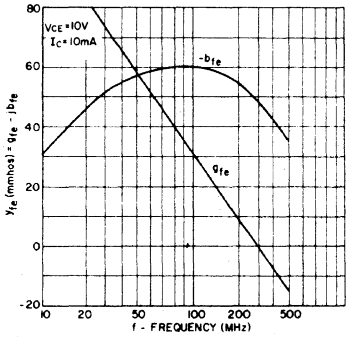
Collector Bias Reverse Current
vs
Reverse Bias Voltage



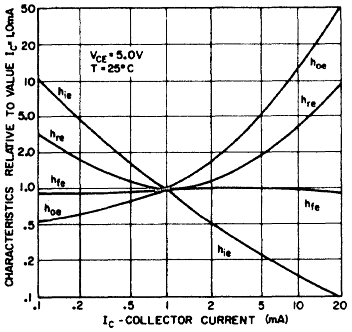
Reverse Transfer Admittance
vs
Frequency – Input Short Circuit



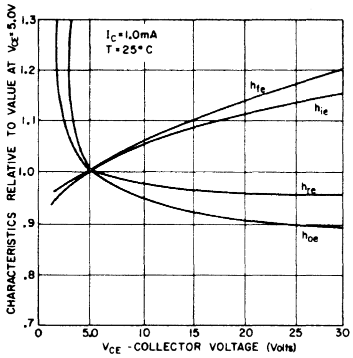
Forward Transfer Admittance
vs
Frequency – Output Short Circuit



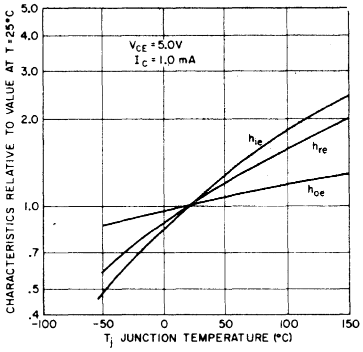
Typical Common Emitter Characteristics



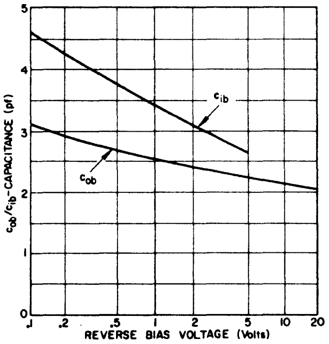
Typical Common Emitter Characteristics



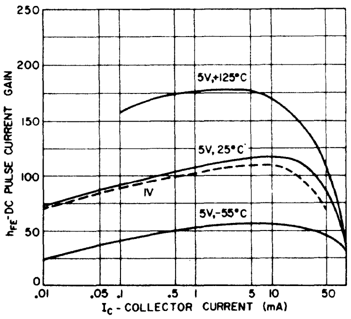
Typical Common Emitter
Characteristics



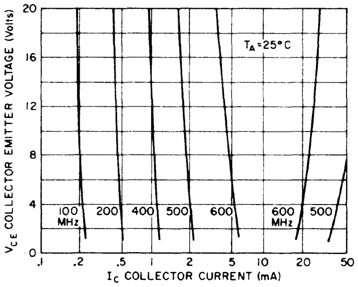
Output and Input Capacitance
vs
Reverse Bias Voltage



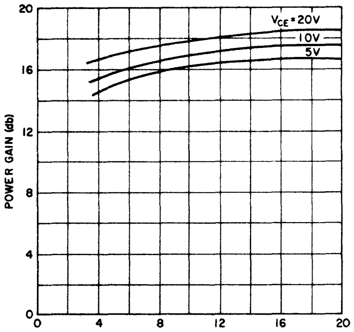
DC Pulse Current Gain
vs
Collector Current



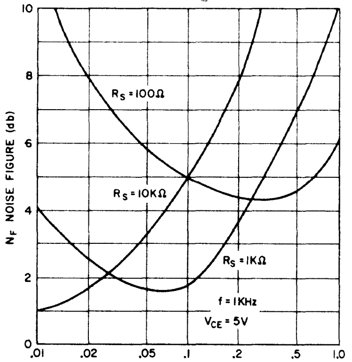
Contours of Constant Gain
Bandwidth Product – f_T



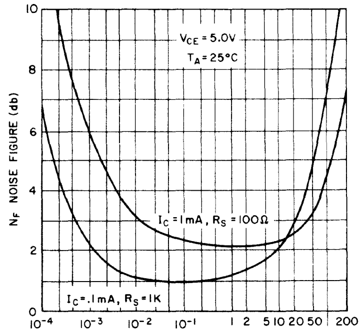
Neutralized 200 MHz Power Gain vs I_C



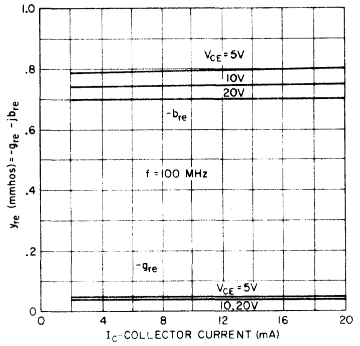
Noise Figure
vs
Collector Current



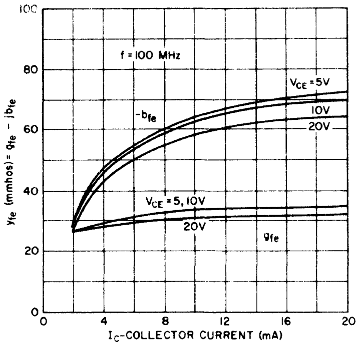
Noise Figure
vs
Frequency



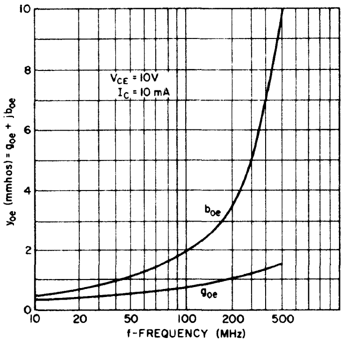
Reverse Transfer Admittance
vs
Collector Current and
Voltage-Input Short Circuit



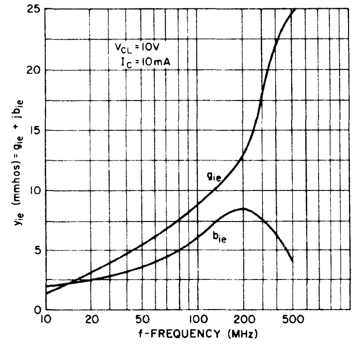
Forward Transfer Admittance
vs
Collector Current and
Voltage-Output Short Circuit



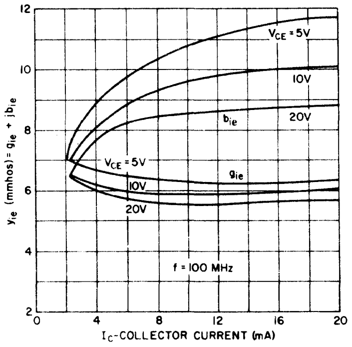
Output Admittance
vs
Frequency – Input Short Circuit



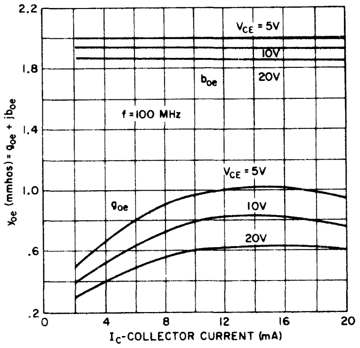
Input Admittance
vs
Frequency – Output Short Circuit



Input Admittance
vs
Collector Current and
Voltage-Output Short Circuit



Output Admittance
vs
Collector Current and
Voltage-Output Short Circuit



NPN TRANSISTOR
RF/IF AMPLIFIER

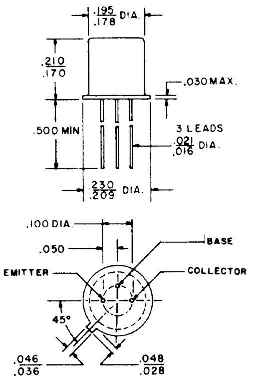
- **HIGH FREQUENCY**
- **HIGH VOLTAGE**
- **HIGH CURRENT GAIN**

JANUARY 1968

2N916
2N916A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		2N916, 2N916A	2N916B	
Collector-Base Voltage	V_{CBO}	45	60	Volts
Collector-Emitter Voltage	V_{CEO}	25	30	Volts
Emitter-Base Voltage	V_{EBO}	5	5	Volts
Collector Current	I_C	Limited by Dissipation Only		
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.36 1.2 0.68		Watts
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.1 6.85		mW/°C
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200		°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage 2N916, 2N916A 2N916B	BV_{CBO}	 $I_C = 10\ \mu A, I_E = 0$ $I_C = 10\ \mu A, I_E = 0$	 45 60		 Volts Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	5		Volts
Collector-Emitter Sustaining Voltage 2N916, 2N916A 2N916B	$V_{CEO(sus)}{}^*$	$I_C = 10\ mA, I_B = 0$	 25 30		 Volts Volts
Collector Saturation Voltage 2N916, 2N916A 2N916B	$V_{CE(sat)}$	$I_C = 10\ mA, I_B = 1\ mA$		 0.5 0.2	 Volts Volts
Collector Saturation Voltage 2N916A 2N916B	$V_{CE(sat)}$	$I_C = 100\ mA, I_B = 10\ mA$		 1.0 0.5	 Volts Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10\ mA, I_B = 1\ mA$		0.9	Volts
Base Saturation Voltage 2N916A 2N916B	$V_{BE(sat)}$	$I_C = 100\ mA, I_B = 10\ mA$		 1.3 1.2	Volts
Collector-Base Cutoff Current 2N916, 2N916A 2N916B 2N916, 2N916A 2N916B	I_{CBO}	 $V_{CB} = 30\ V, I_E = 0$ $V_{CB} = 45\ V, I_E = 0$ $V_{CB} = 30\ V, I_E = 0, T_A = 150°C$ $V_{CB} = 45\ V, I_E = 0, T_A = 150°C$		 10 2 10 3	 nA μA
Emitter-Base Cutoff Current 2N916B	I_{EBO}	$V_{EB} = 3\ V, I_C = 0$		2	nA
DC Pulse Current Gain	$h_{FE}{}^*$	$I_C = 10\ mA, V_{CE} = 5\ V$	50	200	
DC Pulse Current Gain 2N916A, 2N916B	$h_{FE}{}^*$	$I_C = 100\ mA, V_{CE} = 1\ V$	15		

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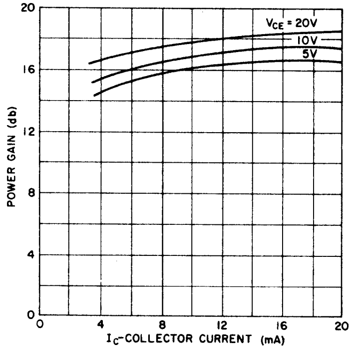
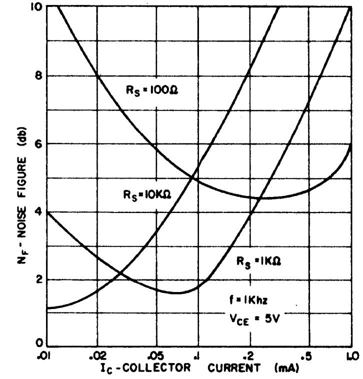
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
DC Pulse Current Gain 2N916B All Types All Types All Types	h_{FE}*	$I_C = 10\ \mu A, V_{CE} = 5\ V$ $I_C = 100\ \mu A, V_{CE} = 5\ V$ $I_C = 1.0\ mA, V_{CE} = 5\ V$ $I_C = 10\ mA, V_{CE} = 1\ V$	50 50 50 50	200 200 200 200	
High Frequency Current Gain 2N916, 2N916A 2N916B	$\vert h_{fe} \vert$	$I_C = 10\ mA, V_{CE} = 15\ V$ $f = 100\ MHz$	3.0 5.0		
Small Signal Current Gain	h_{fe}	$I_C = 5\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$	50	250	
Small Signal Current Gain 2N916, 2N916A 2N916B	h_{fe}	$I_C = 1\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$	40 50	200 200	
Output Capacitance 2N916, 2N916A 2N916B	C_{ob}	$V_{CB} = 5\ V, I_E = 0$		6 3	pf pf
Input Capacitance 2N916, 2N916A 2N916B	C_{ib}	$V_{EB} = 0.5\ V, I_C = 0$		10 5	pf pf
Input Resistance	h_{ie}	$I_C = 5\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$ $I_C = 1\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$		2000 6000	ohms ohms
Output Conductance	h_{oe}	$I_C = 1\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$ $I_C = 5\ mA, V_{CE} = 5\ V$ $f = 1\ kHz$		75 125	µmhos µmhos
Collector-Base Time Constant	$r_b'C_c$	$I_C = 10\ mA, V_{CB} = 10\ V$ $f = 40\ MHz$		300	psec
Noise Figure 2N916B	NF	$I_C = 10\ \mu A, V_{CE} = 5\ V$ $f = 1\ kHz$ $R_S = 10\ K$ $BW = 200\ Hz$		4.0	db

* Pulse Test: Pulse Width = 300 µsec; Duty Cycle = 1%.

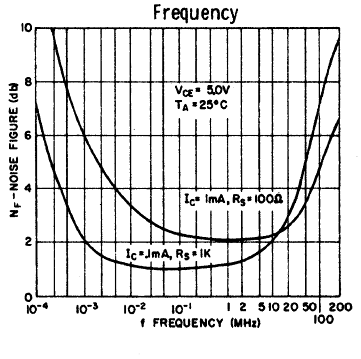
Neutralized 200 MHz Power Gain vs I_C



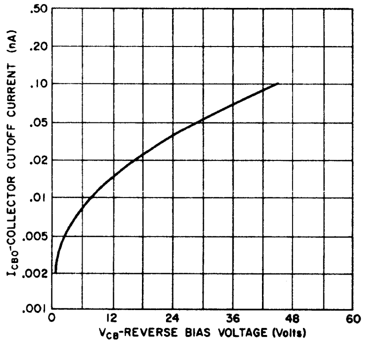
Noise Figure
vs
Collector Current



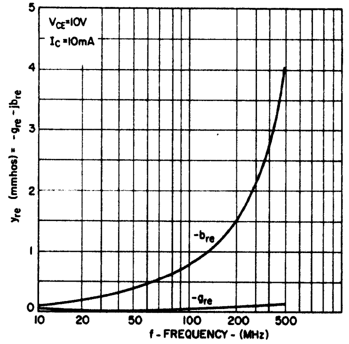
Noise Figure
vs
Frequency



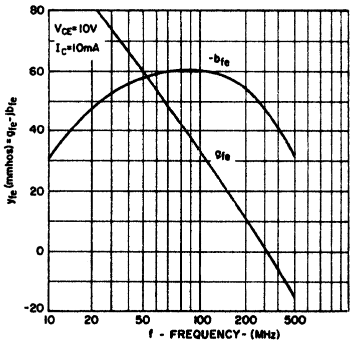
Collector Bias Reverse Current
vs
Reverse Bias Voltage



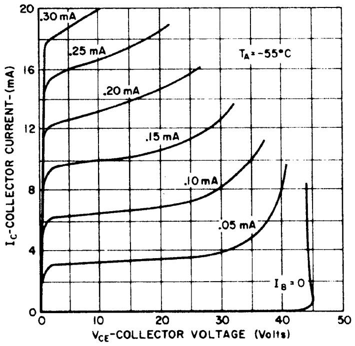
Reverse Transfer Admittance
vs
Frequency-Input Short Circuit



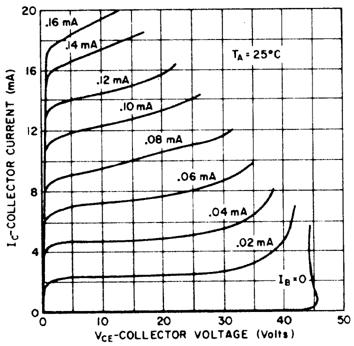
Forward Transfer Admittance
vs
Frequency-Output Short Circuit



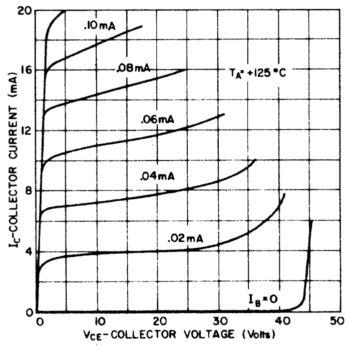
Collector Characteristics



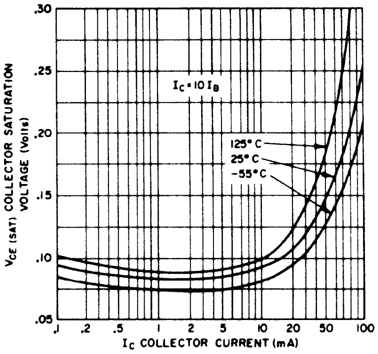
Collector Characteristics



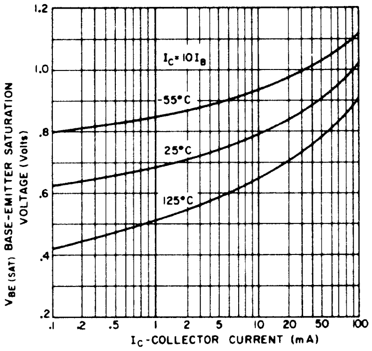
Collector Characteristics



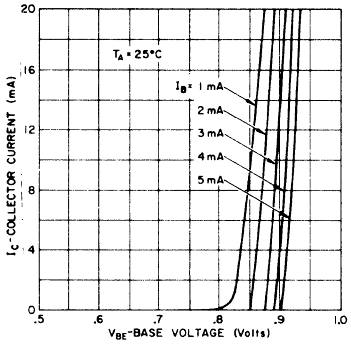
Collector Saturation Voltage vs Collector Current



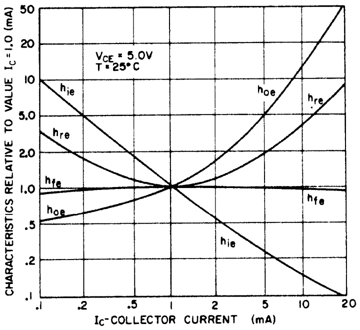
Base-Emitter Saturation Voltage vs Collector Current



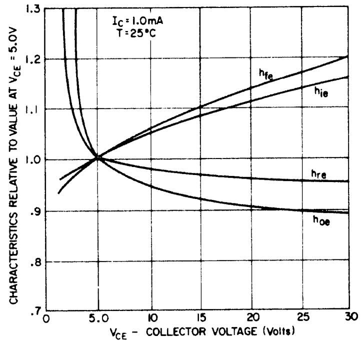
Typical Base Characteristics



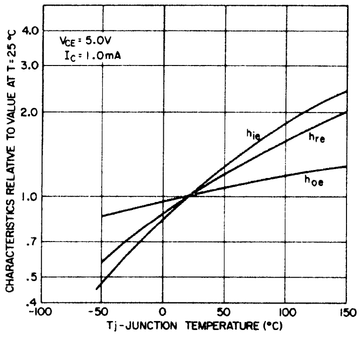
Typical Common Emitter Characteristics



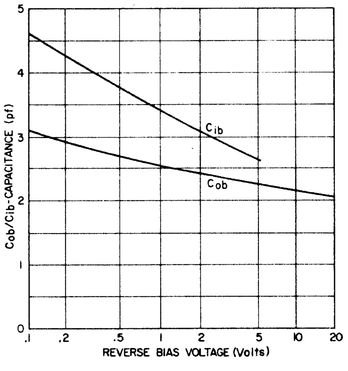
Typical Common Emitter Characteristics



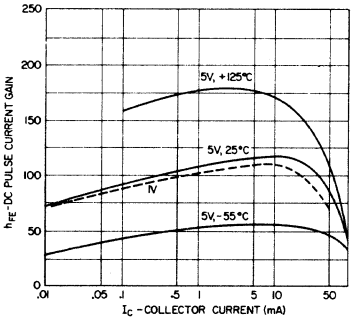
Typical Common Emitter Characteristics



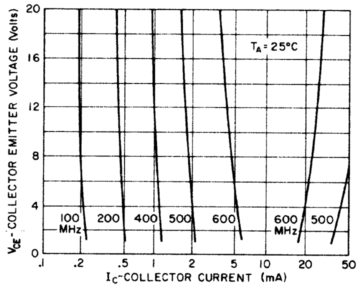
Output and Input Capacitance vs Reverse Bias Voltage



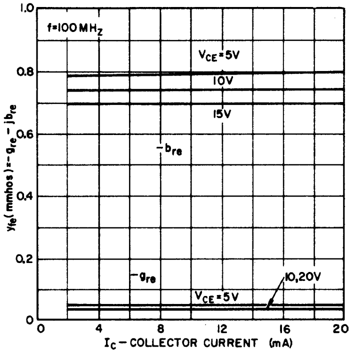
DC Pulse Current Gain vs Collector Current



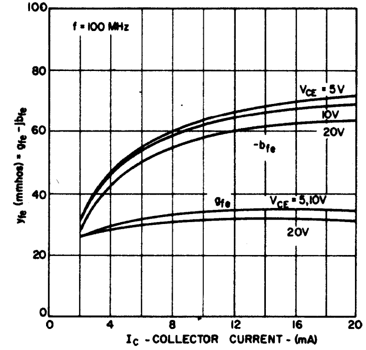
Contours of Constant Gain Bandwidth Product – f_T



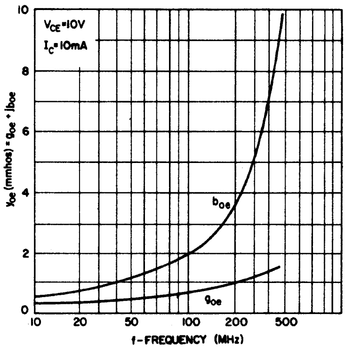
Reverse Transfer Admittance
vs
Collector Current and
Voltage-Input Short Circuit



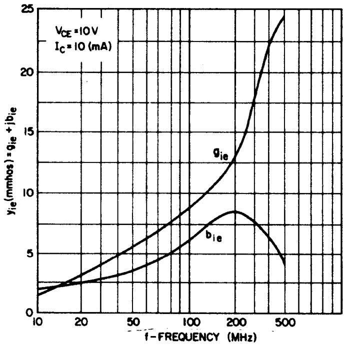
Forward Transfer Admittance
vs
Collector Current and
Voltage-Output Short Circuit



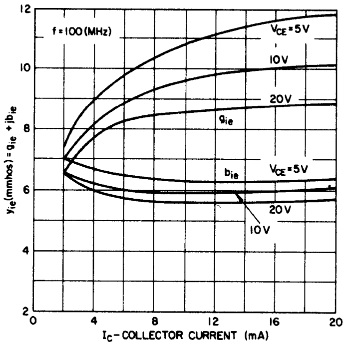
Output Admittance
vs
Frequency-Input Short Circuit



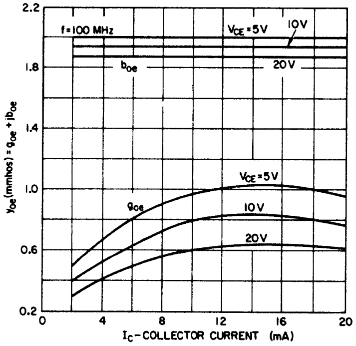
Input Admittance
vs
Frequency-Output Short Circuit



Input Admittance
vs
Collector Current and
Voltage-Output Short Circuit



Output Admittance
vs
Collector Current and
Voltage-Input Short Circuit



NPN TRANSISTOR
RF/IF AMPLIFIER

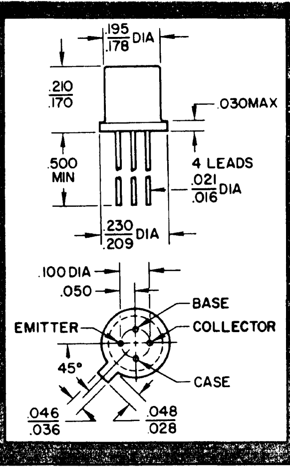
- HIGH FREQUENCY
- LOW SATURATION VOLTAGE
- LOW CAPACITANCE

JANUARY 1968

2N918

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	30	Volts
Collector-Emitter Voltage	V_{CEO}	15	Volts
Emitter-Base Voltage	V_{EBO}	3.0	Volts
Collector Current	I_C	50	mA
Total Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 0.2 0.3	 Watt
Derating Factor above 25°C @ $T_A = 25°C$		 2.0	 mW/°C
Storage Temperature	T_{stg}	−65 to +300	°C
Junction Temperature	T_J	+200	°C

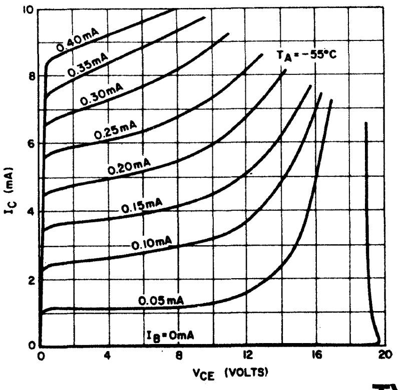


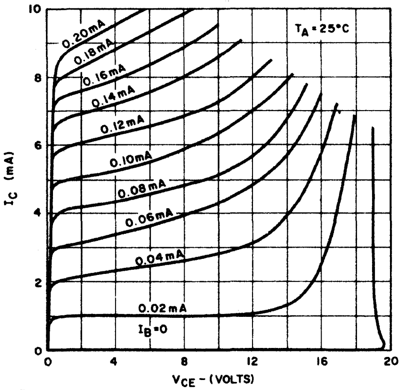
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

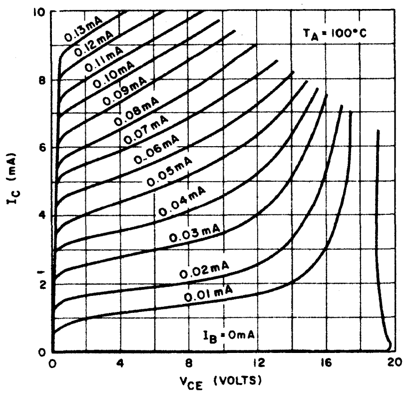
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 1.0\ \mu A$, $I_E = 0$	30		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 3$ mA, $I_B = 0$	15		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 10\ \mu A$, $I_C = 0$	3		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		0.4	Volt
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		1.0	Volt
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 15$ V, $I_E = 0$ $V_{CB} = 15$ V, $T_A = 150°C$, $I_E = 0$		10 1.0	nA μA
DC Current Gain	h_{FE}	$V_{CE} = 1.0$ V, $I_C = 3.0$ mA	20		
High Frequency Current Gain	$\|h_{fe}\|$	$I_C = 4.0$ mA $V_{CE} = 10$ V f = 100 MHz	6.0		
Output Capacitance	C_{ob}	$V_{CB} = 10$ V $I_E = 0$, f = 140 kHz $V_{CB} = 0$, f = 140 kHz $I_E = 0$		1.7 3.0	pf
Input Capacitance	C_{ib}	$V_{EB} = 0.5$ V $I_C = 0$, f = 140 kHz		2.0	pf
Collector Efficiency	η	$V_{CB} = 15$ V f = 500 MHz $I_C = 8.0$ mA	25		%
Available Power Gain	A_p	$I_C = 6.0$ mA $V_{CB} = 12$ V f = 200 MHz (Figure 1)	15		db
Power Output	P_o	$I_C = 8.0$ mA $V_{CB} = 15$ V f = 500 MHz (Figure 2)	30		mW
Noise Figure	NF	$I_C = 1.0$ mA $V_{CE} = 6.0$ V f = 60 MHz $R_G = 400\ \Omega$		6	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

TYPICAL COLLECTOR CHARACTERISTICS

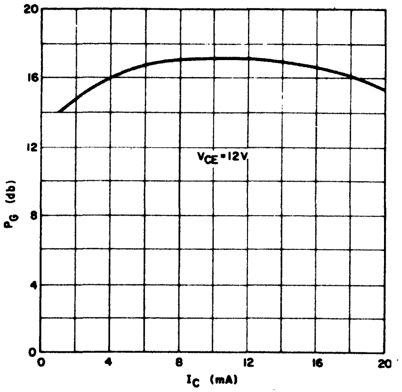






TYPICAL HIGH FREQUENCY CHARACTERISTICS

200 MHz Power Gain vs Collector Current



Neutralized 200 MHz Power Gain Amplifier Test Circuit

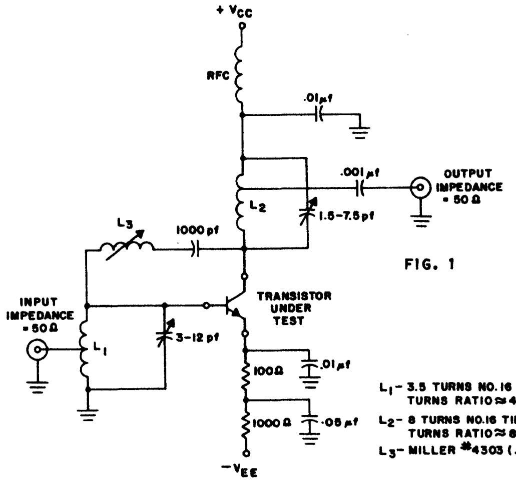


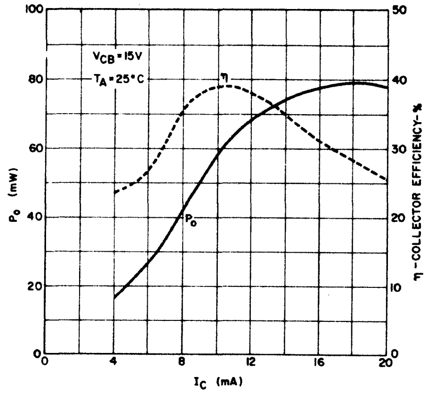
FIG. 1

L_1 - 3.5 TURNS NO.16 TINNED COPPER WIRE; $\frac{5}{16}$ DIA; $\frac{7}{16}$ LONG. TURNS RATIO≈4 TO 2

L_2 - 8 TURNS NO.16 TINNED COPPER WIRE; $\frac{1}{8}$ DIA; $\frac{7}{8}$ LONG TURNS RATIO≈8 TO 1

L_3 - MILLER #4303 (.4-.65µh)

500 MHz Power Output and Collector Efficiency vs Collector Current



500 MHz Oscillator Test Circuit

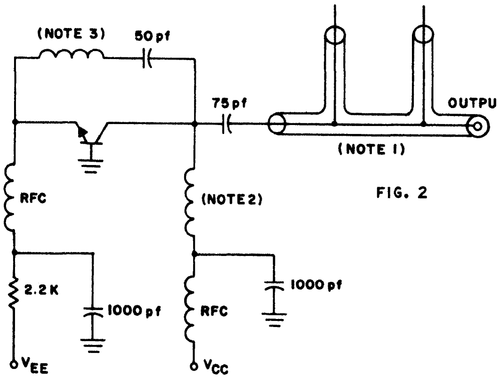


FIG. 2

NOTES:

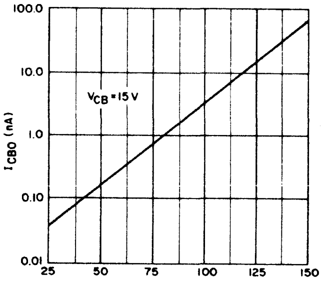
(1) COAX PLUMBING CONSIST OF THE FOLLOWING GR AIR LINES:
- 2 TYPE 874 TEE
- 1 TYPE 874-D20 ADJUSTABLE STUB
- 1 TYPE 874-LA ADJUSTABLE STUB
- 1 TYPE 874-WN3 SHORT-CIRCUIT TERMINATION

(2) 2 TURNS #16 AWG WIRE, 3/8 INCH OD, 1 1/4 INCH LONG

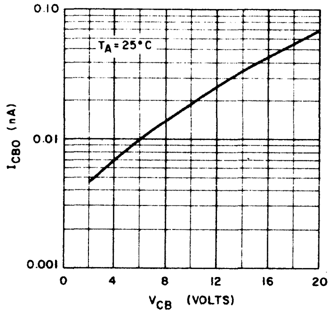
(3) 9 TURNS #22 AWG WIRE, 3/16 INCH OD, 1/2 INCH LONG

TYPICAL ELECTRICAL CHARACTERISTICS

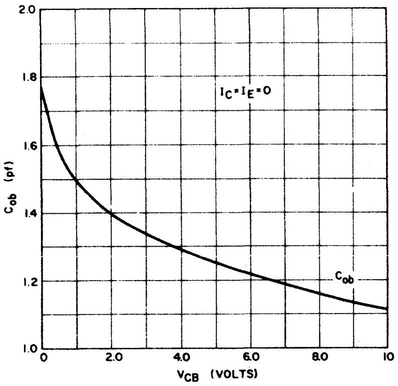
Collector-Base Diode Reverse Current vs Temperature



Collector-Base Diode Reverse Current vs Voltage

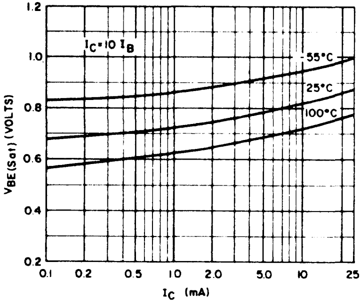


Output Capacitance vs Reverse Bias Voltage

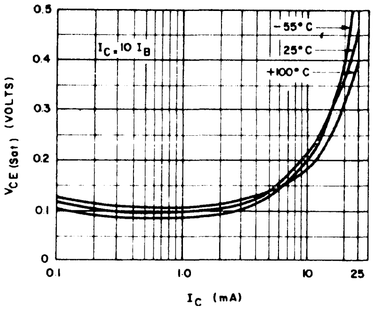


TYPICAL ELECTRICAL CHARACTERISTICS

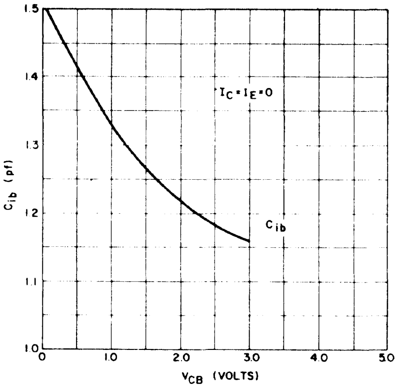
Base Saturation Voltage vs Collector Current



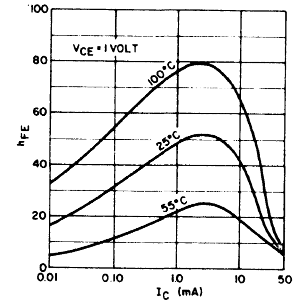
Collector Saturation Voltage vs Collector Current



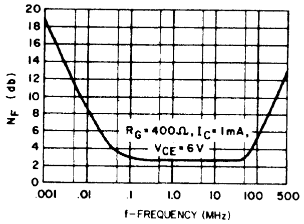
Input Capacitance vs Reverse Bias Voltage



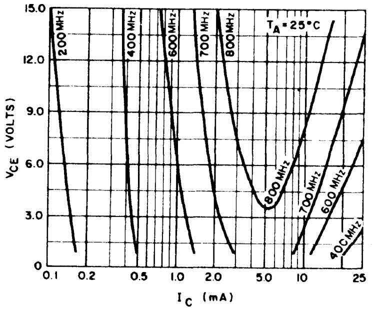
Pulsed DC Current Gain vs Collector Current



Noise Figure vs Frequency

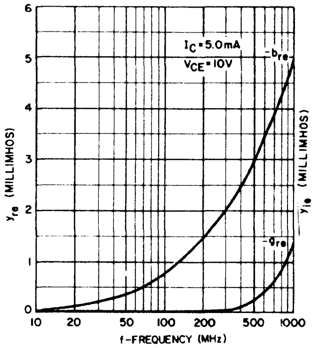


Contours of Constant Gain Bandwidth Product (f_T)

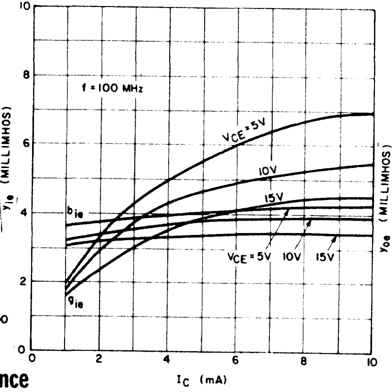


TYPICAL SMALL SIGNAL PARAMETERS

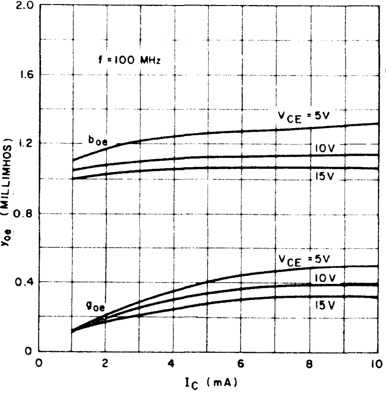
Reverse Transfer Admittance vs Frequency — Input Short Circuit



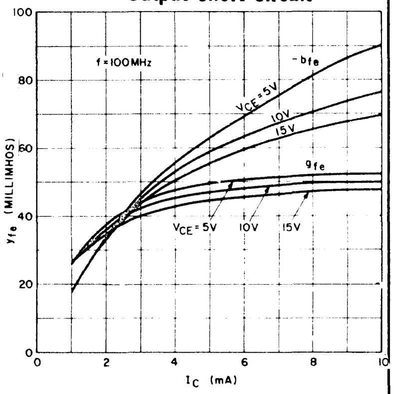
Input Admittance vs Collector Current — Output Short Circuit



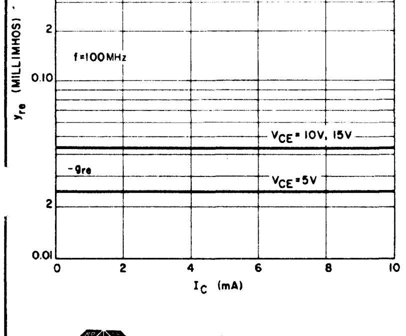
Output Admittance vs Collector Current — Input Short Circuit



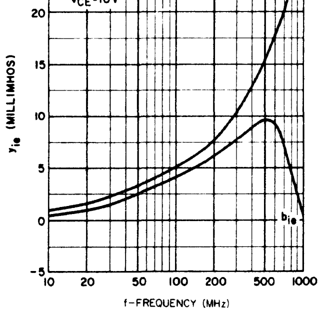
Forward Transfer Admittance vs Collector Current — Output Short Circuit



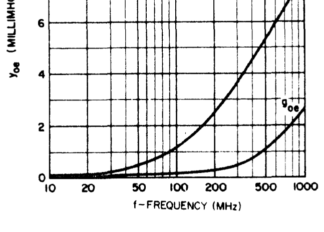
Reverse Transfer Admittance vs Collector Current — Input Short Circuit



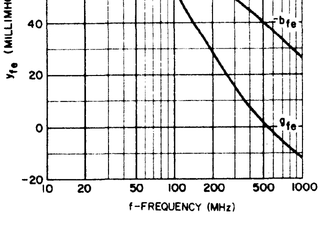
Input Admittance vs Frequency — Output Short Circuit



Output Admittance vs Frequency — Input Short Circuit



Forward Transfer Admittance vs Frequency — Output Short Circuit



JANUARY 1968

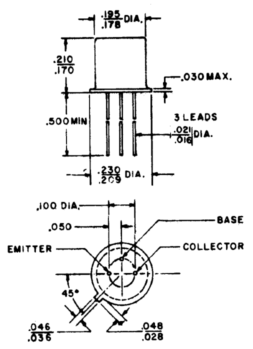
NPN TRANSISTOR
RF/IF AMPLIFIER

- **HIGH FREQUENCY**
- **LOW SATURATION VOLTAGE**
- **FAST SWITCHING SPEEDS**

2N2369A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	40	Volts
Collector-Emitter Voltage	V_{CES}	40	Volts
Collector-Emitter Voltage	V_{CEO}	15	Volts
Emitter-Base Voltage	V_{EBO}	4.5	Volts
Collector Current	I_C	200	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.36 1.2 0.68	Watt
Derating Factor Above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.1 6.85	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$, $I_B = 0$	40		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 10$ mA, $I_B = 0$	15		Volts
Collector-Emitter Voltage	BV_{CES}	$I_C = 10\ \mu A$, $I_B = 0$	40		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A$, $I_C = 0$	4.5		Volts
Base Current	I_B	$V_{CE} = 20$ V, $V_{BE} = 0$		−0.4	μA
Collector-Emitter Cutoff Current	I_{CES}	$V_{CE} = 20$ V, $V_{BE} = 0$		0.4	μA
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1$ mA $I_C = 30$ mA, $I_B = 3$ mA $I_C = 100$ mA, $I_B = 10$ mA $I_C = 10$ mA, $I_B = 1$ mA $T_A = 125°C$		0.2 0.25 0.5 0.3	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1$ mA $I_C = 30$ mA, $I_B = 3$ mA $I_C = 100$ mA, $I_B = 10$ mA $I_C = 10$ mA, $I_B = 1$ mA $T_A = 125°C$ $I_C = 10$ mA, $I_B = 1$ mA $T_A = -55°C$	0.7 0.59 	0.85 1.15 1.6 1.02	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 20$ V, $I_E = 0$ $V_{CB} = 20$ V, $T_A = 150°C$		0.4 30	μA
DC Pulse Current Gain	h_{FE}*	$I_C = 10$ mA, $V_{CE} = 0.35$ V $I_C = 10$ mA, $V_{CE} = 0.35$ V, $T_A = -55°C$ $I_C = 100$ mA, $V_{CE} = 1.0$ V $I_C = 30$mA, $V_{CE} = 0.4$ V	40 20 20 20	 120	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 10$ mA, $V_{CE} = 10$ V, f = 100 MHz	5		
Output Capacitance	C_{ob}	$V_{CB} = 5$ V, $I_E = 0$, f = 140 kHz		4	pf
Storage Time	$t_s(\tau_s)$	$I_C = I_{B1} = I_{B2} = 10$ mA (See Figure 1)		13	nsec
Turn-On Time	t_{on}	$I_C = 10$ mA, $I_{B1} = 3$ mA, $V_{CC} = 3$ V, $V_{OB} = 1.5$ V (See Figure 2)		12	nsec
Turn-Off Time	t_{off}	$I_C = 10$ mA, $I_{B1} = 3$ mA, $I_{B2} = 1.5$ mA, $V_{CC} = 3$ V (See Figure 2)		18	nsec

* Pulse Test: Pulse Width = 300 μsec, Duty Cycle = 2%

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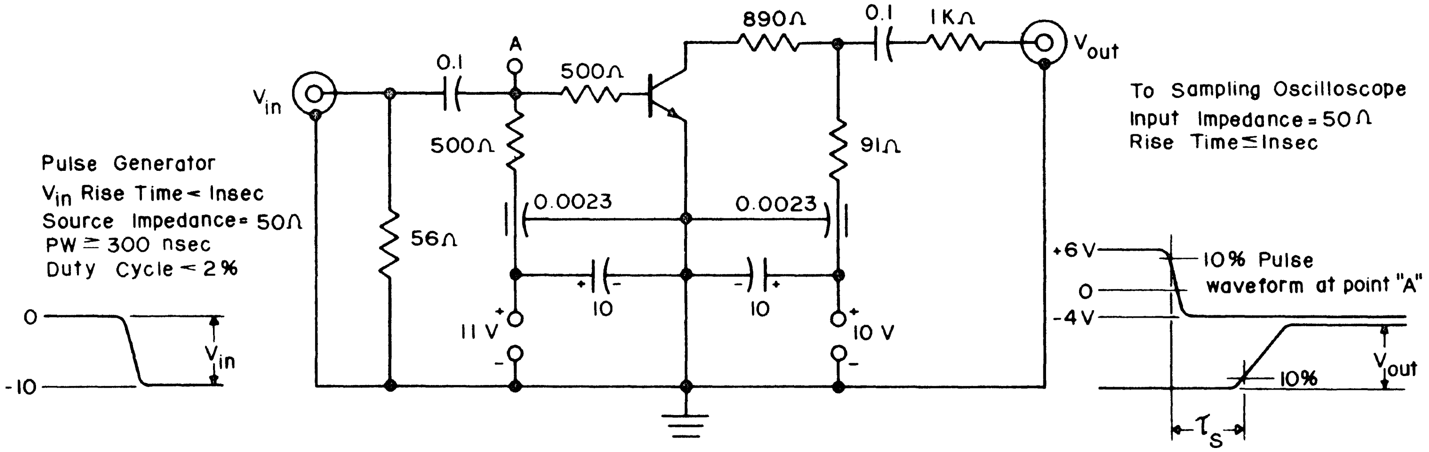


FIGURE 1

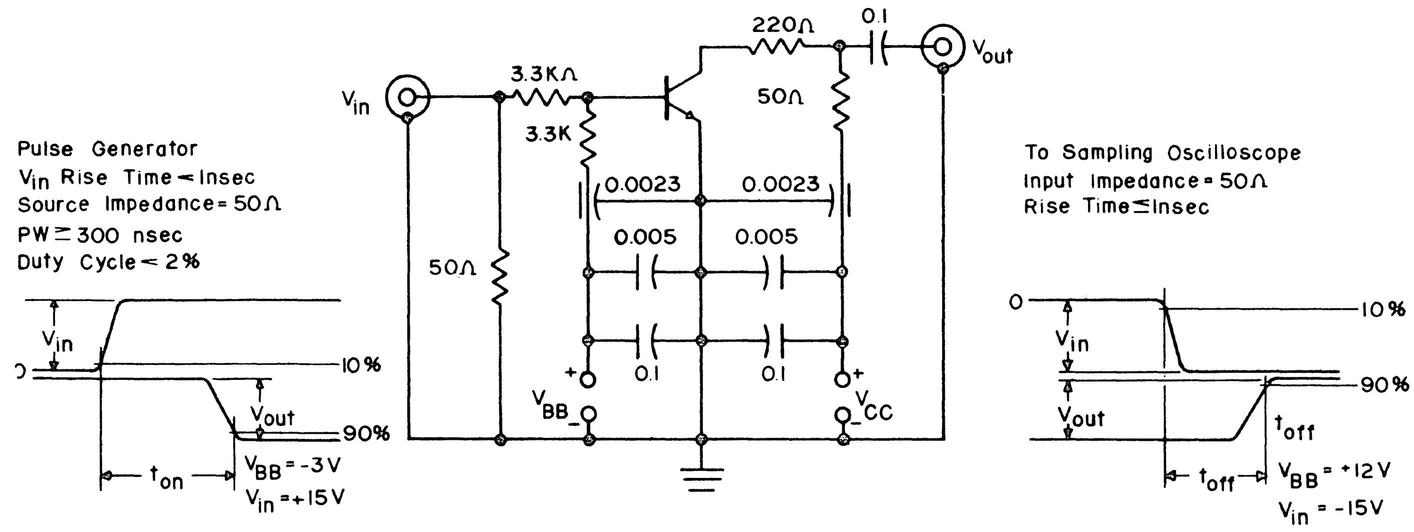


FIGURE 2

NPN TRANSISTOR
RF/IF AMPLIFIER

- HIGH FREQUENCY
- LOW LEAKAGE
- HIGH POWER GAIN

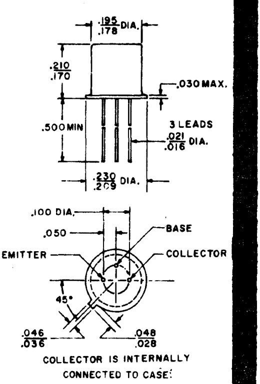
JANUARY 1968

2N2616
2N2729

MAXIMUM RATINGS

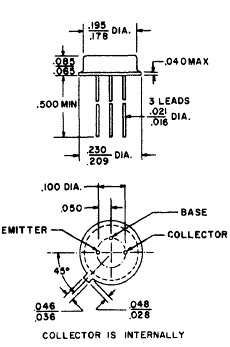
CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	30	Volts
Collector-Emitter Voltage	V_{CEO}	15	Volts
Emitter-Base Voltage	V_{EBO}	3.0	Volts
Collector Current	I_C	50	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 0.3 0.8	Watts
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 2.1 4.56	mW/°C
Storage Temperature	T_{stg}	−65 to +300	°C
Junction Temperature	T_J	+200	°C

2N2616



COLLECTOR IS INTERNALLY CONNECTED TO CASE.

2N2729



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 1.0\ \mu A, I_E = 0$	30		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	3.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 3.0$ mA, $I_B = 0$	15		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		0.4	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = 15$ V $I_E = 0, V_{CB} = 15$ V, $T_A = 150°C$		1.0 1.0	nA μA
DC Pulsed Current Gain	h_{FE}*	$I_C = 3.0$ mA, $V_{CE} = 1.0$ V	20		
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 4.0$ mA, $V_{CE} = 10$ V f = 100 MHz	6.0		
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = 10$ V f = 140 kHz		2.8	pf
Input Capacitance	C_{ib}	$I_C = 0, V_{BE} = 0.5$ V f = 140 kHz		2.0	pf
Available Power Gain (See Figure 1)	A_p	$I_C = 6.0$ mA, $V_{CE} = 12$ V f = 200 MHz (Figure 1)	15		db
Power Output (See Figure 2)	P_o	$I_C = 8.0$ mA, $V_{CE} = 15$ V f = 500 MHz (Figure 2)	30		mW
Noise Figure	NF	f = 60 MHz Source resistance = 400 Ω $I_C = 1.0$ mA, $V_{CE} = 6.0$ V		6.0	db
Collector Efficiency	η	$I_C = 8.0$ mA, $V_{CB} = 15$ V f = 500 MHz	25		%

*Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%

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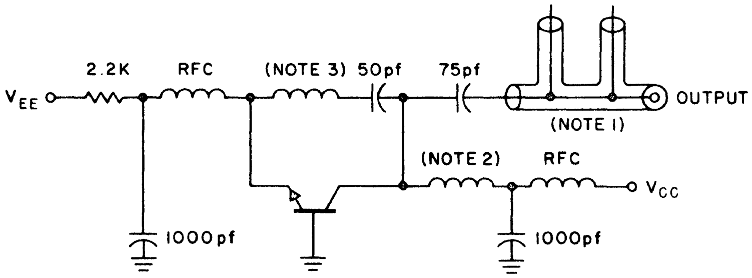
500 MHz OSCILLATOR TEST CIRCUIT



Notes:

(1) Coax plumbing consists of the following GR air lines:
- 2 Type 874 TEE
- 1 Type 874 - D20 Adjustable Stub
- 1 Type 874 - LA Adjustable Line
- 1 Type 874 - WN3 Short-Circuit Termination

(2) 2 turns #16 AWG wire, 3/8 inch OD, 1-1/4 inch long

(3) 9 turns #22 AWG wire, 3/16 inch OD, 1/2 inch long

NPN TRANSISTOR
RF/IF AMPLIFIER

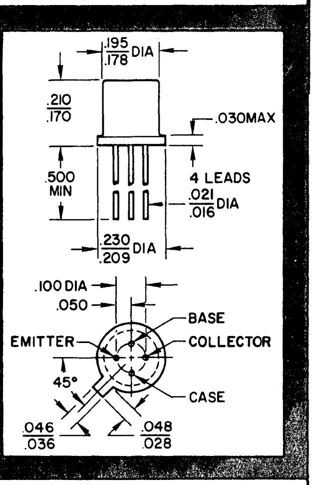
- **HIGH FREQUENCY**
- **HIGH POWER GAIN**
- **LOW CAPACITANCE**

JANUARY 1968

2N2708

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	35	Volts
Collector-Emitter Voltage	V_{CEO}	20	Volts
Emitter-Base Voltage	V_{EBO}	3.0	Volts
Collector Current	I_C	Limited by P_D only	
Total Device Dissipation $T_A = 25°C$	P_D	0.2	Watts
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Derating Factor above 25°C @ $T_A = 25°C$		1.14	mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 1.0\ \mu A$, $I_E = 0$	35		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	3.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 3.0$ mA, $I_B = 0$	20		Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 15$ V $I_E = 0$, $V_{CB} = 15$ V, $T_A = 150°C$		10 10	nA μA
DC Current Gain	h_{FE}	$I_C = 2.0$ mA, $V_{CE} = 2.0$ V	30	200	
Small Signal Current Gain	h_{fe}	$I_C = 2.0$ mA, $V_{CE} = 15$ V f = 1 kHz	30	180	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 2.0$ mA, $V_{CE} = 15$ V f = 100 MHz	7.0	12	
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 15$ V f = 140 kHz		1.5	pf
Collector-Base Time Constant	$r_b'C_c$	$I_C = 2.0$ mA, $V_{CB} = 15$ V f = 31.9 MHz, 4th Lead = gnd	15	33	psec
Available Power Gain Neutralized	G_{pe}	$I_C = 2.0$ mA, $V_{CE} = 15$ V f = 200 MHz (Figure 1)	15	22	db
Noise Figure	NF	Source Resistance 50Ω $I_C = 2.0$ mA, $V_{CE} = 15$ V f = 200 MHz		8.5	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

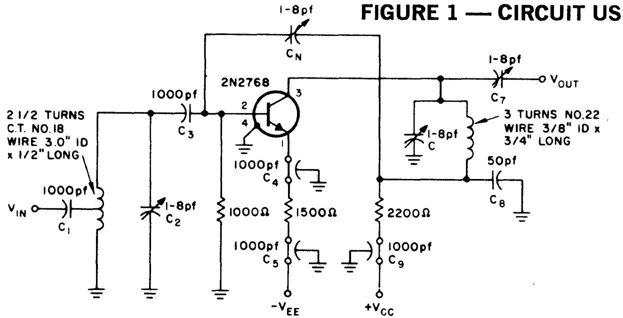


FIGURE 1 — CIRCUIT USED TO MEASURE POWER GAIN AT 200 MHz

NOTE 1 (Neutralization Procedure): (a) Connect a 200 MHz signal generator (with Z_{OUT} = 50 ohms) to the input terminals of the amplifier. (b) Connect a 50-ohm r-f voltmeter across the output terminals of the amplifier. (c) Apply V_{EE} and V_{CC}, and with the signal generator adjusted for 10 mV output, tune C_2, C_6, and C_7 for maximum output. (d) Interchange the connections to the signal generator and the output indicator. (e) With sufficient signal applied to the output terminals of the amplifier, adjust C_N for a minimum indication at the input. (f) Repeat steps (a), (b), and (c) to determine if retuning is necessary.

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NPN TRANSISTOR
RF/IF AMPLIFIER

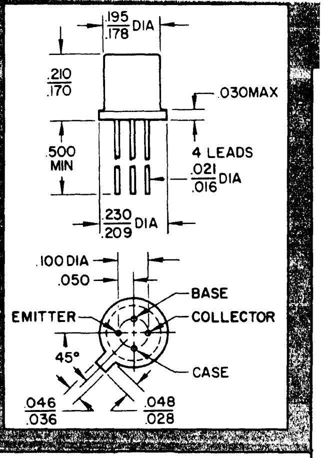
- HIGH POWER GAIN
- HIGH FREQUENCY
- LOW SATURATION VOLTAGE

JANUARY 1968

2N2865

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	25	Volts
Collector-Emitter Voltage	V_{CEO}	13	Volts
Emitter-Base Voltage	V_{EBO}	3.0	Volts
Collector Current	I_C	50	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	0.2 0.3	Watts
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Derating Factor above 25°C @ $T_A = 25°C$		1.14	mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 1.0\ \mu A$, $I_E = 0$	25		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	3.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 4.0$ mA, $I_B = 0$	13		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		0.4	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 15$ V $I_E = 0$, $V_{CB} = 15$ V, $T_A = 150°C$		10 1.0	nA μA
DC Current Gain	h_{FE}	$I_C = 4.0$ mA, $V_{CE} = 10$ V	20	200	
Small Signal Current Gain	h_{fe}	$I_C = 4.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	20	200	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 4.0$ mA, $V_{CE} = 10$ V f = 200 MHz	3.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 10$ V f = 1 MHz		2.5	pf
Collector-Base Time Constant	$r_b'C_c$			15	psec
Neutralized Small-Signal Power Gain	G_{pe}	$I_C = 4.0$ mA, $V_{CE} = 10$ V f = 200 MHz (Figure 1)	16.5		db
Unneutralized Small-Signal Power Gain	G_{pe}	$I_C = 4.0$ mA, $V_{CE} = 10$ V f = 200 MHz (Figure 2)	10		db
Power Output	P_o	$I_E = -12$ mA, $V_{CB} = 10$ V f = 500 MHz (Figure 3)	40		mW
Spot Noise Figure	NF	f = 200 MHz Source resistance = 75Ω $I_E = 1.5$ mA, $V_{CB} = 10$ V		4.5	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

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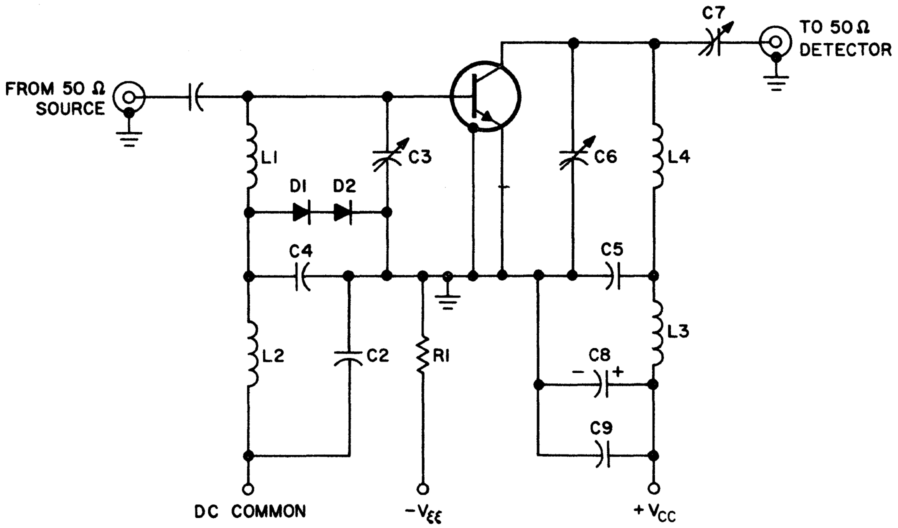
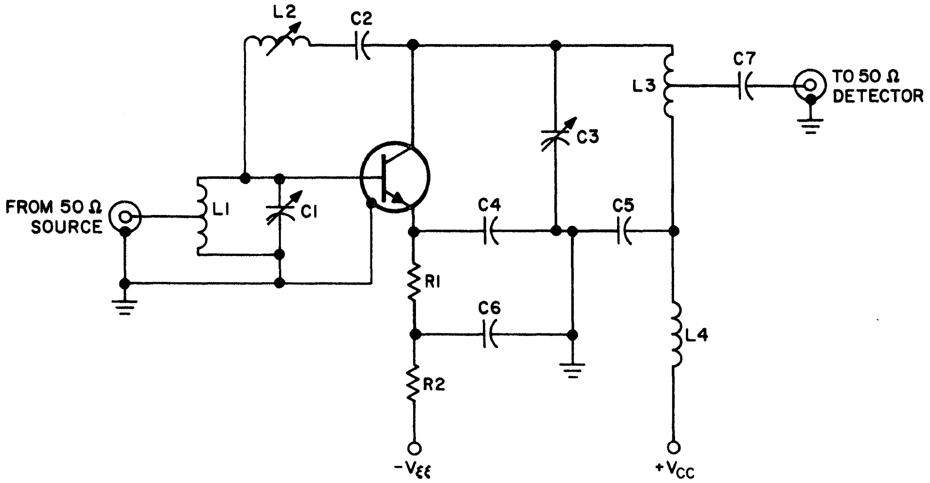


CIRCUIT COMPONENT INFORMATION

C1, C2, and C9: 0.05 μf
C3: 1.5—10 pf
C4 and C5: 1000 pf
C6 and C7: 3—15 pf
C8: 25 μf
R1: 2.2 kΩ
L1: 1 T #12 AWG, 2 cm ID'
L2 and L3: 200 MHz RFC
L4: ½ T #12 AWG, 3 cm ID
D1 and D2: 1N2070

FIGURE 1 – NEUTRALIZED 200 MHz INSERTION POWER GAIN TEST CIRCUIT



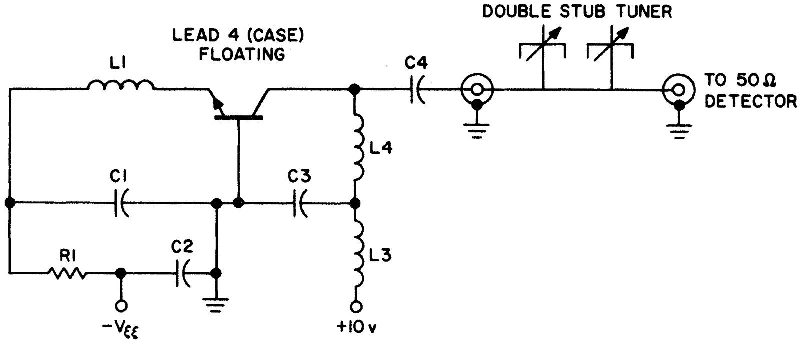
NEUTRALIZATION ADJUSTMENT PROCEDURE

After tuning amplifier as for normal gain measurement, reverse input and output connections and tune L2 for minimum indication on detector.

CIRCUIT COMPONENT INFORMATION

C1: 3—12 pf
C2: 1000 pf
C3: 1.5—7.5 pf
C4 and C5: 0.01 μf
C6: 0.05 μf
C7: 0.001 μf
R1: 100 Ω
R2: 1 kΩ
L1: 3½ T #16 AWG, 5/16" ID, 1" length, Turns Ratio ≈ 3½ to 3
L2: 0.4—1.0 μh, Q $\geq$ 75
L3: 8 T #16 AWG, ⅛" ID, ⅞" length, Turns Ratio ≈ 8 to 1
L4: 200 MHz RFC

FIGURE 2 – UNNEUTRALIZED 200 MHz INSERTION POWER GAIN TEST CIRCUIT



CIRCUIT COMPONENT INFORMATION

C1, C2 and C3: 1000 pf
C4: 250 pf
R1: 2.2 kΩ
L1: 7 T #22 AWG, ⅛" ID, ½" length
L2: 3¾ T #18 AWG, ½" ID, ¾" length
L3: 500 MHz RFC
Double Stub Tuner: Weinschel DS 109L (or equivalent)

FIGURE 3 – 500 MHz OSCILLATOR POWER OUTPUT TEST CIRCUIT

NPN TRANSISTOR
RF/IF AMPLIFIER

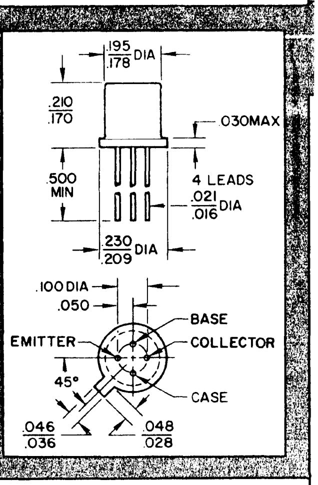
- HIGH FREQUENCY
- LOW SATURATION VOLTAGE
- LOW CAPACITANCE

JANUARY 1968

2N3289
2N3290

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	2N3289 2N3290	UNIT
Collector-Base Voltage	V_{CBO}	30	Volts
Collector-Emitter Voltage	V_{CES}	30	Volts
Collector-Emitter Voltage	V_{CEO}	15	Volts
Emitter-Base Voltage	V_{EBO}	3.0	Volts
Collector Current	I_C	50	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 200 300	 mW
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 1.14 1.71	 mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	30		Volts
Collector-Emitter Breakdown Voltage	BV_{CES}	$I_C = 10\ \mu A, V_{BE} = 0$	30		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 2.0$ mA, $I_B = 0$	15		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A, I_C = 0$	3.0		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 5$ mA, $I_B = 0.5$ mA		0.4	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 5$ mA, $I_B = 0.5$ mA		1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 15$ V		.010	μA
DC Current Gain	h_{FE}	$V_{CE} = 10$ V, $I_C = 2$ mA	10	150	
Small Signal Current Gain	h_{fe}	$V_{CE} = 10$ V, $I_C = 2$ mA f = 1 kHz	10	200	
Output Capacitance	C_{ob}*	$V_{CB} = 10$ V, $I_E = 0$ f = 0.1 MHz		1.5	pf
Collector-Base Time Constant	$r_b'C_c$	$V_{CB} = 10$ V, $I_C = 2$ mA f = 31.8 MHz	3	20	psec
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 2$ mA, $V_{CE} = 10$ V f = 100 MHz	3.0	12	
Maximum Frequency of Oscillation	f_{max}	$V_{CE} = 10$ V, $I_C = 2$ mA	2000 (Typ)		MHz
Power Gain	G_e	$V_{CE} = 10$ V, $I_C = 2$ mA f = 200 MHz	17	24	db
Power Gain (AGC) 2N3289	G_e**	$V_{CE} = 5$ V, $I_C = 20$ mA f = 200 MHz		 +5	 db
Noise Figure	NF	$V_{CE} = 10$ V, $I_C = 2$ mA f = 200 MHz		7.0	db

*C_{ob} is measured in guarded circuit such that the can capacitance is not included.
**AGC is obtained by increasing I_C. The circuit remains adjusted for $V_{CE} = 10$ Vdc, $I_C = 2$ mAdc operation.

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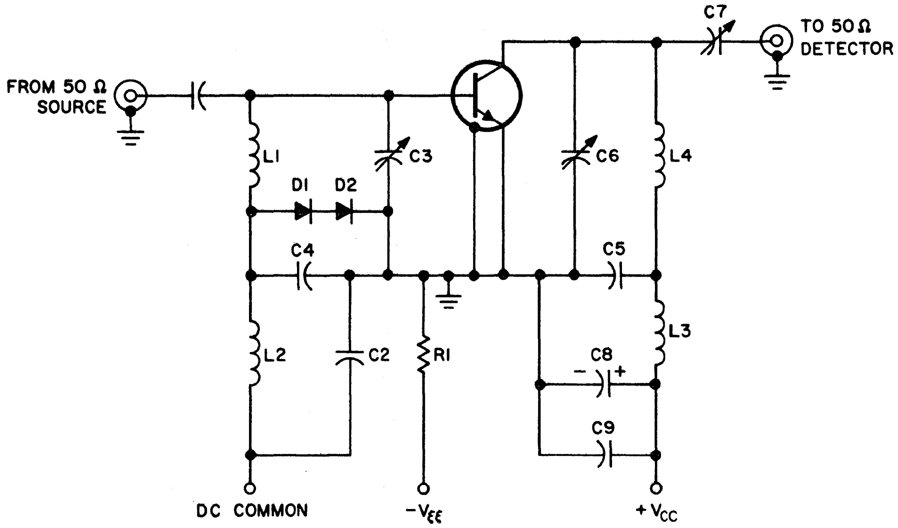


CIRCUIT COMPONENT INFORMATION

C1, C2, and C9: 0.05 μf
C3: 1.5—10 pf
C4 and C5: 1000 pf
C6 and C7: 3—15 pf
C8: 25 μf
R1: 2.2 kΩ
L1: 1 T #12 AWG, 2 cm ID
L2 and L3: 200 MHz RFC
L4: ½ T #12 AWG, 3 cm ID
D1 and D2: 1N2070

FIGURE 1 – NEUTRALIZED 200 MHz INSERTION POWER GAIN TEST CIRCUIT

NPN TRANSISTOR
RF/IF AMPLIFIER

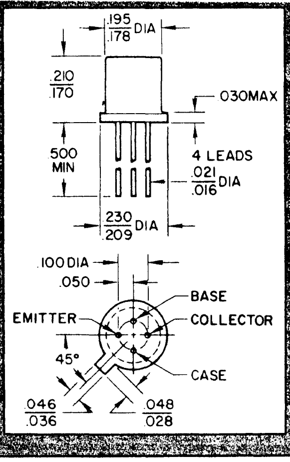
- **HIGH FREQUENCY**
- **HIGH POWER GAIN**
- **LOW CAPACITANCE**

JANUARY 1968

2N3291
THRU
2N3294

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	2N3291 2N3292	2N3293 2N3294	UNIT
Collector-Base Voltage	V_{CBO}	25	20	Volts
Collector-Emitter Voltage	V_{CES}	25	20	Volts
Emitter-Base Voltage	V_{EBO}	3.0	3.0	Volts
Collector Current	I_C	50	50	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$	P_D	 200 300	 200 300	 mW
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		 1.14 1.71	 1.14 1.71	 mW/°C
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200	+200	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Emitter Breakdown Voltage 2N3291, 2N3292 2N3293, 2N3294	BV_{CES}	$I_C = 25\ \mu A, V_{BE} = 0$	 25 20		 Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 10\ V, I_E = 0$		0.1	μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 0.5\ V, I_C = 0$		100	μA
DC Current Gain	h_{FE}	$V_{CE} = 10\ V, I_C = 2\ mA$	10		
Small Signal Current Gain	h_{fe}	$V_{CE} = 10\ V, I_C = 2\ mA$ $f = 1\ kHz$	10	200	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$V_{CE} = 10\ V, I_C = 2\ mA$ $f = 100\ MHz$	2.5	12	
Output Capacitance	C_{ob}*	$V_{CB} = 10\ V, I_E = 0$ $f = 100\ kHz$*		2.0	pf
Collector-Base Time Constant	$r_b'C_c$	$V_{CB} = 10\ V, I_C = 2\ mA$ $f = 31.8\ MHz$		30	psec
Maximum Frequency of Oscillation	f_{max}	$V_{CE} = 10\ V, I_C = 2\ mA$	2000 (Typ)		MHz
Power Gain 2N3291, 2N3292 2N3294	G_e	$I_C = 2\ mA, V_{CE} = 10\ V$ $f = 200\ MHz$ (Figure 1)	 16 14		 db
Noise Figure 2N3291 2N3292 2N3294	NF	$I_C = 2\ mA, V_{CE} = 10\ V$ $f = 200\ MHz$ (Figure 1)	 8 (Typ) 9 (Typ) 7 (Typ)		 db
Power Gain 2N3293	P_o	$V_{EE} = -11\ V, f = 257\ MHz$ (Figure 2)	 2.0		 db

* C_{ob} is measured in guarded circuit such that the can capacitance is not included.

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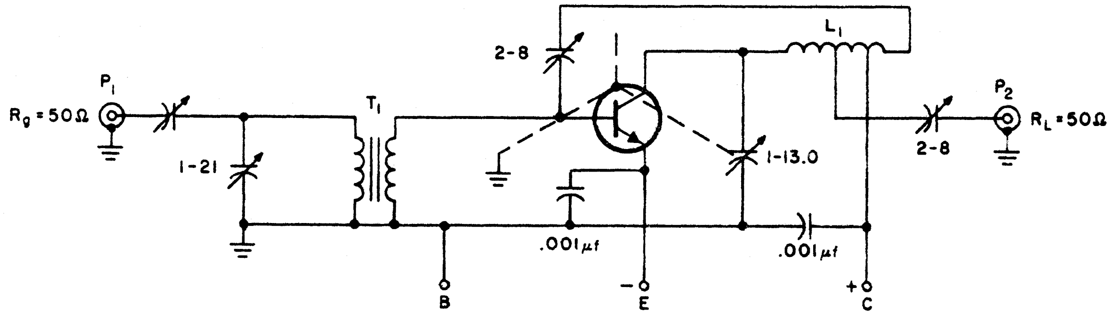
FIGURE 1 — 200 MHz TEST CIRCUIT: POWER GAIN, NOISE FIGURE, & AGC



L_1 — 6 turns of #16 tinned wire; 3/8" ID; Air wound; winding length 3/4"; V_{CC} feeds tap 4-3/4 turns from collector end; output tap 3-1/2 turns from collector end.

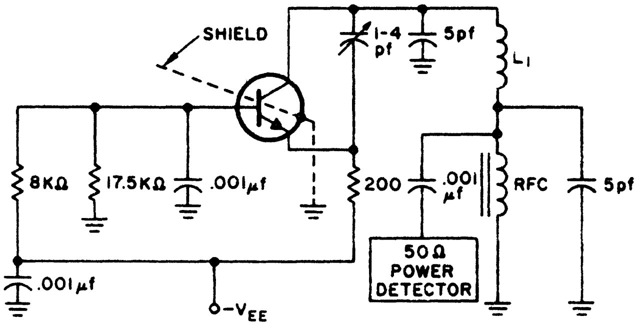
T_1 — 3 turns primary and secondary Bifilar wound (close wound) on 1/4" ceramic form Cambion type) with brass slug. #22 enameled wire.

P_1 — General Radio 874 G6 Pad (6 db)

P_2 — General Radio 874 G6 Pad (6 db)

Figure 1

FIGURE 2 — 257 MHz OSCILLATOR POWER OUTPUT TEST CIRCUIT



L_1 — 4 turns of #22 Nykland wire spaced for 257 mc coil form 7/32" center Cambion LST ceramic aircore

RFC — 4.5 μh, 24 turns #30 Nykland wire close wound 7/32" Cambion ceramic form

All capacitors are ceramic type

Figure 2

PNP TRANSISTOR
GENERAL PURPOSE

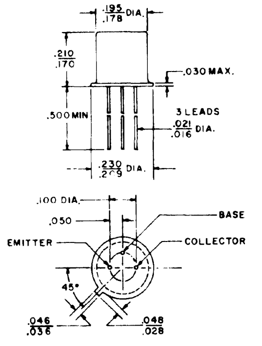
- HIGH FREQUENCY
- LOW SATURATION VOLTAGE
- LOW CAPACITANCE

JANUARY 1968

2N869

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	25	Volts
Collector-Emitter Voltage	V_{CEO}	18	Volts
Emitter-Base Voltage	V_{EBO}	5	Volts
Total Device Dissipation	P_D		
@ $T_A = 25°C$		0.36	Watts
@ $T_C = 25°C$		1.2	
@ $T_C = 100°C$		0.68	
Derating Factor above 25°C			
@ $T_A = 25°C$		2.1	
@ $T_C = 25°C$		6.85	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A,\ I_E = 0$	25		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A,\ I_C = 0$	5		Volts
Collector-Emitter Sustaining Voltage*	$V_{CEO(sust)}{}^*$	$I_C = 10\ mA,\ I_B = 0$	18		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10\ mA,\ I_B = 1.0\ mA$		1.0	Volt
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10\ mA,\ I_B = 1.0\ mA$		1.0	Volt
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 15\ V,\ I_E = 0$ $V_{CB} = 15\ V,\ I_E = 0,\ T_A = 150°C$		.010 25	μA
DC Pulse Current Gain	$h_{FE}{}^*$	$I_C = 10\ mA,\ V_{CE} = 5.0\ V$	20	120	
High Frequency Current Gain	$\vert h_{fe} \vert$	$I_C = 10\ mA,\ V_{CE} = 15\ V,\ f = 100\ MHz$	1.0		
Output Capacitance	C_{ob}	$V_{CB} = 10\ V,\ I_E = 0$		9	pf
Input Capacitance	C_{ib}	$V_{BE} = 0.5\ V,\ I_C = 0$		11	pf

*Pulse Test: Pulse Width = 300 μsec, Duty Cycle = 1%

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PNP TRANSISTOR
GENERAL PURPOSE

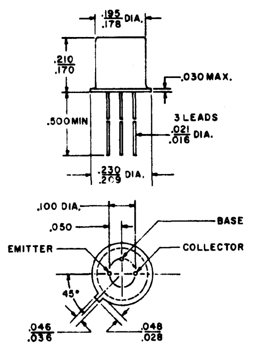
- LOW LEAKAGE
- LOW SATURATION VOLTAGE
- LOW NOISE

JANUARY 1968

2N995

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	−20	Volts
Collector-Emitter Voltage	V_{CEO}	−15	Volts
Emitter-Base Voltage	V_{EBO}	−4.0	Volts
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	 0.36 1.2 0.68	Watts
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Derating Factor above 25°C $T_A = 25°C$ $T_C = 25°C$		 2.06 6.86	mW/°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	−20		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	−4		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 10$ mA, $I_B = 0$	−15		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 20$ mA, $I_B = 2.0$ mA		0.2	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 20$ mA, $I_B = 2.0$ mA		0.95	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = -15$ V $I_E = 0, V_{CB} = -15$ V, $T_A = 150°C$		5.0 25.0	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = 4.0$ V		10	μA
DC Current Gain	$h_{FE}{}^*$	$I_C = 20$ mA, $V_{CE} = -1.0$ V $I_C = 50$ mA, $V_{CE} = -1.0$ V $I_C = 1.0$ mA, $V_{CE} = -1.0$ V	35 25 25	140	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 10$ mA, $V_{CE} = -10$ V f = 100 MHz	1.0		
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = -10$ V		10	pf
Input Capacitance	C_{ib}	$I_C = 0, V_{BE} = -0.5$ V		11	pf
Low Frequency Noise Figure	NF	f = 1 kHz Source resistance = 2 kΩ Equivalent noise power bandwidth = 200 Hz $I_C = 100\ \mu A, V_{CE} = 5.0$ V	6.0 Typ		db
100 MHz Oscillator Efficiency	η	$I_C = 10$ mA, $V_{CB} = -10$ V (Figure 1)	40		%

* Pulse Test: Pulse Width = 300 μs; Duty Cycle = 1%.

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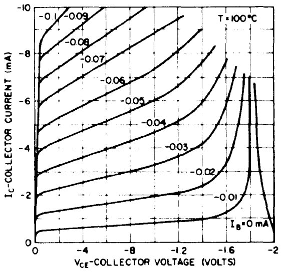
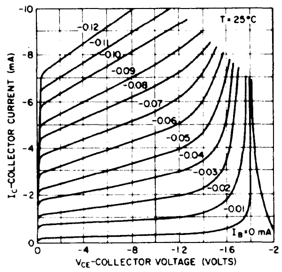
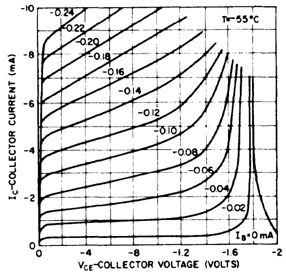
TYPICAL COLLECTOR AND BASE CHARACTERISTICS*

Active Region

Collector Characteristics

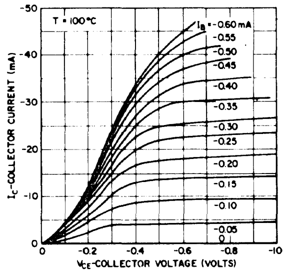


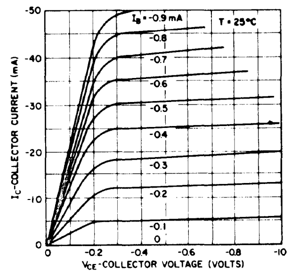


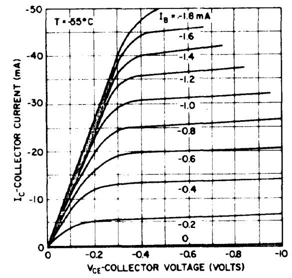


Saturation Region

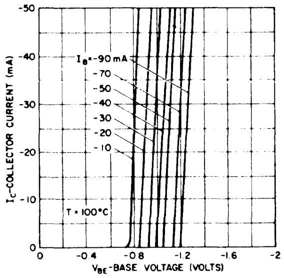
Collector Characteristics

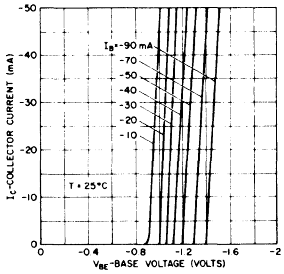


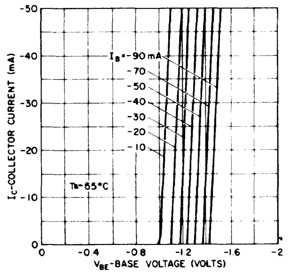




Base Characteristics

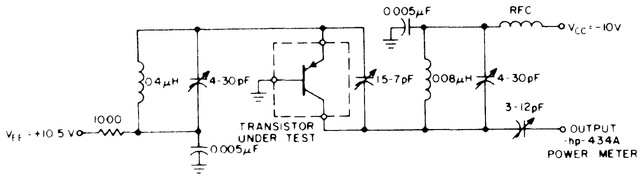






*Single family characteristics on transistor curve tracer.

Oscillator Efficiency Circuit (I_C = 10 mA, V_{CB} = -10V)



PNP TRANSISTOR
GENERAL PURPOSE

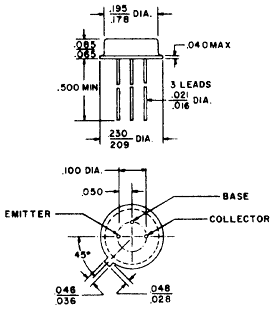
- HIGH BREAKDOWN VOLTAGE
- LOW SATURATION VOLTAGE
- LOW NOISE

JANUARY 1968

2N2601
2N2602
2N2603

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	−60	Volts
Collector-Emitter Voltage	V_{CEO}	−60	Volts
Emitter-Base Voltage	V_{EBO}	−6	Volts
Collector Current	I_C	−50	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.400	Watts
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Derating Factor above 25°C @ $T_A = 25°C$		2.28	mW/°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = -50\ \mu A, I_E = 0$	−60		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = -1$ mA, $I_B = 0$	−60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = -100\ \mu A$	−6		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = -10$ mA, $I_B = -1$ mA		−0.5	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = -10$ mA, $I_B = -1$ mA	−0.7	−0.9	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = -45$ V $I_E = 0, V_{CB} = -45$ V, $T_A = 150°C$		−25 −25	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = -5$ V		−5	nA
DC Current Gain	h_{FE}	$I_C = -1$ mA, $V_{CE} = -5$ V			
2N2601			12.5		
2N2602			25.0		
2N2603			50.0		
Small Signal Current Gain	h_{fe}	$I_E = 100\ \mu A, V_{CB} = -5$ V f = 1 kHz			
2N2601			12		
2N2602			25		
2N2603			50		
2N2601		$I_E = 1$ mA, $V_{CB} = -5$ V f = 1 kHz	18	90	
2N2602			36	90	
2N2603			76	333	
2N2601		$I_E = 10$ mA, $V_{CB} = -5$ V f = 1 kHz	25		
2N2602			50		
2N2603			100		
2N2601		$I_E = 10$ mA, $V_{CB} = -5$ V f = 1 kHz, $T_A = -55°C$	12		
2N2602			25		
2N2603			50		
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = -5$ mA, $V_{CE} = -5$ V f = 20 MHz			
2N2601			1.0		
2N2602			2.0		
2N2603			3.0		
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = -5$ V, f = 140 kHz		6.0	pf
Voltage Feedback Ratio	h_{rb}	$I_E = 1$ mA, $V_{CB} = -5$ V f = 1 kHz		10^{-3}	
Input Resistance	h_{ib}	$I_E = 1$ mA, $V_{CB} = -5$ V f = 1 kHz	25	35	ohms
Output Conductance	h_{ob}	$I_E = 1$ mA, $V_{CB} = -5$ V f = 1 kHz		1	μmhos
Real Part of Input Impedance	$Re(h_{ie})$	$I_E = 1$ mA, $V_{CE} = 5$ V f = 100 MHz		200	Ohms

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PNP TRANSISTOR
GENERAL PURPOSE

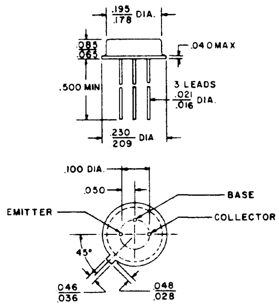
- LOW NOISE
- HIGH BREAKDOWN VOLTAGE
- HIGH CURRENT GAIN

JANUARY 1968

2N2604
2N2605

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	V_{CBO}	−60	Volts
Collector-Emitter Voltage	V_{CEO}	−45	Volts
Emitter-Base Voltage	V_{EBO}	−6.0	Volts
Collector Current	I_C	30	mA
Total Device Dissipation	P_D		
@ $T_A = 25°C$		0.4	Watts
@ $T_C = 25°C$		1.2	
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+175	°C
Derating Factor above 25°C			
@ $T_A = 25°C$		2.28	mW/°C
@ $T_C = 25°C$		6.9	



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A,\ I_E = 0$	−60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0,\ I_E = -10\ \mu A$	−6		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}^{*}$	$I_C = -10$ mA, $I_B = 0$	−45		Volts
Nonsaturated Base Voltage	V_{BE}	$I_C = -10$ mA, $I_B = -0.5$ mA	−0.7	−0.9	Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = -10$ mA, $I_B = -0.5$ mA		−0.5	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0,\ V_{CB} = -45$ V		−10	nA
Collector-Emitter Cutoff Current	I_{CES}	$V_{EB} = 0,\ V_{CE} = -45$ V $V_{EB} = 0,\ V_{CE} = -45$ V, $T_A = 170°C$		−10 −10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0,\ V_{EB} = -5$ V		−2	nA
DC Current Gain	h_{FE}				
2N2604		$I_C = -10\ \mu A,\ V_{CE} = -5$ V	40	120	
2N2605			100	300	
2N2604		$I_C = -500\ \mu A,\ V_{CE} = -5$ V	60		
2N2605			150		
2N2604		$I_C = -10\ \mu A,\ V_{CE} = -5$ V	10		
2N2605		$T_A = -55°C$	20		
2N2604		$I_C = -10$ mA, $V_{CE} = -5$ V		350	
2N2605				600	
Small Signal Current Gain	h_{fe}				
2N2604		$I_C = -1.0$ mA, $V_{CE} = -5$ V	60	350	
2N2605		f = 1 kHz	150	600	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = -0.5$ mA, $V_{CE} = -5$ V f = 30 MHz	1.0		
Output Capacitance	C_{ob}	$I_E = 0,\ V_{CB} = -5$ V f = 1 MHz		6	pf
Voltage Feedback Ratio	h_{rb}	$I_E = -1.0$ mA, $V_{CB} = -5$ V f = 1 kHz		10	$x10^{-4}$
Input Resistance	h_{ie}	$I_E = 1.0$ mA, $V_{CB} = -5$ V	25	35	ohms
Output Conductance	h_{oe}	$I_E = 1.0$ mA, $V_{CE} = -5$ V f = 1 kHz		1.0	μmhos

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Real Part of Input Impedance	$Re(h_{ie})$	$I_C = 1$ mA, $V_{CE} = -5$ V f = 100 MHz		200	ohms
Wideband Noise Factor	NF				
2N2604		f = 10 kHz		4	db
2N2605		Source resistance = 10 kΩ Equivalent noise power bandwidth = 15 kHz $I_C = -10$ μA, $V_{CE} = -5$ V		3	

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle ≤ 2%.

PNP TRANSISTOR
MEDIUM POWER

- LOW SATURATION VOLTAGE
- FAST SWITCHING SPEEDS
- HIGH BREAKDOWN VOLTAGE

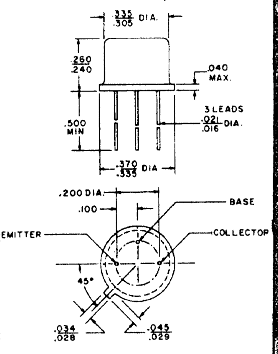
JANUARY 1968

2N2904
THRU
2N2907A

MAXIMUM RATINGS

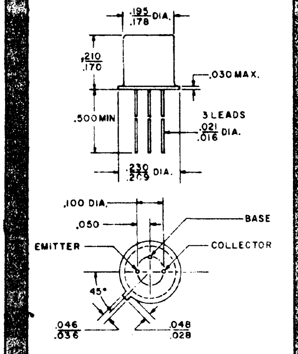
CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	60		Volts
Collector-Emitter Voltage	V_{CEO}			Volts
2N2904-2N2907,		40		
2N2904A, 2N2907A		60		
Emitter-Base Voltage	V_{EBO}	5		Volts
Collector Current	I_C	600		mA
		2N2904, A 2N2905, A	2N2906, A 2N2907, A	
Total Device Dissipation	P_D			
@ $T_A = 25°C$		0.6	0.4	Watts
@ $T_C = 25°C$		3.0	1.8	
Derating Factor above 25°C				
@ $T_A = 25°C$		3.43	2.28	mW/°C
@ $T_C = 25°C$		17.2	10.3	
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	−65 to +200		°C

2N2904, A
2N2905, A



COLLECTOR IS INTERNALLY CONNECTED TO CASE

2N2906, A
2N2907, A



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10$ A, $I_E = 0$	60		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}^*$				
2N2904 thru 2N2907,		$I_C = 10$ mA, $I_B = 0$	40		Volts
2N2904A thru 2N2907A,			60		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_B = 10$A, $I_C = 0$	5		Volts
Collector Saturation Voltage	$V_{CE(sat)}^*$	$I_C = 150$ mA, $I_B = 15$ mA		0.4	Volts
		$I_C = 500$ mA, $I_B = 50$ mA		1.6	
Base Saturation Voltage	$V_{BE(sat)}^*$	$I_C = 150$ mA, $I_B = 15$ mA		1.3	Volts
		$I_C = 500$ mA, $I_B = 50$ mA		2.6	
Collector-Base Cutoff Current	I_{CBO}				
2N2904 thru 2N2907,		$V_{CB} = 50$ V, $I_E = 0$		.020	μA
2N2904A thru 2N2907A,				.010	
2N2904 thru 2N2907,		$V_{CB} = 50$ V, $I_E = 0$, $T_A = 150°C$		20	
2N2904A thru 2N2907A,				10	
Base Cutoff Current	I_{BL}	$V_{CE} = 30$ V, $V_{BE} = 0.5$ V		50	nA
Collector-Emitter Cutoff Current	I_{CEX}	$V_{CE} = 30$ V, $V_{BE} = 0.5$ V		50	nA
DC Current Gain	h_{FE}				
2N2904, 2N2906,		$I_C = 0.1$ mA, $V_{CE} = 10$ V	20		
2N2905, 2N2907,			35		
2N2904A, 2N2906A,			40		
2N2905A, 2N2907A,			75		
2N2904, 2N2906,		$I_C = 1$ mA, $V_{CE} = 10$ V	25		
2N2905, 2N2907,			50		
2N2904A, 2N2906A,			40		
2N2905A, 2N2907A,			100		
2N2904, 2N2906,		$I_C = 10$ mA, $V_{CE} = 10$ V	35		
2N2905, 2N2907,			75		
2N2904A, 2N2906A,			40		
2N2905A, 2N2907A,			100		
2N2904, 2N2904A, 2N2906, 2N2906A,		$I_C = 150$ mA, $V_{CE} = 10$ V*	40	120	
2N2905, 2N2905A, 2N2907, 2N2907A			100	300	
2N2904, 2N2906,		$I_C = 500$ mA, $V_{CE} = 10$ V*	20		
2N2905, 2N2907,			30		
2N2904A, 2N2906A,			40		
2N2905A, 2N2907A,			50		

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Rise Time	t_r	$I_{CS} = 150$ mA, $I_{B1} = 15$ mA (Figure 1)		40	nsec
Delay Time	t_d	$I_{CS} = 150$ mA, $I_{B1} = 15$ mA (Figure 1)		10	nsec
Fall Time	t_f	$I_{CS} = 150$ mA, $I_{B1} = I_{B2} = 15$ mA (Figure 2)		30	nsec
Storage Time	t_s	$I_{CS} = 150$ mA, $I_{B1} = I_{B2} = 15$ mA (Figure 2)		80	nsec
Turn-On Time	t_{on}	$I_{CS} = 150$ mA, $I_{B1} = 15$ mA (Figure 1)		45	nsec
Turn-Off Time	t_{off}	$I_{CS} = 150$ mA, $I_{B1} = I_{B2} = 15$ mA (Figure 2)		100	nsec
Output Capacitance	C_{ob}	$V_{CE} = 10$ V, $I_E = 0$, f = 100 kHz		8	pf
Input Capacitance	C_{ib}	$V_{BE} = 2$ V, $I_C = 0$, f = 100 kHz		30	pf
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 50$ mA, $V_{CE} = 20$ V f = 100 MHz	2		

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle $\leq$ 2%.

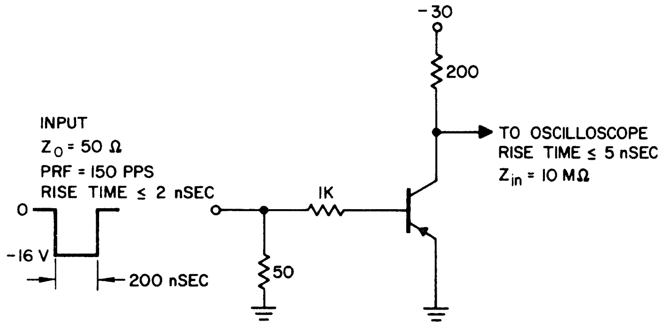


Figure 1. Test Circuit for Determining Delay Time and Rise Time

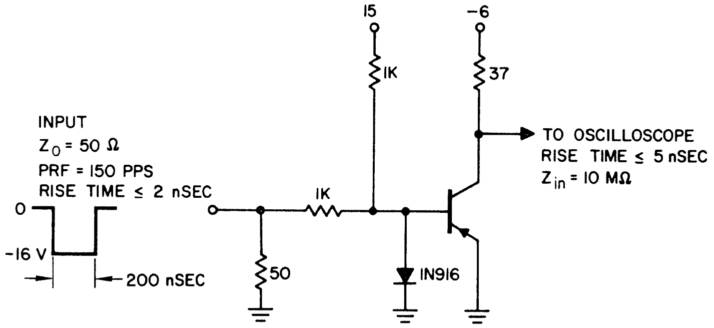


Figure 2. Test Circuit for Determining Storage Time and Fall Time

JANUARY 1968

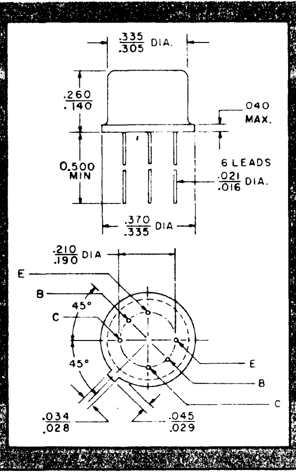
DUAL NPN TRANSISTOR
GENERAL PURPOSE

- CLOSELY MATCHED CURRENT GAIN
- VERY CLOSELY MATCHED, V_{BE}
- LOW DIFFERENTIAL DRIFT

2N2453
2N2453A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage 2N2453 2N2453A	V_{CBO}	60 80		Volts
Collector-Emitter Voltage 2N2453 2N2453A	V_{CEO}	30 50		Volts
Emitter-Base Voltage	V_{EBO}	7.0		Volts
		Each Side	Both Sides	
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 100°C$ @ $T_C = 25°C$	P_D	0.2 0.35 0.6	0.3 0.7 1.2	Watts
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200		°C
Derating Factor above 25°C 2N2453 2N2453A		1.14 1.71		mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage 2N2453 2N2453A	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$	60 80		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 0.1\ \mu A$	7.0		Volts
Collector-Emitter Sustaining Voltage 2N2453 2N2453A	$V_{CEO(sus)}$**	$I_C = 10$ mA, $I_B = 0$	30 60		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 5.0$ mA, $I_B = 0.5$ mA		1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 5.0$ mA, $I_B = 0.5$ mA		0.9	Volts
Collector-Base Cutoff Current 2N2453 2N2453A 2N2453 2N2453A	I_{CBO}	$I_E = 0$, $V_{CB} = 50$ V $I_E = 0$, $V_{CB} = 60$ V $I_E = 0$, $V_{CB} = 50$ V, $T_A = 150°C$ $I_E = 0$, $V_{CB} = 60$ V, $T_A = 150°C$		5.0 5.0 10 10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 5.0$ V		2.0	nA
DC Current Gain	h_{FE}	$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$ $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $T_A = -55°C$	80 40 150 75	 600	
DC Current Gain Ratio 2N2453A only Both Types Both Types	h_{FE1}/h_{FE2}*	$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $T_A = -55°C$ to $+125°C$	0.9 0.9 0.85	1.0 1.0 1.0	
Base Voltage Differential	$V_{BE1}-V_{BE2}$	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		5.0 3.0	mV

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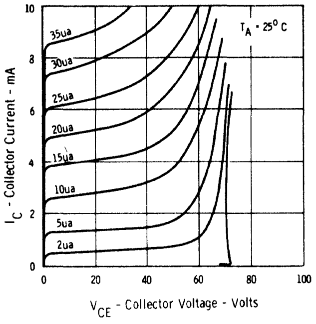
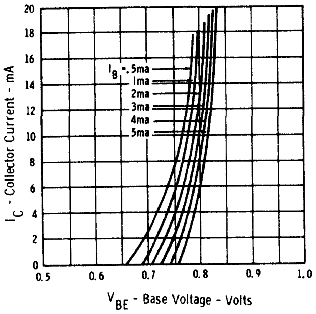
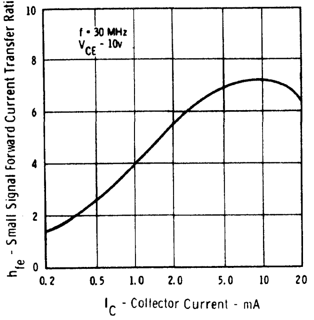
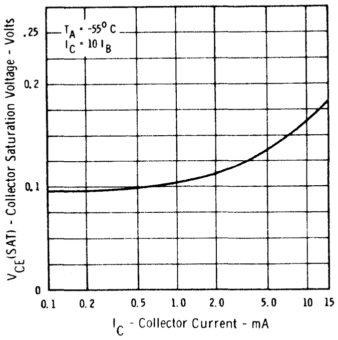
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Base Voltage Differential Drift 2N2453 2N2453A	$\Delta(V_{BE1}-V_{BE2})/\Delta T$	$I_C = 10\ \mu A, V_{CE} = 5.0\ V$ $T_A = -55°C$ to $+125°C$		10 5.0	μV/°C
Small Signal Current Gain	h_{fe}	$I_C = 1.0\ mA, V_{CE} = 5.0\ V$ f = 1 kHz	150	600	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 5.0\ mA, V_{CE} = 10\ V$ f = 30 MHz	2.0		
Output Capacitance 2N2453 2N2453A	C_{ob}	$I_E = 0, V_{CB} = 10\ V$ f = 140 kHz		8.0 4.0	pf
Input Capacitance	C_{ib}	$I_C = 0, V_{BE} = 0.5\ V$ f = 140 kHz		10	pf
Voltage Feedback Ratio	h_{rb}	$I_C = 1.0\ mA, V_{CE} = 5.0\ V$ f = 1 kHz		5.0	$x10^{-4}$
Reverse Voltage Feedback Ratio	h_{re}	$I_C = 1.0\ mA, V_{CE} = 5.0\ V$ f = 1 kHz		6.0	$x10^{-4}$
Input Resistance	h_{ib}	$I_C = 1.0\ mA, V_{CB} = 5.0\ V$ f = 1 kHz	20	30	ohms
Input Resistance	h_{ie}	$I_C = 1.0\ mA, V_{CE} = 5.0\ V$ f = 1 kHz		5.0	kΩ
Output Conductance	h_{ob}	$I_C = 1.0\ mA, V_{CB} = 5.0\ V$ f = 1 kHz		0.2	μmhos
Output Conductance	h_{oe}	$I_C = 1.0\ mA, V_{CB} = 5.0\ V$ f = 1 kHz	5.0	30	μmhos
Low Frequency Noise Figure 2N2453 2N2453A	NF	f = 1 kHz Source resistance = 10 kΩ Equivalent noise power bandwidth = 200 Hz $I_C = 10\ \mu A, V_{CE} = 5.0\ V$		7.0 4.0	db

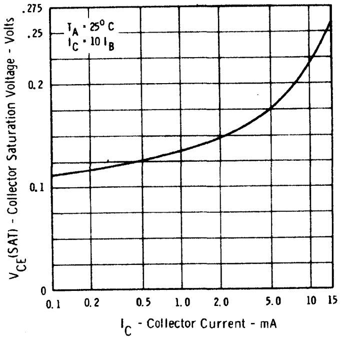
* The lower of the h_{FE} readings is taken as h_{FE1}.
** Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

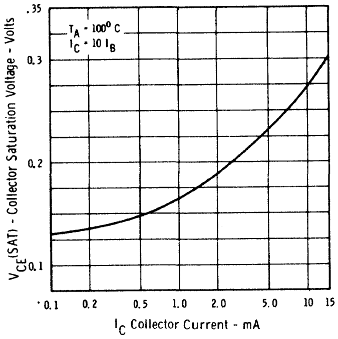

Collector Characteristics


Typical Base Characteristics

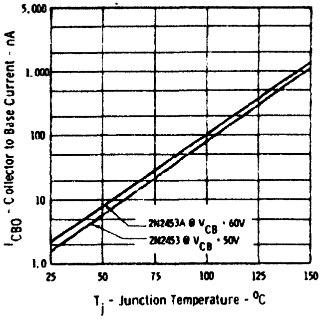

Small Signal Current Gain at 30 MHz Versus Collector Current


Collector Saturation Voltage Versus Collector Current

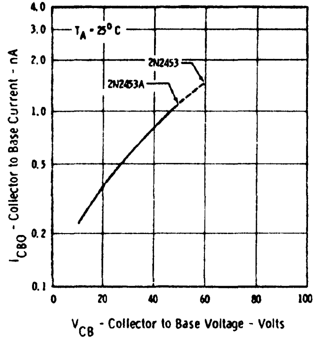

Collector Saturation Voltage Versus Collector Current


Collector Saturation Voltage Versus Collector Current

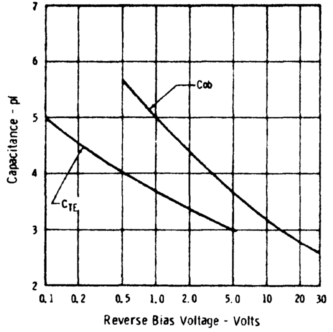
Collector - Base Diode Reverse Current versus Temperature



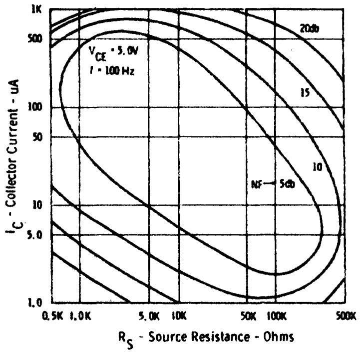
Collector - Base Diode Reverse Current Versus Voltage



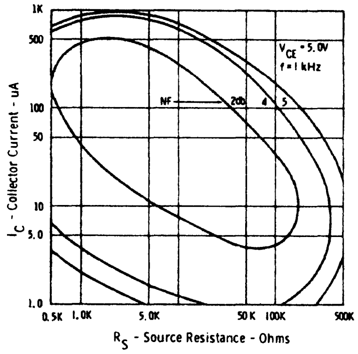
Collector and Emitter Transition Capacitance Versus Reverse Bias Voltage



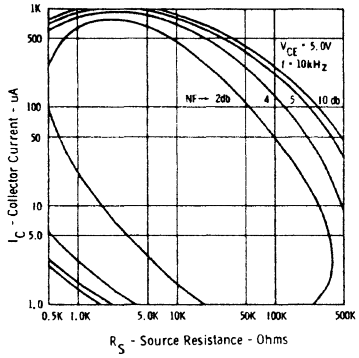
Noise Figure at 100 Hz



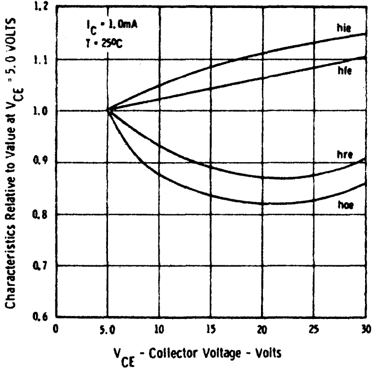
Noise Figure at 1 kHz



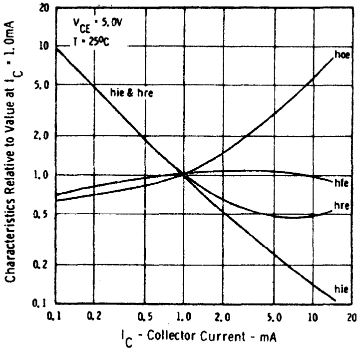
Noise Figure at 10 kHz



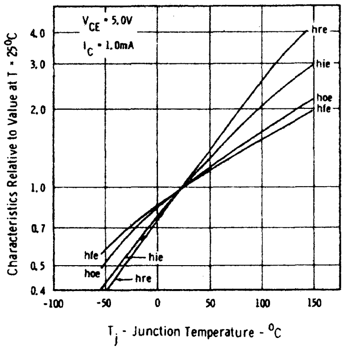
Typical Common Emitter Characteristics



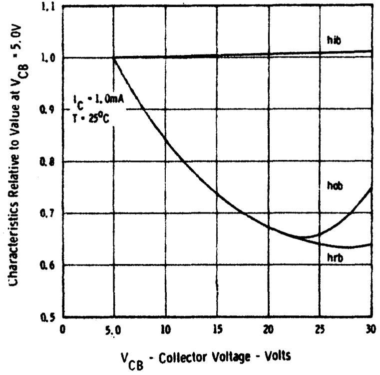
Typical Common Emitter Characteristics



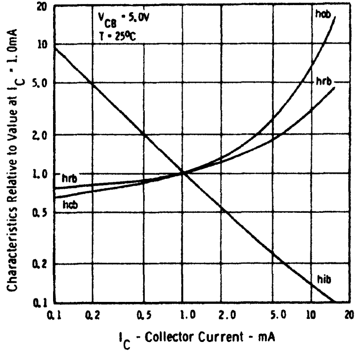
Typical Common Emitter Characteristics



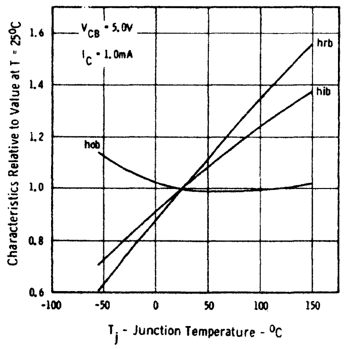
Typical Common Base Characteristics

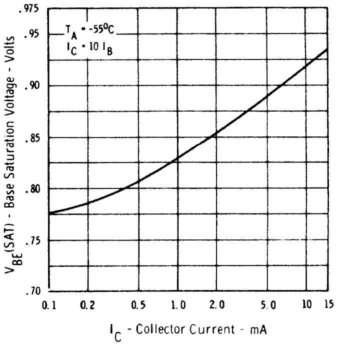


Typical Common Base Characteristics

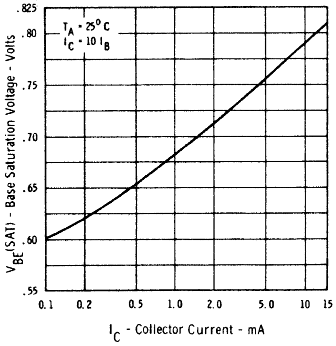


Typical Common Base Characteristics

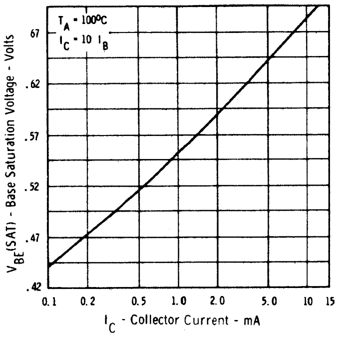




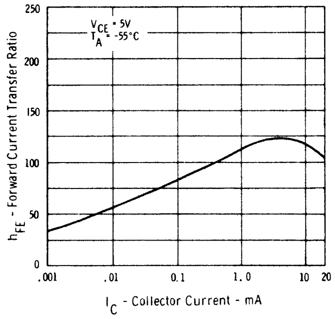
Base Saturation Voltage vs. Collector Current



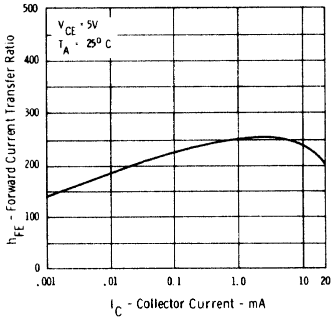
Base Saturation Voltage vs. Collector Current



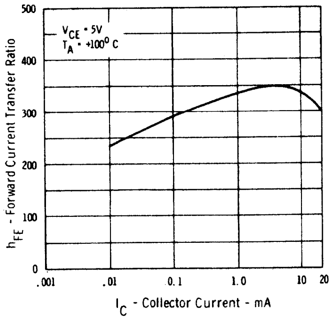
Base Saturation Voltage vs. Collector Current



Pulsed DC Current Gain Versus Collector Current



Pulsed DC Current Gain Versus Collector Current



Pulsed DC Current Gain Versus Collector Current

DUAL NPN TRANSISTOR
GENERAL PURPOSE

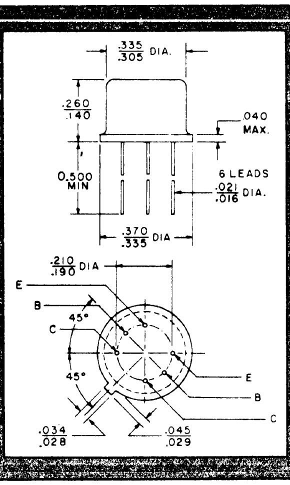
- CLOSELY MATCHED CURRENT GAIN
- VERY LOW DIFFERENTIAL DRIFT
- LOW NOISE

JANUARY 1968

2N2639
THRU
2N2644

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	45		Volts
Collector-Emitter Voltage	V_{CEO}	45		Volts
Emitter-Base Voltage	V_{EBO}	5.0		Volts
Collector Current	I_C	30		mA
Total Device Dissipation	P_D	One Side	Both Sides	
@ $T_A = 25°C$		0.3	0.6	Watts
@ $T_C = 25°C$		0.6	1.2	
Derating Factor above 25°C				
@ $T_A = 25°C$		2.0	4.0	mW/°C
@ $T_C = 25°C$		4.0	8.0	
Storage Temperature	T_{stg}	−65 to +300		°C
Junction Temperature	T_J	+175		°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$	45		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	5.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$**	$I_C = 10$ mA, $I_B = 0$	45		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA		1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA	0.6	1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 45$ V		10	nA
		$I_E = 0$, $V_{CB} = 45$ V, $T_A = 150°C$		10	μA
Collector-Emitter Cutoff Current	I_{CEO}	$I_B = 0$, $V_{CE} = 5.0$ V		10	nA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 5.0$ V		10	nA
DC Current Gain	h_{FE}				
2N2639-41		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V	50	300	
		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V	55		
		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	65		
		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$	10		
2N2642-44		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V	100	300	
		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V	110		
		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	130		
		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$	20		
DC Current Gain Ratio	h_{FE1}/h_{FE2}*				
2N2639, 2N2642		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V	0.9	1.0	
2N2640, 2N2643			0.8	1.0	
Base Voltage Differential	V_{BE1}-V_{BE2}				
2N2639, 2N2642		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		5.0	mV
2N2640, 2N2643				10	
Base Voltage Differential Drift	$\Delta(V_{BE1}$-$V_{BE2})/\Delta T$				
2N2639, 2N2642		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		10	μ V/°C
2N2640, 2N2643		$T_A = -55°C$ to $+125°C$		20	
Small Signal Current Gain	h_{fe}				
2N2639-41		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	65	600	
2N2642-44		f = 1.0 kHz	130	600	

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 20 MHz	4.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0$ V f = 1.0 MHz		8.0	pf
Voltage Feedback Ratio	h_{rb}	$I_E = -1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz		6.0	$X\,10^{-4}$
Input Resistance	h_{ib}	$I_E = -1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz	25	32	Ohms
Output Conductance	h_{ob}	$I_E = -1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz		1.0	μmhos
Noise Figure	NF	f = 10 Hz to 15.7 kHz Source Resistance = 10 kΩ $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		4.0	db

* The lower h_{FE} reading is taken as h_{FE1}.

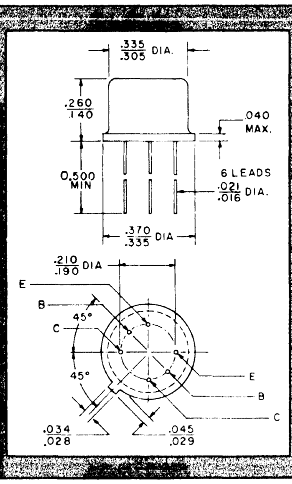
** Pulse Conditions: Pulse Width = 300 μsec; Duty Cycle = 1%.

DUAL NPN TRANSISTOR
GENERAL PURPOSE

- LOW NOISE
- CLOSELY MATCHED CURRENT GAIN
- HIGH BREAKDOWN VOLTAGE

JANUARY 1968

2N2720
2N2721
2N2722



MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}			
2N2720, 21		80		Volts
2N2722		45		
Collector-Emitter Voltage	V_{CEO}			
2N2720, 21		60		Volts
2N2722		45		
Emitter-Base Voltage	V_{EBO}			
2N2720, 21		6.0		Volts
2N2722		5.0		
Total Device Dissipation	P_D	One Side	Both Sides	
@ $T_A = 25°C$		0.3	0.6	Watts
@ $T_C = 25°C$		0.6	1.2	
Derating Factor above 25°C				
@ $T_A = 25°C$		1.71	3.4	mW/°C

ELECTRICAL CHARACTERISTICS at +25 °C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}				
2N2720, 21		$I_C = 10\ \mu A, I_E = 0$	80		Volts
2N2722			45		
Emitter-Base Breakdown Voltage	BV_{EBO}				
2N2720, 21		$I_C = 0, I_E = 10\ \mu A$	6.0		Volts
2N2722			5.0		
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^{**}$				
2N2720, 21		$I_C = 10\text{ mA}, I_B = 0$	60		Volts
2N2722			45		
Collector Saturation Voltage	$V_{CE(sat)}$				
2N2720, 21		$I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$		1.0	Volts
2N2722		$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$		1.0	
Base Saturation Voltage	$V_{BE(sat)}$				
2N2720, 21		$I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$	0.65	0.85	Volts
2N2722		$I_C = 10\text{ mA}, I_B = 0.5\text{ mA}$	0.65	0.85	
Collector-Base Cutoff Current	I_{CBO}				
2N2720, 21		$I_E = 0, V_{CB} = 60\text{ V}$		10	nA
2N2722		$I_E = 0, V_{CB} = 30\text{ V}$		1.0	
2N2720, 21		$I_E = 0, V_{CB} = 60\text{ V}, T_A = 150°C$		10	μA
2N2722		$I_E = 0, V_{CB} = 30\text{ V}, T_A = 150°C$		1.0	
Collector-Emitter Reverse Current	I_{CEO}				
2N2720, 21		$I_B = 0, V_{CE} = 5.0\text{ V}$		10	nA
2N2722				2.0	
Emitter-Base Cutoff Current	I_{EBO}				
2N2720, 21		$I_C = 0, V_{EB} = 5.0\text{ V}$		10	nA
2N2722				1.0	
DC Current Gain	h_{FE}				
2N2722		$I_C = 1.0\ \mu A, V_{CE} = 5.0\text{ V}$	50	250	
2N2722		$I_C = 10\ \mu A, V_{CE} = 5.0\text{ V}$	100		
2N2720, 21		$I_C = 100\ \mu A, V_{CE} = 5.0\text{ V}$	30	120	
2N2722			125		
2N2720, 21		$I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$	35		
2N2720, 21		$I_C = 10\text{ mA}, V_{CE} = 5.0\text{ V}$	42		

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
DC Current Gain Ratio	h_{FE1}/h_{FE2}*				
2N2720		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V	0.9	1.0	
2N2721			0.8	1.0	
2N2722		$I_C = 1.0\ \mu A$, $V_{CE} = 5.0$ V	0.9	1.0	
Base Voltage Differential	V_{BE1}-V_{BE2}				
2N2720		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V		5.0	mV
2N2721				10	
2N2722		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		5.0	
Base Voltage Differential Change	$\Delta(V_{BE1}$-$V_{BE2})$				
2N2720		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V		0.8	mV
2N2721		$T_A = -55°C$ to $+25°C$		1.6	
2N2722		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		0.8	
		$T_A = -55°C$ to $+25°C$			
2N2720		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V		1.0	
2N2721		$T_A = 25°C$ to $125°C$		2.0	
2N2722		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		1.0	
		$T_A = 25°C$ to $125°C$			
Small Signal Current Gain	h_{fe}				
2N2720, 21		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	30	200	
		f = 1.0 kHz			
2N2722		$I_C = 0.1$ mA, $V_{CE} = 5.0$ V	100	700	
		f = 1.0 kHz			
High Frequency Current Gain	$\|h_{fe}\|$				
2N2720, 21		$I_C = 10$ mA, $V_{CE} = 10$ V	4.0		
2N2722		f = 20 MHz	5.0		
Output Capacitance	C_{ob}				
2N2720, 21		$I_E = 0$, $V_{CB} = 5.0$ V		6.0	pf
		f = 1.0 MHz			
2N2722		$I_E = 0$, $V_{CB} = 5.0$ V		6.0	
		f = 140 kHz			
Voltage Feedback Ratio	h_{rb}				
2N2720, 21		$I_E = 1.0$ mA, $V_{CB} = 5.0$ V		5.0	X 10^{-4}
2N2722		f = 1.0 kHz		6.0	
Input Resistance	h_{ib}	$I_E = 1.0$ mA, $V_{CB} = 5.0$ V	25	32	Ohms
		f = 1.0 kHz			
Output Conductance	h_{ob}	$I_E = 1.0$ mA, $V_{CB} = 5.0$ V		1.0	μmhos
		f = 1.0 kHz			
Noise Figure	NF	f = 10 Hz to 15.7 kHz			
2N2722		Source resistance = 10 kΩ		4.0	db
		$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V			

* The lower h_{FE} reading is taken as h_{FE1}.
** Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

DUAL NPN TRANSISTOR
GENERAL PURPOSE

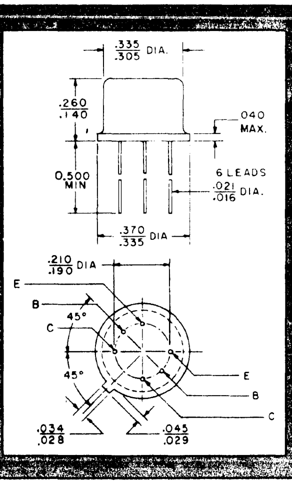
- CLOSELY MATCHED CURRENT GAIN
- VERY LOW DIFFERENTIAL DRIFT
- LOW NOISE

JANUARY 1968

2N2913-20
2N2915A, 16A
2N2919A, 20A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage 2N2913, 14, 15, 15A, 16, 16A, 17, 18 2N2919, 19A, 20, 20A	V_{CBO}	45 60		Volts
Collector-Emitter Voltage 2N2913, 14, 15, 15A, 16, 16A, 17, 18 2N2919, 19A, 20, 20A	V_{CEO}	45 60		Volts
Emitter-Base Voltage	V_{EBO}	6.0		Volts
Collector Current	I_C	30		mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	One Side 0.30 0.75 0.43	Both Sides 0.6 1.5 0.86	Watts
Derating Factor above 25°C @ $T_A = 25°C$ @ $T_C = 25°C$		One Side 1.7 4.3	Both Sides 3.4 8.6	mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage 2N2913, 14, 15, 15A, 16, 16A, 17, 18 2N2919, 19A, 20, 20A	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$	45 60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	6.0		Volts
Collector-Emitter Sustaining Voltage 2N2913, 14, 15, 15A, 16, 16A, 17, 18 2N2919, 19A, 20, 20A	$V_{CEO(sus)}$**	$I_C = 10$ mA, $I_B = 0$	45 60		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 1.0$ mA, $I_B = 0.1$ mA		0.35	Volts
Nonsaturated Base Voltage	$V_{BE(ON)}$	$I_C = 0.1$ mA, $V_{CE} = 5.0$ V		0.7	Volts
Collector-Base Cutoff Current 2N2913, 14, 15, 15A, 16, 16A, 17, 18 2N2919, 19A, 20, 20A	I_{CBO}	$I_E = 0$, $V_{CB} = 45$ V $I_E = 0$, $V_{CB} = 45$ V, $T_A = 150°C$		10 2.0 10	nA μA
Collector-Emitter Reverse Current	I_{CEO}	$I_B = 0$, $V_{CB} = 5.0$ V		2.0	nA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 5.0$ V		2.0	nA
DC Current Gain 2N2913, 15, 15A, 17, 19, 19A 2N2914, 16, 16A, 18, 20, 20A 2N2913, 15, 15A, 17, 19, 19A 2N2914, 16, 16A, 18, 20, 20A 2N2913, 15, 15A, 17, 19, 19A 2N2914, 16, 16A, 18, 20, 20A 2N2913, 15, 15A, 17, 19, 19A 2N2914, 16, 18, 20 2N2916A, 20A	h_{FE}	$I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $I_C = 1.0$ mA, $V_{CE} = 5.0$ V $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$	60 150 100 225 150 300 15 30 40	240 600	
DC Current Gain Ratio 2N2915, 15A, 16, 16A, 19, 19A, 20, 20A 2N2917, 18 2N2915A, 16A, 19A, 20A	h_{FE1}/h_{FE2}*	$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$ to $+125°C$	0.9 0.8 0.85	1.0 1.0 1.0	

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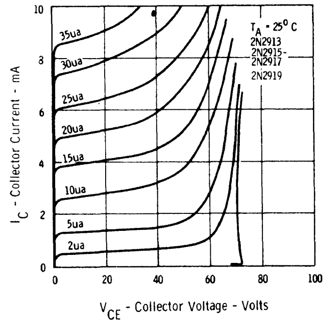
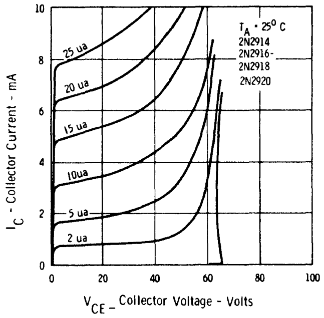
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Base Voltage Differential	V_{BE1}-V_{BE2}				
2N2915, 16, 19, 20		$I_C = 10\ \mu A$ to 1.0 mA, $V_{CE} = 5.0$ V		5.0	mV
2N2917, 18				10	
2N2915A, 16A, 19A, 20A				2.0	
2N2915, 16, 19, 20		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V		3.0	
2N2917, 18				5.0	
2N2915A, 16A, 19A, 20A				1.5	
Base Voltage Differential Change	$\Delta(V_{BE1}$-$V_{BE2})$				
2N2915, 16, 19, 20		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $T_A = -55°C$ to 125°C		0.8	mV
2N2915A, 16A, 19A, 20A				0.4	
2N2917, 18				1.6	
2N2915, 16, 19, 20		$I_C = 100\ \mu A$, $V_{CE} = 5.0$ V $T_A = 25°C$ to 125°C		1.0	
2N2915A, 16A, 19A, 20A				0.5	
2N2917, 18				2.0	
High Frequency Current Gain	$\|h_{fe}\|$	$I_C = 0.5$ mA, $V_{CE} = 5.0$ V f = 20 MHz	3.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0$ V f = 140 kHz		6.0	pf
Input Capacitance 2N2915A, 16A, 19A, 20A	C_{ib}	$I_C = 0$, $V_{BE} = 5.0$ V f = 1.0 MHz		10	pf
Input Resistance	h_{ib}	$I_C = 1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz	25	32	Ohms
Output Conductance	h_{ob}	$I_C = 1.0$ mA, $V_{CB} = 5.0$ V f = 1.0 kHz		1.0	μmhos
Noise Figure	NF	f = 1.0 kHz			
2N2913, 15, 15A, 17, 19, 19A		Source resistance = 10 kΩ		4.0	db
2N2914, 16, 16A, 18, 20, 20A		Equivalent noise power bandwidth = 200 Hz $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		3.0	
2N2913, 15, 15A, 17, 19, 19A		f = 10 Hz to 10 kHz		4.0	
2N2914, 16, 16A, 18, 20, 20A		Source resistance = 10 kΩ Equivalent noise power bandwidth = 15.7 kHz $I_C = 10\ \mu A$, $V_{CE} = 5.0$ V		3.0	

* Lowest of the two h_{FE} readings is taken as h_{FE1} for purposes of this ratio.
** Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

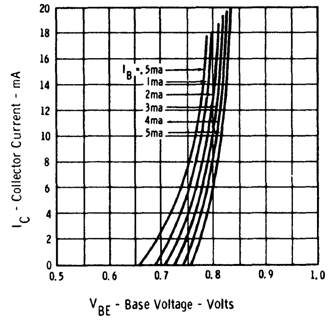
2N2919
2N2915-2N2917
2N2913 Collector Characteristics



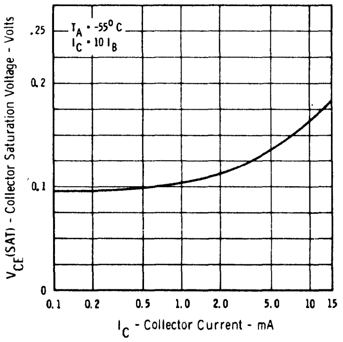
2N2920
2N2916-2N2918
2N2914 Collector Characteristics



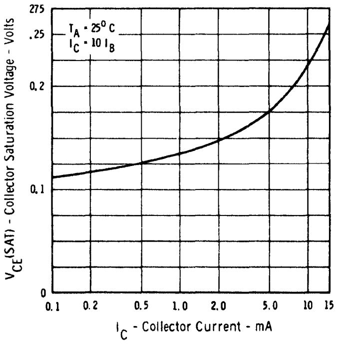
Typical Base Characteristics



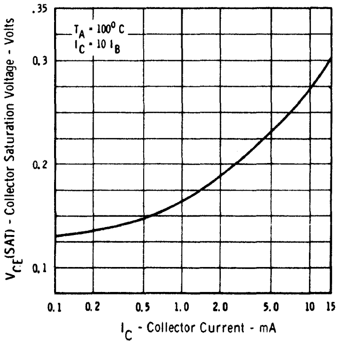
Collector Saturation Voltage
Versus Collector Current



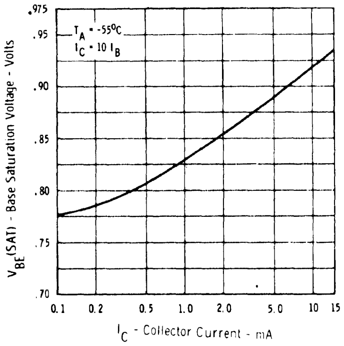
Collector Saturation Voltage
Versus Collector Current



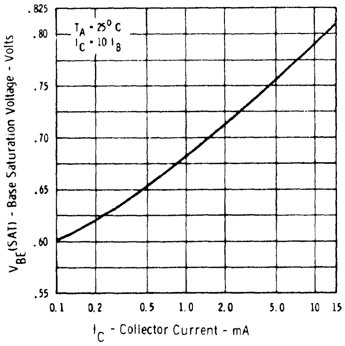
Collector Saturation Voltage
Versus Collector Current



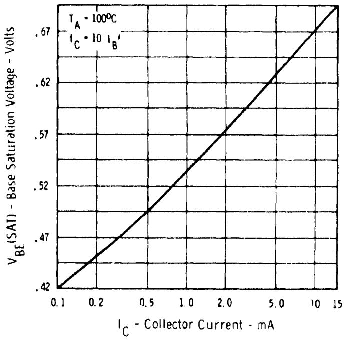
Base Saturation Voltage vs. Collector Current



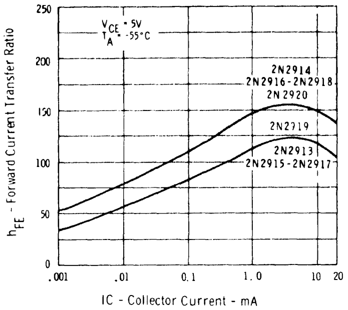
Base Saturation Voltage vs. Collector Current



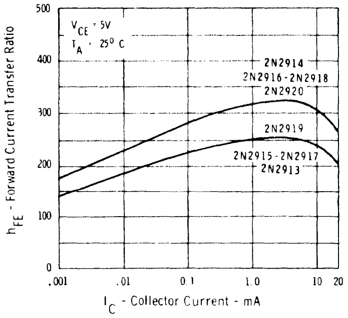
Base Saturation Voltage vs. Collector Current



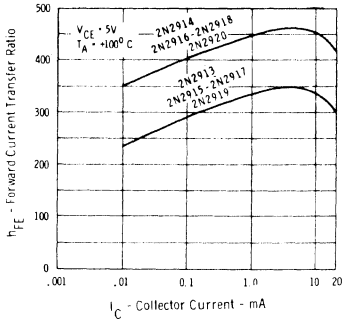
Pulsed DC Current Gain Versus Collector Current



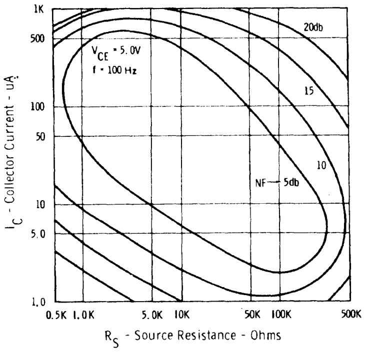
Pulsed DC Current Gain Versus Collector Current



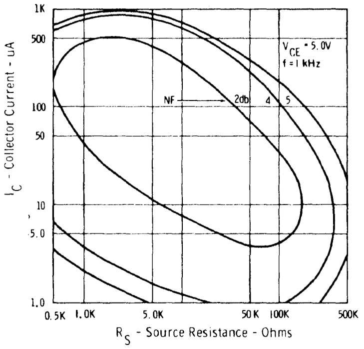
Pulsed DC Current Gain Versus Collector Current



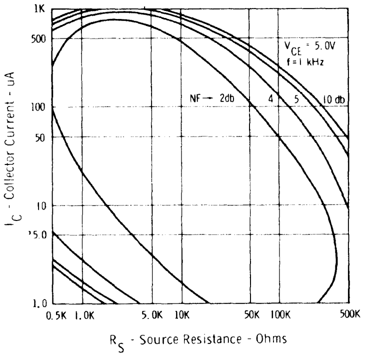
Noise Figure at 100 CPS



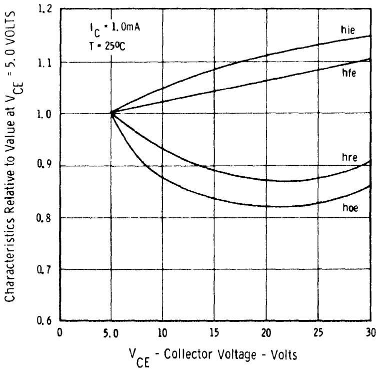
Noise Figure at 1 KC



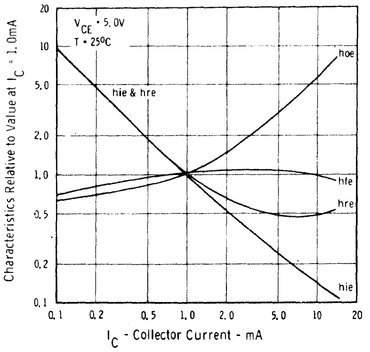
Noise Figure at 10 KC



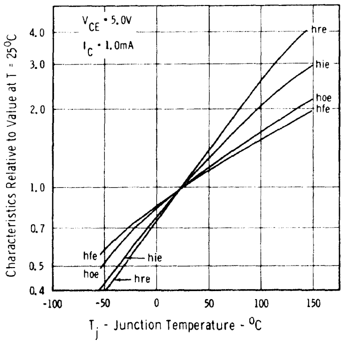
Typical Common Emitter Characteristics



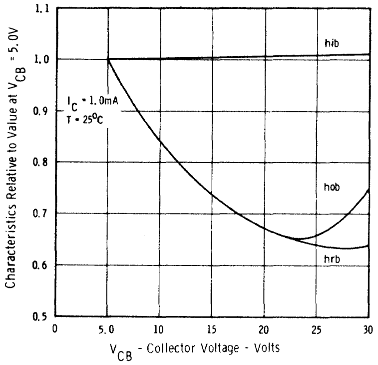
Typical Common Emitter Characteristics



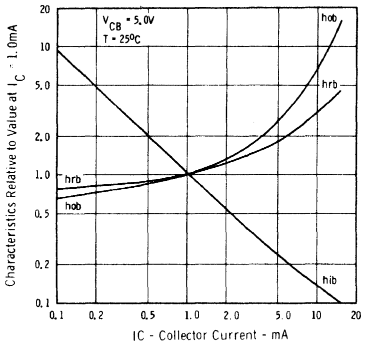
Typical Common Emitter Characteristics



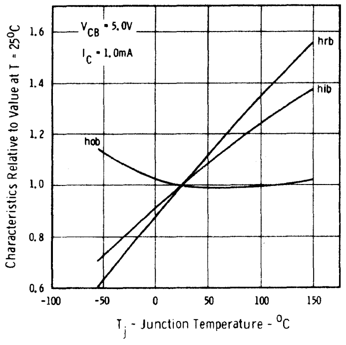
Typical Common Base Characteristics



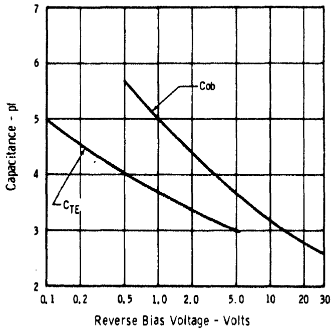
Typical Common Base Characteristics



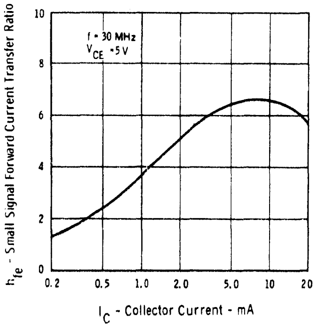
Typical Common Base Characteristics



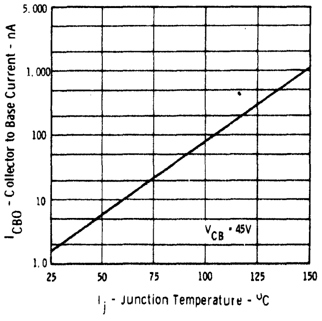
Collector and Emitter
Transition Capacitance Versus
Reverse Bias Voltage



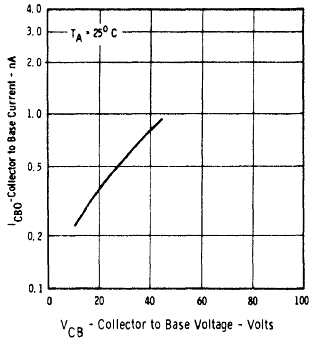
Small Signal Current Gain at
30 mc Versus Collector Current



Collector - Base Diode Reverse
Current versus Temperature



Collector - Base Diode Reverse
Current Versus Voltage



DUAL NPN TRANSISTOR
GENERAL PURPOSE

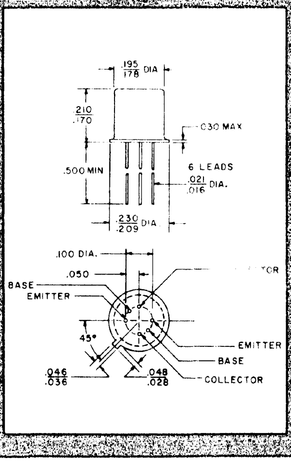
- LOW NOISE
- CLOSELY MATCHED CURRENT GAIN
- VERY CLOSELY MATCHED, V_{BE}

JANUARY 1968

2N2972
THRU
2N2979

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING 2N2972 to 2N2977	 2N2978-2N2979	UNIT
Collector-Base Voltage	V_{CBO}	45	60	Volts
Collector-Emitter Voltage	V_{CEO}	45	60	Volts
Emitter-Base Voltage	V_{EBO}	6.0	6.0	Volts
Collector Current	I_C	30		mA
Total Device Dissipation	P_D			
@ $T_A = 25°C$		0.3		Watts
@ $T_C = 25°C$		0.75		
@ $T_C = 100°C$		0.43		
Storage Temperature	T_{stg}	-65 to $+200$		°C
Junction Temperature	T_J	$+200$		°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}				
2N2972-2N2977		$I_C = 10\ \mu A, I_E = 0$	45		Volts
2N2978, 2N2979			60		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	6.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$				
2N2972-2N2977		$I_C = 10$ mA, $I_B = 0$	45		Volts
2N2978, 2N2979			60		
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 1.0$ mA, $I_B = 0.1$ mA		0.35	Volts
Nonsaturated Base Voltage	$V_{BE(on)}$	$I_C = 0.1$ mA, $V_{CE} = 5.0$ V		0.7	Volts
Collector-Base Cutoff Current	I_{CBO}				
2N2972-2N2977		$I_E = 0, V_{CB} = 45$ V		10	nA
2N2978, 2N2979				2.0	
2N2972-2N2979		$I_E = 0, V_{CB} = 45$ V, $T_A = 150°C$		10	μA
Collector-Emitter Cutoff Current	I_{CEO}	$I_B = 0, V_{CE} = 5.0$ V		2.0	nA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0, V_{EB} = 5.0$ V		2.0	nA
DC Current Gain	h_{FE}				
2N2972, 74, 76, 78		$I_C = 10\ \mu A, V_{CE} = 5.0$ V	60	240	
2N2973, 79			150	600	
2N2975, 77			150		
2N2972, 74, 76, 78		$I_C = 100\ \mu A, V_{CE} = 5.0$ V	100		
2N2973, 75, 77, 79			225		
2N2972, 74, 76, 78		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	150		
2N2973, 75, 77, 79			300		
2N2972, 74, 76, 78		$I_C = 10\ \mu A, V_{CE} = 5.0$ V	15		
2N2973, 75, 77		$T_A = -55°C$	30		
2N2979			40		
DC Current Ratio	$h_{FE1}/h_{FE2}{}^*$				
2N2974, 75, 78, 79		$I_C = 100\ \mu A, V_{CE} = 5.0$ V	0.9	1.0	
2N2976, 77			0.8	1.0	
Base Voltage Differential	V_{BE1}-V_{BE2}				
2N2974, 75, 78, 79		$I_C = 10\ \mu A$ to 1.0 mA, $V_{CE} = 5.0$ V		5.0	mV
2N2976, 77				10	
2N2974, 75, 78, 79		$I_C = 100\ \mu A, V_{CE} = 5.0$ V		3.0	
2N2976, 77				5.0	

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Base Voltage Differential Change	$\Delta(V_{BE1}-V_{BE2})$				
2N2974, 75, 78, 79		$I_C = 100\ \mu A$, $V_{CE} = 5.0\ V$		0.8	mV
2N2976, 77		$T_A = -55°C$ to $+25°C$		1.6	
2N2974, 75, 78, 79		$I_C = 100\ \mu A$, $V_{CE} = 5.0\ V$		1.0	
2N2976, 77		$T_A = 25°C$ to $125°C$		2.0	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 0.5\ mA$, $V_{CE} = 5.0\ V$ $f = 20\ MHz$	3.0		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 5.0\ V$ $f = 140\ kHz$		6.0	pf
Input Resistance	h_{ib}	$I_C = 1.0\ mA$, $V_{CE} = 5.0\ V$ $f = 1.0\ kHz$	25	32	Ohms
Output Conductance	h_{ob}	$I_C = 1.0\ mA$, $V_{CE} = 5.0\ V$ $f = 1.0\ kHz$		1.0	μmhos
Noise Figure	NF	$f = 1.0\ kHz$			
2N2972, 74, 76, 78		Source resistance = 10 kΩ		4.0	db
2N2973, 75, 77, 79		Equivalent noise power		3.0	
		bandwidth = 200 Hz			
		$I_C = 10\ \mu A$, $V_{CE} = 5.0\ V$			
		$f = 10\ Hz$ to $10\ kHz$			
2N2972, 74, 76, 78		Source resistance = 10 kΩ		4.0	
2N2973, 75, 77, 79		Equivalent noise power		3.0	
		bandwidth = 15.7 kHz			
		$I_C = 10\ \mu A$, $V_{CE} = 5.0\ V$			

* Lowest of the two h_{FE} readings is taken as h_{FE1} for purposes of this ratio.
** Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

DUAL NPN TRANSISTOR
GENERAL PURPOSE

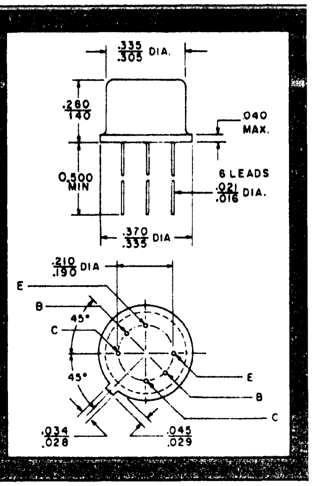
- VERY CLOSELY MATCHED, V_{BE}
- VERY LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED CURRENT GAIN

JANUARY 1968

2N3680

MAXIMUM RATINGS

CHARACTERISTIC	RATING	RATING		UNIT
Collector-Base Voltage	V_{CBO}	60		Volts
Collector-Emitter Voltage	V_{CEO}	50		Volts
Emitter-Base Voltage	V_{EBO}	6.0		Volts
		Each Side	Both Sides	
Collector Current	I_C	30	—	mA
Total Device Dissipation	P_D			
@ $T_A = 25°C$		0.3	0.6	Watts
@ $T_C = 25°C$		0.6	1.2	
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+175		°C
Derating Factor above 25°C				
@ $T_A = 25°C$		2.0	4.0	mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A, I_E = 0$	60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0, I_E = 10\ \mu A$	60		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$**	$I_C = 10$ mA, $I_B = 0$	50		Volts
Nonsaturated Base Voltage	$V_{BE(on)}$	$I_C = 10$ mA, $V_{CE} = 5.0$ V	0.6	0.8	Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $V_{CE} = 0.5$ V		0.7	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0, V_{CB} = 45$ V		10	nA
		$I_E = 0, V_{CB} = 45$ V, $T_A = 150°C$		10	μA
Collector-Emitter Cutoff Current	I_{CEO}	$I_B = 0, V_{CE} = 5.0$ V		10	nA
DC Current Gain	h_{FE}	$I_C = 1.0\ \mu A, V_{CE} = 5.0$ V	80		
		$I_C = 10\ \mu A, V_{CE} = 5.0$ V	150	600	
		$I_C = 10\ \mu A, V_{CE} = 5.0$ V $T_A = -55°C$	45		
		$I_C = 100\ \mu A, V_{CE} = 5.0$ V	225		
		$I_C = 1.0$ mA, $V_{CE} = 5.0$ V	300		
DC Current Gain Ratio	$h_{FE1}/_{FE2}$*	$I_C = 1.0\ \mu A, V_{CE} = 5.0$ V	0.9	1.0	
		$I_C = 10\ \mu A, V_{CE} = 5.0$ V $T_A = -55°C$ to $+125°C$	0.85	1.0	
Base Voltage Differential	V_{BE1}-V_{BE2}	$I_C = 10\ \mu A, V_{CE} = 5.0$ V		3.0	mV
Base Voltage Differential Change	$\Delta(V_{BE1}-V_{BE2})/\Delta T$	$I_C = 10\ \mu A, V_{CE} = 5.0$ V $T_A = -55°C$ to $+25°C$		0.4	mV
		$I_C = 10\ \mu A, V_{CE} = 5.0$ V $T_A = 25°C$ to $125°C$		0.5	
Small Signal Current Gain	h_{fe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz	300	900	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 0.5$ mA, $V_{CE} = 5.0$ V f= 30 MHz	2.0	6.0	
Output Capacitance	C_{ob}	$I_E = 0, V_{CB} = 5.0$ V f = 1 MHz		6.0	pf
Input Capacitance	C_{ib}	$I_C = 0, V_{BE} = 0.5$ V f = 1 MHz		6.0	pf

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Reverse Voltage Feedback Ratio	h_{re}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz		10	x10^{-4}
Input Resistance	h_{ie}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz	7.5	24	k ohms
Output Conductance	h_{oe}	$I_C = 1.0$ mA, $V_{CE} = 5.0$ V f = 1 kHz		45	μmhos
Noise Figure	NF	f = 15.7 kHz Source resistance = 10 kΩ $I_E = 10$ μA, $V_{CB} = 5.0$ V		3.0	db

* The lower reading is taken as h_{FE1}.

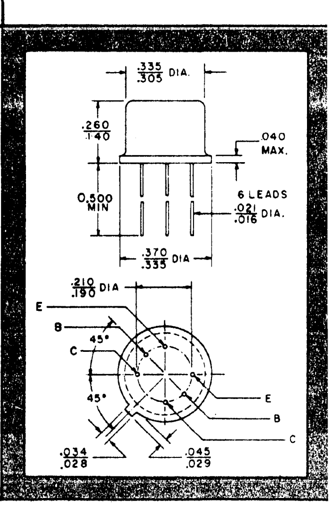
** Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.

DUAL NPN TRANSISTOR
MEDIUM POWER

- HIGH VOLTAGE
- LOW VOLTAGE
- HIGH CURRENT GAIN

JANUARY 1968

2N2223
2N2223A



MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	100		Volts
Collector-Emitter Voltage	V_{CEO}	60		Volts
Collector-Emitter Voltage ($R_{BE} \leqq 10\Omega$)	V_{CER}	80		Volts
Emitter-Base Voltage	V_{EBO}	7		Volts
Collector Current	I_C	500		mA
Total Device Dissipation	P_D	One Side	Both Sides	
@ $T_A = 25°C$		0.5	0.6	Watt
@ $T_C = 25°C$		1.6	3.0	
@ $T_C = 100°C$		0.9	1.7	
Derating Factor above 25°C		One Side	Both Sides	
@ $T_A = 25°C$		2.86	3.43	mW/°C
@ $T_C = 25°C$		9.1	17.2	
Storage Temperature	T_{stg}	−65 to +300		°C
Junction Temperature	T_J	+200		°C

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 100\ \mu A, I_E = 0$	100		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}{}^*$	$I_C = 30$ mA, $I_B = 0$	60		Volts
Collector-Emitter Sustaining Voltage	$V_{CER(sus)}{}^*$	$I_C = 100$ mA, $R_{BE} \leqq 10\Omega$	80		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 100\ \mu A, I_C = 0$	7		Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 80$ V, $I_E = 0$ $V_{CB} = 80$ V, $I_E = 0$, $T_A = 150°C$		.010 15	μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 5$ V, $I_C = 0$		10	nA
DC Current Gain	h_{FE}	$I_C = 10\ \mu A, V_{CE} = 5$ V $I_C = 100\ \mu A, V_{CE} = 5$ V $I_C = 10$ mA, $V_{CE} = 5$ V	15 25 50	 150 200	
DC Current Gain Ratio 2N2223A 2N2223	$h_{FE1}/h_{FE2}{}^{**}$	$I_C = 100\ \mu A, V_{CE} = 5$ V	0.9 0.8	1.0 1.0	
Base Voltage Differential 2N2223A 2N2223	$\lvert V_{BE1}—V_{BE2}\rvert$	$I_C = 100\ \mu A, V_{CE} = 5$ V		5 15	mV
Base Voltage Differential Drift	$\Delta(V_{BE1}\text{-}V_{BE2})/\Delta T$	$I_C = 100\ \mu A, V_{CE} = 5$ V $T_A = -55°C$ to $+125°C$		25	$\mu V/°C$
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 50$ mA, $I_B = 5$ mA		1.2	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 50$ mA, $I_B = 5$ mA		0.9	Volts
Small Signal Current Gain	h_{fe}	$I_C = 1$ mA, $V_{CE} = 5$ V, f = 1 kHz	40	200	
High Frequency Current Gain	$\lvert h_{fe}\rvert$	$I_C = 50$ mA, $V_{CE} = 10$ V, f = 20 MHz	2.5		
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 10$ V, f = 140 kHz		15	pf
Input Capacitance	C_{ib}	$I_C = 0$, $V_{BE} = 0.5$ V, f = 140 kHz		85	pf
Input Resistance	h_{ib}	$I_C = 1$ mA, $V_{CB} = 5$ V, f = 1 kHz	20	30	Ohms
Output Conductance	h_{ob}	$I_C = 1$ mA, $V_{CB} = 5$ V, f = 1 kHz		0.5	μmhos
Voltage Feedback Ratio	h_{rb}	$I_C = 1$ mA, $V_{CB} = 5$ V, f = 1 kHz		300	$\times 10^{-6}$

*The lower of the two h_{FE} readings is taken as h_{FE1}.
** Pulse Test: Pulse Width $\leq 300\ \mu$sec; Duty Cycle = 1%.

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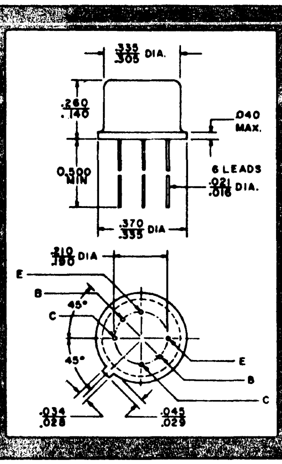
DUAL MONOLITHIC NPN TRANSISTOR

MEDIUM POWER

- HIGH BREAKDOWN VOLTAGE
- LOW SATURATION VOLTAGE
- VERY CLOSELY MATCHED PARAMETERS

SA 2716
SA 2717
SA 2718



MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	50		Volts
Collector-Emitter Voltage	V_{CEO}	30		Volts
Collector-Collector Voltage	V_{CCO}	±60		Volts
Emitter-Base Voltage	V_{EBO}	6.0		Volts
Total Device Dissipation	P_D	One Side	Both Sides	
@T_A = 25°C		0.3	0.6	Watts
@T_C = 25°C		0.6	1.2	
@T_C = 100°C		0.25	0.5	
Derating Factor above 25°C				
@T_A = 25°C		2.0	4.0	mW/°C
@T_C = 25°C		4.0	8.0	
Storage Temperature Range	T_{STG}	−65 to +150		°C
Operating Junction Temperature	T_J	+150		°C
Lead Soldering Temperature, 1/16 inch from Case, 10 seconds max		+300		°C

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\mu A$, $I_E = 0$	50		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$	$I_C = 5.0mA$, $I_B = 0$	30		Volts
Base-Emitter Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\mu A$	6.0		Volts
Collector-Collector Breakdown Voltage	BV_{CCO}	$I_B = 0$, $I_E = 0$, $I_{CC} = 10\mu A$	±60		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 1.0mA$, $I_B = 0.1mA$ $I_C = 5.0mA$, $I_B = 0.5mA$ $I_C = 10mA$, $I_B = 1.0mA$		0.3 0.7 1.0	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 1.0mA$, $I_B = 0.1mA$ $I_C = 5.0mA$, $I_B = 0.5mA$ $I_C = 10mA$, $I_B = 1.0mA$		0.8 0.85 0.9	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 30V$, $I_E = 0$ $V_{CB} = 30V$, $I_E = 0$, $T_A = 150°C$		2.0 2.0	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 5.0V$, $I_C = 0$		2.0	nA
Collector-Emitter Cutoff Current	I_{CEO}	$V_{CE} = 5.0V$, $I_B = 0$		2.0	nA
Collector-Collector Leakage Curr.	I_{CCO}	$V_{CC} = \pm 50V$, $I_B = 0$, $I_E = 0$ $V_{CC} = \pm 50V$, $I_B = 0$, $I_E = 0$, $T_A = 150°C$		2.0 2.0	nA μA
DC Current Gain	h_{FE}	$V_{CE} = 5.0V$, $I_C = 10\mu A$ $V_{CE} = 5.0V$, $I_C = 10\mu A$, $T_A = -55°C$ $V_{CE} = 5.0V$, $I_C = 100\mu A$ $V_{CE} = 5.0V$, $I_C = 1.0mA$ $V_{CE} = 5.0V$, $I_C = 10mA$	150 40 200 250 150		
DC Current Gain Ratio SA2716, SA2717 SA2718 SA2716, SA2717	h_{FE1}/h_{FE2}	$V_{CE} = 5.0V$, $I_C = 100\mu A$ $V_{CE} = 5.0V$, $I_C = 100\mu A$ (T_A = −55°C to +125°C)	0.9 0.8 0.85	1.11 1.25 1.17	
Base Voltage Differential SA2716 SA2717 SA2718	$V_{BE1} - V_{BE2}$	$V_{CE} = 5.0V$, $I_C = 100\mu A$		2.0 3.0 5.0	mV

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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Base Voltage Differential Drift SA2716 SA2717 SA2718	$\frac{\Delta(V_{BE1} - V_{BE2})}{\Delta T}$	V_{CE} = 5.0V, I_C = 100μA T_A = −55°C to +125°C		3.0 5.0 10.0	μV/°C
High Frequency Current Gain	$\|h_{fe}\|$	V_{CE} = 5.0V, I_C = 1.0mA, f=30MHz	6.0		
Input Capacitance	C_{ib}	V_{EB} = 0.5V, I_C = 0, f=140kHz		3.0	pf
Output Capacitance	C_{ob}	V_{CB} = 10V, I_E = 0, f=140kHz		3.0	pf
Collector-Collector Capacitance	C_{cc}	V_{CC} = 0V, I_B = 0, I_E = 0, f = 140kHz		3.0	pf
Noise Figure	NF	V_{CE} = 5.0V, I_C = 10μA R_S = 10KΩ, f = 1.0kHz BW = 200Hz		2.0	db

DUAL NPN TRANSISTOR
RF/IF AMPLIFIER

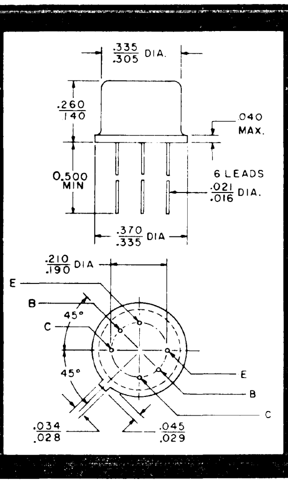
- LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED CURRENT GAIN
- HIGH FREQUENCY

JANUARY 1968

2N3423
2N3424

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	30		Volts
Collector-Emitter Voltage	V_{CEO}	15		Volts
Emitter-Base Voltage	V_{EBO}	3.0		Volts
Collector Current	I_C	50		mA
Total Device Dissipation	P_D	Each Side	Both Sides	
@ $T_A = 25°C$		0.3	0.6	Watts
@ $T_C = 100°C$		0.25	0.5	
@ $T_C = 25°C$		0.6	1.2	
Derating Factor above 25°C		Each Side	Both Sides	
@ $T_A = 25°C$		1.7	3.4	mW/°C
@ $T_C = 25°C$		3.4	6.8	
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200		°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 1.0\ \mu A$, $I_E = 0$	30		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_C = 0$, $I_E = 10\ \mu A$	3.0		Volts
Collector-Emitter Sustaining Voltage	$V_{CEO(sus)}$*	$I_C = 3.0$ mA, $I_B = 0$	15		Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		0.4	Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 1.0$ mA		1.0	Volts
Collector-Base Cutoff Current	I_{CBO}	$I_E = 0$, $V_{CB} = 15$ V		10	nA
		$I_E = 0$, $V_{CB} = 15$ V, $T_A = 150°C$		1.0	μA
Emitter-Base Cutoff Current	I_{EBO}	$I_C = 0$, $V_{EB} = 3.0$ V		10	μA
DC Pulse Current Gain	h_{FE}*	$I_C = 3.0$ mA, $V_{CE} = 3.0$ V	20	200	
DC Current Gain Ratio	h_{FE1}/h_{FE2}**	$I_C = 3.0$ mA, $V_{CE} = 3.0$ V			
2N3423			0.8	1.0	
2N3424			0.9	1.0	
Base Voltage Differential	V_{BE1}-V_{BE2}				
2N3423		$I_C = 3.0$ mA, $V_{CE} = 3.0$ V		10	mV
2N3424				5.0	
Base Voltage Differential Change	$\Delta(V_{BE1}$-$V_{BE2})/\Delta T$				
2N3423		$I_C = 3.0$ mA, $V_{CE} = 3.0$ V		3.2	mV
2N3424		$T_A = -55°C$ to $+25°C$		1.6	
2N3423		$I_C = 3.0$ mA, $V_{CE} = 3.0$ V		4.0	
2N3424		$T_A = +25°C$ to $+125°C$		2.0	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 4.0$ mA, $V_{CE} = 10$ V f = 100 MHz	6.0	12	
Output Capacitance	C_{ob}	$I_E = 0$, $V_{CB} = 10$ V f = 140 kHz		1.7	pf
		$I_E = 0$, $V_{CB} = 0$ f = 140 kHz		3.0	
Input Capacitance	C_{ib}	$I_C = 0$, $V_{BE} = 0.5$ V f = 140 kHz		2.0	pf
Input Resistance	h_{ie}	$I_C = 3.0$ mA, $V_{CE} = 3.0$ V f = 350 kHz		45	ohms
Low Frequency Noise Figure	NF	f = 60 MHz Source Resistance = 400Ω $I_C = 1.0$ mA, $V_{CE} = 6.0$ V		3.5 (typ.)	db

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 1%.
** Lowest of the two h_{FE} readings is taken as h_{FE1} for purposes of this ratio.

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DUAL PNP TRANSISTOR
GENERAL PURPOSE

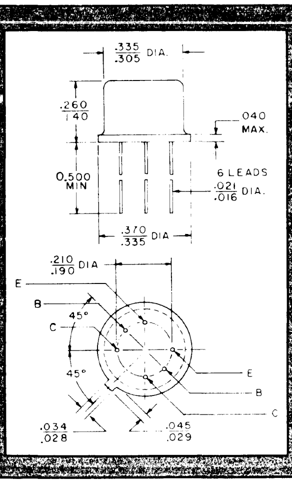
- CLOSELY MATCHED, V_{BE} LOW DIFFERENTIAL DRIFT
- HIGH CURRENT GAIN

JANUARY 1968

2N3347
THRU
2N3352

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Collector-Base Voltage	V_{CBO}	60		Volts
Collector-Emitter Voltage	V_{CEO}	45		Volts
Emitter-Base Voltage	V_{EBO}	6		Volts
Collector Current	I_C	30		mA
Total Device Dissipation	P_D	Each Side	Both Sides	
@ $T_A = 25°C$		300	600	mW
@ $T_C = 25°C$		0.6	1.2	
Storage Temperature	T_{stg}	−65 to +200		°C



ELECTRICAL CHARACTERISTICS at +25 C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A,\ I_E = 0$	60		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 10\ mA,\ I_B = 0$	45		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A,\ I_C = 0$	6		Volts
Base-Emitter Voltage	V_{BE}	$I_C = 10\ mA,\ V_{CE} = 5\ V$		0.9	Volts
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10\ mA,\ I_B = 0.5mA$		0.5	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 45\ V,\ I_E = 0$ $V_{CB} = 45\ V,\ I_E = 0,\ T_A = 150°C$		10 10	nA μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 6\ V,\ I_C = 0$		2	nA
DC Current Gain	h_{FE}				
2N3347, 48, 49		$I_C = 10\ \mu A,\ V_{CE} = 5\ V$	40	300	
2N3350, 51, 52		$I_C = 10\ \mu A,\ V_{CE} = 5\ V$	100	300	
2N3347, 48, 49		$I_C = 1.0\ mA,\ V_{CE} = 5\ V$	60		
2N3350, 51, 52		$I_C = 1.0\ mA,\ V_{CE} = 5\ V$	150		
DC Current Gain Ratio	h_{FE1}/h_{FE2}*	$I_C = 10\ \mu A,\ V_{CE} = 5\ V$			
2N3347, 50			0.9	1.0	
2N3348, 51			0.8	1.0	
2N3349, 52			0.6	1.0	
Base-Emitter Voltage Differential	V_{BE1}-V_{BE2}	$I_C = 10\ \mu A,\ V_{CE} = 5\ V$			
2N3347, 50				5.0	mV
2N3348, 51				10	
2N3349, 52				20	
Base-Emitter Voltage Differential Change	$\Delta(V_{BE1}\text{-}V_{BE2})/\Delta T$	$I_C = 10\ \mu A,\ V_{CE} = 5\ V$			
2N3347, 50		$T_1 = 25°C,\ T_2 = -55°C$		0.8	mV
2N3348, 51				1.6	
2N3349, 52				3.2	
Base-Emitter Voltage Differential Change	$\Delta(V_{BE1}\text{-}V_{BE2})/\Delta T$	$I_C = 10\ \mu A,\ V_{CE} = 5\ V$			
2N3347, 50		$T_1 = 25°C,\ T_2 = 125°C$		1.0	mV
2N3348, 51				2.0	
2N3349, 52				40	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 1.0\ mA,\ V_{CE} = 5\ V$ $f = 30\ MHz$	2.0	8.0	

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Small Signal Current Gain	h_{fe}	$I_C = 10$ mA, $V_{CE} = 5$ V			
2N3347, 48, 49		f = 1 kHz	60	600	
2N3350, 51, 52			150	600	
Output Capacitance	C_{ob}	$V_{CE} = 5$ V, f = 1 MHz		6	pf
Output Capacitance	C_{ib}	$V_{EB} = 0.5$ V, f = 1 MHz		8	pf
Output Admittance	h_{oe}	$I_C = 1.0$ mA, $V_{CE} = 5$ V f = 1 kHz		100	μmhos
Input Impedance	h_{ie}	$I_C = 1.0$ mA, $V_{CE} = 5$ V			
2N3347, 48, 49		f = 1 kHz	1.5	2.0	K ohms
2N3350, 51, 52			3.7	2.0	

* The lowest h_{FE} reading is taken as h_{FEI} for this ratio.

DUAL PNP TRANSISTOR
GENERAL PURPOSE

- LOW NOISE
- VERY LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED CURRENT GAIN

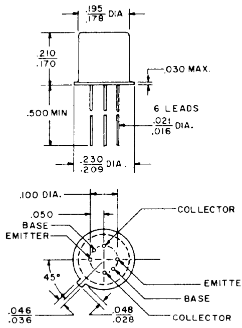
JANUARY 1968

2N3800
THRU
2N3811

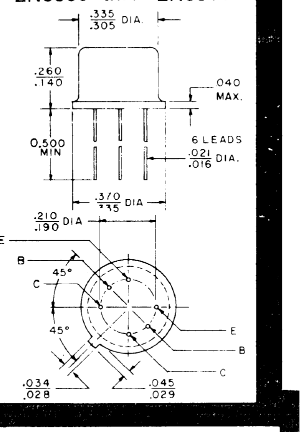
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING				UNIT
Collector-Base Voltage	V_{CBO}	60				Volts
Collector-Emitter Voltage	V_{CEO}	60				Volts
Emitter-Base Voltage	V_{EBO}	5				Volts
Collector Current	I_C	50				mA
		2N3800 thru 2N3805		2N3806 thru 2N3811		
		Each Side	Both Sides	Each Side	Both Sides	
Total Device Dissipation @ $T_A = 25°C$	P_D	250	360	500	600	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.5	2.1	2.9	3.4	mW/°C
Storage Temperature	T_{stg}	−65 to +200				°C
Junction Temperature	T_J	+200				°C
Lead Temperature 1/16 inch from case, 10 seconds max.		+230				°C

2N3800 thru 2N3805



2N3806 thru 2N3811



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\mu A$, $I_E = 0$	60		Volts
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 10mA$, $I_B = 0$	60		Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\mu A$, $I_C = 0$	5		Volts
Base Emitter "ON" Voltage	$V_{BE(ON)}$	$I_C = 100\mu A$, $V_{CE} = 5$ V		0.7	Volts
Collector Saturation Voltage	$V_{CE(sat)}$*	$I_C = 100\mu A$, $I_B = 10\ \mu A$ $I_C = 1$ mA, $I_B = 100\ \mu A$		0.2 0.25	Volts
Base Saturation Voltage	$V_{BE(sat)}$*	$I_C = 100\mu A$, $I_B = 10\ \mu A$ $I_C = 1$ mA, $I_B = 100\ \mu A$		0.7 0.8	Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 50$ V, $I_E = 0$ $V_{CB} = 50$ V, $I_E = 0$, $T_A = 150°C$		0.010 10	μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 4$ V, $I_C = 0$		20	nA
DC Current Gain	h_{FE}*				
2N3801, 03, 05, 07, 09, 11		$I_C = 1\ \mu A$, $V_{CE} = 5$ V	75		
2N3800, 02, 04, 06, 08, 10		$I_C = 10\ \mu A$, $V_{CE} = 5$ V	100		
2N3801, 03, 05, 07, 09, 11			225		
2N3800, 02, 04, 06, 08, 10		$I_C = 100\ \mu A$, $V_{CE} = 5$ V	150	450	
2N3801, 03, 05, 07, 09, 11			300	900	
2N3800, 02, 04, 06, 08, 10		$I_C = 100\ \mu A$, $V_{CE} = 5$ V	75		
2N3801, 03, 05, 07, 09, 11		$T_A = -55°C$	150		
2N3800, 02, 04, 06, 08, 10		$I_C = 500\ \mu A$, $V_{CE} = 5$ V	150	450	
2N3801, 03, 05, 07, 09, 11			300	900	
2N3800, 02, 04, 06, 08, 10		$I_C = 1$ mA, $V_{CE} = 5$ V	150	450	
2N3801, 03, 05, 07, 09, 11			300	900	
2N3800, 02, 04, 06, 08, 10		$I_C = 10$ mA, $V_{CE} = 5$ V	125		
2N3801, 03, 05, 07, 09, 11			250		
DC Current Gain Ratio	h_{FE1}/h_{FE2}**				
2N3802, 03, 08, 09		$I_C = 100\ \mu A$, $V_{CE} = 5$ V	0.8	1.0	
2N3804, 05, 10, 11			0.9	1.0	

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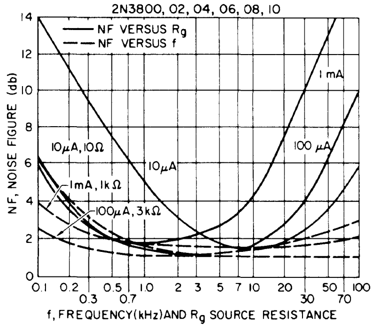
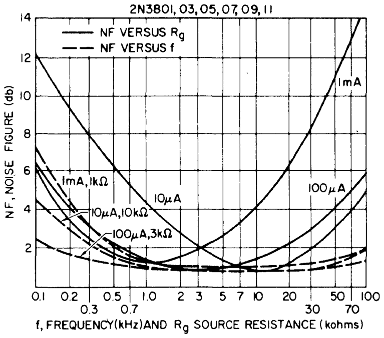
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Base Voltage Differential	$\lvert V_{BE1}-V_{BE2} \rvert$				
2N3802, 03, 08, 09		$I_C = 10\ \mu A$ to 10 mA, $V_{CE} = 5$ V		8	mV
2N3804, 05, 10, 11				5	
2N3802, 03, 08, 09		$I_C = 100\ \mu A$, $V_{CE} = 5$ V		5	
2N3804, 05, 10, 11				3	
Base Voltage Differential Change	$\Delta(V_{BE1}-V_{BE2})/\Delta T$				
2N3802, 03, 08, 09		$I_C = 100\ \mu A$, $V_{CE} = 5$ V		1.6	mV
2N3804, 05, 10, 11		$T_A = -55°C$ to $+25°C$		0.8	
2N3802, 03, 08, 09		$I_C = 100\ \mu A$, $V_{CE} = 5$ V		2.0	
2N3804, 05, 10, 11		$T_A = 25°C$ to $125°C$		1.0	
High Frequency Current Gain	$\lvert h_{fe} \rvert$	$I_C = 500\ \mu A$, $V_{CE} = 5$ V, f = 30 MHz	1.0		
		$I_C = 1$ mA, $V_{CE} = 5$ V, f = 100 MHz	1.0	5	
Small Signal Current Gain	h_{fe}				
2N3800, 02, 04, 06, 08, 10		$I_C = 1$ mA, $V_{CE} = 10$ V, f = 1 kHz	150	600	
2N3801, 03, 05, 07, 09, 11			300	900	
Output Capacitance	C_{ob}	$V_{CB} = 5$ V, $I_E = 0$, f = 100 kHz		4	pf
Input Capacitance	C_{ib}	$V_{EB} = 0.5$ V, $I_E = 0$, f = 100 kHz		8	pf
Voltage Feedback Ratio	h_{re}	$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz		25	$X10^{-4}$
Input Resistance	h_{ie}				
2N3800, 02, 04, 06, 08, 10		$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	3	15	K ohms
2N3081, 03, 05, 07, 09, 11			10	40	
Output Conductance	h_{oe}	$I_C = 1.0$ mA, $V_{CE} = 10$ V, f = 1 kHz	5	60	μ mhos
Noise Figure	NF				
2N3800, 02, 04, 06, 08, 10		$I_C = 100\ \mu A$, $V_{CE} = 10$ V, $R_S = 3\ k\Omega$		7	db
2N3801, 03, 05, 07, 09, 11		f = 100 Hz, BW = 20 Hz		4	
2N3800, 02, 04, 06, 08, 10		f = 1 kHz, BW = 200 Hz		3	
2N3801, 03, 05, 07, 09, 11				1.5	
2N3800, 02, 04, 06, 08, 10		f = 10 kHz, BW = 2 kHz		2.5	
2N3801, 03, 05, 07, 09, 11				1.5	
2N3800, 02, 04, 06, 08, 10		Noise Bandwidth 10 Hz to 10 kHz		3.5	
2N3801, 03, 05, 07, 09, 11		BW = 15.7 kHz		2.5	

* Pulse Test ≤ 300μsec, duty cycle ≤ 2%

** The lowest h_{FE} reading is taken as h_{FE1} for this ratio

Noise Figure vs Frequency and Source Resistance



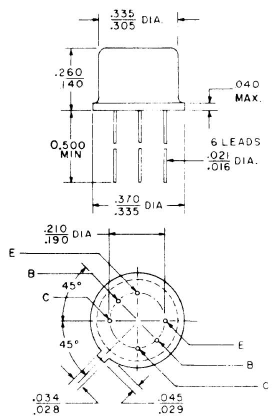


DUAL PNP TRANSISTOR
GENERAL PURPOSE

- LOW NOISE
- LOW SATURATION VOLTAGE
- HIGH BREAKDOWN VOLTAGE

JANUARY 1968

2N4017
2N4018
2N4019



MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING			UNIT
		4017	4018	4019	
Collector-Base Voltage	V_{CBO}	−45	−60	−80	Volts
Collector-Emitter Voltage	V_{CEO}	−45	−60	−80	Volts
Emitter-Base Voltage	V_{EBO}	6	6	6	Volts
		Each Side	Both Sides		
Collector Current	I_C	200			mA
Total Device Dissipation	P_D				
@ $T_A = 25°C$		0.4	0.6		Watts
@ $T_C = 25°C$		0.8	1.3		
Storage Temperature	T_{stg}	−65 to +200			°C
Junction Temperature	T_J	+200			°C
Derating Factor above 25°C					
@ $T_A = 25°C$		2.28	3.4		mW/°C
@ $T_C = 25°C$		4.57	7.4		

ELECTRICAL CHARACTERISTICS at +25 °C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$, $I_E = 0$			
2N4017			80		Volts
2N4018			60		
2N4019			45		
Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C = 5.0$ mA, $I_B = 0$			
2N4017			80		Volts
2N4018			60		
2N4019			45		
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 10\ \mu A$, $I_C = 0$	6.0		Volts
Base Saturation Voltage	$V_{BE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA		0.9	Volts
		$I_C = 50$ mA, $I_B = 5.0$ mA		0.95	
Collector Saturation Voltage	$V_{CE(sat)}$	$I_C = 10$ mA, $I_B = 0.5$ mA		0.25	Volts
		$I_C = 50$ mA, $I_B = 5.0$ mA		0.4	
Collector-Base Cutoff Current	I_{CBO}				
2N4017		$V_{CB} = 70$ V, $I_E = 0$		10	nA
2N4018		$V_{CB} = 50$ V, $I_E = 0$		10	
2N4019		$V_{CB} = 30$ V, $I_E = 0$		10	
2N4017		$V_{CB} = 70$ V, $I_E = 0$, $T_A = 125°C$		10	μA
2N4018		$V_{CB} = 50$ V, $I_E = 0$, $T_A = 125°C$		10	
2N4019		$V_{CB} = 30$ V, $I_E = 0$, $T_A = 125°C$		10	
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = 4.0$ V, $I_C = 0$		10	nA
DC Current Gain	h_{FE}				
2N4017, 2N4018		$I_C = 1.0\ \mu A$, $V_{CE} = 5$ V	60		
2N4019			180		
2N4017		$I_C = 10\ \mu A$, $V_{CE} = 5$ V	100	350	
2N4018			100	500	
2N4019			250	500	
2N4017, 2N4018		$I_C = 100\ \mu A$, $V_{CE} = 5$ V	100		
2N4019			250		
2N4017		$I_C = 1.0$ mA, $V_{CE} = 5$ V	100	500	
2N4018			100	600	
2N4019			250	600	
2N4017, 2N4018		$I_C = 10$ mA, $V_{CE} = 5$ V	100		
2N4019			200		

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
DC Current Gain	h_{FE}				
2N4017, 2N4018		$I_C = 50$ mA, $V_{CE} = 5$ V	90		
2N4019			180		
2N4017		$I_C = 1.0$ mA, $V_{CE} = 5$ V		600	
2N4018, 2N4019		$T_A = 100°C$		800	
2N4017, 2N4018		$I_C = 10$ μA, $V_{CE} = 5$ V	40		
2N4019		$T_A = -55°C$	100		
2N4017, 2N4018		$I_C = 50$ mA, $V_{CE} = 5$ V	40		
2N4019		$T_A = -55°C$	80		
2N4017		$I_C = 1.0$ mA, $V_{CE} = 5$ V	100	550	
2N4018		$T_A = -55°C$	100	700	
2N4019			250	700	
High Frequency Current Gain	$\|h_{fe}\|$				
2N4017, 2N4018		$I_C = 0.5$ mA, $V_{CE} = 5$ V	2.0	8.0	
2N4019		f = 20 MHz	2.5	8.0	
Output Capacitance	C_{ob}	$V_{CB} = 5.0$ V, f = 1.0 MHz, $I_E = 0$		6.0	pf
Small Signal Feedback Ratio	h_{re}	$I_C = 1.0$ mA, $V_{CE} = 5$ V f = 1 kHz		10	$X10^{-4}$
Input Impedance	h_{ie}				
2N4017		$I_C = 1.0$ mA, $V_{CE} = 5$ V	2.5	17	K ohms
2N4018		f = 1 kHz	2.5	20	
2N4019			6.0	20	
Output Conductance	h_{oe}				
2N4017		$I_C = 1.0$ mA, $V_{CE} = 5$ V	5	40	μmhos
2N4018, 2N4019		f = 1 kHz	5	40	
Noise Figure	NF	$I_C = 20$ μA, $V_{CE} = 5$ V			
2N4017, 2N4018		f = 1 kHz, BW = 150 Hz		3	db
2N4019		Rg = 10 kΩ		2	
		$I_C = 20$ μA, $V_{CE} = 5$ V			
2N4017, 2N4018		f = 100 Hz, BW = 15 Hz		10	
2N4019		Rg = kΩ		4	
2N4019		$I_C = 20$ μA, $V_{CE} = 5$ V		8	
		f = 10 Hz, BW = 2 Hz			
		Rg = 10 kΩ			

N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

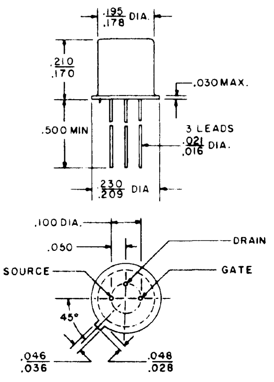
- LOW NOISE
- LOW CAPACITANCE
- HIGH TRANSCONDUCTANCE

JANUARY 1968

2N3069-71
2N3368-70

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING 2N3069-71	RATING 2N3368-70	UNIT
Total Device Dissipation @ $T_A = 25°C$	P_D	350	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		2.0	2.4	mW/°C
Storage Temperature	T_{stg}	−65 to +300	−65 to +175	°C
Junction Temperature	T_J	200	150	°C



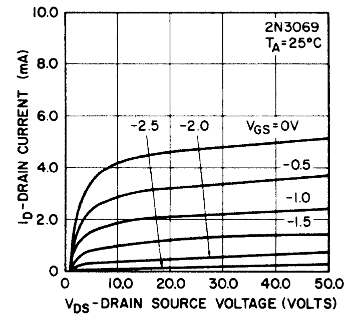
GATE IS INTERNALLY CONNECTED TO CASE

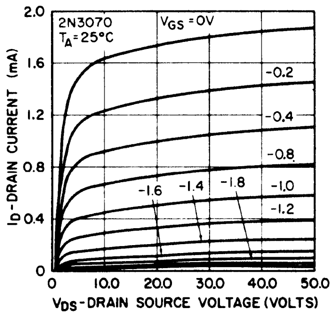
ELECTRICAL CHARACTERISTICS at +25 C (Unless Otherwise Specified)

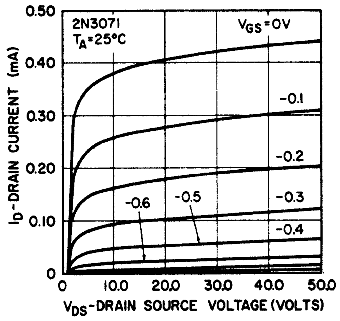
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}				
2N3069-71		$I_D = 1.0\ \mu A, I_S = 0$	50		Volts
2N3368-70			40		
Total Gate Leakage Current	I_{GSS}				
2N3069-71		$V_{GS} = -30\ V, V_{DS} = 0$		1.0	nA
2N3368-70				5.0	
2N3069-71		$V_{GS} = -30\ V, V_{DS} = 0$ $T_A = 150°C$		1.0	μA
2N3368-70		$V_{GS} = -30\ V, V_{DS} = 0$ $T_A = 100°C$		1.5	
Saturation Current	I_{DSS}				
2N3068		$V_{DS} = 30\ V, V_{GS} = 0$	2.0	10	mA
2N3069			2.0	12	
2N3369, 2N3070			0.5	2.5	
2N3370, 2N3071			0.1	0.6	
Pinch Off Voltage	V_P				
2N3069		$V_{DS} = 30\ V, I_D = 1.0\ nA$		10	Volts
2N3070				5.0	
2N3071				2.5	
2N3368				12	
2N3369				7.0	
2N3370				3.5	
Transconductance	g_m				
2N3368		$V_{DS} = 30\ V, V_{GS} = 0$	1000	2500	μmhos
2N3069		$f = 1.0\ kHz$	1000	4000	
2N3070			750	2500	
2N3369			600	2500	
2N3071			500	2500	
2N3370			300	2500	
Output Conductance	g_{os}				
2N3069		$V_{DS} = 30\ V, V_{GS} = 0$		80	μmhos
2N3070				30	
2N3071				7.0	
Output Capacitance	C_{os}				
2N3069-71		$V_{DS} = 30\ V, V_{GS} = 0$		1.5	pf

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{is}				
2N3069		$V_{DS} = 12$ V, $V_{GS} = 0$		15	pf
2N3070		$V_{DS} = 8.0$ V, $V_{GS} = 0$		15	
2N3071		$V_{DS} = 5.0$ V, $V_{GS} = 0$		15	
Drain-Gate Capacitance	C_{DG}				
2N3069		$V_{DG} = 10$ V, $I_S = 0$, f = 140 kHz		2.5	pf
2N3070		$V_{DG} = 8.0$ V, $I_S = 0$, f = 140 kHz		2.5	
2N3071		$V_{DG} = 5.0$ V, $I_S = 0$, f = 140 kHz		2.5	
2N3368		$V_{DG} = 10$ V, $I_S = 0$, f = 140 kHz		3.5	
2N3369		$V_{DG} = 8.0$ V, $I_S = 0$, f = 140 kHz		3.5	
2N3370		$V_{DG} = 5.0$ V, $I_S = 0$, f = 140 kHz		3.5	
Source-Gate Capacitance	C_{SG}				
2N3069		$V_{GS} = -10$ V, $I_D = 0$, f = 140 kHz		5.0	pf
2N3070		$V_{GS} = -8.0$ V, $I_D = 0$, f = 140 kHz		5.0	
2N3071		$V_{GS} = -5.0$ V, $I_D = 0$, f = 140 kHz		5.0	
2N3368		$V_{GS} = -10$ V, $I_D = 0$, f = 140 kHz		6.0	
2N3369		$V_{GS} = -8.0$ V, $I_D = 0$, f = 140 kHz		6.0	
2N3370		$V_{GS} = -5.0$ V, $I_D = 0$, f = 140 kHz		6.0	
Noise Figure	NF				
2N3069		$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1.0 kHz, Rg = 10 MΩ, BW = 200 Hz		4	db
2N3070		$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1.0 kHz, Rg = 10 MΩ, BW = 200 Hz		4	
2N3071		$V_{DS} = 5.0$ V, $V_{GS} = 0$ f = 1.0 kHz, Rg = 10 MΩ, BW = 200 Hz		4	

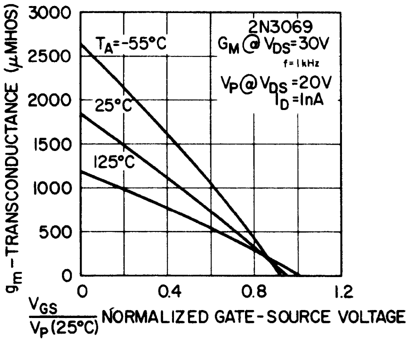
COMMON SOURCE – DRAIN CHARACTERISTICS

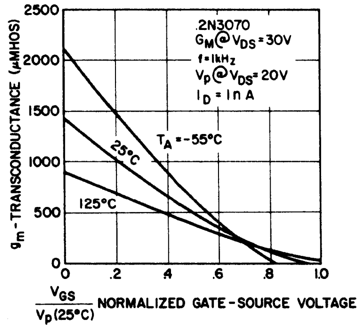


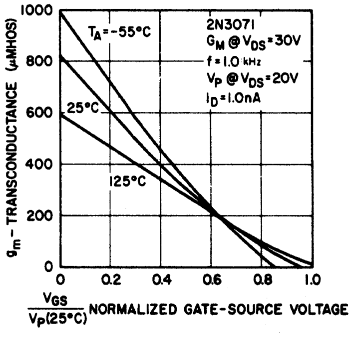




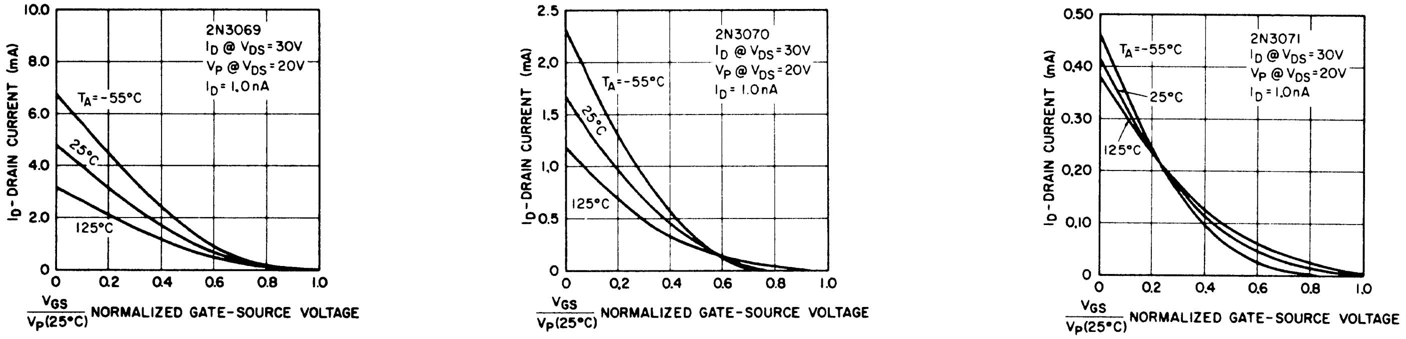
TRANSCONDUCTANCE VS. NORMALIZED GATE-SOURCE VOLTAGE



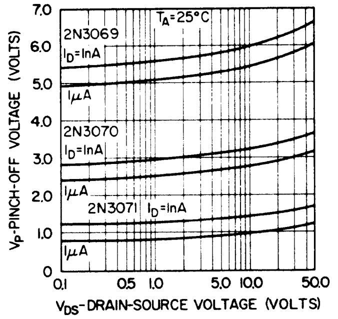




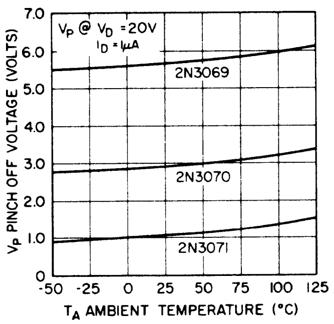
DRAIN CURRENT VS. NORMALIZED GATE-SOURCE VOLTAGE



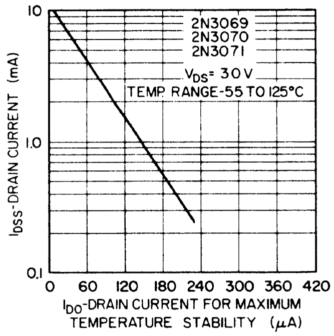
Pinch Off Voltage vs Drain Source Voltage



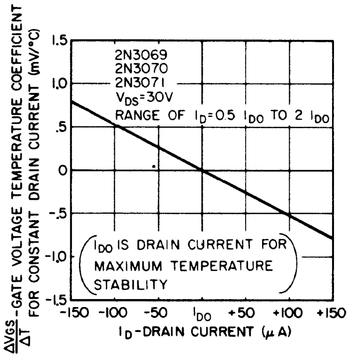
Pinch Off Voltage vs Temperature



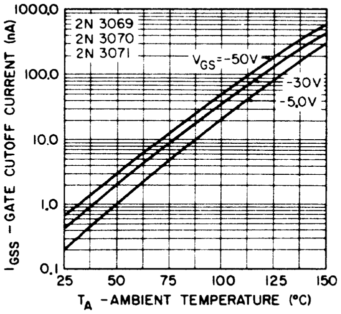
Drain Current For Maximum Temperature Stability vs I_{DSS}



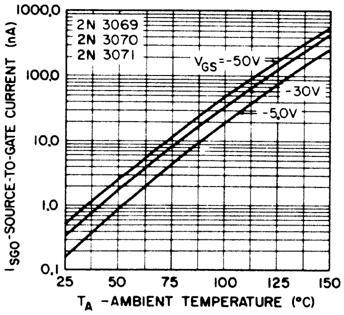
Gate Voltage Temperature Coefficient For Constant Drain Current vs Drain Current



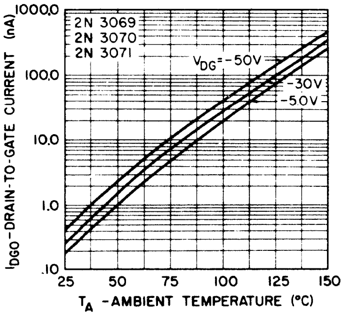
Gate Cutoff Current vs Temperature



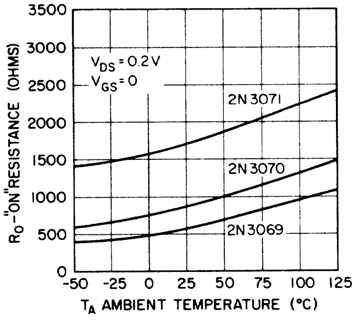
Source – Gate Reverse Current vs Temperature



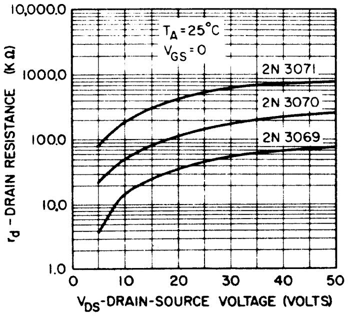
Drain – Gate Reverse Current vs Temperature



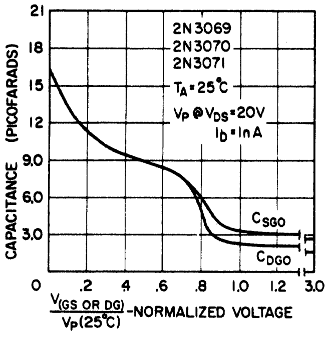
"ON" Resistance vs Temperature



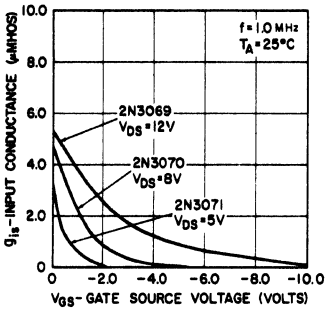
Dynamic Resistance vs Drain – Source Voltage



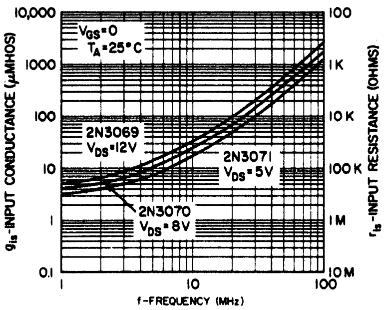
Junction Capacity
vs
Normalized Bias



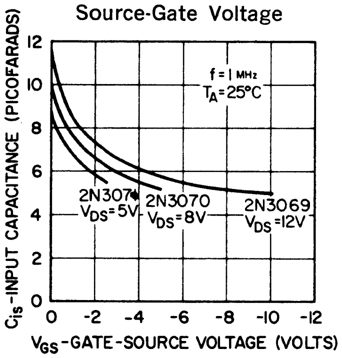
Input Conductance
vs
Gate – Source Voltage



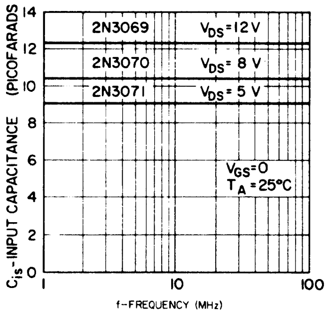
Input Conductance
vs
Frequency



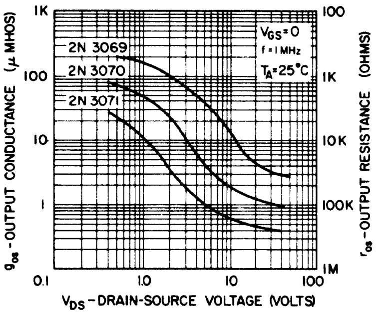
Input Capacitance
vs
Source-Gate Voltage



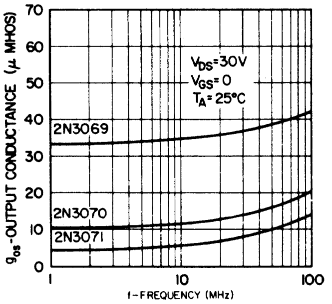
Input Capacitance
vs
Frequency



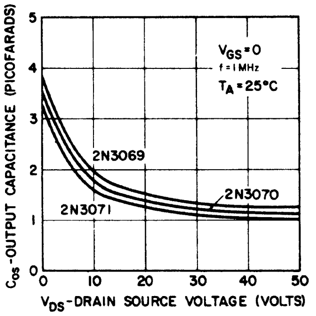
Output Conductance
vs
Drain Source Voltage



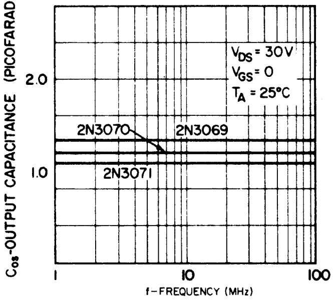
Output Conductance
vs
Frequency



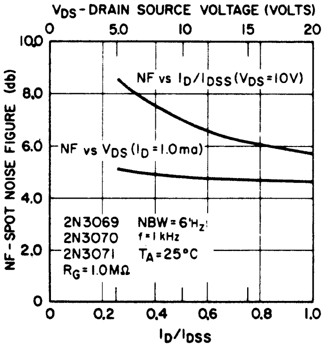
Output Capacitance
vs
Drain-Source Voltage



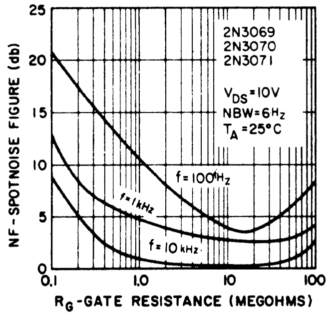
Output Capacitance
vs
Frequency



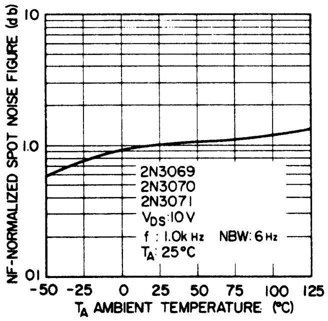
Spot Noise
vs
Drain – Source Voltage



Spot Noise
vs
Gate Resistance



Spot Noise
vs
Temperature



N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

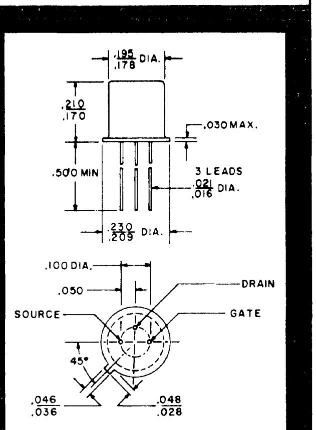
- HIGH TRANSCONDUCTANCE
- HIGH BREAKDOWN VOLTAGE
- LOW NOISE

JANUARY 1968

2N3436-38
2N3458-60

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.7	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A, I_S = 0$	50		Volts
Total Gate Leakage Current	I_{GSS}				
2N3436-38		$V_{GS} = -30\ V, V_{DS} = 0$		0.5	nA
2N3458-60				0.25	
2N3436-38		$V_{GS} = -30\ V, V_{DS} = 0$ $T_A = 150°C$		1.0	μA
2N3458-60				0.5	
Saturation Current	I_{DSS}				
2N3436, 2N3458		$V_{DS} = 20\ V, V_{GS} = 0$	3.0	15	mA
2N3437, 2N3459			0.8	4.0	
2N3438, 2N3460			0.2	1.0	
Pinch Off Voltage	V_P				
2N3436		$V_{DS} = 20\ V, I_D = 1.0\ nA$		10	Volts
2N3437				5.0	
2N3438				2.5	
2N3458				8.0	
2N3459				4.0	
2N3460				2.0	
Transconductance	g_m				
2N3436, 2N3458		$V_{DS} = 20\ V, V_{GS} = 0$	2500	10,000	μmhos
2N3437, 2N3459			1500	6000	
2N3438, 2N3460			800	4500	
Input Conductance	G_{is}				
2N3436, 2N3458		$V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ MHz$		4.0	μmhos
2N3437, 2N3459		$V_{DS} = 6.0\ V, V_{GS} = 0$ $f = 1.0\ MHz$		3.5	
2N3438, 2N3460		$V_{DS} = 4.0\ V, V_{GS} = 0$ $f = 1.0\ MHz$		2.5	
Output Conductance	G_{os}				
2N3436, 2N3458		$V_{DS} = 30\ V, V_{GS} = 0$ $f = 1.0\ MHz$		35	μmhos
2N3437, 2N3459				20	
2N3438, 2N3460				5.0	

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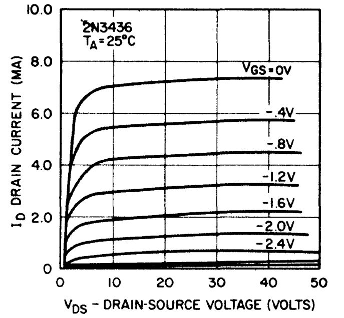
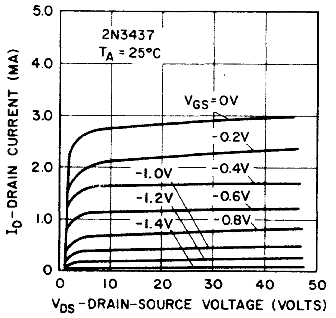
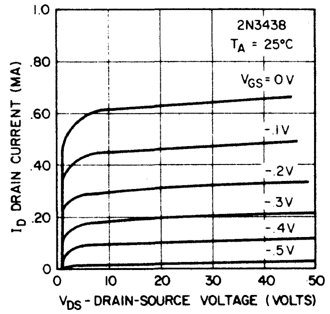
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{is}				
2N3436, 2N3458		$V_{DS} = 10$ V, $V_{GS} = 0$		18	pf
2N3437, 2N3459		$V_{DS} = 6.0$ V, $V_{GS} = 0$		18	
2N3438, 2N3460		$V_{DS} = 4.0$ V, $V_{GS} = 0$		18	
Output Capacitance	C_{os}				
2N3436-38		$V_{DS} = 30$ V, $V_{GS} = 0$		6.0	pf
2N3458-60		f = 1.0 MHz		5.0	
Drain-Gate Capacitance	C_{DG}	$V_{DG} = 10$ V, $I_S = 0$ f = 140 kHz		5.0	pf
Source-Gate Capacitance	C_{SG}	$V_{GS} = -10$ V, $I_D = 0$ f = 140 kHz		5.0	pf
Noise Figure	NF				
2N3458		$V_{DS} = 10$ V, $R_G = 1.0$ MΩ		6.0	db
2N3459		BW = 6.0 Hz, f = 20 Hz		2.0	
2N3460				1.5	
2N3436-38		$V_{DS} = 10$ V, $R_G = 1.0$ MΩ		2.0	
2N3458-60		BW = 6.0 Hz, f = 1.0 kHz		1.0	

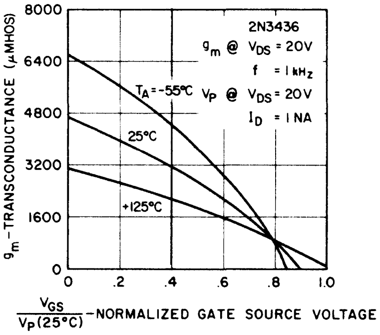
COMMON SOURCE-DRAIN CHARACTERISTICS

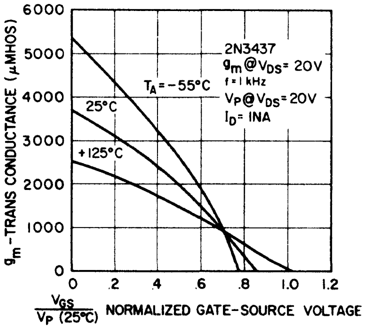


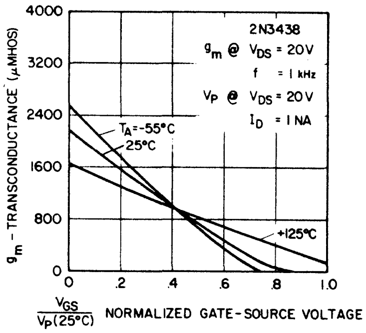




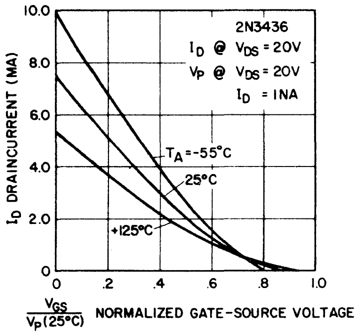
TRANSCONDUCTANCE VS NORMALIZED GATE-SOURCE VOLTAGE

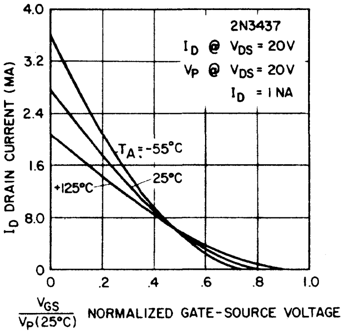


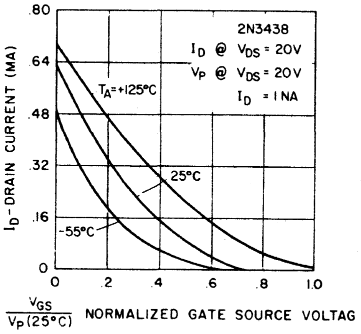




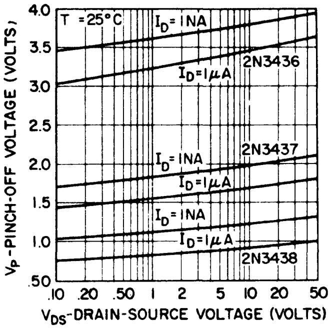
DRAIN CURRENT VS NORMALIZED GATE-SOURCE VOLTAGE



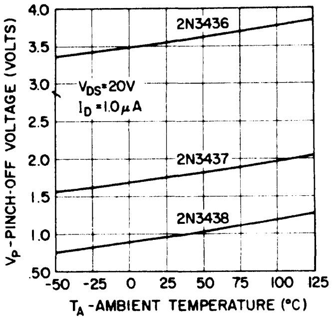




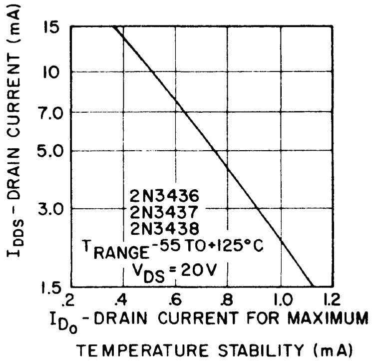
Pinch Off Voltage
vs
Drain-Source Voltage



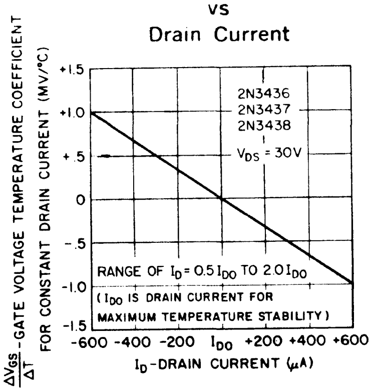
Pinch Off Voltage
vs
Temperature



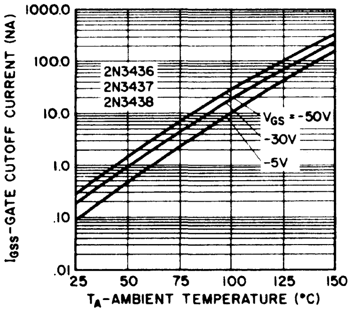
Drain Current for
Maximum Temperature
Stability
vs
I_{DSS}



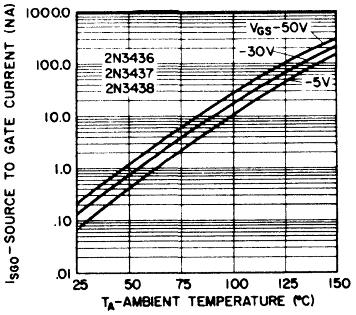
Gate Voltage Temperature
Coefficient for Constant
Drain Current
vs
Drain Current



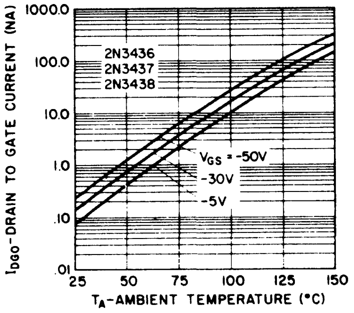
Gate Cutoff Current
vs
Temperature



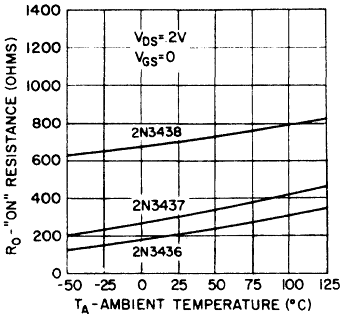
Source-Gate
Reverse Current
vs
Temperature



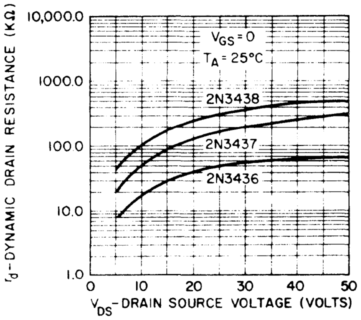
Drain-Gate
Reverse Current
vs
Temperature



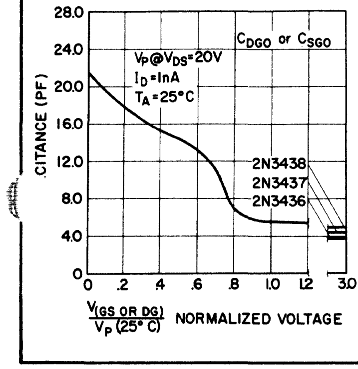
"On" Resistance
vs
Temperature



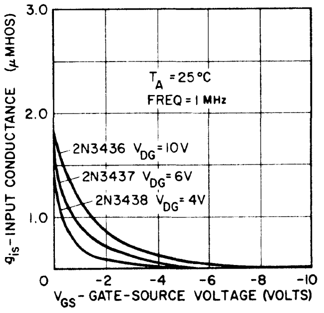
Dynamic Resistance
vs
Drain-Source Voltage



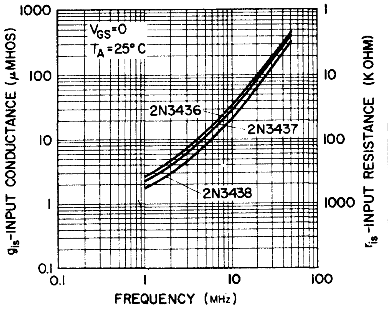
Junction Capacitance
vs
Normalized Bias



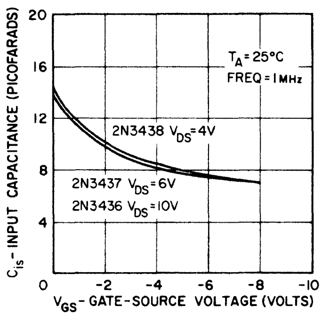
Input Conductance
vs
Gate-Source Voltage



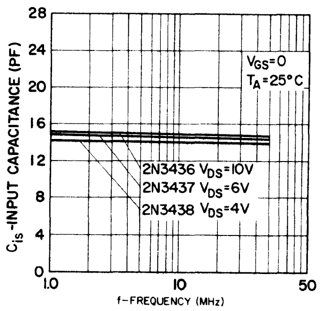
Input Conductance
vs
Frequency



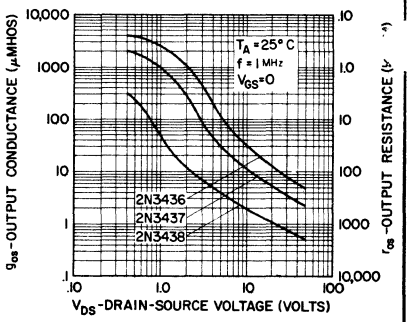
Input Capacitance
vs
Source-Gate Voltage



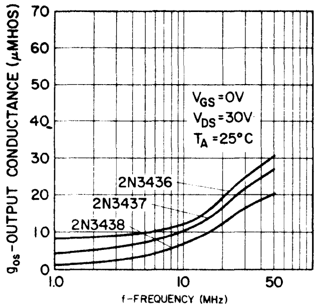
Input Capacitance
vs
Frequency



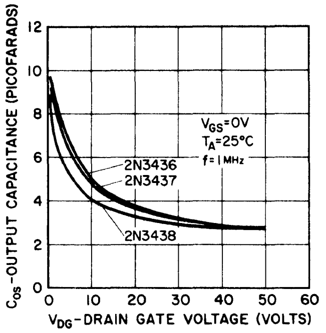
Output Conductance
vs
Drain-Source Voltage



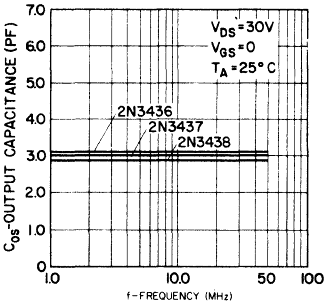
Output Conductance
vs
Frequency



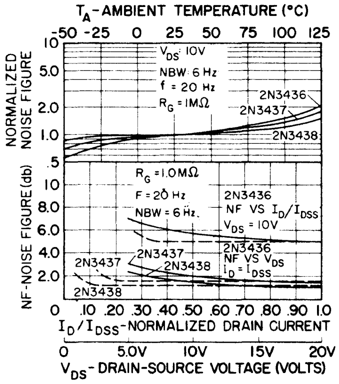
Output Capacitance
vs
Drain-Source Voltage



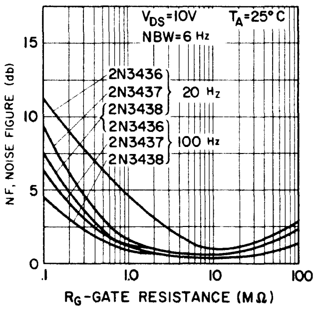
Output Capacitance
vs
Frequency



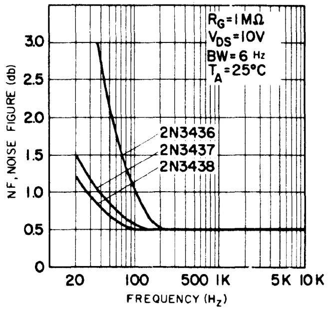
Noise Figure
vs
Drain Current
Drain-Source Voltage
and Temperature



Noise Figure
vs
Gate Resistance



Noise Figure
vs
Frequency



N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

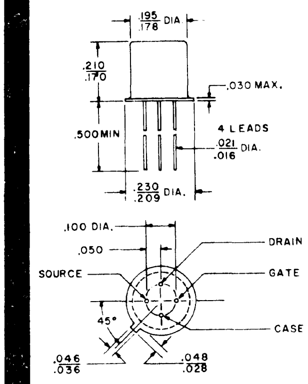
- LOW NOISE
- HIGH BREAKDOWN VOLTAGE
- LOW LEAKAGE

JANUARY 1968

2N3452
THRU
2N3457

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Storage Temperature	T_{stg}	−55 to +200	°C
Junction Temperature	T_J	200	°C
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.7	mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A$, $I_S = 0$	50		Volts
Total Gate Leakage Current	I_{GSS}				
2N3452-54		$V_{GS} = -30$ V, $V_{DS} = 0$		0.1	nA
2N3455-57				0.04	
2N3452-54		$V_{GS} = -30$ V, $V_{DS} = 0$ $T_A = 150°C$		400	
2N3455-57				150	
Saturation Current	I_{DSS}				
2N3452, 2N3455		$V_{DS} = 30$ V, $V_{GS} = 0$	0.8	4.0	mA
2N3453, 2N3456			0.2	1.0	
2N3454, 2N3457			0.05	0.25	
Pinch Off Voltage	V_P				
2N3452, 2N3455		$V_{DS} = 20$ V, $I_D = 0.5$ nA		10	Volts
2N3453, 2N3456				5.0	
2N3454, 2N3457				2.5	
Transconductance	g_m				
2N3452		$V_{DS} = 30$ V, $V_{GS} = 0$	200	1200	μmhos
2N3453		f = 1.0 kHz	150	900	
2N3454			100	600	
2N3455			400	1200	
2N3456			300	900	
2N3457			150	600	
Input Conductance	g_{is}				
2N3452, 2N3455		$V_{DS} = 12$ V, $V_{GS} = 0$ f = 1.0 MHz		1.0	μmhos
2N3453, 2N3456		$V_{DS} = 8.0$ V, $V_{GS} = 0$ f = 1.0 MHz		1.0	
2N3454, 2N3457		$V_{DS} = 4.0$ V, $V_{GS} = 0$ f = 1.0 MHz		1.0	
Output Conductance	g_{os}				
2N3452, 2N3455		$V_{DS} = 30$ V, $V_{GS} = 0$		15	μmhos
2N3453, 2N3456		f = 1.0 MHz		5.0	
2N3454, 2N3457				3.0	

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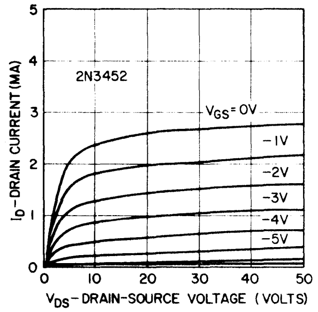
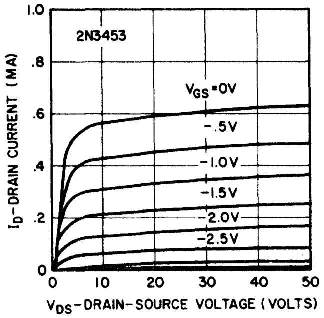
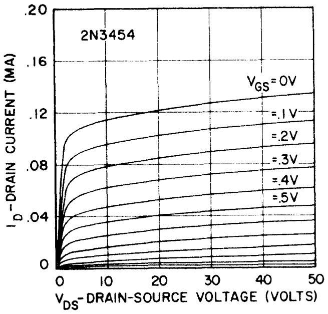
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{is}				
2N3452		$V_{DS} = 12$ V, $V_{GS} = 0$		6.0	pf
2N3455		f = 1.0 MHz		5.0	
2N3453		$V_{DS} = 8.0$ V, $V_{GS} = 0$		6.0	
2N3456		f = 1.0 MHz		5.0	
2N3454		$V_{DS} = 4.0$ V, $V_{GS} = 0$		6.0	
2N3457		f = 1.0 MHz		5.0	
Output Capacitance	C_{os}	$V_{DS} = 30$ V, $V_{GS} = 0$ f = 1.0 MHz		1.5	pf
Drain-Gate Capacitance	C_{DG}				
2N3452-54		$V_{DG} = 10$ V, $I_S = 0$		1.2	pf
2N3455-57		f = 140 kHz		1.0	
Source-Gate Capacitance	C_{SG}				
2N3452-54		$V_{GS} = -10$ V, $I_D = 0$		1.8	pf
2N3455-57		f = 140 kHz		1.5	
Noise Figure	NF				
2N3455-57		$V_{DS} = 10$ V, $R_G = 1.0$ MΩ		4.0	db
2N3452		BW = 6.0 Hz, f = 20 Hz		6.0 (Typ.)	
2N3453				5.0 (Typ.)	
2N3454				4.0 (Typ.)	
2N3455-57		$V_{DS} = 10$ V, $R_G = 1.0$ MΩ		1.0	
2N3452-54		BW = 6.0 Hz, f = 100 Hz.		2.0	

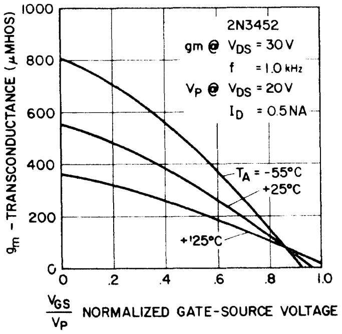
COMMON SOURCE — DRAIN CHARACTERISTICS

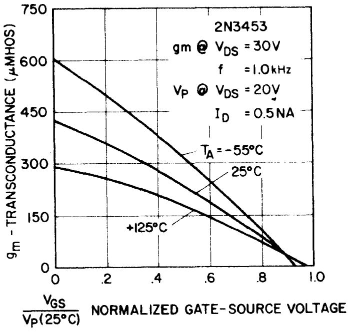


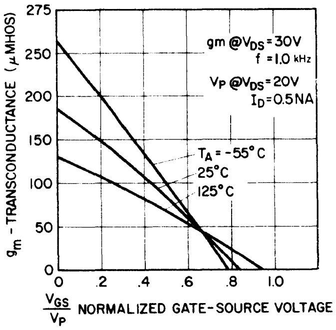




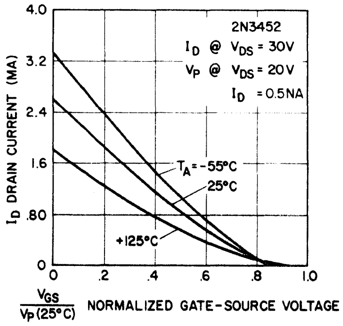
TRANSCONDUCTANCE VS NORMALIZED GATE - SOURCE VOLTAGE

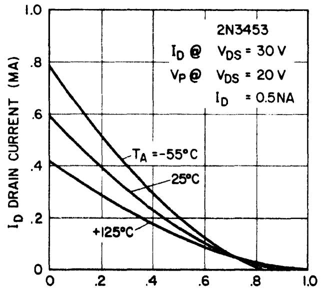


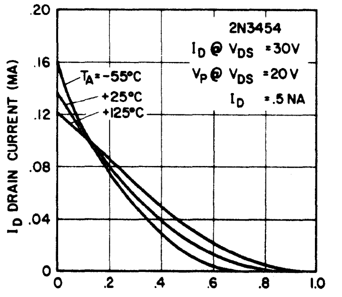




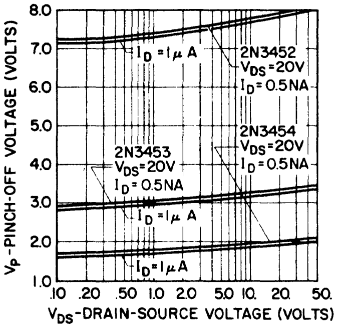
DRAIN CURRENT VS NORMALIZED GATE - SOURCE VOLTAGE



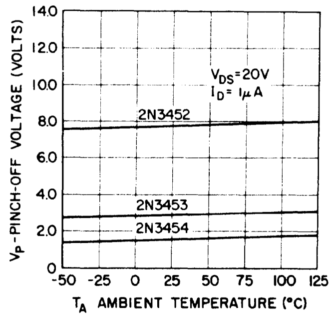




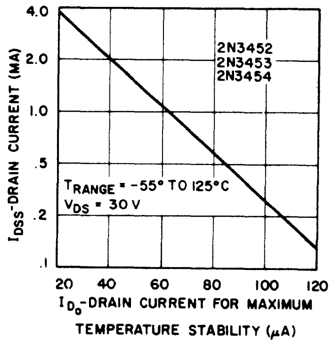
Pinch Off Voltage
vs
Drain-Source Voltage



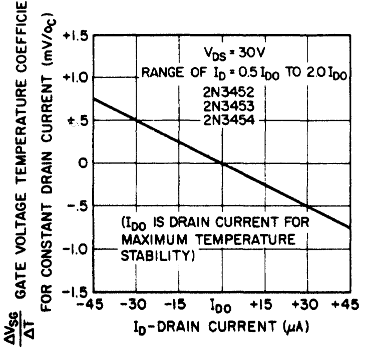
Pinch Off Voltage
vs
Temperature



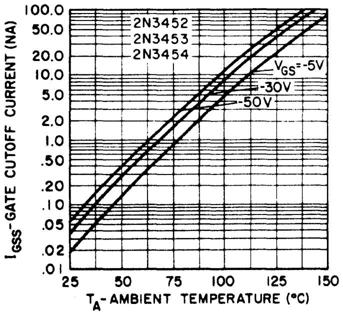
Drain Current for
Maximum Temperature
Stability
vs
I_{DSS}



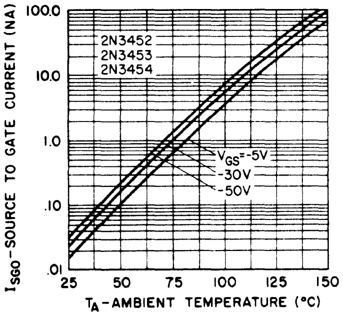
Gate Voltage Temperature
Coefficient for Constant
Drain Current
vs
Drain Current



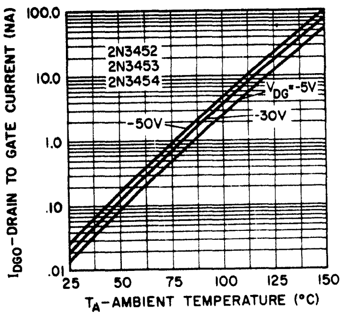
Gate Cutoff Current
vs
Temperature



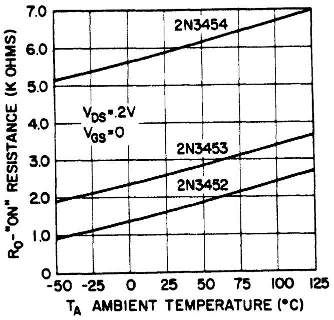
Source-Gate
Reverse Current
vs
Temperature



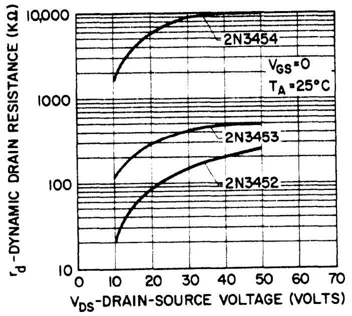
Drain-Gate
Reverse Current
vs
Temperature



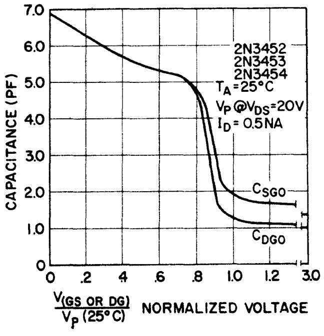
"On" Resistance
vs
Temperature



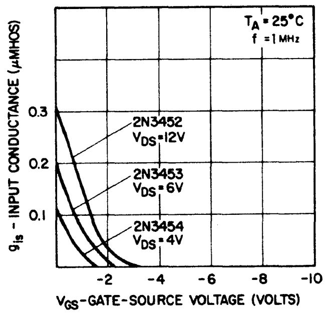
Dynamic Resistance
vs
Drain-Source Voltage



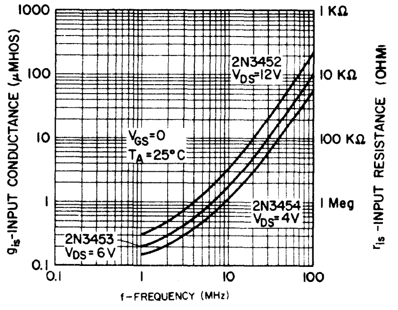
Junction Capacitance
vs
Normalized Bias



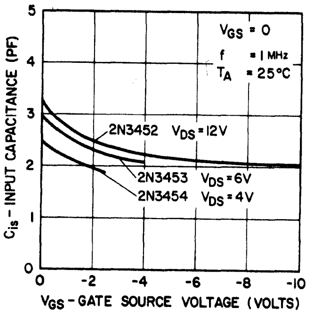
Input Conductance
vs
Gate-Source Voltage



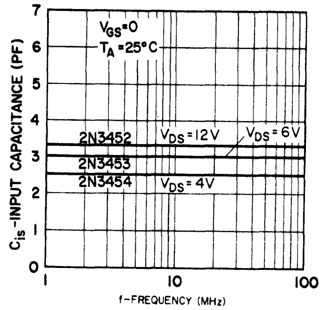
Input Conductance
vs
Frequency



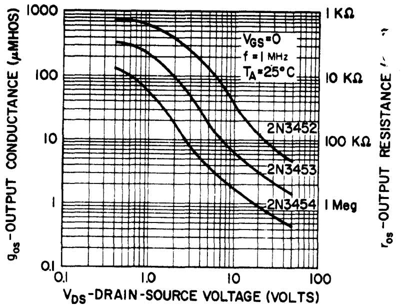
Input Capacitance vs Source-Gate Voltage



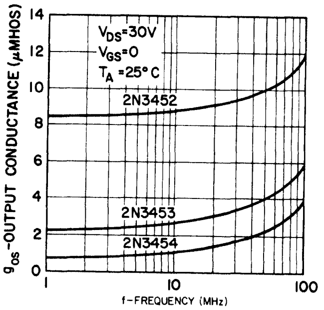
Input Capacitance vs Frequency



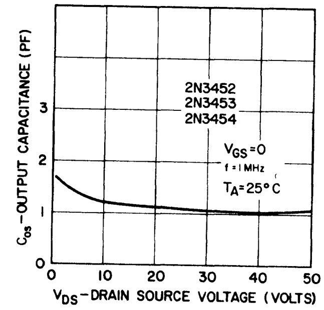
Output Conductance vs Drain-Source Voltage



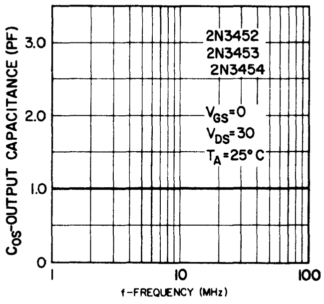
Output Conductance vs Frequency



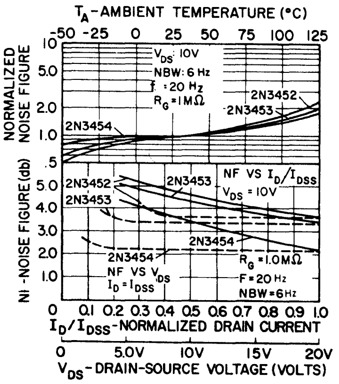
Output Capacitance vs Drain-Source Voltage



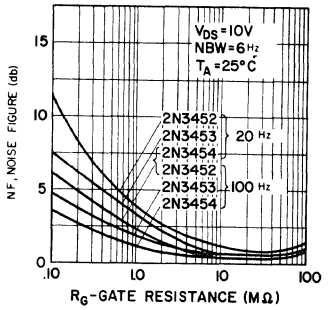
Output Capacitance vs Frequency



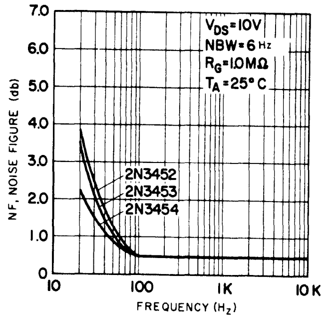
Noise Figure vs Drain Current Drain-Source Voltage and Temperature



Noise Figure vs Gate Resistance



Noise Figure vs Frequency



N-CHANNEL FIELD EFFECT TRANSISTOR
RF/IF AMPLIFIER

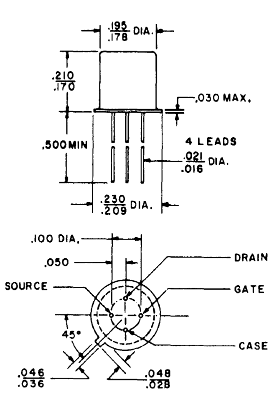
- LOW NOISE
- HIGH TRANSCONDUCTANCE
- LOW CAPACITANCE

JANUARY 1968

2N3823

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Gate-Source Voltage	V_{GS}	30	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		2.0	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	175	°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$	$I_D = 50$ nA, $V_{DS} = 15$ V		8.0	Volts
Gate-Source Voltage	V_{GS}	$I_D = 0.4$ mA, $V_{DS} = 15$ V	1.0	7.5	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = 20$ V, $V_{DS} = 0$		0.50	nA
		$V_{GS} = 20$ V, $V_{DS} = 0$, $T_A = 150°C$		500	
Zero-Gate-Voltage Current	I_{DSS}*	$V_{DS} = 15$ V, $V_{GS} = 0$	4.0	20	mA
Input Capacitance	C_{iss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1.0 MHz		6.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1.0 MHz		2.0	pf
Forward Transfer Admittance	$\|Y_{fs}\|$*	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1.0 kHz	3500	6500	μmhos
		$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz	3200		
Input Admittance	Y_{is}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		800	μmhos
Output Admittance	$\|Y_{os}\|$*	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1.0 kHz		35	μmhos
		$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		200	
Noise Figure	NF	$V_{DS} = 15$ V, $V_{GS} = 0$ $R_S = 1000\ \Omega$, f = 100 MHz		2.5	db

* Pulse Test: Pulse Width = 100 ms; Duty Cycle = 10%.

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Printed in U.S.A.

N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

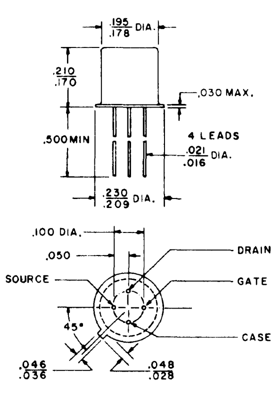
- LOW NOISE
- LOW CAPACITANCE
- FAST SWITCHING SPEEDS

JANUARY 1968

2N3966-69
THRU
2N3967A-69A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gain Voltage	V_{DG}	30	Volts
Reverse Gate-Source Voltage	V_{GS}	30	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.3	Watts
Derating Factor Above 25°C @ $T_A = 25°C$		1.71	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Voltage	V_{GS}				
2N3967, 2N3967A		$V_{DS} = 20\ V, I_D = 0.25\ mA$	1.0	4.5	Volts
2N3968, 2N3968A		$V_{DS} = 20\ V, I_D = 0.10\ mA$	0.5	2.8	
2N3969, 2N3969A		$V_{DS} = 20\ V, I_D = 0.04\ mA$	0.3	1.6	
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
2N3966		$V_{DS} = 10\ V, I_D = 10\ nA$	4.0	6.0	Volts
2N3967, 2N3967A		$V_{DS} = 20\ V, I_D = 1.0\ nA$	2.0	5.0	
2N3968, 2N3968A				3.0	
2N3969, 2N3969A				1.7	
Drain Cutoff Current	$I_{D(OFF)}$				
2N3966		$V_{DS} = 10\ V, V_{GS} = -7.0\ V$		1.0	nA
2N3966		$V_{DS} = 10\ V, V_{GS} = -7.0\ V, T_A = 150°C$		2.0	µA
Gate-Drain Leakage Current	I_{DGO}				
2N3966		$V_{DG} = 20\ V, I_S = 0$		0.1	nA
2N3966		$V_{DG} = 20\ V, I_D = 0, T_A = 150°C$		0.2	µA
Gate Reverse Current	I_{GSS}	$V_{GS} = 20\ V, V_{DS} = 0$		0.1	nA
		$V_{GS} = 20\ V, V_{DS} = 0, T_A = 150°C$		0.2	µA
Zero-Gate-Voltage Drain Current	I_{DSS}				
2N3966		$V_{DS} = 20\ V, V_{GS} = 0$	2.0		mA
2N3967, 2N3967A			2.5	10	
2N3968, 2N3968A			1.0	5.0	
2N3969, 2N3969A			0.4	2.0	
Drain-Source "ON" Resistance	$r_{ds(ON)}$				
2N3966		$V_{DS} = 0, V_{GS} = 0$		220	Ohms
2N3967, 2N3967A		$f = 1.0\ kHz$		400	
2N3968, 2N3968A				700	
Rise Time	t_r				
2N3966		See Figures 1 & 2		100	nsec
Turn-on Delay Time	t_d				
2N3966		See Figures 1 & 2		20	nsec
Turn-off Time	t_{off}				
2N3966		See Figures 1 & 2		100	nsec

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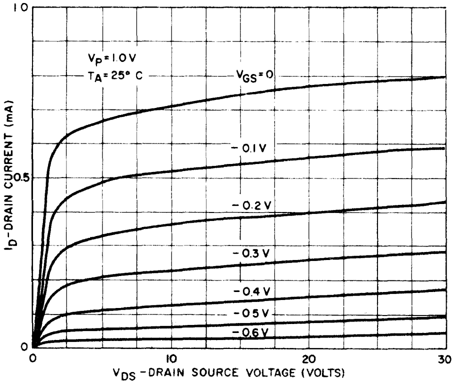
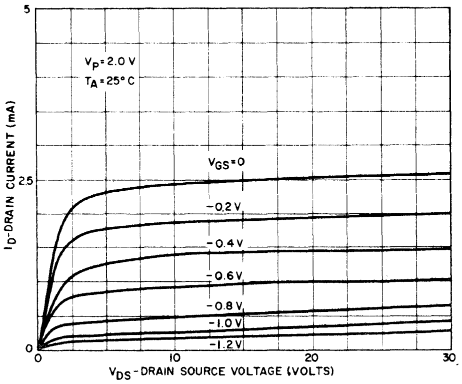
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{iss}				
2N3966		$V_{DS} = 20$ V, $V_{GS} = 0$ f = 1.0 MHz		6.0	pf
2N3967A		$V_{DS} = 20$ V, $I_D = 0.25$ mA f = 1.0 MHz		5.0	
2N3968A		$V_{DS} = 20$ V, $I_D = 0.10$ mA f = 1.0 MHz		5.0	
2N3969, 2N3969A		$V_{DS} = 20$ V, $I_D = 0.04$ mA f = 1.0 MHz		5.0	
Reverse Transfer Capacitance	C_{rss}				
2N3966		$V_{DS} = 0$, $V_{GS} = 7.0$ V f = 1.0 MHz		1.5	pf
2N3967, 2N3967A		$V_{DS} = 20$ V, $I_D = 1.0$ mA f = 1.0 MHz		1.3	
2N3968, 2N3968A		$V_{DS} = 20$ V, $I_D = 0.5$ mA f = 1.0 MHz		1.3	
2N3969, 2N3969A		$V_{DS} = 20$ V, $I_D = 0.2$ mA f = 1.0 MHz		1.3	
Transadmittance	Y_{fs}				
2N3967, 2N3967A		$V_{DS} = 20$ V, $V_{GS} = 0$	2500		μmhos
2N3968, 2N3968A		f = 1.0 kHz	2000		
2N3969, 2N3969A			1300		
Forward Transadmittance	Y_{fs}				
2N3967, 2N3967A		$V_{DS} = 20$ V, $I_D = 0.25$ mA	1600	2400	μmhos
2N3968, 2N3968A		$V_{DS} = 20$ V, $I_D = 0.10$ mA	1400	2000	
2N3969, 2N3969A		$V_{DS} = 20$ V, $I_D = 0.04$ mA	950	1450	
Forward Transadmittance	Y_{fs}				
2N3967, 2N3967A		$V_{DS} = 20$ V, $V_{GS} = 0$	1600		μmhos
2N3968, 2N3968A		f = 10 MHz	1400		
2N3969, 2N3969A			950		
Output Admittance	Y_{os}				
2N3967, 2N3967A		$V_{DS} = 20$ V, $I_D = 0.25$ mA f = 1.0 MHz		35	μmhos
2N3968, 2N3968A		$V_{DS} = 20$ V, $I_D = 0.10$ mA f = 1.0 MHz		15	
2N3969, 2N3969A		$V_{DS} = 20$ V, $I_D = 0.04$ mA f = 1.0 MHz		5.0	
Noise Figure	NF				
2N3967-2N3969A		$V_{DS} = 20$ V, $V_{GS} = 0$ $R_G = 1.0$ MΩ f = 100 Hz BW = 6 Hz		1.5	db
2N3967A, 68A, 69A		$V_{DS} = 10$ V, $V_{GS} = 0$ $R_G = 1.0$ MΩ f = 10 Hz BW = 6 Hz		4.0	
2N3967A, 68A, 69A		$V_{DS} = 10$ V, $V_{GS} = 0$ $R_G = 1.0$ MΩ f = 1.0 kHz BW = 200 Hz		1.0	

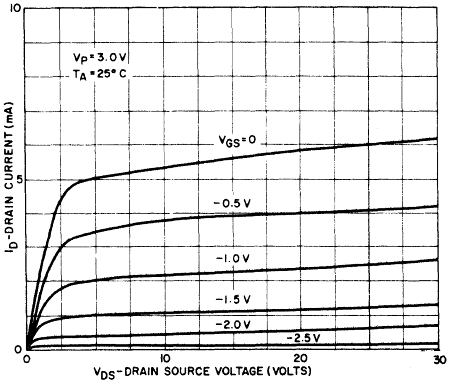
COMMON SOURCE-DRAIN CHARACTERISTICS



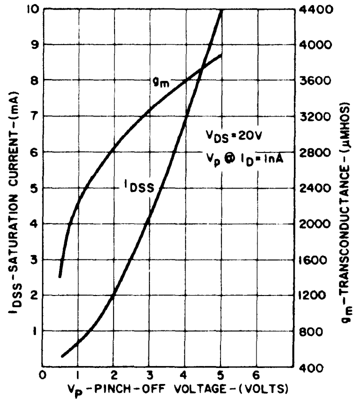
COMMON SOURCE-DRAIN CHARACTERISTICS



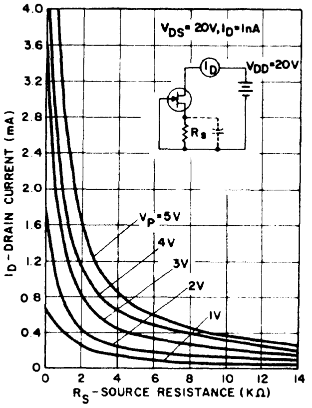
COMMON SOURCE-DRAIN CHARACTERISTICS



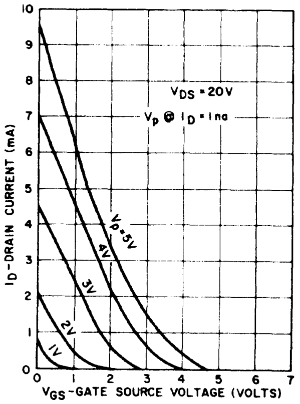
TRANSCONDUCTANCE
AND DRAIN CURRENT
VS
PINCH-OFF VOLTAGE



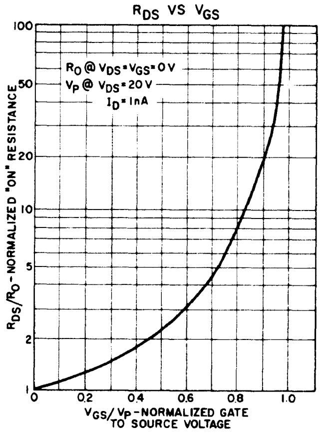
SOURCE FOLLOWER
DRAIN CURRENT
VS
SOURCE RESISTANCE



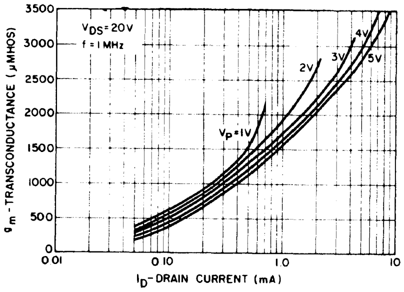
DRAIN CURRENT
VS
GATE-SOURCE BIAS



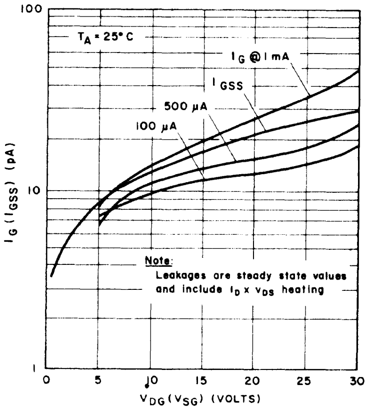
NORMALIZED
R_{DS} VS V_{GS}



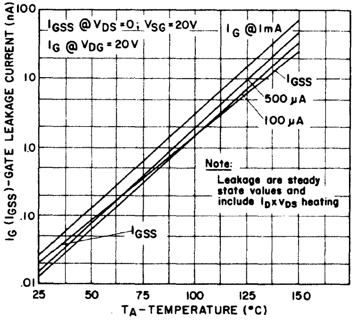
TRANSCONDUCTANCE
VS
DRAIN CURRENT



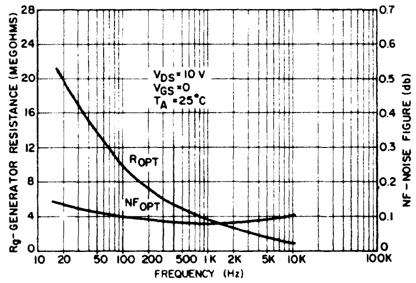
GATE LEAKAGE CURRENT
VS
VOLTAGE



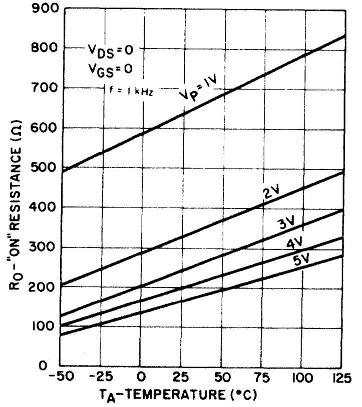
GATE LEAKAGE CURRENT
VS
TEMPERATURE



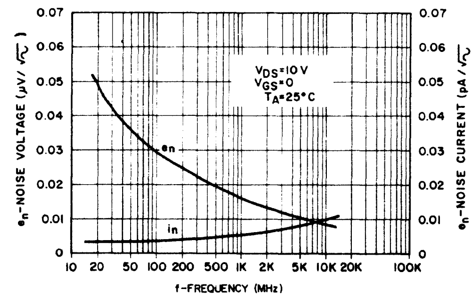
OPTIMUM GENERATOR RESISTANCE
AND
NOISE FIGURE



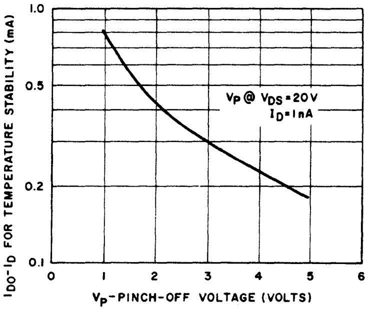
"ON" RESISTANCE
VS
TEMPERATURE



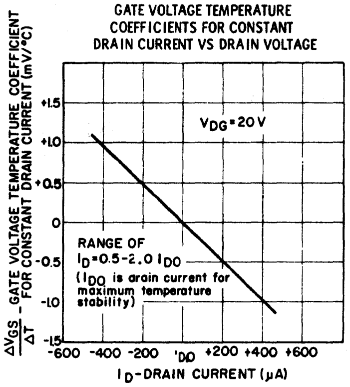
NOISE VOLTAGE/CURRENT
VS
FREQUENCY



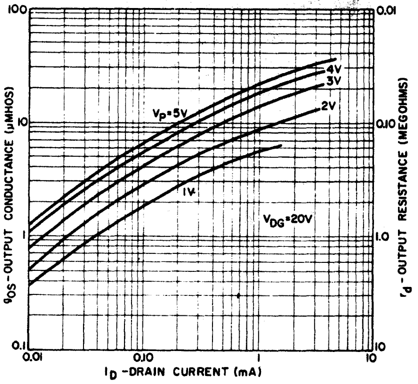
DRAIN CURRENT FOR MAXIMUM TEMPERATURE STABILITY



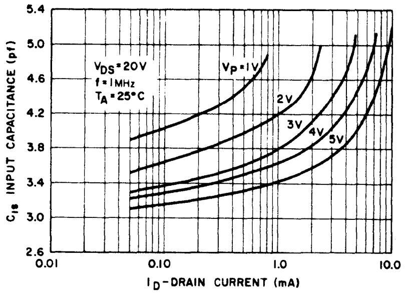
GATE VOLTAGE TEMPERATURE COEFFICIENTS FOR CONSTANT DRAIN CURRENT VS DRAIN VOLTAGE



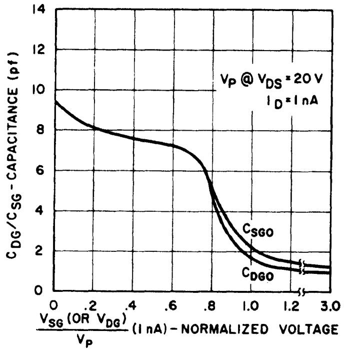
OUTPUT CONDUCTANCE VS DRAIN CURRENT



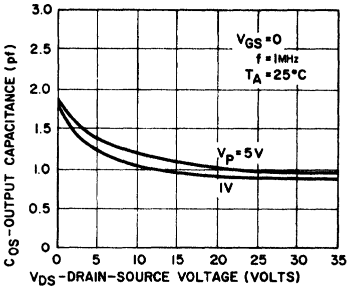
INPUT CAPACITANCE VS DRAIN CURRENT



JUNCTION CAPACITANCE VS NORMALIZED BIAS



OUTPUT CAPACITANCE VS DRAIN SOURCE VOLTAGE



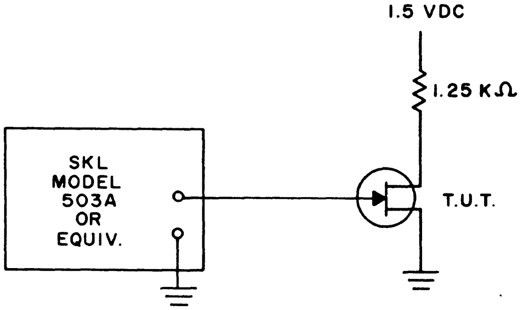


FIGURE 1

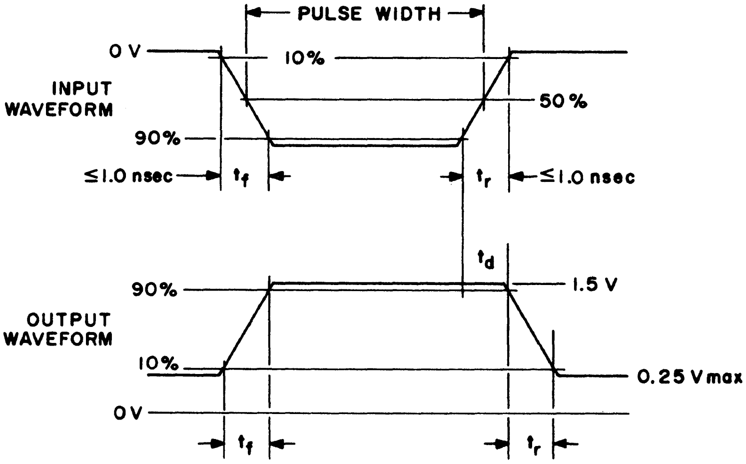


FIGURE 2

N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

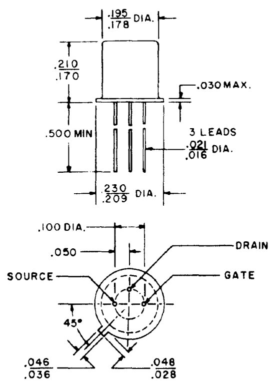
- HIGH TRANSCONDUCTANCE
- LOW LEAKAGE
- LOW NOISE

JANUARY 1968

2N4139

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor Above 25°C @ $T_A = 25°C$		1.7	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A, I_S = 0$	50		Volts
Source-Gate Breakdown Voltage	BV_{SGO}	$I_S = 1.0\ \mu A, I_D = 0$	50		Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -30\ V, V_{DS} = 0$ $V_{GS} = -30\ V, V_{DS} = 0, T_A = 125°C$		1.0 1.0	nA μA
Saturation Current	I_{DSS}	$V_{DS} = 20\ V, V_{GS} = 0$	8.0	11	mA
Pinch Off Voltage	V_P	$V_{DS} = 20\ V, I_D = 1.0\ nA$	2.0	8.0	Volts
Transconductance	g_m	$V_{DS} = 20\ V, V_{GS} = 0$ $f = 1.0\ kHz$ $V_{DS} = 20\ V, V_{GS} = 0$ $f = 1.0\ MHz$	3500 3000	7000	μmhos
Short-circuit, common-source input conductance	G_{is}	$V_{DS} = 20\ V, V_{GS} = 0$ $f = 1.0\ MHz$		4.0	μmhos
Output Conductance	g_{os}	$V_{DS} = 20\ V, V_{GS} = 0$ $f = 1.0\ MHz$		35	μmhos
Input Capacitance	C_{is}	$V_{DS} = 20\ V, V_{GS} = 0$ $f = 1.0\ MHz$		18	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 20\ V, V_{GS} = 0$ $f = 140\ kHz$		5.0	pf
Drain to Gate Capacitance	C_{DG}	$V_{DG} = 10\ V, I_S = 0$ $f = 140\ kHz$		5.0	pf
Noise Figure	NF	$V_{DS} = 20\ V, V_{gs} = 0, R_G = 1.0\ M\Omega$ $f = 1.0\ kHz, BV = 6.0\ Hz$		2.0	db

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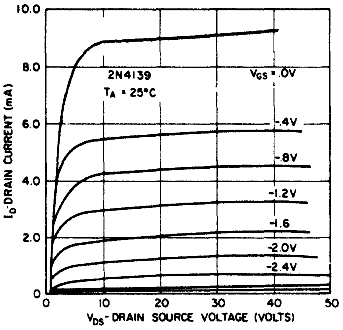
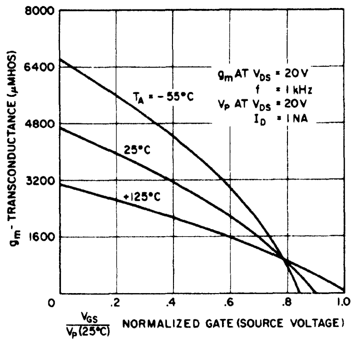
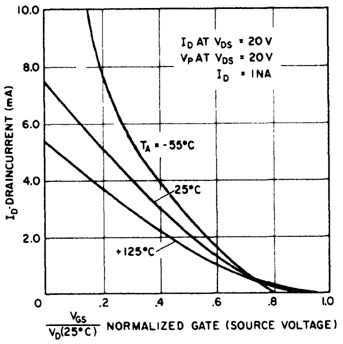
Common Source-Drain Characteristics



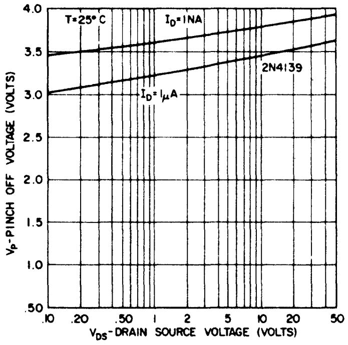
Transconductance vs Normalized Gate-Source Voltage



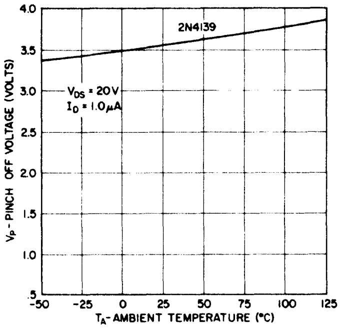
Drain Current vs Normalized Gate-Source Voltage



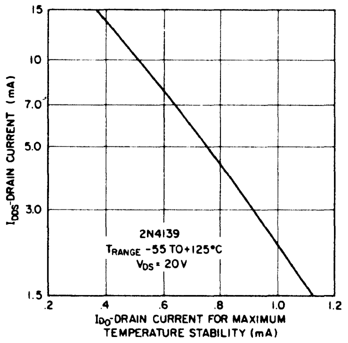
Pinch Off Voltage vs Drain-Source Voltage



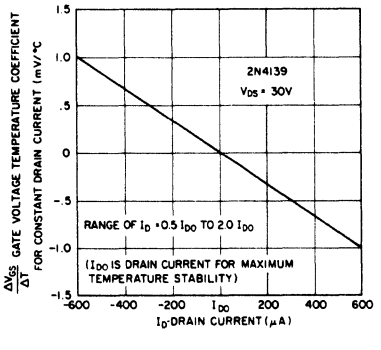
Pinch Off Voltage vs Temperature



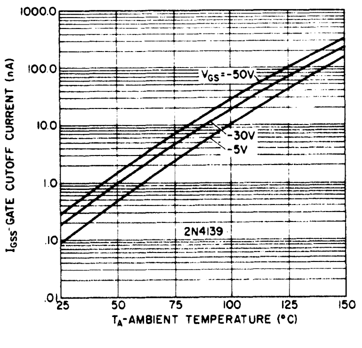
Drain Current for Maximum Temperature Stability vs I_{DSS}



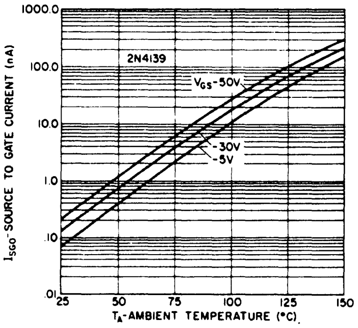
Gate Voltage Temperature Coefficient for Constant Drain Current vs Drain Current



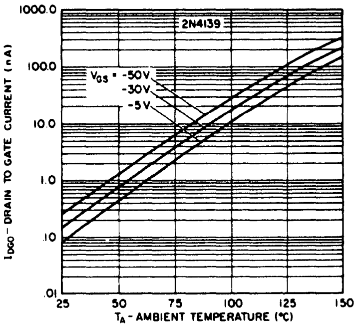
Gate Cutoff Current vs Temperature



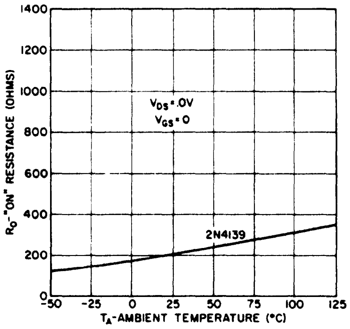
Source-Gate Reverse Current vs Temperature



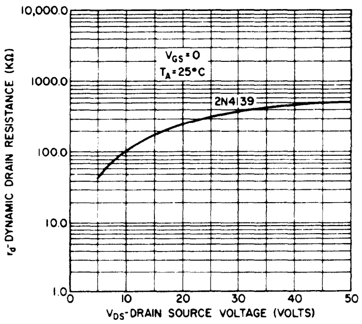
Drain-Gate Reverse Current vs Temperature



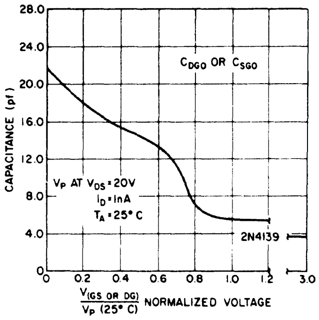
"On" Resistance vs Temperature



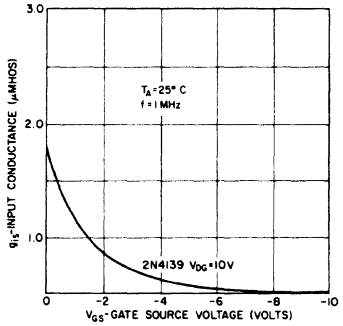
Dynamic Resistance vs Drain-Source Voltage



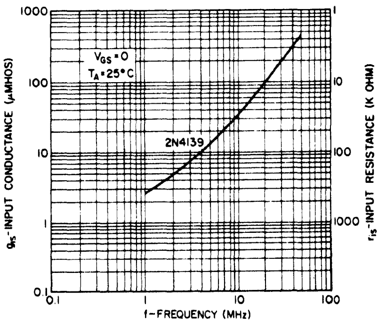
Junction Capacity vs Normalized Bias



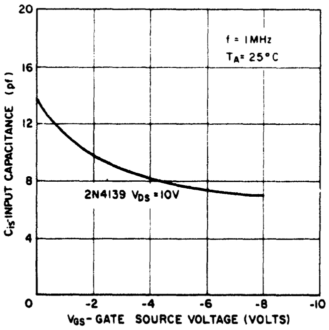
Input Conductance vs Gate-Source Voltage



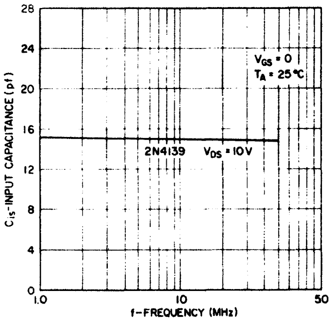
Input Conductance vs Frequency



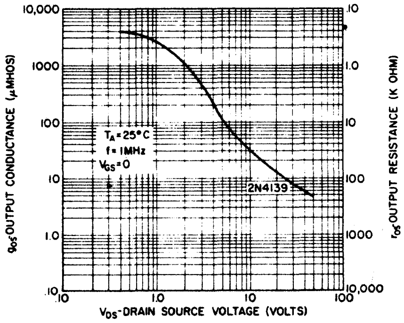
Input Capacity vs Source-Gate Voltage



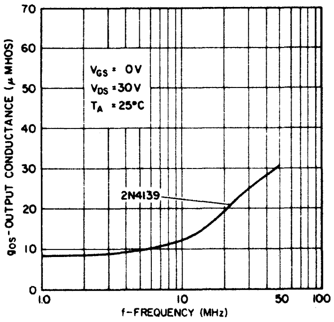
Input Capacity
vs
Frequency



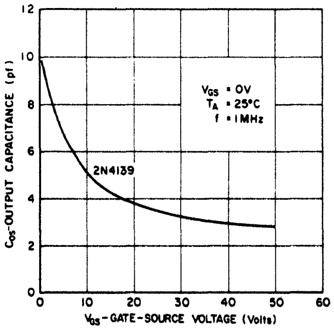
Output Conductance
vs
Drain-Source Voltage



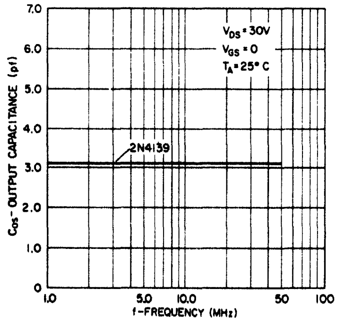
Output Conductance
vs
Frequency



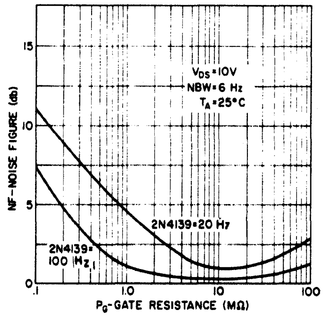
Output Capacitance
vs
Drain-Source Voltage



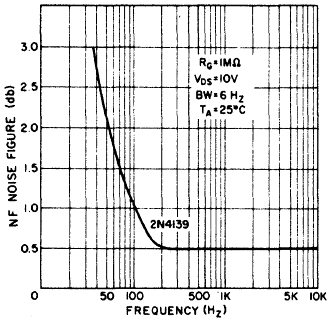
Output Capacitance
vs
Frequency



Noise Figure
vs
Gate Resistance



Noise Figure
vs
Frequency



N-CHANNEL FIELD EFFECT TRANSISTOR
RF/IF AMPLIFIER

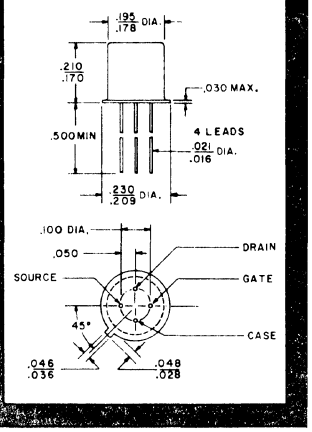
- HIGH TRANSCONDUCTANCE
- LOW LEAKAGE
- LOW NOISE

JANUARY 1968

2N4223
2N4224

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Gate-Source Voltage	V_{GS}	−30	Volts
Drain Current	I_D	20	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		2	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+175	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)\,GSS}$	$I_G = 10\ \mu A, V_{DS} = 0$	−30		Volts
Gate-Source Cutoff Voltage	$V_{GS(off)}$				
2N4223		$I_D = 0.25$ nA, $V_{DS} = 15$ V		−8	Volts
2N4224		$I_D = 0.50$ nA, $V_{DS} = 15$ V		−8	
Gate-Source Voltage	V_{GS}				
2N4223		$I_D = 0.3$ mA, $V_{DS} = 15$ V	−1.0	−7.0	Volts
2N4224		$I_D = 0.2$ mA, $V_{DS} = 15$ V	−1.0	−7.5	
Gate Reverse Current	I_{GSS}				
2N4223		$V_{GS} = -20$ V, $V_{DS} = 0$		−0.25	nA
2N4224				−0.50	
2N4223		$V_{GS} = -20$ V, $V_{DS} = 0$, $T_A = 100°C$		−250	
2N4224				−500	
Zero-Gate-Voltage Drain Current	I_{DSS}*				
2N4223		$V_{DS} = 15$ V, $V_{GS} = 0$	3	18	mA
2N4224			2	20	
Input Conductance	Y_{is}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		800	μmhos
Output Conductance	Y_{os}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		200	μmhos
Small-Signal Power Gain	G_{ps}	$V_{DS} = 15$ V, $V_{GS} = 0$			
2N4223		f = 200 MHz (Figure 1)	10		db
Input Capacitance	C_{iss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1 MHz		6	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1 MHz		2	pf
Forward Transfer Admittance	$\|y_{fs}\|$				
2N4223		$V_{DS} = 15$ V, $V_{GS} = 0$	3000	7000	μmhos
2N4224		f = 1 kHz	2000	7500	
2N4223		$V_{DS} = 15$ V, $V_{GS} = 0$	2700		
2N4224		f = 200 MHz	1700		
Noise Figure	NF	$V_{DS} = 15$ V, $V_{GS} = 0$, $R_S = 1\ k\Omega$			
2N4223		f = 200 MHz (Figure 1)		5	db

* Pulse Test: Pulse Width ≦ 630 ms, Duty Cycle ≦ 10%

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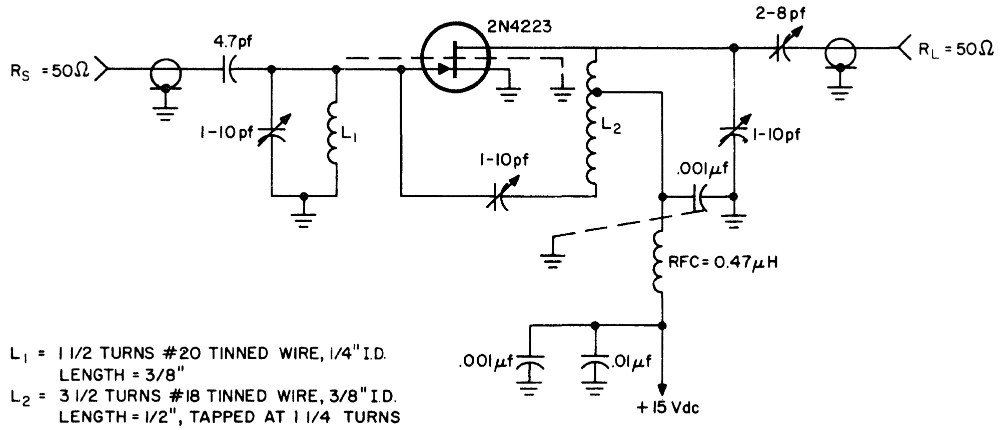
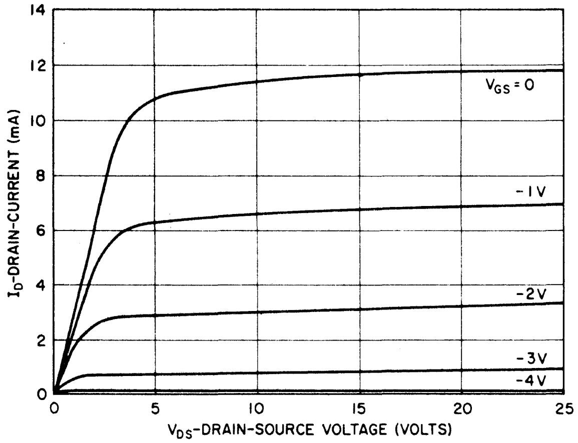
Figure 1. Noise Figure and Power Gain Test Circuit

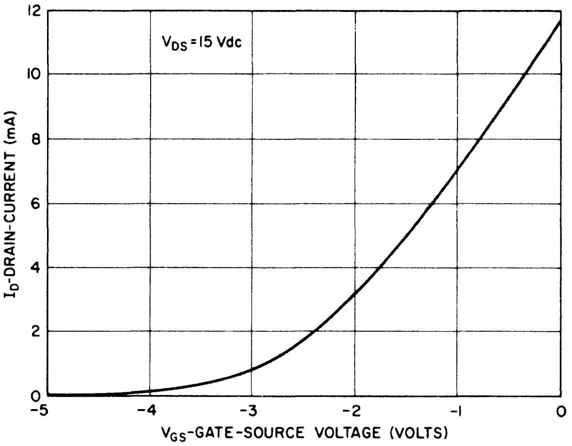


L_1 = 1 1/2 TURNS #20 TINNED WIRE, 1/4" I.D.
LENGTH = 3/8"
L_2 = 3 1/2 TURNS #18 TINNED WIRE, 3/8" I.D.
LENGTH = 1/2", TAPPED AT 1 1/4 TURNS
FROM DRAIN

Drain Characteristics



Common Source Transfer Characteristics



N-CHANNEL FIELD EFFECT TRANSISTOR

GENERAL PURPOSE

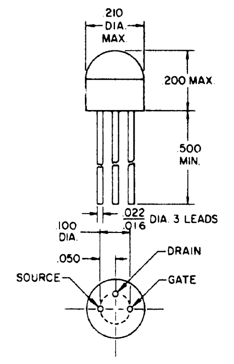
- LOW NOISE
- LOW LEAKAGE
- LOW CAPACITANCE

JANUARY 1968

2N4302
2N4303
2N4304

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Reverse-Gate-Source Voltage	V_{GS}	20	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor Above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	125	°C

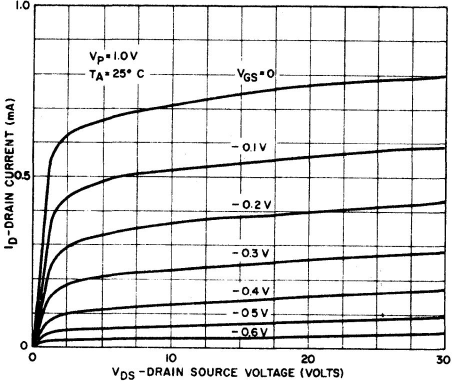


LEADS ELECTRICALLY ISOLATED FROM CASE

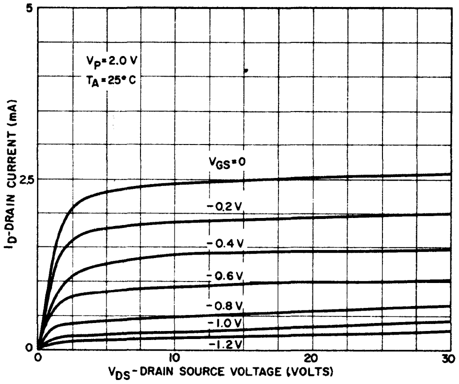
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -10\ V, V_{DS} = 0$ $V_{GS} = -10\ V, V_{DS} = 0, T_A = 85°C$		1.0 0.1	nA μA
Saturation Current	I_{DSS}				
2N4302		$V_{DS} = 20\ V, V_{GS} = 0$	0.5	5.0	mA
2N4303			4.0	10	
2N4304			0.5	15	
Pinch Off Voltage	V_P				
2N4302		$V_{DS} = 20\ V, I_D = 10\ nA$		4.0	Volts
2N4303				6.0	
2N4304				10	
Transconductance	g_m				
2N4302		$V_{DS} = 20\ V, V_{GS} = 0$	1000		μmhos
2N4303		f = 1.0 kHz	2000		
2N4304			1000		
Output Conductance	g_{os}	$V_{DS} = 20\ V, V_{GS} = 0$ f = 1.0 kHz		50	μmhos
Input Capacitance	C_{iss}	$V_{DS} = 20\ V, V_{GS} = 0$ f = 1.0 MHz		6.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 20\ V, V_{GS} = 0$ f = 1.0 MHz		3.0	pf
Drain-Gate Capacitance	C_{DG}	$V_{DG} = 10\ V, I_S = 0$ f = 140 kHz		2.0	pf
Magnitude of Small Signal, Common Source, Short Circuit, forward Transadmittance	Y_{fs}	$V_{DS} = 20\ V, V_{GS} = 0$ f = 10 MHz			
2N4302			700		μmhos
2N4303			1400		
2N4304			700		
Noise Figure	NF				
2N4302		$V_{DS} = 10\ V, R_G = 1.0\ M\Omega$		2.0	db
2N4303		f = 1.0 kHz		2.0	
2N4304		$V_{GS} = 0$, BW = 200 Hz		3.0	

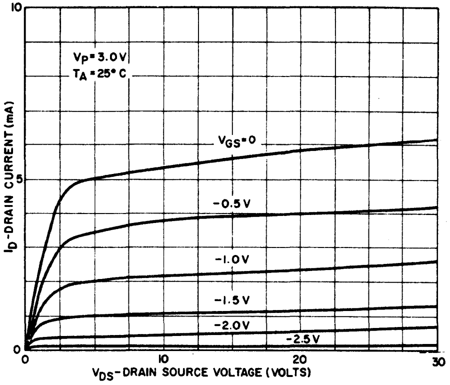
COMMON SOURCE-DRAIN CHARACTERISTICS



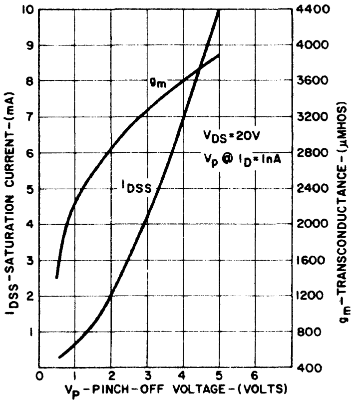
COMMON SOURCE-DRAIN CHARACTERISTICS



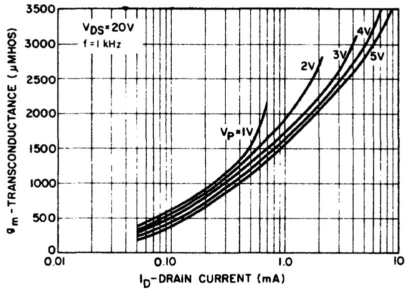
COMMON SOURCE-DRAIN CHARACTERISTICS



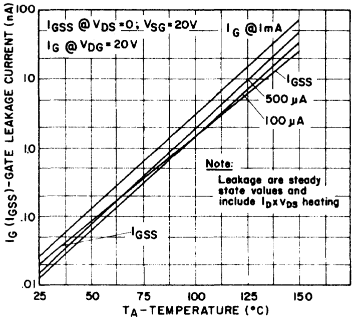
TRANSCONDUCTANCE AND DRAIN CURRENT VS PINCH-OFF VOLTAGE



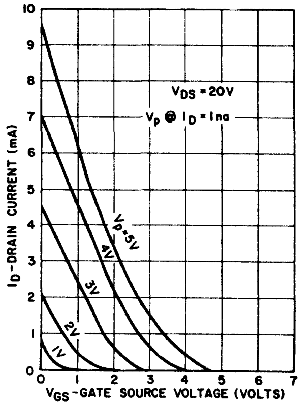
TRANSCONDUCTANCE VS DRAIN CURRENT



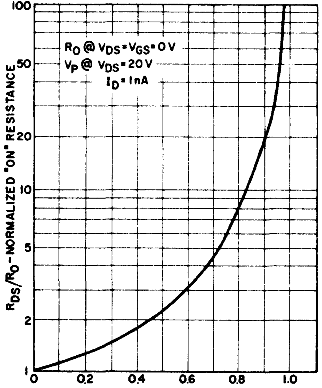
GATE LEAKAGE CURRENT VS TEMPERATURE



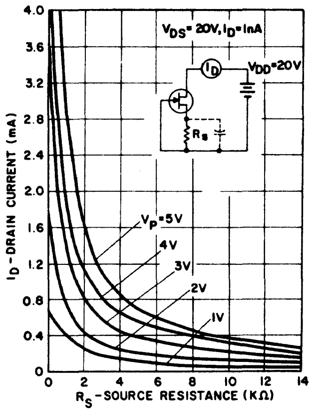
DRAIN CURRENT VS GATE-SOURCE BIAS



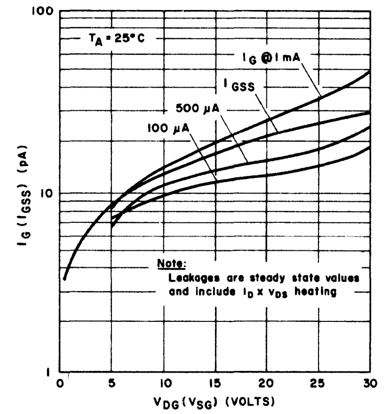
NORMALIZED R_{DS} VS V_{GS}



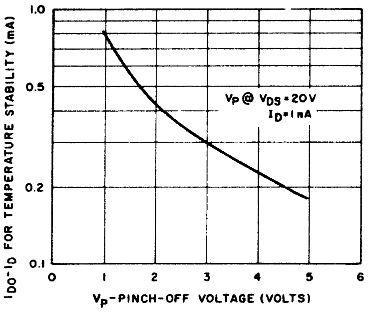
SOURCE FOLLOWER DRAIN CURRENT VS SOURCE RESISTANCE



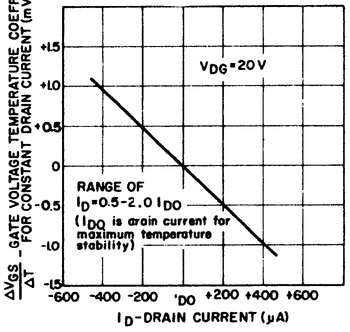
GATE LEAKAGE CURRENT VS VOLTAGE



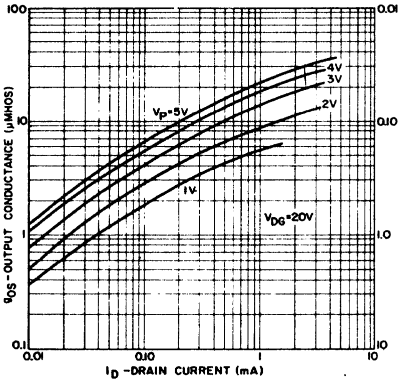
DRAIN CURRENT FOR MAXIMUM
TEMPERATURE STABILITY



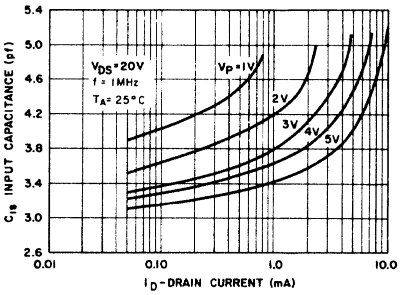
GATE VOLTAGE TEMPERATURE
COEFFICIENTS FOR CONSTANT
DRAIN CURRENT VS DRAIN VOLTAGE



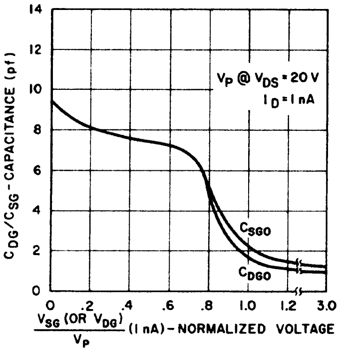
OUTPUT CONDUCTANCE
VS
DRAIN CURRENT



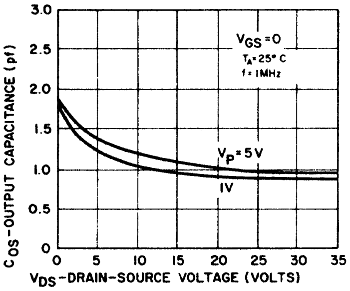
INPUT CAPACITANCE
VS
DRAIN CURRENT



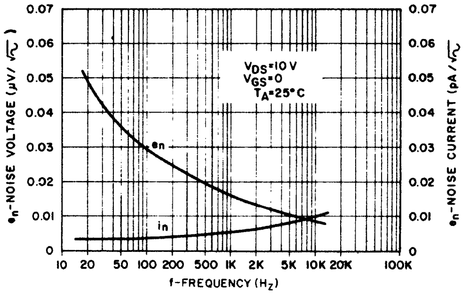
JUNCTION CAPACITANCE
VS
NORMALIZED BIAS



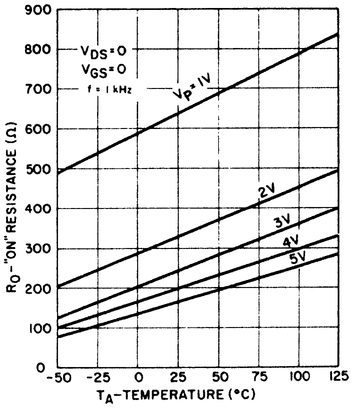
OUTPUT CAPACITANCE
VS
DRAIN SOURCE VOLTAGE



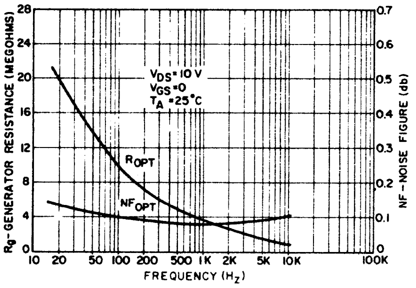
NOISE VOLTAGE/CURRENT
VS
FREQUENCY



"ON" RESISTANCE
VS
TEMPERATURE



OPTIMUM GENERATOR RESISTANCE
AND
NOISE FIGURE



N-CHANNEL FIELD EFFECT TRANSISTOR
RF/IF AMPLIFIER

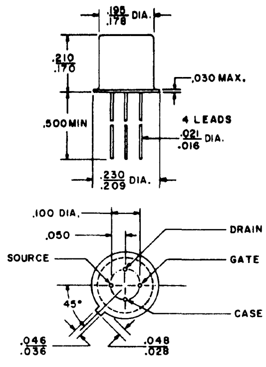
- HIGH TRANSCONDUCTANCE
- LOW CAPACITANCE
- LOW NOISE

NOVEMBER 1968

2N4416
2N4416A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		2N4416	2N4416A	
Reverse Gate-Source Voltage	V_{GS}	−30	−35	Volts
Drain-Source Voltage	V_{DS}	30	35	Volts
Drain-Gate Voltage	V_{DG}	30	35	Volts
Drain Current	I_D	30		mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.3		Watts
Derating Factor above 25°C @ $T_A = 25°C$		1.7		mW/°C
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200		°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		+300		°C



NOTES: ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$			Volts
2N4416			30		
2N4416A			35		
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15\ V$, $I_D = 1.0\ nA$			Volts
2N4416				−6.0	
2N4416A			−2.5	−6.0	
Gate-Source Voltage	V_{GS}	$V_{DS} = 15\ V$, $I_D = 0.5\ mA$	−1.0	−5.5	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -20\ V$, $V_{DS} = 0$ $V_{GS} = -20\ V$, $V_{DS} = 0$, $T_A = 150°C$		−0.1 −0.2	nA µA
Zero-Gate-Voltage Drain Current	I_{DSS}	$V_{DS} = 15\ V$, $V_{GS} = 0$	5.0	15	mA
Input Capacitance	C_{iss}	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 1 MHz		4.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 1 MHz		0.8	pf
Output Capacitance	C_{oss}	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 1 MHz		2.0	pf
Forward Transadmittance	$\|Y_{fs}\|$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 1 kHz	4500	7500	µmhos
Output Admittance	$\|Y_{os}\|$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 1 kHz		50	µmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 400 MHz		1000	µmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 400 MHz		10000	µmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 100 MHz		100	µmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\ V$, $V_{GS} = 0$ f = 100 MHz		2500	µmhos

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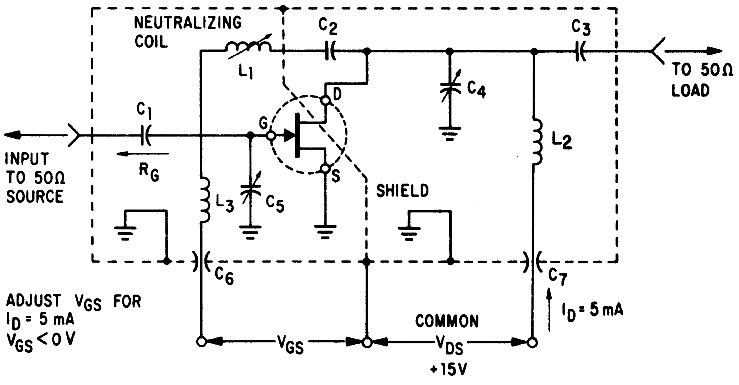
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Output Conductance	RE(Y_{os})	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		100	μmhos
Output Susceptance	IM(Y_{os})	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		4000	μmhos
Output Conductance	RE(Y_{os})	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		75	μmhos
Output Susceptance	IM(Y_{os})	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		1000	μmhos
Forward Transconductance	RE(Y_{fs})	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz	4000		μmhos
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 100 MHz (figure 1)	18		db
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 400 MHz (figure 1)	10		db
Noise Figure	NF	$V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 100 MHz (figure 1) $V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 400 MHz (figure 1)		2.0 4.0	db



REF. DESIG.	VALUE	
	100 MHz	400 MHz
C1	7.0 pF	1.8 pF
C2	1000 pF	27 pF
C3	3.0 pF	1.0 pF
C4	1.0-12 pF	0.8-8 pF
C5	1.0-12 pF	0.8-8 pF
C6	0.0015 μF	0.001 μF
C7	0.0015 μF	0.001 μF
L1	3.0 μh	0.2 μh
L2	0.25 μh	0.03 μh
L3	0.14 μh	0.022 μh

100 MHz & 400 MHz NEUTRALIZED AMPLIFIER

Figure 1

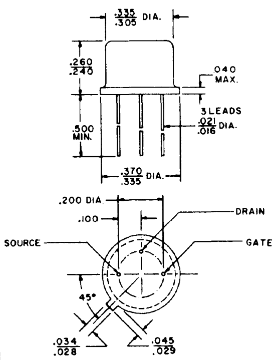
N-CHANNEL FIELD EFFECT TRANSISTOR
HIGH VOLTAGE AMPLIFIER
- HIGH BREAKDOWN VOLTAGE
- LOW LEAKAGE
- LOW CAPACITANCE

JANUARY 1968

2N4881
THRU
2N4886

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING			UNIT
		2N4881-2	2N4883-4	2N4885-6	
Drain-Source Voltage	V_{DS}	300	200	125	Volts
Drain-Gate Voltage	V_{DG}	300	200	125	Volts
Reverse Gate-Source Voltage	V_{GS}	100	100	75	Volts
Gate Current	I_G	10			mA
Total Device Dissipation @ $T_A = 25°C$	P_D	800			mW
Derating Factor Above 25°C @ $T_A = 25°C$		4.57			mW/°C
Storage Temperature	T_{stg}	−65 to +200			°C
Junction Temperature	T_J	200			°C
Lead Temperature, 1/16 inch from case, 10 sec. max.		300			°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$				
2N4881-4		$I_G = 1.0\ \mu A, V_{DS} = 0$	100		Volts
2N4885-6			75		
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
2N4881-2		$V_{DS} = 50\ V, I_D = 2.0\ nA$	0.5	15	Volts
2N4883-6		$V_{DS} = 50\ V, I_D = 1.0\ nA$	0.5	10	
Gate-Source Voltage	V_{GS}				
2N4881		$V_{DS} = 50\ V, I_D = 40\ \mu A$	0.5	14.5	Volts
2N4882		$V_{DS} = 50\ V, I_D = 150\ \mu A$	0.5	14.5	
2N4883, 5		$V_{DS} = 50\ V, I_D = 40\ \mu A$	0.5	9.5	
2N4884, 6		$V_{DS} = 50\ V, I_D = 150\ \mu A$	0.5	9.5	
Gate Reverse Current	I_{GSS}				
2N4881-2		$V_{GS} = 50\ V, V_{DS} = 0$		2.0	nA
2N4883-6				1.0	
2N4881-2		$V_{GS} = 50\ V, V_{DS} = 0, T_A = 150°C$		4.0	μA
2N4883-6				2.0	
Zero-Gate-Voltage Drain Current	I_{DSS}^*				
2N4881, 3, 5		$V_{DS} = 50\ V, V_{GS} = 0$	0.4	2.0	mA
2N4882, 4, 6			1.5	7.5	
Drain-Source "ON" Resistance	r_{DS}				
2N4881, 3, 5		$I_D = 100\ \mu A, V_{GS} = 0$		5000	Ohms
2N4882, 4, 6				3000	
Input Capacitance	C_{iss}	$V_{DS} = 50\ V, V_{GS} = 0$ $f = 1.0\ MHz$		15	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 50\ V, V_{GS} = 0$ $f = 1.0\ MHz$		1.5	pf
Drain-Gate Capacitance	C_{dgo}	$V_{DG} = 50\ V, I_S = 0$ $f = 1.0\ MHz$		1.5	pf
Forward Transfer Admittance	$\lvert Y_{fs} \rvert$				
2N4881, 3, 5		$V_{DS} = 50\ V, V_{GS} = 0$ $f = 1.0\ kHz$	350	1000	μmhos
2N4882, 4, 6			600	1500	

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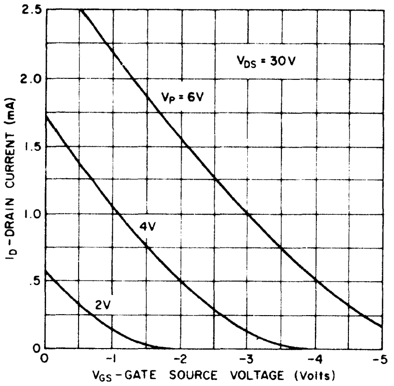
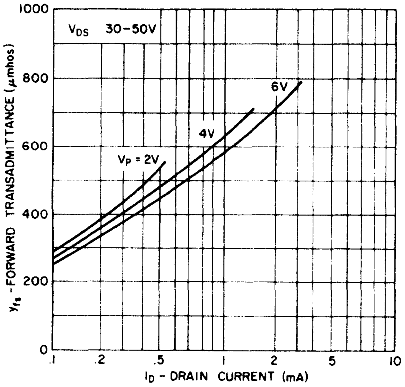
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Forward Transfer Admittance 2N4881, 3, 5 2N4882, 4, 6	$\lvert Y_{fs} \rvert$	$V_{DS} = 50$ V, $V_{GS} = 0$ f = 1.0 MHz	300 550		μmhos
Output Admittance 2N4881, 3, 5 2N4882, 4, 6 2N4881, 3, 5 2N4882, 4, 6	$\lvert Y_{os} \rvert$	$V_{DS} = 50$ V, $V_{GS} = 0$ f = 1.0 kHz $V_{DS} = 50$ V, $I_D = 0.2$ mA f = 1.0 kHz		10 20 2.5 5.0	μmhos
Noise Figure	NF	$V_{DS} = 50$ V, $V_{GS} = 0$ $R_G = 1.0$ MΩ f = 1.0 kHz BW = 200 Hz		3.0	db

* Pulse Test: Pulse Width = 300μsec; Duty Cycle = 1%.

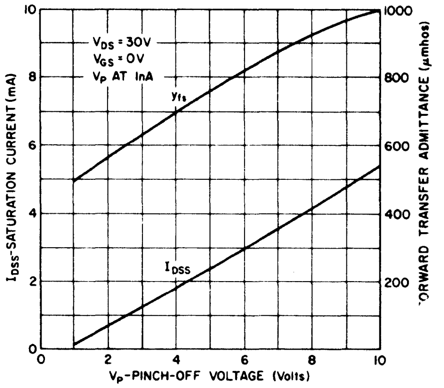
Drain Current vs Drain-Source Voltage



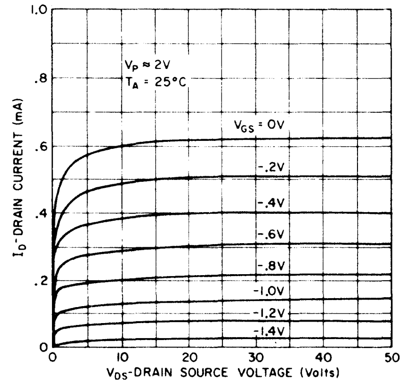
Forward Transadmittance vs Drain Current



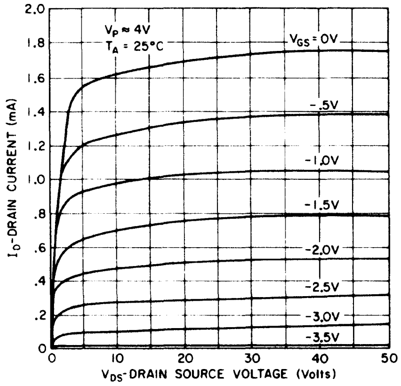
Forward Transfer Admittance And Drain Current vs Pinch-Off Voltage



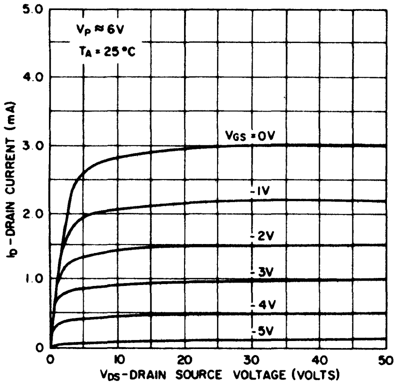
Common Source Drain Characteristics



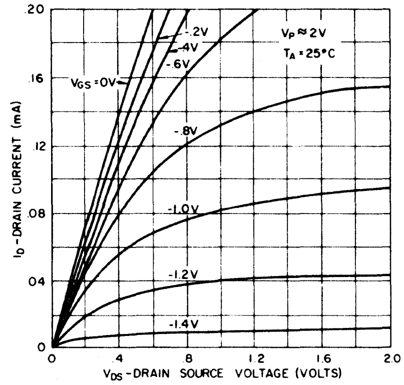
Common Source Drain Characteristics



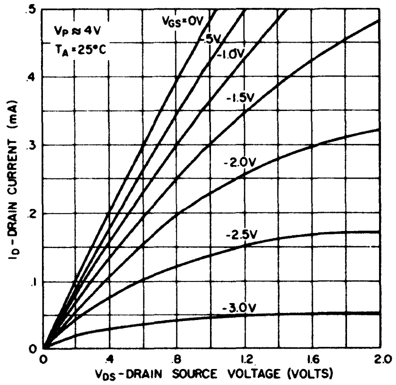
Common Source Drain Characteristics



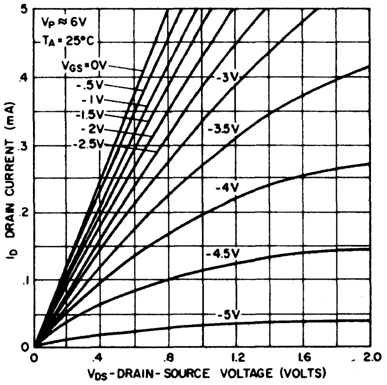
Common Source Drain Characteristics



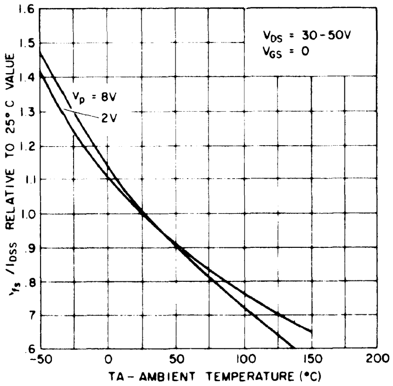
Common Source Drain Characteristics



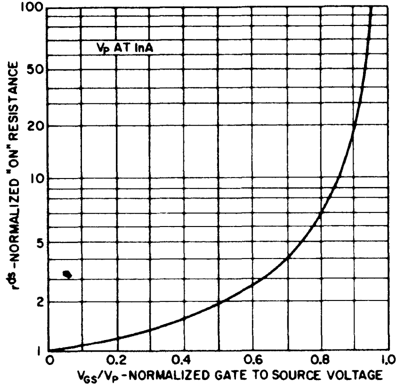
Common Source Drain Characteristics



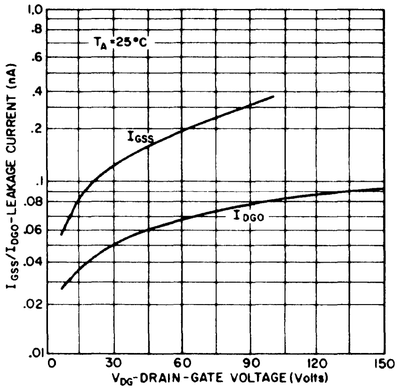
Normalized Forward Transfer Admittance/ Saturation Current vs Ambient Temperature



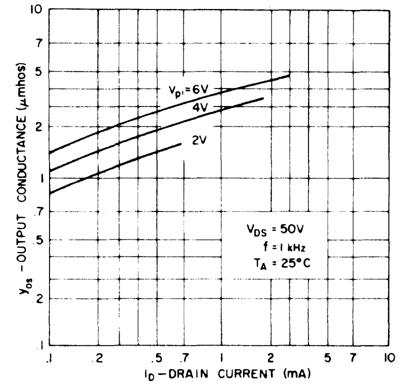
Normalized r_{ds} vs V_{gs}



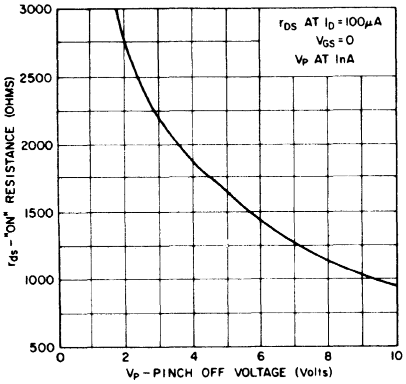
Leakage Current vs Voltage



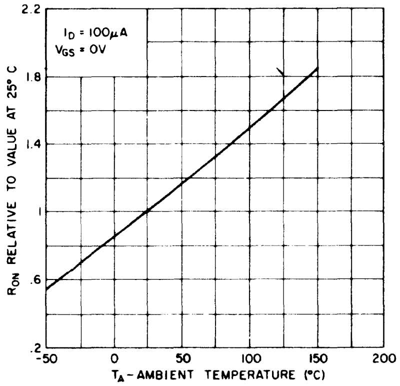
Output Conductance vs Drain Current



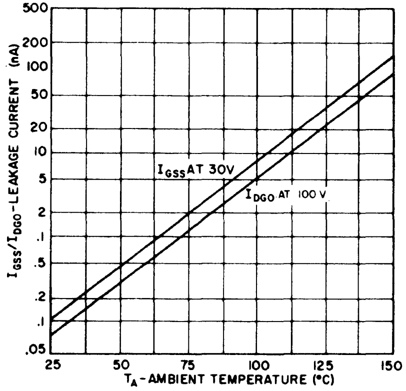
"On" Resistance vs Pinch Off Voltage



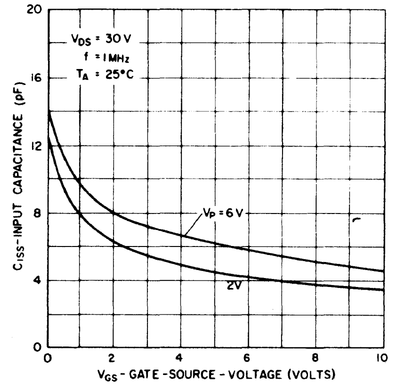
Normalized "On" Resistance vs Ambient Temperature



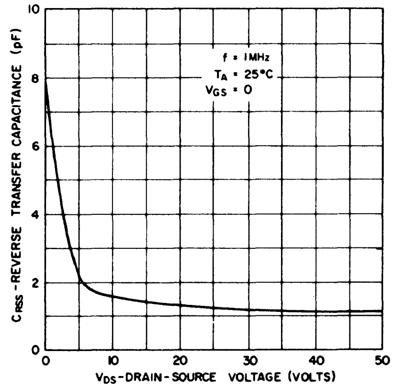
Leakage Current vs Ambient Temperature



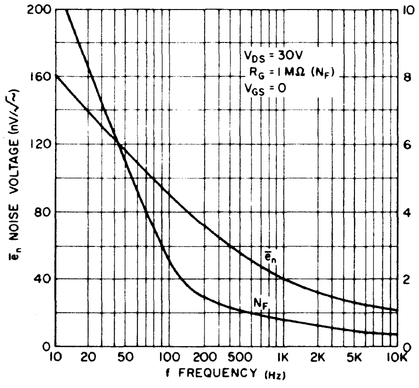
Short Circuit Input Capactance vs Gate Source Voltage



Reverse Transfer Capacitance vs Drain Source Voltage



Noise Voltage/Noise Figure vs Frequency



N-CHANNEL FIELD EFFECT TRANSISTOR

RF/IF AMPLIFIER

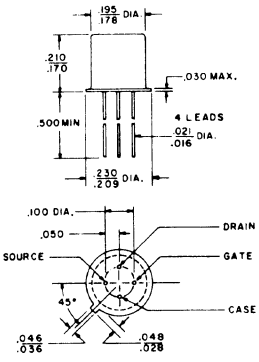
- HIGH TRANSCONDUCTANCE
- LOW LEAKAGE
- LOW NOISE

JANUARY 1968

2N5078

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gain Voltage	V_{DG}	30	Volts
Drain Current	I_D	30	mA
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.3	Watts
Derating Factor above 25°C @ $T_A = 25°C$		1.7	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		+300	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15\ V, I_D = 1.0\ \mu A$	−0.5	−8.0	Volts
Gate-Source Voltage	V_{GS}	$V_{DS} = 15\ V, I_D = 0.4\ mA$	−0.5	−7.0	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -20\ V, V_{DS} = 0$ $V_{GS} = -20\ V, V_{DS} = 0, T_A = 150°C$		−0.25 −0.25	nA µA
Zero-Gate-Voltage Drain Current	I_{DSS}	$V_{DS} = 15\ V, V_{GS} = 0$	4.0	25	mA
Power Gain	G_{ps}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 200 MHz (figure 1)	15		db
Power Gain	G_{ps}	$V_{DS} = 15\ V, I_D = 4\ mA$ f = 400 MHz (figure 2)	12		db
Input Capacitance	C_{iss}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 MHz		6.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 2 MHz		2.0	pf
Forward Transadmittance	$\|Y_{fs}\|$	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 kHz	4500	10000	µmhos
		$V_{DS} = 15\ V, V_{GS} = 0$ f = 200 MHz	4000		
Input Conductance	Y_{is}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 200 MHz		800	µmhos
Output Admittance	Y_{os}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 200 MHz		150	µmhos
Noise Figure	NF	$V_{DS} = 15\ V, V_{GS} = 0$ $R_S = 1\ M\Omega$, f = 10 Hz BW = 5 Hz		5.0	db
		$V_{DS} = 15\ V, V_{GS} = 0$ $R_S = 1\ k\Omega$ f = 200 MHz (figure 1)		3.0	
		$V_{DS} = 15\ V, I_D = 4\ mA$ f = 400 MHz, $R_S = 1\ k\Omega$ (figure 2)		4.0	

NOTE: Case Lead Grounded During All Electric Tests

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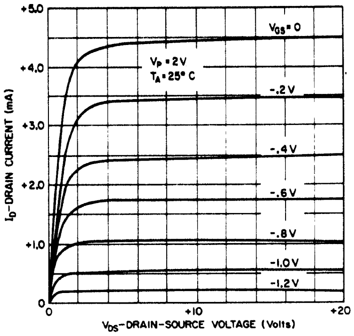
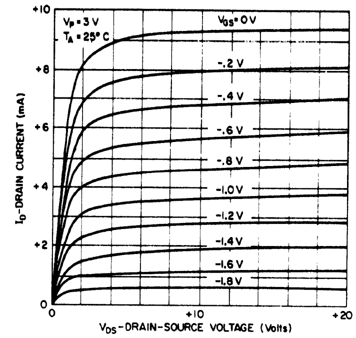
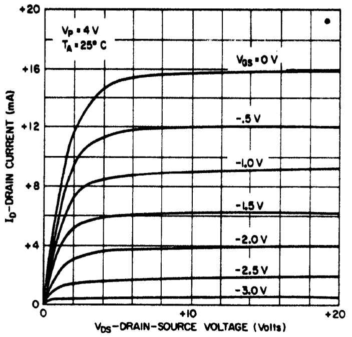
Common Source-Drain Characteristics



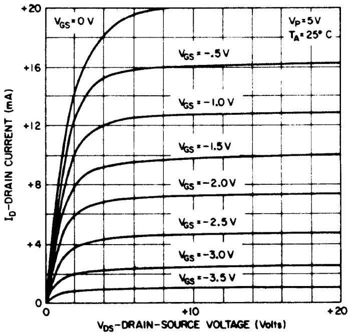
Common Source-Drain Characteristics



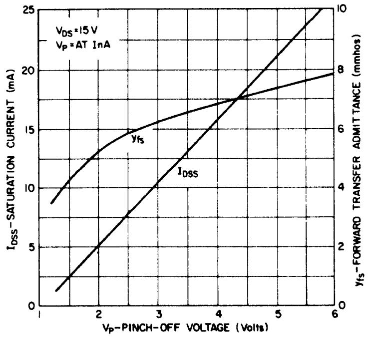
Common Source-Drain Characteristics



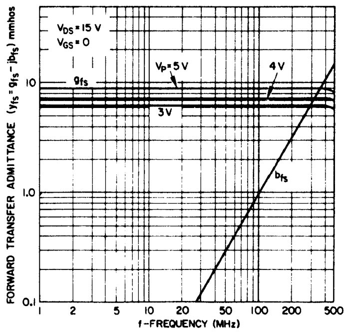
Common Source-Drain Characteristics



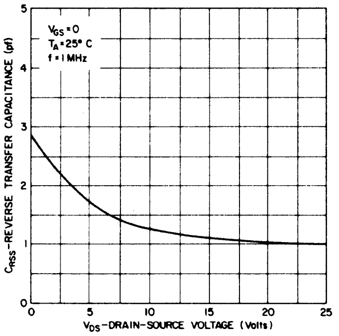
Forward Transfer Admittance and Drain Current vs Pinch Off Voltage



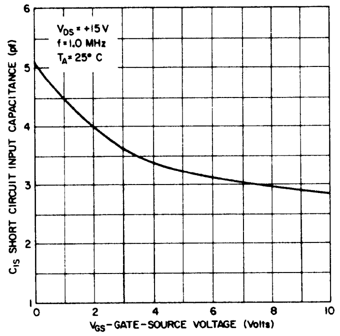
Forward Transfer Admittance vs Frequency



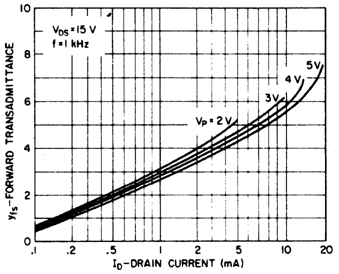
Reverse Transfer Capacitance vs Drain-Source Voltage



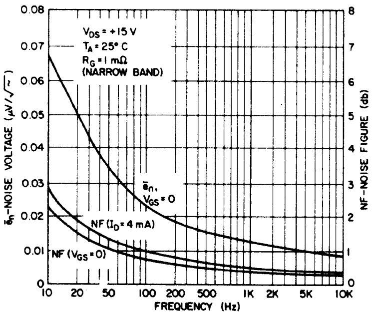
Short Circuit Input Capacitance vs Gate-Source Voltage



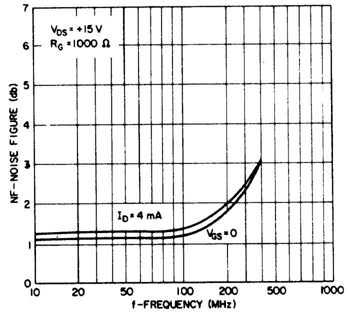
Forward Transadmittance vs Drain Current



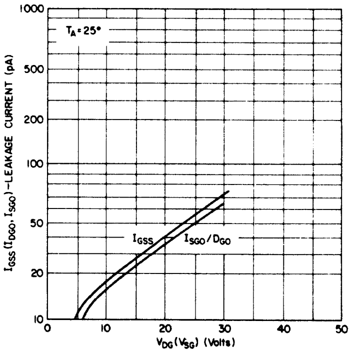
Noise Voltage/Noise Figure vs Frequency

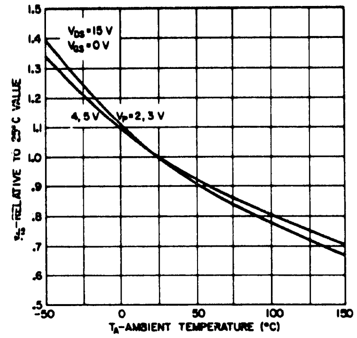


Noise Figure vs Frequency

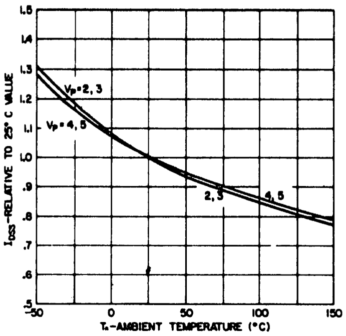


Leakage Current vs Voltage

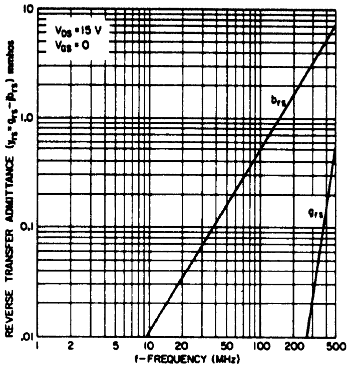




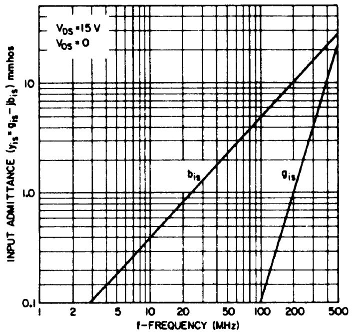
Normalized Forward Transfer Admittance vs Ambient Temperature



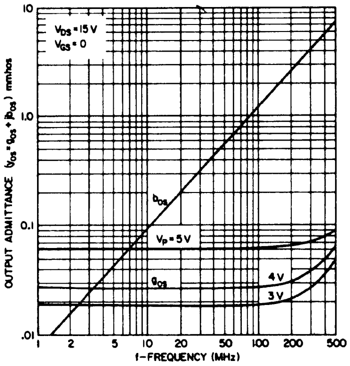
Normalized Drain Saturation Current vs Ambient Temperature



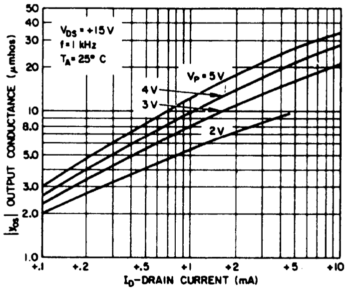
Reverse Transfer Admittance vs Frequency



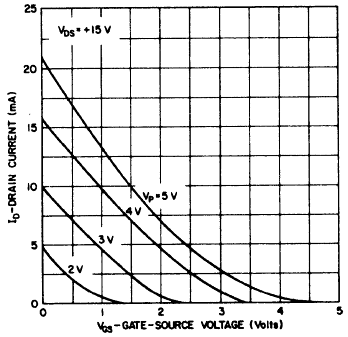
Input Admittance vs Frequency



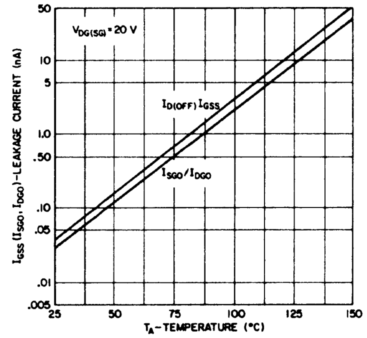
Output Admittance vs Frequency



Output Conductance vs Drain Current



Drain Current vs Gate-Source Voltage



Gate Leakage vs Voltage

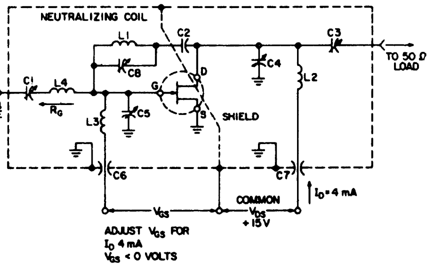
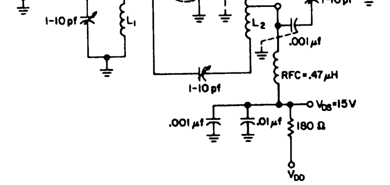


Figure 2.

C_1	Arco 400 .9-7 pf
C_2	27 pf
C_3	Arco 420 1-12 pf
C_4	Johansen 2954 .8-10 pf
C_5	Johansen 2954 .8-10 pf
C_6	.001 µF
C_7	.001 µF
C_8	Arco 420 1-12 pf
L_1	5/16 dia x 3/8 long, #14 Copper wire
L_2	5/8" Straight, #12 Copper wire
L_3	3/8" Straight, #18 Copper wire
L_4	3 turns 1/4 ID, 1/4" long x 14 Copper wire



L_1	1-1/2 turns, #20 tinned wire, 1/4 ID, Length = 3/8"
L_2	3-1/2 turns, #18 tinned wire, 3/8" ID, Length = 1/2" Tapped at 1-1/4 turns from drain

Figure 1.

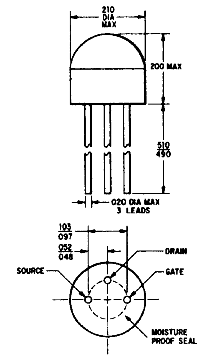
NOVEMBER 1968

N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE AMPLIFIER

2N5163

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	25	Volts
Drain-Gate Voltage	V_{DG}	25	Volts
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor Above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	+125	°C



NOTES: ALL LEADS ELECTRICALLY ISOLATED FROM CASE
ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at 25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = -10\ \mu A, V_{DS} = 0$	25		Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -15\ V, V_{DS} = 0$		10	nA
Gate Reverse Current	I_{GSS} (85°C)	$V_{GS} = -15\ V, V_{DS} = 0$		0.6	μA
Zero-Gate-Voltage Drain Current	I_{DSS}	$V_{DS} = 15\ V, V_{GS} = 0$	1.0	40	mA
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15\ V, I_D = 1.0\ \mu A$	−0.4	−8.0	Volts
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 kHz	1800		μmhos
Output Admittance	Y_{os}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 kHz		200	μmhos
Input Capacitance	C_{iss}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 MHz		12	pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15\ V, V_{GS} = 0$ f = 1 MHz		3.0	pF
Noise Figure	NF	$V_{DS} = 15\ V, I_D = 1\ mA$ $R_S = 150$ K ohm, f = 1 kHz BW = 150 Hz		3.0	dB

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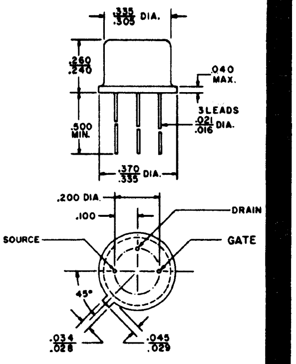
N-CHANNEL FIELD EFFECT TRANSISTOR HIGH VOLTAGE AMPLIFIER

MAY 1968

2N5277
2N5278

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Gate Voltage	V_{DG}	200	Volts
Reverse Gate-Source Voltage	$V_{GS(r)}$	-150	Volts
Gate Current	I_G	10	mA
Total Device Power Dissipation @ $T_A = 25°C$	P_D	800	mW
Derating Factor above 25°C @ $T_A = 25°C$		4.57	mW/°C
Storage Temperature Range		-55° to +200°	°C
Operating Junction Temperature		200	°C
Lead Temperature, 1/16 inch from case, 10 seconds maximum		300	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$	150		Volts
Gate-Source Cutoff Voltage 2N5277 2N5278	$V_{GS(OFF)}$	$V_{DS} = 30V$, $I_D = 10$ nA	 0.5 2.0	 7.0 10	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -75V$, $V_{DS} = 0$ $V_{GS} = -75V$, $V_{DS} = 0$, $T_A = 150°C$		5.0 5.0	nA µA
Zero Gate Voltage Drain Current 2N5277 2N5278	I_{DSS}	$V_{DS} = 30V$, $V_{GS} = 0$	 2.5 10	 12.5 25	mA
Forward Transadmittance 2N5277 2N5278	$\|Y_{fs}\|$	$V_{DS} = 30V$, $V_{GS} = 0$, f = 1 kHz	 2000 3000	 5000 6000	µmhos
Output Admittance 2N5277 2N5278	$\|Y_{os}\|$	$V_{DS} = 30V$, $V_{GS} = 0$, f = 1 kHz		 25 60	µmhos
Input Capacitance	C_{iss}	$V_{DS} = 30V$, $V_{GS} = 0$, f = 1 MHz		25	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 30V$, $V_{GS} = 0$, f = 1 MHz		5.0	pf
Noise Figure	NF	$V_{DS} = 30V$, $V_{GS} = 0$ f = 1 KHz, BW = 200 Hz $R_G = 1\ M\Omega$		3.0	db

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N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE
- LOW NOISE
- HIGH VOLTAGE
- HIGH TRANSCONDUCTANCE

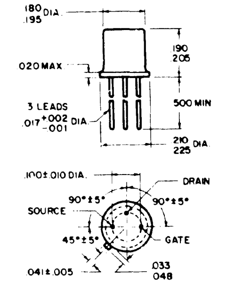
SEPTEMBER 1968

2N5391 THRU 2N5396

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Gain Voltage	V_{DG}	70	Volts
Reverse Gate-Source Voltage	V_{GS}	70	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.71	mW/°C
Storage Temperature Range	T_{stg}	−65 to +200	°C
Operating Junction Temperature	T_J	200	°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300	°C

PHYSICAL DIMENSIONS IN ACCORDANCE WITH JEDEC (TO 18) OUTLINE
NOTE: ALL DIMENSIONS IN INCHES



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25 C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	70		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
2N5391		$V_{DS} = 20\ V, I_D = 1.0\ nA$	0.5	2.0	Volts
2N5392			0.5	2.5	
2N5393			1.0	3.0	
2N5394			1.0	4.0	
2N5395			1.5	4.0	
2N5396			2.0	5.0	
Gate-Source Voltage	V_{GS}				
2N5391		$V_{DS} = 20\ V, I_D = (^{**})$	0.1	1.1	Volts
2N5392			0.3	1.4	
2N5393			0.5	1.6	
2N5394			0.7	1.8	
2N5395			1.0	2.1	
2N5396			1.2	2.6	
Gate Reverse Current	I_{GSS}	$V_{GS} = -35\ V, V_{DS} = 0$		0.2	nA
		$V_{GS} = -10\ V, V_{DS} = 0$		0.1	
Zero-Gate Voltage Drain Current	I_{DSS}				
2N5391		$V_{DS} = 20\ V, V_{GS} = 0$	0.5	1.5	mA
2N5392			1.0	3.0	
2N5393			2.5	4.5	
2N5394			4.0	6.0	
2N5395			5.5	8.0	
2N5396			7.5	10	
Forward Transadmittance	$\lvert Y_{fs} \rvert$				
2N5391		$V_{DS} = 20\ V, V_{GS} = 0$ $f = 1\ kHz$	1500	4500	µmhos
2N5392			2000	6000	
2N5393			3000	6500	
2N5394			4000	7000	
2N5395			4500	7000	
2N5396			4500	7500	
Forward Transadmittance	$\lvert Y_{fs} \rvert$				
2N5391		$V_{DS} = 20\ V, I_D = {}^{***}$ $f = 1\ kHz$	1000		µmhos
2N5392			1000		
2N5393			1000		
2N5394			2000		
2N5395			1900		
2N5396			1800		

Printed in U.S.A.

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Input Capacitance	C_{iss}	$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 0.14\text{-}1.0$ MHz		18	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 0.14\text{-}1.0$ MHz		5.0	pf
Output Admittance	$\|Y_{os}\|$				
2N5391		$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 1$ kHz		4.0	μmhos
2N5392				7.0	
2N5393				10	
2N5394				15	
2N5395				20	
2N5396				25	
Output Admittance	$\|Y_{os}\|$				
2N5391		$V_{DS} = 20$ V, $I_D = (***)$ $f = 1$ kHz		2.0	μmhos
2N5392				2.5	
2N5393				3.0	
2N5394				8.0	
2N5395				10	
2N5396				12	
Noise Figure	NF	$V_{DS} = 20$ V, $V_{GS} = 0$, $R_G = 1$ MΩ, $f = 100$ Hz, NBW = 6 Hz		1.0	db
		$V_{DS} = 20$ V, $V_{GS} = 0$, $R_G = 10$ KΩ, $f = 100$ Hz, NBW = 6 Hz		2.5	
		$V_{DS} = 20$ V, $V_{GS} = 0$, $R_G = 10$ KΩ, $f = 1$ kHz, NBW = 200 Hz		1.5	
		$V_{DS} = 20$ V, $V_{GS} = 0$, $R_G = 1$ KΩ, $f = 1$ kHz, NBW = 200 Hz		5.0	
		$V_{DS} = 20$ V, $V_{GS} = 0$, $R_G = 1$ MΩ, $f = 10$ Hz, NBW = 6 Hz		2.0	
Equivalent Input Noise Voltage	En	$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 10$ Hz, NBW = 6 Hz		17.5	nv/ $\sqrt{\text{Hz}}$
		$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 100$ Hz, NBW = 6 Hz		10	

Notes: (**) 2N5391 $I_D = 0.05$ mA
Notes: (**) 2N5392 $I_D = 0.10$ mA
Notes: (**) 2N5393 $I_D = 0.25$ mA
Notes: (**) 2N5394 $I_D = 0.40$ mA
Notes: (**) 2N5395 $I_D = 0.55$ mA
Notes: (**) 2N5396 $I_D = 0.75$ mA

(***) 2N5391 $I_D = 200$ μA
(***) 2N5392 $I_D = 200$ μA
(***) 2N5393 $I_D = 200$ μA
(***) 2N5394 $I_D = 700$ μA
(***) 2N5395 $I_D = 700$ μA
(***) 2N5396 $I_D = 700$ μA

N-CHANNEL FIELD EFFECT TRANSISTOR
LOW LEAKAGE AMPLIFIER

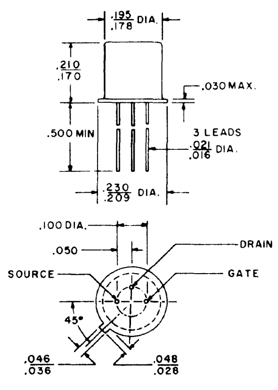
- VERY LOW LEAKAGE
- LOW NOISE
- LOW CAPACITANCE

JANUARY 1968

U1714

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Gate Voltage		25	Volts
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.71	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C



GATE IS INTERNALLY CONNECTED TO C

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{GSS}	$I_G = 1.0\,\mu A$, $V_{DS} = 0$	25		Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -10$ V, $V_{DS} = 0$		5.0	pA
Saturation Current	I_{DSS}	$V_{DS} = 10$ V, $V_{GS} = 0$	0.5	5.0	mA
Source-Gate Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 10$ V, $I_D = 1.0$ nA		5.0	Volts
Transconductance	gm	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1.0 kHz	400		μmhos
Input Capacitance	C_{iss}	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1.0 MHz		3.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 10$ V, $I_S = 0$ f = 140 kHz		1.2	pf
Noise Figure	NF	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 100 Hz, BW = 6.0 Hz $R_G = 1.0\,M\Omega$		3.0	db

N-CHANNEL FIELD EFFECT TRANSISTOR
HIGH VOLTAGE AMPLIFIER

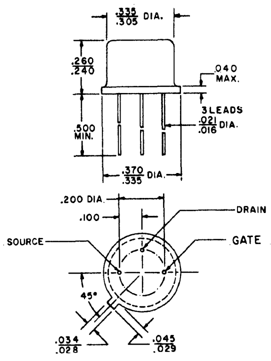
- HIGH BREAKDOWN VOLTAGE
- LOW NOISE
- LOW R_{ON} RESISTANCE

JANUARY 1968

U1715

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Gate Voltage		200	Volts
Source-Gate Voltage		125	Volts
Total Device Dissipation @ $T_A = 25°C$	P_D	800	mW
Derating Factor above 25°C @ $T_A = 25°C$		4.57	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+200	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{GSS}	$I_G = 1.0\ \mu A$, $I_S = 0$	200		Volts
Source-Gate Breakdown Voltage	BV_{SGO}	$I_S = 1.0\ \mu A$, $I_G = 0$	125		Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = 75$ V, $V_{DS} = 0$		5.0	nA
Drain-Gate Leakage Current	I_{DGO}	$V_{DG} = 150$ V		3.0	nA
Saturation Current	I_{DSS}	$V_{DS} = 50$ V, $V_{GS} = 0$	10	50	mA
Source-Gate Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 50$ V, $I_D = 10$ nA		15	Volts
Drain-Source "ON" Resistance	R_O	$I_D = 100\ \mu A$, $V_{GS} = 0$		400	Ohms
Input Capacitance	C_{iss}	$V_{DS} = 50$ V, $V_{GS} = 0$ f = 1.0 MHz		25	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 50$ V, $V_{GS} = 0$ f = 1.0 MHz		4.0	pf
Noise Figure	NF	$V_{DS} = 30$ V, $V_{GS} = 0$ f = 1.0 kHz, BW = 200 Hz $R_G = 1.0\ M\Omega$		3.0	db

N-CHANNEL FIELD EFFECT TRANSISTOR

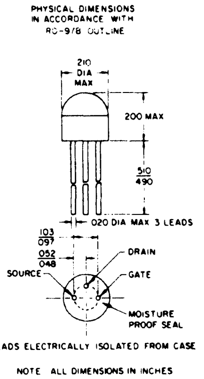
- RF/IF AMPLIFIER
- HIGH TRANSCONDUCTANCE
- LOW LEAKAGE
- LOW NOISE

SEPTEMBER 1968

u1837E

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gain Voltage	V_{DG}	30	Volts
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Gate Current	I_G	10	mA
Drain Current	I_D	30	mA
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	300	mWatts
Derating Factor above 25°C @$T_A = 25°C$		2.5	mW/°C
Storage Temperature Range	T_{stg}	−55 to +125	°C
Operating Junction Temperature	T_J	+125	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = -1.0\ \mu A$, $V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$	$V_{DS} = 15$ V, $I_D = 1.0\ \mu A$	−0.5	−8.0	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -20$ V, $V_{DS} = 0$ $V_{GS} = -20$ V, $V_{DS} = 0$, $T_A = +85°C$		−0.25 −15	nA nA
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 15$ V, $V_{GS} = 0$	4.0	25	
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1 kHz	4500	10000	μmhos
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz	4000		μmhos
Drain-Source "ON" Resistance	$r_{DS(ON)}$	$I_D = 1$ mA, $V_{GS} = 0$		300	Ohms
Input Capacitance	C_{iss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1 MHz		6.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 1 MHz		2.0	pf
Input Admittance	$\lvert Y_{is} \rvert$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		800	μmhos
Output Admittance	$\lvert Y_{os} \rvert$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz		150	μmhos
Power Gain	G_{ps}	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 200 MHz (Figure 1)	15		db
Noise Figure	NF	$V_{DS} = 15$ V, $R_G = 1\ M\Omega$, $V_{GS} = 0$, f = 10 Hz, BW = 5 Hz		5.0	db
Noise Figure	NF	$V_{DS} = 15$ V, $R_G = 1\ K\Omega$, $V_{GS} = 0$, f = 200 MHz, (Figure 1)		3.0	db

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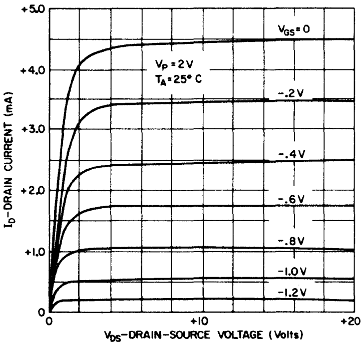
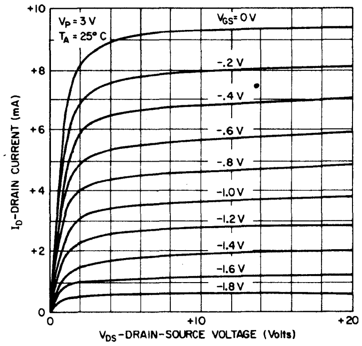
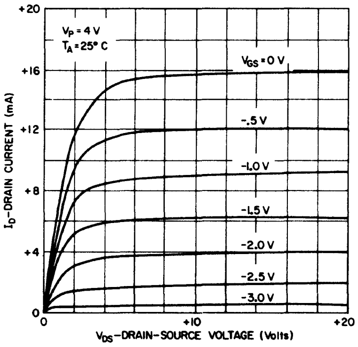
Common Source-Drain Characteristics



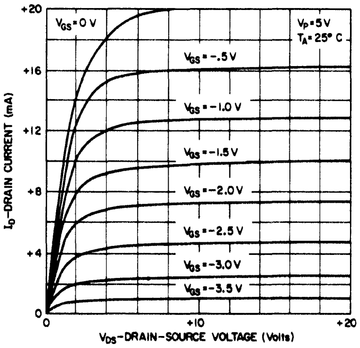
Common Source-Drain Characteristics



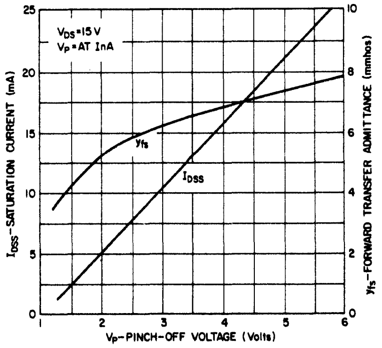
Common Source-Drain Characteristics



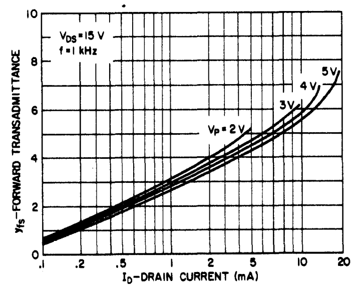
Common Source-Drain Characteristics



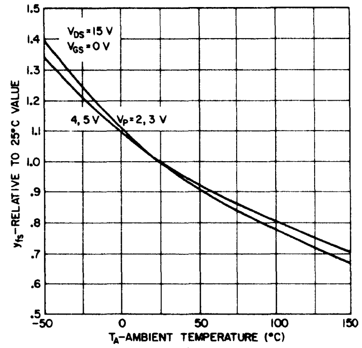
Forward Transfer Admittance and Drain Current vs Pinch Off Voltage



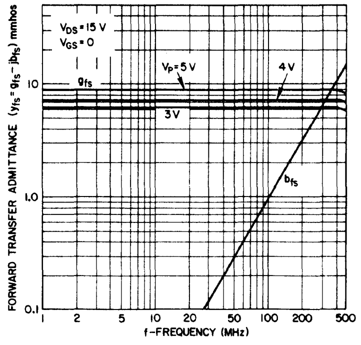
Forward Transadmittance vs Drain Current



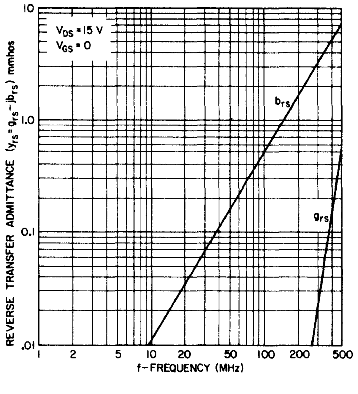
Normalized Forward Transfer Admittance vs Ambient Temperature



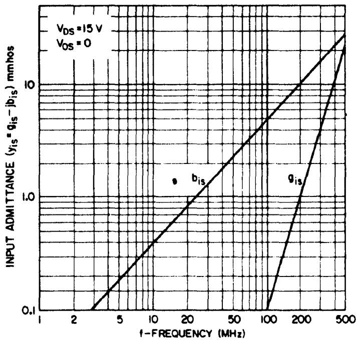
Forward Transfer Admittance vs Frequency



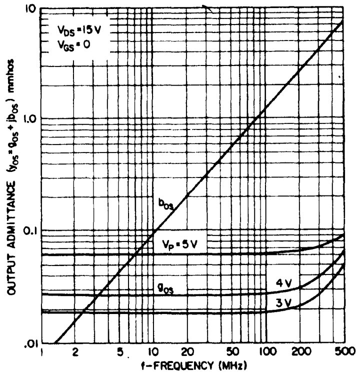
Reverse Transfer Admittance vs Frequency



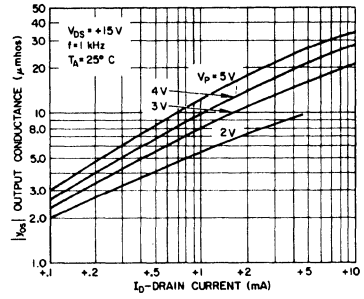
Input Admittance
vs
Frequency



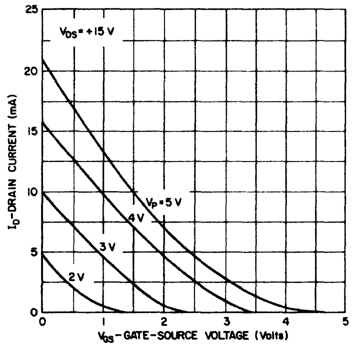
Output Admittance
vs
Frequency



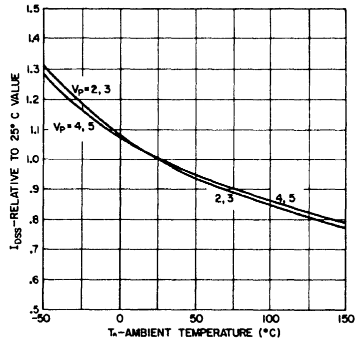
Output Conductance
vs
Drain Current



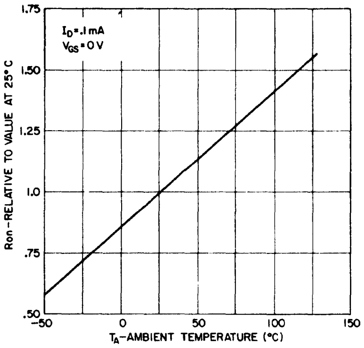
Drain Current
vs
Gate-Source Voltage



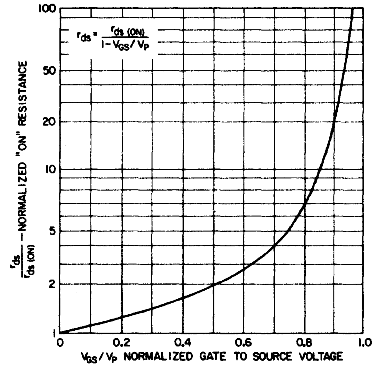
Normalized Drain Saturation Current
vs
Ambient Temperature



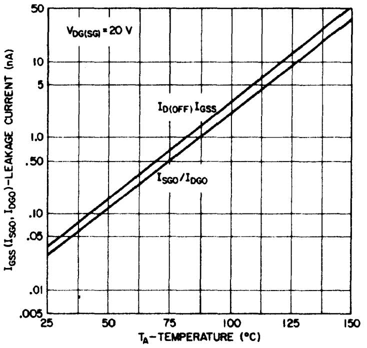
Normalized "On" Resistance
vs
Ambient Temperature



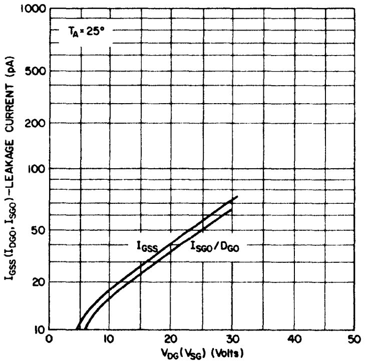
Normalized r_{ds}
vs
V_{GS}



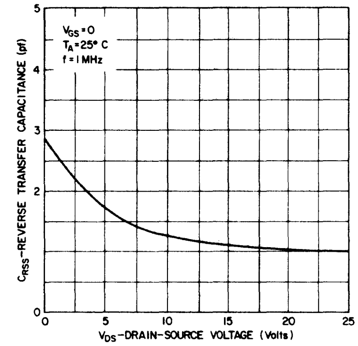
Gate Leakage
vs
Voltage



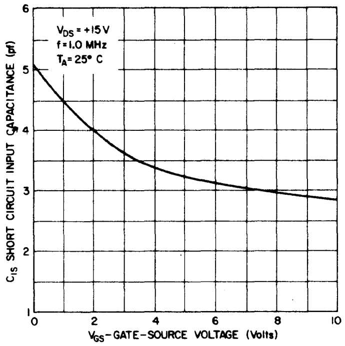
Leakage Current
vs
Voltage



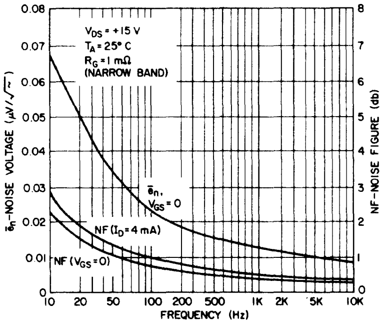
Reverse Transfer Capacitance vs Drain-Source Voltage



Short Circuit Input Capacitance vs Gate-Source Voltage



Noise Voltage/Noise Figure vs Frequency



Noise Figure vs Frequency

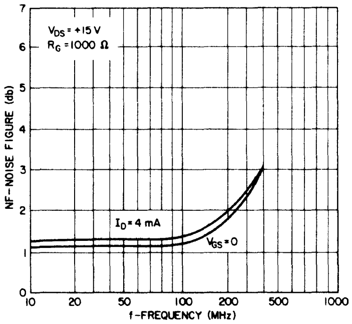
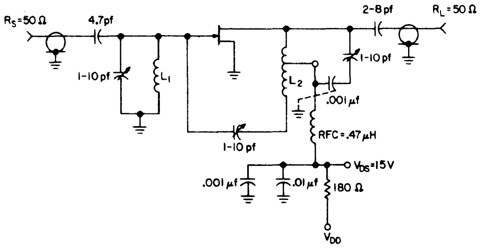


Figure 1.



L_1 1-1/2 turns, #20 tinned wire, 1/4 ID, Length = 3/8"

L_2 3-1/2 turns, #18 tinned wire, 3/8" ID, Length = 1/2"
Tapped at 1-1/4 turns from drain

N-CHANNEL FIELD EFFECT TRANSISTOR
RF/IF AMPLIFIER

- HIGH TRANSCONDUCTANCE
- LOW CAPACITANCE
- LOW NOISE

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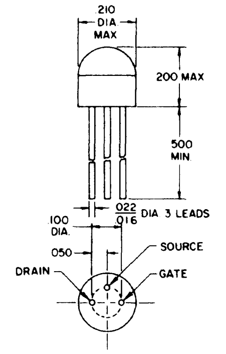

LEADS ELECTRICALLY ISOLATED FROM CASE

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Drain Current	I_D	30	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.3	Watts
Derating Factor above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	+125	°C

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A,\ V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15\ V,\ I_D = 1.0\ nA$		−6.0	Volts
Gate-Source Voltage	V_{GS}	$V_{DS} = 15\ V,\ I_D = 0.5\ mA$	−1.0	−5.5	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -20\ V,\ V_{DS} = 0$ $V_{GS} = -20\ V,\ V_{DS} = 0,\ T_A = 100°C$		−0.1 −10	nA nA
Zero-Gate-Voltage Drain Current	I_{DSS}	$V_{DS} = 15\ V,\ V_{GS} = 0$	5.0	15	mA
Input Capacitance	C_{iss}	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 1 MHz		4.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 1 MHz		1.0	pf
Output Capacitance	C_{oss}	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 1 MHz		2.0	pf
Forward Transadmittance	$\|Y_{fs}\|$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 1 kHz	4500	7500	μmhos
Output Admittance	$\|Y_{os}\|$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 1 kHz		50	μmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 400 MHz		1000	μmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 400 MHz		10000	μmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 100 MHz		100	μmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\ V,\ V_{GS} = 0$ f = 100 MHz		2500	μmhos

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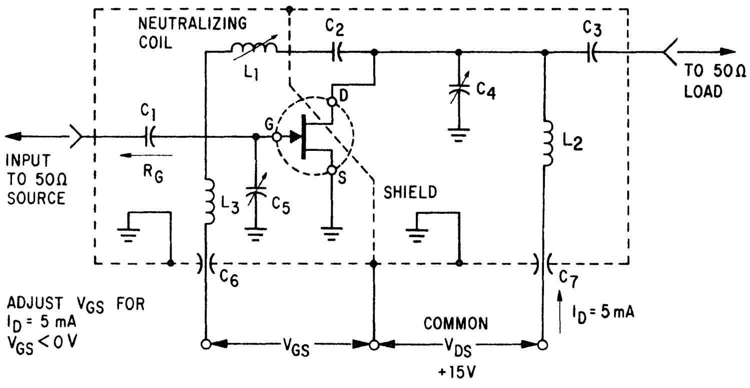
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Output Conductance	$RE(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		100	µmhos
Output Susceptance	$IM(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		4000	µmhos
Output Conductance	$RE(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		75	µmhos
Output Susceptance	$IM(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		1000	µmhos
Forward Transconductance	$RE(Y_{fs})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz	4000		µmhos
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 100 MHz (figure 1)	18		db
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 400 MHz (figure 1)	10		db
Noise Figure	NF	$V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 100 MHz (figure 1) $V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 400 MHz (figure 1)		2.0 4.0	db

NOTE: Case lead grounded during all electrical tests.



REF. DESIG.	VALUE	
	100 MHz	400 MHz
C1	7.0 pF	1.8 pF
C2	1000 pF	27 pF
C3	3.0 pF	1.0 pF
C4	1.0-12 pF	0.8-8 pF
C5	1.0-12 pF	0.8-8 pF
C6	0.0015 µF	0.001 µF
C7	0.0015 µF	0.001 µF
L1	3.0 µh	0.2 µh
L2	0.25 µh	0.03 µh
L3	0.14 µh	0.022 µh

100 MHz & 400 MHz NEUTRALIZED AMPLIFIER

Figure 1

N-CHANNEL FIELD EFFECT TRANSISTOR
RF/IF AMPLIFIER

- HIGH TRANSCONDUCTANCE
- LOW CAPACITANCE
- LOW NOISE

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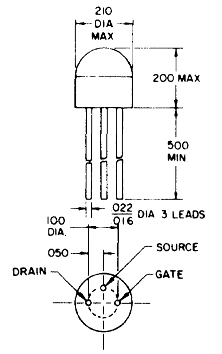

LEADS ELECTRICALLY ISOLATED FROM CASE

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Drain Current	I_D	30	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	0.3	Watts
Derating Factor above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	+125	°C

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\,\mu A$, $V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(off)}$	$V_{DS} = 15\,V$, $I_D = 1.0\,nA$		−8.0	Volts
Gate-Source Voltage	V_{GS}	$V_{DS} = 15\,V$, $I_D = 0.4\,mA$	−1.0	−7.0	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = -20\,V$, $V_{DS} = 0$ $V_{GS} = -20\,V$, $V_{DS} = 0$, $T_A = 100°C$		−.25 −15	nA nA
Zero-Gate-Voltage Drain Current	I_{DSS}	$V_{DS} = 15\,V$, $V_{GS} = 0$	4.0	25	mA
Input Capacitance	C_{iss}	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 1 MHz		4.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 1 MHz		1.3	pf
Output Capacitance	C_{oss}	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 1 MHz		2.0	pf
Forward Transadmittance	$\|Y_{fs}\|$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 1 kHz	4500		μmhos
Output Admittance	$\|Y_{os}\|$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 1 kHz		50	μmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 400 MHz		1000	μmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 400 MHz		10000	μmhos
Input Conductance	$RE(Y_{is})$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 100 MHz		100	μmhos
Input Susceptance	$IM(Y_{is})$	$V_{DS} = 15\,V$, $V_{GS} = 0$ f = 100 MHz		2500	μmhos

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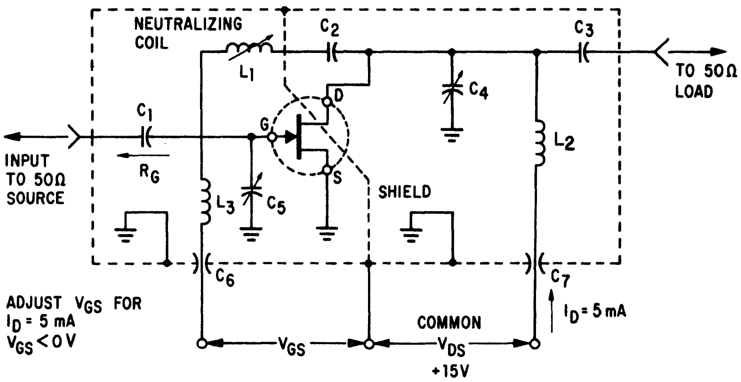
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Output Conductance	$RE(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		100	μmhos
Output Susceptance	$IM(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz		4000	μmhos
Output Conductance	$RE(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		75	μmhos
Output Susceptance	$IM(Y_{os})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 100 MHz		1000	μmhos
Forward Transconductance	$RE(Y_{fs})$	$V_{DS} = 15$ V, $V_{GS} = 0$ f = 400 MHz	4000		μmhos
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 100 MHz (figure 1)	18		db
Power Gain	G_{ps}	$V_{DS} = 15$ V, $I_D = 5$ mA f = 400 MHz (figure 1)	10		db
Noise Figure	NF	$V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 100 MHz (figure 1) $V_{DS} = 15$ V, $I_D = 5$ mA $R_S = 1$ kΩ, f = 400 MHz (figure 1)		2.0 4.0	db



REF. DESIG.	VALUE	
	100 MHz	400 MHz
C1	7.0 pF	1.8 pF
C2	1000 pF	27 pF
C3	3.0 pF	1.0 pF
C4	1.0-12 pF	0.8−8 pF
C5	1.0-12 pF	0.8−8 pF
C6	0.0015 μF	0.001 μF
C7	0.0015 μF	0.001 μF
L1	3.0 μh	0.2 μh
L2	0.25 μh	0.03 μh
L3	0.14 μh	0.022 μh

100 MHz & 400 MHz NEUTRALIZED AMPLIFIER

Figure 1

N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE SWITCH

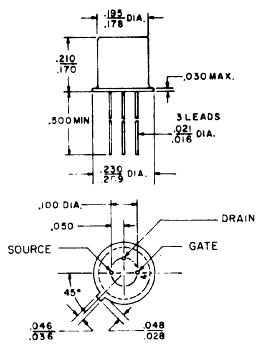
- LOW LEAKAGE
- VERY LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS

JANUARY 1968

2N3970
2N3971
2N3972

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Total Device Dissipation @ $T_C = 25°C$	P_D	1.8	Watts
Derating Factor above 25°C @ $T_C = 25°C$		10	mW/°C
Storage Temperature	T_{stg}	200	°C
Junction Temperature	T_J	200	°C



COLLECTOR IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A, I_S = 0$	40		Volts
Source-Gate Breakdown Voltage	BV_{SGO}	$I_S = 1.0\ \mu A, I_D = 0$	40		Volts
Saturation Current 2N3970 2N3971 2N3972	$I_{DSS}{}^*$	$V_{DS} = 20\ V, V_{GS} = 0$	50 25 5.0	150 75 30	mA
Gate-Drain Leakage Current	I_{DGO}	$V_{DG} = 20\ V, I_S = 0$ $V_{DG} = 20\ V, I_S = 0$ $T_A = 150°C$		0.25 0.5	nA μA
Drain Cutoff Current	$I_{D(OFF)}$	$V_{GS} = -12\ V$ $V_{GS} = -12\ V$ $T_A = 150°C$		0.25 0.5	nA μA
Drain-Source "ON" Voltage 2N3970 2N3971 2N3972	$V_{DS(ON)}$	$I_D = 20\ mA, V_{GS} = 0$ $I_D = 10\ mA, V_{GS} = 0$ $I_D = 5.0\ mA, V_{GS} = 0$		1.0 1.5 2.0	Volts
Pinch Off Voltage 2N3970 2N3971 2N3972	V_P	$V_{DS} = 20\ V, I_D = 1.0\ nA$	4.0 2.5 0.5	10 5.0 3.0	Volts
Small-Signal Drain-Source "ON" Resistance 2N3970 2N3971 2N3972	$r_{ds(ON)}$	$I_D = 0, V_{GS} = 0$		30 60 100	Ohms
"ON" Resistance 2N3970 2N3971 2N3972	R_{ON}	$I_D = 1.0\ mA, V_{GS} = 0$		30 60 100	Ohms
Rise Time 2N3970 2N3971 2N3972	t_r	See Figures 1 & 2		10 15 40	nsec

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Delay Time 2N3970 2N3971 2N3972	t_d	See Figures 1 & 2		10 15 40	nsec
Turn-Off Time 2N3970 2N3971 2N3972	t_{off}	See Figures 1 & 2		30 60 100	nsec
Input Capacitance	C_{is}	$V_{DS} = 20$ V, $V_{GS} = 0$ $f = 1.0$ MHz		25	pf
Drain-Gate Feedback Capacitance	C_{rss}	$V_{DS} = 0$, $V_{GS} = -12$ V $f = 1.0$ MHz		6.0	pf

* Pulse Test: Pulse Width = 300 μsec; Duty Cycle = 3%.

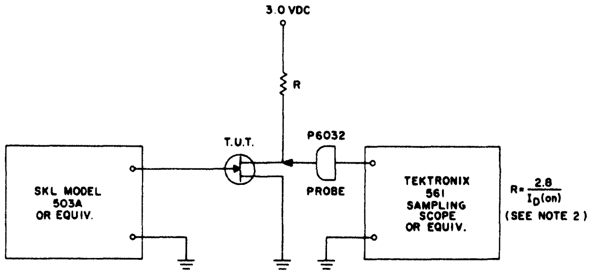


Figure 1

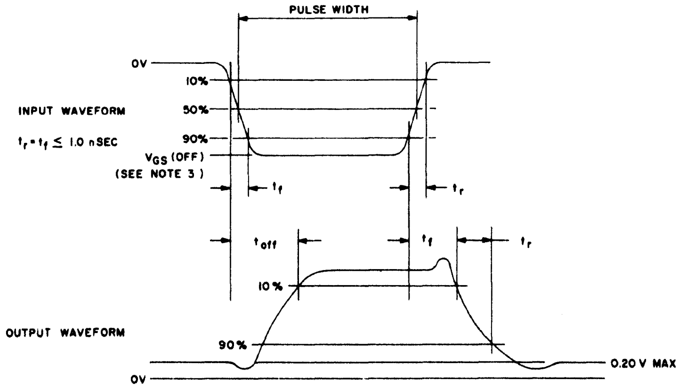


Figure 2

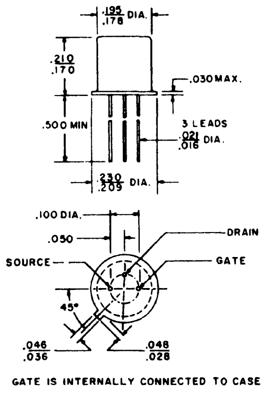
N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE SWITCH
- VERY LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS
- LOW LEAKAGE

JANUARY 1968

2N4091
2N4092
2N4093

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Power Dissipation @ $T_C = 25°C$	P_D	1.8	Watt
Derating Temperature @ $T_C = 25°C$		10	mW/°C
Storage Temperature	T_{stg}	−55 to +200	°C
Junction Temperature	T_J	+200	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A, I_S = 0$	40		Volts
Source-Gate Breakdown Voltage	BV_{SGO}	$I_S = 1.0\ \mu A, I_D = 0$	40		Volts
Drain-Source "ON" Voltage	$V_{DS(ON)}$	$I_D = (**), V_{GS} = 0$		0.2	Volts
Saturation Current 2N4091 2N4092 2N4093	$I_{DSS}{}^*$	$V_{DS} = 20\ V, V_{GS} = 0$	30 15 8.0		mA
Gate-Drain Leakage Current	I_{DGO}	$V_{DG} = 20\ V, I_S = 0$		0.2	nA
Drain Cutoff Current	$I_{D(OFF)}$	$V_{GS} = (***), V_{DS} = 20\ V$ $V_{GS} = (***), V_{DS} = 20\ V, T_A = 150°C$		0.2 0.4	nA μA
Gate-Source Leakage Current	I_{SGO}	$V_{SG} = 20\ V, I_D = 0$		0.2	nA
Pinch Off Voltage 2N4091 2N4092 2N4093	V_p	$V_{DS} = 20\ V, I_D = 1.0\ nA$	5.0 2.0 1.0	10 7.0 5.0	Volts
Small-Signal Drain-Source "ON" Resistance 2N4091 2N4092 2N4093	$r_{ds(ON)}$	$V_{DS} = 0, V_{GS} = 0$		30 50 80	Ohms
"ON" Resistance 2N4091 2N4092 2N4093	R_O	$I_D = 1.0\ mA, V_{GS} = 0$		30 50 80	Ohms
Rise Time 2N4091 2N4092 2N4093	t_r	See Figures 1 & 2		10 20 40	nsec
Delay Time 2N4091 2N4092 2N4093	t_d	See Figures 1 & 2		15 15 20	nsec

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MAX.	MIN.	UNIT
Turn-Off Time 2N4091 2N4092 2N4093	t_{off}	See Figures 1 & 2		40 60 80	nsec
Input Capacitance	C_{is}	$V_{DS} = 20\text{ V}, V_{GS} = 0$ $f = 1.0\text{ MHz}$		16	pf
Drain-Gate Capacitance	C_{DG}	$V_{DG} = 20\text{ V}, I_S = 0$ $f = 1.0\text{ MHz}$		5.0	pf
Source Gate Capacitance	C_{SG}	$V_{SG} = 20\text{ V}, I_D = 0$ $f = 1.0\text{ MHz}$		5.0	pf

NOTES: * Pulse Test: Pulse Width $\leq$ 300 μsec; Duty Cycle $\leq$ 3%.

** 2N4091	$I_D = 6.6\text{ mA}$		*** 2N4091	$V_{GS(OFF)} = -12\text{ V}$
2N4092	$I_D = 4.0\text{ mA}$		2N4092	$V_{GS(OFF)} = -8.0\text{ V}$
2N4093	$I_D = 2.5\text{ mA}$		2N4093	$V_{GS(OFF)} = -6.0\text{ V}$

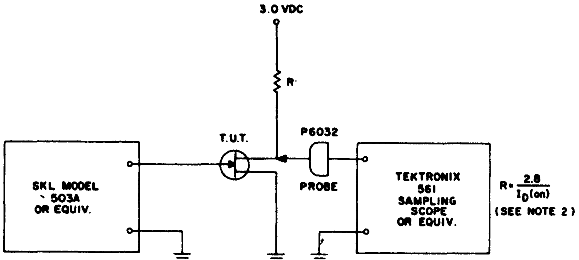


Figure 1

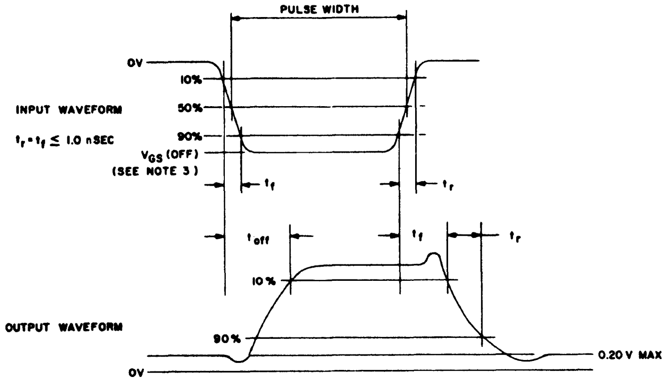
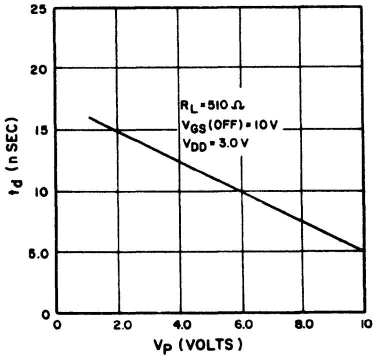
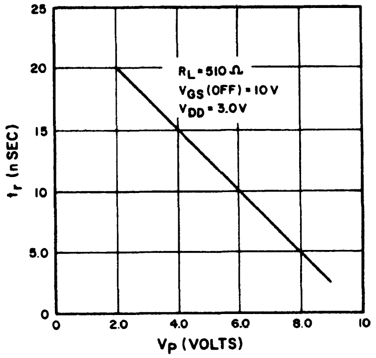
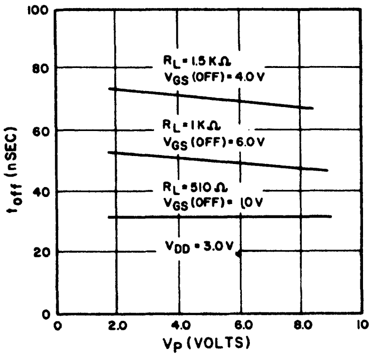


Figure 2

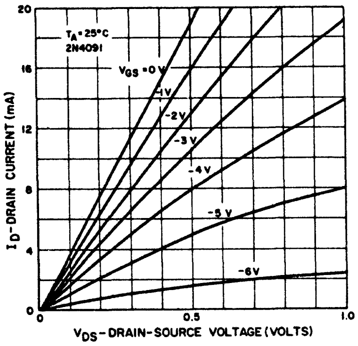
Switching Characteristics

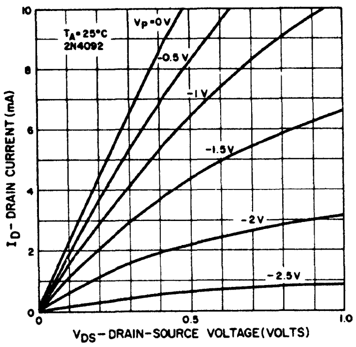


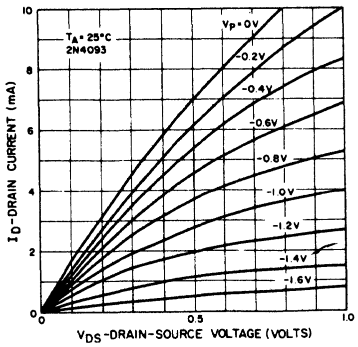




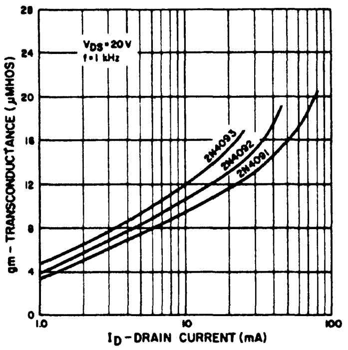
Common Source-Drain Characteristics



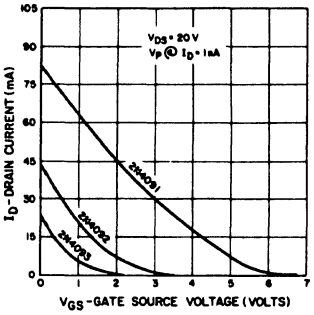




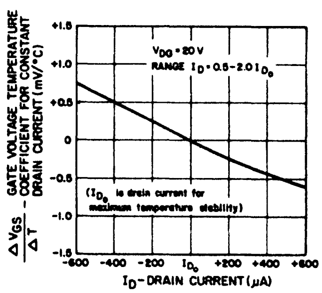
Transconductance vs Drain Current



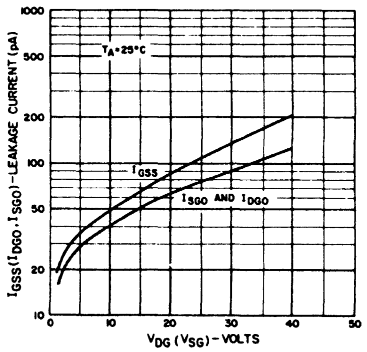
Drain Current vs Gate-Source Bias



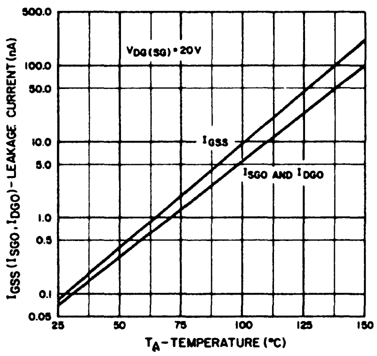
Gate Voltage Temperature Coefficients for Constant Drain Current vs Drain Voltage



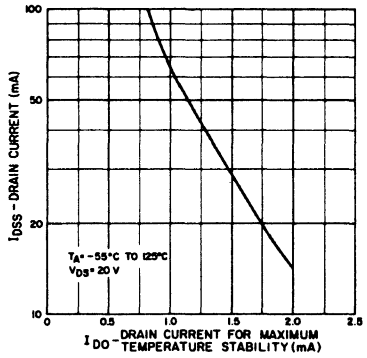
Leakage Current vs Voltage



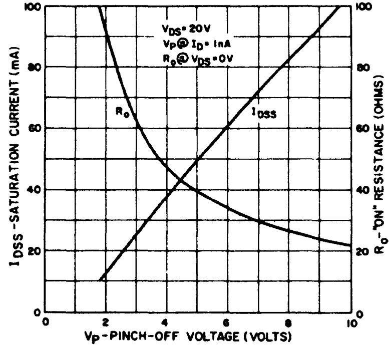
Gate Leakage Current vs Temperature



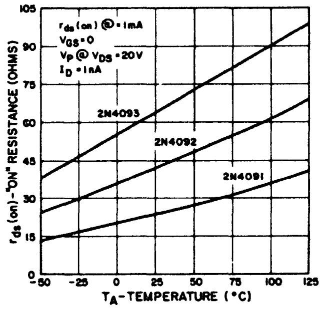
Drain Current for Maximum Temperature Stability



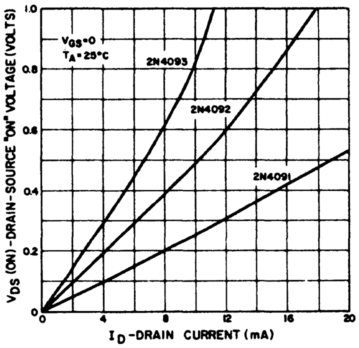
"ON" Resistance And Drain Current vs Pinch-Off Voltage



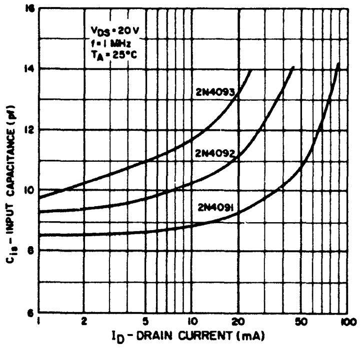
"ON" Resistance vs Temperature



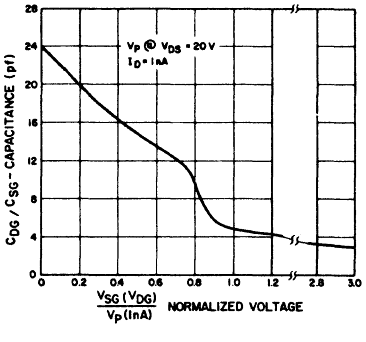
Drain-Source "ON" Voltage vs Drain Current



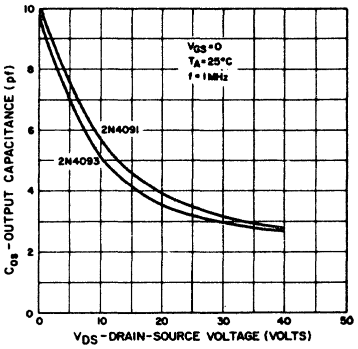
Input Capacitance vs Drain Current



Junction Capacitance vs Normalized Bias



Output Capacitance vs Drain-Source Voltage



N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE SWITCH

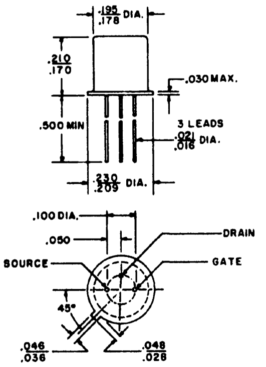
- VERY LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS
- LOW LEAKAGE

NOVEMBER 1968

2N4856 2N4859
2N4857 2N4860
2N4858 2N4861

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		2N4856-57-58	2N4859-60-61	
Drain-Source Voltage	V_{DS}	40	30	Volts
Drain-Gate Voltage	V_{DG}	40	30	Volts
Reverse Gate-Source Voltage	V_{GS}	−40	−30	Volts
Power Dissipation @ $T_A = 25°C$	P_D	360		mWatt
Derating Temperature @ $T_A = 25°C$		2.4		mW/°C
Storage Temperature	T_{stg}	−65 to +200		°C
Junction Temperature	T_J	+200		°C
Lead Temperature 1/16" from case for 10 seconds		300		°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at 25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage 2N4856-57-58 2N4859-60-61	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	40 30		Volts
Gate-Source Cutoff Voltage 2N4856, 2N4859 2N4857, 2N4860 2N4858, 2N4861	$V_{GS(OFF)}$	$V_{DS} = 15\ V, I_D = 0.5$ na	4.0 2.0 0.8	10 6.0 4.0	Volts
Drain-Source "ON" Voltage 2N4856-59 2N4857-60 2N4858-61	$V_{DS(ON)}$	$I_D = 20\ mA, V_{GS} = 0$ $I_D = 10\ mA, V_{GS} = 0$ $I_D = 5\ mA, V_{GS} = 0$		0.75 0.50 0.50	Volts
Saturation Current 2N4856, 2N4859 2N4857, 2N4860 2N4858, 2N4861	I_{DSS}*	$V_{DS} = 15\ V, V_{GS} = 0$	50 20 8	 100 80	mA
Gate Reverse Current 2N4856-57-58 2N4859-60-61	I_{GSS}	$V_{GS} = 20\ V, V_{DS} = 0\ V$ $V_{GS} = 20\ V, V_{DS} = 0\ V, T_A = 150°C$ $V_{GS} = 15\ V, V_{DS} = 0\ V$ $V_{GS} = 15\ V, V_{DS} = 0\ V, T_A = 150°C$		0.25 0.5 0.25 0.5	nA μA nA μA
Drain Cutoff Current	$I_{D(OFF)}$	$V_{GS} = -10\ V, V_{DS} = 15\ V$ $V_{GS} = -10\ V, V_{DS} = 15\ V, T_A = 150°C$		0.25 0.5	nA μA
Small Signal Drain Source "ON" Resistance 2N4856, 2N4859 2N4857, 2N4860 2N4858, 2N4861	$r_{ds(ON)}$	$V_{DS} = 0, V_{GS} = 0$		25 40 60	Ohms
"ON" Resistance 2N4856, 2N4859 2N4857, 2N4860 2N4858, 2N4861	R_O	$I_D = 1.0\ mA, V_{GS} = 0$		25 40 60	Ohms

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Rise Time	t_r				
2N4856, 2N4859		See Figures 1 & 2		3	ns
2N4857, 2N4860				4	
2N4858, 2N4861				10	
Delay Time	t_d				
2N4856, 2N4859		See Figures 1 & 2		6	ns
2N4857, 2N4860				6	
2N4858, 2N4861				10	
Turn-Off Time	t_{off}				
2N4856, 2N4859		See Figures 1 & 2		25	ns
2N4857, 2N4860				50	
2N4858, 2N4861				100	
Input Capacitance	C_{iss}	$V_{DS} = 0$ V, $V_{GS} = -10$ V f = 1.0 MHz		18	pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 0$ V, $V_{GS} = -10$ V f = 1.0 MHz		8.0	pF

*Pulse Test: Pulse Width = 100 msec, Duty Cycle ≤ 10%.

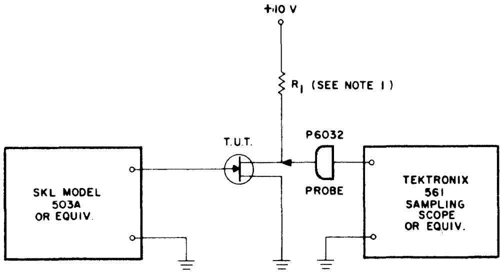


Figure 1

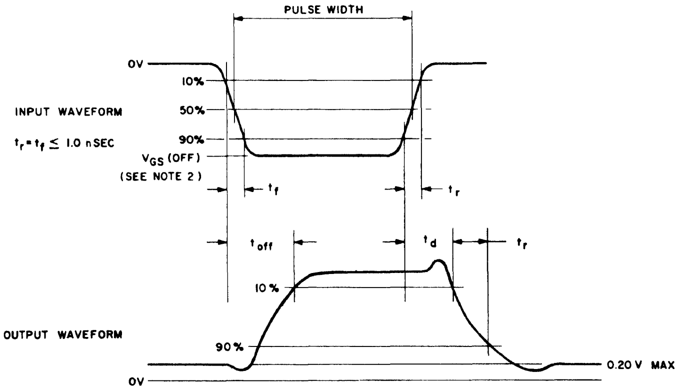


Figure 2

NOTES: 1) 2N4856, 2N4859 $R_l = 464$ ohms
2N4857, 2N4860 $R_l = 953$ ohms
2N4858, 2N4861 $R_l = 1910$ ohms
2) 2N4856, 2N4859 $V_{GS(OFF)} = -10$ V
2N4857, 2N4860 $V_{GS(OFF)} = -6$ V
2N4858, 2N4861 $V_{GS(OFF)} = -4$ V

N-CHANNEL FIELD EFFECT TRANSISTOR

GENERAL PURPOSE SWITCH

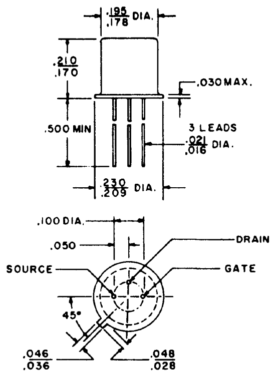
- LOW LEAKAGE
- FAST SWITCHING SPEEDS
- VERY LOW "ON" RESISTANCE

JANUARY 1968

2N4977
2N4978
2N4979

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	30	Volts
Drain-Gate Voltage	V_{DG}	30	Volts
Reverse Gate-Source Voltage	V_{GS}	30	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_C = 25°C$	P_D	1.8	Watts
Derating Factor Above 25°C @ $T_C = 25°C$		10.3	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C
Lead Temperature, 1/16 inch from case, 10 sec. max.		300	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
2N4977		$V_{DS} = 15\ V, I_D = 1.0\ nA$	4.0	10	Volts
2N4978			4.0	8.0	
2N4979			0.5	5.0	
Drain-Source "ON" Voltage	$V_{DS(ON)}$				
2N4977		$I_D = 25\ mA, V_{GS} = 0$		0.4	nA
2N4978		$I_D = 10\ mA, V_{GS} = 0$		0.4	
2N4979		$I_D = 5\ mA, V_{GS} = 0$		0.4	
Gate Reverse Current	I_{GSS}	$V_{GS} = 15\ V, V_{DS} = 0$		0.5	nA
Drain Reverse Current	I_{DGO}	$V_{DG} = 15\ V, I_S = 0$		0.5	nA
		$V_{DG} = 15\ V, I_S = 0, T_A = 150°C$		1.0	µA
Drain Cutoff Current	$I_{D(OFF)}$	$V_{DS} = 15\ V, V_{GS} = -12\ V$		0.5	nA
		$V_{DS} = 15\ V, V_{GS} = -12\ V, T_A = 150°C$		1.0	µA
Zero-Gate-Voltage Drain Current	I_{DSS}				
2N4977		$V_{DS} = 20\ V, V_{GS} = 0$	50		mA
2N4978			15		
2N4979			7.5		
Drain-Source "ON" Resistance	$r_{DS(ON)}$				
2N4977		$I_D = 1.0\ mA, V_{GS} = 0$		15	Ohms
2N4978				20	
2N4979				40	
Drain-Source "ON" Resistance	$r_{ds(ON)}$				
2N4977		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		15	Ohms
2N4978		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		20	
2N4979		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		40	
Input Capacitance	C_{iss}	$V_{DS} = 15\ V, V_{GS} = 0$ $f = 1.0\ MHz$		35	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 0, V_{GS} = -12\ V$ $f = 1.0\ MHz$		8.0	pf

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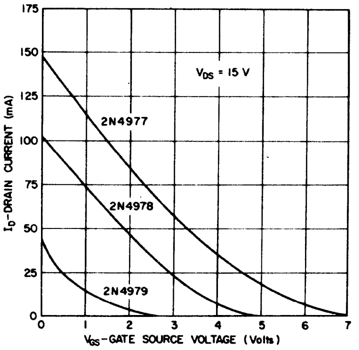
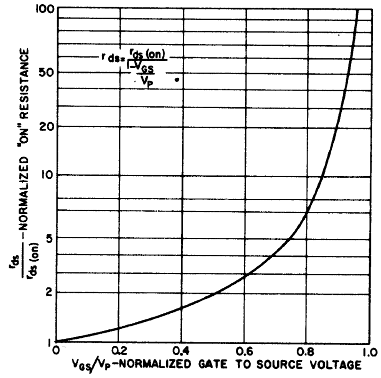
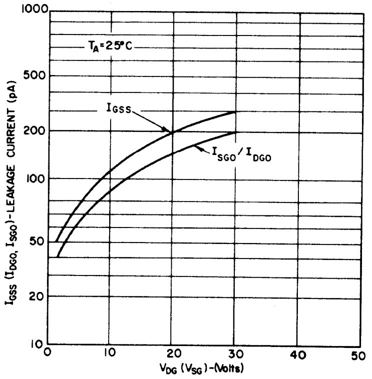
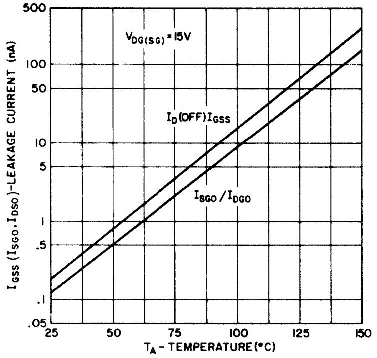
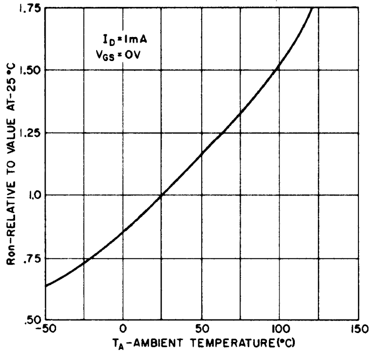
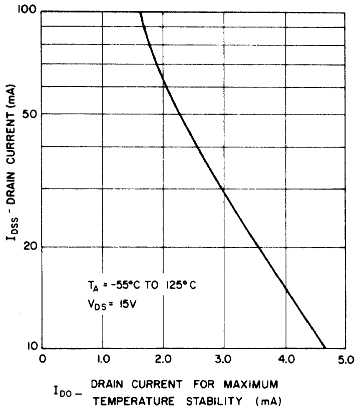

Drain Current vs Gate-Source Bias

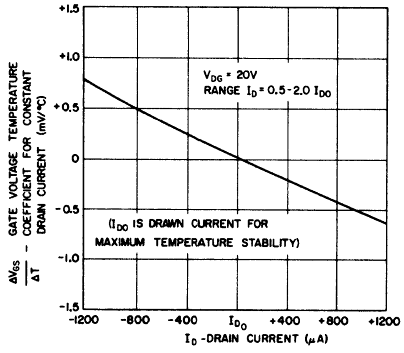

Normalized r_{ds} vs V_{GS}

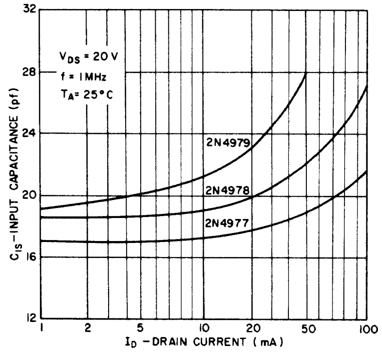

Leakage Current vs Voltage

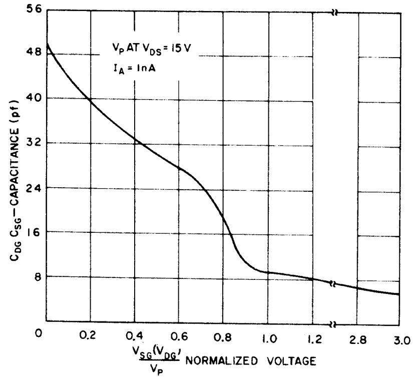

Leakage Gate vs Ambient Temperature

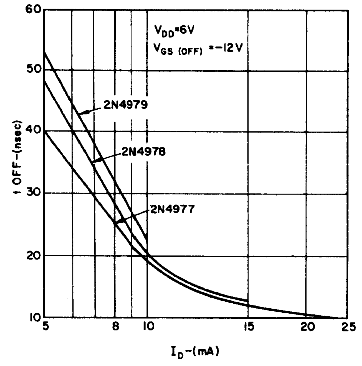

Normalized "On" Resistance vs Ambient Temperature

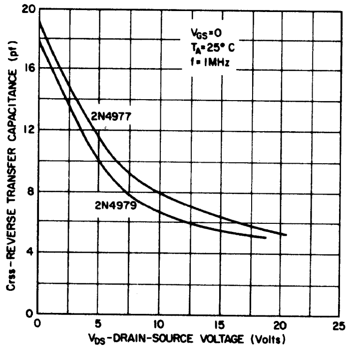

Drain Current for Maximum Temperature Stability


Gate Voltage Temperature Coefficients for Constant Drain Current vs Drain Voltage


Input Capacitance vs Drain Current

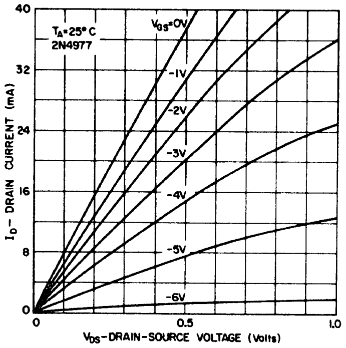

Junction Capacitance vs Normalized Bias


Switching Characteristics Turn-Off Time vs Drain Current

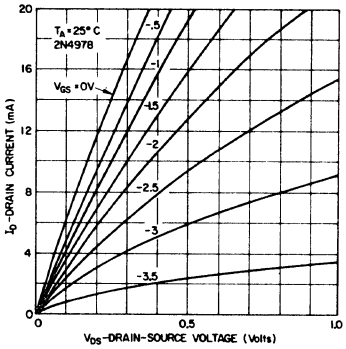

Reverse Transfer Capacitance vs Drain-Source Voltage

CHARACTERISTIC		SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Delay Time		t_d				
	2N4977		See Figure 1		5	nsec
	2N4978		See Figure 2		5	
	2N4979		See Figure 3		10	
Rise Time		t_r				
	2N4977		See Figure 1		5	nsec
	2N4978		See Figure 2		10	
	2N4979		See Figure 3		30	
Turn-Off Time		t_{off}				
	2N4977		See Figure 1		20	nsec
	2N4978		See Figure 2		40	
	2N4979		See Figure 3		60	

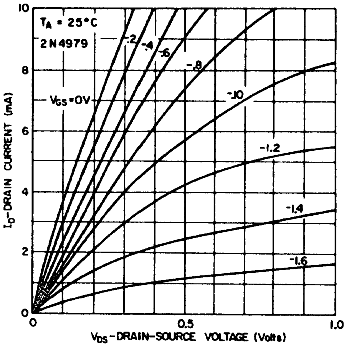
Common Source-Drain
Characteristics



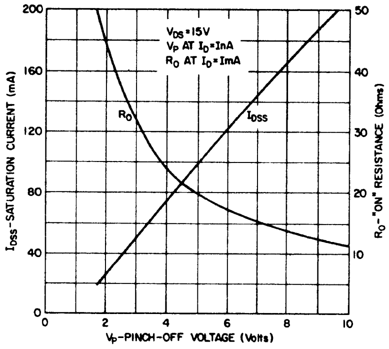
Common Source-Drain
Characteristics



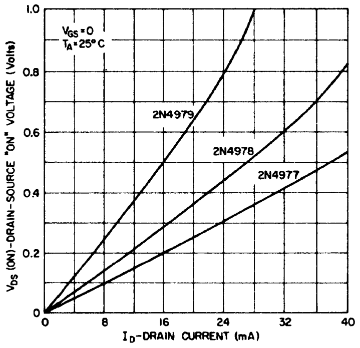
Common Source-Drain
Characteristics



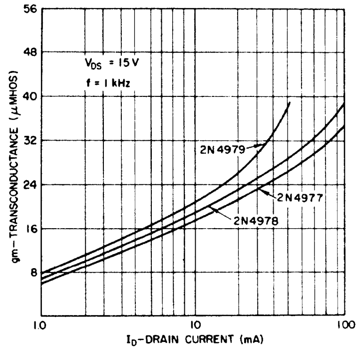
"On" Resistance and Drain Current
vs
Pinch-Off Voltage



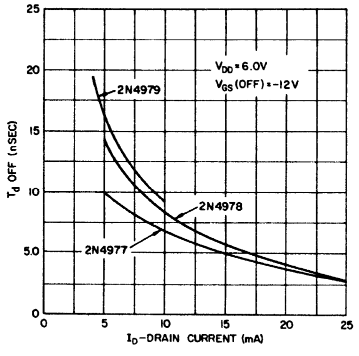
Drain-Source "On" Voltage
vs
Drain Current



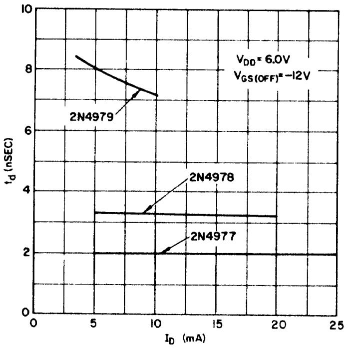
Transconductance
vs
Drain Current



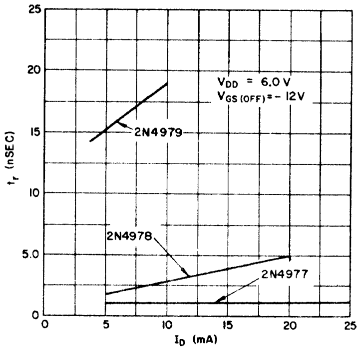
Switching Characteristics
Turn-Off Delay Time
vs
Drain Current

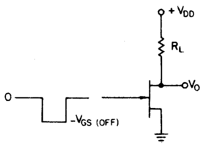


Switching Characteristics
Delay Time
vs
Drain Current



Switching Characteristics
Rise Time
vs
Drain Current



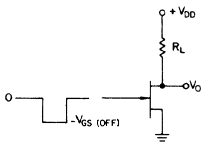


R_L = 220Ω
$I_{D(ON)}$ = 25 mA
$V_{GS(OFF)}$ = -10V
$V_{GS(ON)}$ = 0V
V_{DD} = 6.0V

Input Pulse
- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 110 ns, 10.0% Duty Cycle
- Gen. Source Imp. = 50Ω

Oscilloscope
- Rise Time ≤ 0.4 nsec
- Input Resistance ≃ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 1.

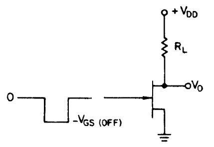


R_L = 560 Ohms
$I_{D(ON)}$ = 10 mA
$V_{GS(OFF)}$ = -8V
$V_{GS(ON)}$ = 0V
V_{DD} = 6.0V

Input Pulse
- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 110 ns, 10.0% Duty Cycle
- Gen. Source Imp. = 50Ω

Oscilloscope
- Rise Time ≤ 0.4 nsec
- Input Resistance ≃ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 2.



R_L = 1.1 kΩ
$I_{D(ON)}$ = 5.0 mA
$V_{GS(OFF)}$ = -5.0V
$V_{GS(ON)}$ = 0V
V_{DD} = 6.0V

Input Pulse
- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 110 ns, 10.0% Duty Cycle
- Gen. Source Imp. = 50Ω

Oscilloscope
- Rise Time ≤ 0.4 nsec
- Input Resistance ≥ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 3.

N-CHANNEL FET
GENERAL PURPOSE SWITCH

- LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS
- LOW LEAKAGE

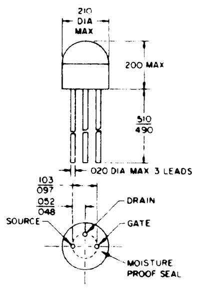
SEPTEMBER 1968

u1897E
u1898E
u1899E

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	40	Volts
Drain-Gain Voltage	V_{DG}	40	Volts
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature Range	T_{stg}	−55 to +125	°C
Operating Junction Temperature	T_J	+125	°C

PHYSICAL DIMENSIONS
IN ACCORDANCE WITH
RO-97B OUTLINE



LEADS ELECTRICALLY ISOLATED FROM CASE

NOTE ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A,\ I_S = 0$	40		Volts
Source-Gate Breakdown Voltage	BV_{SGO}	$I_S = 1.0\ \mu A,\ I_D = 0$	40		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
U1897E		$V_{DS} = 20\ V,\ I_D = 1.0\ nA$	5.0	10	Volts
U1898E			2.0	7.0	
U1899E			1.0	5.0	
Drain Source "ON" Voltage	$V_{DS(on)}$	$I_D = (**),\ V_{GS} = 0$		0.2	Volts
Gate-Drain Leakage Current	I_{DGO}	$V_{DG} = 20\ V,\ I_S = 0$		0.2	nA
Gate-Source Leakage Current	I_{SGO}	$V_{SG} = 20\ V,\ I_D = 0$		0.2	nA
Drain Cutoff Current	$I_{D(OFF)}$	$V_{GS} = (***),\ V_{DS} = 20\ V$ $V_{GS} = (***),\ V_{DS} = 20\ V,\ T_A = +85°C$		0.2 10	nA nA
Zero-Gate Voltage Drain Current	$I_{DSS}{}^*$				
U1897E		$V_{DS} = 20\ V,\ V_{GS} = 0$	30		mA
U1898E			15		
U1899E			8.0		
Drain-Source "ON" Resistance	$r_{DS(ON)}$				
U1897E		$I_D = 1.0\ mA,\ V_{GS} = 0$		30	Ohms
U1898E				50	
U1899E				80	
Input Capacitance	C_{iss}	$V_{DS} = 20\ V,\ V_{GS} = 0$ $f = 1\ MHz$		16	pf
Drain-Gate Capacitance	C_{DG}	$V_{DG} = 20\ V,\ I_S = 0$ $f = 1\ MHz$		5.0	pf
Source-Gate Capacitance	C_{SG}	$V_{SG} = 20\ V,\ I_D = 0$ $f = 1\ MHz$		5.0	pf

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CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Rise Time	t_r				
U1897E		See Figures 1 & 2		10	nsec
U1898E				20	
U1899E				40	
Delay Time	t_d				
U1897E		See Figures 1 & 2		15	nsec
U1898E				15	
U1899E				20	
Turn-OFF Time	t_{off}	See Figures 1 & 2			
U1897E				40	nsec
U1898E				60	
U1899E				80	

NOTES: *Measure under pulse conditions: pulse width $\leq$ 300 μsec; duty cycle $\leq$ 3%.

**U1897E $I_D = 6.6$ mA ∗∗∗U1897E $V_{GS(OFF)} = -12$ V
U1898E $I_D = 4.0$ mA U1898E $V_{GS(OFF)} = -8.0$ V
U1899E $I_D = 2.5$ mA U1899E $V_{GS(OFF)} = -6.0$ V

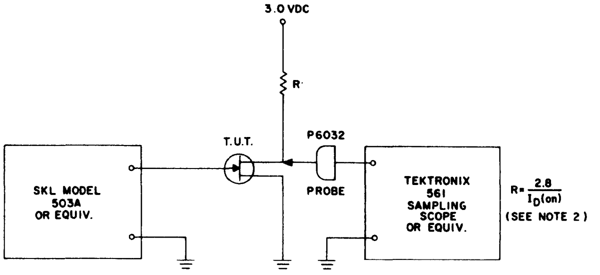


Figure 1

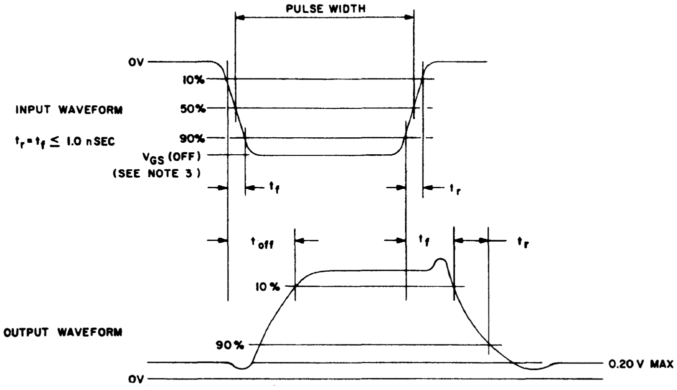
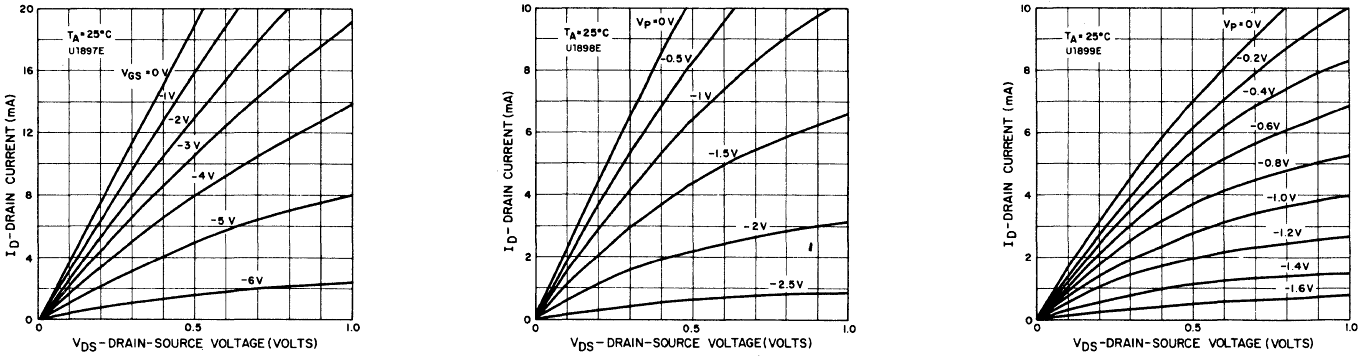
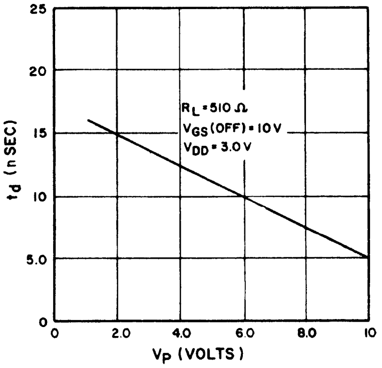


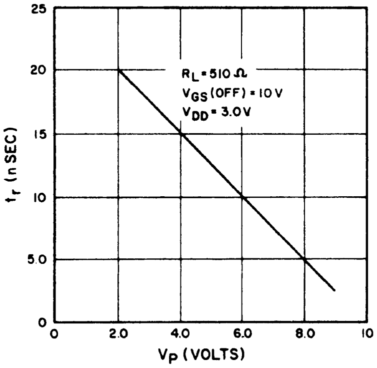
Figure 2

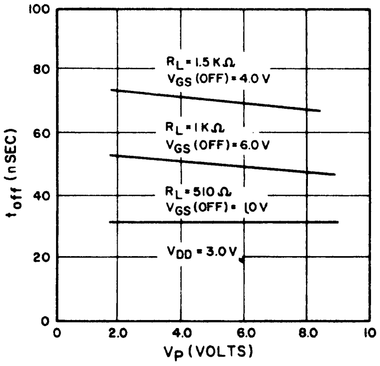
Common Source-Drain Characteristics



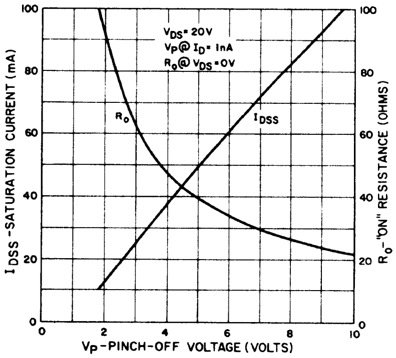
Switching Characteristics



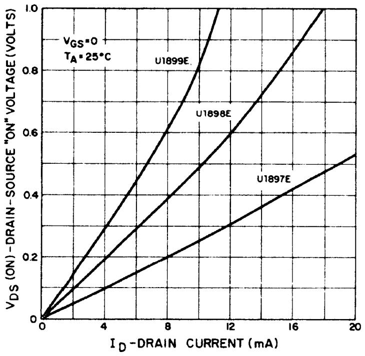




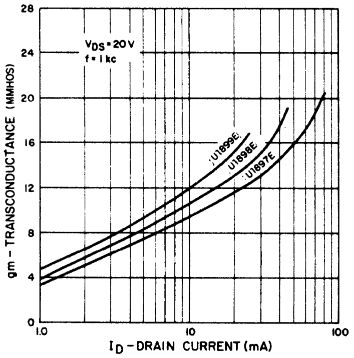
"ON" Resistance And Drain Current vs Pinch-Off Voltage



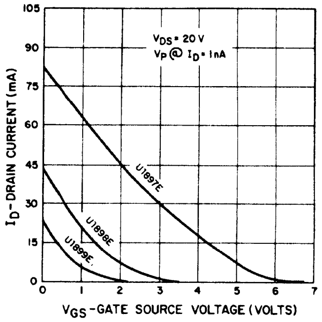
Drain-Source "ON" Voltage vs Drain Current



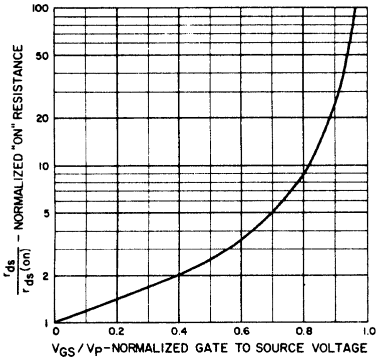
Transconductance vs Drain Current



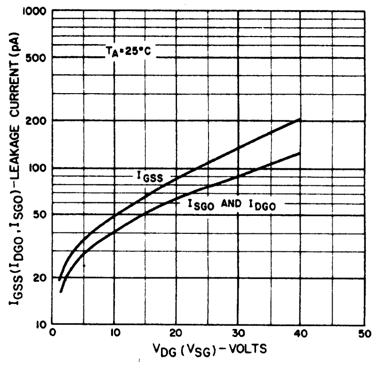
Drain Current vs Gate-Source Bias



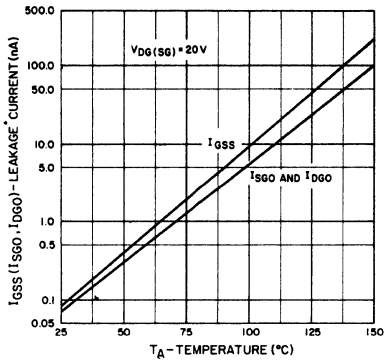
Normalized r_{ds} vs V_{GS}



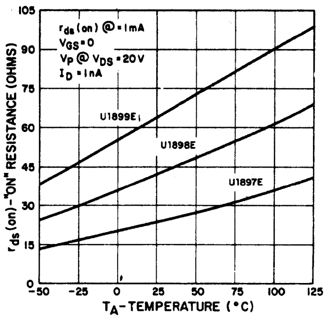
Leakage Current
vs
Voltage



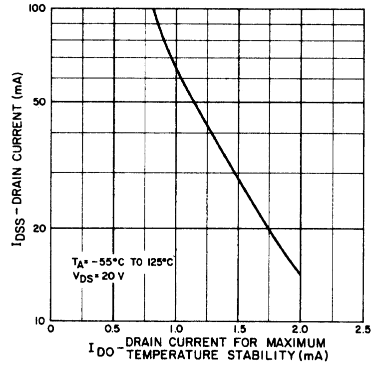
Gate Leakage Current
vs
Temperature



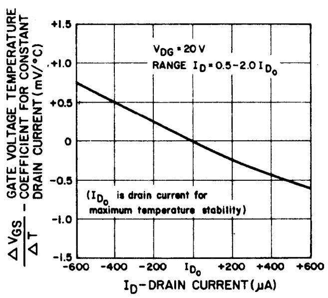
"ON" Resistance
vs
Temperature



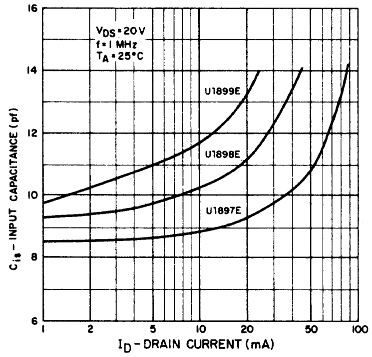
Drain Current for Maximum Temperature Stability



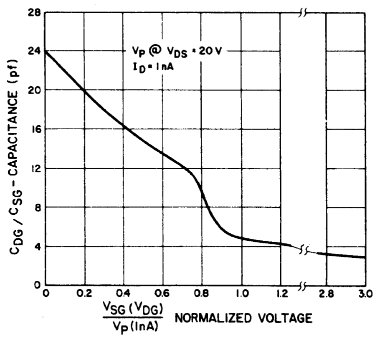
Gate Voltage Temperature Coefficients for Constant Drain Current vs Drain Voltage



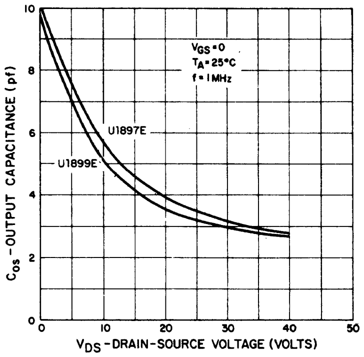
Input Capacitance
vs
Drain Current



Junction Capacitance
vs
Normalized Bias



Output Capacitance
vs
Drain-Source Voltage



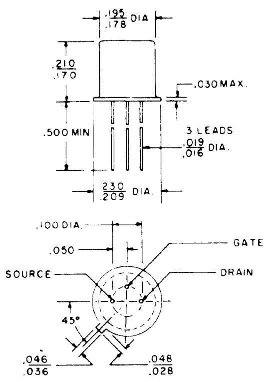
P-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE
- LOW LEAKAGE
- LOW NOISE

JANUARY 1968

2N2606
THRU
2N2609

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mW
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	+175	°C
Derating Factor above 25°C @ $T_A = 25°C$		2	mW/°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate to Source Breakdown Voltage	BV_{GSS}	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Total Gate Leakage Current	I_{GSS}				
2N2606		$V_{GS} = 5.0\ V, V_{DS} = 0$		1.0	nA
2N2607				3.0	
2N2608				10	
2N2609				30	
2N2606		$V_{GS} = 5.0\ V, V_{DS} = 0$ $T_A = 150°C$		1.0	μA
2N2607				3.0	
2N2608				10	
2N2609				30	
Saturation Current	I_{DSS}				
2N2606		$V_{DS} = -5.0\ V, V_{GS} = 0$	100	500	μA
2N2607			300	1500	
2N2608			0.9	4.5	mA
2N2609			2.0	10	
Transconductance	g_m				
2N2606		$V_{DS} = -5.0\ V, V_{GS} = 0$ $f = 1\ kHz$	110		μmhos
2N2607			330		
2N2608			1000		
2N2609			2500		
Input Capacitance	C_{ib}				
2N2606		$V_{DS} = -5.0\ V, V_{GS} = 1.0\ V$ $f = 140\ kHz$		6.0	pf
2N2607				10	
2N2608				17	
2N2609				30	
Pinch Off Voltage	Vp	$V_{DS} = -5.0\ V, I_D = 1.0\ \mu A$	1.0	4.0	Volts
Noise Figure	NF	$V_{DS} = -5.0\ V, f = 1\ kHz$			
2N2606, 2N2607		$BW = 160\ Hz, Rg = 10\ M\Omega$		3.0	db
2N2608, 2N2609		$Rg = 1.0\ M\Omega$		3.0	

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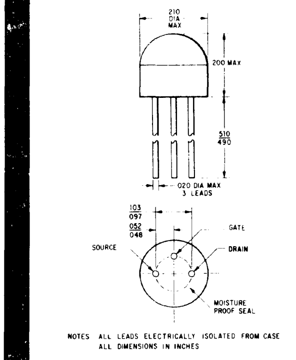
JANUARY 1969

P-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE AMPLIFIER

P1069E

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	−20	Volts
Drain-Gate Voltage	V_{DG}	−20	Volts
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mV
Derating Factor above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature Range	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	+125	°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A$, $I_S = 0$	−20		Volts
Gate Leakage Current	I_{GSS}	$V_{GS} = 5.0\ V$, $V_{DS} = 0$		3.0	nA
Saturation Current	I_{DSS}	$V_{DS} = -10\ V$, $V_{GS} = 0$	−1.0	−5.0	mA
Gate-Source Cutoff Voltage	$V_{GS(Off)}$	$V_{DS} = -10\ V$, $I_D = 3.0\ nA$	1.0	4.0	Volts
Transconductance	g_{fs}	$V_{DS} = -10\ V$, $V_{GS} = 0$, f = 1 kHz	3000	8000	µmhos
Drain-Source "ON" Resistance	$r_{DS(ON)}$	$I_D = 0.1\ mA$, $V_{GS} = 0$		600	ohms
Output Conductance	g_{os}	$V_{DS} = -10\ V$, $V_{GS} = 0$		100	µmhos
Input Capacitance	C_{iss}	$V_{DS} = -10\ V$, $V_{GS} = 0$, f = 140 kHz		40	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = -10\ V$, $V_{GS} = 0$ f = 140 kHz		5.0	pf
Noise Figure	NF	$V_{DS} = -10\ V$, $V_{GS} = 0$, $R_G = 1.0\ M\Omega$ f = 1.0 kHz, BW = 6.0 Hz		3.0	db

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P-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE SWITCH

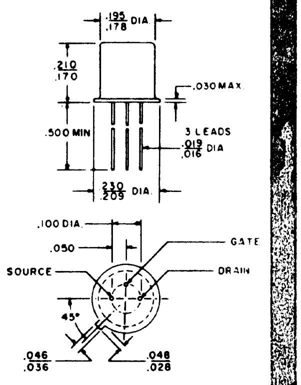
- VERY LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS
- LOW LEAKAGE

JANUARY 1968

2N5018
2N5019

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	−30	Volts
Drain-Gate Voltage	V_{DG}	−30	Volts
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_C = 25°C$	P_D	1.8	Watts
Derating Factor Above 25°C @ $T_A = 25°C$		10	mW/°C
Storage Temperature	T_{stg}	−65 to +200	°C
Junction Temperature	T_J	200	°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300	°C



GATE IS INTERNALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
2N5018		$V_{DS} = -15\ V, I_D = 1.0\ \mu A$		10	Volts
2N5019		$V_{DS} = -15\ V, I_D = 1.0\ \mu A$		5	
Drain-Source "On" Voltage	$V_{DS(ON)}$				
2N5018		$I_D = -6.0\ mA, V_{GS} = 0$		−0.5	Volts
2N5019		$I_D = -3.0\ mA, V_{GS} = 0$		−0.5	
Gate Reverse Current	I_{GSS}	$V_{GS} = 15\ V, V_{DS} = 0$		2.0	nA
Zero-Gate-Voltage Drain Current	I_{DSS}				
2N5018		$V_{DS} = -20\ V, V_{GS} = 0$	−10		mA
2N5019		$V_{DS} = -20\ V, V_{GS} = 0$	−5		
Drain Cutoff Current	$I_{D(OFF)}$				
2N5018		$V_{DS} = -15\ V, V_{GS} = 12\ V$		10	nA
2N5019		$V_{DS} = -15\ V, V_{GS} = 7.0\ V$		10	
2N5018		$V_{DS} = -15\ V, V_{GS} = 12\ V, T_A = 150°C$		10	µA
2N5019		$V_{DS} = -15\ V, V_{GS} = 7.0\ V, T_A = 150°C$		10	
Drain Reverse Current	I_{DGO}	$V_{DG} = -15\ V, I_S = 0$		2.0	nA
		$V_{DG} = -15\ V, I_S = 0, T_A = 150°C$		3.0	µA
Drain-Source "ON" Resistance	$r_{DS(ON)}$				
2N5018		$I_D = 1.0\ mA, V_{GS} = 0$		75	Ohms
2N5019		$I_D = 1.0\ mA, V_{GS} = 0$		150	
Drain-Source "ON" Resistance	$r_{ds(ON)}$				
2N5018		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		75	Ohms
2N5019		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		150	
Rise Time	t_r				
2N5018		See Figure 1		20	nsec
2N5019		See Figure 2		75	
Delay Time	t_d				
2N5018		See Figure 1		15	nsec
2N5019		See Figure 2		15	

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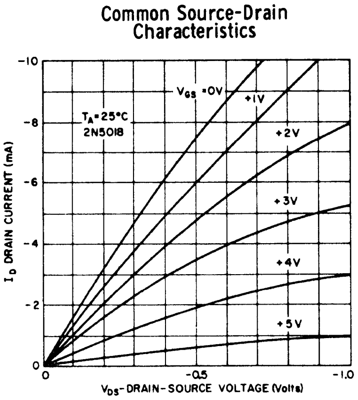
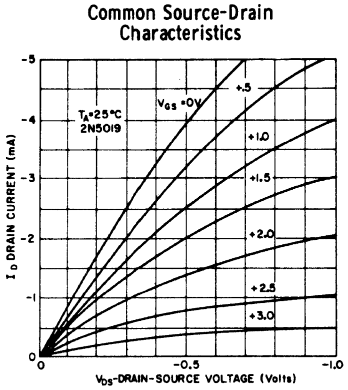
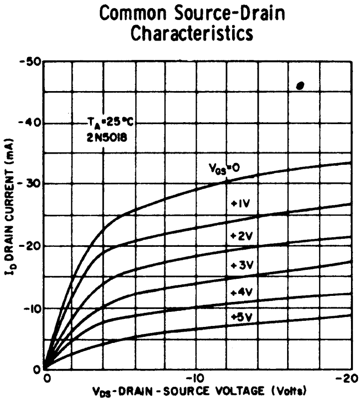
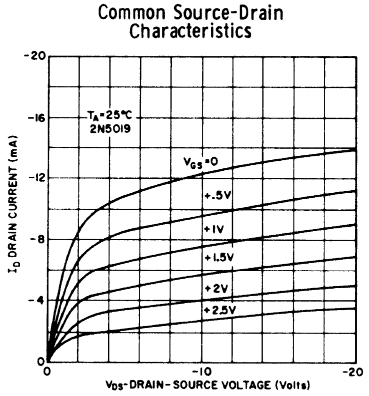
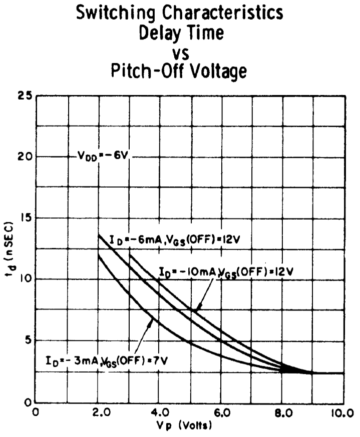
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Turn-Off Delay Time	$t_{d(OFF)}$				
2N5018		See Figure 1		15	nsec
2N5019		See Figure 2		25	
Turn-Off Time	$t_{(OFF)}$				
2N5018		See Figure 1		50	nsec
2N5019		See Figure 2		100	
Input Capacitance	C_{iss}	$V_{DS} = -15\ V, V_{GS} = 0$ $f = 1.0\ MHz$		45	pf
Reverse Transfer Capacitance	C_{rss}				
2N5018		$V_{DS} = 0, V_{GS} = 12\ V$ $f = 1.0\ MHz$		10	pf
2N5019		$V_{DS} = 0, V_{GS} = 7.0\ V$ $f = 1.0\ MHz$		10	

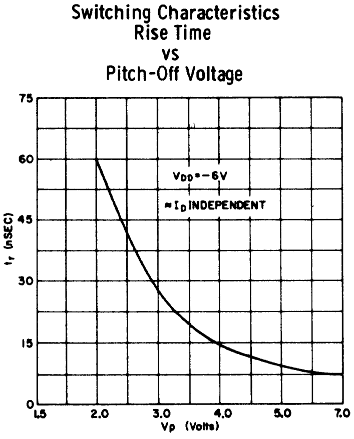

Common Source-Drain Characteristics

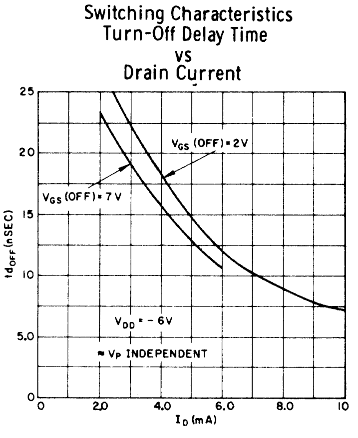

Common Source-Drain Characteristics

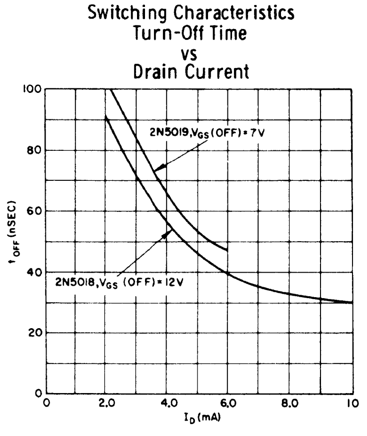

Common Source-Drain Characteristics

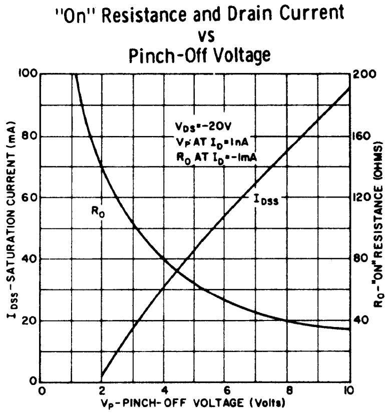

Common Source-Drain Characteristics


Switching Characteristics
Delay Time
vs
Pitch-Off Voltage

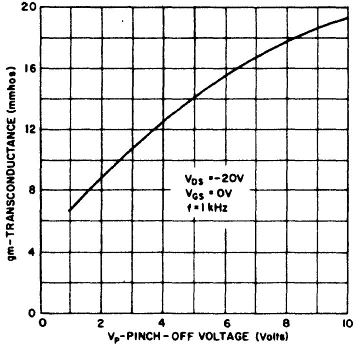

Switching Characteristics
Rise Time
vs
Pitch-Off Voltage


Switching Characteristics
Turn-Off Delay Time
vs
Drain Current

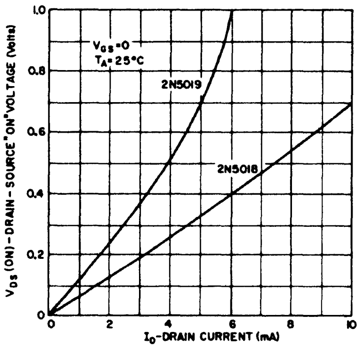

Switching Characteristics
Turn-Off Time
vs
Drain Current


"On" Resistance and Drain Current
vs
Pinch-Off Voltage

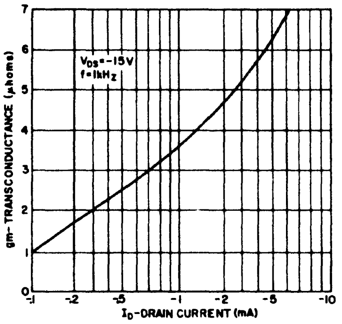
Transconductance
vs
Pinch-Off Voltage



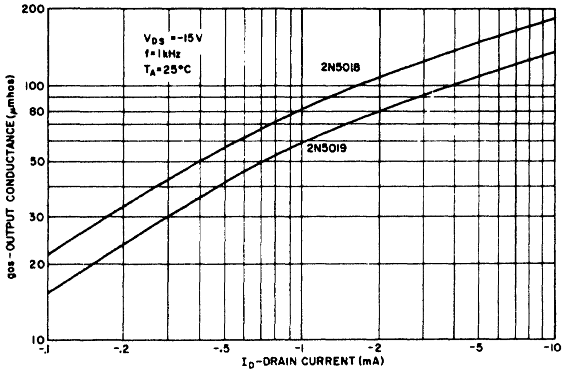
Drain-Source "On" Voltage
vs
Drain Current



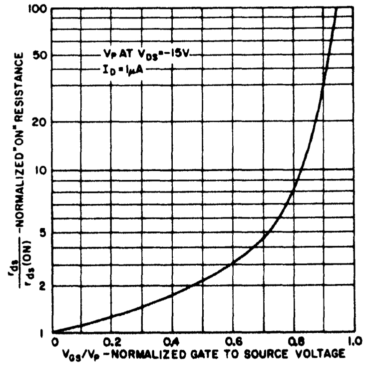
Transconductance
vs
Drain Current



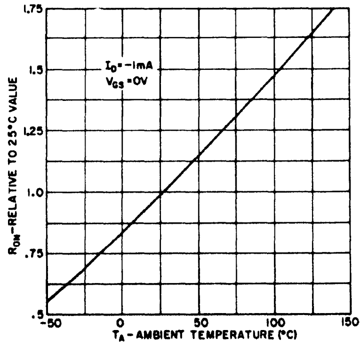
Output Conductance
vs
Drain Current



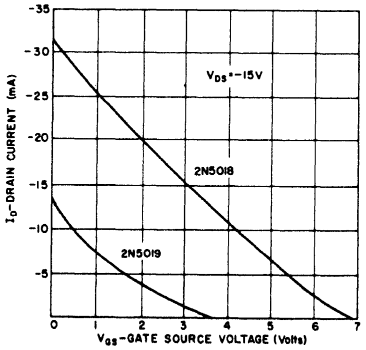
Normalized r_{ds}
vs
V_{GS}



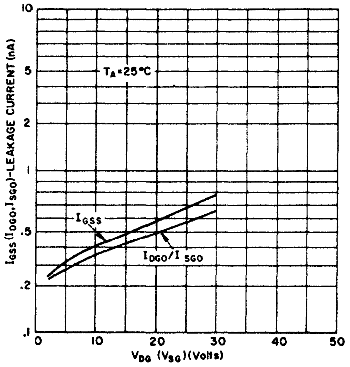
Normalized "On" Resistance
vs
Ambient Temperature



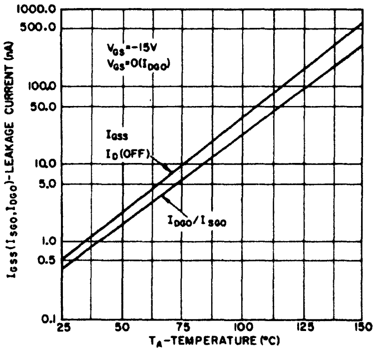
Drain Current
vs
Gate-Source Bias



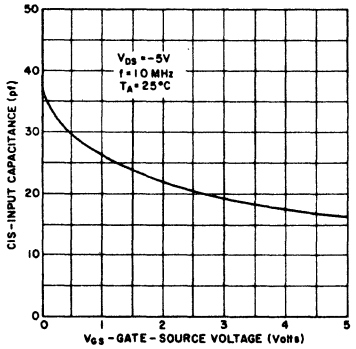
Leakage Current
vs
Voltage

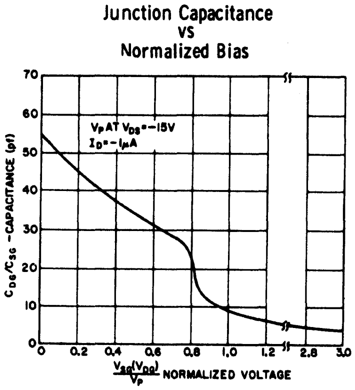


Gate Leakage Current
vs
Temperature

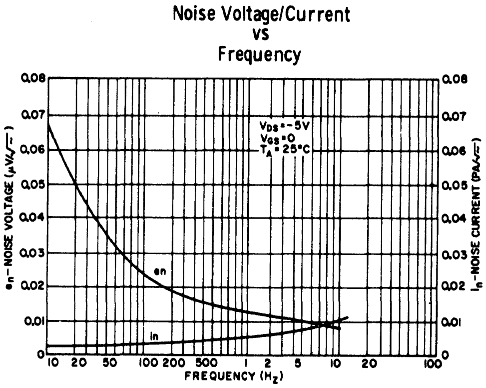


Input Capacitance
vs
Gate-Source Voltage

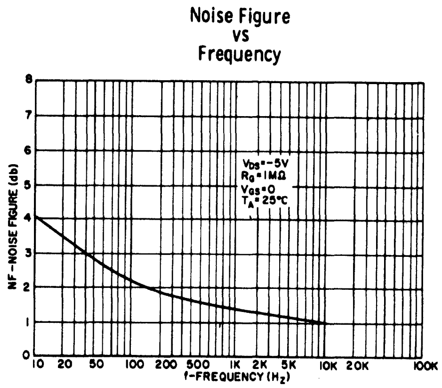




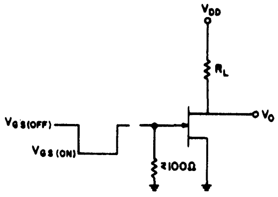
Junction Capacitance
vs
Normalized Bias



Noise Voltage/Current
vs
Frequency



Noise Figure
vs
Frequency

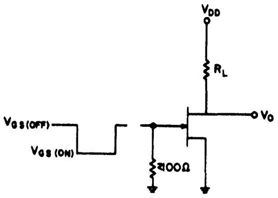


R_L = 910Ω
$I_{D(ON)}$ = 6.0 mA
$V_{GS(OFF)}$ = +12
$V_{GS(ON)}$ = 0V
V_{DD} = -6V

Input Pulse
- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 110 ns, 10% Duty Cycle
- Gen. Source Imp. ≤ 100Ω

Oscilloscope
- Rise Time ≤ 0.4 ns
- Input Resistance ≥ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 1.



R_L = 1.8k
$I_{D(ON)}$ = 3 mA
$V_{GS(OFF)}$ = +7V
$V_{GS(ON)}$ = 0V
V_{DD} = -6V

Input Pulse
- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 100 ns, 10% Duty Cycle
- Gen. Source Imp. ≤ 100Ω

Oscilloscope
- Rise Time ≤ 0.4 ns
- Input Resistance ≥ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 2.

JANUARY 1968

P-CHANNEL FIELD EFFECT TRANSISTOR

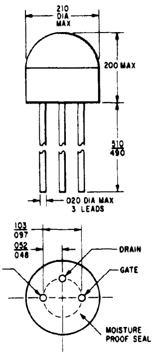
GENERAL PURPOSE SWITCH

- VERY LOW "ON" RESISTANCE
- FAST SWITCHING SPEEDS
- LOW LEAKAGE

P1086E
P1087E

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	−30	Volts
Drain-Gate Voltage	V_{DG}	−30	Volts
Reverse Gate-Source Voltage	V_{GS}	−30	Volts
Gate Current	I_G	10	mA
Total Device Dissipation @ $T_A = 25°C$	P_D	300	mWatts
Derating Factor Above 25°C @ $T_A = 25°C$		2.5	mW/°C
Storage Temperature	T_{stg}	−55 to +125	°C
Junction Temperature	T_J	+125	°C



NOTES: ALL LEADS ELECTRICALLY ISOLATED FROM CASE
ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$				
P1086E		$V_{DS} = -15\ V, I_D = 1.0\ \mu A$		10	Volts
P1087E		$V_{DS} = -15\ V, I_D = 1.0\ \mu A$		5	
Drain-Source "On" Voltage	$V_{DS(ON)}$				
P1086E		$I_D = -6.0\ mA, V_{GS} = 0$		−0.5	Volts
P1087E		$I_D = -3.0\ mA, V_{GS} = 0$		−0.5	
Gate Reverse Current	I_{GSS}	$V_{GS} = 15\ V, V_{DS} = 0$		2.0	nA
Zero-Gate-Voltage Drain Current	I_{DSS}				
P1086E		$V_{DS} = -20\ V, V_{GS} = 0$	−10		mA
P1087E		$V_{DS} = -20\ V, V_{GS} = 0$	−5		
Drain Cutoff Current	$I_{D(OFF)}$				
P1086E		$V_{DS} = -15\ V, V_{GS} = 12\ V$		10	nA
P1087E		$V_{DS} = -15\ V, V_{GS} = 7.0\ V$		10	
P1086E		$V_{DS} = -15\ V, V_{GS} = 12\ V, T_A = 85°C$		0.5	μA
P1087E		$V_{DS} = -15\ V, V_{GS} = 7.0\ V, T_A = 85°C$		0.5	
Drain Reverse Current	I_{DGO}	$V_{DG} = -15\ V, I_S = 0$		2.0	nA
		$V_{DG} = -15\ V, I_S = 0, T_A = 85°C$		0.1	μA
Drain-Source "ON" Resistance	$r_{DS(ON)}$				
P1086E		$I_D = 1.0\ mA, V_{GS} = 0$		75	Ohms
P1087E		$I_D = 1.0\ mA, V_{GS} = 0$		150	
Drain-Source "ON" Resistance	$r_{ds(ON)}$				
P1086E		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		75	Ohms
P1087E		$V_{GS} = 0, I_D = 0$ $f = 1.0\ kHz$		150	
Rise Time	t_r				
P1086E		See Figure 1		20	nsec
P1087E		See Figure 2		75	
Delay Time	t_d				
P1086E		See Figure 1		15	nsec
P1087E		See Figure 2		15	

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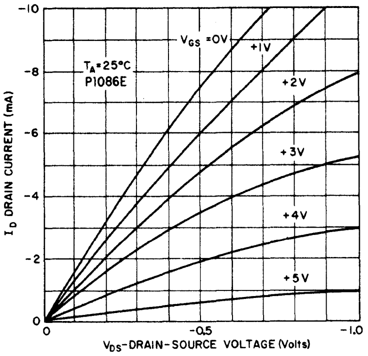
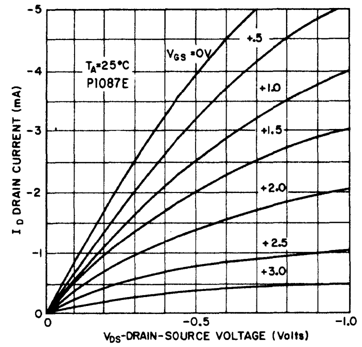
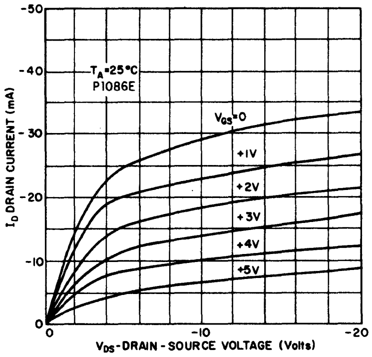
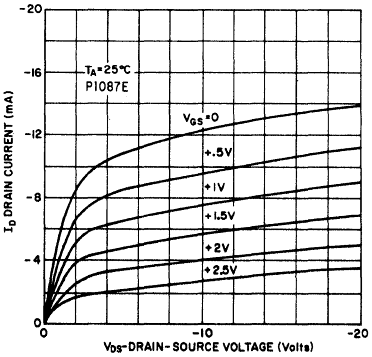
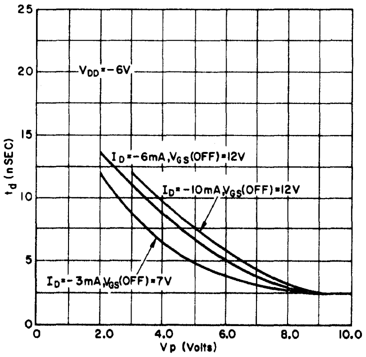
CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Turn-Off Delay Time	$t_{d(OFF)}$				
P1086E		See Figure 1		15	nsec
P1087E		See Figure 2		25	
Turn-Off Time	$t_{(OFF)}$				
P1086E		See Figure 1		50	nsec
P1087E		See Figure 2		100	
Input Capacitance	C_{iss}	$V_{DS} = -15$ V, $V_{GS} = 0$ f = 1.0 MHz		45	pf
Reverse Transfer Capacitance	C_{rss}				
P1086E		$V_{DS} = 0$, $V_{GS} = 12$ V f = 1.0 MHz		10	pf
P1087E		$V_{DS} = 0$, $V_{GS} = 7.0$ V f = 1.0 MHz		10	

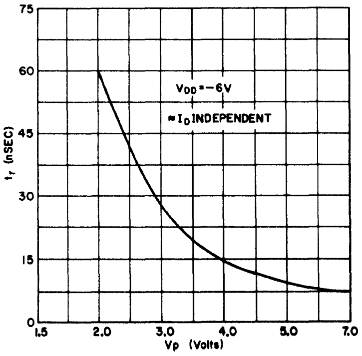

Common Source-Drain Characteristics

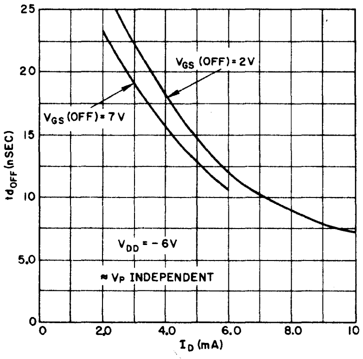

Common Source-Drain Characteristics

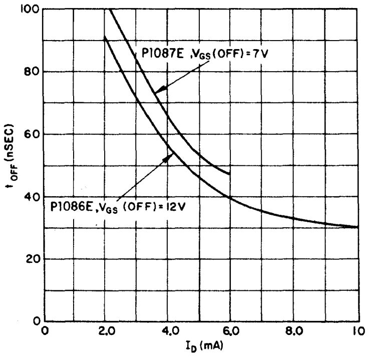

Common Source-Drain Characteristics

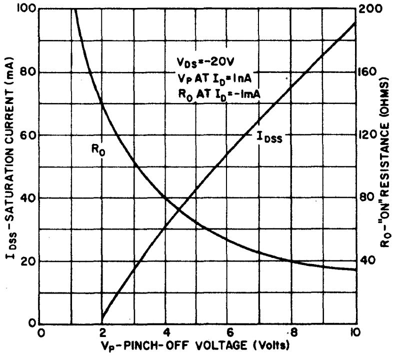

Common Source-Drain Characteristics

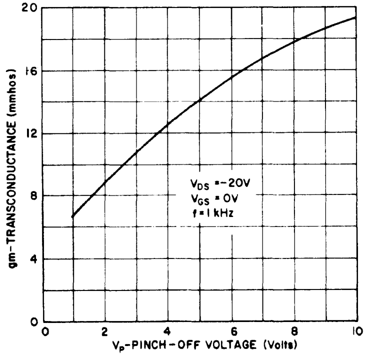

Switching Characteristics Delay Time vs Pitch-Off Voltage

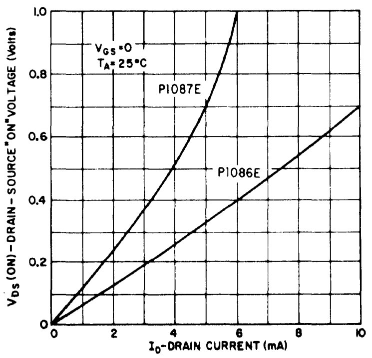

Switching Characteristics Rise Time vs Pitch-Off Voltage

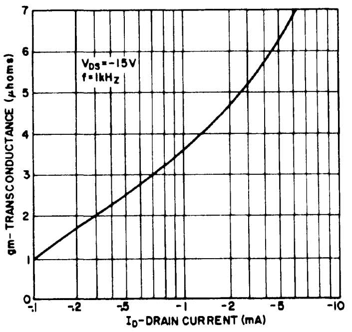

Switching Characteristics Turn-Off Delay Time vs Drain Current

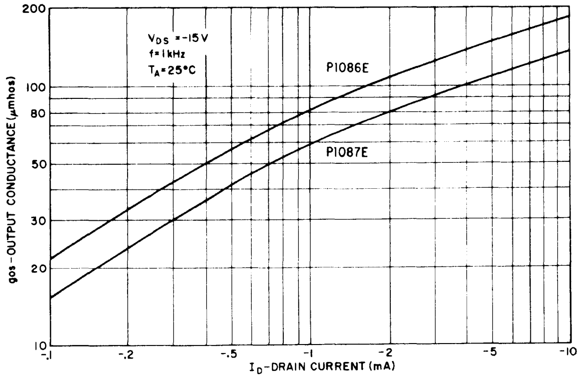

Switching Characteristics Turn-Off Time vs Drain Current

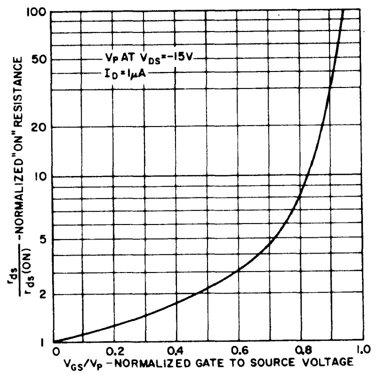

"On" Resistance and Drain Current vs Pinch-Off Voltage

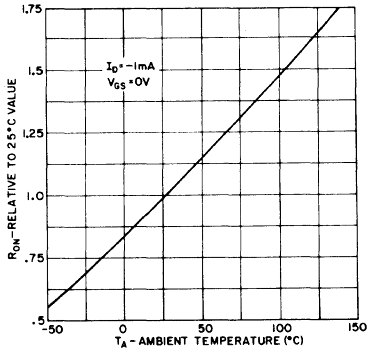

Transconductance vs Pinch-Off Voltage

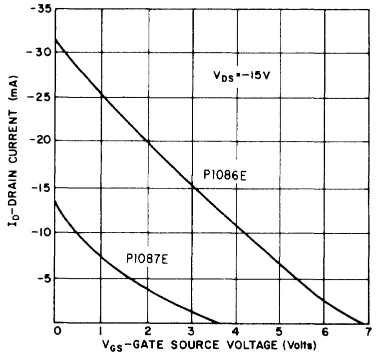

Drain-Source "On" Voltage vs Drain Current

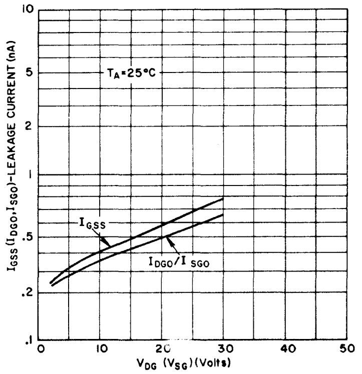

Transconductance vs Drain Current

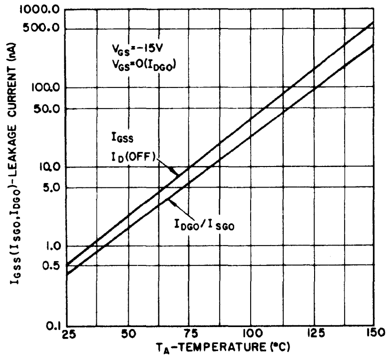

Output Conductance vs Drain Current

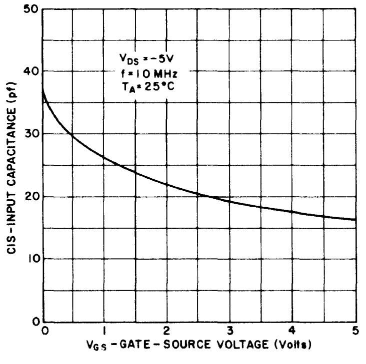

Normalized r_{ds} vs V_{GS}

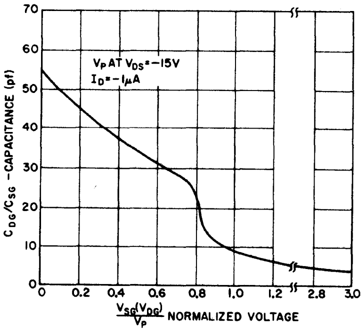

Normalized "On" Resistance vs Ambient Temperature


Drain Current vs Gate-Source Bias

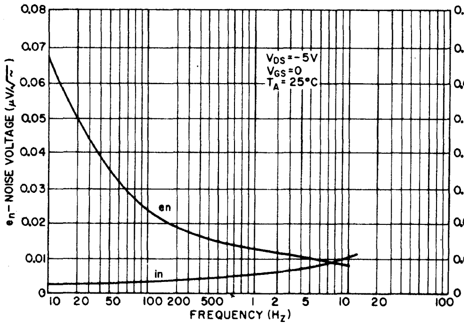

Leakage Current vs Voltage


Gate Leakage Current vs Temperature

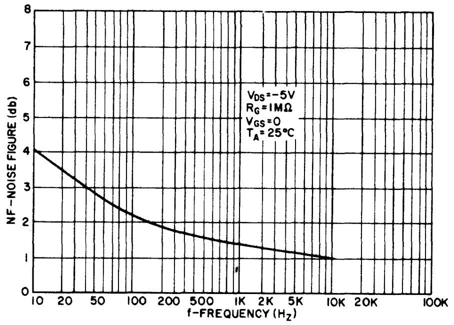

Input Capacitance vs Gate-Source Voltage



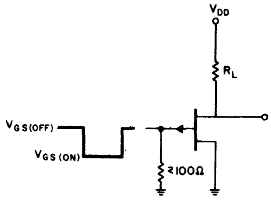
Junction Capacitance vs Normalized Bias



Noise Voltage/Current vs Frequency



Noise Figure vs Frequency



R_L = 910Ω

$I_{D(ON)}$ = 6.0 mA

$V_{GS(OFF)}$ = +12

$V_{GS(ON)}$ = 0V

V_{DD} = -6V

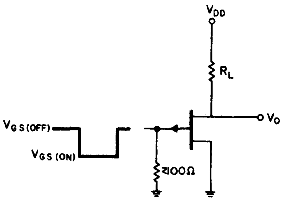
Input Pulse

- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 110 ns, 10% Duty Cycle
- Gen. Source Imp. ≤ 100Ω

Oscilloscope

- Rise Time ≤ 0.4 ns
- Input Resistance ≥ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 1.



R_L = 1.8k

$I_{D(ON)}$ = 3 mA

$V_{GS(OFF)}$ = +7V

$V_{GS(ON)}$ = 0V

V_{DD} = -6V

Input Pulse

- Rise Time < 1.0 ns
- Fall Time < 1.0 ns
- Pulse Width ≤ 100 ns, 10% Duty Cycle
- Gen. Source Imp. ≤ 100Ω

Oscilloscope

- Rise Time ≤ 0.4 ns
- Input Resistance ≥ 9.8 MΩ
- Input Capacitance ≤ 1.7 pf

Figure 2.

DUAL N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

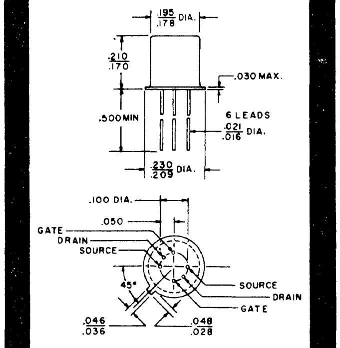
- **VERY CLOSELY MATCHED gm**
- **CLOSELY MATCHED V_{GS}**
- **VERY LOW DIFFERENTIAL DRIFT**

JANUARY 1968

2N3921-22
2N4084-85

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		One Side	Both Sides	
Total Device Dissipation @ $T_A = 25°C$	P_D	250	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.7		mW/°C
Storage Temperature	T_{stg}	−55 to +200		°C
Junction Temperature	T_J	+200		°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A, I_S = 0$	50		Volts
Gate-Source Voltage	V_{GS}	$V_{DS} = 10\ V, I_D = 0.1\ mA$	0.2	2.7	Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -30\ V, V_{DS} = 0$ $V_{GS} = -30\ V, V_{DS} = 0, T_A = 100°C$		1.0 1.0	nA µA
Gate Leakage Current	I_G	$V_{DG} = 10\ V, I_D = 0.7\ mA$ $V_{DG} = 10\ V, I_D = 0.7\ mA, T_A = 100°C$		0.25 25	nA
Saturation Current	I_{DSS}	$V_{DS} = 10\ V, V_{GS} = 0$	1.0	10	mA
Pinch Off Voltage	V_P	$V_{DS} = 10\ V, I_D = 1.0\ nA$		3.0	Volts
Input Conductance	g_{is}	$V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ MHz$		4.0	µmhos
Output Conductance	g_{os}	$V_{DG} = 10\ V, I_D = 0.7\ mA$ $f = 1.0\ MHz$ $V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ kHz$		20 35	µmhos
Input Capacitance	C_{is}	$V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ MHz$		18	pf
Output Capacitance	C_{os}	$V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ MHz$		6.0	pf
Noise Figure	NF	$V_{DS} = 10\ V, R_G = 1.0\ M\Omega$ $f = 1.0\ kHz$		2.0	db
Transconductance	g_m	$V_{DS} = 10\ V, V_{GS} = 0$ $f = 1.0\ kHz$ $V_{DG} = 10\ V, I_D = 0.7\ mA$ $f = 1.0\ kHz$	1500 1500	7500	µmhos
Transconductance Ratio	g_{m1}/g_{m2}	$V_{DG} = 10\ V, I_D = 0.7\ mA$	0.95	1.0	
Gate-Source Voltage Differential 2N3921, 22 2N4084, 85	V_{GS1}-V_{GS2}	$V_{DG} = 10\ V, I_D = 0.7\ mA$		5.0 15	mV
Gate-Source Voltage Differential Drift 2N3921 & 2N4084 2N3922 & 2N4085	$\Delta \mid V_{GS1}$-$V_{GS2} \mid / \Delta T$	$V_{DG} = 10\ V, I_D = 0.7\ mA$ $T_A = 0°C$ to $100°C$		10 25	µV/°C

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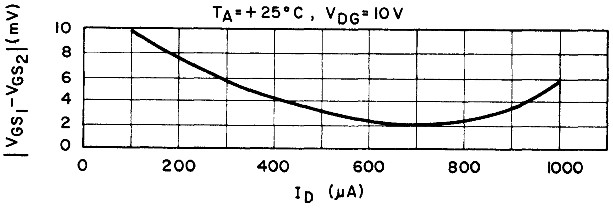
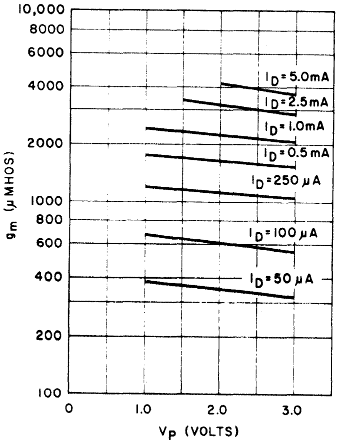
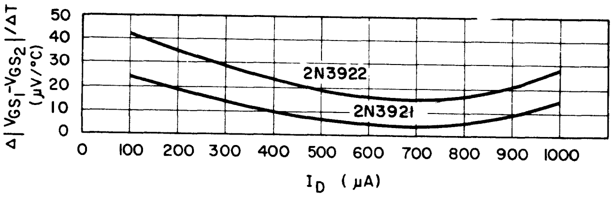
GATE TO SOURCE
VOLTAGE DIFFERENTIAL
VS
DRAIN CURRENT



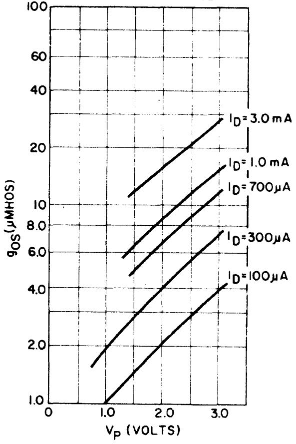
TRANSCONDUCTANCE
VS
PINCH OFF VOLTAGE



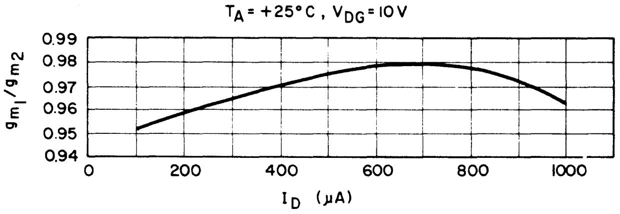
GATE TO SOURCE
VOLTAGE DIFFERENTIAL DRIFT
VS
DRAIN CURRENT



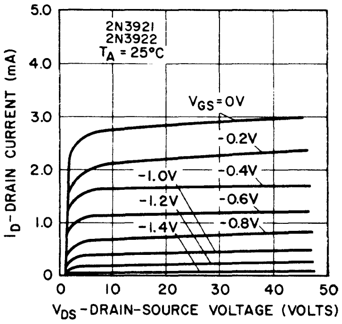
OUTPUT CONDUCTANCE
VS
PINCH OFF VOLTAGE



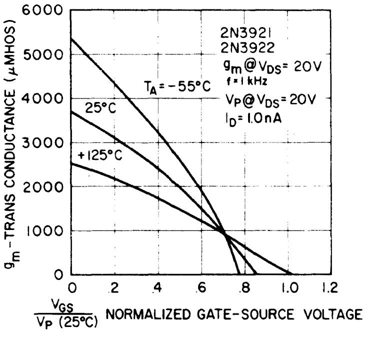
TRANSCONDUCTANCE RATIO
VS
DRAIN CURRENT



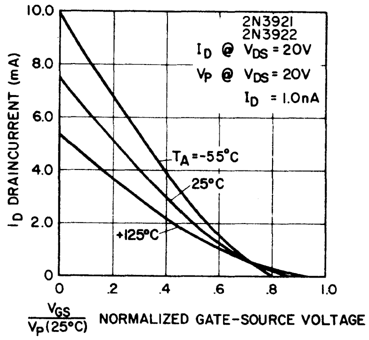
COMMON SOURCE-
DRAIN CHARACTERISTICS



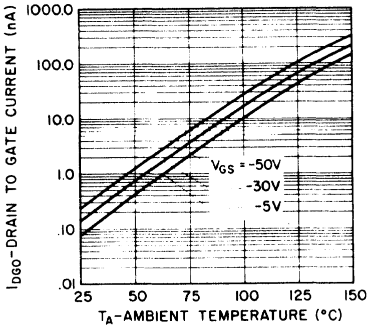
TRANSCONDUCTANCE
VS
NORMALIZED GATE-SOURCE
VOLTAGE



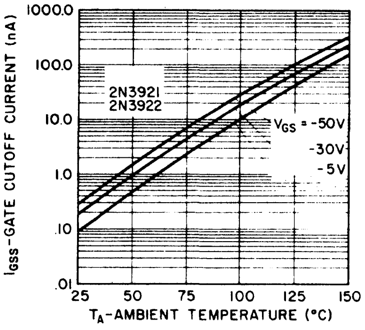
DRAIN CURRENT
VS
NORMALIZED GATE-SOURCE
VOLTAGE



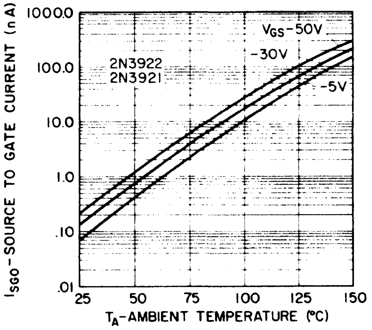
DRAIN-GATE
REVERSE CURRENT
VS
TEMPERATURE



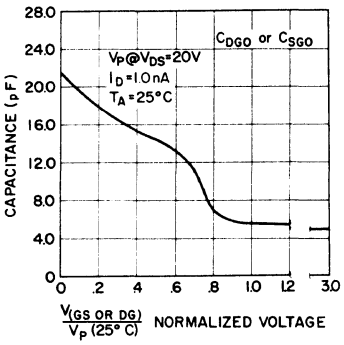
GATE CUTOFF CURRENT
VS
TEMPERATURE



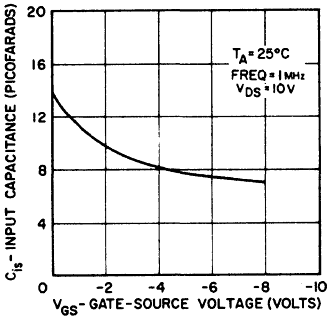
SOURCE-GATE
REVERSE CURRENT
VS
TEMPERATURE



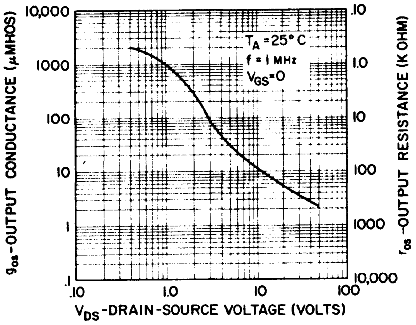
JUNCTION CAPACITY
VS
NORMALIZED BIAS



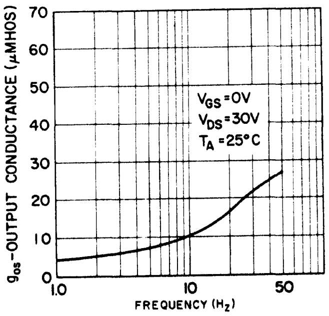
Input Capacitance
vs
Source-Gate Voltage



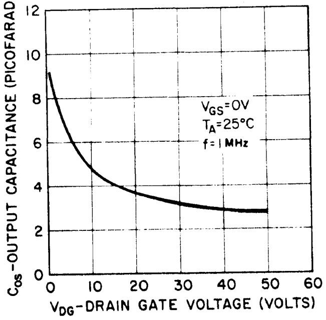
OUTPUT CAPACITY
VS
DRAIN-SOURCE VOLTAGE



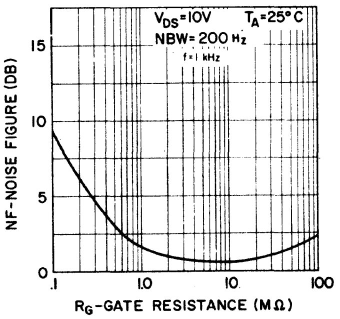
OUTPUT CONDUCTANCE
VS
FREQUENCY



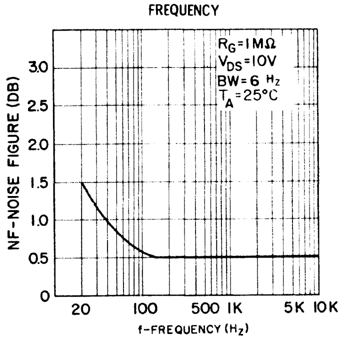
Output Capacitance
vs
Drain-Source Voltage



NOISE FIGURE
VS
GATE RESISTANCE



NOISE FIGURE
VS
FREQUENCY



DUAL N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

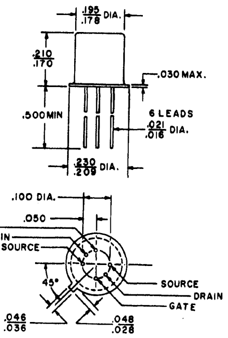
- VERY CLOSELY MATCHED gm
- LOW DIFFERENTIAL DRIFT
- LOW LEAKAGE

JANUARY 1968

2N3934
2N3935
2N4082
2N4083

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		One Side	Both Sides	
Total Device Dissipation @ $T_A = 25°C$	P_D	300	250	mW
Derating Factor Above 25°C @ $T_A = 25°C$		1.7		mW/°C
Storage Temperature	T_{stg}	−55 to +200		°C
Junction Temperature	T_J	+200		°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain-Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A$, $I_S = 0$	50		Volts
Gate-Source Voltage	V_{GS}	$V_{DS} = 10$ V, $I_D = 25\ \mu A$	0.2	2.7	Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = 10$ V, $V_{DS} = 0$ $V_{GS} = 10$ V, $V_{DS} = 0$, $T_A = 100°C$		0.4 0.4	nA μA
Gate Leakage Current	I_G	$V_{DG} = 10$ V, $I_D = 0.2$ mA $V_{DG} = 10$ V, $I_D = 0.2$ mA, $T_A = 100°C$		0.1 10	nA nA
Saturation Current	I_{DSS}	$V_{DS} = 10$ V, $V_{GS} = 0$	0.25	1.3	mA
Pinch Off Voltage	V_P	$V_{DS} = 10$ V, $I_D = 0.5$ nA		3.0	Volts
Transconductance	g_m	$V_{DG} = 10$ V, $I_D = 0.2$ mA, f = 1.0 kHz $V_{DS} = 10$ V, $V_{GS} = 0$, f = 1.0 kHz	300 300	 900	μmhos
Input Conductance	g_{is}	$V_{DS} = 10$ V, $V_{GS} = 0$, f = 1.0 MHz		1.0	μmhos
Output Conductance	g_{os}	$V_{DS} = 10$ V, $V_{GS} = 0$, f = 1.0 kHz $V_{DG} = 10$ V, $I_D = 0.2$ mA, f = 1.0 MHz		10 5.0	μmhos
Input Capacitance	C_{is}	$V_{DS} = 10$ V, $V_{GS} = 0$, f = 1.0 MHz		7.0	pf
Output Capacitance	C_{os}	$V_{DS} = 10$ V, $V_{GS} = 0$, f = 1.0 MHz		2.2	pf
Noise Figure	NF	$V_{DS} = 10$ V, $R_G = 1.0\ M\Omega$, f = 100 Hz		2.0	db
Transconductance Ratio	g_{m1}/g_{m2}*	$V_{DG} = 10$ V, $I_D = 0.2$ mA	0.95	1.0	
Gate-Source Voltage Differential 2N3934, 2N3935 2N4082, 2N4083	$V_{GS1}\text{-}V_{GS2}$	$V_{DG} = 10$ V, $I_D = 0.2$ mA		 5.0 15	mV
Gate-Source Voltage Differential Drift 2N4082, 2N3934 2N4083, 2N3935	$\Delta \mid V_{GS1}\text{-}V_{GS2} \mid / \Delta T$	$V_{DG} = 10$ V, $I_D = 0.2$ mA $T_A = 0°C$ to $100°C$		 10 25	μV/°C

* The lowest g_m reading is g_{m1} for this ratio.

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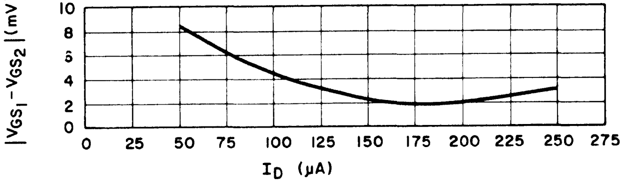
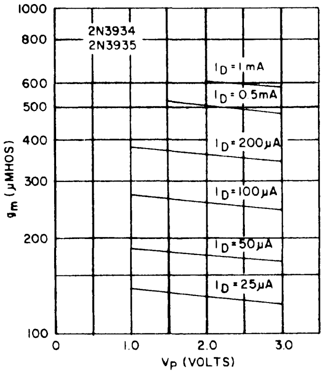
GATE TO SOURCE
VOLTAGE DIFFERENTIAL
VS
DRAIN CURRENT

$T_A = +25°C$, $V_{DG} = 10V$

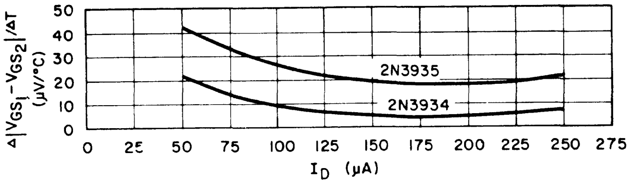


TRANSCONDUCTANCE
VS
PINCH OFF VOLTAGE

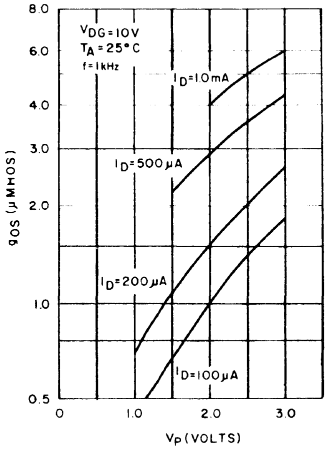


GATE TO SOURCE
VOLTAGE DIFFERENTIAL DRIFT
VS
DRAIN CURRENT

$T_A = 0$ to $+100°C$, $V_{DG} = 10V$

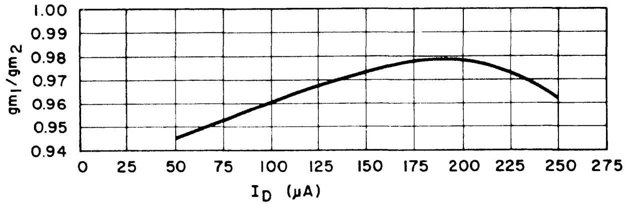


OUTPUT CONDUCTANCE
VS
PINCH OFF VOLTAGE

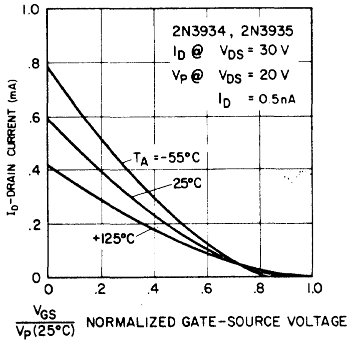


TRANSCONDUCTANCE RATIO
VS
DRAIN CURRENT

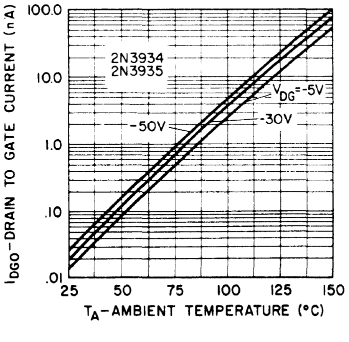
$T_A = +25°C$ $V_{DG} = 10V$



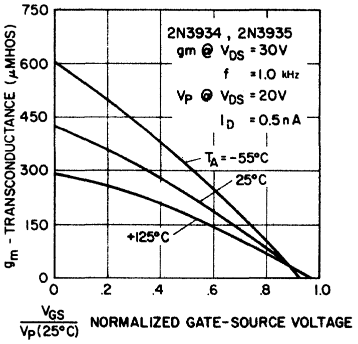
DRAIN CURRENT
VS
NORMALIZED GATE-SOURCE
VOLTAGE



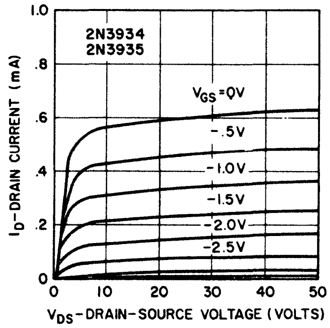
DRAIN-GATE
REVERSE CURRENT
VS
TEMPERATURE



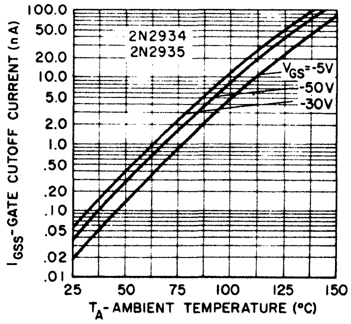
TRANSCONDUCTANCE
VS
NORMALIZED GATE-SOURCE
VOLTAGE



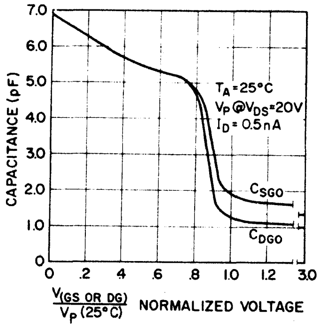
COMMON SOURCE-
DRAIN CHARACTERISTICS



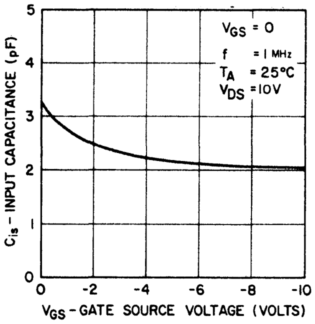
GATE CUTOFF CURRENT
VS
TEMPERATURE



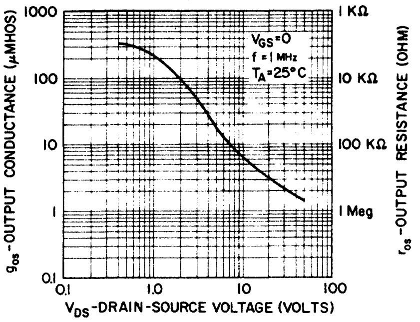
JUNCTION CAPACITY
VS
NORMALIZED BIAS



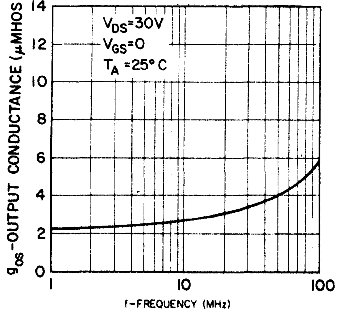
INPUT CAPACITY
VS
SOURCE-GATE VOLTAGE



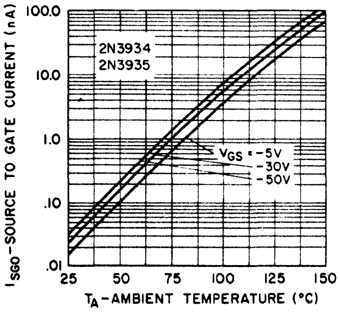
OUTPUT CONDUCTANCE
VS
DRAIN-SOURCE VOLTAGE



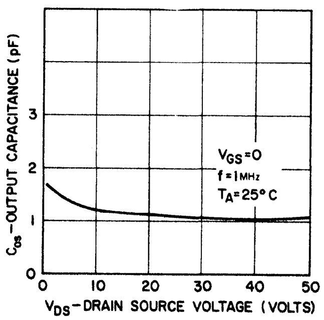
OUTPUT CONDUCTANCE
VS
FREQUENCY



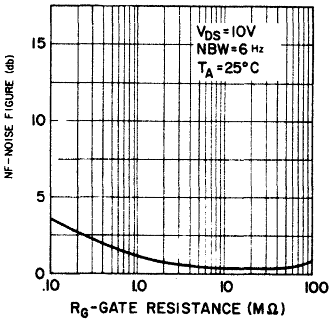
SOURCE-GATE
REVERSE CURRENT
VS
TEMPERATURE



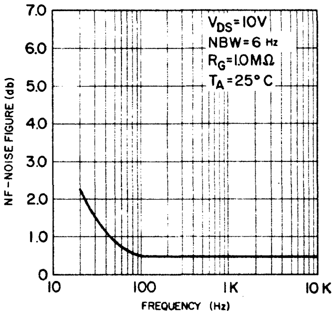
OUTPUT CAPACITY
VS
DRAIN-SOURCE VOLTAGE



NOISE FIGURE
VS
GATE RESISTANCE



NOISE FIGURE
VS
FREQUENCY



DUAL N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

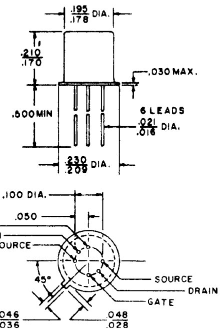
- VERY CLOSELY MATCHED gm
- LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED V_{GS}

JANUARY 1968

SU2098
SU2099

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		Each Side	Both Sides	
Total Device Dissipation	P_D	250	300	mW
Storage Temperature	T_{stg}	−55 to +200		°C
Junction Temperature	T_J	+200		°C
Derating Factor above 25°C @ $T_A = 25°C$		1.7		mW/°C



ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Drain to Gate Breakdown Voltage	BV_{DGO}	$I_D = 1.0\ \mu A$, $I_S = 0$	30		Volts
Pinch off Voltage	V_P	$V_{DS} = 10$ V, $I_D = 0.5$ nA		4.0	Volts
Gate Leakage Current	I_G	$V_{DG} = 10$ V, $I_D = 0.2$ mA		0.1	nA
Gate Leakage Current	I_G(100°C)	$V_{DG} = 10$ V, $I_D = 0.2$ mA		10	nA
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -10$ V, $V_{DS} = 0$ $V_{GS} = -10$ V, $V_{DS} = 0$, $T_A = 100°C$		0.4 0.4	nA μA
Saturation Current	I_{DSS}	$V_{DS} = 10V$, $V_{GS} = 0$	1.0	8.0	mA
Transconductance	g_m	$V_{DS} = 10V$, $V_{GS} = 0$ f = 1 kHz	1000		μmhos
Transconductance	g_m	$V_{DG} = 10$ V, $I_D = 0.2$ mA f = 1 kHz	700		μmhos
Transconductance Ratio	g_{m1}/g_{m2}*	$V_{DG} = 10$ V, $I_D = 0.2$ mA	0.95	1.0	
Gate to Source Voltage Differential	V_{GS1}-V_{GS2}	$V_{DG} = 10$ V, $I_D = 0.2$ mA		5.0	mV
Gate to Source Voltage Differential Drift SU2098 SU2099	$\Delta\lvert V_{GS1}-V_{GS2}\rvert/\Delta T$	$V_{DG} = 10$ V, $I_D = 0.2$ mA $T_A = 0°C$ to 100°C		10 25	μV/°C
Input Capacitance	C_{iss}	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1 MHz		7.0	pf
Output Capacitance	C_{oss}	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1 MHz		2.2	pf
Input Conductance	$\lvert Y_{is}\rvert$	$V_{DS} = 10$ V, $V_{GS} = 0$ f = 1 MHz		4.0	μmhos
Output Conductance	$\lvert Y_{os}\rvert$	$V_{DG} = 10$ V, $I_D = 0$ f = 1 MHz		15	μmhos
Noise Figure	NF	$V_{DS} = 10$ V, $R_G = 1\ M\Omega$ f = 100 Hz		2.0	db

* The lowest g_m reading is taken as g_{m1} for this ratio.

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DUAL N-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

- CLOSELY MATCHED gm
- LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED V_{GS}

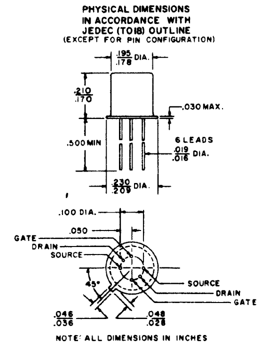
SEPTEMBER 1968

SU2098A
SU2098B
SU2099A

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
		One Side	Both Sides	
Total Device Dissipation @ $T_A = 25°C$ @ $T_C = 25°C$ @ $T_C = 100°C$	P_D	250	300	mW
Derating Factor above 25°C @ $T_A = 25°C$		1.7		mW/°C
Storage Temperature Range	T_{stg}	−55 to +200		°C
Operating Junction Temperature	T_J	+200		°C

PHYSICAL DIMENSIONS IN ACCORDANCE WITH JEDEC (TO18) OUTLINE (EXCEPT FOR PIN CONFIGURATION)



NOTE: ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$	50		Volts
Gate-Source Cutoff Voltage	$V_{GS(OFF)}$	$V_{DS} = 10\ V$, $I_D = 0.5\ nA$	0.5	4.0	Volts
Gate-Source Voltage	V_{GS}	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$	0.5	3.0	Volts
Total Gate Leakage Current	I_{GSS}	$V_{GS} = -10\ V$, $V_{DS} = 0$ $V_{GS} = -10\ V$, $V_{DS} = 0$, $T_A = +100°C$		0.1 10	nA
Gate Leakage Current	I_G	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$ $V_{DG} = 10\ V$, $I_D = 0.2\ mA$, $T_A = +100°C$		0.05 5.0	nA
Gate Leakage Current Differential	$I_{G1}-I_{G2}$	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$ $V_{DG} = 10\ V$, $I_D = 0.2\ mA$, $T_A = +100°C$		0.03 3.0	nA
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 10\ V$, $V_{GS} = 0$	1.0	8.0	mA
Transconductance	g_m	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$ $f = 1\ kHz$	700		μmhos
Transconductance	g_m	$V_{DG} = 10\ V$, $V_{GS} = 0$, $f = 1\ kHz$	1500	4500	μmhos
Transconductance Ratio	g_{m1}/g_{m2}	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$	0.95	1.0	
Gate-Source Voltage Differential	$V_{GS1}-V_{GS2}$	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$		5.0	mV
Gate-Source Voltage Differential Drift SU2098A SU2099A SU2098B	$\Delta\|V_{GS1}-V_{GS2}\|/\Delta T$	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$ $T_A = 0°C$ to $+100°C$		10 25 5.0	μV/°C
Input Capacitance	C_{iss}	$V_{DS} = 10\ V$, $V_{GS} = 0$, $f = 1\ MHz$		6.0	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = 10\ V$, $V_{GS} = 0$, $f = 1\ MHz$		2.0	pf
Input Conductance	g_{is}	$V_{DS} = 10\ V$, $V_{GS} = 0$, $f = 1\ MHz$		4.0	μmhos
Output Conductance	g_{os}	$V_{DG} = 10\ V$, $I_D = 0$, $f = 1\ kHz$		15	μmhos
Output Conductance Differential	$g_{os1} - g_{os2}$	$V_{DG} = 10\ V$, $I_D = 0.2\ mA$ $f = 1\ kHz$		2.0	μmhos
Noise Figure	NF	$V_{DS} = 10\ V$, $R_G = 1\ M\Omega$ $f = 100\ Hz$, $BW = 6\ Hz$		1.0	db
Equivalent Input Noise Voltage	En	$V_{DS} = 10\ V$, $V_{GS} = 0$ $f = 1\ kHz$		20	$nv/\sqrt{Hz}$

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Printed in U.S.A.

MAY 1969

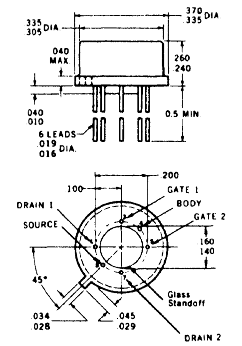
DUAL P-CHANNEL MOS FIELD EFFECT TRANSISTORS

- **ZERO OFFSET VOLTAGE**
- **HIGH FORWARD TRANSADMITTANCE**
- **LOW LEAKAGE**

2N4066
2N4067

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Storage Temperature	T_{stg}	−65 to +200	°C
Operating Junction Temperature	T_J	−65 to +175	°C
Total Dissipation @ $T_C = 25°C$ @ $T_A = 25°C$	P_D	 1.7 0.6	Watts



BODY IS ELECTRICALLY CONNECTED TO CASE

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source Breakdown Voltage 2N4066, 2N4067	BV_{DSS}	$I_D = 10\ \mu A$, $V_{GS} = 0$	−30	−40		Volts
Source to Drain Breakdown Voltage 2N4066, 2N4067	$BV_{SDS}{}^*$	$I_S = 10\ \mu A$, $V_{GD} = 0$, $V_{BD} = 0$	−30	−40		Volts
Zero-Gate Voltage Drain Current 2N4066, 2N4067	I_{DSS}	$V_{DS} = -15$ V, $V_{GS} = 0$		0.06	1.0	nA
Zero-Gate Voltage Source Current 2N4066, 2N4067	$I_{SDS}{}^*$	$V_{SD} = -15$ V, $V_{GD} = 0$, $V_{BD} = 0$		0.07	1.0	nA
Gate Forward Leakage Current 2N4066, 2N4067	$I_{G(F)}$	$V_{GS} = -25$ V, $V_{DS} = 0$		0.5	2.5	.pA
Gate-Source Threshold Voltage 2N4066, 2N4067	V_T	$V_{DS} = -15$ V, $I_D = 10\ \mu A$	−3.0	−4.0	−6.0	Volts
"ON" Drain Current 2N4066, 2N4067	$I_{D(on)}$	$V_{DS} = -15$ V, $V_{GS} = -15$ V	10	32	50	mA
Drain Source "ON" Resistance (Single) 2N4066 2N4067	$r_{ds(on)}$	$V_{GS} = -15$ V, $I_D = 0$ f = 1.0 kHz		300 125	500 250	Ohms
Drain Source "ON" Resistance (Paralleled) 2N4066 2N4067	$r_{ds(on)}$	$V_{GS} = -15$ V, $I_D = 0$ f = 1.0 kHz		150 75	250 125	Ohms
Forward Transadmittance (Single) 2N4066 2N4067	Y_{fs}	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 kHz	1500 2500	2900 4200		μmhos
Forward Transadmittance (Paralleled) 2N4066 2N4067	Y_{fs}	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 kHz	3000 5000	5800 8400		μmhos

*Body (substrate) connected to Drain.
Body (substrate) connected to Source for all other parameters.

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4501

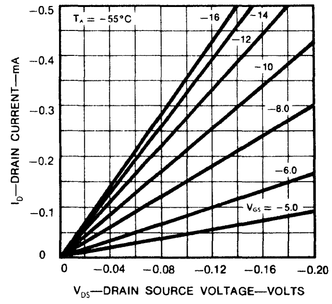
ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Transadmittance 2N4066 2N4067	Y_{fs}(100°C)	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 kHz	 1000 1750	 2600 3900		μmhos
Output Admittance 2N4066, 2N4067	Y_{os}	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 kHz		260	300	μmhos
Input Capacitance (Single) 2N4066, 2N4067	C_{iss}	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 MHz		4.0	7.0	pF
Input Capacitance (Paralleled) 2N4066, 2N4067	C_{iss}	$V_{DS} = -15$ V, $V_{GS} = -15$ V f = 1.0 MHz		8.0	14	pF
Reverse Transfer Capacitance (Single) 2N4066, 2N4067	C_{rss}	$V_{DS} = 0$, $V_{GS} = 0$ f = 1.0 MHz		0.6	1.5	pF
Reverse Transfer Capacitance (Paralleled) 2N4066, 2N4067	C_{rss}	$V_{DS} = 0$, $V_{GS} = 0$ f = 1.0 MHz		1.2	3.0	pF
Zero-Gate Voltage Drain Current 2N4066, 2N4067	I_{DSS}(150°C)	$V_{DS} = -15$ V, $V_{GS} = 0$		0.3	2.0	μA
Zero-Gate Voltage Source Current 2N4066, 2N4067	I_{SDS}(150°C)	$V_{SD} = -15$ V, $V_{GD} = 0$, $V_{BD} = 0$		0.5	2.0	μA
Source to Body Capacity 2N4066, 2N4067	C_{sb}	$V_{DB} = -15$ V, $V_{GS} = 0$, $I_S = 0$ f = 1.0 MHz		4.2	5.0	pF
Drain to Body Capacity 2N4066, 2N4067	C_{db}	$V_{DB} = -15$ V, $V_{GS} = 0$, $I_S = 0$ f = 1.0 MHz		4.2	5.0	pF
Delay Time 2N4066, 2N4067	t_d	$V_{DD} = -15$ V, $I_{D(on)} = 10$ mA $V_{GS(on)} = -15$ V, $R_L = R_G = 1.4$ KΩ		8.0	20	ns
Rise Time 2N4066, 2N4067	t_r	$V_{DD} = -15$ V, $I_{D(on)} = 10$ mA $V_{GS(on)} = -15$ V, $R_L = R_G = 1.4$ KΩ		14	30	ns
Turn Off Time 2N4066, 2N4067	t_{off}	$V_{DD} = -15$ V, $I_{D(on)} = 10$ mA $V_{GS(on)} = -15$ V, $R_L = R_G = 1.4$ KΩ		30	50	ns

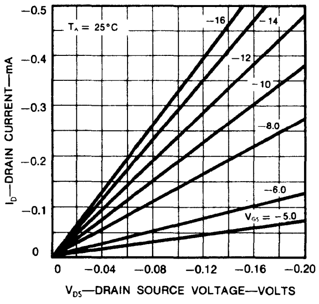
TYPICAL ELECTRICAL CHARACTERISTICS

2N4066

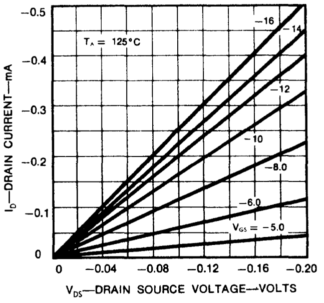
LOW VOLTAGE DRAIN CHARACTERISTICS



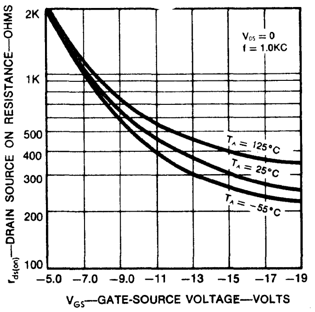
LOW VOLTAGE DRAIN CHARACTERISTICS



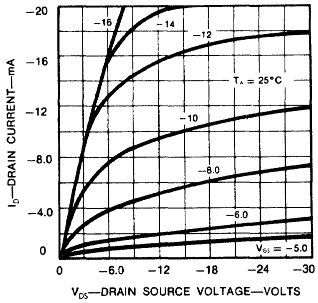
LOW VOLTAGE DRAIN CHARACTERISTICS



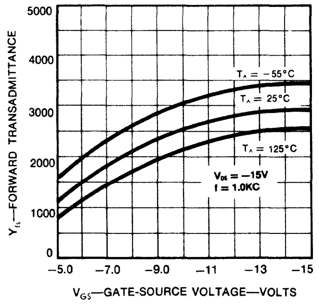
DRAIN-SOURCE ON RESISTANCE VERSUS GATE-SOURCE VOLTAGE



DRAIN CHARACTERISTICS



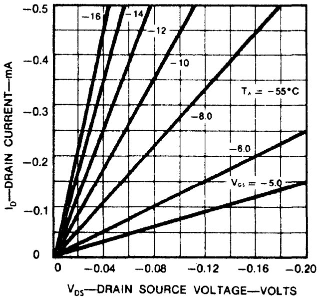
FORWARD TRANSADMITTANCE VERSUS GATE-SOURCE VOLTAGE



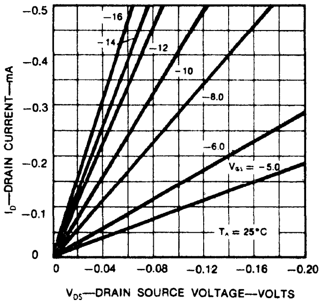
TYPICAL ELECTRICAL CHARACTERISTICS

2N4067

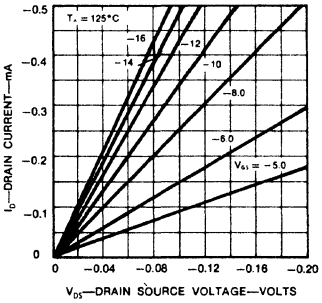
LOW VOLTAGE DRAIN CHARACTERISTICS



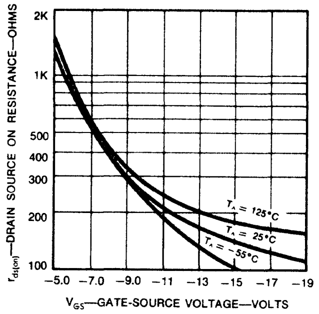
LOW VOLTAGE DRAIN CHARACTERISTICS



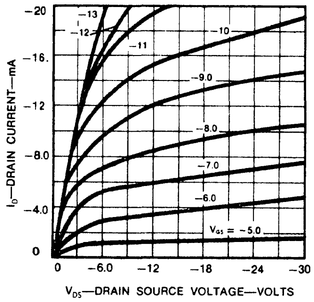
LOW VOLTAGE DRAIN CHARACTERISTICS



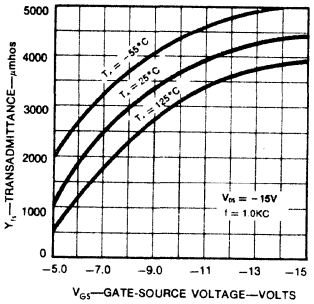
DRAIN-SOURCE ON RESISTANCE VERSUS GATE-SOURCE VOLTAGE



DRAIN CHARACTERISTICS

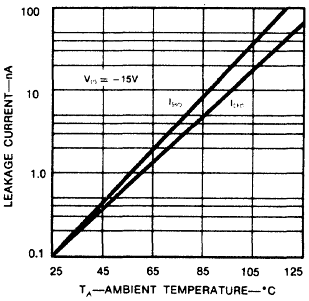


FORWARD TRANSADMITTANCE VERSUS GATE-SOURCE VOLTAGE

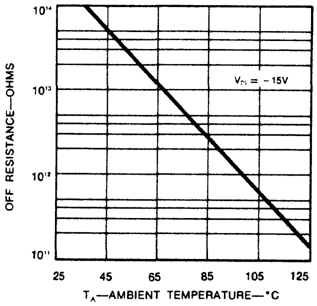


2N4066 • 2N4067

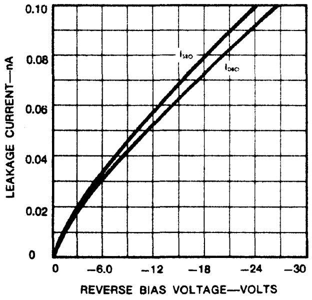
DRAIN-BODY AND SOURCE-BODY LEAKAGE CURRENT VERSUS AMBIENT TEMPERATURE



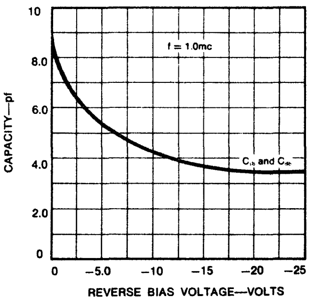
DRAIN SOURCE OFF RESISTANCE VERSUS AMBIENT TEMPERATURE



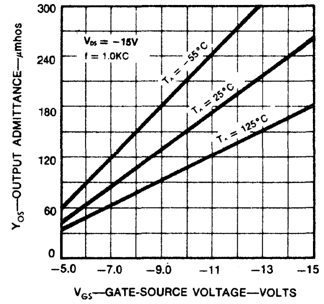
DRAIN-BODY AND SOURCE-BODY LEAKAGE CURRENT VERSUS REVERSE BIAS VOLTAGE



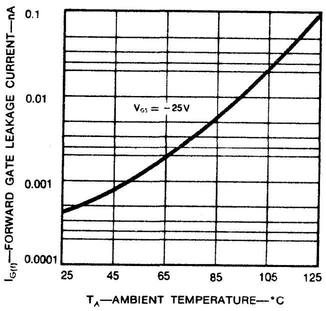
DRAIN-BODY AND SOURCE-BODY CAPACITY VERSUS REVERSE BIAS VOLTAGE



OUTPUT ADMITTANCE VERSUS GATE-SOURCE VOLTAGE

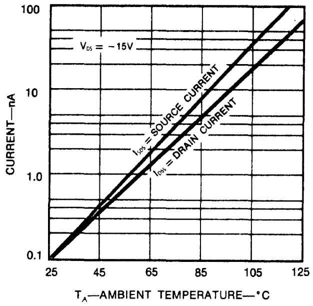


GATE FORWARD LEAKAGE CURRENT VERSUS AMBIENT TEMPERATURE

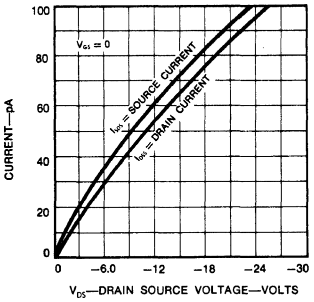


TYPICAL ELECTRICAL CHARACTERISTICS

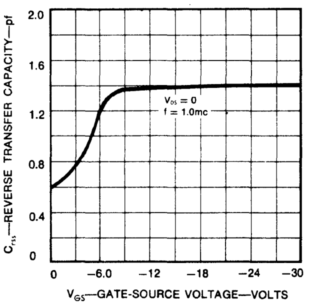
2N4066 • 2N4067



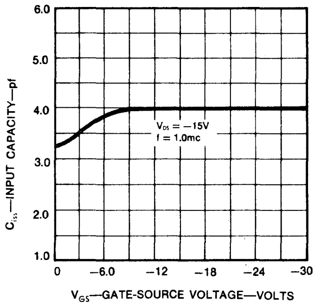
ZERO GATE VOLTAGE SOURCE AND DRAIN CURRENT VERSUS AMBIENT TEMPERATURE



ZERO GATE VOLTAGE DRAIN CURRENT AND SOURCE CURRENT VERSUS DRAIN-SOURCE VOLTAGE

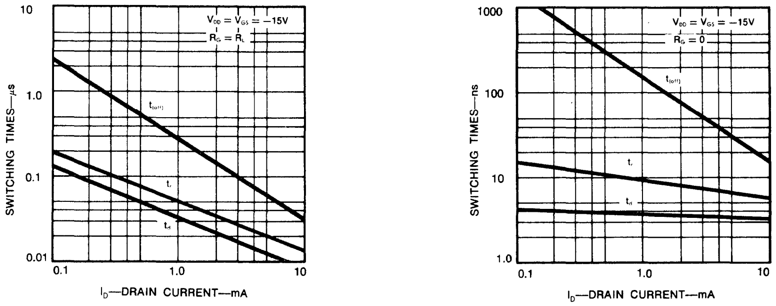


REVERSE TRANSFER CAPACITY VERSUS GATE-SOURCE VOLTAGE

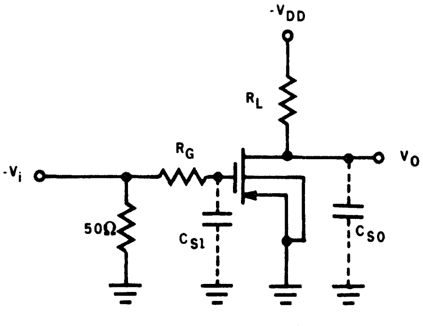


INPUT CAPACITY VERSUS GATE-SOURCE VOLTAGE

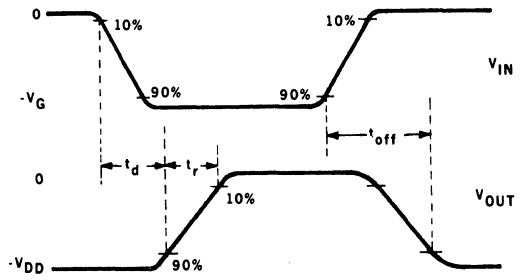
SWITCHING CHARACTERISTICS



SWITCHING TIMES VERSUS DRAIN CURRENT



INPUT STRAY CAPACITY $C_{SI} \leq 2.0pF$
OUTPUT STRAY CAPACITY $C_{SO} \leq 4.0pF$



Storage:	All six leads should be in contact with each other.
Testing:	Grasp the test chassis prior to insertion of the device into any circuit or test equipment. Additional precautions should be taken to ground all soldering iron tips, etc.

MONOLITHIC DUAL P-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

- CLOSELY MATCHED gm
- LOW DIFFERENTIAL DRIFT
- CLOSELY MATCHED V_{GS}

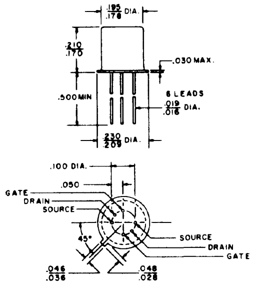
SEPTEMBER 1968

2N5505
THRU
2N5509

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Drain-Gain Voltage	V_{DG}	30		Volts
Reverse Gate-Source Voltage	V_{GS}	30		Volts
Drain-Drain Voltage	V_{DD}	30		Volts
Gate Current	I_G	10		mA
Total Device Dissipation @ $T_A = 25°C$	P_D	One Side 250	Both Sides 300	mWatts
Derating Factor above 25°C @ $T_A = 25°C$		2.0	2.4	mW/°C
Storage Temperature Range	T_{stg}	−55 to +200		°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300		°C

PHYSICAL DIMENSIONS
IN ACCORDANCE WITH
JEDEC (TO18) OUTLINE
(EXCEPT FOR PIN CONFIGURATION)



NOTE: ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage 2N5505-2N5508 2N5509	$V_{GS(OFF)}$	$V_{DS} = -10\ V$, $I_D = -1.0\ nA$	0.5 0.5	4.0 5.0	Volts
Gate-Source Voltage 2N5505-2N5508 2N5509	V_{GS}	$V_{DS} = -10\ V$, $I_D = -100\ \mu A$	0.2 0.2	3.7 4.5	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = 15\ V$, $V_{DS} = 0$ $V_{GS} = 15\ V$, $V_{DS} = 0$, $T_A = 100°C$		0.25 25	nA
Gate Leakage Current	I_G	$V_{DG} = -10\ V$, $I_D = -700\ \mu A$ $V_{DG} = -10\ V$, $I_D = -700\ \mu A$ $T_A = 100°C$		0.20 25	nA
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -10\ V$, $V_{GS} = 0$	−0.8	−7.0	mA
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DS} = -10\ V$, $V_{GS} = 0$ f = 1 kHz	1000	3500	μmhos
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DG} = -10\ V$, $I_D = -700\ \mu A$ f = 1 kHz	1000		μmhos
Output Admittance	$\lvert Y_{os} \rvert$	$V_{DG} = -10\ V$, $I_D = -700 \mu A$ f = 1 kHz		15	μmhos
Output Admittance	$\lvert Y_{os} \rvert$	$V_{DS} = -10\ V$, $V_{GS} = 0$ f = 1 kHz		60	μmhos
Input Capacitance	C_{iss}	$V_{DS} = -10\ V$, $V_{GS} = 0$ f = 0.14 MHz-1 MHz		16	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = -10\ V$, $V_{GS} = 0$ f = 0.14 MHz-1 MHz		6.0	pf
Noise Figure	NF	$V_{DS} = -10\ V$, $R_G = 1\ M\Omega$, $V_{GS} = 0$, f = 1 kHz, BW = 200 Hz		2.0	db

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MATCHING CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Differential Gate-Leakage Current	I_{G1}-I_{G2}	$V_{DG} = -10$ V, $I_D = -700 \mu A$		50	pA
		$V_{DG} = -10$ V, $I_D = -700 \mu A$, $T_A = 100°C$		4	nA
Differential Output Admittance	$\|Y_{os1}\|$-$\|Y_{os2}\|$	$V_{DG} = -10$ V, $I_D = -700 \mu A$ f = 1 kHz		1.5	µmhos
Forward Transadmittance Ratio	$\|Y_{fs1}\|/\|Y_{fs2}\|$*				
DP1001		$V_{DG} = -10$ V, $I_D = -700$ µA	0.95	1.0	
2N5506		f = 1 kHz	0.95	1.0	
2N5507			0.95	1.0	
			0.95	1.0	
DP1005			0.90	1.0	
Gate-Source Voltage Differential	V_{GS1}-V_{GS2}				
DP1001		$V_{DG} = -10$ V, $I_D = -700$ µA		5.0	mV
2N5506				15	
2N5507				5.0	
DP1004				15	
DP1005				25	
Gate-Source Voltage Differential Drift	$\Delta\|V_{GS1}$-$V_{GS2}\|/\Delta T$				
2N5505		$V_{DG} = -10$ V, $I_D = -700$ µA		10	µV/°C
2N5506		$T_A = 0°C$ to $100°C$		10	
2N5507				15	
2N5508				25	
2N5509				50	

* The lowest Y_{fs} reading is taken as Y_{fs1} for this ratio.

MONOLITHIC DUAL P-CHANNEL FIELD EFFECT TRANSISTOR
GENERAL PURPOSE

- **CLOSELY MATCHED gm**
- **LOW DIFFERENTIAL DRIFT**
- **CLOSELY MATCHED V_{GS}**

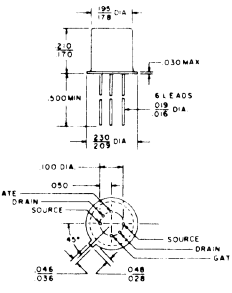
SEPTEMBER 1968

2N5510
THRU
2N5514

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING		UNIT
Drain-Gain Voltage	V_{DG}	30		Volts
Reverse Gate-Source Voltage	V_{GS}	30		Volts
Gate Current	I_G	10		mA
Total Device Dissipation @ $T_A = 25°C$	P_D	One Side 250	Both Sides 300	mW
Derating Factor above 25°C @ $T_A = 25°C$		2.0	2.4	mW/°C
Storage Temperature Range	T_{stg}	−55 to +200		°C
Lead Temperature, 1/16 inch from case, 10 seconds max.		300		°C

PHYSICAL DIMENSIONS
IN ACCORDANCE WITH
JEDEC (TO18) OUTLINE
(EXCEPT FOR PIN CONFIGURATION)



NOTE ALL DIMENSIONS IN INCHES

ELECTRICAL CHARACTERISTICS at +25°C (Unless Otherwise Specified)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNIT
Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A, V_{DS} = 0$	30		Volts
Gate-Source Cutoff Voltage 2N5510-2N5513 2N5514	$V_{GS(OFF)}$	$V_{DS} = -10\ V,\ I_D = -1.0\ nA$	0.5 0.5	4.0 5.0	Volts
Gate-Source Voltage 2N5510-2N5513 2N5514	V_{GS}	$V_{DS} = -10\ V, I_D = -25\ \mu A$	0.2 0.2	3.7 4.5	Volts
Gate Reverse Current	I_{GSS}	$V_{GS} = 15\ V, V_{DS} = 0$ $V_{GS} = 15\ V, V_{DS} = 0, T_A = 100°C$		0.25 25	nA
Gate Leakage Current	I_G	$V_{DG} = -10\ V,\ I_D = -200\ \mu A$ $V_{DG} = -10\ V,\ I_D = -200\ \mu A, T_A = 100°C$		0.20 25	nA
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -10\ V, V_{GS} = 0$	−0.25	−5.0	mA
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DS} = -10\ V, V_{GS} = 0$, f = 1 kHz	500	3000	μmhos
Forward Transadmittance	$\lvert Y_{fs} \rvert$	$V_{DG} = -10\ V, I_D = -200\mu A$, f = 1 kHz	500		μmhos
Output Admittance	$\lvert Y_{os} \rvert$	$V_{DG} = -10\ V,\ I_D = -200\ \mu A$, f = 1 kHz		10	μmhos
Output Admittance	$\lvert Y_{os} \rvert$	$V_{DG} = -10\ V, V_{GS} = 0$, f = 1 kHz		60	μmhos
Input Capacitance	C_{iss}	$V_{DS} = -10\ V, V_{GS} = 0$, f = 0.14 MHz-1 MHz		16	pf
Reverse Transfer Capacitance	C_{rss}	$V_{DS} = -10\ V, V_{GS} = 0$, f = 0.14 MHz-1 MHz		6.0	pf
Noise Figure	NF	$V_{DS} = -10\ V, R_G = 1\ M\Omega$, $V_{GS} = 0$, f = 1 kHz, BW = 200 Hz		2.0	db

JANUARY 1968

DIGITAL CIRCUIT
HIGH NOISE IMMUNITY LOGIC

300
SERIES

High Noise Immunity Logic (HNIL) is ideally suited for applications requiring maximum noise immunity and excellent line driving capability. A sixteen pin package and complex logic functions result in a minimum number of packages per system. Buffered outputs on all elements and 12 volt logic swings eliminate the necessity for interface circuitry in most applications. This logic family is also available for 15 volt operation. Designation for −55 to +125°C 15 volt unit is M and for −30 to +85°C is A.

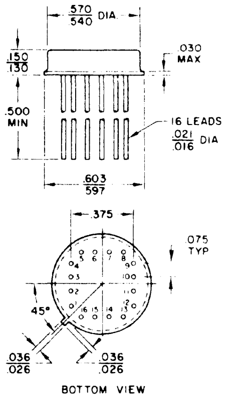
DUAL 5 INPUT BUFFER
QUAD 2 INPUT "OR" ABLE BUFFER
QUAD 2 INPUT GATE
QUAD 2 INPUT "OR" ABLE GATE
DUAL 5 INPUT GATE
DUAL 5 INPUT EXPANDER
DUAL EXCLUSIVE-OR
DUAL 2 DUAL 3 INPUT GATE
BCD TO DECADE DECODER
RST FLIP-FLOP
DUAL JK FLIP-FLOP
QUAD "D" FLIP-FLOP
DUAL ONE SHOT
DUAL INPUT INTERFACE
DUAL OUTPUT INTERFACE
DECADE COUNTER
QUAD RIPPLE COUNTER

ABSOLUTE MAXIMUM RATINGS*

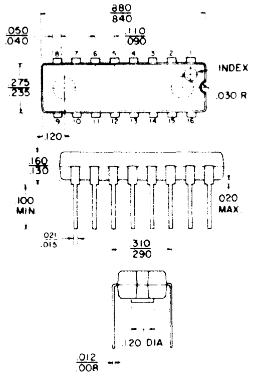
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	
300 B	−55°C to +125°C
300 C	−30°C to +85°C
Lead Temperature, 1/16 inch from case, 10 seconds maximum	300°C
Supply Voltage - Continuous	+15 Volts
Supply Voltage - Continuous	+10.5 Volts min.
Supply Voltage - Pulsed < 0.1 second	+18 Volts
Input Voltage - (exclusive of expanders)	−0.5 V to +15 Volts
Input Voltage - expanders	0 V to +6.0 Volts
Input Voltage, (RTL inputs, 362)	5.0 Volts
Voltage applied to output	−0.5 V to +13.0 Volts
Sink Current at $T_A = 25°C$, continuous	
301 & 302	80 mA
All other types	15 mA
Surge Sink Current at $T_A = 25°C$, <1 sec.	
301 & 302	100 mA
All other types	20 mA
Output Short Circuit Duration to GND	Continuous
Input Current, (RTL inputs, 362)	10 mA

*Exceeding Ratings May Cause Permanent Damage.

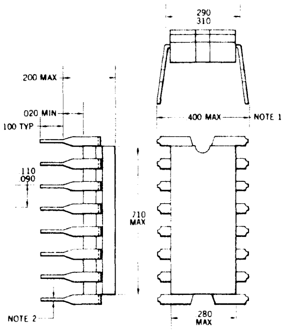
E PACKAGE



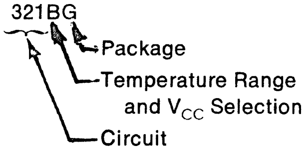
J PACKAGE



N PACKAGE



Complete part number designation consists of three digits and two letters, for example:



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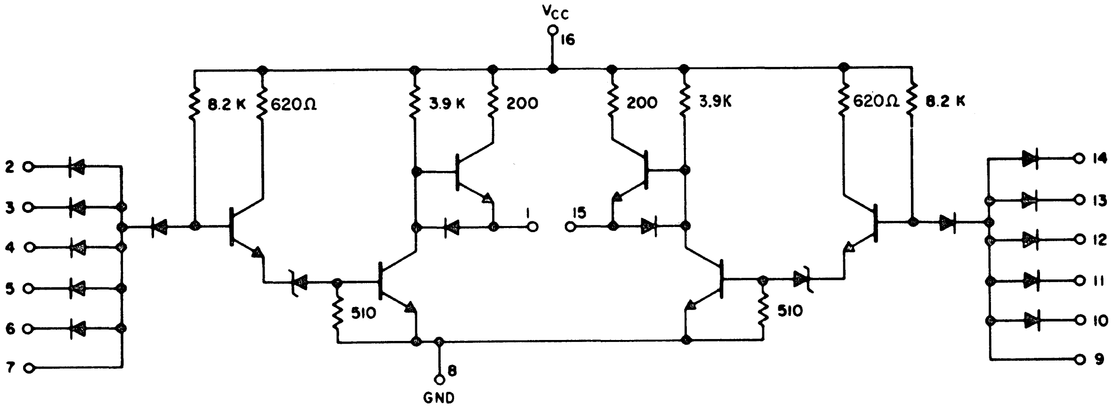
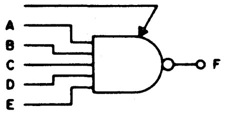
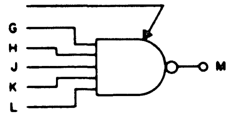
DUAL 5 INPUT BUFFER

HIGH FAN-OUT
60 mA CAPABILITY

301







$F = \overline{A \cdot B \cdot C \cdot D \cdot E}$

$M = \overline{G \cdot H \cdot J \cdot K \cdot L}$

LIMITS	301 B			301 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL1}	1.6	1.5	1.5	2.0	1.8	1.8	Volts max.
V_{OL} @ I_{OL1}		1.2			1.2		Volts typ.
V_{OL} @ I_{OL2}				1.6	1.5	1.5	Volts max.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (2−1+)	80	100	180	90	100	160	nsec typ.
T_{PD} (2+1−)	70	80	90	75	80	90	nsec typ.
I_{PS} (inputs open)		30			30		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
I_{OL1}	68	60	54	68	60	58	mA
I_{OL2}				45	40	38	mA
I_{OH}	−15	−15	−15	−15	−15	−15	mA

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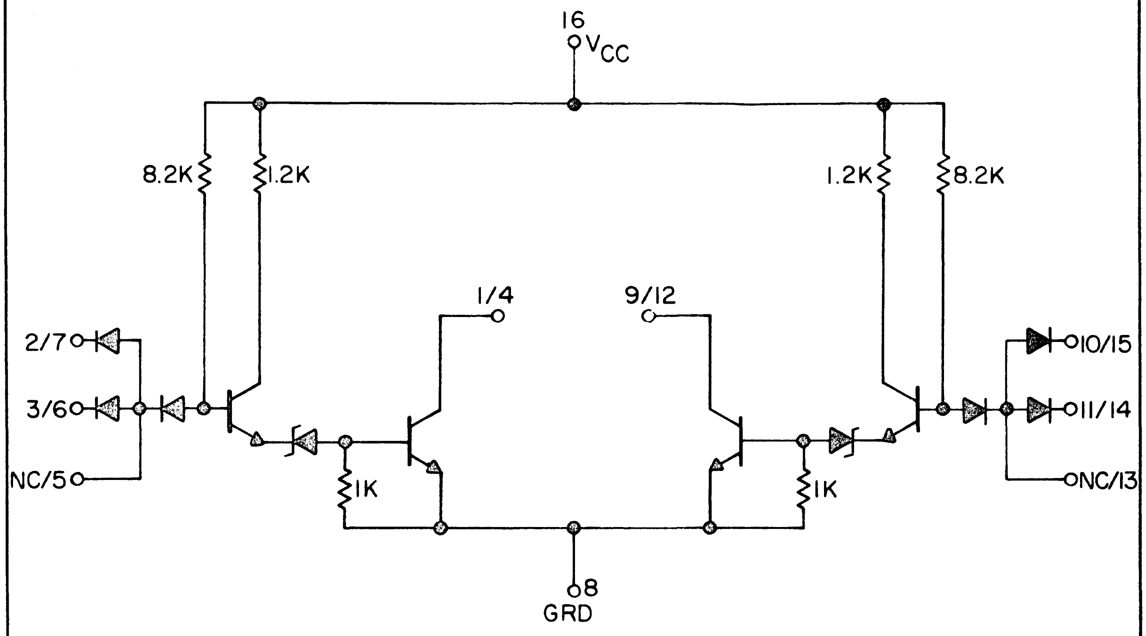
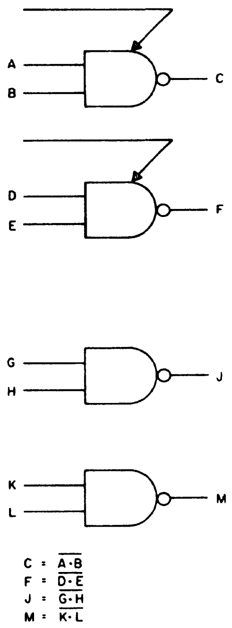
QUAD 2 INPUT BUFFER

COLLECTOR - "OR" ABLE
HIGH FAN-OUT
60 mA CAPABILITY

302





LIMITS	302 B			302 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL1}	1.2	1.2	1.2	1.2	1.2	1.2	Volts max.
V_{OL} @ I_{OL1}		0.8			0.8		Volts typ.
V_{OL} @ I_{OL2}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL2}		0.3			0.3		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{CEX}	1.0	1.0	100	1.0	1.0	100	μA max.
I_{CEX}		0.05			0.05		μA typ.
I_{PS} (inputs open)		30			30		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL1}	68	60	54	68	60	58	mA
I_{OL2}	34	30	27	34	30	29	mA

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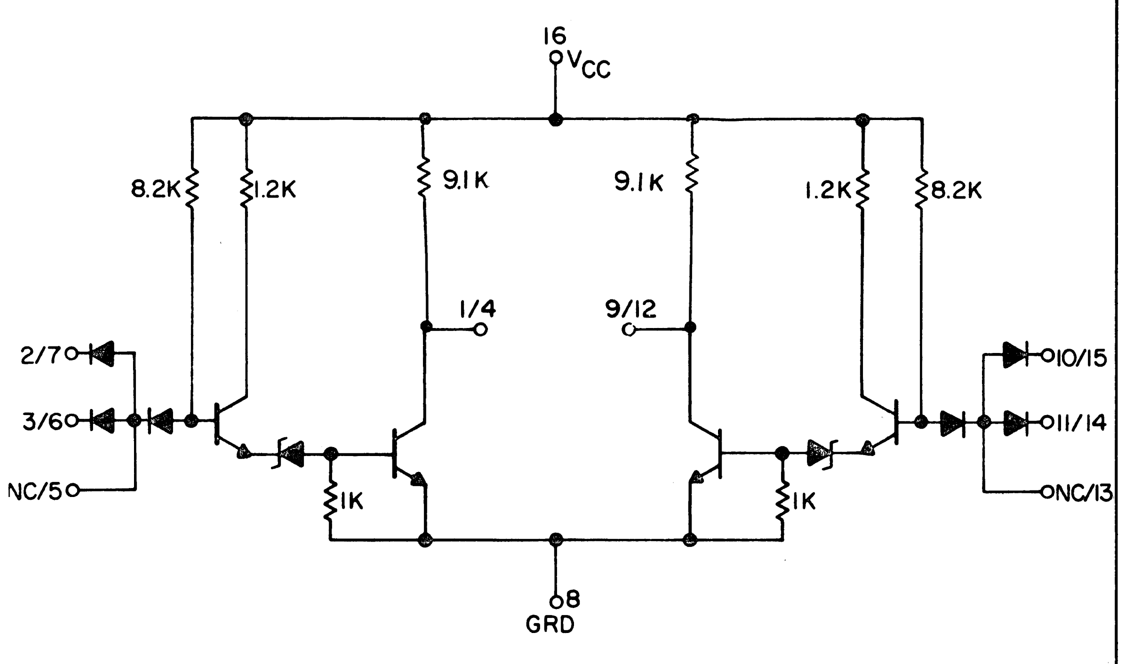
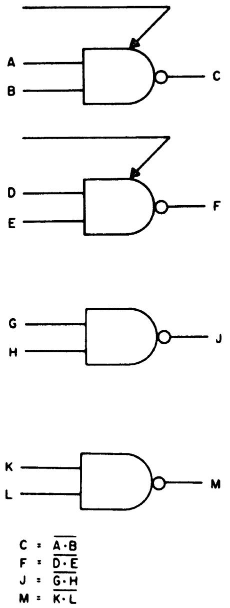
JANUARY 1969

QUAD 2 INPUT BUFFER

COLLECTOR - "OR" ABLE
HIGH FAN-OUT
60 mA CAPABILITY

303





C = $\overline{A \cdot B}$
F = $\overline{D \cdot E}$
J = $\overline{G \cdot H}$
M = $\overline{K \cdot L}$

LIMITS	303B			303C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL1}	1.2	1.2	1.2	1.2	1.2	1.2	Volts max.
V_{OL} @ I_{OL1}		0.8			0.8		Volts typ.
V_{OL} @ I_{OL2}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL2}		0.3			0.3		Volts typ.
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{PS} (inputs open)		30			30		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL1}	68	60	54	68	60	58	mA
I_{OL2}	34	30	27	34	30	29	mA
I_{OH}	−300	−300	−300	−300	−300	−300	μA

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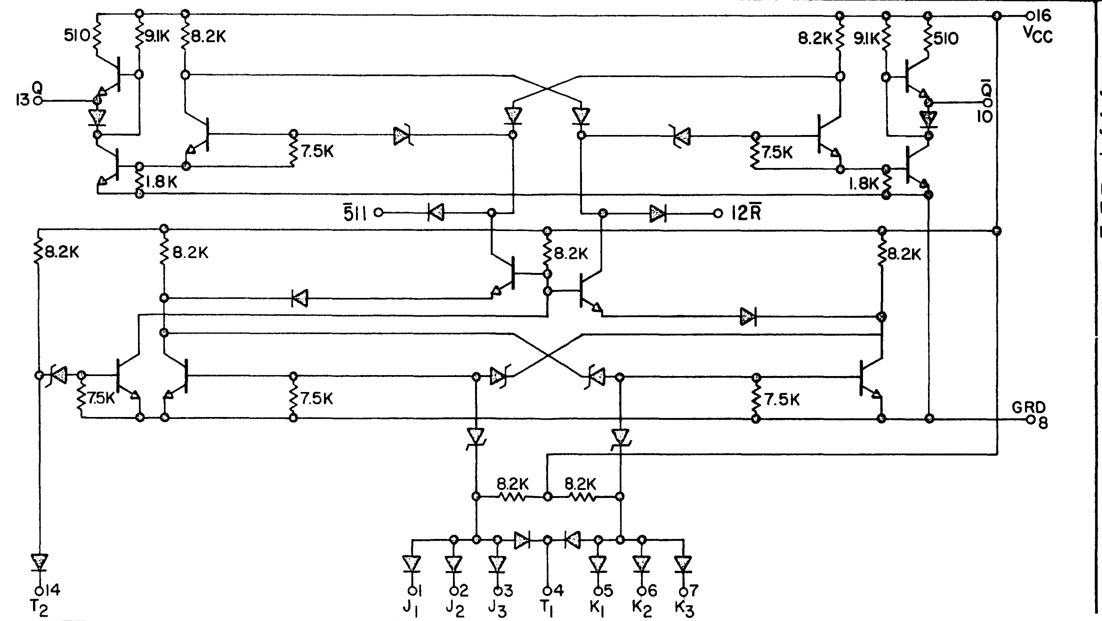
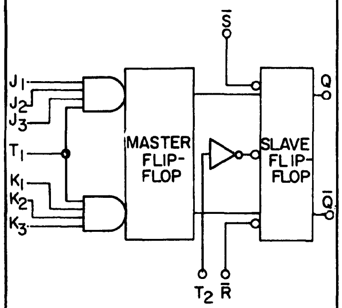
JANUARY 1968

MASTER SLAVE FLIP-FLOP

311





TRUTH TABLE
$J = J_1 = J_2$ $K = K_1 = K_2$
$J_3 = \bar{Q}$ $K_3 = Q$

J	K	Q^{n+1}
L	L	Q^n
L	H	L
H	L	H
H	H	$\bar{Q}^n$

TRUTH TABLE
$J = J_1 = J_2 = J_3$
$K = K_1 = K_2 = K_3$

J	K	Q^{n+1}
L	L	Q^n
L	H	L
H	L	H
H	H	?

FOR SINGLE PHASE OPERATION CONNECT T_1 TO T_2

LIMITS	311 B			311 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_{IL} (pin 4)	−3.8	−3.4	−3.0	−3.8	−3.4	−3.2	mA max.
I_{IL} (pin 4)		−2.4			−2.4		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} ($\bar{R}-\bar{Q}+$)	70	90	160	70	90	130	nsec typ.
T_{PD} ($t-\bar{Q}+$)	120	190	270	140	190	255	nsec typ.
T_{PD} ($\bar{S}-\bar{Q}-$)	90	90	110	90	90	100	nsec typ.
T_{PD} ($t+\bar{Q}-$)	100	160	240	120	160	210	nsec typ.
Toggle		2.0			2.0		MHz min.
I_{PS} (inputs open)		15			15		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA
V_{IH} ($\bar{S}$ & $\bar{R}$)	7.0	7.0	7.0	7.0	7.0	7.0	Volts

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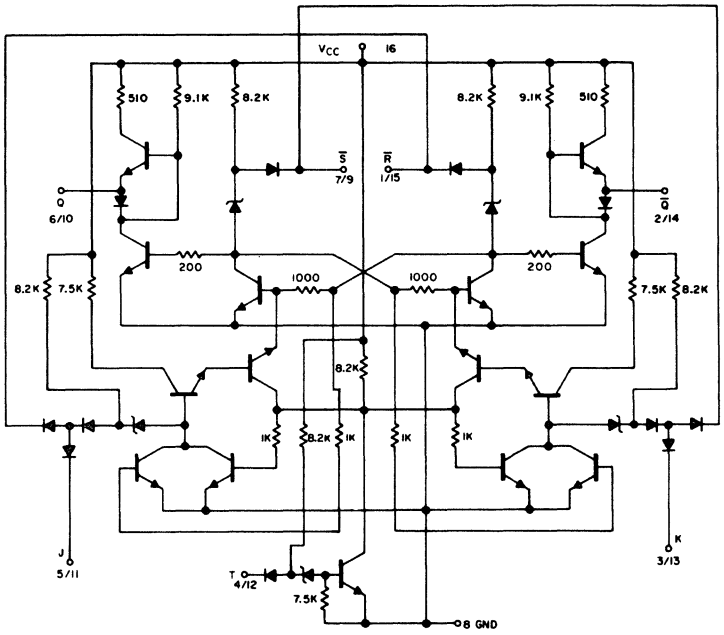
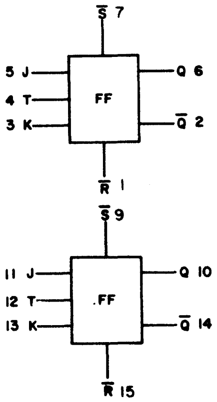
DUAL JK FLIP-FLOP

312





TRUTH TABLE

CLOCKED

J	K	Q^{n+1}
L	L	Q^n
L	H	L
H	L	H
H	H	$\overline{Q^n}$

SET-RESET

$\overline{S}$	$\overline{R}$	Q
H	H	?
H	L	L
L	H	H
L	L	H

LIMITS	312 B			312 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_{IL} (1, 7, 9, 15)	−3.8	−3.4	−3.0	−3.8	−3.4	−3.2	mA max.
I_{IL} (1, 7, 9, 15)		−2.4			−2.4		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (t−$\overline{Q}$−)		80			80		nsec typ.
T_{PD} (t−$\overline{Q}$+)		70			70		nsec typ.
T_{PD} ($\overline{R}$−$\overline{Q}$+)		30			30		nsec typ.
T_{PD} ($\overline{S}$−$\overline{Q}$−)		35			35		nsec typ.
I_{PS} (inputs open)		24			24		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

* NOTE: Fall time of clock should be 3 volts per microsecond or faster.

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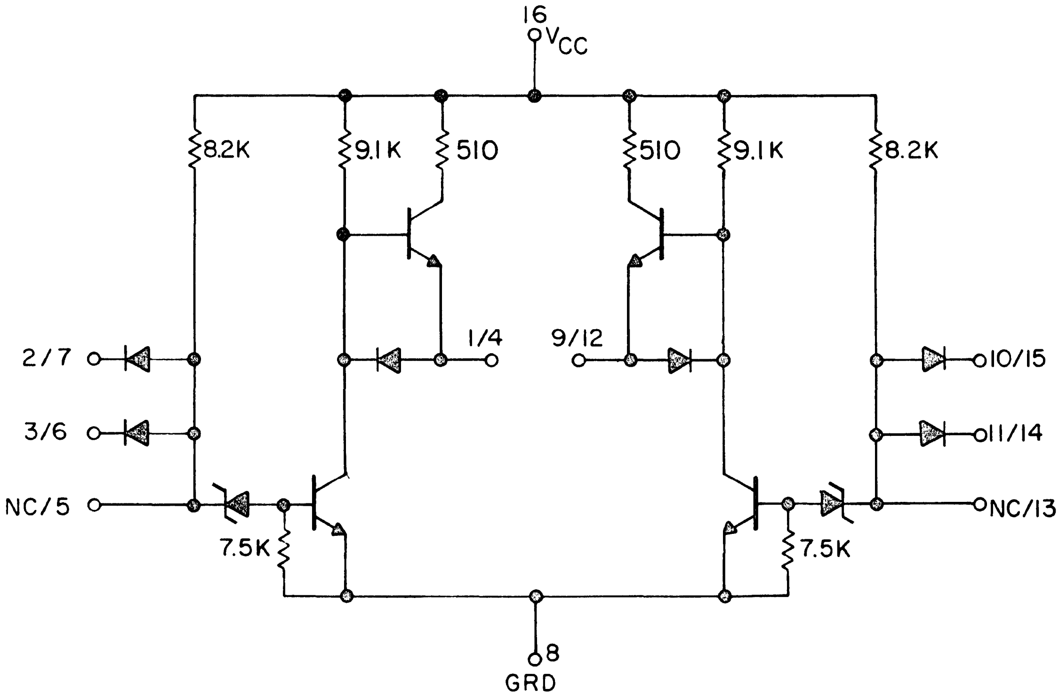
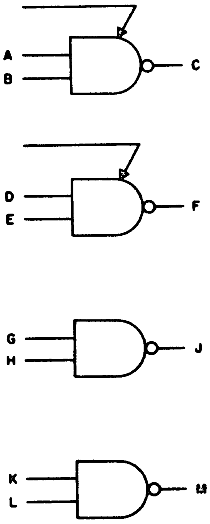
QUAD 2 INPUT GATE

321





$C = \overline{A \cdot B}$
$F = \overline{D \cdot E}$
$J = \overline{G \cdot H}$
$M = \overline{K \cdot L}$

LIMITS	321 B			321 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (2−1+)	120	160	250	130	160	220	nsec typ.
T_{PD} (2+1−)	80	70	70	75	70	70	nsec typ.
I_{PS} (inputs open)		13			13		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

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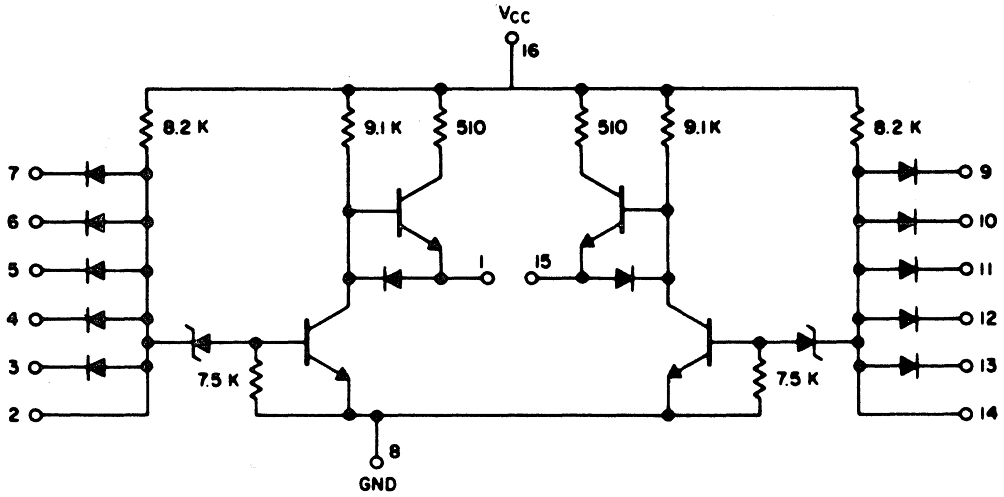
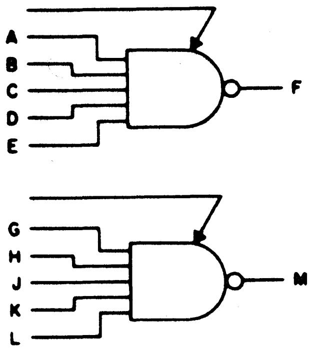
DUAL 5 INPUT GATE

322





$F = \overline{A \cdot B \cdot C \cdot D \cdot E}$

$M = \overline{G \cdot H \cdot J \cdot K \cdot L}$

LIMITS	322 B			322 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (3−1+)	120	160	250	130	160	220	nsec typ.
T_{PD} (3+1−)	130	100	80	120	100	85	nsec typ.
I_{PS} (inputs open)		6.0			6.0		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

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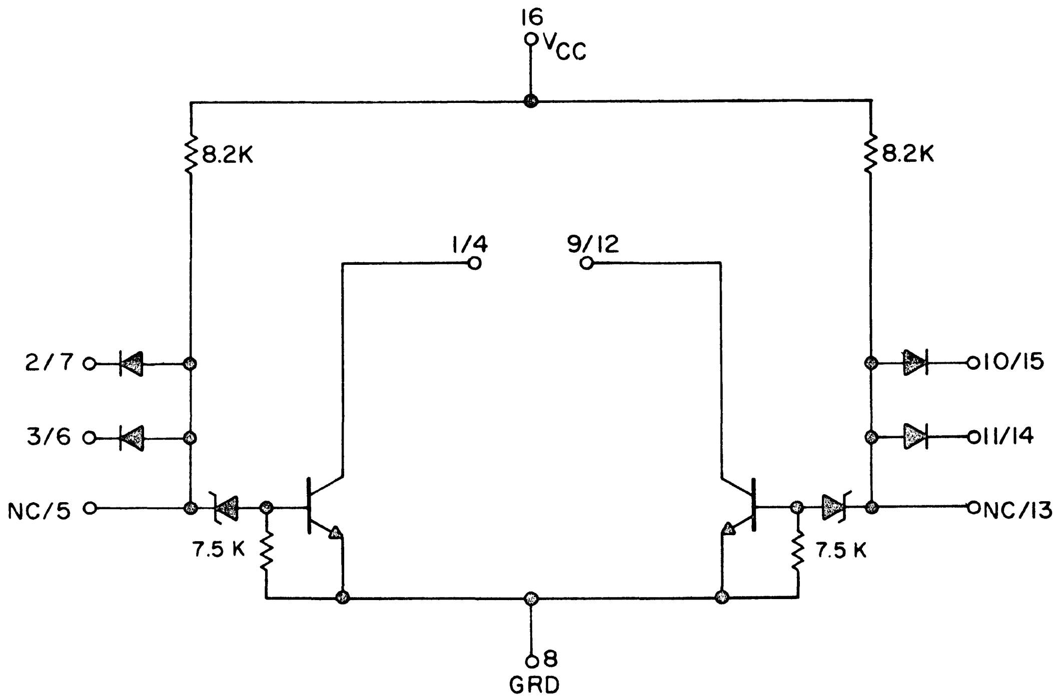
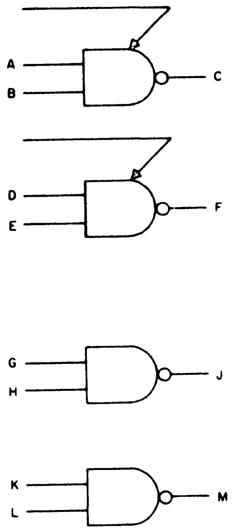
QUAD 2 INPUT GATE
COLLECTOR "OR" ABLE

323





$C = \overline{A \cdot B}$
$F = \overline{D \cdot E}$
$J = \overline{G \cdot H}$
$M = \overline{K \cdot L}$

LIMITS	323 B			323 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL}		0.3			0.3		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{CEX}	1.0	1.0	100	1.0	1.0	100	μA max.
I_{CEX}		0.05			0.05		μA typ.
I_{PS} (inputs open)		4.5			4.5		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL}	11	10	9.0	11	10	9.5	mA

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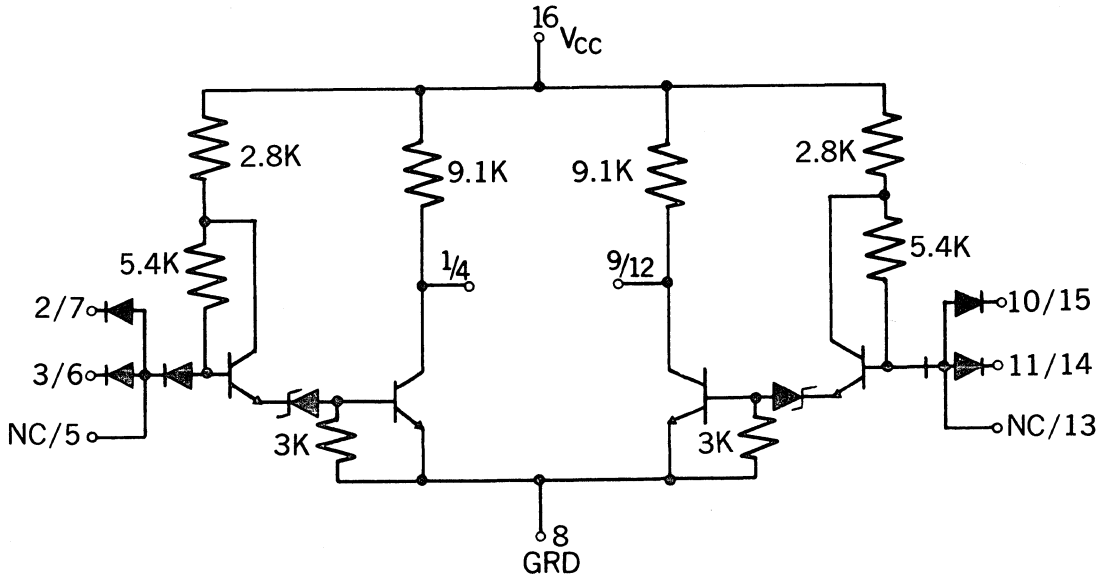
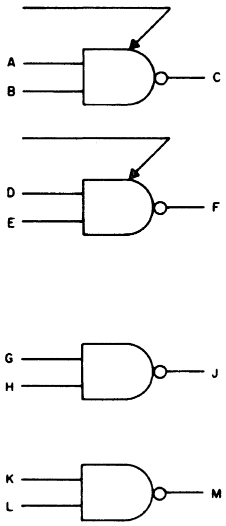
QUAD 2 INPUT GATE

324





$C = \overline{A \cdot B}$

$F = \overline{D \cdot E}$

$J = \overline{G \cdot H}$

$M = \overline{K \cdot L}$

LIMITS	324B			324C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL1}	0.8	0.8	0.8	0.8	0.8	0.8	Volts max.
V_{OL} @ I_{OL1}		0.5			0.5		Volts typ.
V_{OL} @ I_{OL2}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL2}		0.3			0.3		Volts typ.
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{PS} (inputs open)		24			24		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL1}	15	15	15	15	15	15	mA
I_{OL2}	11	10	10	11	10	10	mA
I_{OH}	−300	−300	−300	−300	−300	−300	μA

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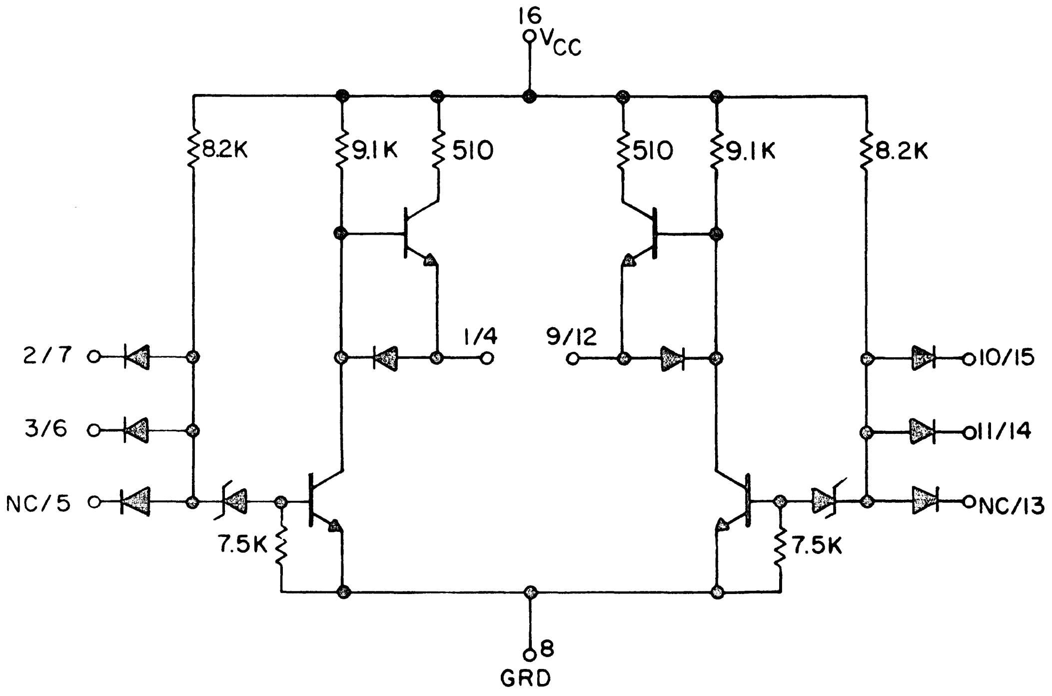
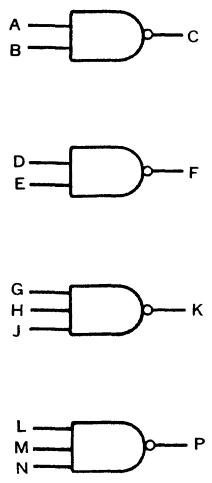
DUAL 2, DUAL 3
INPUT GATE

325





$C = \overline{A \cdot B}$
$F = \overline{D \cdot E}$
$K = \overline{G \cdot H \cdot J}$
$P = \overline{N \cdot M \cdot L}$

LIMITS	325B			325C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (2−1+)	120	160	250	130	160	220	nsec typ.
T_{PD} (2+1−)	80	70	70	75	70	70	nsec typ.
I_{PS} (inputs open)		13			13		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

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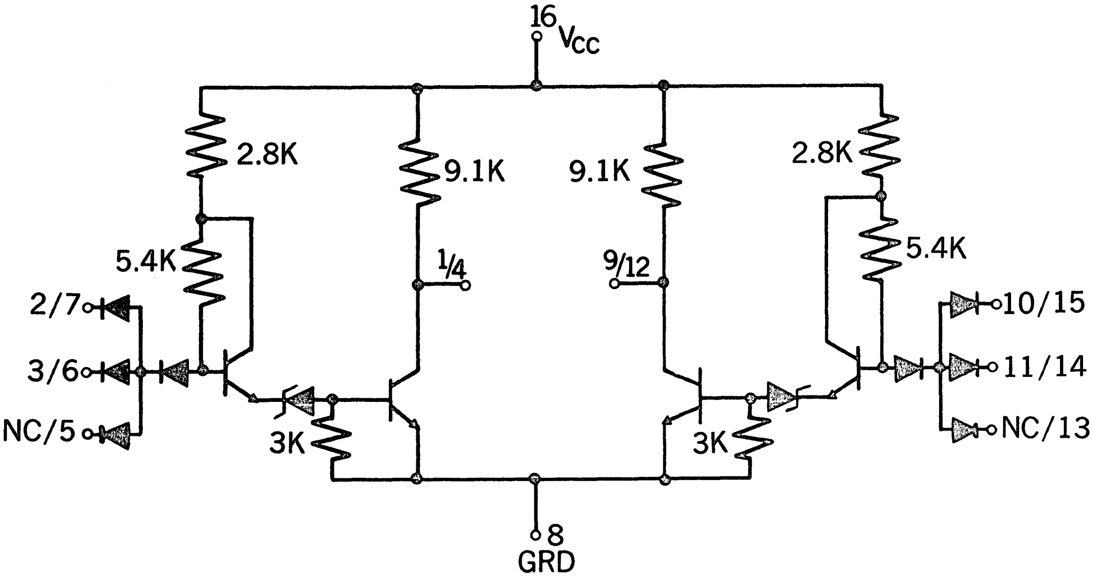
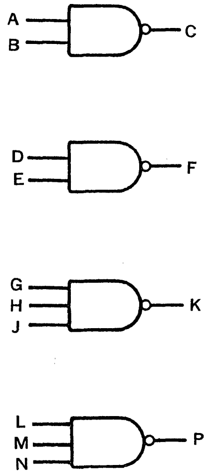
DUAL 2, DUAL 3 INPUT GATE

326





$C = \overline{A \cdot B}$
$F = \overline{D \cdot E}$
$K = \overline{G \cdot H \cdot J}$
$P = \overline{N \cdot M \cdot L}$

LIMITS	326B			326C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL1}	0.8	0.8	0.8	0.8	0.8	0.8	Volts max.
V_{OL} @ I_{OL1}		0.5			0.5		Volts typ.
V_{OL} @ I_{OL2}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL2}		0.3			0.3		Volts typ.
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{PS} (inputs open)		24			24		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL1}	15	15	15	15	15	15	mA
I_{OL2}	11	10	10	11	10	10	mA
I_{OH}	−300	−300	−300	−300	−300	−300	μA

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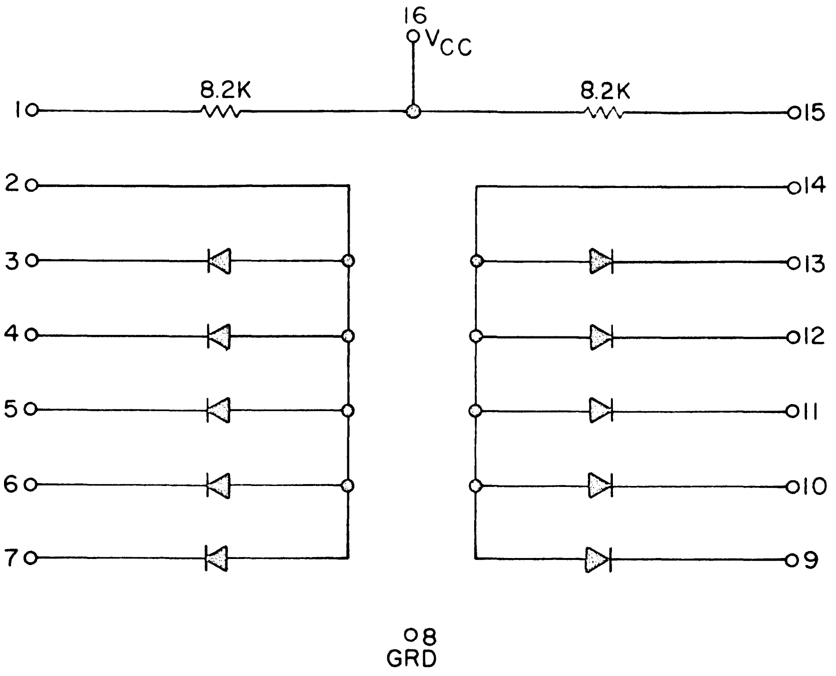
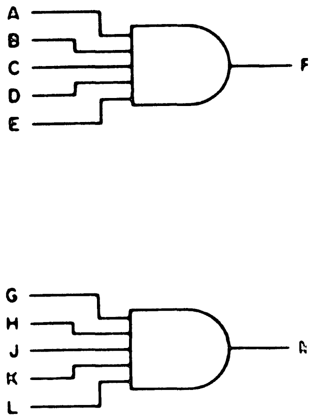
DUAL 5 INPUT EXPANDER

331





F = A·B·C·D·E
M = G·H·J·K·L

LIMITS	331 B			331 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts

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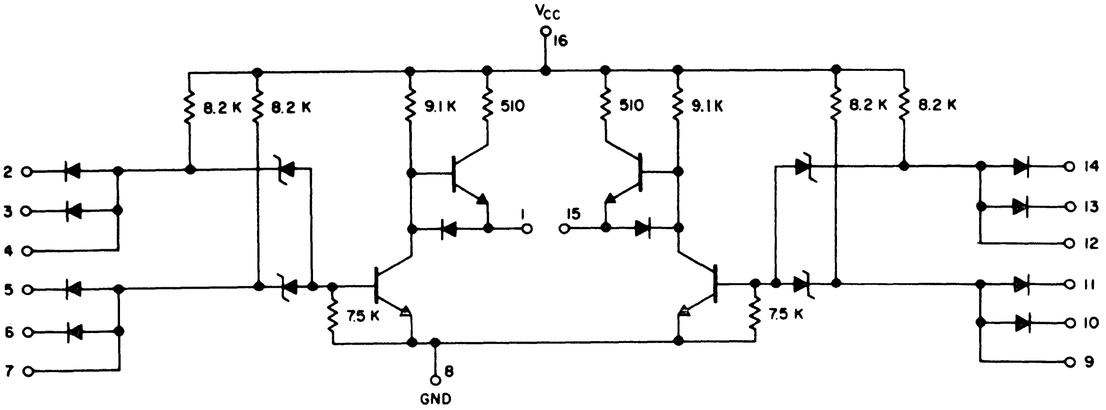
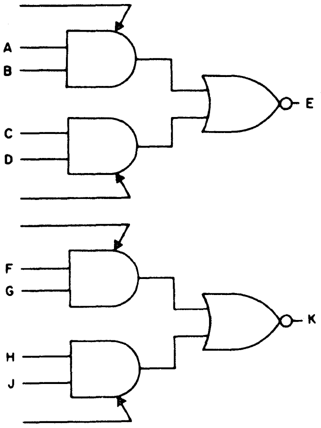
DUAL EXCLUSIVE - OR

341





$E = \overline{A \cdot B + C \cdot D}$

$K = \overline{F \cdot G + H \cdot J}$

LIMITS	341 B			341 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (2, 5−1+)	120	160	250	130	160	220	nsec typ.
T_{PD} (2, 5+1−)	130	100	80	120	100	85	nsec typ.
I_{PS} (inputs open)		8.0			8.0		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{OH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

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DUAL ONE SHOT

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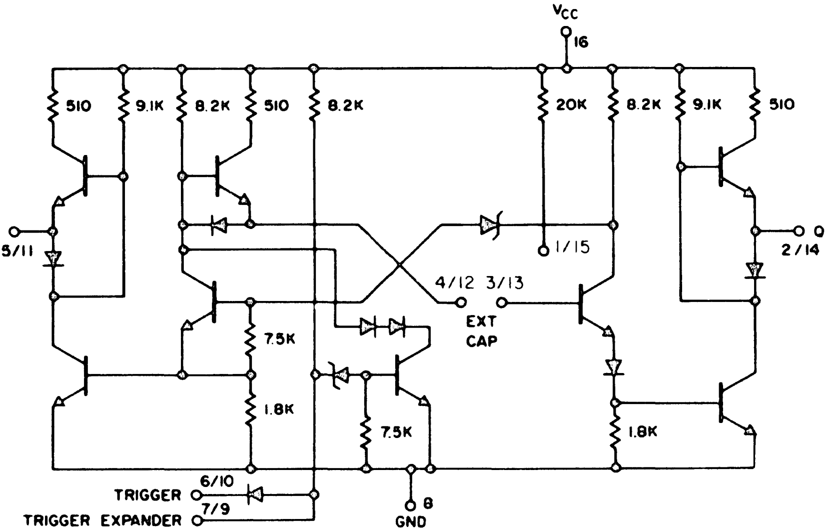
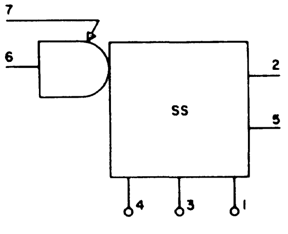
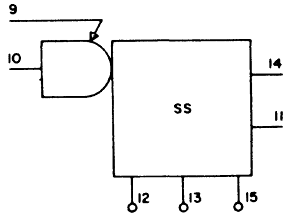




EXT. TIMING CONNECTIONS



EXT. TIMING CONNECTIONS

LIMITS	342 B			342 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		11.3			11.3		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	1.6	1.5	1.5	1.6	1.5	1.5	Volts max.
V_{OL} @ I_{OL}		1.2			1.2		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (6+2+)	80	100	150	80	100	140	nsec typ.
T_{PD} (6+5−)	70	75	75	70	75	75	nsec typ.
I_{PS} (Pin 1 connected to Pin 3) (Pin 13 connected to Pin 15)		15			15		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−5.0	−5.0	−5.0	−5.0	−5.0	−5.0	mA
I_{OL}	9.5	8.5	7.5	9.5	8.5	8.0	mA

The dual one shot is useful for timing and pulse generation over the range of 100 nsec to several seconds. The trigger input (triggers on a positive going input) is a standard HNIL gate input with the expander node brought out for added flexibility. The trigger input is completely isolated from the timing circuitry allowing trigger pulse width to be greater than or less than the output pulse width, and limited only by duty cycle considerations. The output pulse width ($P_W \simeq 0.7$ RC) is determined by an external capacitor, and, for precision applications, an external timing resistor which should not exceed 62 KΩ or less than 2 KΩ. An internal resistor with a nominal value of 20 KΩ is provided for normal applications. The allowable duty cycle can be calculated from $T_{recovery} = 3C$ where C is in picofarads (pf) and T is in nanoseconds (nsec) and is the time required to charge the timing capacitor to greater than 99% of its final value. For normal applications the capacitor is placed between 3 and 4 (12 & 13) and pin 1 (15) is shorted to pin 3 (13).

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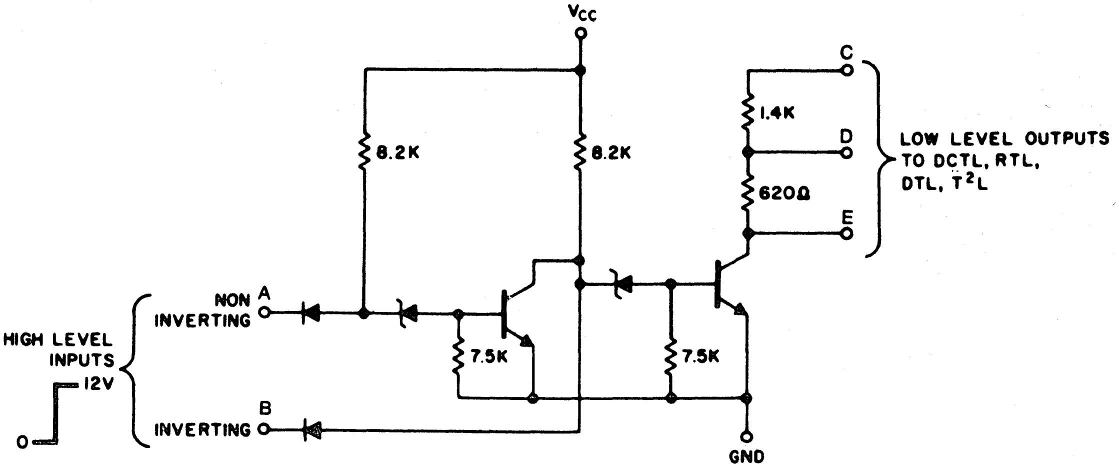
JANUARY 1968

DUAL INPUT INTERFACE

CONVERTS HIGH LEVEL LOGIC TO LOW LEVEL LOGIC

361



361 TERMINAL IDENTIFICATION		
	G & J PACKAGE	1/4 x 1/4 FLAT PACKAGE (H)
A1	5	6
B1	4	5
C1	1	2
D1	2	3
E1	3	4
A2	11	9
B2	12	10
C2	15	13
D2	14	12
E2	13	11
V_{CC}	16	14
GND	8	7

LIMITS	361 B			361 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH} @ V_I	4.8	4.8	4.8	4.8	4.8	4.8	Volts min.
V_{OH} @ V_I		5.0			5.0		Volts typ.
V_{OL} @ I_{OL1}	350	300	330	350	300	330	mV max.
V_{OL} @ I_{OL2}		500			500		mV max.
I_{IL}	−2.2	−2.0	−1.8	−2.2	−2.0	−1.9	mA max.
I_{IL}		−1.4			−1.4		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_O @ V_2 & V_3	−2.5	−2.5	−2.3	−2.3	−2.2	−2.0	mA min.
T_{PD} (5+3+)	85	110	160	90	110	145	nsec typ.
T_{PD} (5−3−)	65	85	125	70	85	115	nsec typ.
T_{PD} (4+3−)	65	75	115	65	75	100	nsec typ.
T_{PD} (4−3+)	60	75	110	65	75	95	nsec typ.
I_{PS} (inputs open)		6.5			6.5		mA max.

I_O The output (drive) current available when terminated at a specific voltage (V).

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	0.5	0.5	0.5	0.5	0.5	0.5	Volts
V_1 @ (Pins 1 and 15)	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_2 @ (Pins 2 and 14)	3.0	3.0	3.0	3.0	3.0	3.0	Volts
V_3 @ (Pins 3 and 13)	1.01	0.85	0.675	0.9	0.85	0.76	Volts
I_{OL1}	6.0	6.0	6.0	6.0	6.0	6.0	mA
I_{OL2}		10			10		mA

Pins in ( ) for G, J and N packages.

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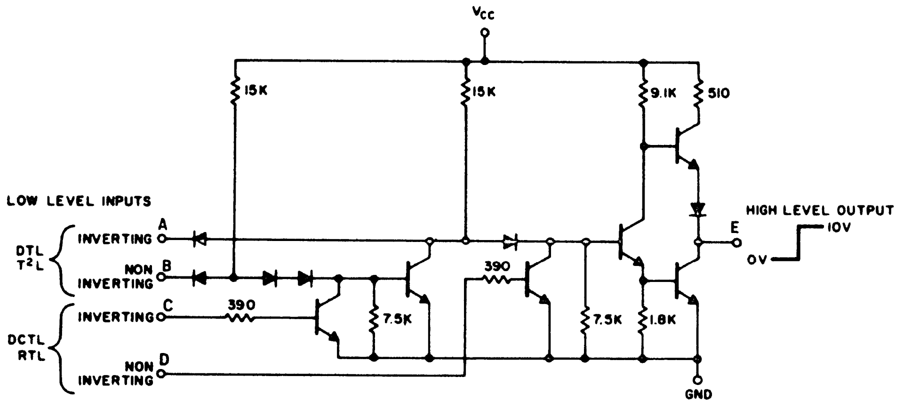
JANUARY 1968

DUAL OUTPUT INTERFACE

CONVERTS LOW LEVEL LOGIC TO HIGH LEVEL LOGIC

362



362 TERMINAL IDENTIFICATION	G & J PACKAGE	1/4 x 1/4 FLAT PACKAGE (H)
A1	4	4
B1	6	6
C1	5	5
D1	3	3
E1	2	2
A2	12	11
B2	10	9
C2	11	10
D2	13	12
E2	14	13
V_{CC}	16	14
GND	8	7

LIMITS	362 B			362 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	9.5	9.5	9.5	9.5	9.5	9.5	Volts min.
V_{OH}		10.7			10.7		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL}	0.5	0.5	0.5	0.5	0.5	0.5	Volts min.
V_{OL}		0.3			0.3		Volts typ.
$I_{IN(S)}$	−1.3	−1.2	−1.1	−1.3	−1.2	−1.1	mA max.
$I_{IN(D)}$	495	440	470	460	440	500	μA max.
$I_{L(S)}$	1.0	1.0	100	1.0	1.0	100	μA max.
$I_{L(D)}$	−1.0	−1.0	−100	−1.0	−1.0	−100	μA max.
T_{PD} (4+2−)	40	60	110	45	60	100	nsec typ.
T_{PD} (4−2+)	40	20	15	35	20	15	nsec typ.
T_{PD} (6+2+)	55	50	40	55	50	45	nsec typ.
T_{PD} (6−2−)	40	50	105	45	50	90	nsec typ.
T_{PD} (5−2+)	70	50	45	60	50	45	nsec typ.
T_{PD} (5+2−)	80	110	190	85	110	170	nsec typ.
T_{PD} (3+2+)	90	100	160	90	100	140	nsec typ.
T_{PD} (3−2−)	35	55	100	40	55	90	nsec typ.
I_{PS} (Pin 6 & Pin 10 = Gnd)		8.0			8.0		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
$V_{IH(S)}$	1.9	1.7	1.5	2.1	2.0	2.0	Volts
$V_{IL(S)}$	0.9	0.9	0.7	0.8	0.8	0.7	Volts
$V_{IN(S)}$	350	350	350	350	350	350	mV
$V_{IH(D)}$	1.01	0.85	0.675	0.95	0.85	0.75	Volts
$V_{IL(D)}$	0.71	0.5	0.32	0.6	0.5	0.38	Volts
$V_{IN(D)}$	1.01	8.5	0.675	0.95	0.85	0.75	Volts
I_{OL}	11	10	9.0	10.5	10	9.5	mA
I_{OH}	−3.0	−3.0	−3.0	−3.0	−3.0	−3.0	mA
$V_{L(D)}$	−4.0	−4.0	−4.0	−4.0	−4.0	−4.0	Volts
$V_{L(S)}$	4.0	4.0	4.0	4.0	4.0	4.0	Volts

Pins in ( ) for G, J and N packages.

$_{N(S)}$ same definition as I_{IL}, measured on DTL inputs.

$I_{IN(D)}$ that current which flows into the RTL inputs with $V_{IN(D)}$ applied to that terminal.
$I_{L(S)}$ same definition as I_I, measured on DTL inputs with $V_{L(S)}$ applied.
$I_{L(D)}$ that current which flows from the RTL inputs with $V_{L(D)}$ applied to that terminal.

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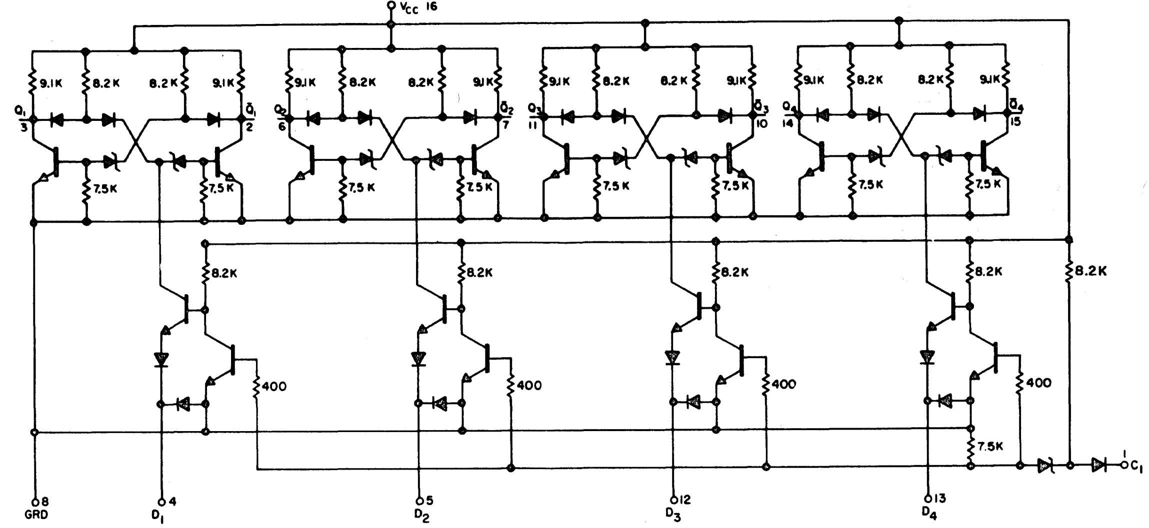
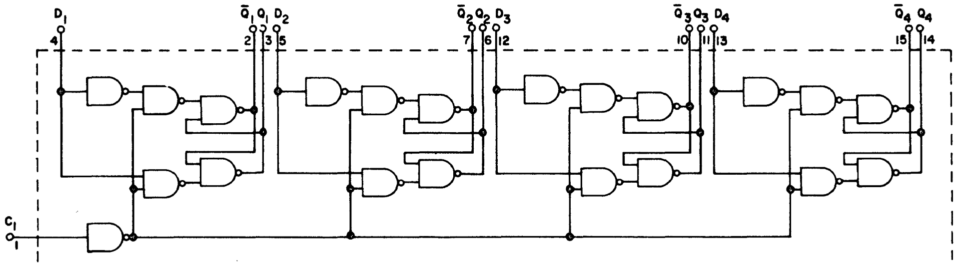
JANUARY 1968

QUAD D FLIP-FLOP

370





TRUTH TABLE

C_1	D^n	Q^{n+1}
1	1	Q^n
1	0	Q^n
0	1	1
0	0	0

LIMITS	370 B			370 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		12			12		Volts typ.
V_{OHL}	7.0	7.0	7.0	7.0	7.0	7.0	Volts min.
V_{OHL}		8.0			8.0		Volts typ.
V_{OL} @ I_{OL}	0.5	0.5	0.5	0.5	0.5	0.5	Volts max.
V_{OL} @ I_{OL}		0.3			0.3		Volts typ.
I_{IL} (pin 1)	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL} (pin 1)		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
T_{PD} (4+3+)	120	160	250	130	160	220	nsec typ.
T_{PD} (4−3−)	80	70	75	75	70	70	nsec typ.
I_{PS} (inputs open)		30			30		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OH}	−300	−300	−300	−300	−300	−300	μA
I_{OL}	7.6	6.8	6.0	7.6	6.8	6.4	mA

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JUNE 1969

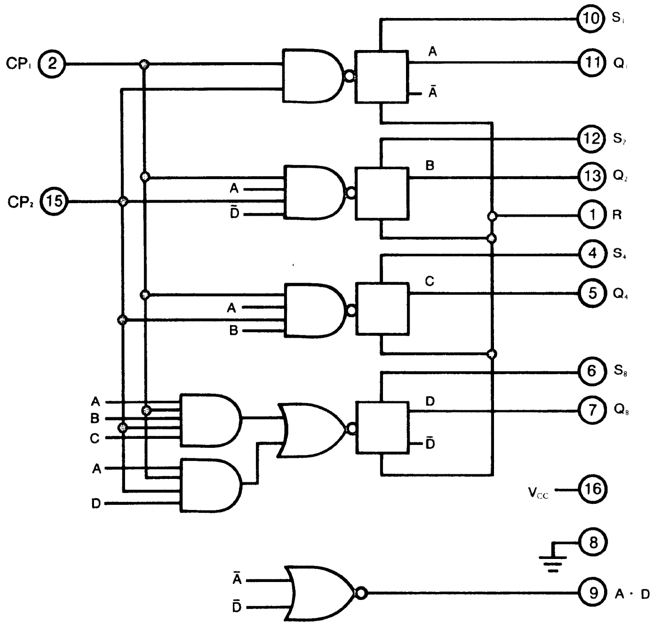
DECADE COUNTER
QUAD RIPPLE COUNTER

371
372

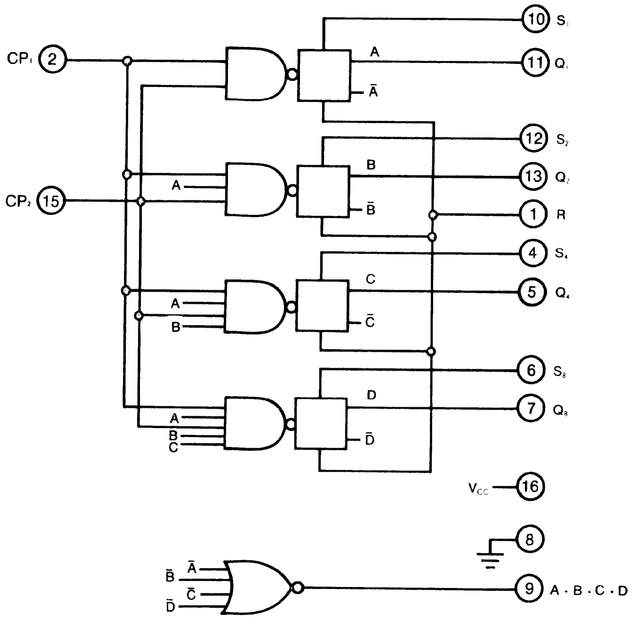
The HNIL 371 is a DECADE COUNTER consisting of four ripple-connected binaries and necessary gating capable of operating up to 2 MHz typically. It generates the standard 1248 BCD code on its outputs. The clock operates on a HI to LO transition. The alternate clock pin is useful for inhibit purposes. All unused direct SET and RESET inputs must be grounded and the Clock must be low when direct SETing or RESETing. A ninth count gated output is available.

The HNIL 372 is a HEXADECIMAL (or divide by 16) COUNTER. Except for the internal connections which produce the count sequence, this element is similar to the HNIL 371. A fifteenth count gated output is available.

371 LOGIC BLOCK



372 LOGIC BLOCK



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LIMITS	371 C			372 C			
	−30°C	+25°C	+85°C	−30°C	+25°C	+85°C	
V_{OH}	10.5	10.5	10.5	10.5	10.5	10.5	Volts min.
V_{OH}		12			12		Volts typ.
V_{OL} @ I_{OL}	0.7	0.7	0.7	0.7	0.7	0.7	Volts max.
V_{OL} @ I_{OL}		0.4			0.4		Volts typ.
I_{IL} (clock & reset)	−2.7	−2.5	−2.4	−2.7	−2.5	−2.4	mA max.
I_{IL} (set inputs)	−0.68	−0.63	−0.6	−0.68	−0.63	−0.6	mA max.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{PS} (inputs open)		28			28		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL}	9.5	8.5	8.0	9.5	8.5	8.0	mA
I_{OL} (pin 9)	3.8	3.4	3.0	3.8	3.4	3.0	mA

371 TRUTH TABLE

CP_1 or CP_2	Q_1	Q_2	Q_4	Q_8	$Q_1{\bullet}Q_8$
0	0	0	0	0	0
1	0	0	0	0	0
0	1	0	0	0	0
1	1	0	0	0	0
0	0	1	0	0	0
1	0	1	0	0	0
0	1	1	0	0	0
1	1	1	0	0	0
0	0	0	1	0	0
1	0	0	1	0	0
0	1	0	1	0	0
1	1	0	1	0	0
0	0	1	1	0	0
1	0	1	1	0	0
0	1	1	1	0	0
1	1	1	1	0	0
0	0	0	0	1	0
1	0	0	0	1	0
0	1	0	0	1	1
1	1	0	0	1	1

372 TRUTH TABLE

CP_1 or CP_2	Q_1	Q_2	Q_4	Q_8	$Q{\bullet}Q_2$ $Q_4{\bullet}Q_8$
0	0	0	0	0	0
1	0	0	0	0	0
0	1	0	0	0	0
1	1	0	0	0	0
0	0	1	0	0	0
1	0	1	0	0	0
0	1	1	0	0	0
1	1	1	0	0	0
0	0	0	1	0	0
1	0	0	1	0	0
0	1	0	1	0	0
1	1	0	1	0	0
0	0	1	1	0	0
1	0	1	1	0	0
0	1	1	1	0	0
1	1	1	1	0	0
0	0	0	0	1	0
1	0	0	0	1	0
0	1	0	0	1	0
1	1	0	0	1	0
0	0	1	0	1	0
1	0	1	0	1	0
0	1	1	0	1	0
1	1	1	0	1	0
0	0	0	1	1	0
1	0	0	1	1	0
0	1	0	1	1	0
1	1	0	1	1	0
0	0	1	1	1	0
1	0	1	1	1	0
0	1	1	1	1	1
1	1	1	1	1	1

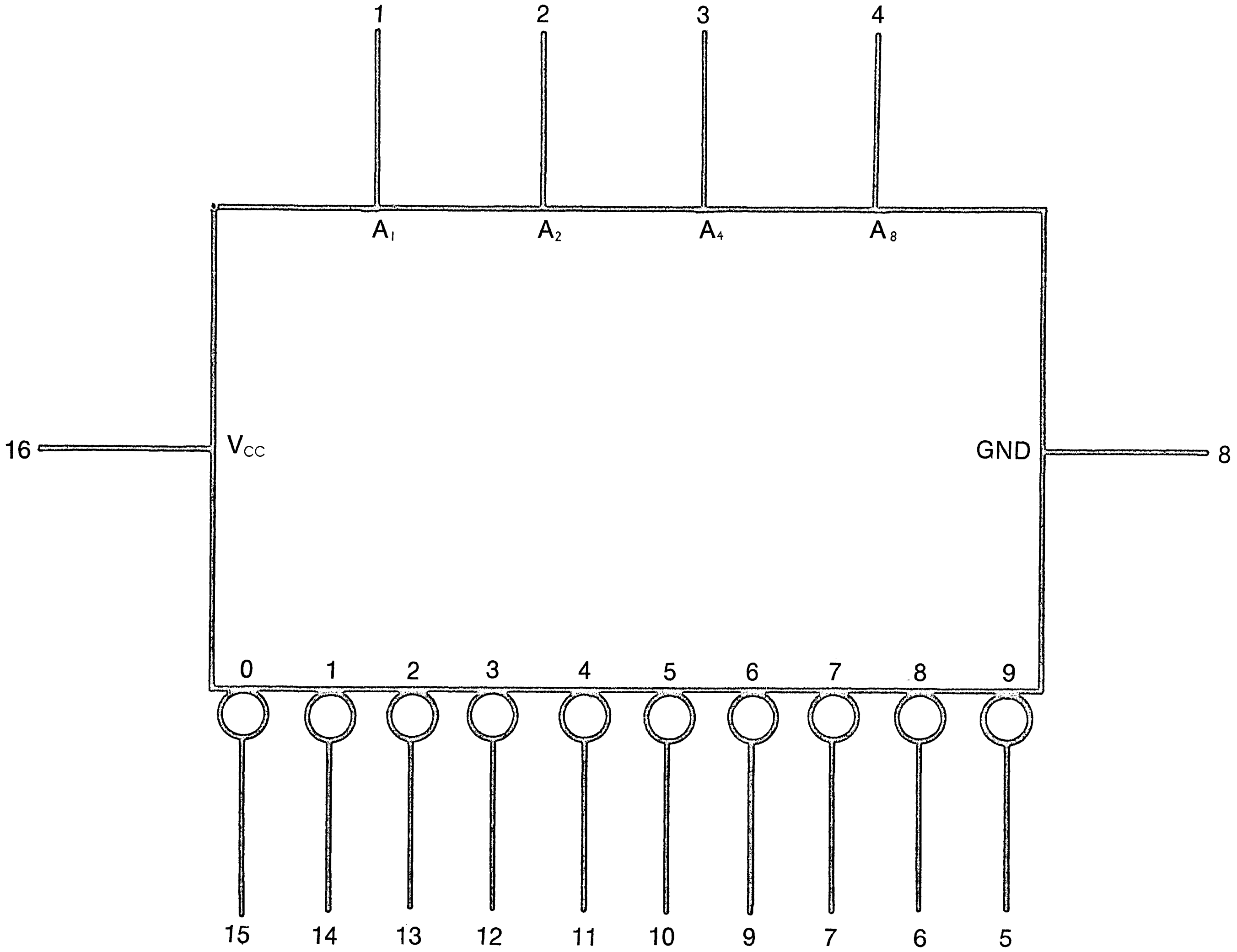
0 = LOW LEVEL
1 = HIGH LEVEL

JUNE, 1969

BCD TO DECADE DECODER

380

The HNIL 380 Decoder is used to decode the BCD 1248 code of the 371 or similarly generated inputs and produces a low (saturated) level on one of its ten outputs. These outputs can sink up to 30 ma at less than one volt and can operate from a 24 volt source. It produces no ambiguous outputs.



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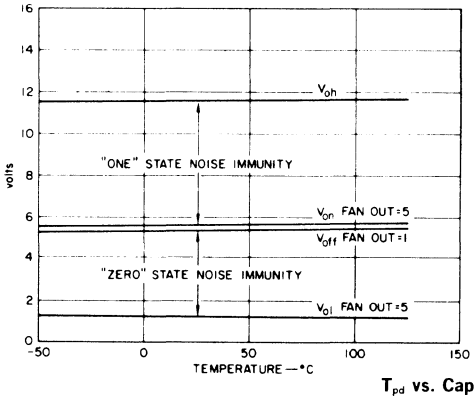
LIMITS	380B			380 C			
	−55°C	+25°C	+125°C	−30°C	+25°C	+85°C	
V_{OL} @ I_{OL}	1.0	1.0	1.0	1.0	1.0	1.0	Volts max.
V_{OL} @ I_{OL}		0.5			0.5		Volts typ.
I_{IL}	−1.9	−1.7	−1.5	−1.9	−1.7	−1.6	mA max.
I_{IL}		−1.2			−1.2		mA typ.
I_L	1.0	1.0	100	1.0	1.0	100	μA max.
I_L		0.05			0.05		μA typ.
I_{CEX}	1.0	1.0	100	1.0	1.0	100	μA max.
I_{CEX}		0.05			0.05		μA typ.
I_{PS} (inputs open)		20			20		mA max.

CONDITIONS							
V_{CC}	12	12	12	12	12	12	Volts
V_{IH}	6.5	6.5	6.5	6.5	6.5	6.5	Volts
V_{IL}	5.0	5.0	5.0	5.0	5.0	5.0	Volts
V_{IN}	1.6	1.5	1.5	1.6	1.5	1.5	Volts
I_{OL}	30	30	27	30	30	27	mA
V_{CEX}	24	24	24	24	24	24	Volts

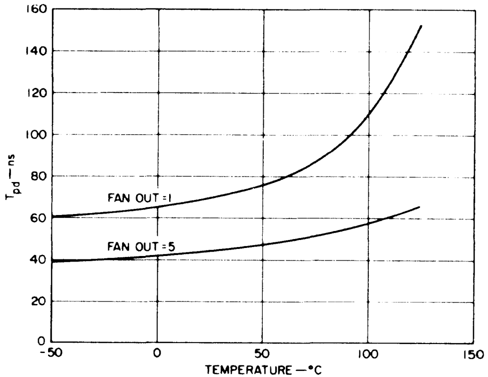
DEFINITION OF SYMBOLS AND TERMS

V_{CC}	Supply Voltage
V_{IL}	Maximum voltage that may be applied to an input without changing the output from a "1" state to a "0" state.
V_{IH}	Minimum voltage that may be applied to an input without changing the output from a "0" state to a "1" state.
V_{OL}	The output voltage with I_{OL} applied and V_{IH} applied to all inputs.
V_{OH}	The output voltage with V_{IL} applied to the input.
V_{OHL}	The output voltage with V_{IL} applied to the input and a drive current, I_{OH}, being supplied.
V_{IN}	The voltage which is applied to an input for the I_{IL} test measurement, equals V_{OL} for standard diode input.
I_{IL}	The input forward current with V_{IN} applied to that input.
I_L	The maximum reverse current at the input when V_{CC} is applied and the other adjacent inputs are grounded.
I_{OL}	Load (Sink) current at which the output voltage is guaranteed for the zero state or V_{OL}.
T_{PD}	Propagation delay, (N+, M−), when input pulse at terminal N is going positive (direction of the sign) and the output, Terminal M, is going negative. Propagation time is measured at the 50% levels.
FAN-OUT	Minimum number of logic elements that may be driven by one other logic element of the same family, and is determined by the ratio of I_{OL}/I_{IL}.
"Zero" State Noise Immunity	The additional amount of positive voltage required at the output ot a gate, when in the "zero" state, to raise that voltage to the maximum voltage that may be applied to an input without changing that gate's output state. It is determined by the equation, $NI = V_{IL} - V_{OL}$ (5.0 V−1.5 V = 3.5 Volts).
"One" State Noise Immunity	The additional amount of negative voltage required at the output of a gate, when in the "one" state, to lower that voltage to the minimum voltage that may be applied to an input without changing that gate's output state. It is determined by the equation, $NI = V_{OH} - V_{IH}$ (10.5 V−6.5 V = 4.0 Volts).
I_{PS}	Power Supply Current, no load, $V_{CC} = +12$ Volts.

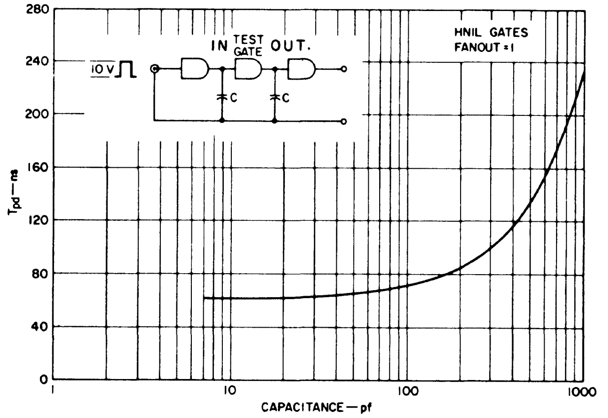
Noise Immunity vs. Temperature



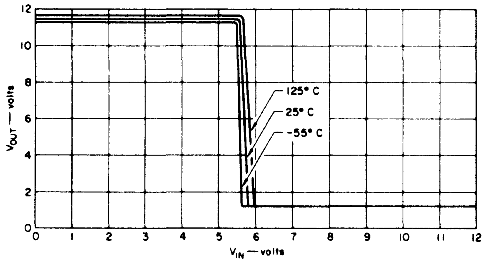
High Noise Immunity Gate T_{pd} vs. Temperature



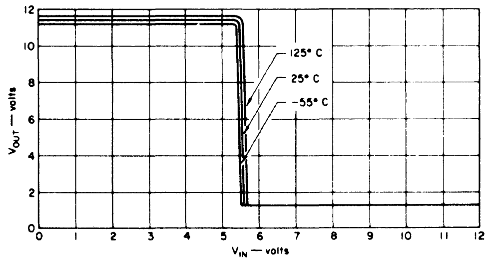
T_{pd} vs. Capacitive Loading



V_{OUT} vs. V_{IN} 2 mA Load



V_{OUT} vs. V_{IN} No Load



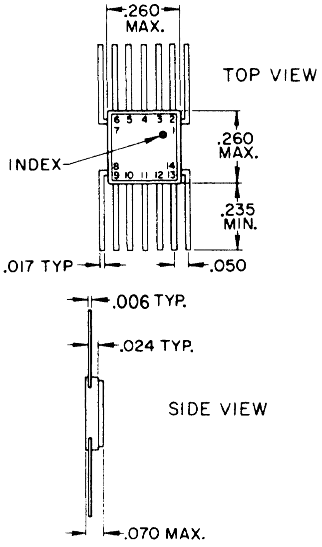
JANUARY 1968

DIGITAL CIRCUIT
TRANSISTOR-TRANSISTOR LOGIC

500
SERIES

The Amelco Transistor-Transistor Logic has been designed specifically for use in applications where primary emphasis is placed on low power consumption. The logic family is provided in three compatible and interchangeable power levels, 0.5 mW, 1.2 mW, and 4.0 mW, allowing the Designer to optimize his speed-power trade-off. Most of the gate elements are also available with no pull up resistor, allowing collector "OR"ing.

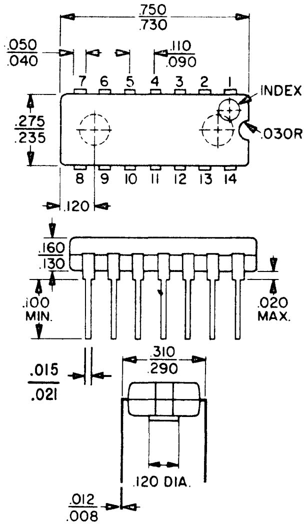
H PACKAGE



TRANSISTOR-TRANSISTOR LOGIC ELEMENTS

JK Flip-Flop
Quad-2 Input Gate
Triple-3 Input Gate
Dual-4 Input Gate
Dual-4 Input Power Gate with Expander
Dual-4 Input Buffer with Expander
Dual-4 Input Nand/Nor Gate with Inverter
Dual-4 Input Power Gate and Lamp Driver

J PACKAGE



ABSOLUTE MAXIMUM RATINGS

	500BH	500CJ
Storage Temperature	−65°C to +150°C	−65°C to +150°C
Operating Temperature	−55°C to +125°C	0°C to 70°C
Maximum Voltage	6.8 V	6.8 V
Operating Voltage	4.0 V to 5.5 V	4.0 V to 5.5 V

NUMBERING SEQUENCE

500-529	Low Power
530-559	Medium Power
570-589	High Power

Complete part number designation consists of three digits and two letters, for example:

500BH
Package
Temperature Range
Circuit

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ELECTRICAL CHARACTERISTICS

	POWER LEVELS									UNITS
	LOW			MEDIUM			HIGH			
	−55°C	+25°C	+125°C	−55°C	+25°C	+125°C	−55°C	+25°C	+125°C	
V_{CC} max.	6.8	6.8	6.8	6.8	6.8	6.8	6.8	6.8	6.8	Volts
V_{CC}	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	4.0	Volts
V_{OL} at I_{OL}	0.4	0.2	0.25	0.4	0.3	0.35	0.5	0.4	0.4	Volts max.
V_{OH} (Note 1)	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	3.5	Volts min.
V_{IL}	1.4	1.0	0.6	1.4	1.0	0.7	1.4	1.0	0.7	Volts max.
V_{IH}	2.0	1.8	1.5	2.0	1.8	1.5	2.0	1.8	1.6	Volts min.
I_{IL}	200	150	120	550	450	400	1100	1100	1100	μA max.
I_{IL} R & S (f/f)	130	100	80	550	450	400	750	750	750	μA max.
I_{IL} C (flip-flop)	400	300	240	1450	1200	1050	2250	2250	2250	μA max.
I_{IL} C_2 R_D	400	300	240	1450	1200	1050	2250	2250	2250	μA max.
I_{IH1}	2.0	2.0	3.0	4.0	4.0	6.0	12	12	18	μA max.
I_{IH2}		10			20			60		μA max.
I_{OH1}		100			100			100		μA max.
I_{OH2} at $V_{CC} = 4.0$ V					2.5	2.5	2.0	5.0	6.0	mA
I_{OH2} at $V_{CC} = 4.5$ V				2.0	4.0	4.0	4.0	7.0	8.0	mA
I_{OL1}	1.2	0.9	0.72	3.3	2.7	2.4	8.0	8.0	8.0	mA
I_{OL2} med. pwr.				8.0	8.0	8.0				mA
I_{OL3} high pwr.				22	22	22	34	36	32	mA
I_{OL4} high pwr.							36	40	36	mA
I_{OL}SR		0.9		4.4	3.6	3.2	13.5	13.5	13.5	mA
I_A		20			200			375		μA min.
V_{I1}	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	3.0	Volts
V_{I2}	6.0	6.0	6.0	6.0	6.0	6.0	6.0	6.0	6.0	Volts

NOTE 1: For 540, 541, 580 and 587 loaded V_{OH} is 2.5V.

DEFINITION OF SYMBOL & TERMS

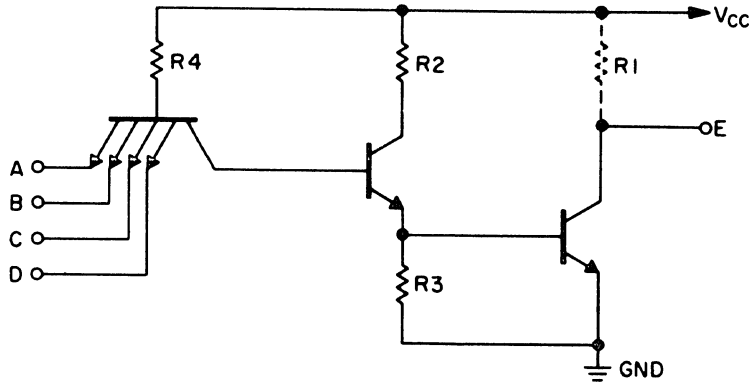
V_{CC}	Supply Voltage
V_{OL}	The output voltage with I_{OL} applied and V_{IH} applied to all inputs.
V_{OH}	The output voltage with input grounded.
V_{IL}	Maximum voltage that may be applied to an input without changing the output from "1" to a "0" state.
V_{IH}	Minimum voltage that may be applied to an input without changing the output from a "0" to a "1" state.
I_{IL}	The input forward current.
I_{IH1}	The maximum reverse current allowable at the input when V_{I1} is applied and the adjacent input is grounded.
I_{IH2}	The maximum total reverse current at the input when V_{I2} is applied to all inputs.
I_{OH1}	The output high current when V_{max} is applied to the outputs and V_{CC}, with inputs grounded.
I_{OH2}	The output current with inputs grounded, and the output voltage at V_{OH} minimum.
I_{OL}	Minimum load current at the output of the logic element in the "0" state.
I_A	Minimum load current at the output of the logic element in the "1" state.
T_{PD}	Propagation delay — average of T_{on} and T_{off}.
Fan-out	Minimum number of logic elements that may be driven by one other logic element and is determined by the ratio of $\frac{I_{OL}}{I_{IL}}$

JANUARY 1968

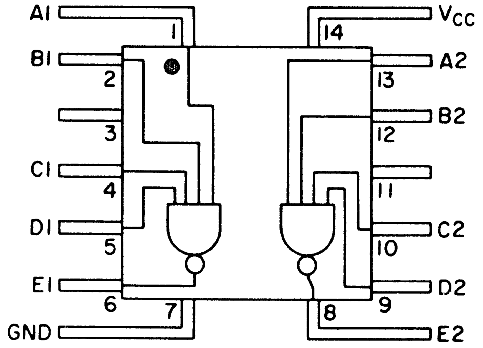
DUAL 4 INPUT GATE

500 504
530 534
570 574

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				
										−55°C	+25°C		+125°C	
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}
500	L	∞	20K	20K	40K			0.5	1.0	225	180	300	215	I_{OL1}
504	L	40K	20K	20K	40K			0.7	1.2	175	140	250	175	I_{OL1}
530	M	∞	10K	10K	10K			1.5	2.2	85	75	100	85	I_{OL1}
534	M	10K	10K	10K	10K			2.0	3.0	75	60	90	75	I_{OL1}
570	H	∞	7.0K	4.0K	3.5K			4.1	5.5	45	25	55	38	I_{OL1}
574	H	6.0K	7.0K	4.0K	3.5K			5.0	6.8	45	25	55	38	I_{OL1}

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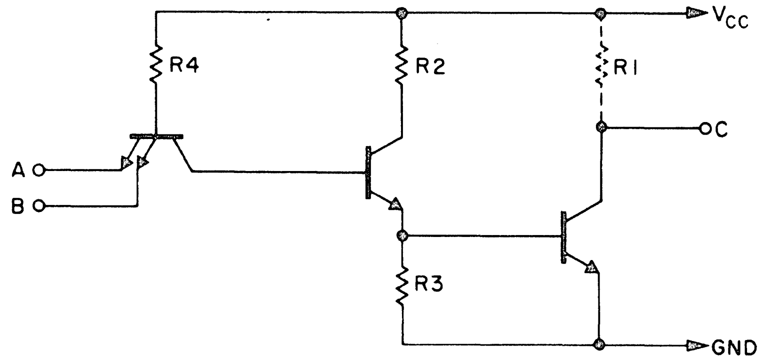
5202

JANUARY 1968

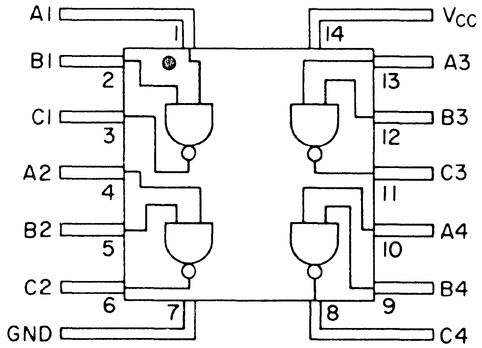
QUAD 2 INPUT GATE

501 505
531 535
571 575

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				
										−55°C	+25°C		+125°C	
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}
501	L	∞	20K	20K	40K			0.5	1.0	225	180	300	215	I_{OL1}
505	L	40K	20K	20K	40K			0.7	1.2	175	140	250	175	I_{OL1}
531	M	∞	10K	10K	10K			1.5	2.2	85	75	100	85	I_{OL1}
535	M	10K	10K	10K	10K			2.0	3.0	75	60	90	75	I_{OL1}
571	H	∞	7.0K	4.0K	3.5K			4.1	5.5	45	25	55	38	I_{OL1}
575	H	6.0K	7.0K	4.0K	3.5K			5.0	6.8	45	25	55	38	I_{OL1}

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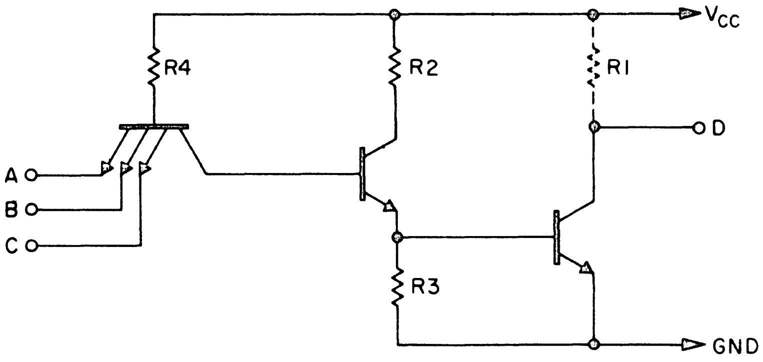
5203

JANUARY 1968

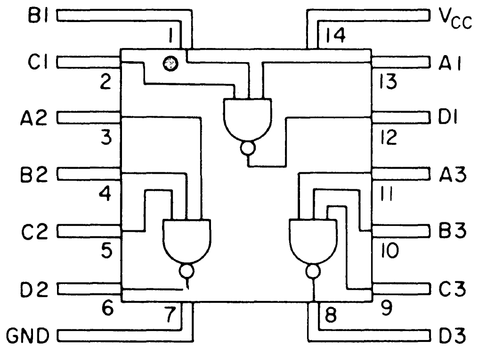
TRIPLE 3 INPUT GATE

503 507
533 537
573 577

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

		RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				
										−55°C	+25°C		+125°C	
PART NO.	POWER LEVEL	R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}
503	L	∞	20K	20K	40K			0.5	1.0	225	180	300	215	I_{OL1}
507	L	40K	20K	20K	40K			0.7	1.2	175	140	250	175	I_{OL1}
533	M	∞	10K	10K	10K			1.5	2.2	85	75	100	85	I_{OL1}
537	M	10K	10K	10K	10K			2.0	3.0	75	60	90	75	I_{OL1}
573	H	∞	7.0K	4.0K	3.5K			4.1	5.5	45	25	55	38	I_{OL1}
577	H	6.0K	7.0K	4.0K	3.5K			5.0	6.8	45	25	55	38	I_{OL1}

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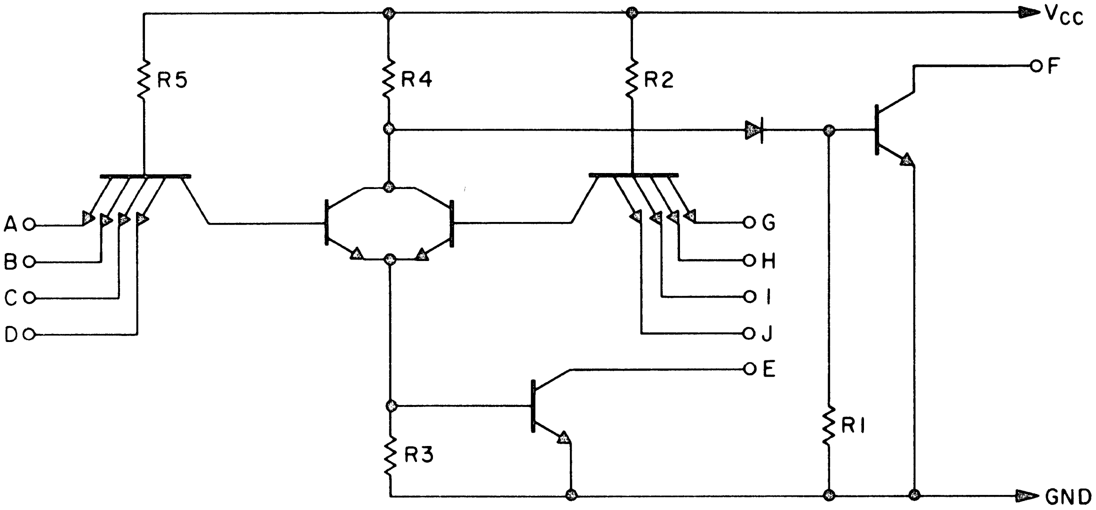
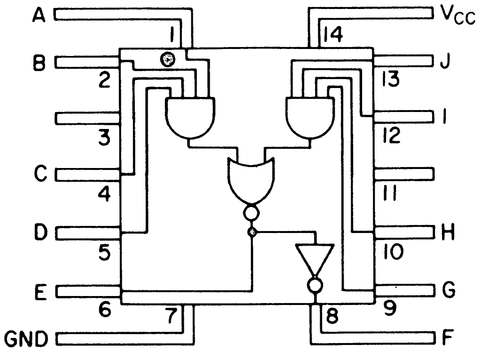
DUAL 4 INPUT NAND-NOR GATE
WITH INVERTER

508
538
578

SCHEMATIC



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				PIN #6	PIN #8
										−55°C	+25°C		+125°C		
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}	I_{OL}
508	L	20K	40K	20K	15K	40K		1.4	2.0	240	200	360	240	I_{OLI}	2/3 I_{OLI}
538	M	10K	10K	10K	7.5K	10K		3.8	4.8	100	85	120	100	I_{OLI}	2/3 I_{OLI}
578	H	4.0K	3.8K	4.0K	3.6K	3.8K		8.9	11.2	55	35	65	45	I_{OLI}	2/3 I_{OLI}

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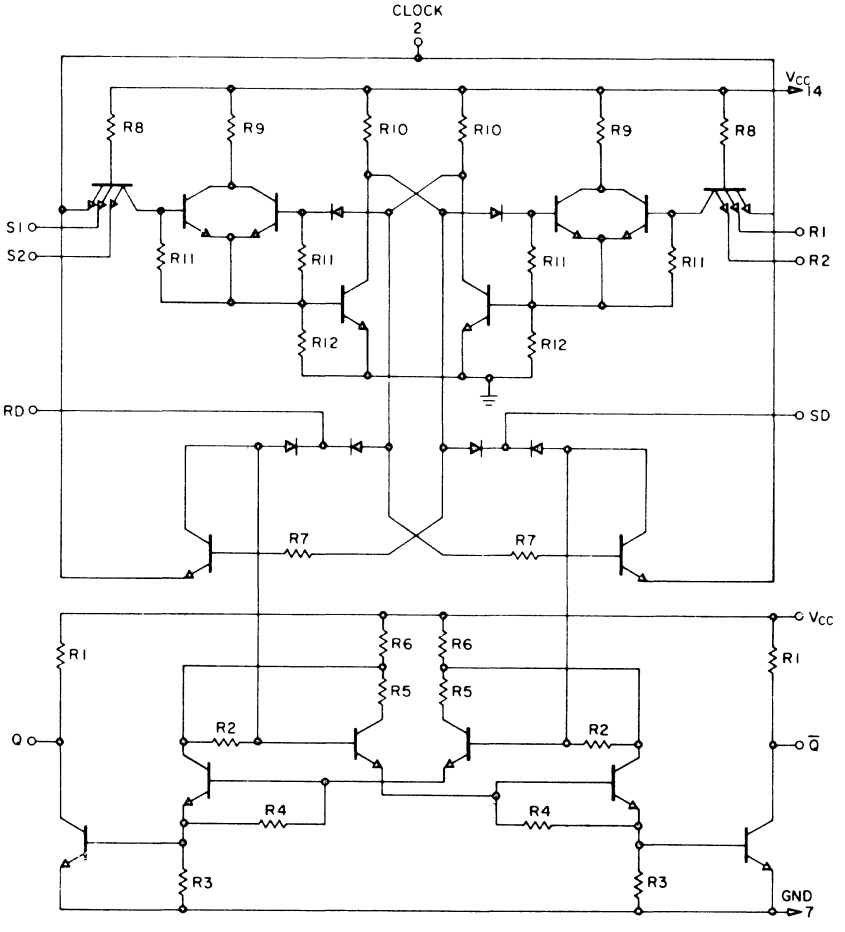
JK FLIP-FLOP

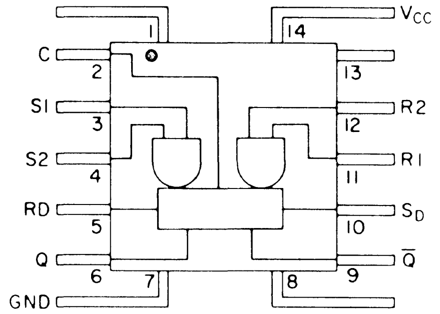
509
539
579

SCHEMATIC



MASTER-SLAVE FLIP-FLOP

LOGIC DIAGRAM AND PIN CONNECTIONS



TRUTH TABLE

R-S MODE					J-K MODE		
S_1^n	S_2^n	R_1^n	R_2^n	Q^{n+1}	J^n	K^n	Q^{n+1}
L	X	L	X	Q^n	L	L	Q^n
L	X	X	L	Q^n	L	H	L
X	L	L	X	Q^n	H	L	H
X	L	X	L	Q^n	H	H	$\overline{Q^n}$
L	X	H	H	L			
X	L	H	H	L			
H	H	L	X	H			
H	H	X	L	H			
H	H	H	H	Ambiguous			

X = don't care
$R_D = S_D = 1$

ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES												POWER DISS. (mW)			PROPAGATION DELAY AND CLOCK RATE					UNITS
																	-55°C	+25°C			+125°C	
		R_1	R_2	R_3	R_4	R_5	R_6	R_7	R_8	R_9	R_{10}	R_{11}	R_{12}	TYP.	MAX.		TYP.	MIN.	TYP.	MAX.	TYP.	
509	L	15K	40K	24K	36K	12K	20K	110K	56K	56K	28K	56K	28K	4.0	6.0	I_{OL}SR	700		550	700	800	T_{pd}(nsec)
																	0.75	0.5	1.0		0.75	Clock Rate MHz
539	M	10K	10K	10K	15K	3.0K	5.0K	20K	10K	20K	5.0K	15K	10K	12	18	I_{OL}SR	180		140	225	200	T_{pd}(nsec)
																	4.0	3.0	4.0		3.0	Clock Rate MHz
579	H	2.0K	3.3K	3.3K	5.0K	1.4K	2.2K	6.6K	6.0K	7.0K	3.2K	8.0K	3.3K	24	32	I_{OL}SR	75		65	75	75	T_{pd}(nsec)
																	12	10	12		10	Clock Rate MHz

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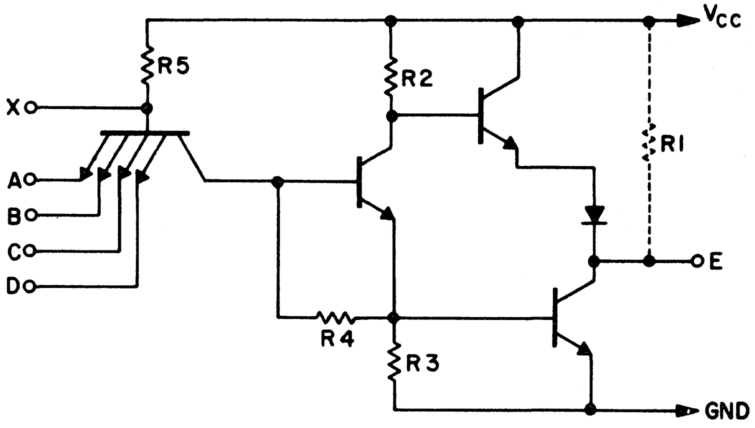
JANUARY 1968

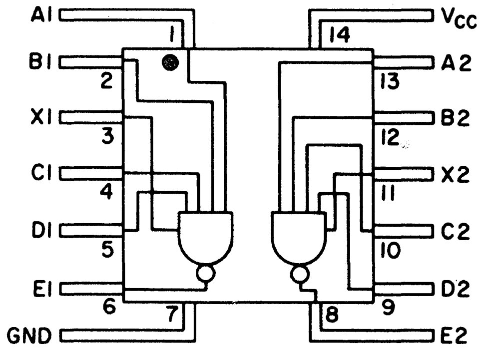
DUAL 4 INPUT BUFFER
WITH EXPANDER

540
541

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)					
										−55°C	+25°C		+125°C		
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}	I_{OH}
540	M	∞	2.6K	2.0K	20K	11K		4.5	6.0	90	70	100	90	I_{OL2}	I_{OH2}
541	M	5.75K	2.6K	2.0K	20K	11K		6.0	8.0	90	70	100	90	I_{OL2}	

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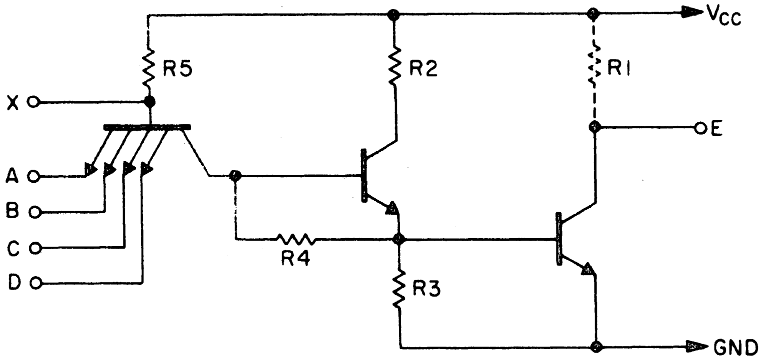
JANUARY 1968

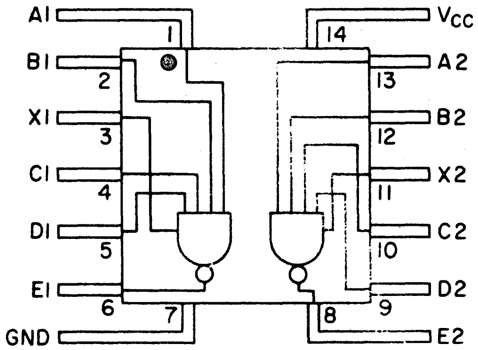
DUAL 4 INPUT GATE WITH EXPANDER

543
544
583
584

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				
										−55°C	+25°C		+125°C	
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}
543	M	∞	10K	10K	20K	10K		1.5	2.3	85	85	120	85	I_{OL1}
544	M	10K	10K	10K	20K	10K		2.0	3.0	75	75	110	75	I_{OL1}
583	H	∞	7.0K	4.0K	5.0K	3.5K		4.1	5.5	50	30	60	45	I_{OL1}
584	H	6.0K	7.0K	4.0K	5.0K	3.5K		5.0	6.8	50	30	60	45	I_{OL1}

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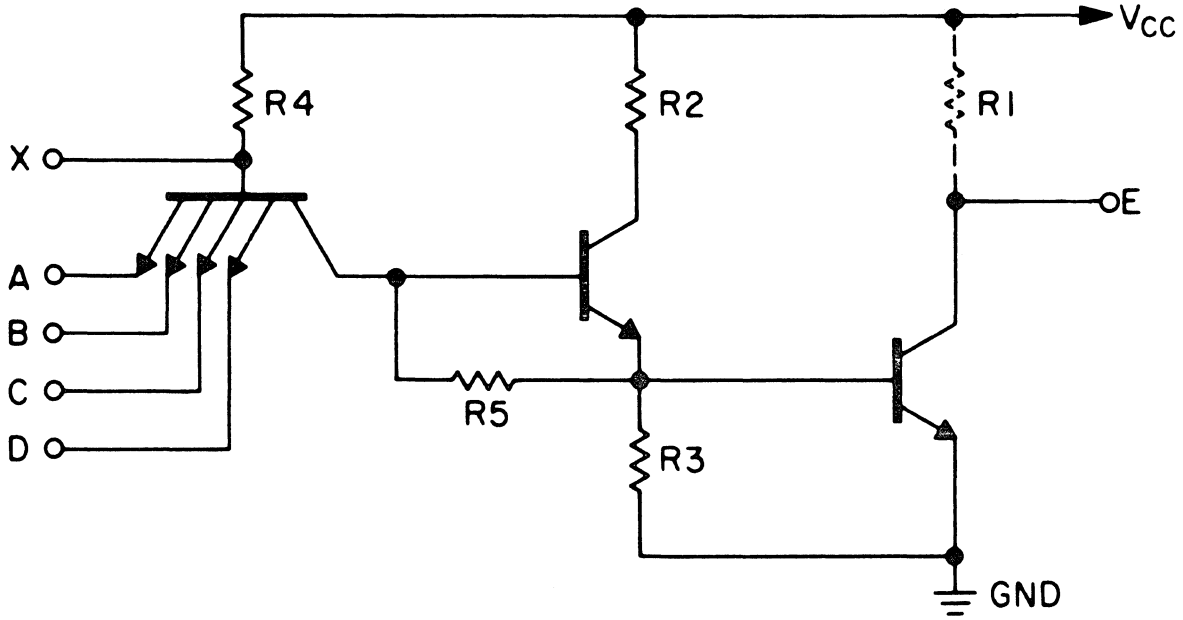
JANUARY 1968

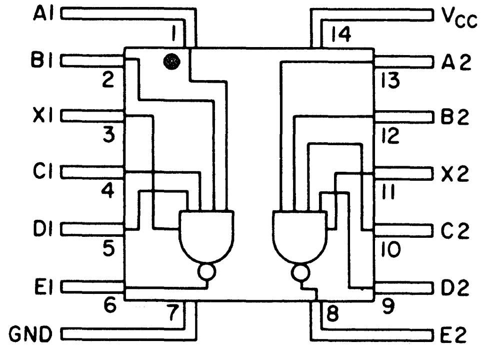
DUAL 4 INPUT
POWER GATE
AND LAMP DRIVER

547
548

SCHEMATIC (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)				
										−55°C	+25°C		+125°C	
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}
547	M	5.0K	1.4K	2.0K	9.0K	20K		7.5	9.6	75	60	90	75	I_{OL3}
548	M	∞	1.4K	2.0K	9.0K	20K		6.2	8.0	75	60	90	75	I_{OL3}

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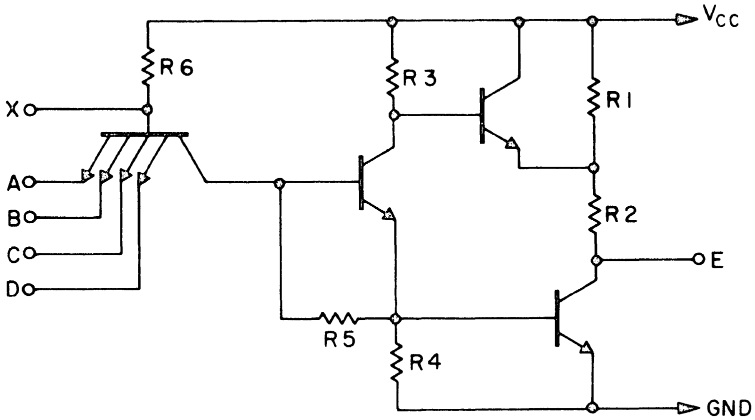
DUAL 4 INPUT BUFFER WITH EXPANDER
DUAL 4 INPUT GATE WITH EXPANDER

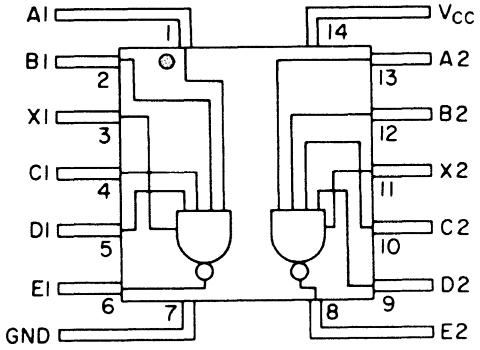
JANUARY 1968

580
587

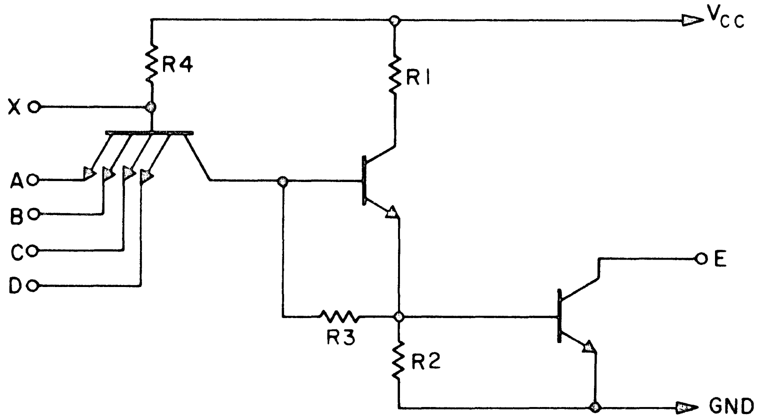
580 SCHEMATIC
DUAL 4 INPUT BUFFER WITH EXPANDER (EACH GATE)



LOGIC DIAGRAM AND PIN CONNECTIONS



587 SCHEMATIC
DUAL 4 INPUT GATE WITH EXPANDER (EACH GATE)



ELECTRICAL CHARACTERISTICS

PART NO.	POWER LEVEL	RESISTANCE VALUES						DISS. PER GATE (mW)		PROPAGATION DELAY (nsec)					
										−55°C	+25°C		+125°C		
		R_1	R_2	R_3	R_4	R_5	R_6	TYP.	MAX.	TYP.	TYP.	MAX.	TYP.	I_{OL}	I_{OH}
580	H	1.85K	150	850	630	5.0K	3.8K	17	22	60	45	60	60	I_{OL3}	I_{OH2}
587	H	850	630	5.0K	3.8K			13	17	60	55	60	60	I_{OL4}	

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ted in U.S.A.

JANUARY 1968

TEST CIRCUITS

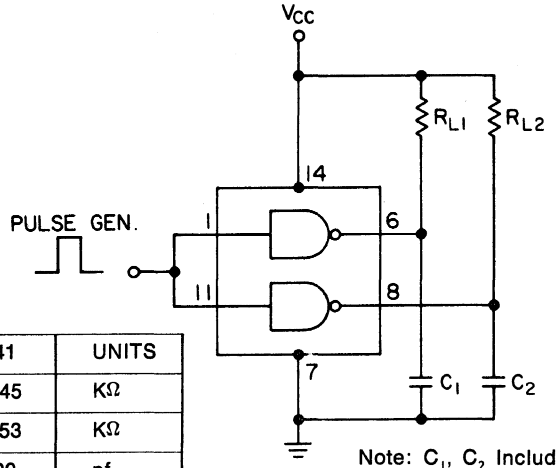
500
SERIES

T_{ON}, T_{OFF}
504, 534, 574, 580, 540, 541

$V_{threshold}$:

-55°C	25°C	125°C
1.8 V	1.5 V	1.2 V

V_{CC} = 4.0 Volt
Clock Freq: 1.0 MHz
Clock Amplitude: 4.0 Volt
Clock Duty Cycle: 50%
$T_r = T_f = 25 \pm 5$ nsec



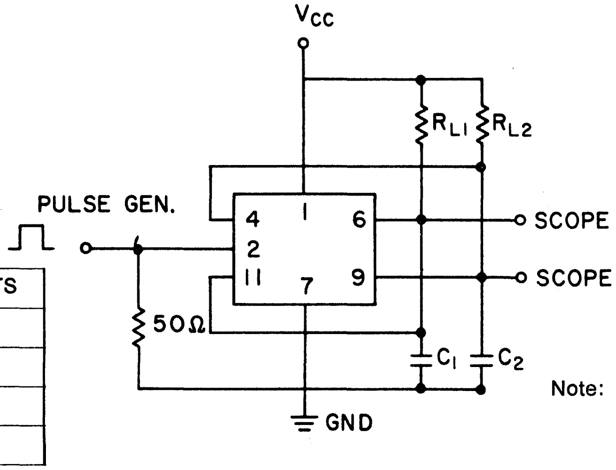
	504	534	574	580	540	541	UNITS
R_{L1}	4.2	1.4	0.47	0.15	0.45	0.45	KΩ
R_{L2}	40	10	3.9	0.51	1.53	1.53	KΩ
C_1	10	10	50	500	500	500	pf
C_2	10	10	30	500	500	500	pf

Note: C_1, C_2 Include Probe & Jig Capacitance
Allocate 10 pf for Probe & Jig Capacitance

T_{ON}, T_{OFF}
509, 539, 579

$V_{threshold}$:

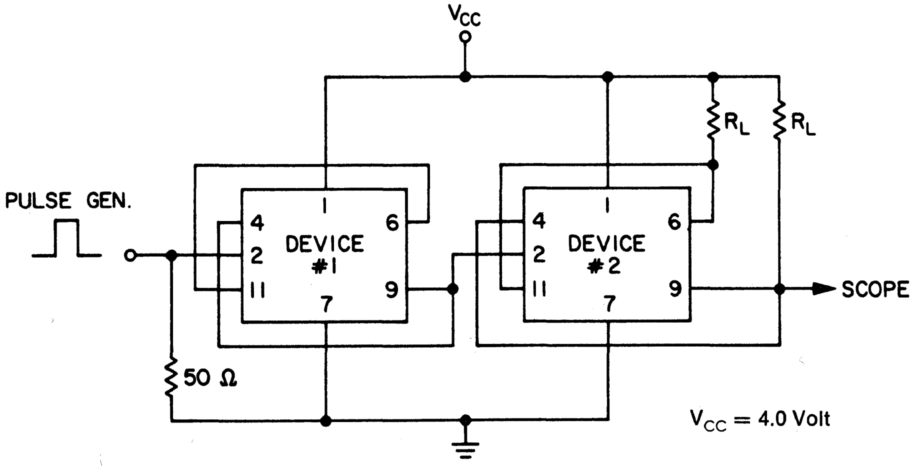
-55°C	25°C	125°C
1.8 V	1.5 V	1.2 V



	509	539	579	UNITS
R_{L1}	4.2	1.4	0.4	KΩ
R_{L2}	60	10	3.9	KΩ
C_1	10	10	30	pf
C_2	10	10	30	pf

Note: C_1, C_2 Include Probe & Jig Capacitance
Allocate 10 pf for Probe & Jig Capacitance

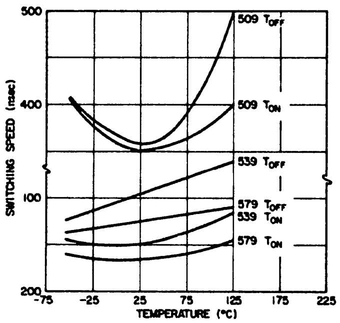
CLOCK RATE
509, 539, 579

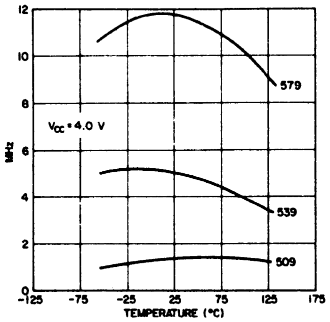


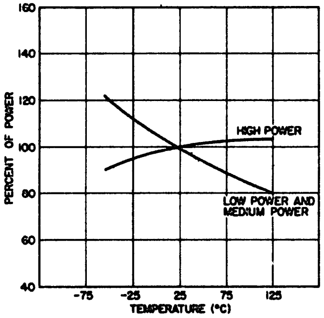
	R_L
509	10 KΩ
539	3 KΩ
579	1 KΩ

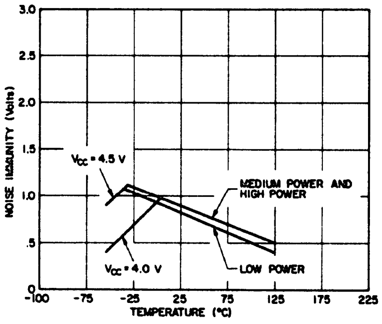
V_{CC} = 4.0 Volt

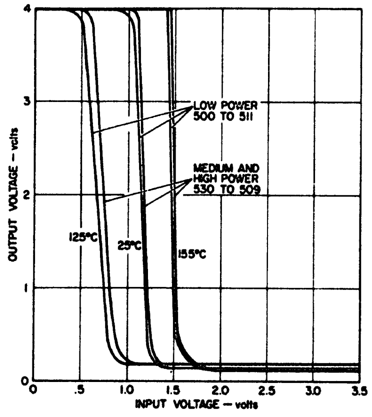
Printed in U.S.A.


SWITCHING SPEEDS vs TEMPERATURE


FLIP-FLOP CLOCK RATE vs TEMPERATURE


VARIATION OF POWER REQUIREMENTS vs TEMPERATURE


NOISE IMMUNITY vs TEMPERATURE


INPUT/OUTPUT TRANSFER CHARACTERISTICS vs TEMPERATURE

DIGITAL CIRCUITS
ULTRA LOW POWER LOGIC

FEBRUARY 1969

525B
526B
527B
528B
529B

The Amelco 520 Ultra Low Power Logic series is specifically designed for critical space applications requiring the ultimate in performance with speed/power as a figure of merit. All devices are fabricated on a single monolithic substrate using Planar epitaxial processes. Critical visual screening and 100% electrical testing over the entire military temperature range insure a product guaranteed to meet the most exacting reliability requirements. Pin and function compatibility with 9040 Logic enable reduction in system power with no mechanical redesign.

ULTRA LOW POWER LOGIC ELEMENTS

525B Quad Two Input Gate
526B Dual Three Input Gate w/ex
527B Dual Four Input Gate
528B Dual Three Input Gate
529B JK Flip Flop

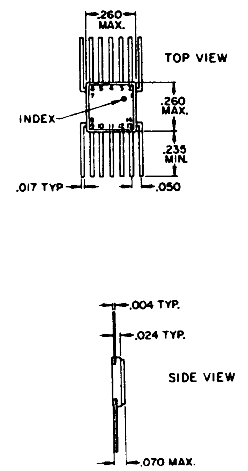
ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to +150°C
Operating Temperature	−55°C to +125°C
Maximum Voltage (Supply)	+6.8 Volts
Maximum Voltage (Input)	+6.8 Volts
Maximum Neg. Voltage	−0.5 Volts

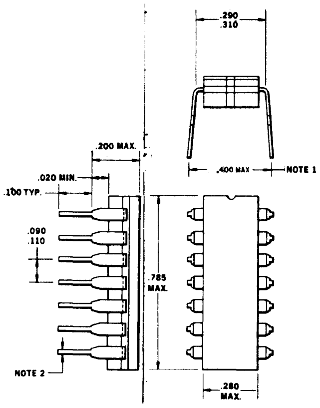
POWER DISSIPATION

	PER GATE		TOTAL		
	TYP.	MAX.	TYP.	MAX.	UNITS
525BH	220	280	885	1120	μw
526BH	220	280	440	560	μw
527BH	220	280	440	560	μw
528BH	220	280	440	560	μw
529BH			380	480	μw

H PACKAGE

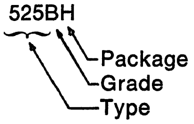


N PACKAGE



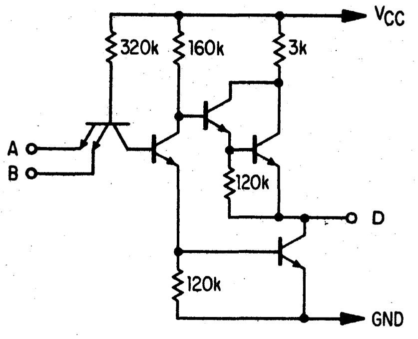
NOTES:
1 Leads are intended for insertion in hole rows on .300" centers. Shipment carriers hold lead on .310 center.

Complete part number designation consist of three digits and two letters, for example:

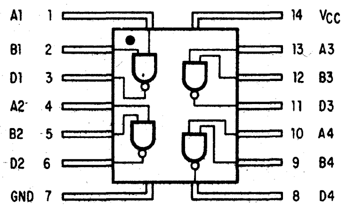


525B QUAD TWO INPUT GATE

SCHEMATIC (EACH GATE)



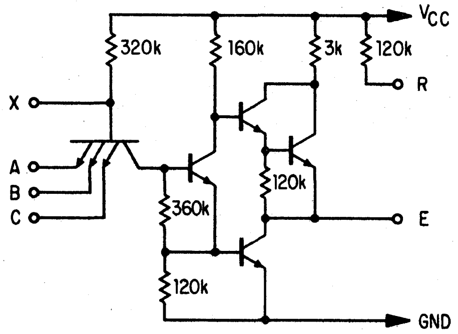
LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



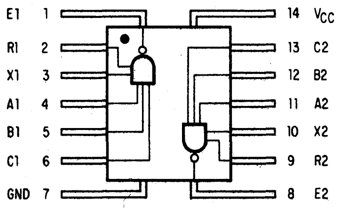
LOADING
INPUT — 1 UL
OUTPUT — 8 UL

526B DUAL THREE INPUT GATE w/ex

SCHEMATIC (EACH GATE)



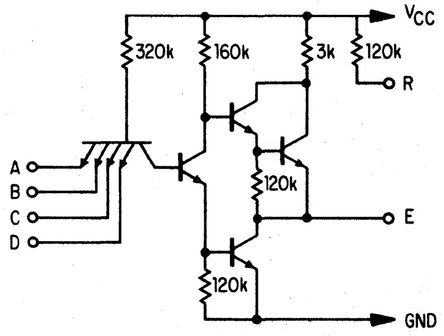
LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



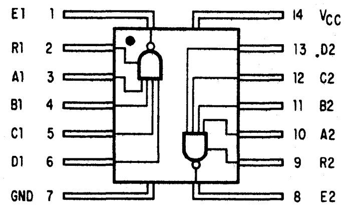
LOADING
INPUT — 1 UL
OUTPUT — 8 UL

527B DUAL FOUR INPUT GATE

SCHEMATIC (EACH GATE)



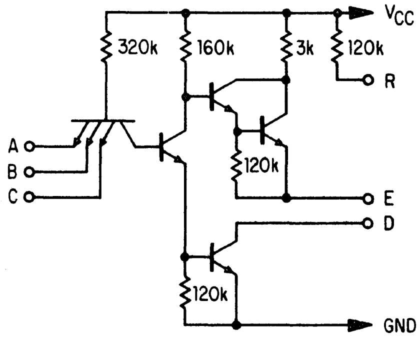
LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



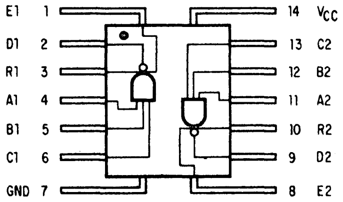
LOADING
INPUT — 1 UL
OUTPUT — 8 UL

528B DUAL THREE INPUT GATE

SCHEMATIC (EACH GATE)

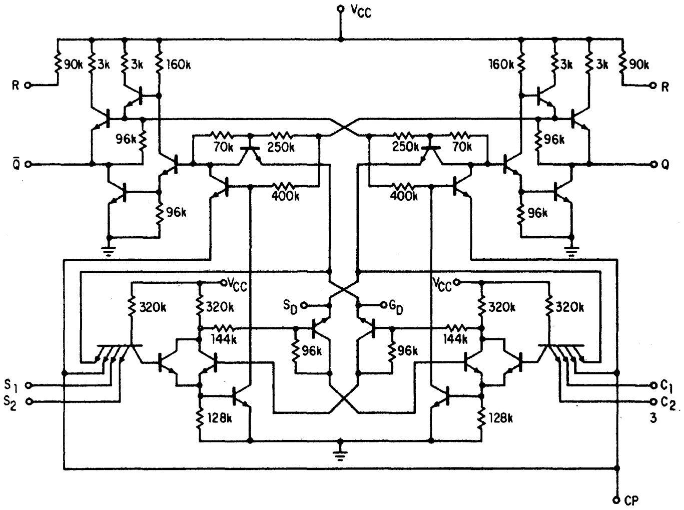


LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE

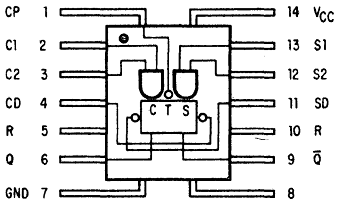


LOADING
INPUT — 1 UL
OUTPUT — 8 UL

529B JK FLIP FLOP



LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



LOADING
$S_1 \bullet S_2 \bullet C_1 \bullet C_2$ — 1 UL
$S_D \bullet C_D \bullet CP$ — 3 UL
OUTPUT — 8 UL

SYNCHRONOUS ENTRY JK MODE
PIN 6 = PIN 3, PIN 9 = PIN 12

S_1	C_1	Q^{n+1}	$\bar{Q}^{n+1}$
L	L	NC	NC
L	H	L	H
H	L	H	L
H	H	Toggles	

ASYCHRONOUS ENTRY

S	C	Q	$\bar{Q}$
H	H	NC	NC
H	L	L	H
L	H	H	L
L	L	H	H

SYNCHRONOUS ENTRY R-S MODE

S	S	C	C	Q^{n+1}	$\bar{Q}^{n+1}$
L	X	L	X	NC	NC
L	X	X	L	NC	NC
X	L	L	X	NC	NC
X	L	X	L	NC	NC
L	X	H	H	L	H
X	L	H	H	L	H
H	H	L	X	H	L
H	H	X	L	H	L
H	H	H	H	Ambiguous	

SYMBOLS
H—most positive logic level
L—most negative logic level
X—either H or L can be present
NC—no change in state

ELECTRICAL CHARACTERISTICS AT 25°C (unless otherwise noted)

TEST LIMITS	−55°C	+25°C	+125°C	UNITS
V_{OL}	250	200	200	mv max
V_{OH}	2.4	2.7	2.5	volts min
I_A	16	16	16	µA min
I_A	130	90	70	µA max
I_{INL}	37	26	20	µA max
I_{INL} (DS & CP)	111	78	60	µA max
I_{INH}	6	4	6	µA max
I_{INH} (DS & CP)	12	8	12	µA max
I_{VCC} (525)	360	280	280	µA max
I_{VCC} (526)	180	140	140	µA max
I_{VCC} (527)	180	140	140	µA max
I_{VCC} (528)	180	140	140	µA max
I_{VCC} (529)	200	160	160	µA max
T_{PD}		1		µsec max
T_{ON}(525,527,528)		0.6		µsec typ
T_{ON}(525,527,528)		1.5		µsec max
T_{OFF}(525,527,528)		0.1		µsec typ
T_{OFF}(525,527,528)		0.5		µsec max
T_{ON}(526)		1.2		µsec typ
T_{ON}(526)		2.3		µsec max
T_{OFF}(526)		0.2		µsec typ
T_{OFF}(526)		0.7		µsec max
T_{ON}(529)		0.4		µsec typ
T_{ON}(529)		1.5		µsec max
T_{OFF}(529)		0.4		µsec typ
T_{OFF}(529)		1.5		µsec max
FAN OUT[1]	8	10	8	minimum

TEST CONDITIONS

V_{CC}	5	5	5	volts
V_{INL}	.8	.8	.55	volts
V_{INH}	2.0	1.7	1.6	volts
I_{OL}	300	260	160	µA
I_{OH}	60	60	100	µA

FEBRUARY 1969

DIGITAL CIRCUIT
LOW POWER DTL LOGIC

6040
6041
6042
6046

The Amelco 6040 Low Power Logic series is designed to be a direct replacement for the 9040 logic series. All devices are identical except for the 6040 flip flop which has improved noise immunity on the set and clear inputs now equal to the noise immunity on the logic inputs. All other functions are identical. For a lower power version (280 μw/gate maximums) which is directly interchangeable on a family basis see the Ultra Low Power Logic data sheet 525 thru 529. The 6044 (9044) and 6047 (9047) are also now available as compatible members of this logic family.

LOW POWER DTL LOGIC ELEMENTS

6040 Clocked Flip Flop
6041 Dual Three Input Nand Gate
6042 Dual Three Input Nand Gate with Extender Inputs
6046 Quad Two Input Gate

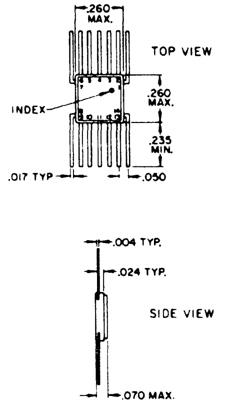
ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to +150°C
Operating Temperature	−55°C to +125°C
Maximum Voltage (Supply)	+8.0 Volts
Maximum Voltage (Input)	+8.0 Volts
Maximum Neg. Voltage	−0.5 Volts

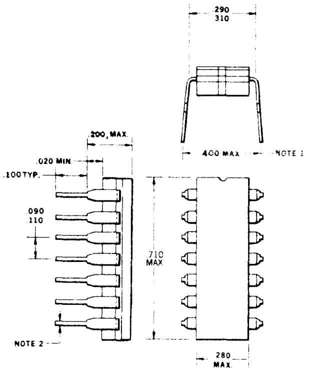
POWER DISSIPATION ($V_{CC} = 5.0$ Volts)

	PER GATE		TOTAL		
TYPE	TYP.	MAX.	TYP.	MAX.	UNITS
6040B			3.5	5.5	mw
6041B	1.38	1.94	2.75	3.87	mw
6042B	1.38	1.94	2.75	3.87	mw
6046B	1.38	1.94	5.5	7.75	mw

H PACKAGE



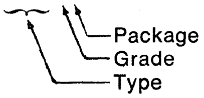
N PACKAGE



NOTES:
1 Leads are intended for insertion in hole rows in .300" centers. Shipment carriers hold lead on .310 center.
2 Bord drilling dimensions should equal your practice for a conventional .020 inch diameter lead.

Complete part number designation consists of four digits and two letters, for example:

6040BH



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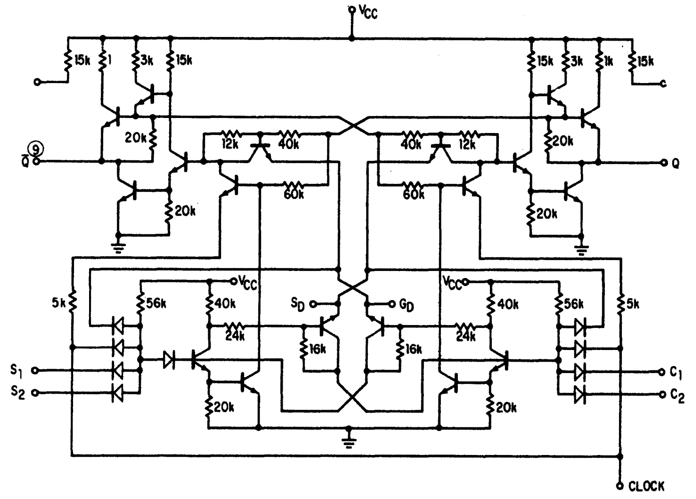
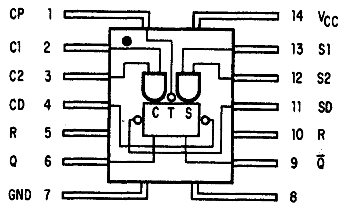
TYPE 6040 CLOCKED FLIP FLOP

The 6040 flip flop is a direct coupled dual rank flip flop designed to be a direct replacement for the 9040 flip flop. The design is identical to the 9040, except on the direct set and reset input where the noise immunity is now as good as the logic inputs. For a lower power replacement see the Amelco 529B.



LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



LOADING

$S_1 \cdot S_2 \cdot C_1 \cdot C_2$ — .75 UL
$S_D \cdot C_D \cdot CP$ — 2.5 UL
OUTPUT — 10 UL (Note 1)

SYNCHRONOUS ENTRY JK MODE
PIN 6 = PIN 3, PIN 9 = PIN 12

S_1	C_1	Q^{n+1}	$\overline{Q}^{n+1}$
L	L	NC	NC
L	H	L	H
H	L	H	L
H	H	Toggles	

ASYCHRONOUS ENTRY

S	C	Q	$\overline{Q}$
H	H	NC	NC
H	L	L	H
L	H	H	L
L	L	H	H

SYNCHRONOUS ENTRY R-S MODE

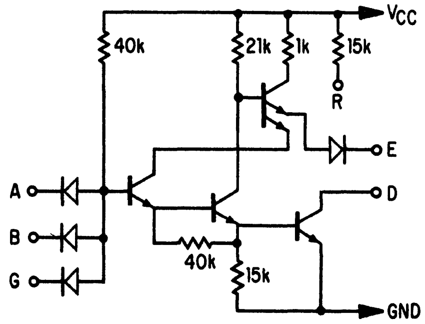
S	S	C	C	Q^{n+1}	$\overline{Q}^{n+1}$
L	X	L	X	NC	NC
L	X	X	L	NC	NC
X	L	L	X	NC	NC
X	L	X	L	NC	NC
L	X	H	H	L	H
X	L	H	H	L	H
H	H	L	X	H	L
H	H	X	L	H	L
H	H	H	H	Ambiguous	

SYMBOLS
H—most positive logic level
L—most negative logic level
X—either H or L can be present
NC—no change in state

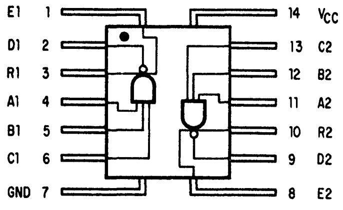
TYPE 6041 DUAL THREE INPUT NAND GATE—"OR" ABLE OUTPUT

This device is identical to and a direct replacement for the 9041 gate. For a lower power replacement see the Amelco 528B.

SCHEMATIC



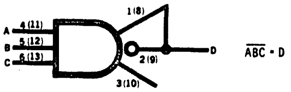
LOGIC DIAGRAM AND PIN CONNECTIONS
H AND N PACKAGE



LOADING
INPUT — 1 UL
OUTPUT — 10 UL (Note 1)

6041 (cont'd.)

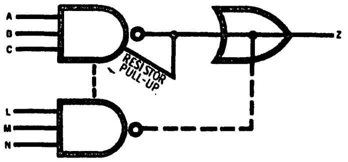
LOGIC SYMBOL



Either the emitter follower or resistor pull-up must be connected to the output to establish the high level μ.

"OR"ING RULES

Wired 'OR' Application



$\overline{ABC + DEF + \ldots . + LMN} = Z$

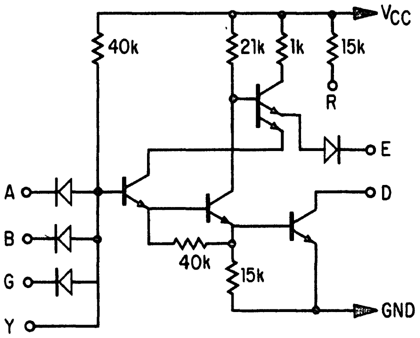
Output fan-out=10 - 3 (No. of resistor pull-ups)

One pull-up resistor is required for every 8 gates connected to the common "OR" node.

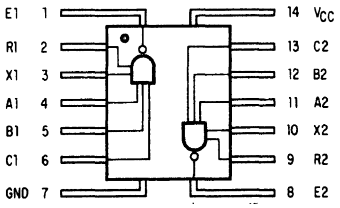
6042 DUAL 3 INPUT NAND GATE WITH EXTENDER INPUTS

This device is identical to and a direct replacement for the 9042. For a lower power replacement see the Amelco 526B.

SCHEMATIC



LOGIC DIAGRAM AND PIN CONNECTION
H AND N PACKAGES

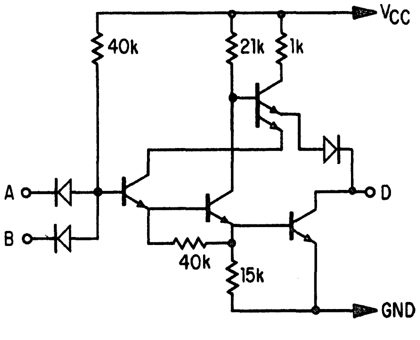


LOADING
INPUT — 1 UL
OUTPUT — 10 UL (Note 1)

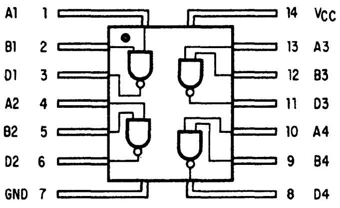
6046 QUAD 2 INPUT NAND GATE

This device is identical to and a direct replacement for the 9046. For a lower power replacement see the Amelco 525B.

SCHEMATIC



LOGIC DIAGRAM AND PIN CONNECTION
H AND N PACKAGES

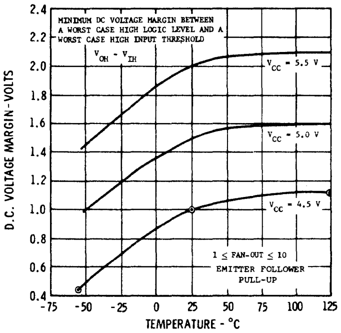


LOADING
INPUT — 1 UL
OUTPUT — 10 UL (Note 1)

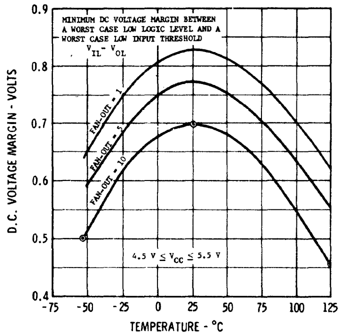
ELECTRICAL CHARACTERISTICS AT 25°C (unless otherwise noted)

TEST LIMITS	V_{CC}	−55°C	+25°C	+125°C	UNITS
V_{OL}	4.5 V to 5.5 V	0.2	0.2	0.2	Volts max
V_{OH}	4.5 V	2.45	2.70	2.50	Volts min
I_{INL}(1 UL)	5.0	1.58	160	146	μA max
¾ I_{INL}(6040 S & C)	5.0	118	120	110	μA max
2.5 I_{INL}(6040 SD, CR)	5.0	395	400	365	μA max
I_{INH}	5 V	1.0	1.0	5.0	μA max
I_{CC} (6040)	5 V	1.100	1.100	1.350	mA max
I_{CC} (6041)	5 V	0.775	0.775	0.820	mA max
I_{CC} (6042)	5 V	0.775	0.775	0.820	mA max
I_{CC} (6046)		1.550	1.550	1.640	mA max
TEST CONDITIONS					
V_{INL}		0.7	0.9	0.7	Volts
V_{INH}		2.0	1.7	1.4	Volts
I_{OL}		1.58	1.60	1.46	mA
I_{OH}		60	60	100	μA

"ONE" STATE NOISE IMMUNITY



"ZERO" STATE NOISE IMMUNITY

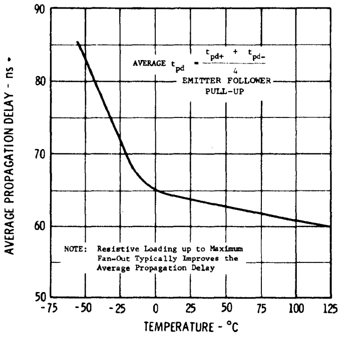


CONDITIONS

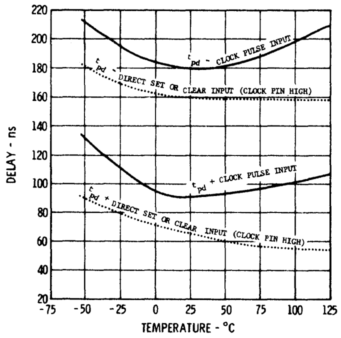
V_{CC}=5.0 V, C_l=50 pF
(Including probe
and jig capacity)

$V_{MEASURE}$ (Gnd. Ref.) 1.6 V @ −55°C
1.3 V @ +25°C
0.9 V @ +125°C

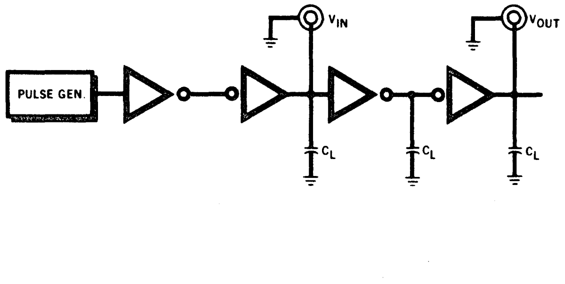
AVERAGE PROPAGATION DELAY
6041 • 6042 • 6046



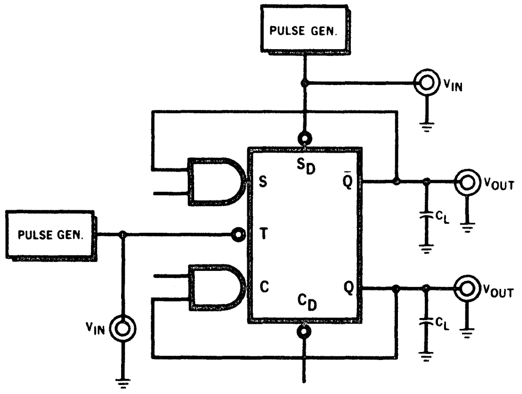
TYPICAL DELAY CHARACTERISTICS



TEST CIRCUIT



TEST CIRCUIT

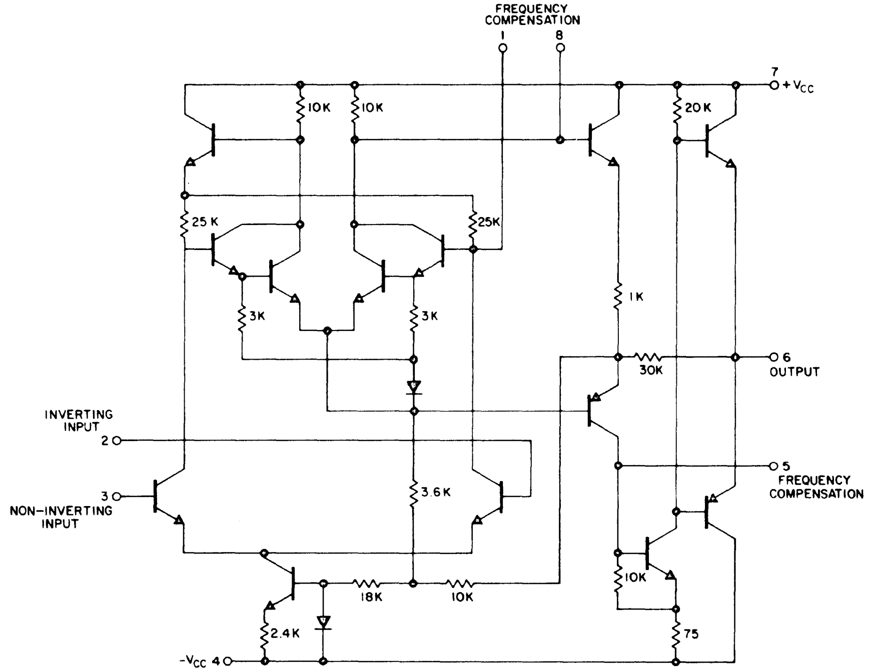


JANUARY 1968

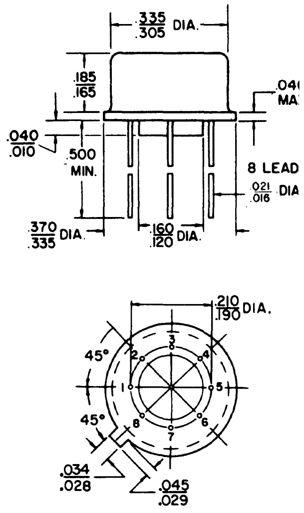
LINEAR CIRCUIT OPERATIONAL AMPLIFIER

709

The Amelco 709 operational amplifier is designed for high performance applications and features silicon planar epitaxial construction on a single monolithic substrate. Outstanding electrical characteristics include low offset voltage and current, high input impedance, high common mode input range, and exceptional thermal stability.



E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO C

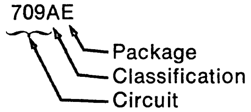
For J, N or H packages, se microcircuit package page

ABSOLUTE MAXIMUM RATINGS

Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C
Lead Soldering Temperature (60 sec.)	300°C
Power Dissipation (Note 1.)	300 mW
Supply Voltage	±18 V
Input Voltage	±10 V
Differential Input Voltage	±5 V
Output Short-Circuit Duration ($T_A = 25°C$)	5 sec.

Note 1. Rating applies for case temperatures to +125°C, derate linearly at 5.6 mW/°C for ambient temperatures above +95°C.

Complete part number desi nation consists of three digi and two letters, for exampl



Contact nearest Amelco Sales Office for C (0° to 70°C) devices.

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

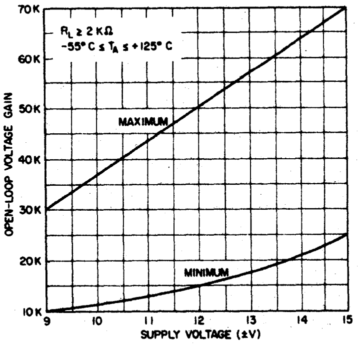
ELECTRICAL CHARACTERISTICS ($T_A = +25°C$, $\pm 9\ V < V_{CC} < \pm 15\ V$ unless otherwise specified)

PARAMETER	709A			709B			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain (Note 2)							
$V_{CC} = \pm 15\ V$, $R_L \geqq 2\ K\Omega$, $V_{OUT} = \pm 10\ V$	25K	45K	70K	25K	45K	70K	
Input Offset Voltage							
$R_S \leqq 1.0\ K\Omega$		0.5	1.0				mV
$R_S \leqq 10\ K\Omega$		0.5	1.5		1.0	5.0	
Input Offset Voltage (Note 2)							
$R_S \leqq 1.0\ K\Omega$			2.0				mV
$R_S \leqq 10\ K\Omega$						6.0	
Average Input Offset Voltage Drift (Note 2)							
$R_S = 50\Omega$		3.0	10		3.0		μV/°C
$R_S \leqq 10\ K\Omega$		6.0			6.0		
Input Bias Current		100	200		200	500	nA
Input Bias Current							
$T_A = -55°C$		0.25	0.75		0.5	1.5	μA
Input Offset Current		10	50		50	200	nA
Input Offset Current							
$T_A = +125°C$		10	50		20	200	nA
$T_A = -55°C$		50	250		100	500	
Input Offset Current Drift							
125°C to 25°C			0.5				nA/°C
+25°C to −55°C			2.8				
Input Resistance	350	400		150	400		K ohms
Input Resistance (Note 2)	40	100		40	100		K ohms
Common Mode Voltage Range							
$V_{CC} = \pm 15\ V$, (Note 2)	±8.0	±10		±8.0	±10		V
Common Mode Rejection Ratio							
$R_S \leqq 10\ K\Omega$ (Note 2)		−90	−80		−90	−70	db
Power Supply Rejection Ratio							
$R_S \leqq 10\ K\Omega$ (Note 2)		25	100		25	150	μV/V
Output Resistance		150			150		Ohms
Output Voltage Swing							
$V_{CC} = \pm 15\ V$, $R_L \geqq 10\ K\Omega$	24	28		24	28		V_{p-p}
$V_{CC} = \pm 15\ V$, $R_L \geqq 2.0\ K\Omega$	20	26		20	26		
Power Consumption							
$V_{CC} = \pm 15\ V$		80	108		80	165	mW
Transient Response							
$V_{in} = 20\ mV$, $R_L = 2.0\ K\Omega$, $R_1 = 1.5\ K\Omega$, $R_2 = 50\Omega$							
$C_1 = 5000\ pf$, $C_2 = 200\ pf$, $C_L \leqq 100\ pf$							
Rise Time		0.3	1.0		0.3	1.0	μsec
Overshoot		10	30		10	30	%

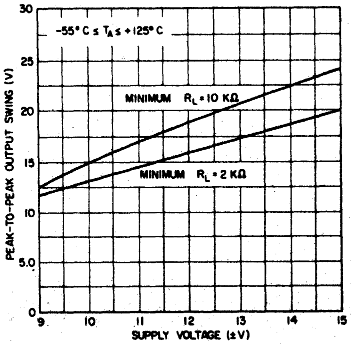
NOTE 2. The Electrical Specifications apply for the Temperature Range of −55°C to +125°C.

GUARANTEED ELECTRICAL CHARACTERISTICS

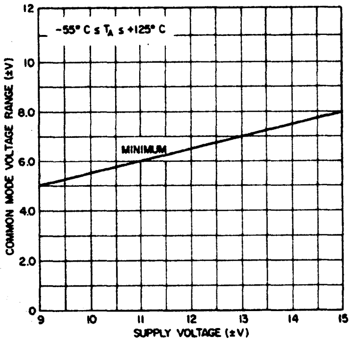
Voltage Gain

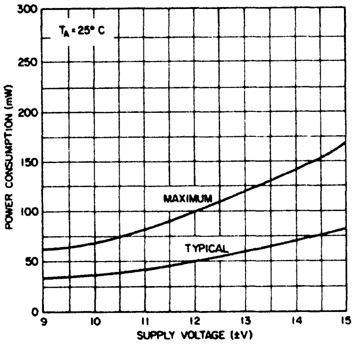


Output Voltage Swing

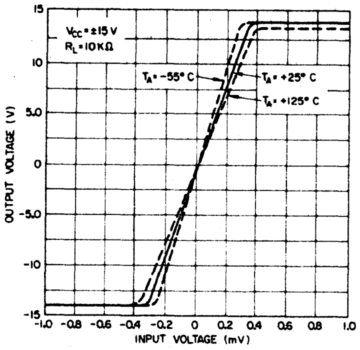


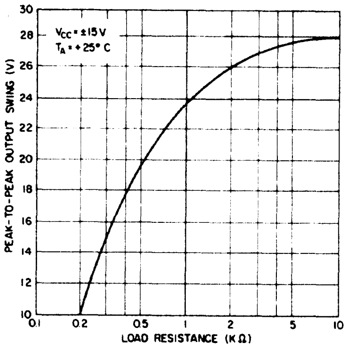
GUARANTEED ELECTRICAL CHARACTERISTICS (Cont)

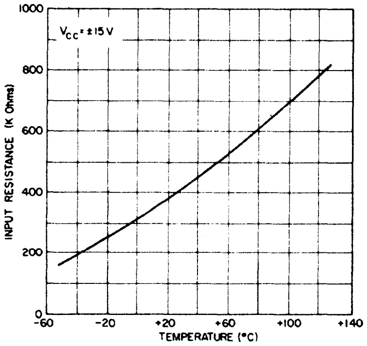

Input Common Mode
Voltage Range

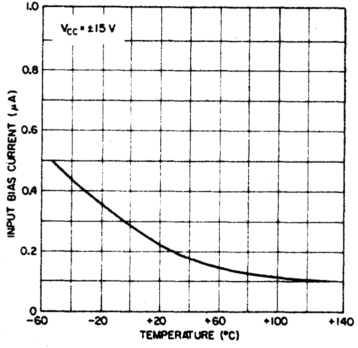

Power Consumption

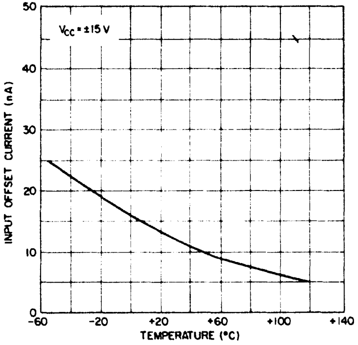
TYPICAL PERFORMANCE CURVES

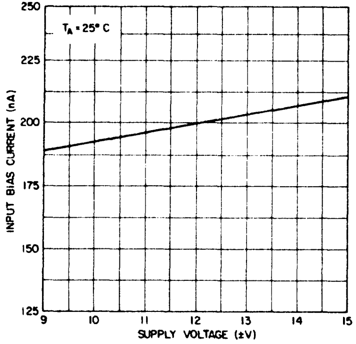

Voltage Transfer
Characteristic

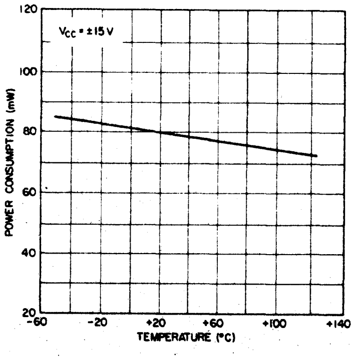

Output Voltage
Swing as a Function of
Load Resistance


Input Resistance
as a Function of
Amibent Temperature

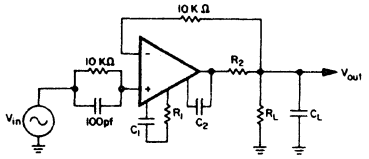

Input Bias Current
as a Function of
Ambient Temperature

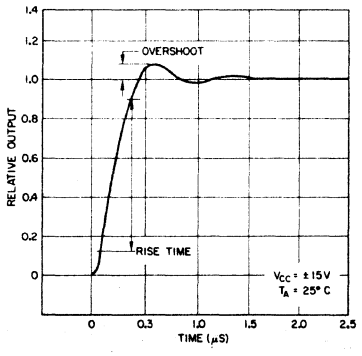

Input Offset Current
as a Function of
Ambient Temperature


Input Bias Current
as a Function of
Supply Voltage


Power Consumption
as a Function of
Ambient Temperature

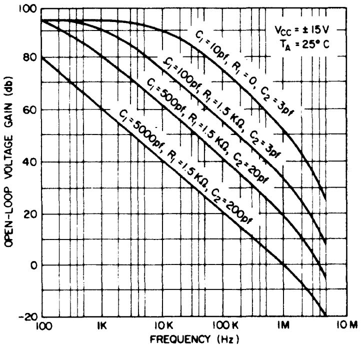
Transient Response Test Circuit



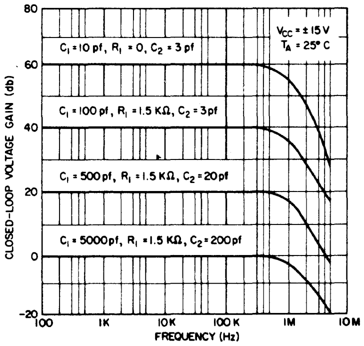

Transient Response

TYPICAL PERFORMANCE CURVES (Cont)

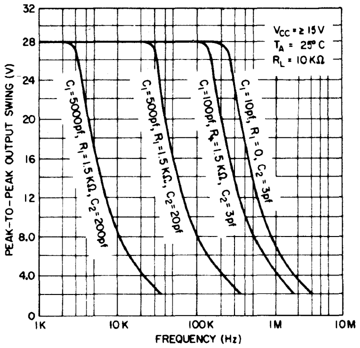
Open-Loop Frequency
Response for Various
Values of Compensation



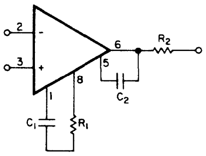
Frequency
Response for Various
Closed-Loop.Gains



Output Voltage
Swing as a Function of
Frequency for Various
Compensation Networks



Frequency
Compensation
Circuit



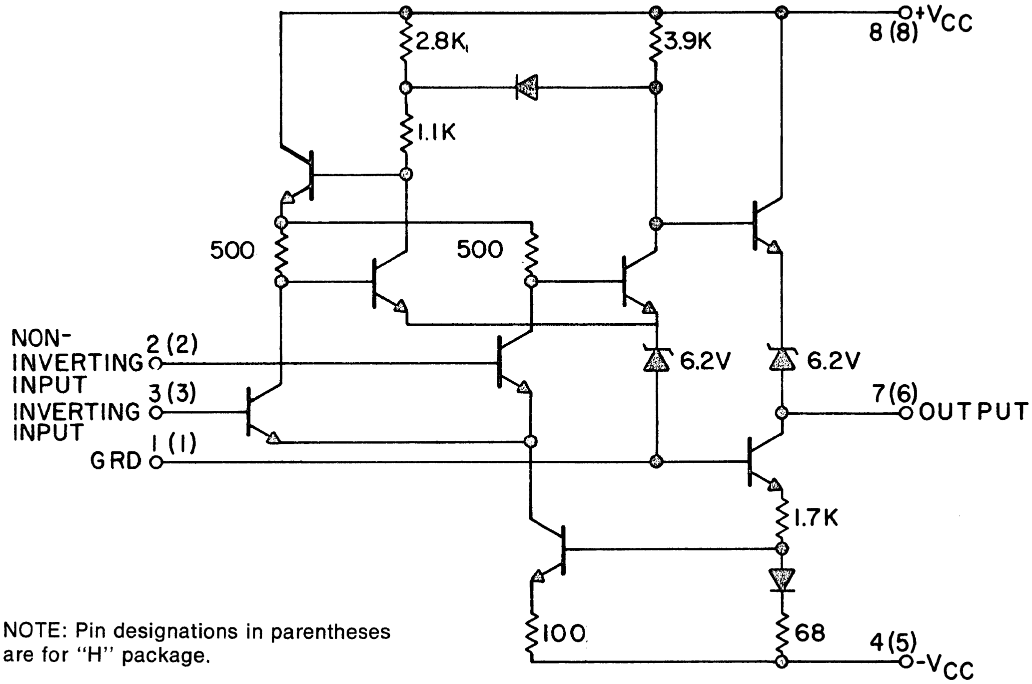
*Use R_2 = 50Ω when the amplifier is operated with capacitive loading.

JANUARY 1968

LINEAR CIRCUIT
DIFFERENTIAL COMPARATOR

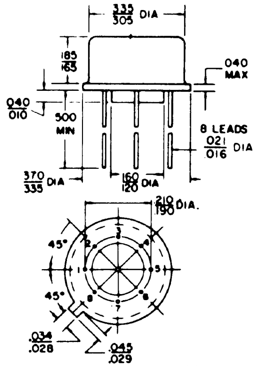
710

The Amelco 710 is a Differential Voltage Comparator featuring silicon planar epitaxial construction on a single monolithic substrate. Outstanding electrical characteristics include high accuracy, fast response times, large input voltage range, low power dissipation, adjustable threshold voltages, and very low offsets.



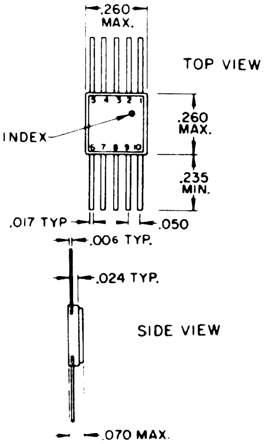
NOTE: Pin designations in parentheses are for "H" package.

E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO CASE

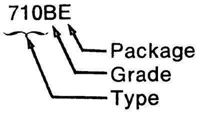
H PACKAGE



ABSOLUTE MAXIMUM RATINGS

	710B	710C
Operating Temperature Range	−55°C to +125°C	0°C to 70°C
Storage Temperature Range	−65°C to +150°C	
Lead Temperature, 1/16 inch from case, 60 seconds maximum.	300°C	
Internal Power Dissipation TO-99 (Note 1)	300mW	
Differential Input Voltage	±5.0 V	
Input Voltage	±7.0 V	
Positive Supply Voltage	+14 V	
Negative Supply Voltage	−7.0 V	
Peak Output Current	10 mA	

Complete part number designation consists of three digits and two letters, for example:



AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

ELECTRICAL CHARACTERISTICS ($T_A = 25°C$, $+V_{CC} = +12V$, $-V_{CC} = -6.0V$, Unless Otherwise Specified)

PARAMETER	710B			710C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Voltage Gain	1250	1700		1000	1500		
Voltage Gain (Note 2)	1000			800			
Input Offset Voltage (Note 3) $R_S \le 200\Omega$		0.6	2.0		1.6	5.0	mV
Input Offset Voltage (Note 2 and 3) $R_S \le 200\Omega$			3.0			6.5	mV
Input Offset Voltage Drift $R_S = 50\Omega$ $T_A = 25°C$ to $125°C$ $T_A = +25°C$ to $-55°C$ $T_A =$ (Note 2)		 3.5 2.7	 10 10		 5.0	 20	µV/°C
Input Bias Current $T_A = -55°C$ $T_A = 0°C$		13 27	20 45		16 25	25 40	µA
Input Offset Current (Note 3) $T_A = 125°C$ $T_A = -55°C$ $T_A =$ (Note 2)		0.75 0.25 1.8	3.0 3.0 7.0		1.8	5.0 7.5	µA
Input Offset Current Drift $T_A = 25°C$ to $125°C$ $T_A = +25°C$ to $-55°C$ $T_A = 25°C$ to $70°C$ $T_A = 25°C$ to $0°C$		 5.0 15	 25 75		 15 24	 50 100	nA/°C
Input Voltage Range (Note 2) $-V_{CC} = -7.0$ V	±5.0			±5.0			Volts
Differential Input Voltage Range (Note 2)	±5.0			±5.0			Volts
Common Mode Rejection Ratio (Note 2)		−100	−80		−98	−70	Volts
Response Time (Note 4)		40			40		nsec.
Positive Output Level $V_{IN} \ge 5.0$ mV, $I_o = 5.0$ mA (Note 2)	2.5	3.2	4.0	2.5	3.2	4.0	Volts
Negative Output Level $V_{IN} \ge 5.0$ mV (Note 2)	−1.0	−0.5		−1.0	−0.5		Volts
Output Resistance		200			200		Ohms
Output Sink Current $V_{IN} \ge 5.0$ mV, $V_{OUT} = 0$ V $T_A = 125°C$ $T_A = -55°C$ $T_A =$ (Note 2)	 2.0 0.5 1.0	 2.5 1.7 2.3		 1.6 0.5	 2.5		mA
Positive Supply Current $V_{OUT} \le 0$ V, (Note 2)		5.2	9.0		5.2	9.0	mA
Negative Supply Current (Note 2)		4.6	7.0		4.6	7.0	mA
Power Dissipation		90	150		90	150	mW

NOTES:
1. Rating applies for case temperatures to +125°C, derate linearly at 5.6 mW/°C for ambient temperatures above +105°C. For the 710C, rating applies for ambient temperatures to +70°C.
2. 710B, −55°C to +125°C; 710C, 0°C to +70°C.
3. The input offset voltage/current is specified for a logic threshold voltage of 1.8 V @ −55°C, 1.5 V @ 0°C, 1.4 V @ +25°C, 1.2 V @ +70°C, and 1.0 V @ +125°C.
4. The response time is for a 100mV input step with a 5.0 mV overdrive.

DEFINITIONS

VOLTAGE GAIN—The ratio of the change in output voltage to the change in voltage between the input terminals producing it with the DC output level in the vicinity of the logic threshold voltage.

INPUT OFFSET VOLTAGE—The voltage between the input terminals when the output is at the logic threshold voltage. The input offset voltage may also be defined for the case where two equal resistances are inserted in a series with the input leads.

INPUT BIAS CURRENT—The average of the two input currents.

INPUT OFFSET CURRENT—The difference in the currents into the two input terminals with the output at the logic threshold voltage.

INPUT VOLTAGE RANGE—The range of voltage on the input terminals for which the comparator will operate within specifications.

DIFFERENTIAL INPUT VOLTAGE RANGE—The range of voltage between the input terminals for which operation within specifications is assured.

INPUT COMMON MODE REJECTION RATIO—The ratio of the input voltage range to the maximum change in input offset voltage over this range.

RESPONSE TIME—The interval between the application of an input step function and the time when the output crosses the logic threshold voltage. The input step drives the comparator from some initial, saturated input voltage to an input level just barely in excess of that required to bring the output from saturation to the logic threshold voltage. This excess is referred to as the voltage overdrive.

POSITIVE OUTPUT LEVEL—The DC output voltage in the positive direction with the input voltage equal to or greater than a minimum specified amount.

NEGATIVE OUTPUT LEVEL—The DC output voltage in the negative direction with the input voltage equal to or greater than a minimum specified amount.

OUTPUT RESISTANCE—The resistance seen looking into the output terminal with the DC output level at the logic threshold voltage.

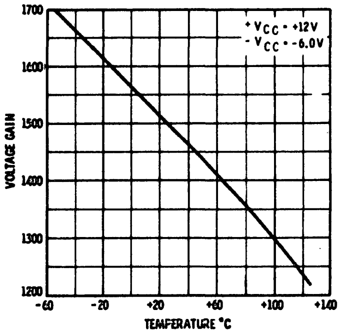
OUTPUT SINK CURRENT—The maximum negative current that can be delivered by the comparator.

PEAK OUTPUT CURRENT—The maximum current that may flow into the output load without causing damage to the comparator.

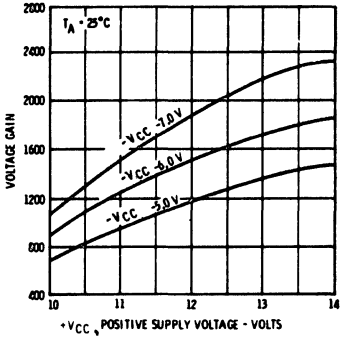
POWER DISSIPATION—The DC power into the amplifier with no output load. The DC power will vary with signal level, but is specified as a maximum for the entire range of input-signal conditions.

LOGIC THRESHOLD VOLTAGE—The approximate voltage at the output of the comparator at which the loading logic circuitry changes its digital state.

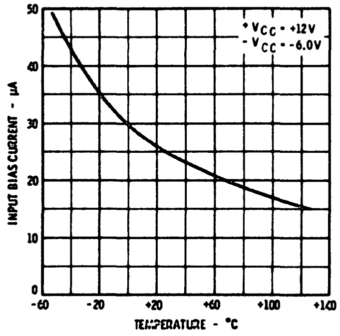
VOLTAGE GAIN
VS.
AMBIENT TEMPERATURE



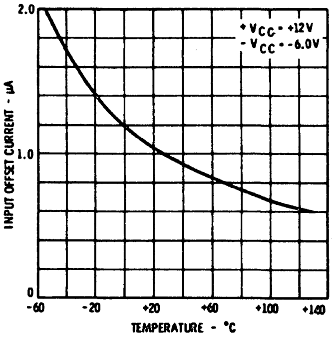
VOLTAGE GAIN
VS.
SUPPLY VOLTAGES



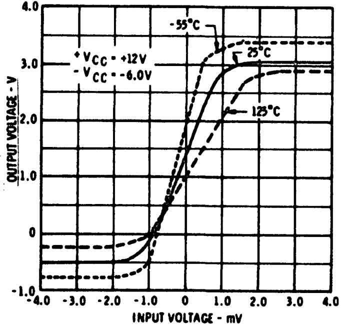
INPUT BIAS CURRENT
VS.
AMBIENT TEMPERATURE



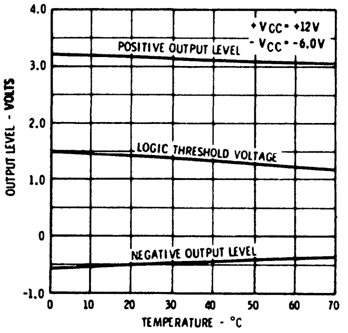
INPUT OFFSET CURRENT
VS.
AMBIENT TEMPERATURE



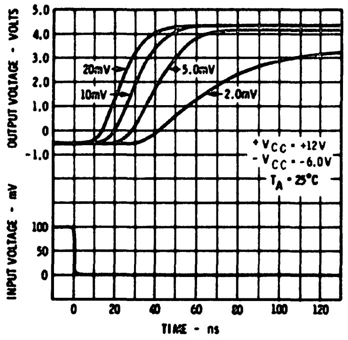
INPUT/OUTPUT
VOLTAGE TRANSFER
CHARACTERISTIC



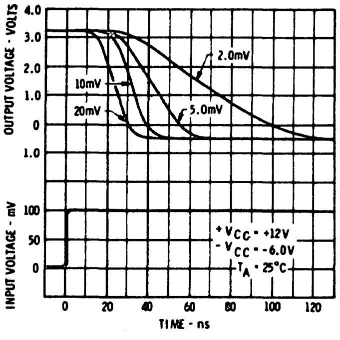
OUTPUT VOLTAGE LEVELS
VS.
AMBIENT TEMPERATURE



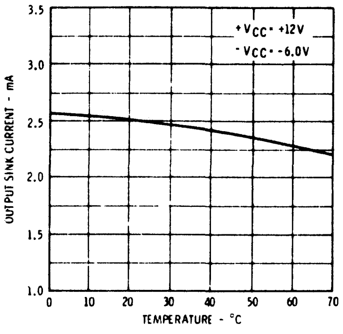
RESPONSE TIME
VS.
INPUT OVERDRIVES



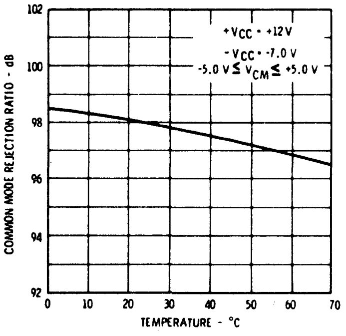
RESPONSE TIME
VS.
INPUT OVERDRIVES



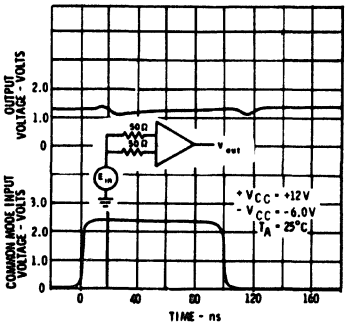
OUTPUT SINK CURRENT
VS.
AMBIENT TEMPERATURE



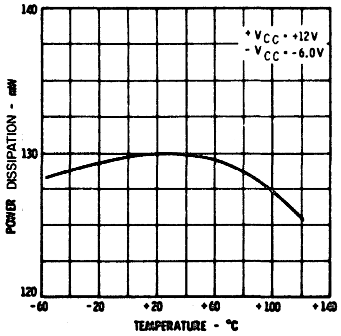
COMMON MODE REJECTION
RATIO VS.
AMBIENT TEMPERATURE



COMMON MODE
PULSE RESPONSE



POWER DISSIPATION
VS.
AMBIENT TEMPERATURE

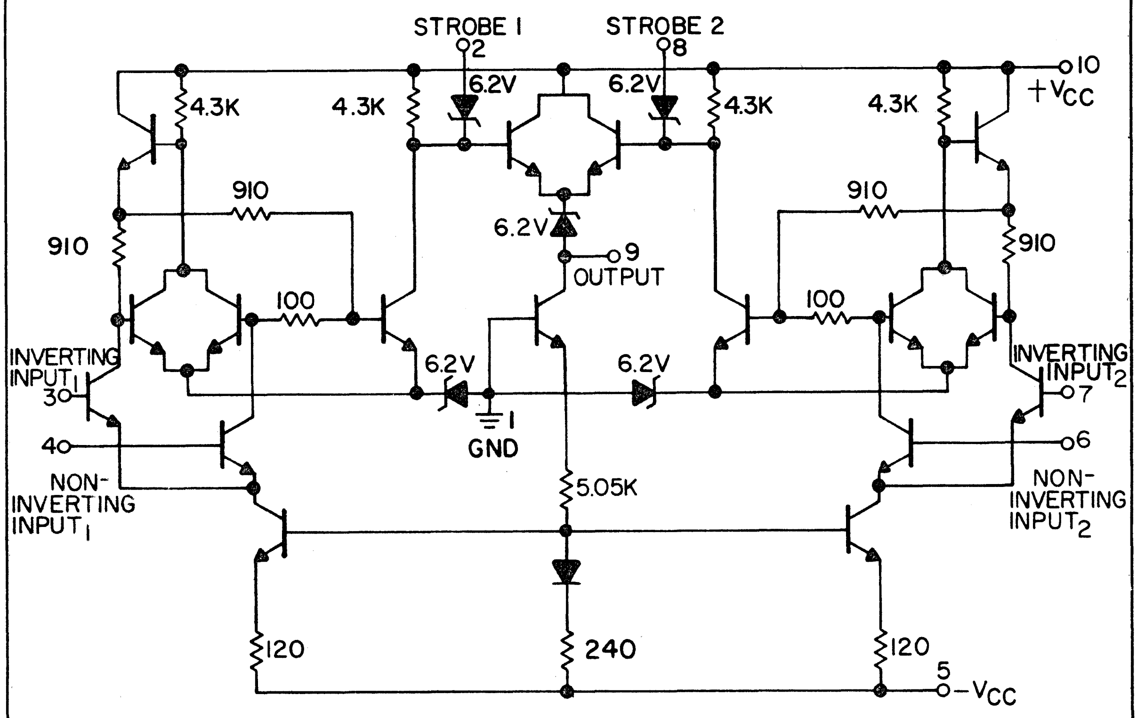


LINEAR CIRCUIT
DUAL
DIFFERENTIAL COMPARATOR

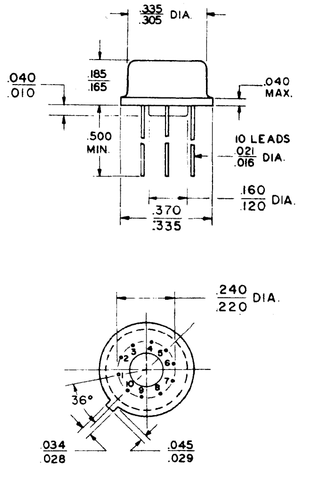
JANUARY 1968

711

The Amelco 711 is a dual Differential Voltage Comparator featuring silicon planar epitaxial construction on a single monolithic substrate. Outstanding electrical characteristics include high accuracy, fast response times, large input voltage range, low power dissipation, adjustable threshold voltages, and independent strobing of each comparator channel.



E PACKAGE

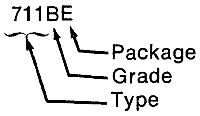


PIN 5 IS INTERNALLY CONNECTED TO CASE

ABSOLUTE MAXIMUM RATINGS

	711B	711C
Operating Temperature Range	−55°C to +125°C	0°C to 70°C
Storage Temperature Range	−65°C to +150°C	
Lead Temperature, 1/16 inch from case, 10 seconds max.	300°C	
Internal Power Dissipation (Note 1)	300mW	
Differential Input Voltage	±5.0 V	
Input Voltage	±7.0 V	
Strobe Voltage	0 to 6.0 V	
Positive Supply Voltage	+14 V	
Negative Supply Voltage	−7.0 V	
Peak Output Current	50 mA	

Complete part number designation consists of three digits and two letters, for example:



AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

ELECTRICAL CHARACTERISTICS ($T_A = 25°C$, $+V_{CC} = +12V$, $-V_{CC} = -6.0V$, Unless Otherwise Specified)

PARAMETER	711B			711C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Voltage Gain*	750	1500		700	1500		
Voltage Gain* (Note 2)	500			500			
Input Offset Voltage* $V_{OUT} = 1.4$ V, $R_S \leq 200\Omega$, $V_{CM} = 0$ $V_{OUT} = 1.4$ V, $R_S \leq 200\Omega$		 1.0 1.0	 3.5 5.0		 1.0 1.0	 5.0 7.5	mV
Input Offset Voltage* (Note 2) V_{OUT} (Note 3), $R_S = 200\Omega$, $V_{CM} = 0$ V_{OUT} (Note 3), $R_S = 200\Omega$			 4.5 6.0			 6.0 10	mV
Input Offset Voltage Drift* (Note 2)		5.0			5.0		μV/°C
Input Bias Current*		25	75		25	100	μA
Input Bias Current* (Note 2)			150			150	μA
Input Offset Current* $V_{OUT} = 1.4$ V		0.5	10		0.5	15	μA
Input Offset Current* $V_{OUT} =$ (Note 3) and (Note 2)			20			25	μA
Input Voltage Range* $-V_{CC} = -7.0$ V	±5.0			±5.0			Volts
Differential Input Voltage Range*	±5.0			±5.0			Volts
Response Time* (Note 4)		40			40		nsec
Strobe Release Time*		12			12		nsec
Positive Output Level* $V_{IN} \geq 10$ mV		4.5	5.0		4.5	5.0	Volts
Loaded Positive Output Level* $V_{IN} \geq 10$ mV, $I_O = 5.0$ mA	2.5	3.5		2.5	3.5		Volts
Negative Output Level* $V_{IN} \geq 10$ mV	−1.0	−0.5		−1.0	−0.5		Volts
Strobed Output Level* $V_{STROBE} \leq 0.3$ V	−1.0			−1.0			Volts
Output Resistance*		200			200		Ohms
Output Sink Current $V_{IN} \geq 10$ mV, $V_{OUT} = 0$	0.5	0.8		0.5	0.8		mA
Strobe Current $V_{STROBE} = 100$ mV		1.2	2.5		1.2	2.5	mA
Positive Supply Current $V_{OUT} \leq 0$		8.6			8.6		mA
Negative Supply Current		3.9			3.9		mA
Power Dissipation		130	200		130	230	mW

* These Specifications apply for either side with the other side disabled with the strobe.

NOTES:
1. Rating applies for case temperatures to +125°C; derate linearly at 5.6 mW/°C for ambient temperatures above +105°C. For the 711C, this rating applies for ambient temperatures to +70°C.
2. 711B, −55°C to +125°C; 711C, 0°C to 70°C.
3. The input offset voltage/current is specified for a logic threshold voltage of 1.8 V at −55°C, 1.5 V at 0°C, 1.4 V at +25°C, 1.2 V at +70°C, and 1.0 V at +125°C.
4. The response time is for a 100 mV input step with a 5.0 mV overdrive.

DEFINITIONS

VOLTAGE GAIN—The ratio of the change in output voltage to the change in voltage between the input terminals producing it with the DC output level in the vicinity of the logic threshold voltage.

INPUT OFFSET VOLTAGE—The voltage between the input terminals when the output is at the logic threshold voltage. The input offset voltage may also be defined for the case where two equal resistances are inserted in a series with the input leads.

INPUT BIAS CURRENT—The average of the two input currents.

INPUT OFFSET CURRENT—The difference in the currents into the two input terminals with the output at the logic threshold voltage.

INPUT VOLTAGE RANGE—The range of voltage on the input terminals for which the comparator will operate within specifications.

DIFFERENTIAL INPUT VOLTAGE RANGE—The range of voltage between the input terminals for which operation within specifications is assured.

RESPONSE TIME—The interval between the application of an input step function and the time when the output crosses the logic threshold voltage. The input step drives the comparator from some initial, saturated input voltage to an input level just barely in excess of that required to bring the output from saturation to the logic threshold voltage. This excess is referred to as the voltage overdrive.

STROBE RELEASE TIME—The time required for the output to rise to the logic threshold voltage after the strobe terminal has been driven from the zero to the one logic level. Appropriate input conditions are assumed.

POSITIVE OUTPUT LEVEL—The DC output voltage in the positive direction with the input voltage equal to or greater than a minimum specified amount.

NEGATIVE OUTPUT LEVEL—The DC output voltage in the negative direction with the input voltage equal to or greater than a minimum specified amount.

STROBED OUTPUT LEVEL—The DC output voltage, independent of input voltage, with the voltage on the strobe terminal equal to or less than a minimum specified amount.

OUTPUT RESISTANCE—The resistance seen looking into the output terminal with the DC output level at the logic threshold voltage.

OUTPUT SINK CURRENT—The maximum negative current that can be delivered by the comparator.

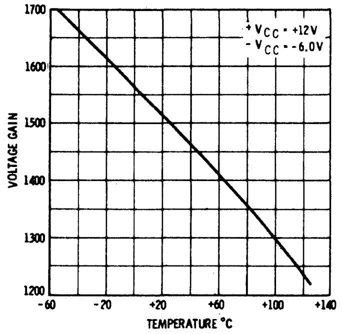
STROBE CURRENT—The maximum current drawn by the strobe terminal when it is at the zero logic level.

PEAK OUTPUT CURRENT—The maximum current that may flow into the output load without causing damage to the comparator.

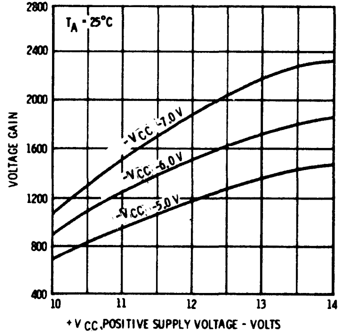
POWER DISSIPATION—The DC power into the amplifier with no output load. The DC power will vary with signal level, but is specified as a maximum for the entire range of input-signal conditions.

LOGIC THRESHOLD VOLTAGE—The approximate voltage at the output of the comparator at which the loading logic circuitry changes its digital state.

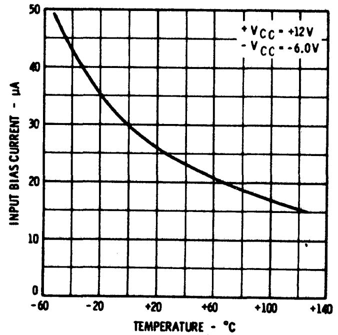
VOLTAGE GAIN
VS.
AMBIENT TEMPERATURE



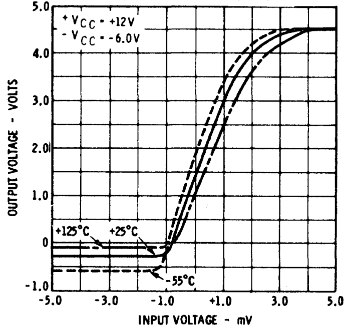
VOLTAGE GAIN
VS.
SUPPLY VOLTAGES



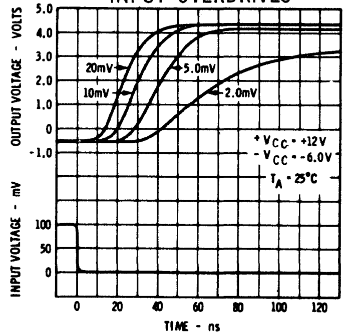
INPUT BIAS CURRENT
VS.
AMBIENT TEMPERATURE



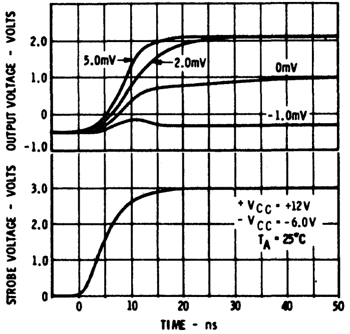
INPUT/OUTPUT
VOLTAGE
CHARACTERISTIC



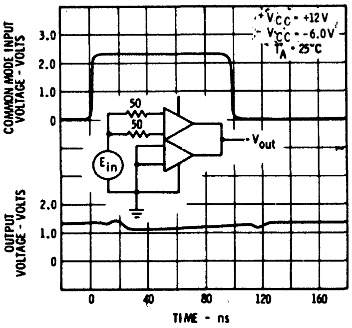
RESPONSE TIME
VS.
INPUT OVERDRIVES



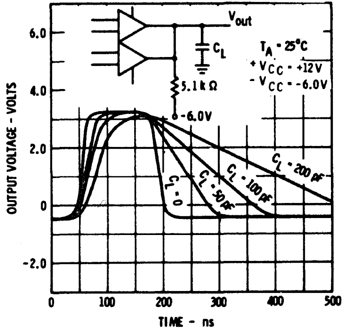
STROBE RELEASE TIME
VS.
INPUT OVERDRIVES



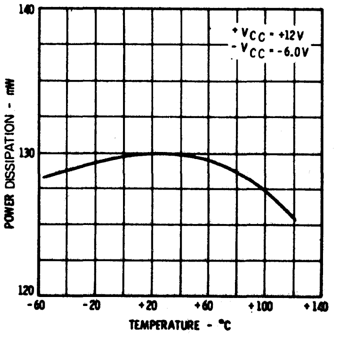
COMMON MODE
PULSE RESPONSE



OUTPUT PULSE STRETCHING
VS.
CAPACITIVE LOADING



POWER DISSIPATION
VS.
AMBIENT TEMPERATURE



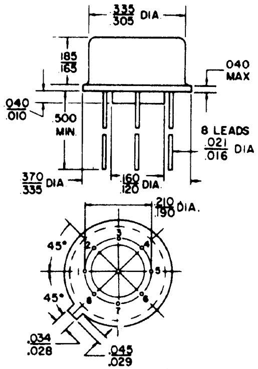
NOVEMBER 1968

LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

741

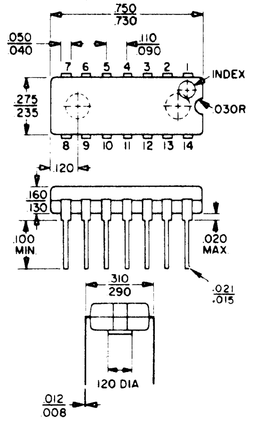
The Amelco 741 Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. The incorporation of an MOS capacitor directly on the substrate eliminates the need for external compensation. Input and output overvoltage and short circuit protection coupled with the elimination of latch up problems result in an excellent general purpose amplifier. Proper pin arrangement makes the 741 a direct replacement for the 709 and LM101 operational amplifiers for most applications with the resultant elimination of compensation components.

E PACKAGE

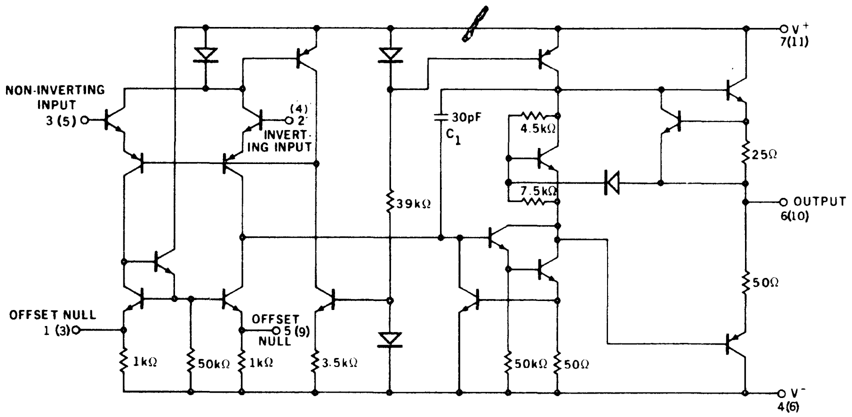


PIN 4 IS INTERNALLY CONNECTED TO CASE

J PACKAGE



Also available in "H" and "N" packages. See page on microcircuit packages.



SCHEMATIC DIAGRAM

Note: NUMBERS IN PARENTHESES ARE FOR DUAL IN LINE CONNECTIONS.

	741B	741C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
Lead Soldering Temperature (60 sec)	300°C	300°C
Power Dissipation (Note 1)	500 mW	500 mW
Supply Voltage	±22 V	±22 V
Input Voltage (Note 2)	±15 V	±15 V
Differential Input Voltage	±30 V	±30 V
Output Short Circuit Duration (Note 3)	Indefinite	Indefinite

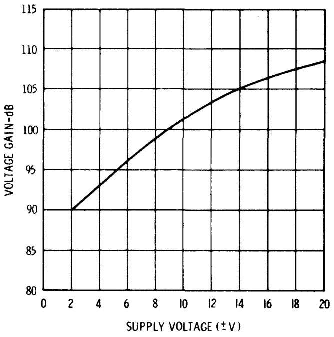
Complete part number designation consists of three digits and two letters, for example:

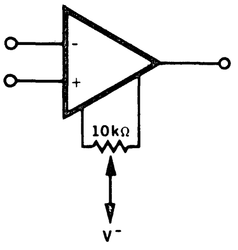
741BE
Package
Temperature Range
Circuit

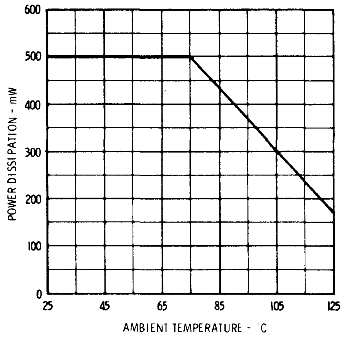
NOTES:
1. Rating applies for case temperatures to 125°C; derate linearly at 6.5 mW/°C for ambient temperature above +75°C.
2. For supply voltages less than ±15 V, the absolute maximum input voltage is equal to the supply voltage.
3. Short circuit may be to ground or either supply. Rating applies to +125°C case temperature or +75°C ambient temperature.

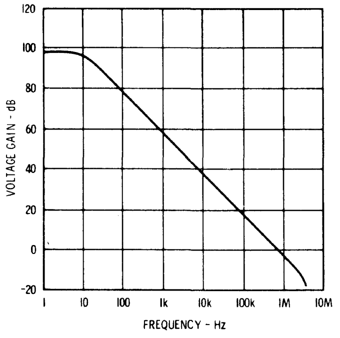
ELECTRICAL CHARACTERISTICS at 25°C and $V_{CC} = \pm 15$ V (Unless Otherwise Specified)

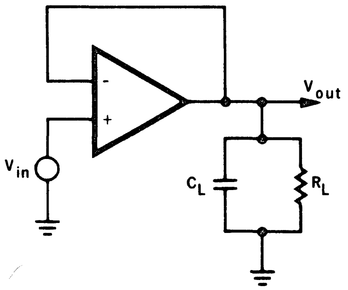
PARAMETER	741B			741C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Input Offset Voltage ($R_S \leq 10$ KΩ)		1.0	5.0		2.0	6.0	mV
Input Offset Current		30	200		30	200	nA
Input Bias Current		200	500		200	500	nA
Input Resistance	0.3	1.0		0.3	1.0		MΩ
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	50,000	200,000		20,000	100,000		
Output Voltage Swing ($R_L \geq 10$ KΩ) ($R_L \geq 2$ KΩ)	±12 ±10	±14 ±13		±12 ±10	±14 ±13		Volts Volts
Input Voltage Range	±12	±13		±12	±13		Volts
Common Mode Rejection Ratio ($R_S \leq 10$ KΩ)	70	90		70	90		dB
Supply Voltage Rejection Ratio ($R_S \leq 10$ KΩ)		30	150		30	150	μV/V
Power Consumption		50	85		50	85	mW
Transient Response (unity gain) $\left\{ V_{IN} = 20 \text{ mV}, R_L = 2 \text{ K}\Omega, C_L \leq 100 \text{ pF} \right\}$ Risetime Overshoot		0.3 5.0			0.3 5.0		μs %
Slew Rate (unity gain) ($R_L \geq 2$ KΩ)		0.5			5		V/μs
The following specifications apply for $T_{min} \leq T_A \leq T_{max}$							
Input Offset Voltage ($R_S \leq 10$ KΩ)			6.0			7.5	mV
Input Offset Current			500			300	nA
Input Bias Current			1.5			0.800	μA
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	25,000			15,000			
Output Voltage Swing ($R_L \geq 2$ KΩ)	±10			±10			Volts

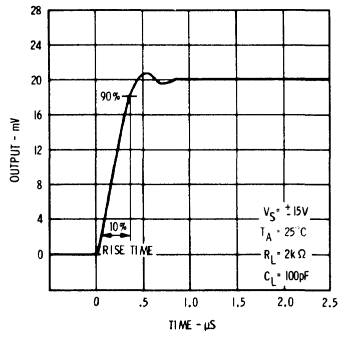

OPEN LOOP
VOLTAGE GAIN


VOLTAGE OFFSET
NULL CIRCUIT


ABSOLUTE MAXIMUM
POWER DISSIPATION


OPEN LOOP
FREQUENCY RESPONSE


TRANSIENT RESPONSE
TEST CIRCUIT

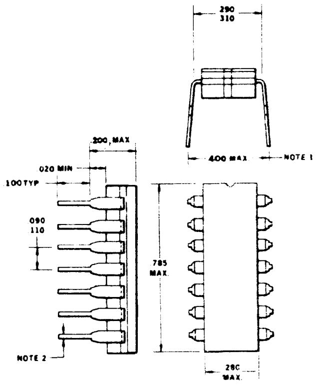

TRANSIENT RESPONSE

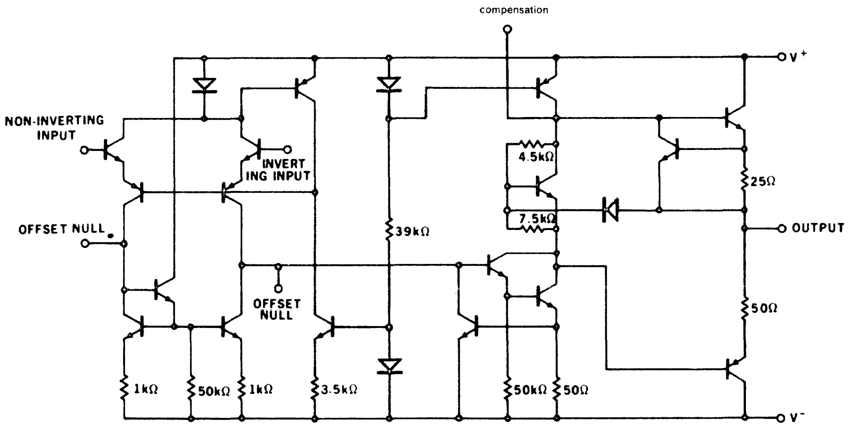
LINEAR CIRCUIT
DUAL
OPERATIONAL AMPLIFIER

747

The Amelco 747 Dual Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. Input and output over voltage and short circuit protection coupled with the elimination of latch up problems result in an excellent general purpose amplifier. External component requirements are reduced to a minimum by internal compensation techniques. The high gain and wide range of operating voltage provides superior performance in integrator, summing amplifier and general feedback applications.

N PACKAGE

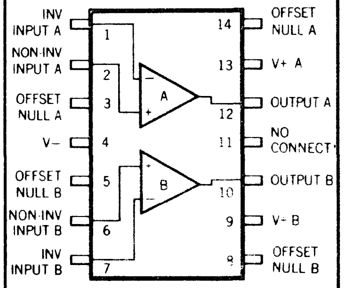




SCHEMATIC DIAGRAM

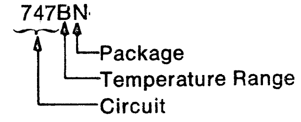
CONNECTION DIAGRAM

(Top View)



	747B	747C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
Lead Soldering Temperature (60 sec)	300°C	300°C
Power Dissipation (Note 1)	800 mW	500 mW
Supply Voltage	±22 V	±22 V
Input Voltage (Note 2)	±15 V	±15 V
Differential Input Voltage	±30 V	±30 V
Output Short Circuit Duration (Note 3)	Indefinite	Indefinite

Complete part number designation consists of three digits and two letters, for example:



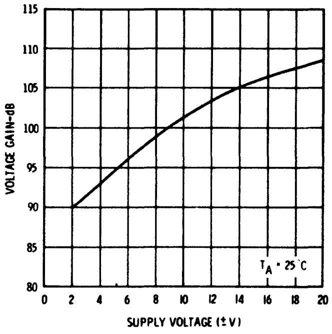
NOTES:
1. Rating applies for case temperatures to 125°C; derate linearly at 6.5 mW/°C for ambient temperature above +75°C.
2. For supply voltages less than ±15 V, the absolute maximum input voltage is equal to the supply voltage.
3. Short circuit may be to ground or either supply. Rating applies to +125°C case temperature or +75°C ambient temperature.

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY PHONE: (415) 968-9241 TWX: (415) 969-9112

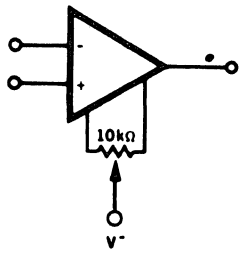
ELECTRICAL CHARACTERISTICS at 25°C and $V_{CC} = \pm 15$ V (Unless Otherwise Specified)

PARAMETER	747B			747C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Input Offset Voltage ($R_S \leq 10$ KΩ		1.0	5.0		2.0	6.0	mV
Input Offset Current		30	200		30	200	nA
Input Bias Current		200	500		200	500	nA
Input Resistance	0.3	1.0		0.3	1.0		MΩ
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	50,000	200,000		20,000	100,000		
Output Voltage Swing ($R_L \geq 10$ KΩ)	±12	±14		±12	±14		Volts
($R_L \geq 2$ KΩ)	±10	±13		±10	±13		Volts
Input Voltage Range	±12	±13		±12	±13		Volts
Common Mode Rejection Ratio ($R_S \leq 10$ KΩ)	70	90		70	90		dB
Supply Voltage Rejection Ratio ($R_S \leq 10$ KΩ)		30	150		30	150	μV/V
Power Consumption		50	85		50	85	mW
Transient Response (unity gain) $\left\{\begin{array}{l} V_{IN} = 20 \text{ mV} \\ R_L = 2 \text{ K}\Omega \\ C_L \leq 100 \text{ pF} \end{array}\right\}$							
Risetime		0.3			0.3		μs
Overshoot		5.0			5.0		%
Slew Rate (unity gain) ($R_L \geq 2$ KΩ)		0.5			0.5		V/μs
The following specifications apply for $T_{min} \leq T_A \leq T_{max}$							
Input Offset Voltage ($R_S \leq 10$ KΩ)			6.0			7.5	mV
Input Offset Current			500			300	nA
Input Bias Current			1.5			0.8	μA
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	25,000			15,000			
Output Voltage Swing ($R_L \geq 2$ KΩ)	±10			±10			Volts

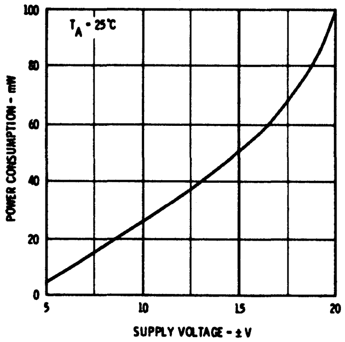
OPEN LOOP VOLTAGE GAIN



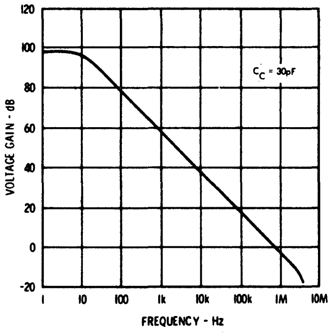
VOLTAGE OFFSET NULL CIRCUIT



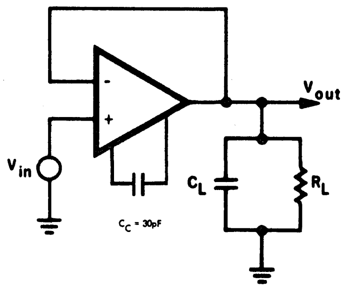
POWER CONSUMPTION AS A FUNCTION OF SUPPLY VOLTAGE



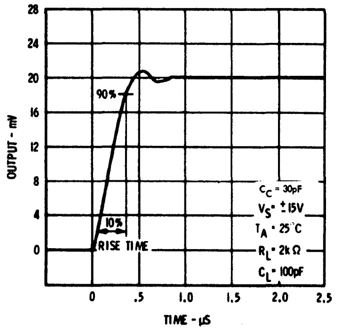
OPEN LOOP FREQUENCY RESPONSE



TRANSIENT RESPONSE TEST CIRCUIT



TRANSIENT RESPONSE

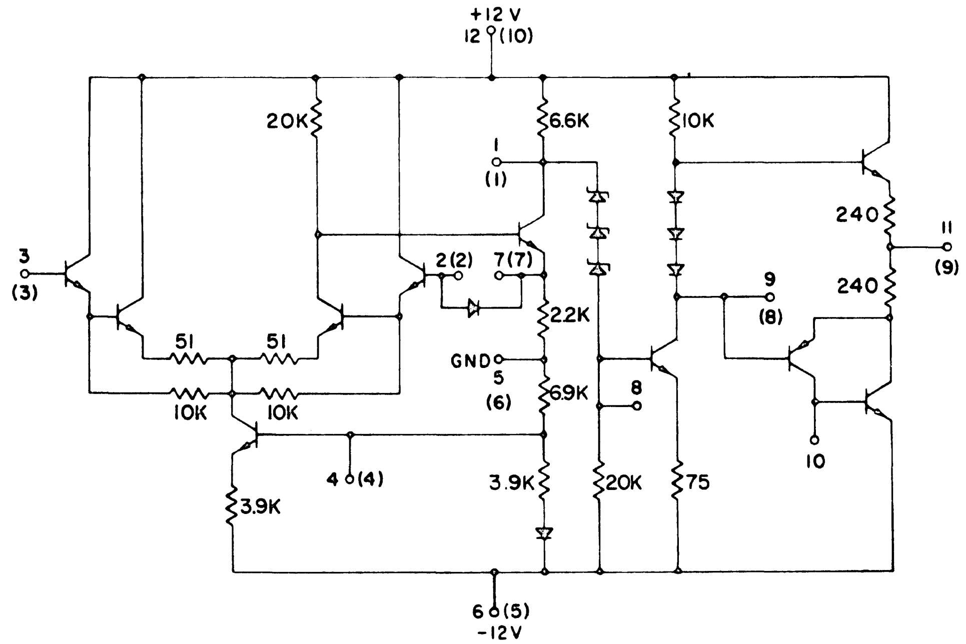


JANUARY 1968

LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

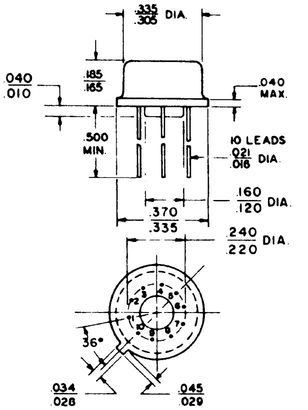
800
801

This General Purpose Amplifier is constructed on a single monolithic silicon substrate. It is ideally suited for applications requiring high input impedance, high voltage swing, high gain, low offset and low drift.



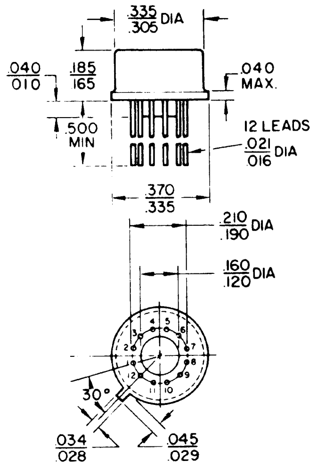
Note NUMBERS IN PARENTHESES REFER TO 10 PIN PACKAGE

800
E PACKAGE



PIN 5 IS INTERNALLY CONNECTED TO CASE

801



PIN 6 IS INTERNALLY CONNECTED TO CASE

ABSOLUTE MAXIMUM RATINGS

Total supply voltage between pins 6 and 12	30 volts.
Storage temperature	−65°C to +150°C
Operating temperature	−55°C to +125°C

SUPPLY VOLTAGES

Pin 12 to ground	+12 Volts, 5.0 mA Typical
Pin 6 to ground	−12 Volts, 5.0 mA Typical

Complete part number designation consists of three digits and two letters, for example:

800DE
- Package
- Temperature Range
- Circuit

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

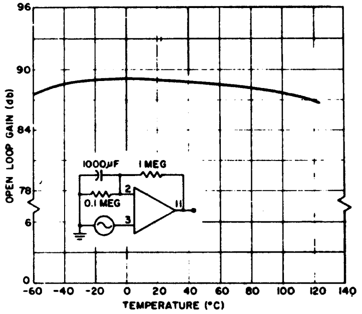
ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

PARAMETER AND CONDITIONS	800BE, 801BE			800DE, 801DE			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop DC Gain (No Load)	10,000	20,000		10,000	20,000		
Open Loop Bandwidth (1, 2)		10			10		MHz
Input Offset Voltage (Untrimmed)		5.0	50				mV
Input Bias Current			1000			2000	nA
Input Offset Current			100			200	nA
Input Offset Voltage Drift		25	50				μV/°C
Input Current Drift −55°C to +125°C			5.0				nA/°C
Input Impedance	250	1000		100	500		KΩ
Output Impedance (Open Loop)		400	1000		400	1000	Ohms
Common Mode Input Range	−2.0		+2.0	−2.0		+2.0	Volts
Dynamic Output Range (No Load)	18			16			V_{p-p}
Dynamic Output Range (1.0 KΩ Load)	10			10			V_{p-p}
Common Mode Rejection		−80	−60				db

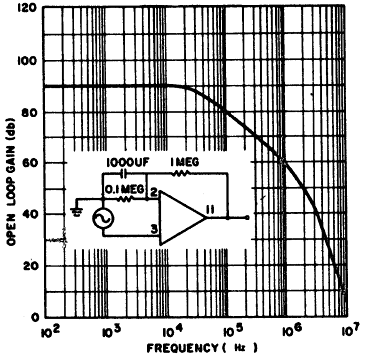
NOTES: (1) Bandwidth measured at unity gain.

(2) For closed loop stabilization, a capacitor should be connected across pins 2 and 7. For additional compensation a capacitor can be connected to pins 1 and 9. Recommended values range from 5 pf to 250 pf depending on the amount of feedback.

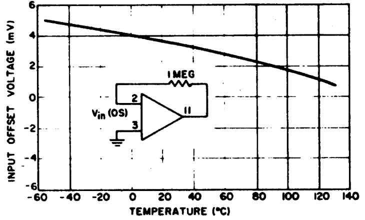
Open Loop Gain vs Temperature



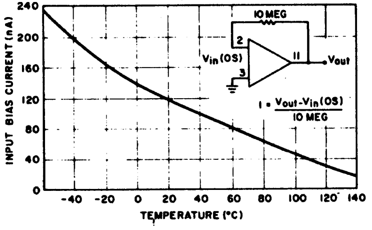
Open Loop Gain vs Frequency

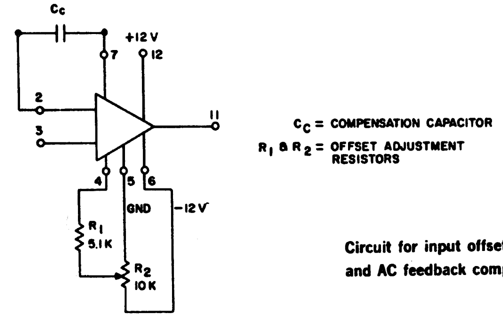


Input Offset Voltage vs Temperature



Input Bias Current vs Temperature





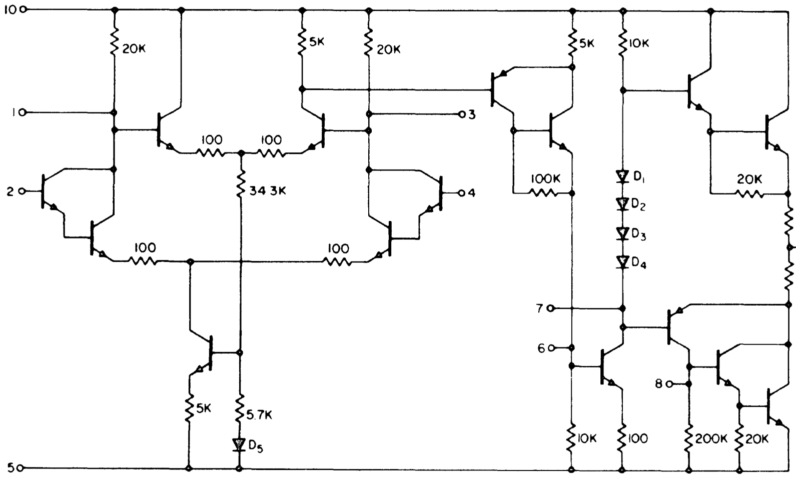
Circuit for input offset adjustment and AC feedback compensation.

LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

JANUARY 1968

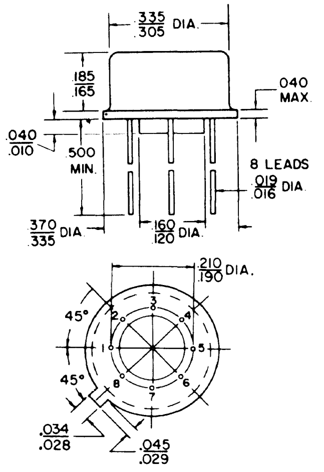
805
THRU
808

The Amelco 805, 806, 807 and 808 series of high performance operational amplifiers feature silicon planar epitaxial construction on a single monolithic substrate. Outstanding electrical characteristics include low offset voltage and current, high input impedance, high common mode input range, excellent thermal stability and output short-circuit protection.



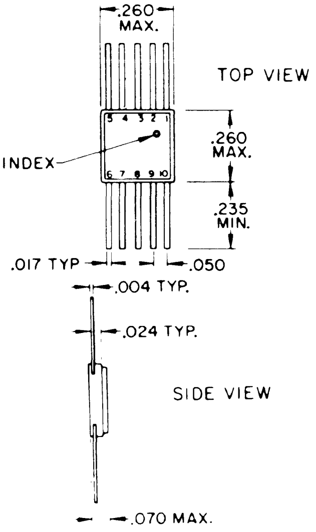
NOTE: "E" and "H" package pin designations are the same.

E PACKAGE

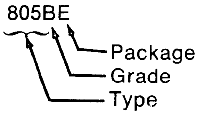


PIN 4 IS INTERNALLY CONNECTED TO CASE

H PACKAGE



Complete part number designation consists of three digits and two letters, for example:



ABSOLUTE MAXIMUM RATINGS

	805B/806B 807B/808A/808B	805C/806C
Storage Temperature	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
	805/807/808	806
Supply Voltage	±18V	±15V
Operating Supply Voltage	±15V	±12V
	All Types	
Differential Input Voltage	±5.0V	
Input Voltage	±10V	
Internal Power Dissipation @ T_A = 25°C	300 mW	
Output Short-Circuit Duration @ T_A = 25°C	Continuous	
Lead Temperature, 1/16 inch from case, 10 seconds max.	+300°C	

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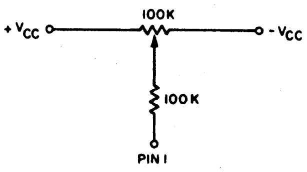
Printed in U.S.A.

ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

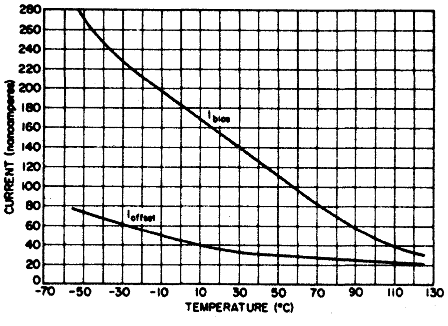
	805B/806B			805C/806C			807B			808AE			808BE			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain	30	60	120	10	60		30	60	120	25	40		25	40		KV/V
−55°C	20						20									
+125°C	20						20									
Input Offset Voltage		1.0	5.0		3.0	10		0.1	2.5		1.0	5.0		1.0	10	mV
−55°C to +125°C		2.0	7.0					1.0	3.0							
Input Bias Current		250	500		250	1000		250	500		25	50		25	50	nA
−55°C			1500						1500			250			250	
+125°C			250						250							
Input Offset Current		10	50		30	100		10	50		3.0	15		5.0	30	nA
−55°C			250						250							
+125°C			100						50							
Input Impedance	500	1000		100	1000		500	1000		1000	2000		1000	2000		KΩ
−55°C	200						300									
+125°C	500						500									
Input Offset Voltage Drift																
(−55°C to +125°C)		5.0	20					3.0	10		5.0	10		10	30	µV/°C
(0°C to100°C)					5.0	30										
Input Offset Current Drift																
(+25°C to +125°C)		0.02	0.5					0.02	0.5							nA/°C
(−55°C to +125°C)		0.5	1.0					0.5	1.0		0.01	0.15		0.1	0.3	
(0°C to 100°C)					0.1	2.0										
Common Mode Voltage Range																
V_{CC} = ±15 V	±8.0	±9.0		±8.0	±9.0		±8.0	±9.0		±8.0	±9.0		±8.0	±9.0		Volts
V_{CC} = ±12 V	±6.0	±7.0		±8.0	±7.0		±6.0	±7.0		±6.0	±7.0		±6.0	±7.0		
Common Mode Rejection Ratio		−90	−70		−90	−70		−90	−80		−90	−70		−90	−70	db
Output Impedance		150	300		150	300		150	300		150	300		150	300	Ohms
−55°C			300						300							
+125°C			360						360							
Power Supply Rejection Ratio		−80	−70		−80			−80	−70		−80	−70		−80	−70	db
Output Voltage Swing																
(+25°C to Temp.*)																
No Load, V_{CC} = ±15 V	24	26		24	26		24	26		24	26		24	26		V_{p-p}
No Load, V_{CC} = ±12 V	18	20		18	20		18	20		18	20		18	20		
1.0 K Load, V_{CC} = ±15 V	20	24		20	24		20	24		20	24		20	24		
1.0 K Load, V_{CC} = ±12 V	15	18		15	18		15	18		15	18		15	18		
(−55°C)																
No Load, V_{CC} = ±15 V	20	25					20	25								
1.0 K Load, V_{CC} = ±15 V	16	23					16	23								
Power Supply Current																
No Load, ±15 V		6.0	7.5		6.0	7.5		6.0	7.5		6.0	7.5		6.0	7.5	mA
No Load, ±12 V		5.0	6.7		5.0	6.7		5.0	6.7		5.0	6.7		5.0	6.7	

* Upper limit for "A & B" grade unit = 125°C
Upper limit for "C" grade unit = 100°C

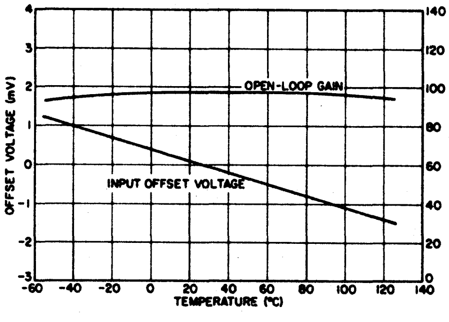


RECOMMENDED OFFSET ADJUSTMENT

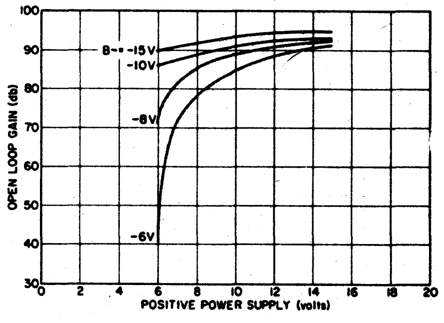
Input Bias and Offset Current vs Temperature



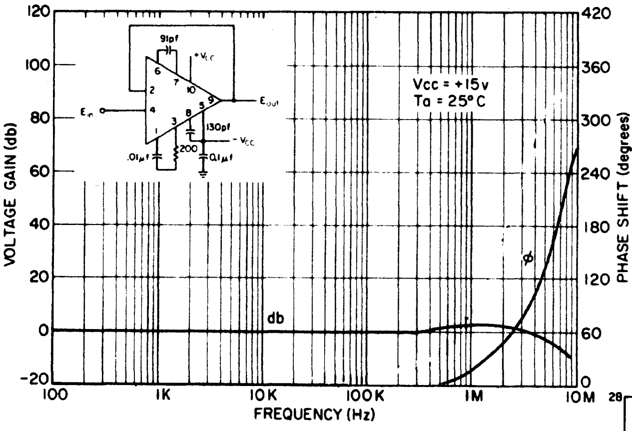
Offset Voltage and Open Loop Gain vs Temperature



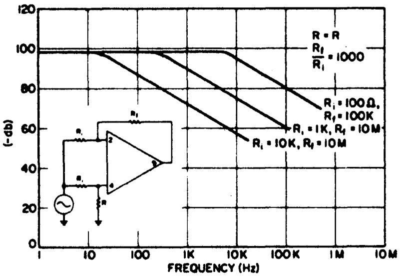
Open Loop Gain vs Power Supplies



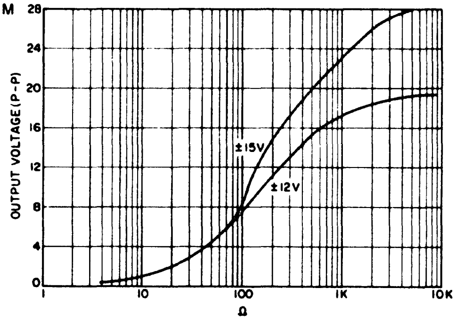
Unity Gain Voltage Follower
Voltage Gain & Closed-Loop Phase Shift
vs Frequency



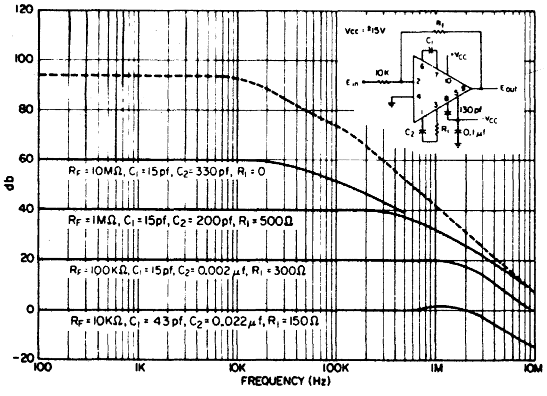
Common Mode Rejection
Ratio vs Frequency



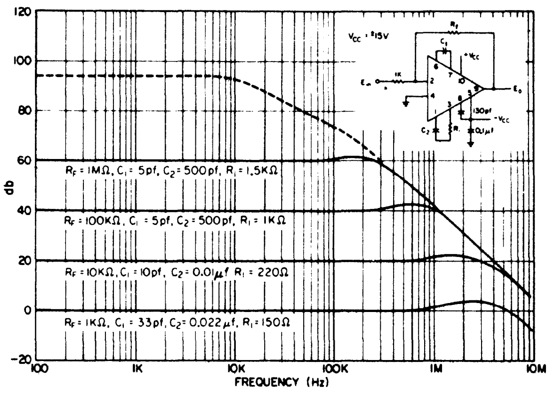
Output Swing (Open Loop)
vs
Load Resistance



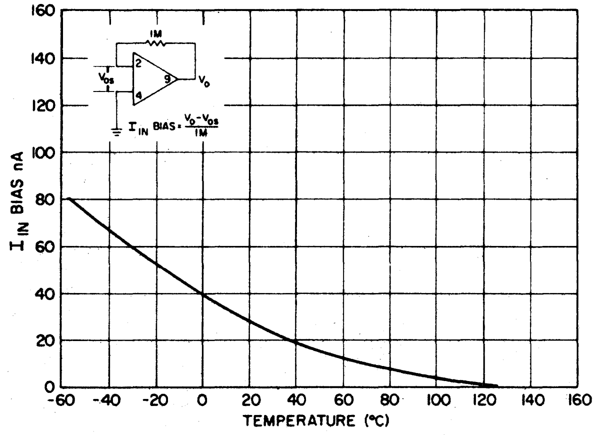
Frequency Response
10K Input Resistance
(Optimized for Various Gains)



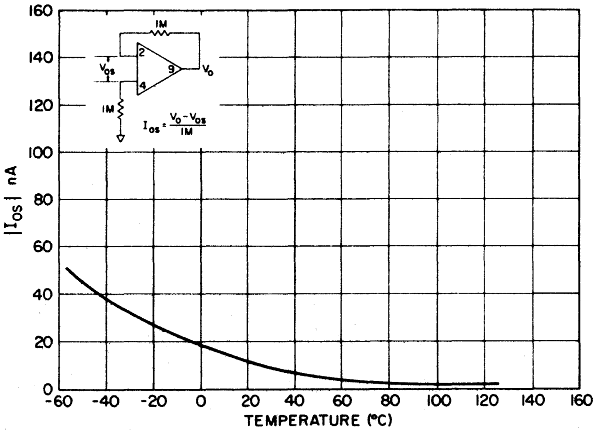
Frequency Response
1K Input Resistance
(Optimized for Various Gains)



Typical Input Bias Current vs Temperature



Typical Input Offset Current vs Temperature

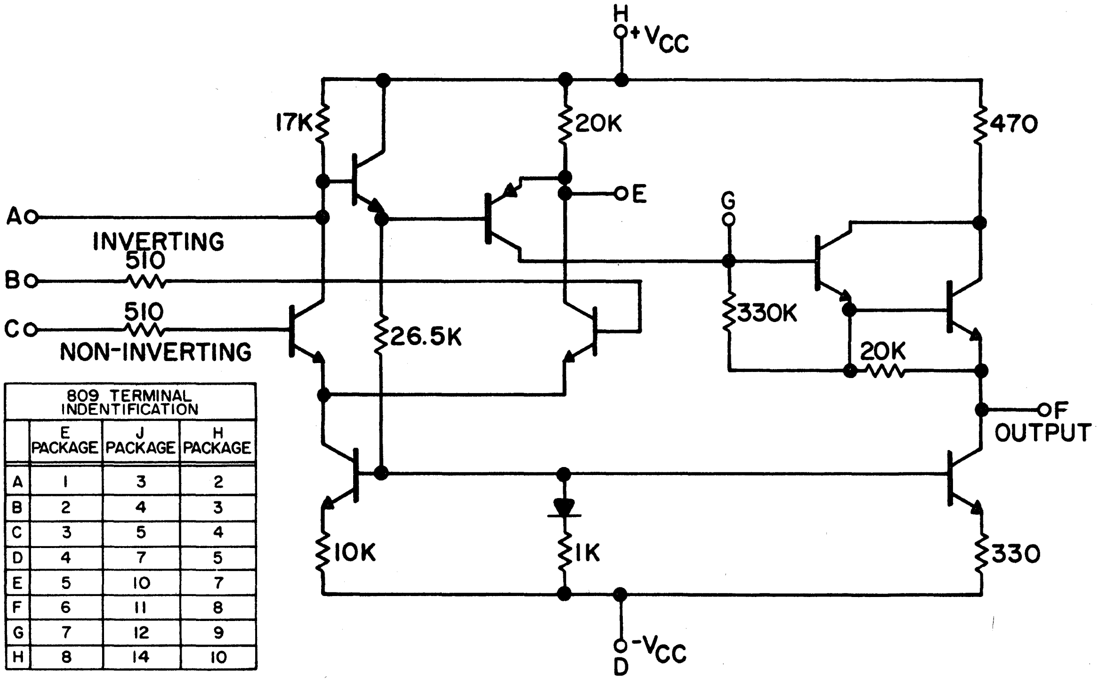


LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

JANUARY 1968

809

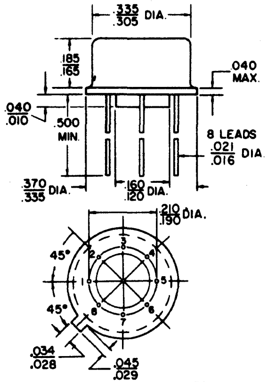
The Amelco 809 Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. The unique simplicity of this design results in a low cost, high performance amplifier. It is ideally suited for applications requiring high common mode range, high input impedance, and low current and voltage offsets and offset drifts. This amplifier can also be operated over a large range of supply voltages.



809 TERMINAL INDENTIFICATION

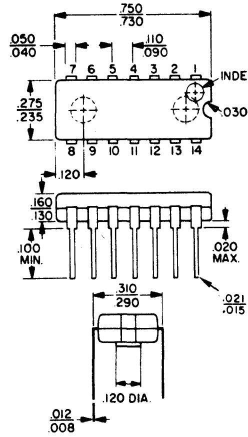
	E PACKAGE	J PACKAGE	H PACKAGE
A	1	3	2
B	2	4	3
C	3	5	4
D	4	7	5
E	5	10	7
F	6	11	8
G	7	12	9
H	8	14	10

E PACKAGE

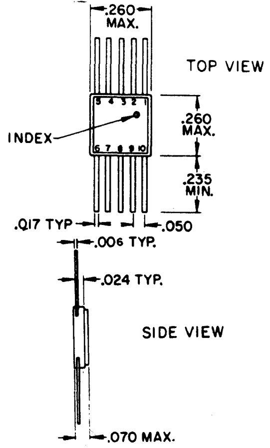


PIN 4 IS INTERNALLY CONNECTED TO CASE

J PACKAGE



H PACKAGE



ABSOLUTE MAXIMUM RATINGS

	809B	809C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
Maximum Supply Voltage	±18V	±18V
Operating Voltage	±15V	±15V
Differential Input Voltage	±15V	±15V
Input Voltage	±15V	±15V
Internal Power Dissipation	300 mW	300 mW
Output Short Circuit Duration	Continuous	Continuous
Lead Temperature, 1/16 inch from case, 10 seconds max.	+300°C	+300°C

"J" Package only available in "C" Grade.

Complete part number designation consists of three digits and two letters, for example:

809BE
Package
Temperature Range
Circuit

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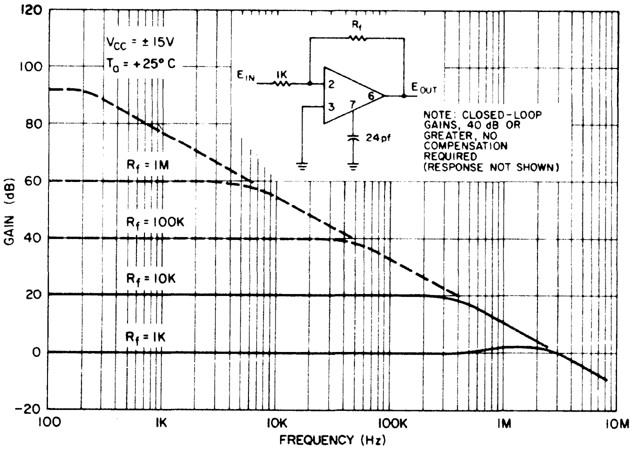
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

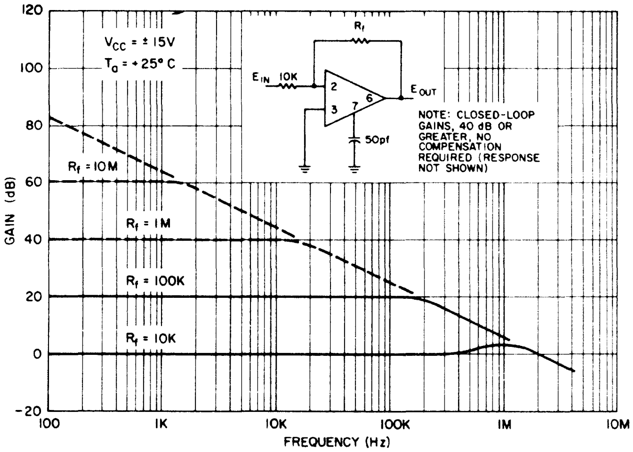
ELECTRICAL CHARACTERISTICS At +25°C and V_{CC} = ±15 V (Unless Otherwise Specified)

PARAMETER	809B			809C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain (−55°C to+125°C)	 10K	 40K		10K	40K		v/v
Input Offset Voltage		5.0	10		5.0	10	mV
Input Offset Voltage Drift		10	50		10	50	μV/°C
Input Bias Current		300	500		500	1000	nA
Input Bias Current (−55°C to +125°C) (0°C to 100°C)		 600	 1500		 750	 1500	 nA
Input Offset Current −55°C 0°C		50	100 500		50	350 500	nA
Input Offset Current Drift		1.0	3.0		1.0		nA/°C
Input Noise Flicker (0.016 to 1.6 Hz) Midband (1.6 to 160 Hz) Broadband (160 to 16 kHz)		 10 1.0 2.0 60 1.5 200			 10 1.0 2.0 60 1.5 200		 μV_{p-p} nA_{p-p} μV_{p-p} pA_{p-p} μV_{rms} pA_{rms}
Common Mode Voltage Range	±10	±13		±10	±13		V
Common Mode Rejection Ratio		−90	−70		−90	−70	db
Power Supply Rejection Ratio		−90	−70		−90	−70	db
Input Impedance	100K	200K		50K	200K		Ohms
Output Voltage Swing (R_L = 5.0 KΩ, V_{CC} = ±15 V)	20	24		20	24		V_{p-p}
Power Dissipation (No Load, V_{CC} = ±15 V)		100	150		100		mW

Frequency Response
1K Input Resistance

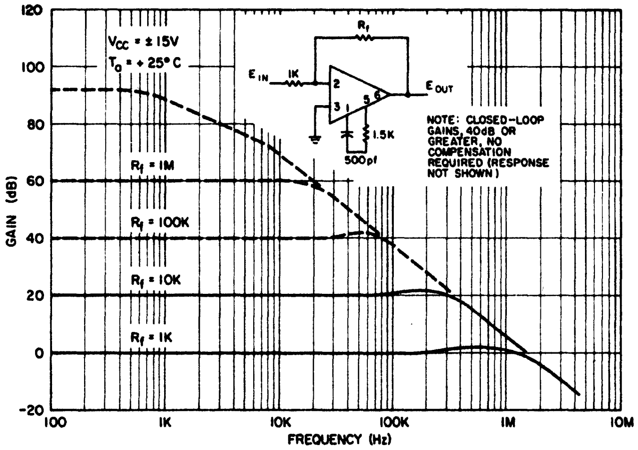


Frequency Response
10K Input Resistance



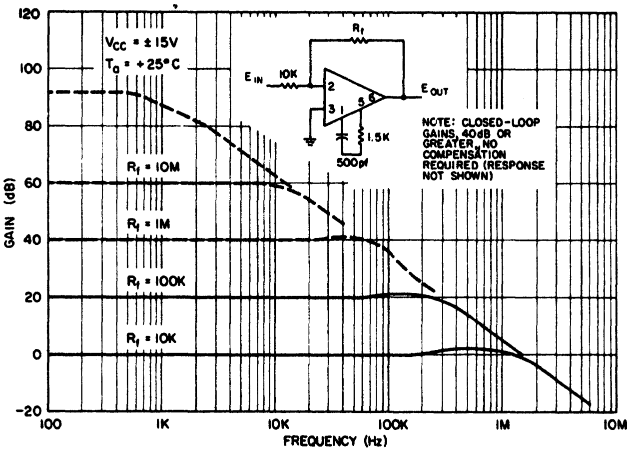
NOTE: Pin designations on graph plots are for "E" package.

Frequency Response
1K Input Resistance



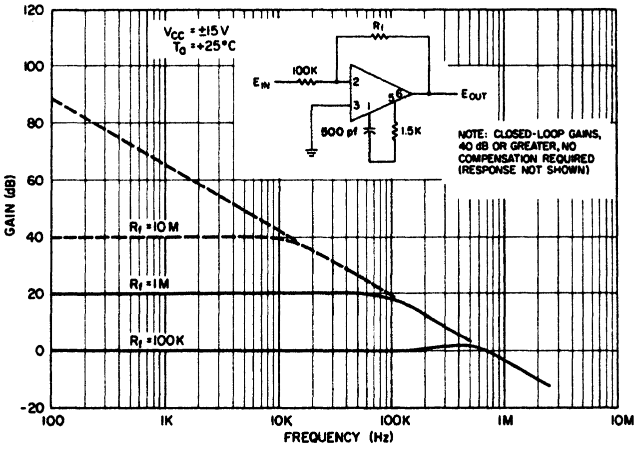
NOTE: CLOSED-LOOP GAINS, 40dB OR GREATER, NO COMPENSATION REQUIRED (RESPONSE NOT SHOWN)

Frequency Response
10K Input Resistance



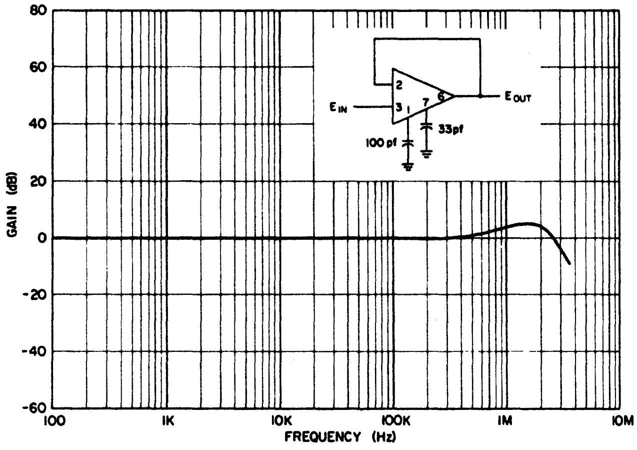
NOTE: CLOSED-LOOP GAINS, 40dB OR GREATER, NO COMPENSATION REQUIRED (RESPONSE NOT SHOWN)

Frequency Response
100K Input Resistance

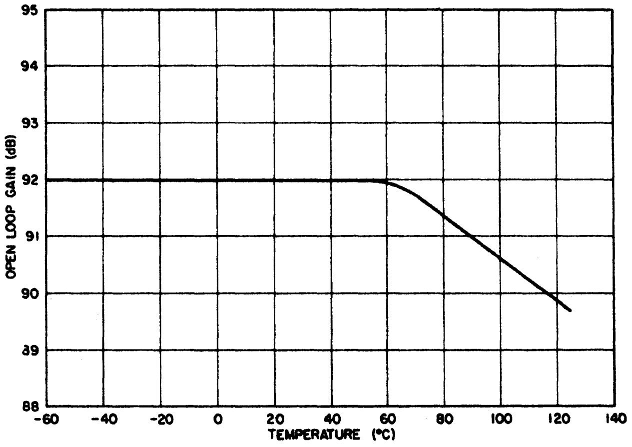


NOTE: CLOSED-LOOP GAINS, 40 dB OR GREATER, NO COMPENSATION REQUIRED (RESPONSE NOT SHOWN)

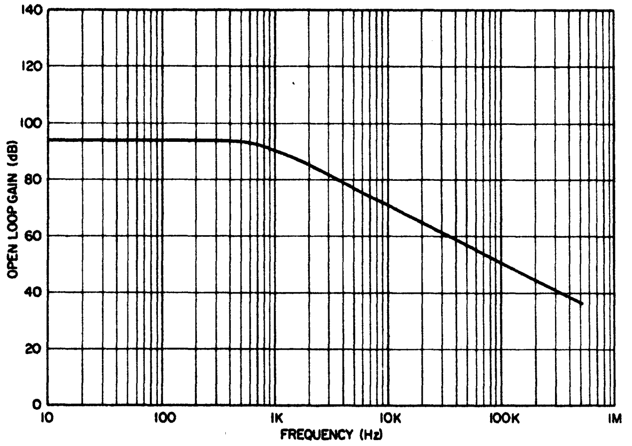
Frequency Response
Voltage Follower



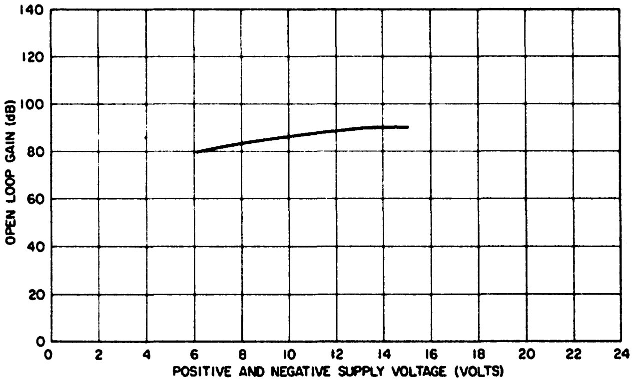
Open Loop Gain vs Temperature



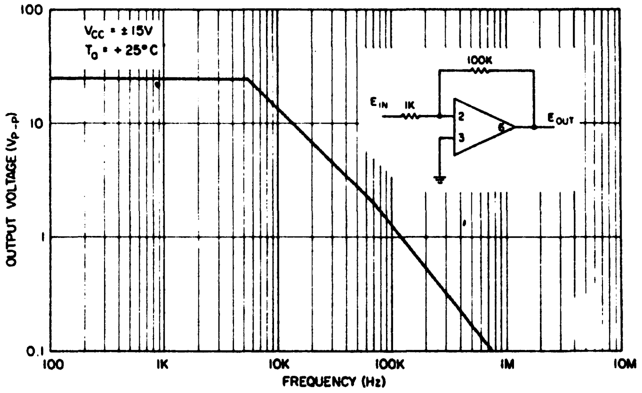
Open Loop Gain vs Frequency



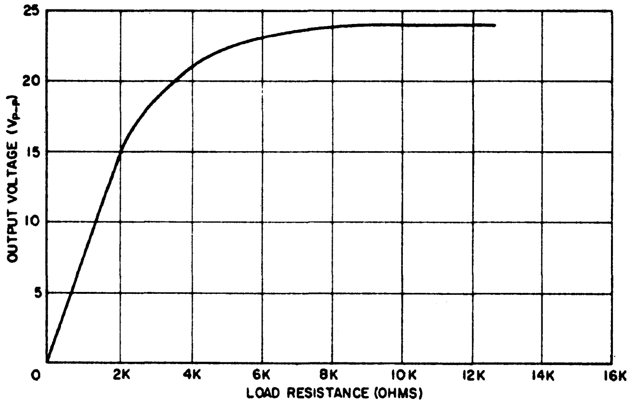
Open Loop Gain vs Positive and Negative Supply Voltage



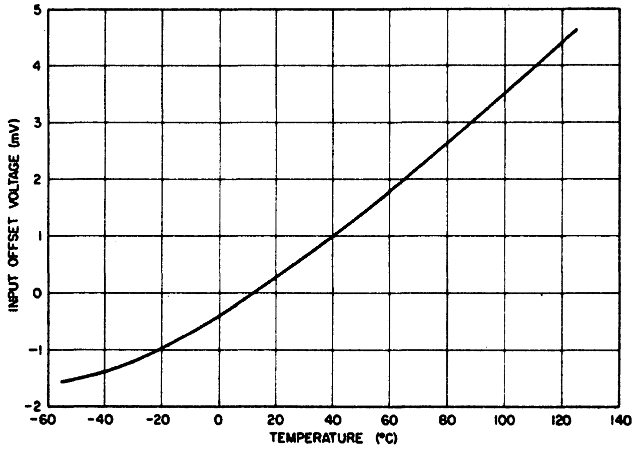
Maximum Output Voltage vs Frequency



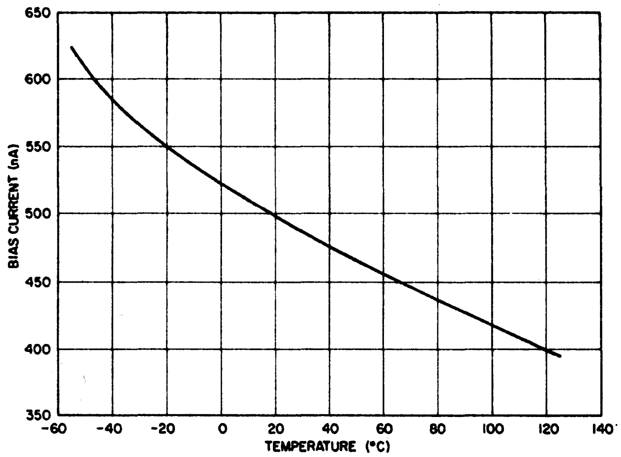
Output Voltage vs Load Resistance



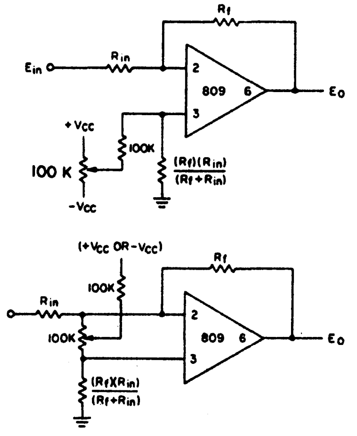
Untrimmed Offset Voltage vs Temperature



Bias Current vs Temperature



SUGGESTED OFFSET ADJUSTMENT

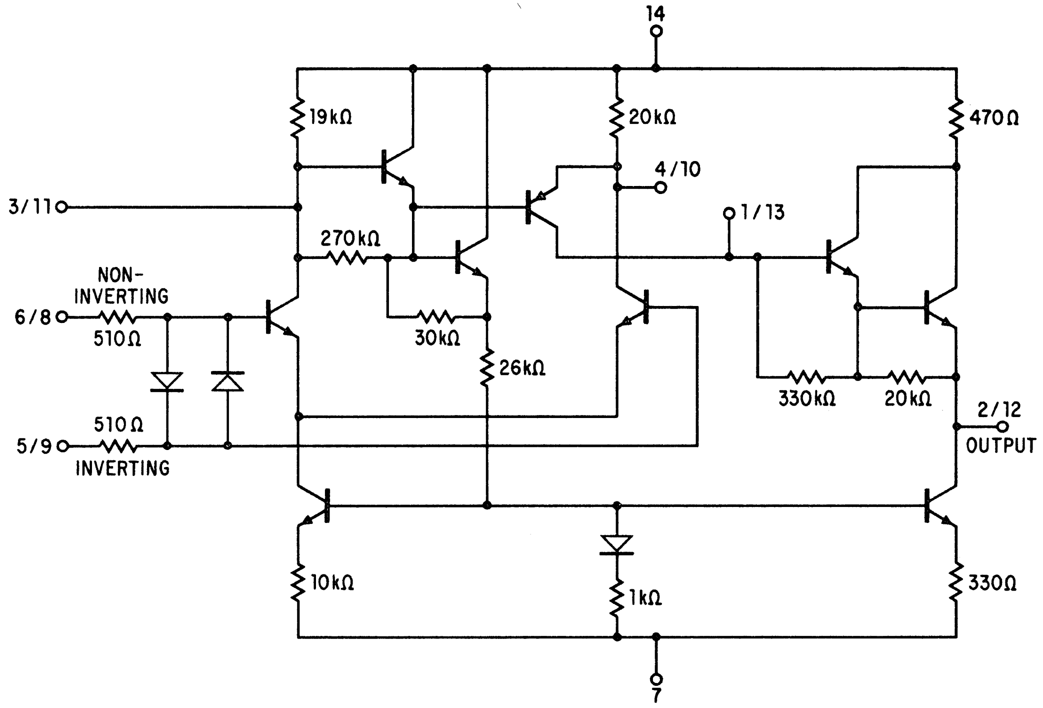


SEPTEMBER 1968

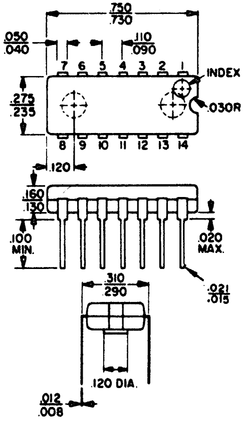
LINEAR CIRCUIT
DUAL
OPERATIONAL AMPLIFIER

810

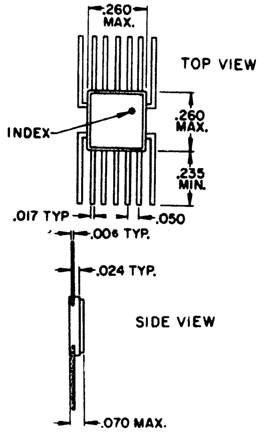
The Amelco 810CJ is a Dual Operational Amplifier constructed on a single monolithic substrate. The unique simplicity of this design results in a dual low cost high performance amplifier. It is ideally suited for applications requiring high common mode range, high input impedance, and low current and voltage offsets and drifts.



J PACKAGE



H PACKAGE



Also available in "N" package. See page on microcircuit packages.

ABSOLUTE MAXIMUM RATINGS

	810B	810C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
Maximum Supply Voltage	±18V	±18V
Operating Voltage	±15V	±15V
Differential Input Voltage	±15V	±15V
Input Voltage	±15V	±15V
Internal Power Dissipation	300 mW	300 mW
Output Short Circuit Duration	Continuous	Continuous
Lead Temperature, 1/16 inch from case, 10 seconds max.	+300°C	+300°C

Complete part number designation consists of three digits and two letters, for example:

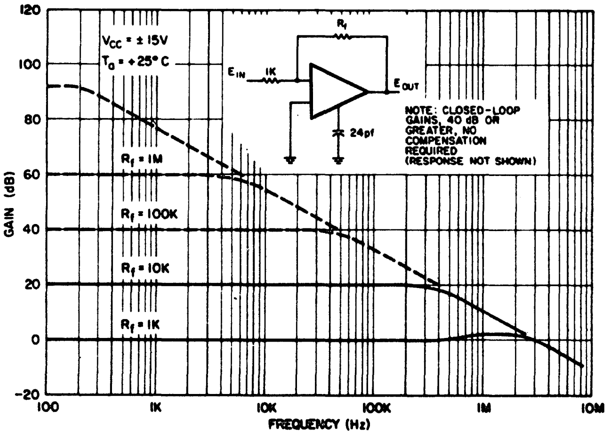
810CJ
- Package
- Temperature Range
- Circuit

Printed in U.S.A.

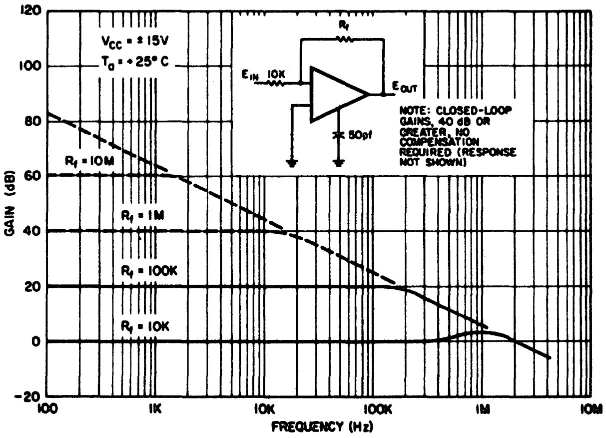
ELECTRICAL CHARACTERISTICS At +25°C and V_{CC} = ±15 V (Unless Otherwise Specified)

PARAMETER	810B			810C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain				10K	40K		v/v
(−55° to +125°C)	10K	40K					
Input Offset Voltage		5.0	10		5.0	10	mV
Input Offset Voltage Drift		5.0	50		5.0	50	μV/°C
Input Bias Current		300	500		500	1000	nA
Input Bias Current							
(−55°C to +125°C)		600	1500				nA
(0° to 100°C)					750	1500	
Input Offset Current		50	100		50	350	nA
−55°C			500				
0°C						500	
Input Offset Current Drift		1.0	3.0		1.0		nA/°C
Input Noise							
Flicker (0.016 to 1.6 Hz)		10			10		μV_{p-p}
		1.0			1.0		nA_{p-p}
Midband (1.6 to 160 Hz)		2.0			2.0		μV_{p-p}
		60			60		pA_{p-p}
Broadband (160 to 16 kHz)		1.5			1.5		μV_{rms}
		200			200		pA_{rms}
Common Mode Voltage Range	±10	±13		±10	±13		V
Common Mode Rejection Ratio		−90	−70		−90	−70	db
Power Supply Rejection Ratio		−90	−70		−90	−70	db
Input Impedance	100K	200K		50K	200K		Ohms
Output Voltage Swing (R_L = 5.0 KΩ, V_{CC} = ±15 V)	20	24		20	24		V_{p-p}
Power Dissipation (No Load, V_{CC} = ±15 V)		100	150		100		mW
Channel Separation		80			80		db

Frequency Response
1K Input Resistance



Frequency Response
10K Input Resistance



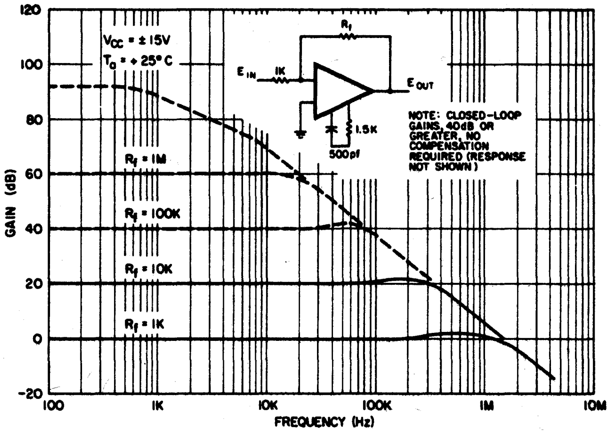
SUGGESTED COMPENSATION TECHNIQUES

RC Series Network Between Terminal 3/11 and 4/10; 1.5 K ohms and 500 pf.

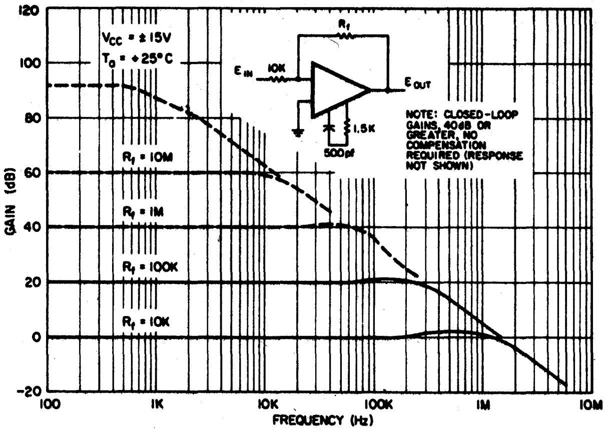
For Minimum Number of Components;
- For 1.0 K ohm Input Non-Inverting Amplifier, A 24 pf Capacitor from Terminal 1/13 to Ground.
- For 10 K ohm Input Non-Inverting Amplifier, A 50 pf Capacitor from Terminal 1/13 to Ground.
- For a Voltage Follower Amplifier, A 100 pf Capacitor from Terminal 1 to Ground and a 33 pf Capacitor from Terminal 7 to Ground.

For Applications of Close Loop Gains of 40 db or greater, No Compensation is required.

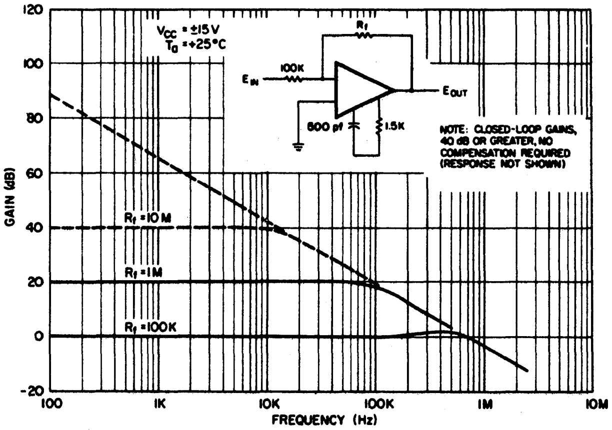
Frequency Response
1K Input Resistance



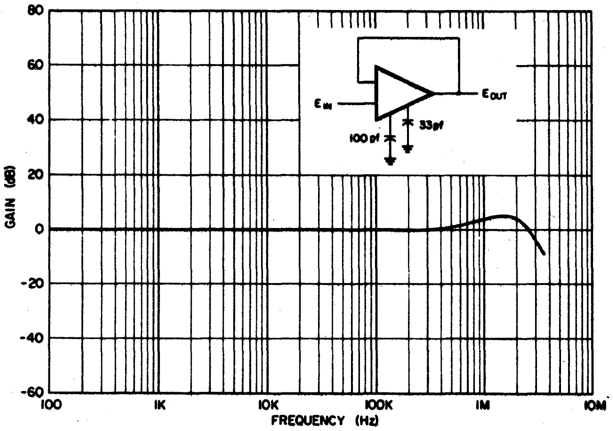
Frequency Response
10K Input Resistance



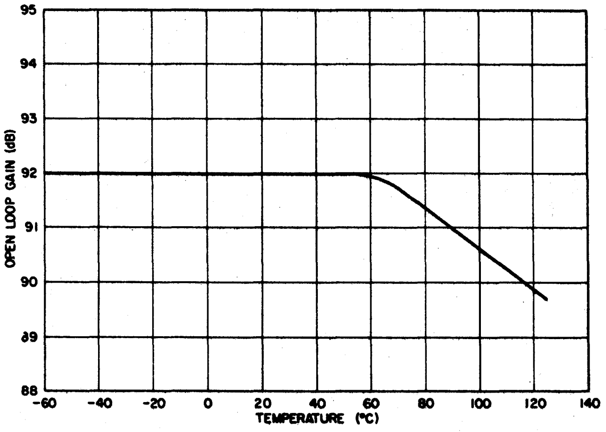
Frequency Response
100K Input Resistance



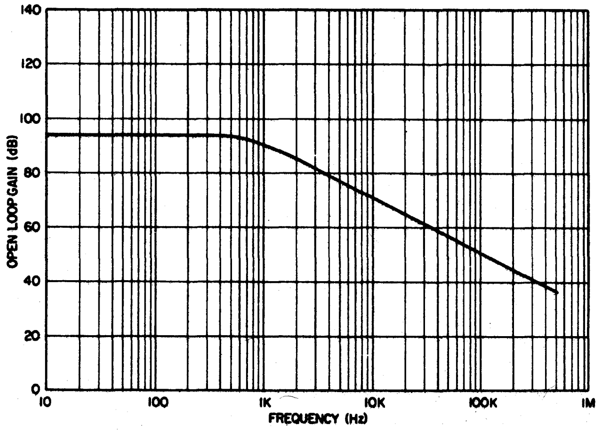
Frequency Response
Voltage Follower

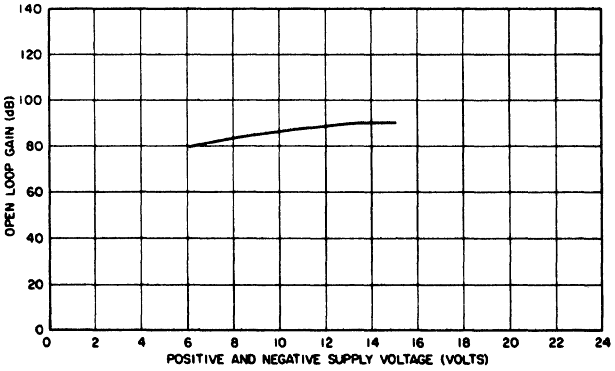


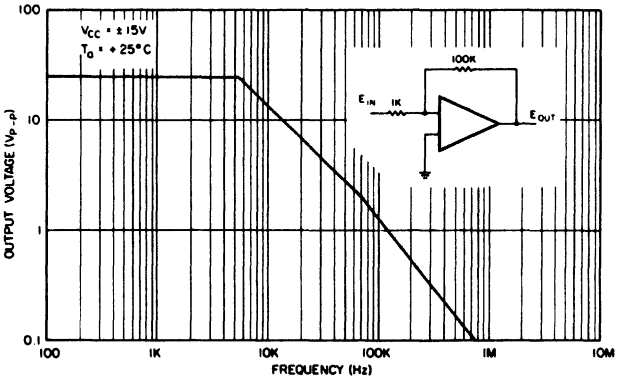
Open Loop Gain vs Temperature

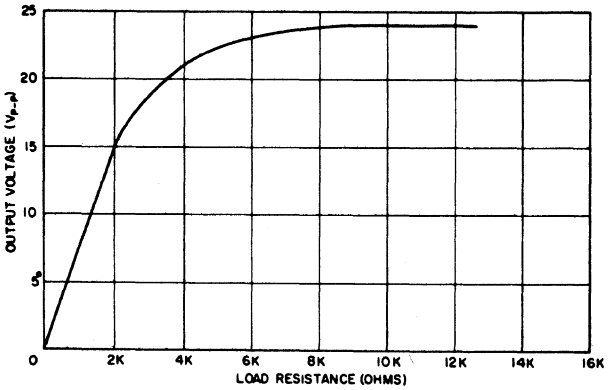


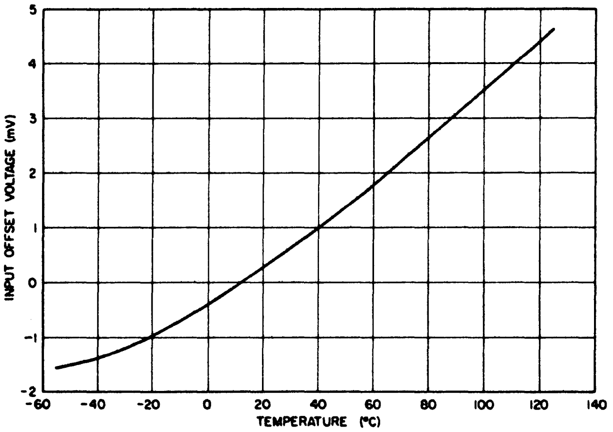
Open Loop Gain vs Frequency

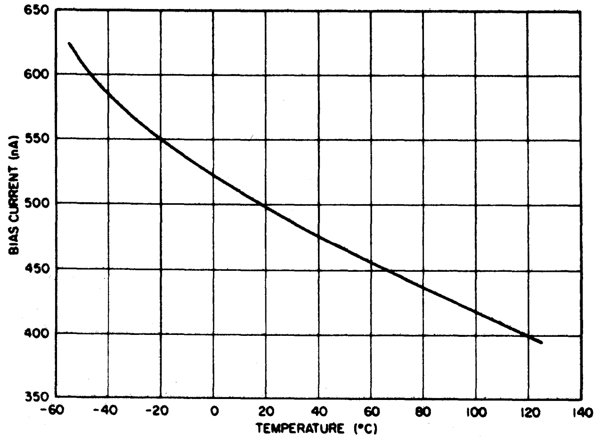



Open Loop Gain vs Positive and Negative Supply Voltage

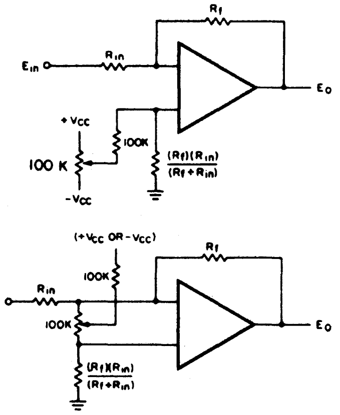

Maximum Output Voltage vs Frequency


Output Voltage vs Load Resistance


Untrimmed Offset Voltage vs Temperature


Bias Current vs Temperature

SUGGESTED OFFSET ADJUSTMENT

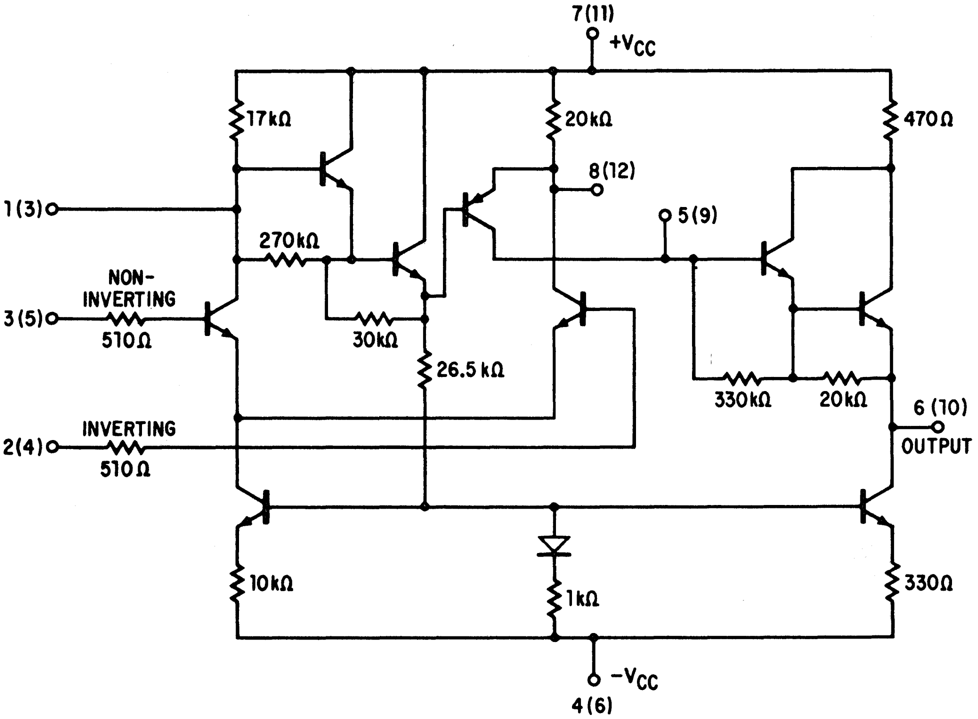


SEPTEMBER 1968

LINEAR CIRCUIT OPERATIONAL AMPLIFIER

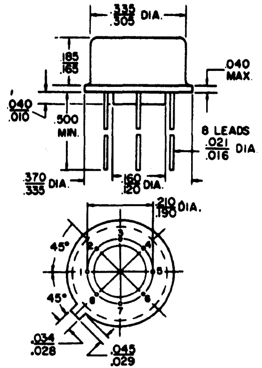
811

The Amelco 811 Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. The unique simplicity of this design results in a low cost, high performance amplifier. It is ideally suited for applications requiring high common mode range, high input impedance, and low current and voltage offsets and offset drifts. This amplifier can also be operated over a large range of supply voltages. Pin interchangeability makes this an excellent low cost replacement for the 709 with the resultant savings of compensation components.



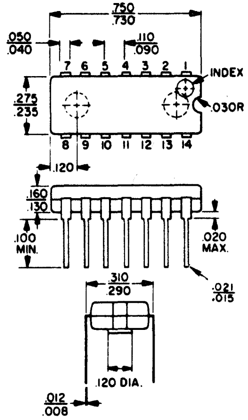
Note: NUMBERS IN PARENTHESES ARE DUAL IN-LINE CONNECTIONS

E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO CASE

J PACKAGE



Also available in "H" and "N" packages. See page on microcircuit packages.

ABSOLUTE MAXIMUM RATINGS

	811B	811C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	
Maximum Supply Voltage	±18 V	±18 V
Operating Voltage	±15 V	±15 V
Differential Input Voltage	±15 V	±15 V
Input Voltage	±15 V	±15 V
Internal Power Dissipation	300 mW	300 mW
Output Short Circuit Duration	Continuous	Continuous
Lead Temperature, 1/16 inch from case, 10 seconds max.	+300°C	+300°C

"J" Package only available in "C" Grade.

Complete part number designation consists of three digits and two letters, for example:

811BE
Package
Temperature Range
Circuit

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY PHONE: (415) 968-9241 TWX: (415) 969-9112

Printed in U.S.A.

ELECTRICAL CHARACTERISTICS At +25°C and $V_{CC} = \pm15$ V (Unless Otherwise Specified)

PARAMETER	811B			811C			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain				10K	40K		v/v
(−55°C to +125°C)	10K	40K					
Input Offset Voltage		5.0	10		5.0	10	mV
Input Offset Voltage Drift		5.0			5.0		μV/°C
Input Bias Current		300	500		500	1 000	nA
Input Bias Current							
(−55°C to +125°C)		600	1500				nA
(0°C to 100°C)					750	1500	
Input Offset Current		50	100		50	350	nA
−55°C			250				
0°C						500	
Input Offset Current Drift		1.0	3.0		1.0		nA/°C
Input Noise							
Flicker (0.016 to 16 Hz)		10			10		μV_{p-p}
		1.0			1.0		nA_{p-p}
Midband (1.6 to 160 Hz)		2.0			2.0		μV_{p-p}
		60			60		pA_{p-p}
Broadband (160 to 16 kHz)		1.5			1.5		μV_{rms}
		200			200		pA_{rms}
Common Mode Voltage Range	±10	±13		±10	±13		V
Common Mode Rejection Ratio		−90	−70		−90	−70	db
Power Supply Rejection Ratio		−90	−70		−90	−70	db
Input Impedance	100K	200K		50K	200K		Ohms
Output Voltage Swing ($R_L = 5.0$ kΩ, $V_{CC} = \pm15$ V)	20	24		20	24		V_{p-p}
Power Dissipation (No Load, $V_{CC} = \pm15$ V)		100	150		100		mW

Suggested Compensation Techniques

RC Series Network Between Terminal 1 and 8; 1.5K ohms and 500 pf.

For Minimum Number of Components;

- For 1K ohm Input Non-Inverting Amplifier, A 24 pf Capacitor from Terminal 5 to Ground.
- For 10K ohm Input Non-Inverting Amplifier, A 50 pf Capacitor from Terminal 5 to Ground.
- For A Voltage Follower Amplifier, A 100 pf Capacitor from Terminal 1 to Ground and a 33 pf Capacitor from Terminal 5 to Ground.

For Applications of Closed Loop Gains of 40 db or greater, No Compensation is required.

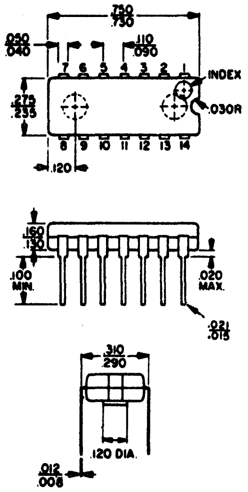
For Additional Compensation and Performance Information Refer to the 810 Data Sheet.

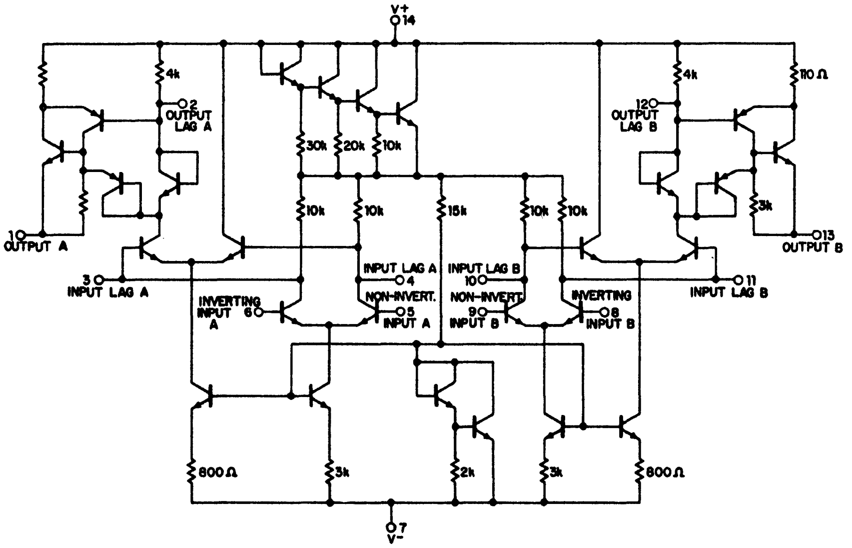
LINEAR CIRCUIT DUAL OPERATIONAL AMPLIFIER

813

The Amelco 813 Dual Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. The collector pull-down resistors are externally applied thereby permitting a variety of loads and applications. The outputs of these two high performance operational amplifiers may also be 'OR'ed as a dual comparator or used as diodes in low threshold rectifying circuits.

J PACKAGE





SCHEMATIC DIAGRAM

	813
Storage Temperature Range	−65°C to +150°C
Operating Temperature Range	0°C to +100°C
Lead Soldering Temperature (60 sec)	300°C
Power Dissipation	500 mW
Supply Voltage	±15V
Input Voltage	± 5V
Differential Input Voltage	± 5V
Output Short Circuit Duration (Note 1)	5 seconds

NOTES: 1. Short circuit may be to ground or either supply.

Complete part number designation consists of three digits and two letters, for example:

813CJ
- Package
- Temperature Range
- Circuit

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY PHONE: (415) 968-9241 TWX: (415) 969-9112

ELECTRICAL CHARACTERISTICS at 25°C, $V_{CC} = \pm 10$ V (Unless Otherwise Specified)

		813C			
PARAMETER		MIN.	TYP.	MAX.	UNITS
Input Offset Voltage	$R_S = 100\Omega$		2.5	4.0	mV
Input Offset Current			0.5	2	μA
Input Bias Current			1.5	5	μA
Large Signal Voltage Gain	$V_{OUT} = \pm 5V$	6,000	20,000		
Power Consumption				120	mW
Propagation Delay	(See Figure 2)		400	500	ns
Recovery Time Differential Mode $t_{r(dm)}$	(See Figure 3)		600	800	ns
Channel Separation	(See Figure 1)		0.3	0.5	Volts

FIGURE 1
CHANNEL SEPARATION

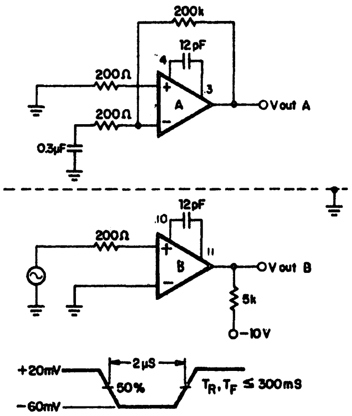


FIGURE 2
PROPAGATION DELAY

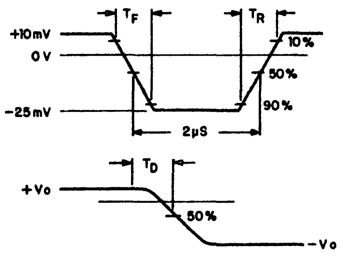
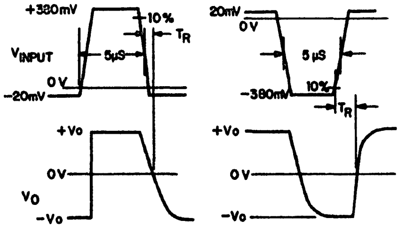


FIGURE 3
RECOVERY TIME



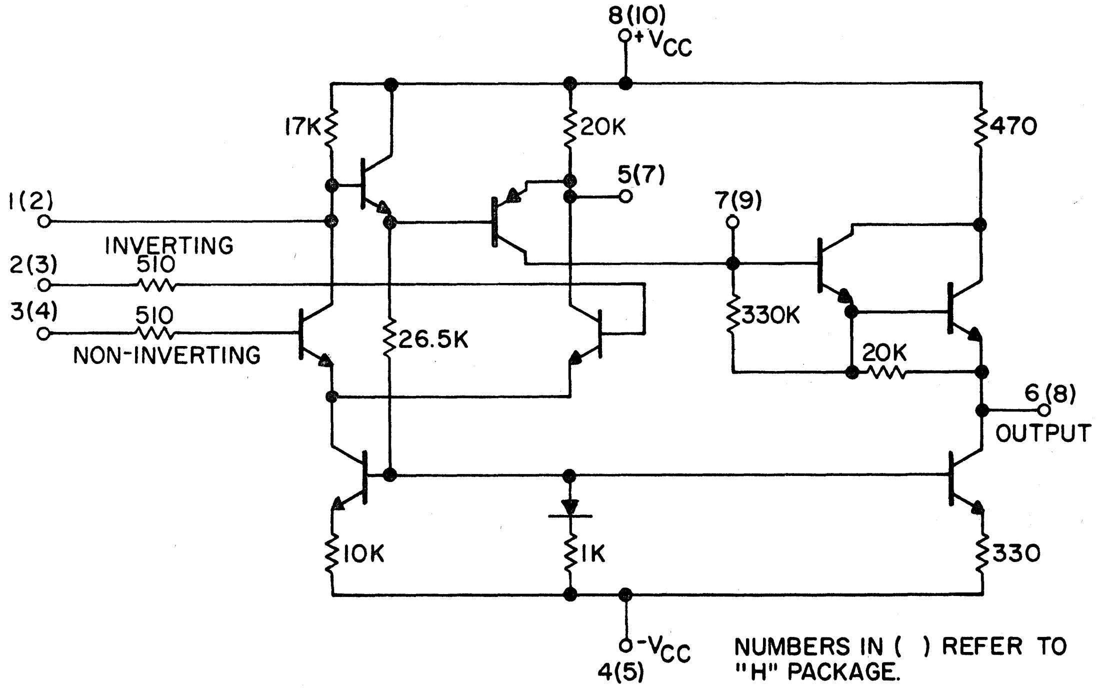
pulse separation = 20μS

JANUARY 1968

LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

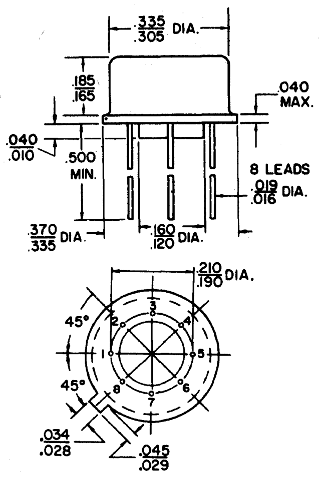
819

The Amelco 819 Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. The unique simplicity of this design results in a low cost, high performance amplifier. It is ideally suited for applications requiring high common mode range, high input impedance, and low current and voltage offsets and offset drifts, and low power.



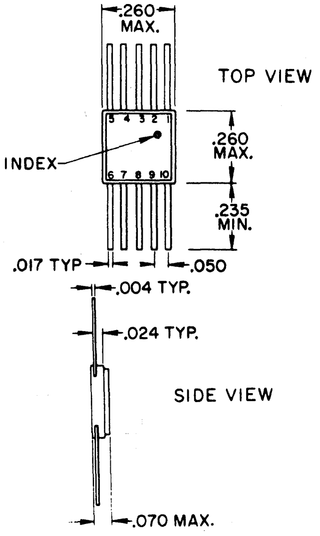
NUMBERS IN ( ) REFER TO "H" PACKAGE.

E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO CASE

H PACKAGE



ABSOLUTE MAXIMUM RATINGS

	819B
Storage Temperature Range	-65°C to $+150^{\circ}$C
Operating Temperature Range	-55°C to $+125^{\circ}$C
Maximum Supply Voltage	±18V
Operating Voltage	±15V
Differential Input Voltage	±15V
Input Voltage	±15V
Internal Power Dissipation	300 mW
Output Short Circuit Duration	Continuous
Lead Temperature, 1/16 inch from case, 10 seconds max.	$+300^{\circ}$C

Complete part number designation consists of three digits and two letters, for example:

819BE
Package
Temperature Range
Type

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

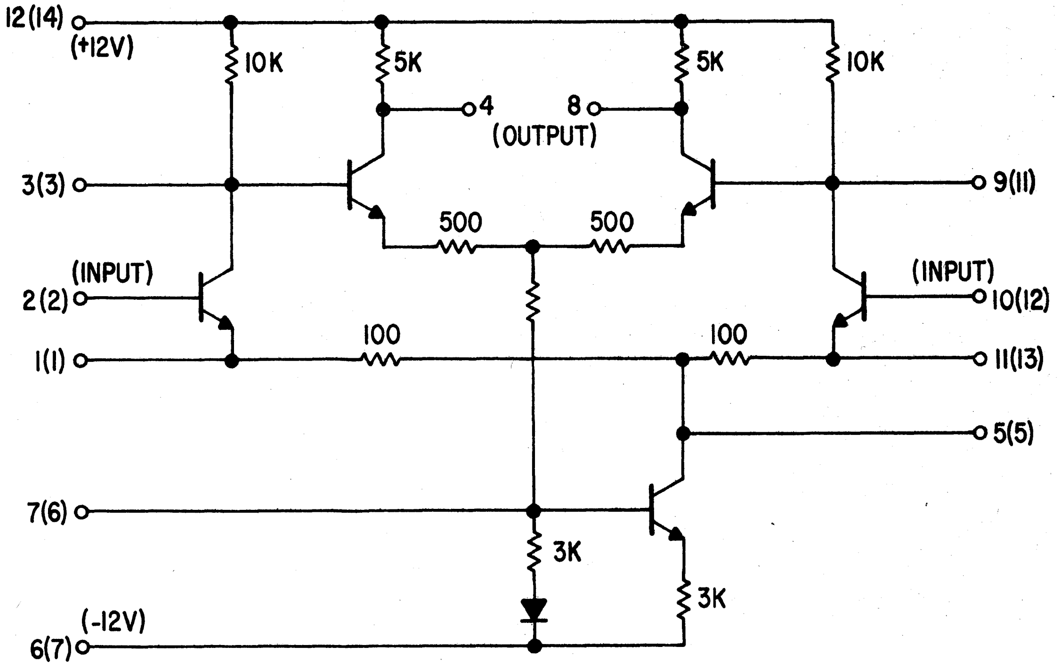
[illegible] CHARACTERISTICS

JANUARY 1968

LINEAR CIRCUIT
DIFFERENTIAL AMPLIFIER

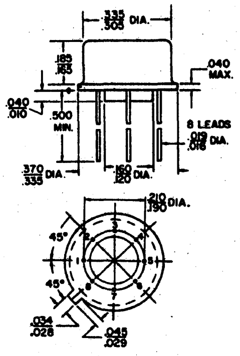
831

This low-level differential amplifier consists of five NPN transistors and associated resistors constructed on a single silicon chip. The amplifier design features tight thermal coupling, close beta and V_{BE} match with common-mode feedback. Because of its design, the amplifier exhibits extremely low drift characteristics and excellent stability over a wide temperature range.



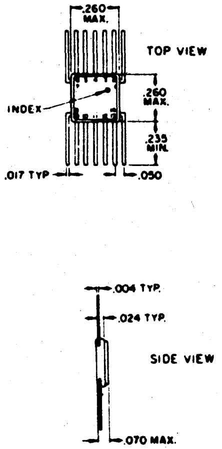
NOTE: Numbers in parentheses refer to "H" package.

E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO CASE

H PACKAGE



TEMPERATURE RANGE:

	831A 831B	831C	831D
Storage	−65°C to +150°C	−65°C to +150°C	−65°C to +150°C
Operating	−55°C to +125°C	−25°C to +85°C	0°C to 70°C

POWER SUPPLY REQUIREMENTS:

+12 Volts at 4.0 mA typical, 5.0 mA maximum
−12 Volts at 4.0 mA typical, 5.0 mA maximum

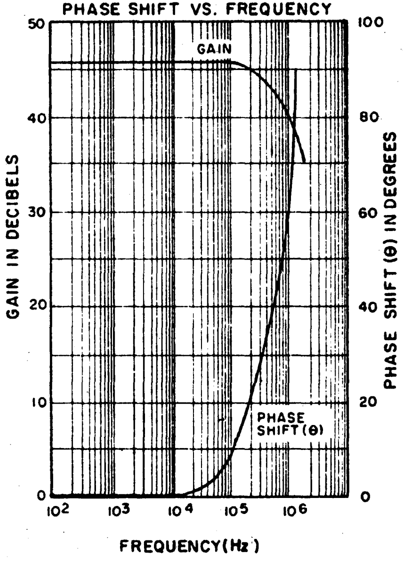
Complete part number designation consists of three digits and two letters, for example:

831DE
- Package
- Temperature Range
- Circuit

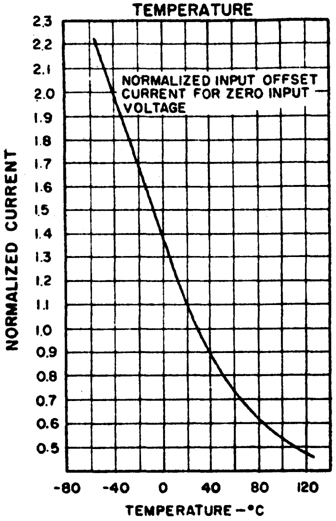
AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

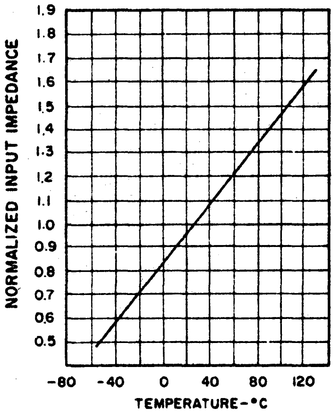
SINGLE ENDED GAIN AND PHASE SHIFT VS. FREQUENCY



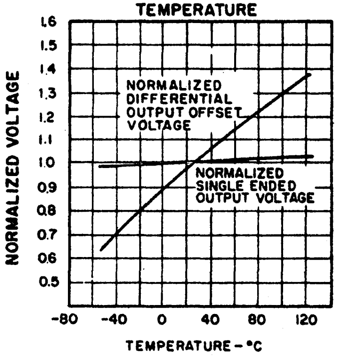
NORMALIZED INPUT OFFSET CURRENT VS. TEMPERATURE



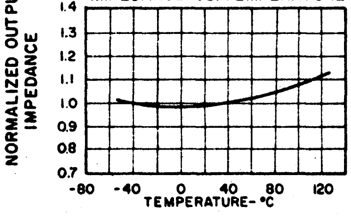
NORMALIZED INPUT IMPEDANCE VS. TEMPERATURE



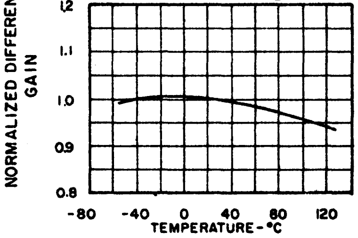
NORMALIZED SINGLE ENDED OUTPUT VOLTAGE AND OUTPUT OFFSET VOLTAGE VS. TEMPERATURE



NORMALIZED SINGLE ENDED OUTPUT IMPEDANCE VS. TEMPERATURE



NORMALIZED DIFFERENTIAL GAIN VS. TEMPERATURE



ELECTRICAL CHARACTERISTICS at 25°C Unless Otherwise Noted

CHARACTERISTICS	831A			831B			831C			831D			UNITS
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
OUTPUT CHARACTERISTICS Single Ended DC Output Voltage (Both Inputs at Zero Volts)	6.0	7.0	8.0	4.5	7.0	9.5	2.5	7.0	11.5				Volts
Differential Output Offset Voltage(1) (With Zero Input Voltage)		1.0	2.0		2.5	5.0		5.0	9.0				Volts
Differential Output Offset Voltage(1) (Referred to Input)		2.5	5.0		8.0	17		20	40		10	40	mV
Single Ended Dynamic Range (No Load)	6.0	6.8		6.0			5.0			5.0	6.0		Volts
Single Ended Output Impedance		5.0	6.0		5.5	7.0		5.5	7.0		5.5	7.0	KΩ
Mean Differential Output Voltage Drift(2) (Referred to Input) −55°C to +125°C −25°C to +85°C		2.0	4.0		5.0	10		 10					µV/°C
INPUT CHARACTERISTICS Input Offset Current (Input Voltage = 0)		0.2	2.0		1.0	5.0		1.0	10			2.0	µA
Input Impedance	20	40		10	20		5.0(3)	20		5.0	20		KΩ
Mean Input Offset Current Drift(2) (Input Voltage = 0) −55°C to +125°C		2.0			5.0								nA/°C
TRANSFER CHARACTERISTICS Differential Gain (No Load)	400			300			250(3)			200(3)			
Differential Gain (No Load with Pins 1, 5, and 11 Tied Together)		2000			2000			1500(4)			1500(4)		
Bandwidth (−3 db)	300	400		300	400		200(3)	400		250(3)	400		kHz
Common Mode Rejection (CM Input Voltage = 1.0 V pp, 100 Hz		−100	−90			−80			−60(3)		−80	−60(3)	db
Common Mode Input Range	−2.0		+1.5	−2.0		+1.0	−1.0		+1.0	−1.0		+1.0	Volts
Power Supply Rejection (+12 V or −12 V Supply)	−80		−70		−70	−60		−70			−70	−50	db

NOTES: (1) The differential output offset voltages given are for untrimmed devices. The offset voltage for all devices can be adjusted to zero by means of a trim potentiometer connected across pins 1, 5, and 11 as shown in test circuit for balancing the amplifier.

(2) The mean differential output voltage drift referred to the input is given by

$$\frac{\frac{\text{Output Offset Voltage (125°C)}}{\text{Differential Gain (125°C)}} - \frac{\text{Output Offset Voltage (−55°C)}}{\text{Differential Gain (−55°C)}}}{(125°\text{C}) - (-55°\text{C})}$$

The mean input offset current drift ($V_{in} = 0$) is given by

$$\frac{\text{Input Offset Current (125°C)} - \text{Input Offset Current (−55°C)}}{(125°\text{C}) - (-55°\text{C})}$$

(3) When balanced with a 1000 ohm potentiometer across pins 1, 5, and 11.

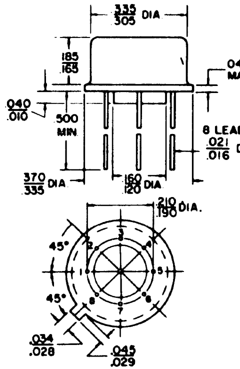
(4) When balanced with a 10 ohm potentiometer across pins 1, 5, and 11.

LINEAR CIRCUIT
OPERATIONAL AMPLIFIER

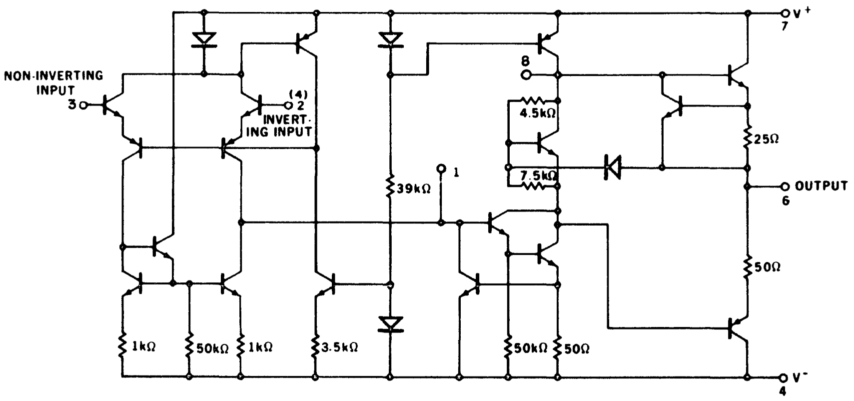
841

The Amelco 841 Operational Amplifier is constructed on a single monolithic silicon substrate using planar epitaxial techniques. Input and output overvoltage and short circuit protection coupled with the elimination of latch up problems result in an excellent general purpose amplifier. Proper pin arrangement makes the 841 a direct replacement for the 709 and LM101 operational amplifiers for most applications. Frequency compensation is accomplished with a single external capacitor and permits the user to shape his open loop frequency response and improve the slew rate magnitude depending upon the compensation value.

E PACKAGE



PIN 4 IS INTERNALLY CONNECTED TO CASE



SCHEMATIC DIAGRAM

Note: NUMBERS IN PARENTHESES ARE FOR DUAL IN LINE CONNECTIONS.

	841B	841C
Storage Temperature Range	−65°C to +150°C	−65°C to +150°C
Operating Temperature Range	−55°C to +125°C	0°C to +100°C
Lead Soldering Temperature (60 sec)	300°C	300°C
Power Dissipation (Note 1)	500 mW	500 mW
Supply Voltage	±22 V	±22 V
Input Voltage (Note 2)	±15 V	±15 V
Differential Input Voltage	±30 V	±30 V
Output Short Circuit Duration (Note 3)	Indefinite	Indefinite

Complete part number designation consists of three digits and two letters, for example:

841BE
Package
Temperature Range
Circuit

NOTES:
1. Rating applies for case temperatures to 125°C; derate linearly at 6.5 mW/°C for ambient temperature above +75°C.
2. For supply voltages less than ±15 V, the absolute maximum input voltage is equal to the supply voltage.
3. Short circuit may be to ground or either supply. Rating applies to +125°C case temperature or +75°C ambient temperature.

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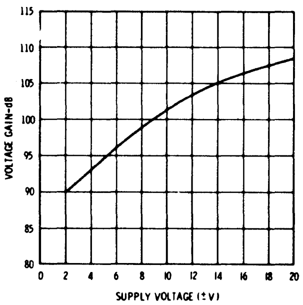
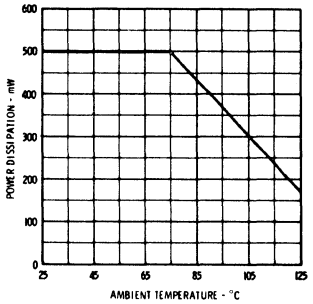
ELECTRICAL CHARACTERISTICS at 25°C and $V_{CC} = \pm 15$ V (Unless Otherwise Specified)

PARAMETER	841B MIN.	841B TYP.	841B MAX.	841C MIN.	841C TYP.	841C MAX.	UNITS
Input Offset Voltage ($R_S \leq 10$ KΩ)		1.0	5.0		2.0	6.0	mV
Input Offset Current		30	200		30	200	nA
Input Bias Current		200	500		200	500	nA
Input Resistance	0.3	1.0		0.3	1.0		MΩ
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	50,000	200,000		20,000	100,000		
Output Voltage Swing ($R_L \geq 10$ KΩ)	±12	±14		±12	±14		Volts
($R_L \geq 2$ KΩ)	±10	±13		±10	±13		Volts
Input Voltage Range	±12	±13		±12	±13		Volts
Common Mode Rejection Ratio ($R_S \leq 10$ KΩ)	70	90		70	90		dB
Supply Voltage Rejection Ratio ($R_S \leq 10$ KΩ)		30	150		30	150	μV/V
Power Consumption		50	85		50	85	mW
Transient Response (unity gain) $\left\{ V_{IN} = 20 \text{ mV}, C_C = 30 \text{ pF} \right\}$							
Risetime $\left\{ R_L = 2 \text{ K}\Omega \right\}$		0.3			0.3		μs
Overshoot $\left\{ C_L \leq 100 \text{ pF} \right\}$		5.0			5.0		%
Slew Rate							
Non-Inverting							
(Unity Gain) $R_L \geq 2$ KΩ, $C_C = 30$ pF		0.5			0.5		
$R_L \geq 2$ KΩ, $C_C = 3$ pF		1.5			1.5		
(Gain ≥ 10) $R_L \geq 2$ KΩ, $C_C = 0$ pF		10			10		V/μS
$R_L \geq 2$ KΩ, $C_C = 3$ pF		5			5		
Inverting							
(Unity Gain) $R_L \geq 2$ KΩ, $C_C = 3$ pF		4			4		
(Gain ≥ 10) $R_L \geq 2$ KΩ, $C_C = 0$ pF		10			10		
$R_L \geq 2$ KΩ, $C_C = 3$ pF		5			5		
The following specifications apply for $T_{min} \leq T_A \leq T_{max}$							
Input Offset Voltage ($R_S \leq 10$ KΩ)			6.0			7.5	mV
Input Offset Current			500			300	nA
Input Bias Current			1.5			0.8	μA
Large-Signal Voltage Gain ($R_L \geq 2$ KΩ)	25,000			15,000			
Output Voltage Swing ($R_L \geq 2$ KΩ)	±10			±10			Volts

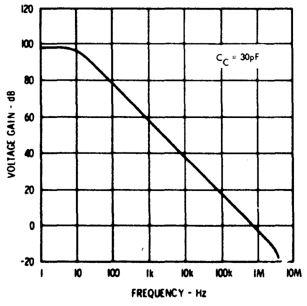
OPEN LOOP
VOLTAGE GAIN



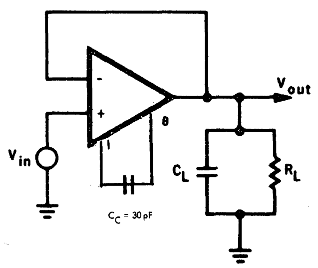
ABSOLUTE MAXIMUM
POWER DISSIPATION



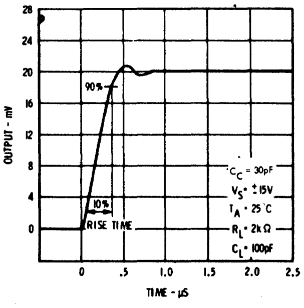
OPEN LOOP
FREQUENCY RESPONSE



TRANSIENT RESPONSE
TEST CIRCUIT



TRANSIENT RESPONSE

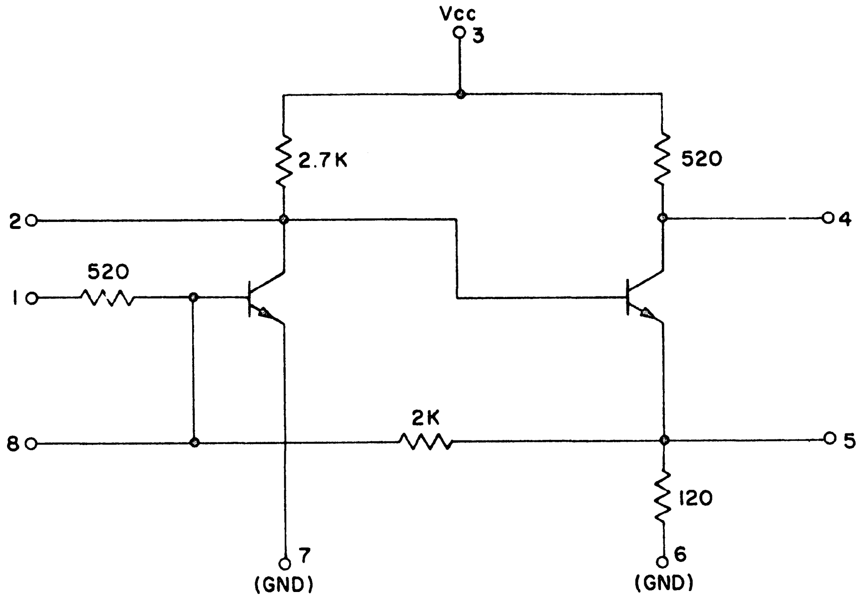


JANUARY 1968

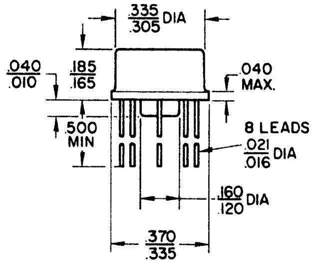
LINEAR CIRCUIT AMPLIFIER
UHF

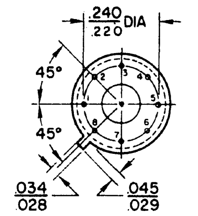
901

The 901BE and 901CE are epitaxial integrated circuits. Precise device design in conjunction with exacting photoetching techniques have resulted in a VHF monolithic amplifier suitable for video and IF amplifier applications in excess of 50 MHz.



E PACKAGE





·PIN 7 IS INTERNALLY CONNECTED TO CASE

ABSOLUTE MAXIMUM RATINGS

Total supply voltage between pins 3 and 7	15 volts	
Storage temperature	−65°C to +150°C	
Operating temperature	901BE −55°C to +125°C	901CE 0°C to 70°C

SUPPLY VOLTAGES

Pin 3 to ground	+12 volts, 12 mA Typical

Complete part number designation consists of three digits and two letters, for example:

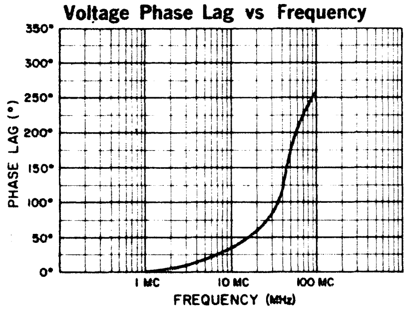
AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

ELECTRICAL CHARACTERISTICS at 25°C (Unless Otherwise Noted)

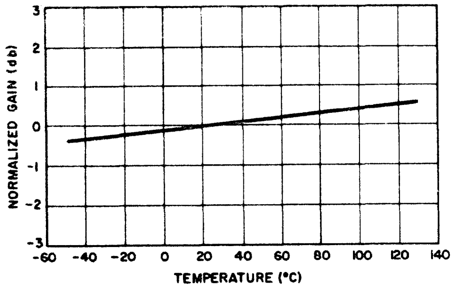
CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS
OUTPUT CHARACTERISTICS Dynamic Range (no load) +25°C Temp*	 5.0 4.0	 7.0		V_{p-p}
Output Impedance		520		Ohms
DC Output Level		8.7		Volts
INPUT CHARACTERISTICS Input Impedance		520		Ohms
Input Signal Level			260	mV_{p-p}
TRANSFER CHARACTERISTICS Voltage Gain	22	24	26	db
Gain Variation Temp*		±0.3		db
Gain Variation (DC to 10 MHz)	−0.5		+0.5	db
Bandwidth (−3.0 db)	40	60		MHz

* Limit applies for "B" grade unit for −55°C to +125°C,
Limit applies for "C" grade unit for 0°C to 70°C.

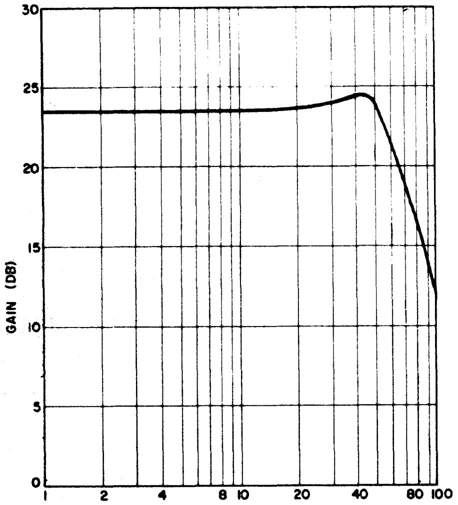
Voltage Phase Lag vs Frequency



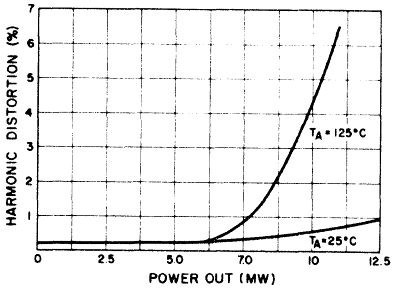
Gain vs Temperature



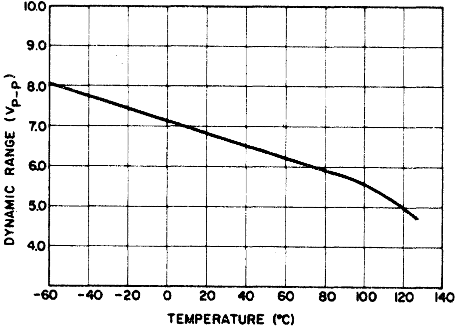
Gain vs Frequency



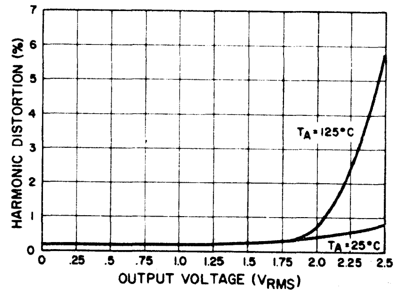
Percent Harmonic Distortion vs Power Output (Milliwatts)



Dynamic Range vs Temperature



Percent Harmonic Distortion vs Output Voltage Swing (RMS)



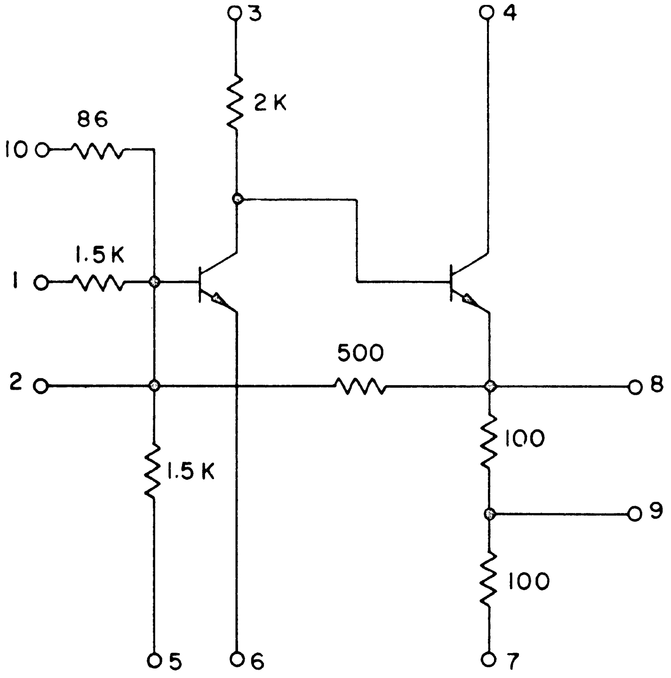
JANUARY 1968

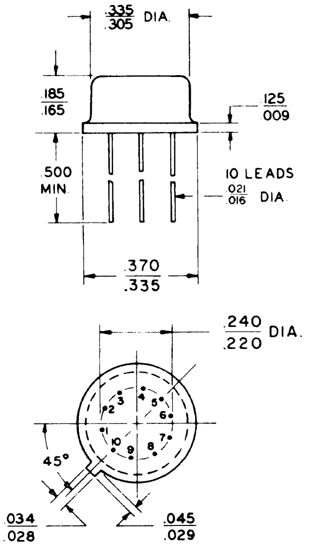
LINEAR CIRCUIT AMPLIFIER UHF

903

The 903BR and 903CR are epitaxial monolithic circuit suitable for oscillator, video and IF amplifier applications, including frequencies in the VHF Band.

R PACKAGE





PIN 6 IS INTERNALLY CONNECTED TO CASE

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to+150°C
Operating Temperature 903BR 903CR	−55°C to +125°C 0°C to 70°C
Total supply voltage between pins 4 and 8 (See Test Circuit)	15 Volts

POWER SUPPLY REQUIREMENTS

+12 Volts at 8.0 mA typical	
−6 Volts at 4.0 mA typical	

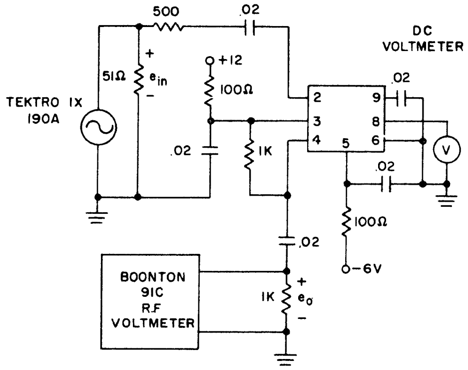
Complete part number designation consists of three digits and two letters, for example:

903BR
Package
Temperature Range
Circuit

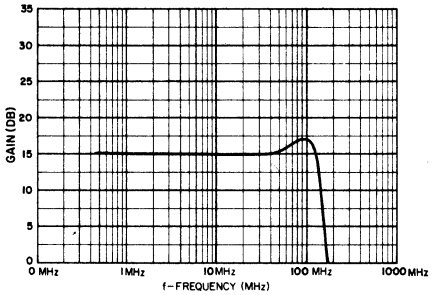
ELECTRICAL CHARACTERISTICS at 25°C (Unless Otherwise Noted)

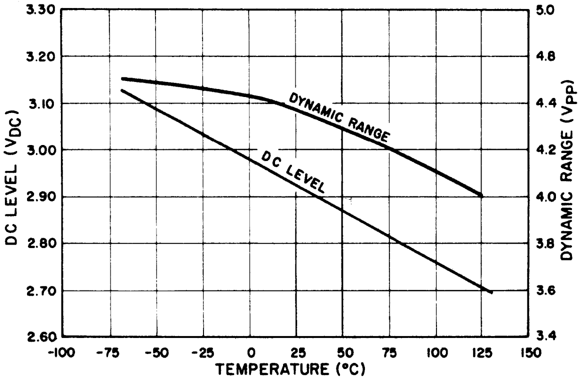
CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS
OUTPUT CHARACTERISTICS				
Dynamic Range (Note 1)	3.0	4.0		V_{p-p}
Temp.*	2.5	3.5		
DC Level (Pin 8)	2.4	3.0	3.4	Volts
Output Admittance		7.0 0.6	15 1.5	pf mmhos
INPUT CHARACTERISTICS				
Input Admittance	−10	−25 10		pf mmhos
TRANSFER CHARACTERISTICS				
Voltage Gain	13	15	17	db
Bandwidth (−3 db)	60	110		MHz

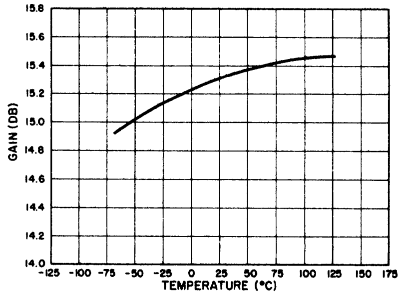
Note 1: f = 500 kHz measured from pin 4 to Ground (see test circuit)
* Limit applies for "B" grade unit for −55°C to +125°C,
Limit applies for "C" grade unit for 0°C to 70°C.



TEST IRCUIT I


Gain vs Freq.


DC Level & Dynamic Range vs Temp.


Gain vs Temp.

JANUARY 1968

LINEAR CIRCUIT
RF/IF AMPLIFIER

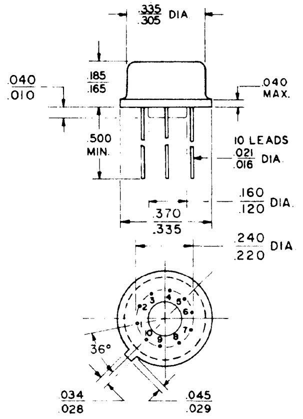
911

This versatile high frequency device may be used as:

- Tuned Emitter Coupled Amplifier
- Tuned Cascode Amplifier with AGC
- Mixer
- Modulator
- Oscillator
- Video Amplifier
- Differential DC Amplifier
- Numerous other applications

Available terminals allow the user to tailor the amplifier to his requirements, including selection of biasing configuration.

E PACKAGE



PIN 5 IS INTERNALLY CONNECTED TO CASE

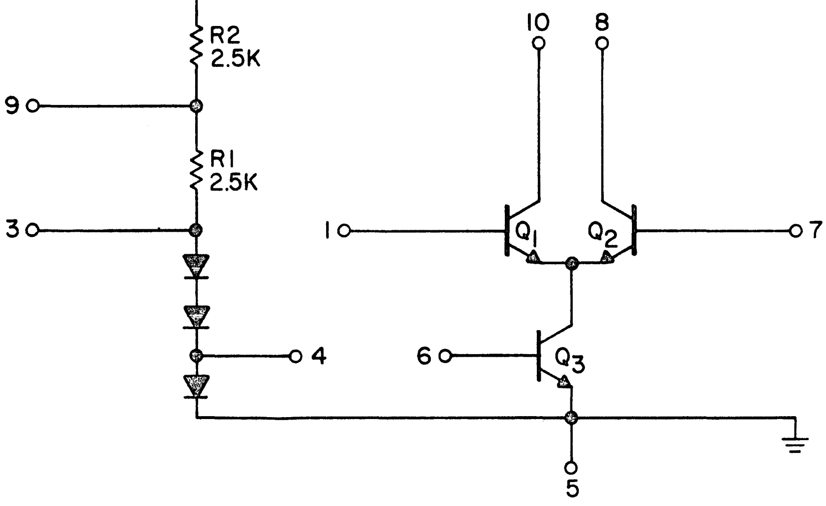
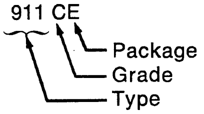


FIGURE I

ABSOLUTE MAXIMUM RATINGS

	911B	911C
Total Supply Voltage	30 Volts	30 Volts
Storage Temperature	−65°C to +150°C	−65°C to +150°C
Operating Temperature	−55°C to +125°C	0 to 100°C
Maximum Operating Voltage	24 Volts	24 Volts
Power Dissipation	230 mW	230 mW
Voltage between 1 and 7	±5 Volts	±5 Volts
Voltage between 4 and 6	±5 Volts	±5 Volts

Complete part number designation consists of three digits and two letters, for example:



AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

ELECTRICAL CHARACTERISTICS AT +25°C & Vcc = + 12 V. (Unless Otherwise Specified)

PARAMETER	SYMBOL	TEST CONDITIONS	BIAS	FIG.	MIN.	TYP.	MAX.	UNITS
DC CHARACTERISTICS								
DC Output Voltage	VoDC	ein = 0	d	27	4.5		9.5	V_{DC}
Power Supply Drain Current	IPS	ein = 0	d	27		8.0	10	mA
Input Offset Voltage	Vio	$I_8 = I_{10}$	b	27		0.3	5.0	mV
EMITTER COUPLED CHARACTERISTICS (Input Signal < 10 mv RMS)								
Input Conductance	G_{11}	455 kHz	b	16		0.30	0.40	mmhos
Output Conductance	G_{22}	455 kHz	b	16		0.01	0.04	mmhos
Magnitude of Forward Transadmittance	$\|Y_{21}\|$	455 kHz	b	16	17	22		mmhos
Magnitude of Reverse Transadmittance	$\|Y_{12}\|$	200 MHz	b	16		0.1		mmhos
Tuned Power Gain	Ap	10.7 MHz, BW = 470 kHz	b	16		24.6		db
Tuned Power Gain	Ap	100 MHz, BW = 5 MHz	b	16		22.7		db
CASCODE CHARACTERISTICS (Input Signal < 10 mv RMS)								
Input Conductance	G_{11}	455 kHz	b	5		1.0	2.5	mmhos
Output Conductance	G_{22}	455 kHz Connect pin 1 to 7	b	5		0.01	0.04	mmhos
Magnitude of Forward Transadmittance	$\|Y_{21}\|$	455 kHz Pin 1 grounded	b	5	25	40		mmhos
Magnitude of Reverse Transadmittance	$\|Y_{12}\|$	200 MHz	b	5		0.001		mmhos
Tuned Power Gain	Ap	100 MHz Pin 1 grounded BW = 5 MHz	b	5		27.5		db
Tuned Power Gain	Ap	200 MHz Pin 1 grounded BW = 6 MHz	b	5		25		db

Total Supply Current vs Supply Voltage

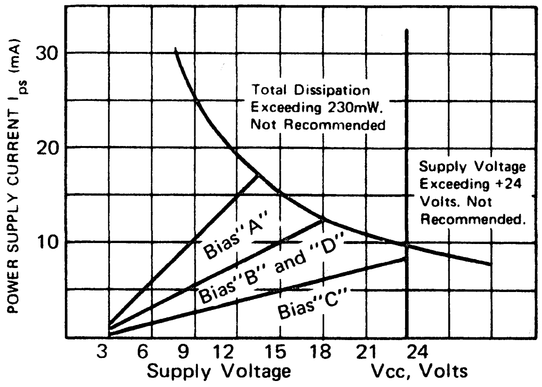


FIGURE 2

Current Source - Diode Current Ratio vs Current Forced Through Diode Chain

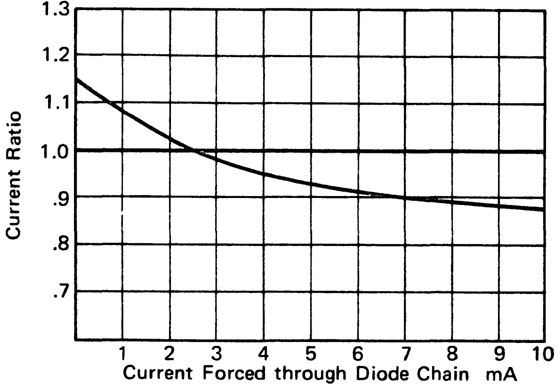


FIGURE 3

BIASING CONSIDERATIONS

DC biasing of the 911 is achieved through monolithic matching of diode-transistor characteristics. Combinations of resistors R1 and R2 may be chosen to force a desired current from Vcc to ground through a three diode chain. If pin 4 is connected to pin 6 directly, through an inductor, or resistor having DC resistance less than 100 ohms, approximately the same current will be established in Q3 as is forced in the diode chain. (See figure 3.)

A DC reference voltage appears at pin 3, which may be used to bias the differential amplifier bases, pins 1 and 7. (See figure 4.) The reference voltage is approximately the minimum voltage required to operate the current source transistor, permitting maximum available output voltage swing in Q1 and Q2 under all conditions.

Currents other than those forced by the internal resistance may be obtained from a given supply voltage with an external resistance from Vcc to pin 3, but care should be taken not to exceed the rated maximum total dissipation. (See figure 2.)

DC Reference Voltage (Pin 3 to 5) vs Diode Chain Current and Supply Current

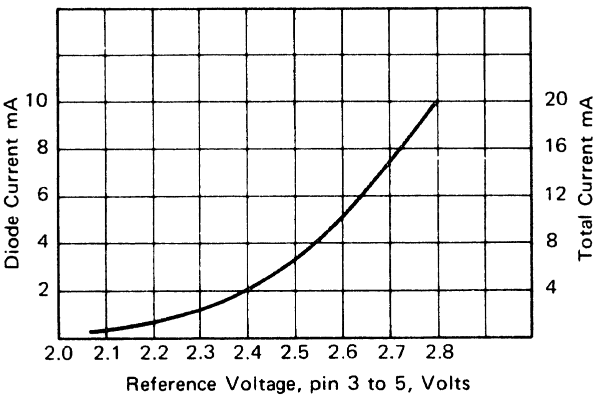


FIGURE 4

CASCODE OPERATION

The common-emitter, common-base, or cascode, configuration is useful as a tuned RF or IF amplifier to 250 MHz. Two common-base stages are formed by the differential pair, Q1 and Q2, which may be used as a gain control system by applying a differential gain control voltage between pins 1 and 7. (Figures 11 and 13.) With Q1 cut off, maximum gain is obtained, being reduced as Q1 is progressively turned on and Q2 turned off. The input common-emitter transistor presents a nearly constant input admittance as AGC is applied (Figure 12.)

DC input bias is obtained through the input inductor from the bias chain, pin 4.

Pin 3 may be used as the DC reference for the AGC input, to assure adequate bias voltage for the collector of Q3. Where large AGC voltages are used, an external resistive divider, from pin 3 to 1 to the AGC voltage may be used to optimize the DC AGC requirements. VAGC is defined as the voltage between pin 1 and 7.

At some frequencies, bypassing may be required at pins 1, 3, 4 or the Vcc connection.

Input Resistance & Capacitance vs Frequency

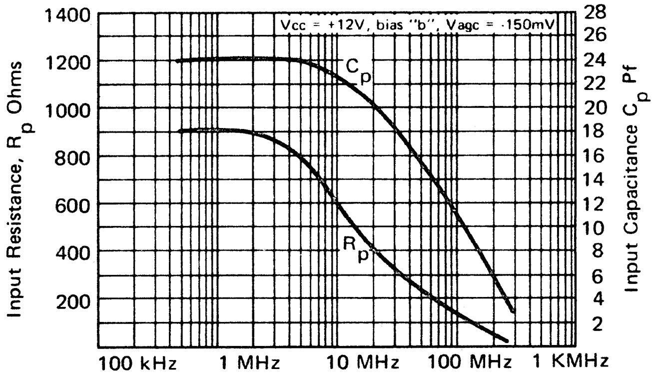


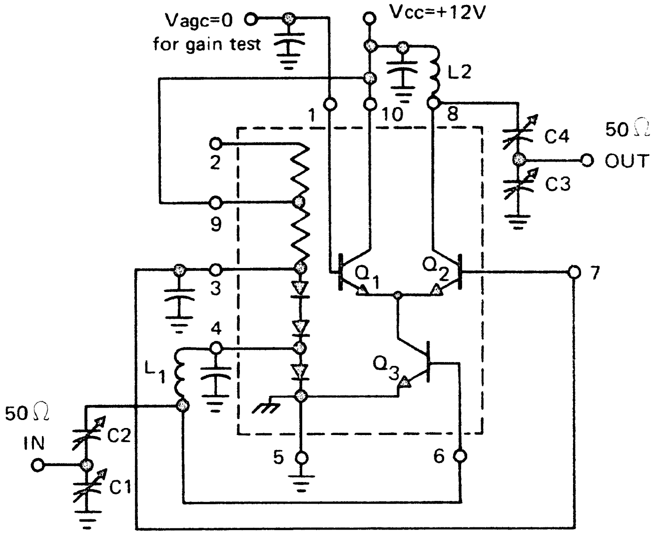
FIGURE 6

Definition of Bias Configurations

BIAS	CONNECT	TYP. BIAS RESISTANCE
a	2 to 3, Vcc to 9	1.25 kΩ
b	Vcc to 9	2.5 kΩ
c	Vcc to 2	5.0 kΩ
d*	2 to 8, Vcc to 9	2.5 kΩ

* Bias "d" is the "General Purpose Amplifier" Configuration, with R_2 as collector load.

100 MHz Cascode Test Circuit



C_1=C_3 = 9-36 pf trimmer L_1=L_2= 7t. #16 a.w.g.
C_2=C_4 = 2-8 pf trimmer spaced 1 turn, ¼" inside diam.

FIGURE 5

Output Resistance & Capacitance vs Frequency

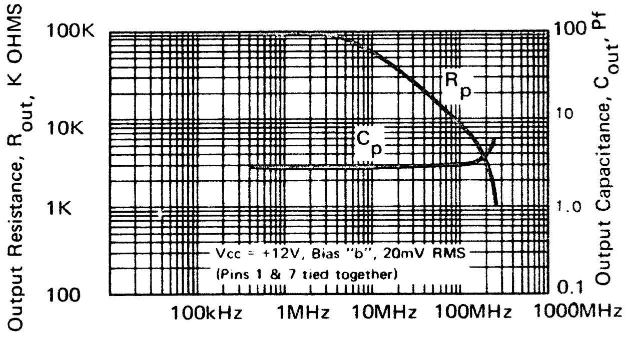
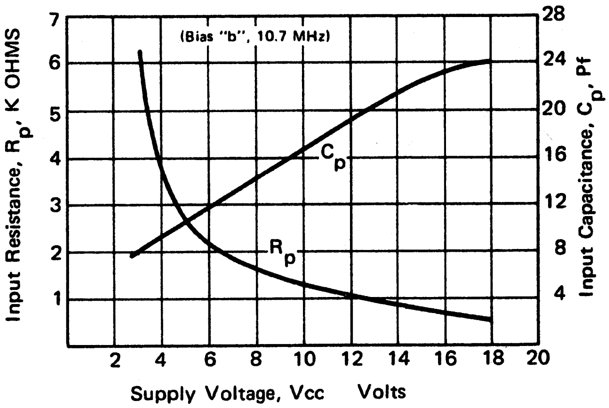
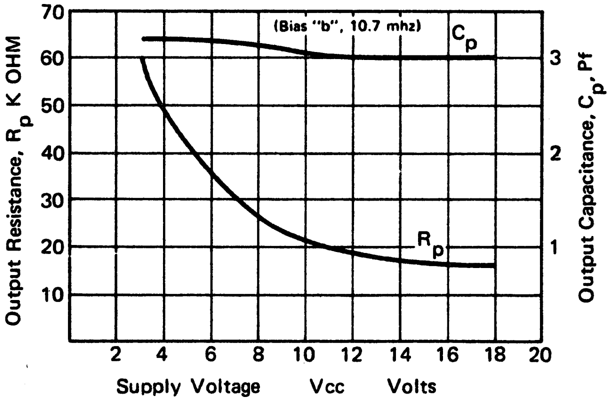


FIGURE 7



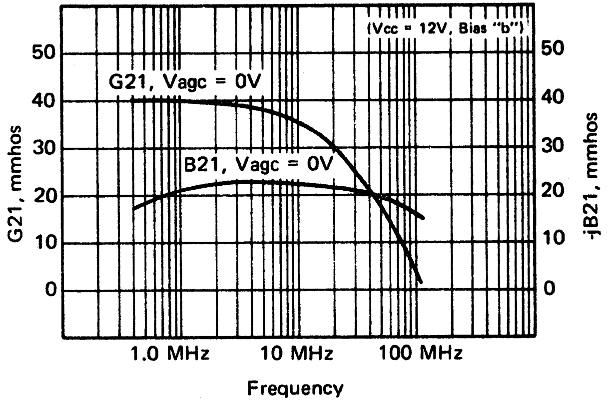
Input Resistance & Capacitance vs Vcc

FIGURE 8



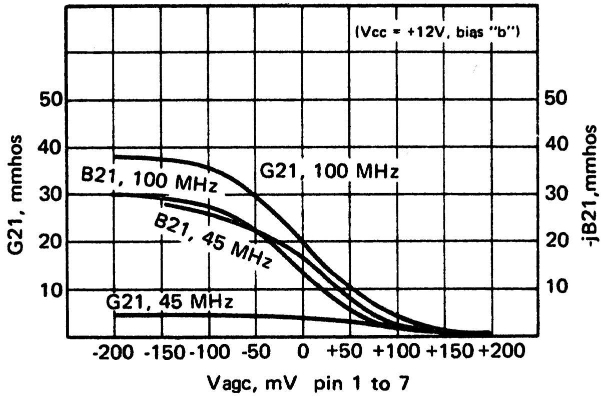
Output Resistance & Capacitance vs Vcc

FIGURE 9



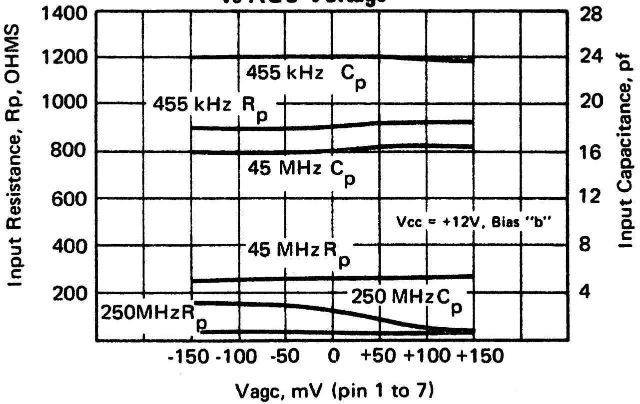
Forward Transadmittance vs Frequency

FIGURE 10



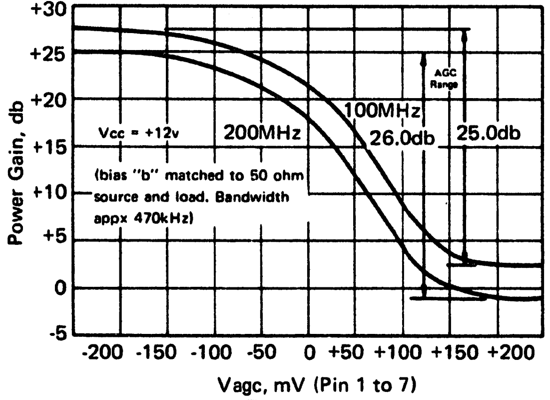
Forward Transadmittance vs AGC Voltage

FIGURE 11



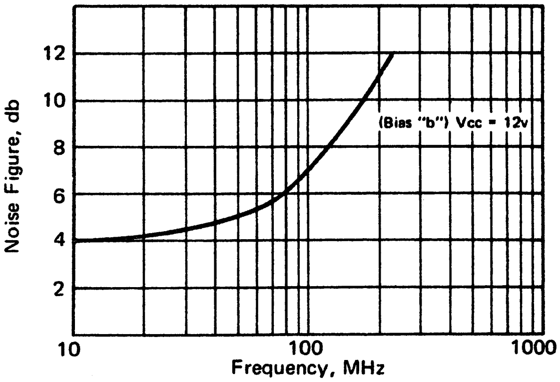
Input Resistance & Capacitance vs AGC Voltage

FIGURE 12



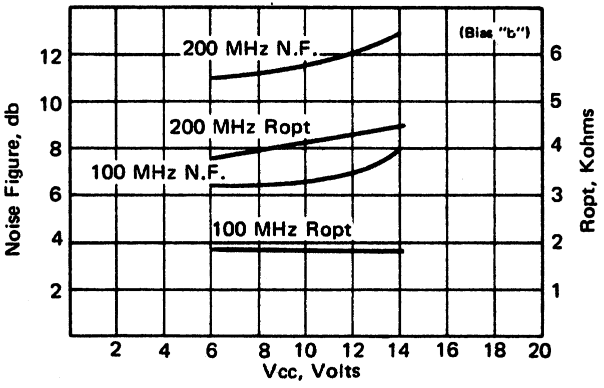
Tuned Power Gain vs AGC Voltage

FIGURE 13



Noise Figure vs Frequency

FIGURE 14



Noise Figure & Optimum Source Resistance vs Vcc

FIGURE 15

EMITTER COUPLED OPERATION

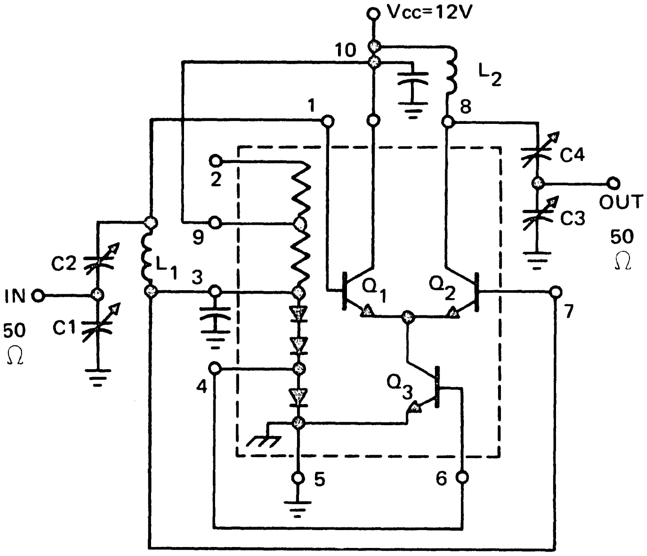
The common-collector, common-base, or emitter-coupled configuration is useful as a symmetrically non-saturated limiting RF or IF amplifier to 150 MHz. Basically a differential amplifier, this configuration is especially suited to FM IF strips using conventional interstage tuning. While available gain is lower and noise figure higher than the cascode, emitter coupled operation may be considered wherever fast recovery from large-signal overdrive or excellent AM rejection is required.

Q3 is used as a current source, obtaining its bias from the diode chain. Current available from Q3 is shunted through Q1 or Q2, depending on input signal, and is equally divided when no signal is present, assuring inherently symmetrical operation. DC bias for pin 7 is obtained from the divider chain, and through the input inductor, the same bias is applied to pin 1.

For non-saturated operation, the output load must be chosen so that the collector voltage of the output transistor is higher than the DC reference voltage, with all source current shunted into the output, for the particular bias levels used.

At some frequencies, bypassing of pins 3, 6, 7, or the Vcc connection may be required.

100 MHz Emitter Coupled Test Circuit



$C_1 = C_3$ = 9-36 pf trimmer
$C_2 = C_4$ = 2-8 pf trimmer

$L_1 = L_2$ = 7t. #16 a.w.g. spaced 1 turn, ¼" inside diam.

FIGURE 16

Input Resistance & Capacitance vs Frequency

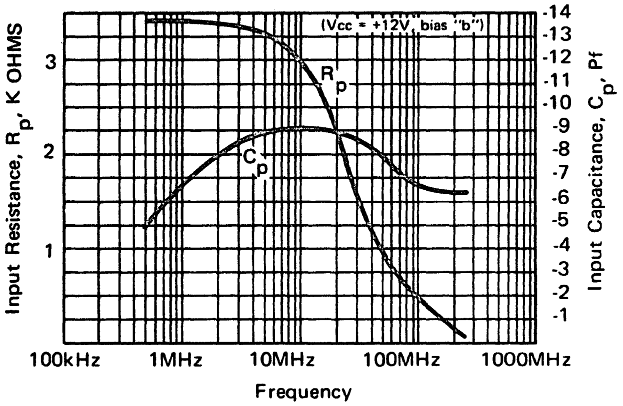


FIGURE 17

Output Resistance & Capacitance vs Frequency

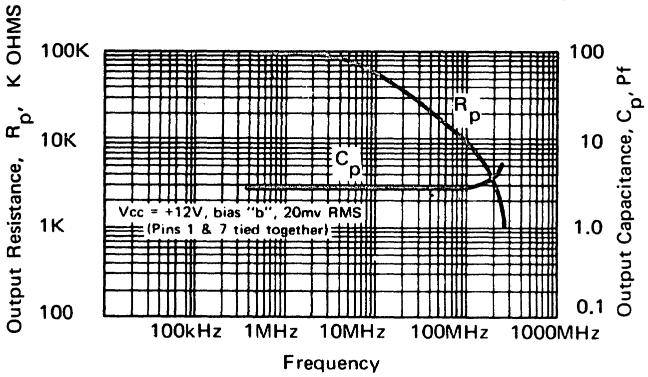


FIGURE 18

Input Resistance & Capacitance vs Vcc

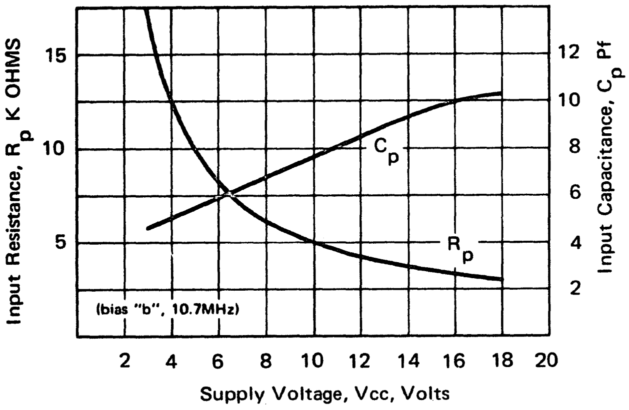


FIGURE 19

Output Resistance & Capacitance vs Vcc

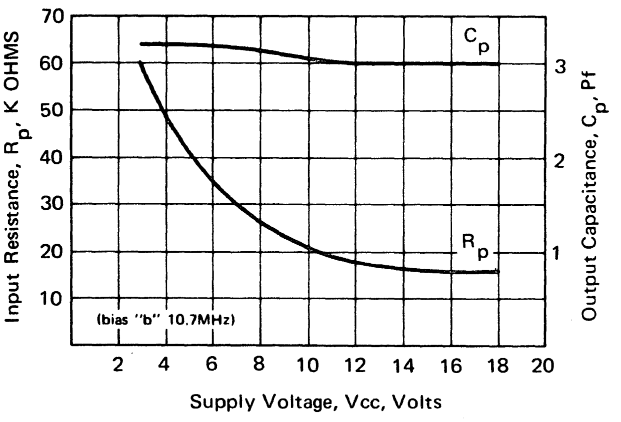


FIGURE 20

Forward Transadmittance vs Frequency

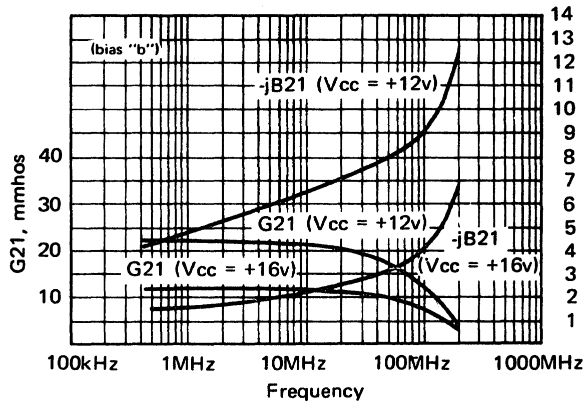


FIGURE 21

Forward Transadmittance vs Vcc

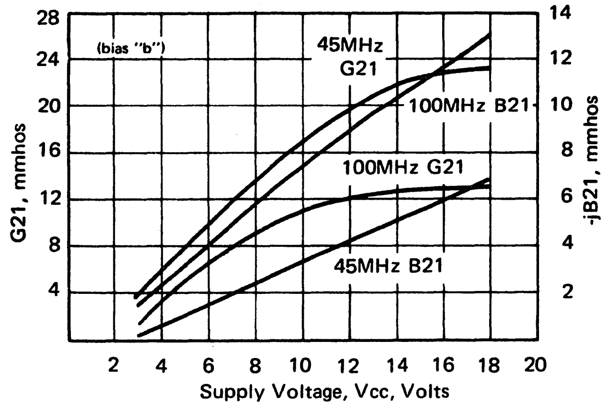


FIGURE 22

Input Resistance & Capacitance vs Input Signal Level

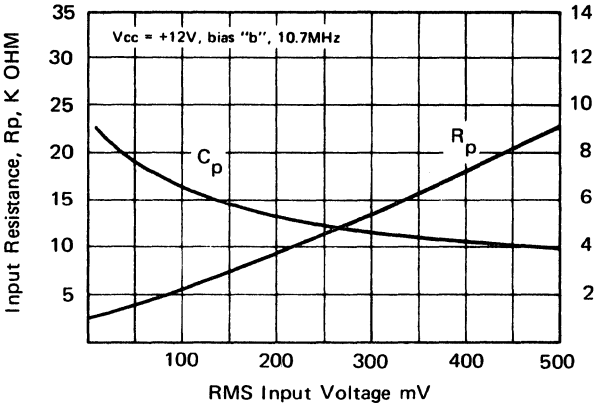


FIGURE 23

Limiting Characteristic
Output Power vs Input Power

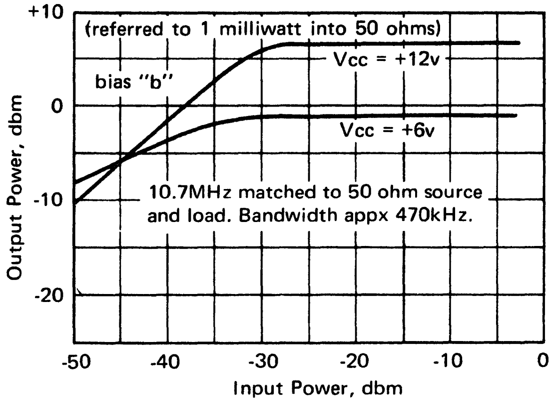


FIGURE 24

Noise Figure vs Frequency

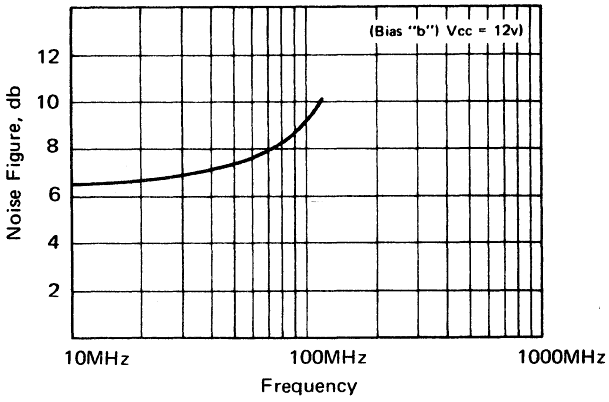


FIGURE 25

Noise Figure & Optimum Source Resistance vs Vcc

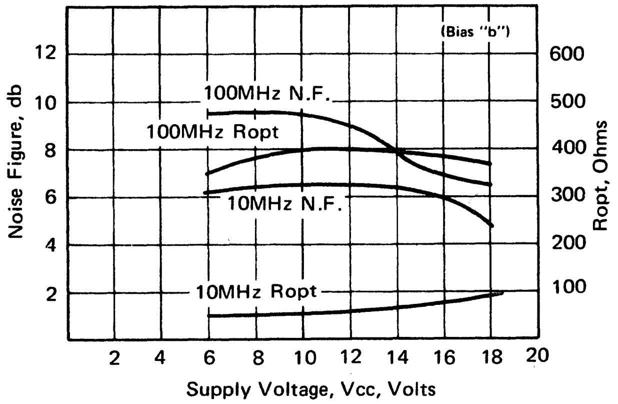


FIGURE 26

DIRECT COUPLED OPERATION

Convenient self-contained biasing, excellent monolithic matching, and high gain-bandwidth product make a wide variety of applications possible using resistive loads.

Bias "d", the "General Purpose Amplifier", uses R2 as collector load for a single-ended output, differential input amplifier, with no external components required, and with large dynamic range for all supply voltages.

By choosing the proper external load resistor, bias configuration, and supply voltage, video amplifiers may be constructed to meet specific gain and bandwidth requirements, in either cascode or emitter coupled form.

With matched pairs of external load resistors, true differential DC amplifiers may be constructed, with large common-mode input range, input offset voltages typically 0.3 mV, and monolithically matched, self-contained current sources easily tailored to specific operating point requirements.

Direct Coupled Test Circuit
(Connect Pins 2 and 8 For Bias "d")

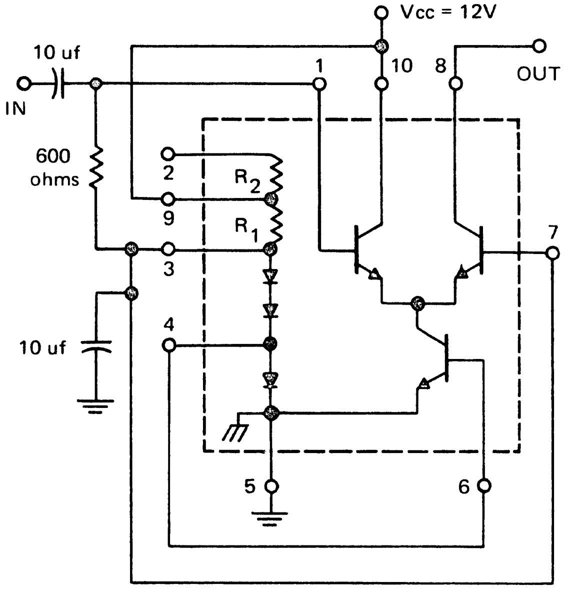


FIGURE 27

General Purpose Amplifier Voltage Gain,
DC Output Voltage & Dynamic Range vs Vcc

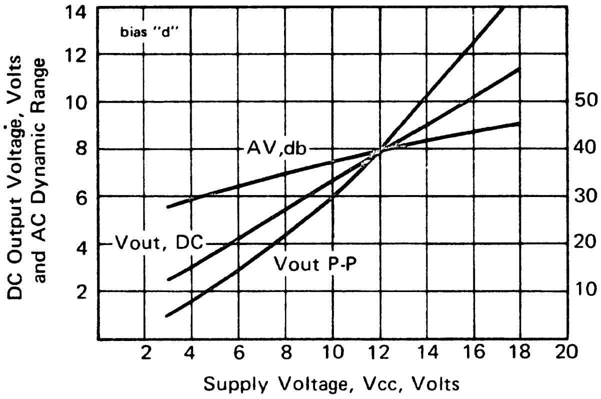


FIGURE 28

Cascode & Emitter Coupled Video Amplifiers
Voltage Gain & Load Resistance vs Bandwidth

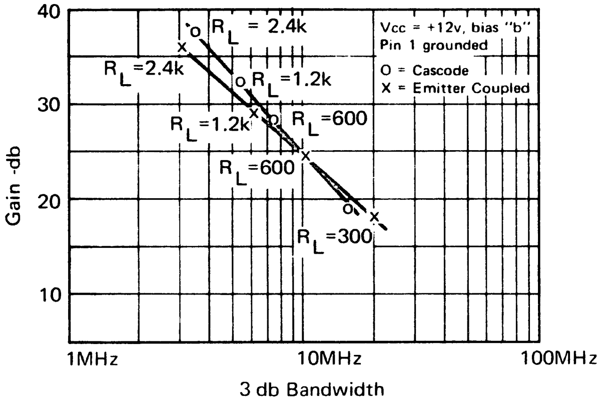


FIGURE 29

Cascode & Emitter Coupled Video Amplifiers
Dynamic Range vs Load Resistance

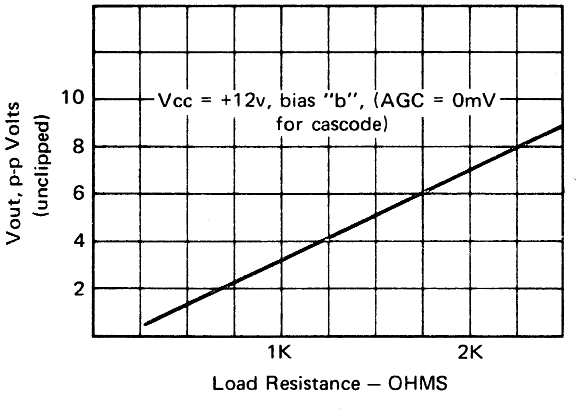


FIGURE 30

Cascode Video Amplifier Voltage Gain &
Dynamic Range vs AGC Voltage

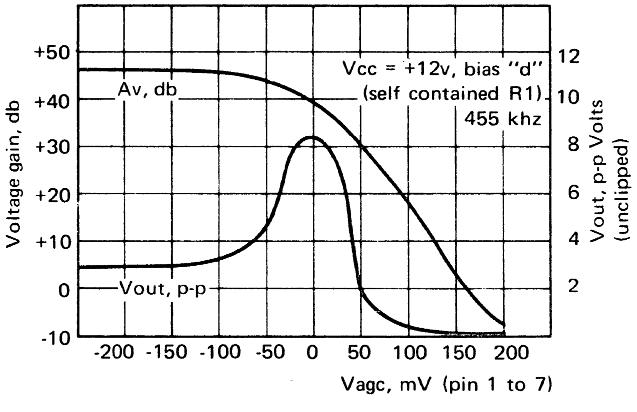


FIGURE 31

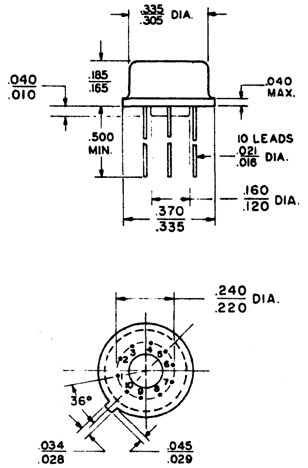
JANUARY 1968

HYBRID CIRCUIT
SWITCH
QUAD INPUT

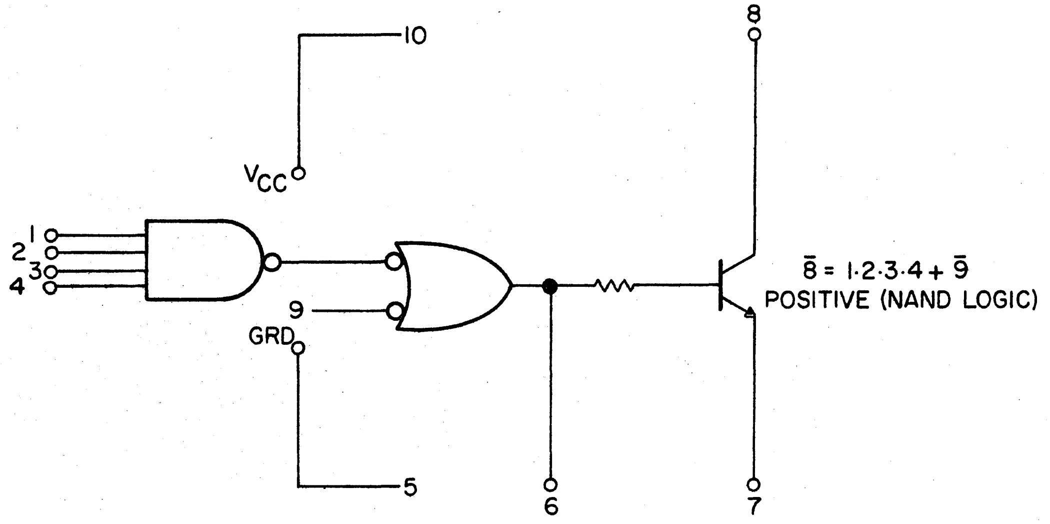
2001BE

- INPUTS DTL COMPATIBLE (USES T²L 580)
- USE FOR CORE, CABLE, AND LAMP DRIVER
- HIGH CURRENT CAPABILITY—UP TO 250 mA
- HIGH VOLTAGE CAPABILITY—40 VOLTS BV_{CEX}
- LOGIC FLEXIBILITY—4 INPUT NAND WITH INHIBIT (NOR) INPUT

E PACKAGE



PIN 5 IS INTERNALLY CONNECTED TO CASE



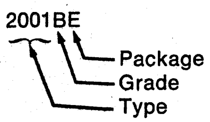
$\overline{8} = 1\cdot2\cdot3\cdot4 + \overline{9}$
POSITIVE (NAND LOGIC)

ABSOLUTE MAXIMUM RATINGS

(25°C Free Air Temperature unless otherwise noted)

Maximum Voltage Applied to Pin 8	40 Volts
Maximum Voltage Applied to Pin 10	6.8 Volts
Power Operating	800 mW
Operating Temperature	−55°C to +125°C
Storage Temperature	−65°C to +150°C

Complete part number designation consists of four digits and two letters, for example:



ELECTRICAL CHARACTERISTICS ($V_{CC} = +5.0$ Volts, Pins 5 and 7 Grounded)

CHARACTERISTICS	PIN MEASURED	MIN.	TYP.	MAX.	UNITS
V_{OL} (Output Low) with $V_1 = V_2 = V_3 = V_4 = V_9 = 2.0$ Volts, $I_8 = 250$ mA	V_8			400	mV
I_{CEX} (Output High) with V_1 or V_2 or V_3 or $V_4 = 1.0$ Volts, V_9 open, $V_8 = 40$ Volts	I_8			5.0	μA
V_{OHB} (Buffer Output High) with $V_1 = V_2 = V_3 = V_4 = V_9 = 2.0$ Volts	V_6	2.1			Volts
V_{OLB} (Buffer Output Low) with V_1 or V_2 or V_3 or $V_4 = 1.0$ Volts, V_9 open	V_6			100	mV
I_F (Input Current of Pin 1, 2, 3, 4, or 9) Pin under test at 0 Volts, other inputs open	$I_{1-4\ 9}$			−1.6	mA
t_{on} (Switch Turn-On Time) (See test conditions Figure 1)			70	160	ns
t_{off} (Switch Turn-Off Time) (See test conditions Figure 1)			110	220	ns

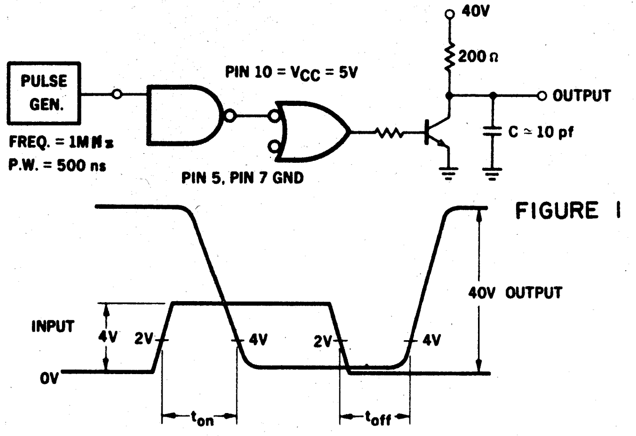
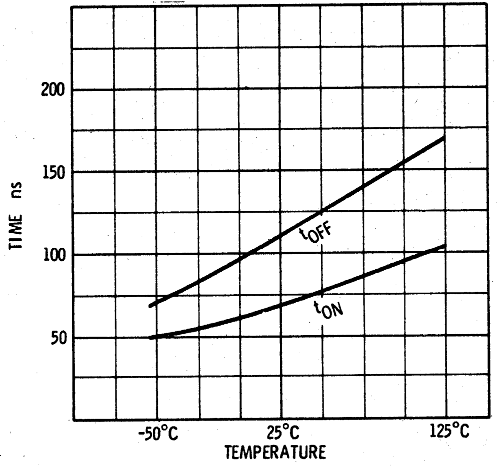
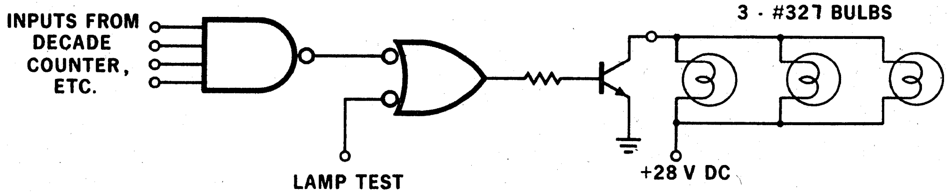


FIGURE I

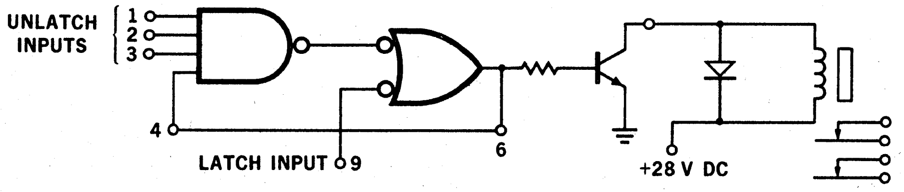
TYPICAL SWITCHING TIMES



LAMP DRIVER-

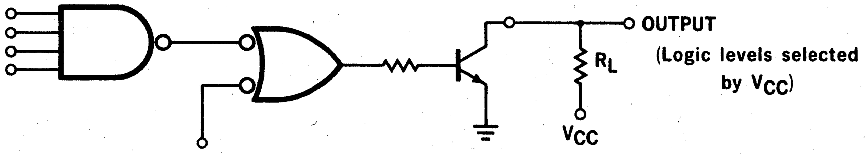


LATCHING RELAY-



Relay will unlatch if any input (1, 2, 3) goes low.

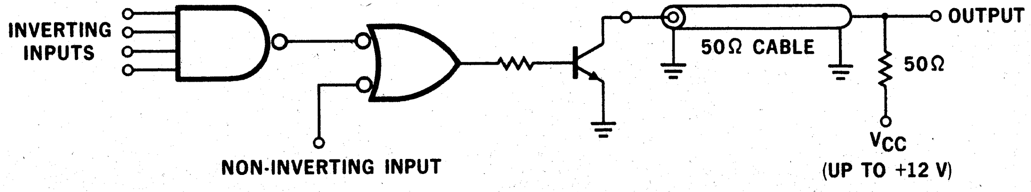
DTμL INTERFACE DRIVER-



$R_L \geq 160\Omega$ at $V_{CC} = 40$ VOLTS

$R_L \geq 80\Omega$ at $V_{CC} = 20$ VOLTS

HIGH-CURRENT LINE TRANSMITTER-



NOTE: If only non-inverting input is used, one of the inverting inputs must be grounded.

JANUARY 1968

HYBRID CIRCUIT SWITCH

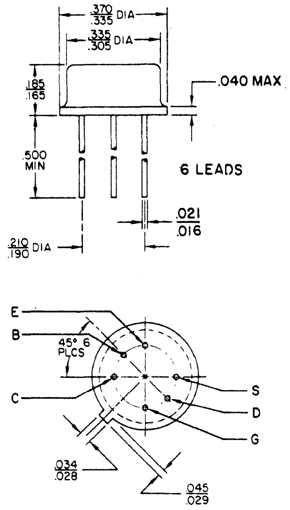
SINGLE POLE SINGLE THROW

2107BE
2110BE

These gates are designed for general purpose high level signal switching, scanning, multiplexing, A/D conversion, telemetry and chopper applications. They feature high switching speed plus the capability of handling high level AC signals at frequencies in excess of 1 MHz.

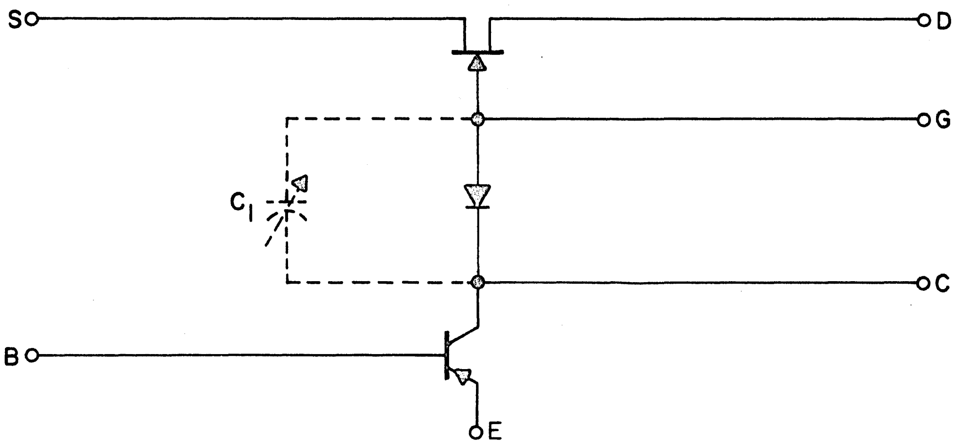
The elements provide the necessary isolation between the data signal and the drive signal without the use of a transformer and have zero offset voltage. Internal diode requires no external capacitor for switching application.

E PACKAGE



ABSOLUTE MAXIMUM RATINGS

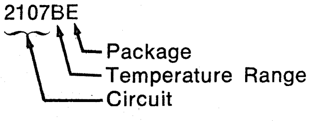
Storage Temperature Range	−65°C to +165°C
Operating Temperature Range	−55°C to +125°C
Power Dissipation at $T_A = 25°C$ $T_C = 25°C$	0.8 Watt 2.0
Derating factors θ_{JA} θ_{JC}	 4.0 mW/°C 20



ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	MAX.	UNITS
DC Output Voltage Range	V_{OUT}				
2107BE		See Figure 1	±5		Volts
2110BE		See Figure 1	±10		
Drain-Source On Resistance	r_{ds}				
2107BE		$I_D = 1.0$ mA $V_{GS} = 0$		100	Ω
2110BE				50	
2107BE		$I_D = 1.0$ mA $V_{GS} = 0$, $T_A = 85°C$		140	
2110BE				90	

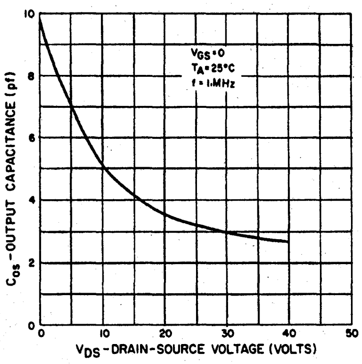
Complete part number designation consists of three digits and two letters, for example:



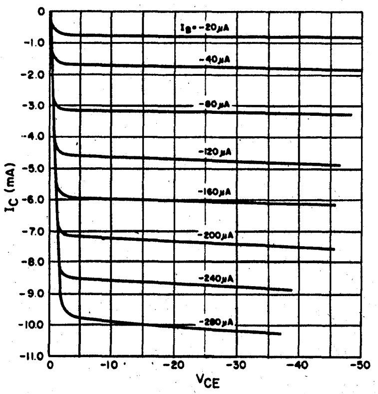
AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Time	t_{on}	See Figure 1		350	700	nsec
Turn-Off Time	t_{off}	See Figure 1		350	700	nsec
Drain-Gate Capacitance	C_{dgo}	$V_{DG} = 10$ V $I_S = 0$ f = 1.0 MHz			5.0	pf
Source-Gate Capacitance	C_{sgo}	$V_{SG} = 10$ V $I_D = 0$ f = 1.0 MHz			5.0	pf
Drain Cutoff Current	$I_{D(OFF)}$	$V_{DS} = 20$ V $V_{GS} = -7.0$ V $V_{DS} = 20$ V $V_{GS} = -7.0$ V, $T_A = 85°C$		0.2 20	1.0	nA
Gate-Channel Breakdown Voltage	BV_{GSS}	$I_G = 1.0\ \mu A$ $V_{DS} = 0$	30			Volts
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = 30$ V $I_E = 0$			10	nA
Collector-Gate Breakdown Voltage	BV_{CBO}	$I_C = 10\ \mu A$ $I_E = 0$	40			Volts
Collector-Emitter Sustaining Voltage	V_{CEO}		40			Volts
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = 0.1\ \mu A$ $I_C = 0$	5.0			Volts
DC Current Gain	h_{FE}	$I_C = 10$ mA $V_{CE} = 10$ V	40			
AC Output Voltage Range 2107BE 2110BE	e_{OUT}	See Figure 2		5.6 10		V_{p-p}

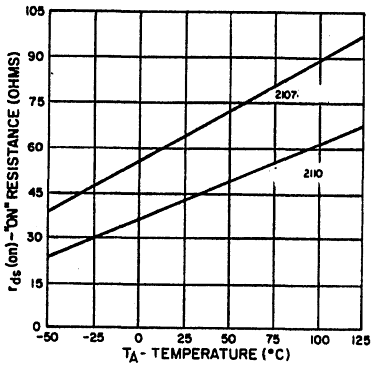
Output Capacitance vs Drain-Source Voltage



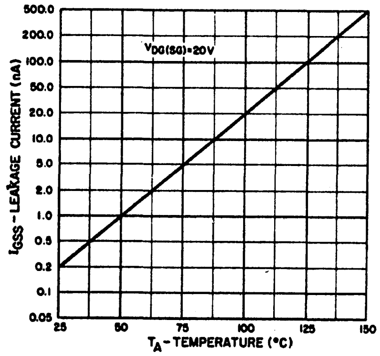
PNP Transfer Characteristics



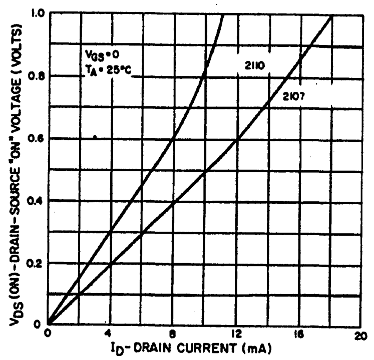
On Resistance vs Ambient Temperature



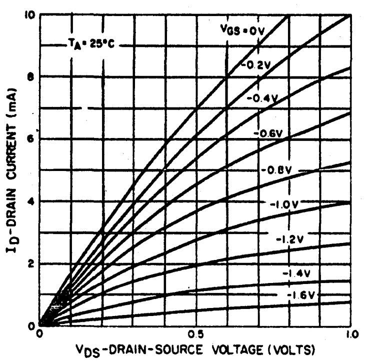
Drain Cutoff Current and Source Cutoff Current vs Ambient Temperature



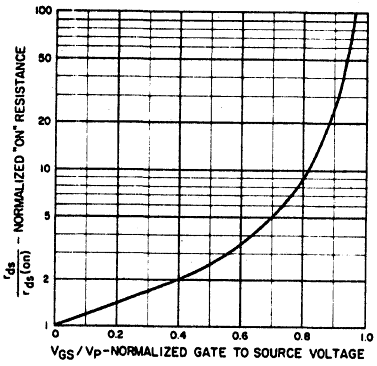
Drain-Source "ON" Voltage vs Drain Current



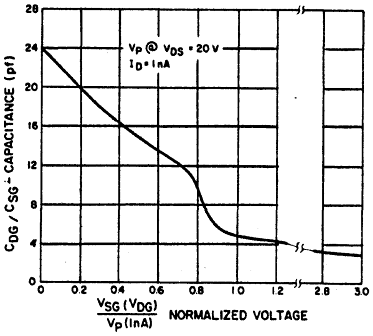
FET Transfer Characteristics 2107 BE



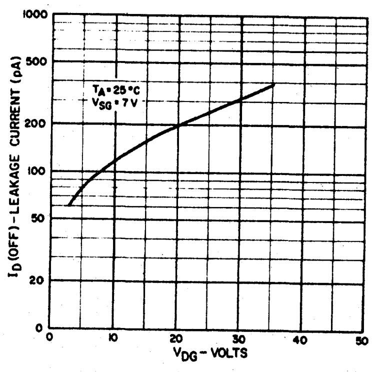
NORMALIZED V_{DS} vs. V_{GS}



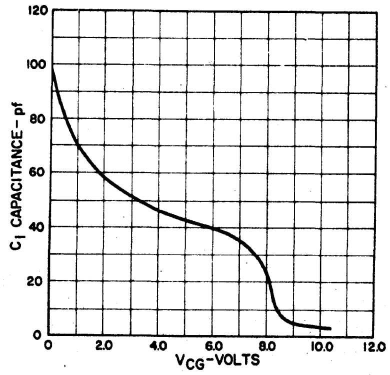
Junction Capacitance vs Normalized Bias



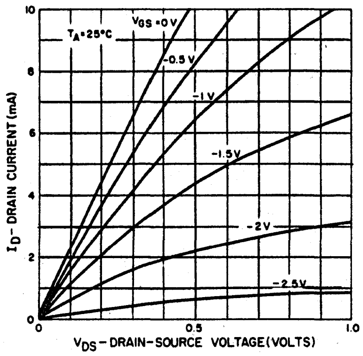
Leakage Current vs Voltage



C_1 Capacitance vs V_{CG}



FET Transfer Characteristics 2110 BE



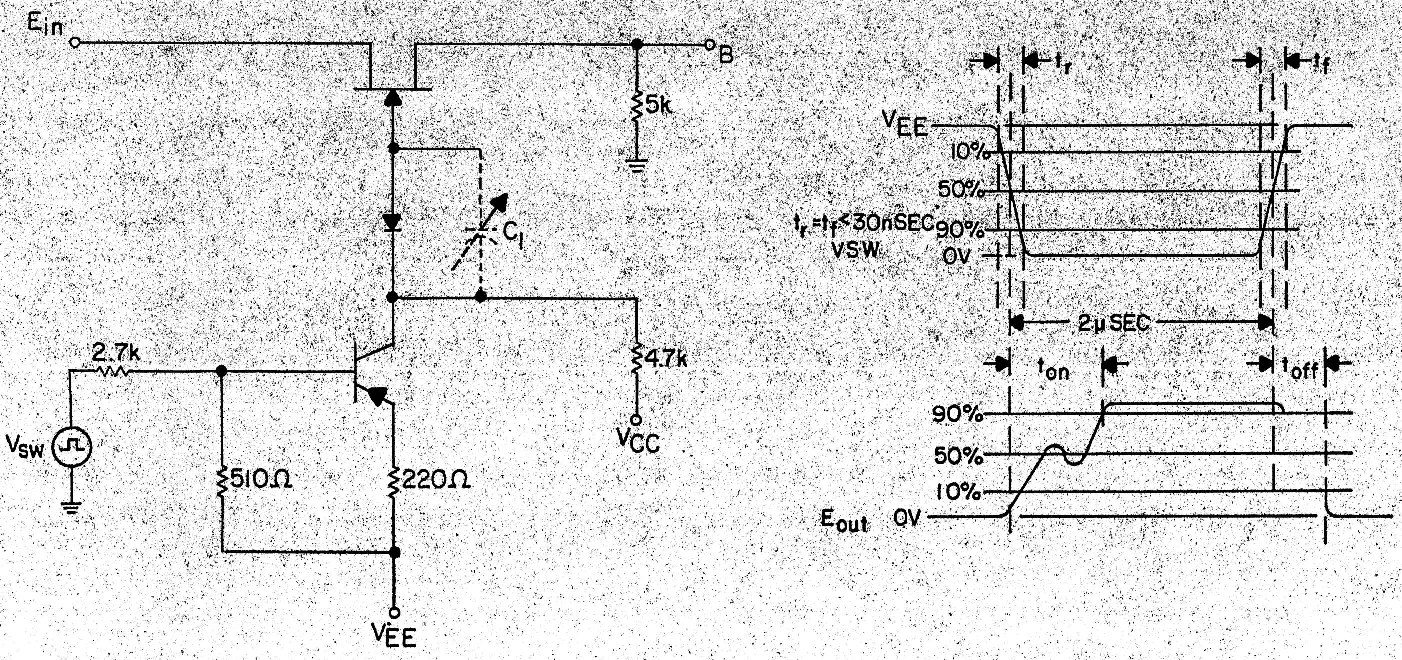


Figure 1. DC Input Test Circuit

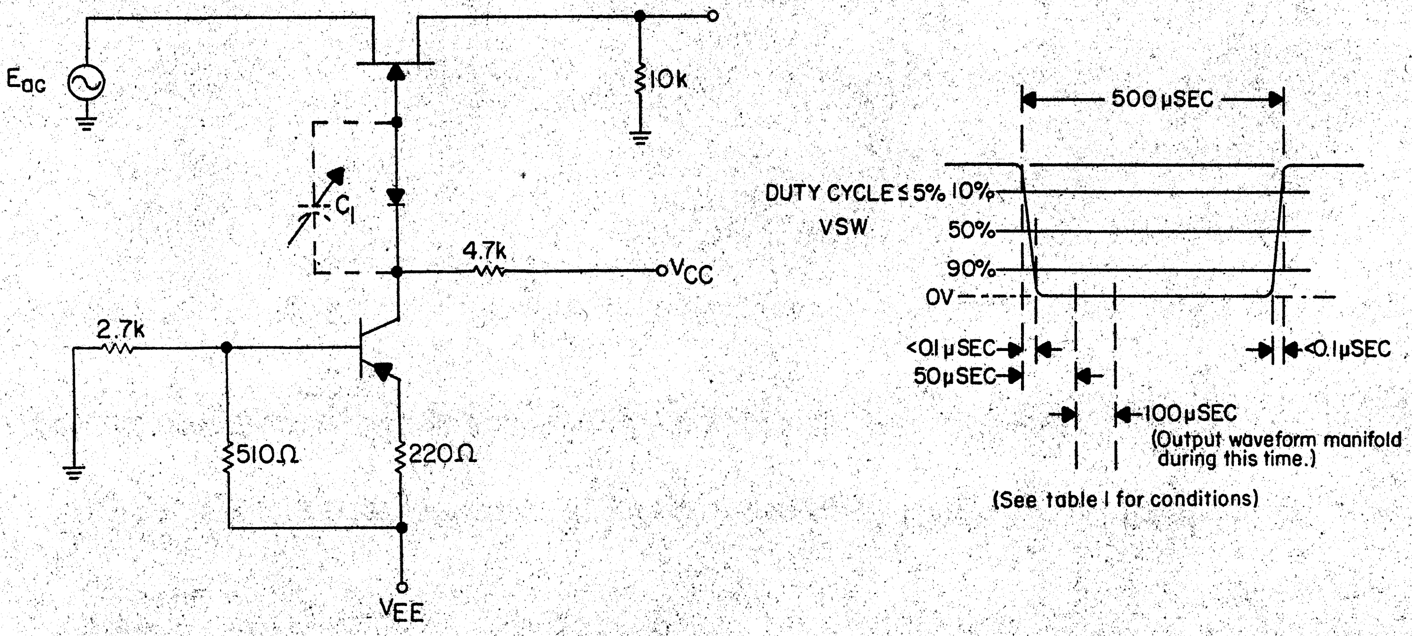


Figure 2. AC Clipping Test Circuit

TABLE 1

GATE	2107BE	2110BE
V_{EE}	+12 V	+18 V
V_{CC}	−12 V	−18 V

HYBRID CIRCUIT SWITCH

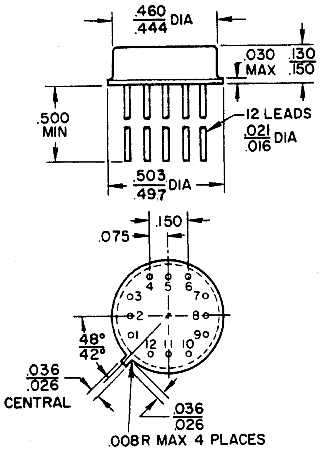
DOUBLE THROW SINGLE POLE

JANUARY 1968

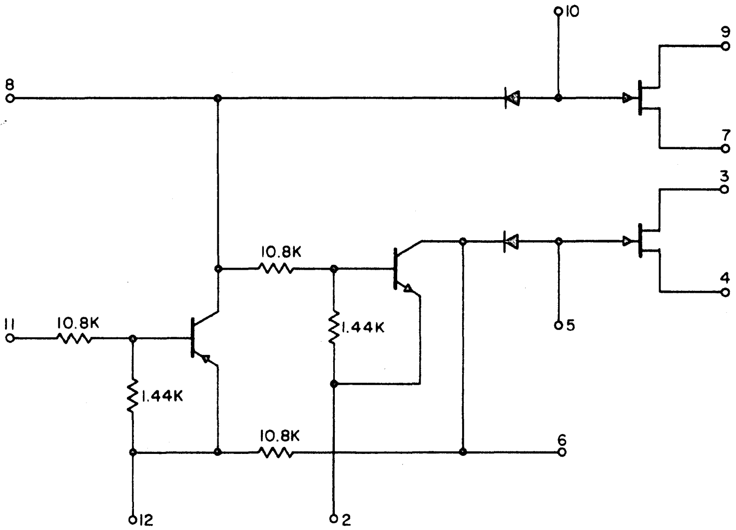
2114BF

This Analog Switch is used for high level multiplexing, A/D conversion, telemetry, and chopper applications. It features high switching speeds and has the capability of handling ac signals with frequencies in excess of one megahertz.

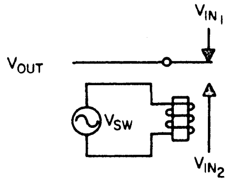
F Package



PIN 6 COMMON TO CASE



Circuit Schematic



(Mechanical Equivalent)

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to +150°C
Operating Temperature	−55°C to +125°C
Power Dissipation @ $T_A = 25°C$	1.36 W
Thermal Resistance @ $T_A = 25°C$ θ_{JC} θ_{JA}	 50°C/Watt 110°C/Watt

Complete part number designation consists of four digits and two letters, for example:

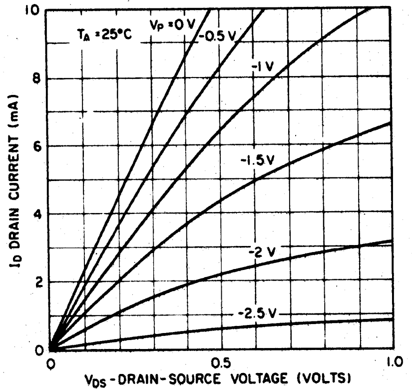
2114BF
- Package
- Temperature Range
- Circuit

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

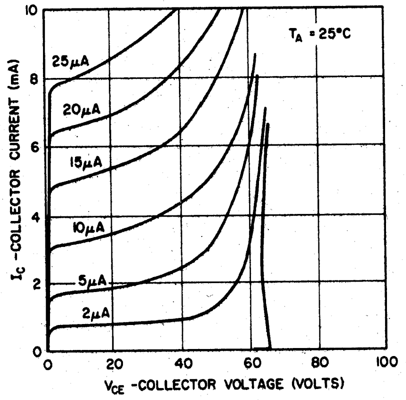
ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMIT		UNITS
			MIN.	MAX.	
Static Drain-Source "ON" Resistance	r_{DS}	$I_D = 1.0$ mA, $V_{GS} = 0$ $I_D = 1.0$ mA, $V_{GS} = 0$, $T_A = 85°C$		100 150	Ω
Drain-Gate Leakage Current	$I_{D(OFF)}$	$V_{DS} = 20$ V, $V_{GS} = -7.0$ V $V_{DS} = 20$ V, $V_{GS} = -7.0$ V, $T_A = 85°C$		1.0 60	nA
FET Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0$ μA, $V_{DS} = 0$	35		Volts
Diode Breakdown Voltage	V_R	$I_R = 1.0$ μA	40		Volts
Drain-Gate Capacitance	C_{dgo}	$V_{DC} = 20$ V, $I_S = 0$ f = 1.0 MHz		5.0	pf
Source-Gate Capacitance	C_{sgo}	$V_{GS} = 20$ V, $I_D = 0$ f = 1.0 MHz		5.0	pf
Turn-On Time	t_{on}	See Figure 1		1.5	μsec
Turn-Off Time	t_{off}	See Figure 1		1.5	μsec
DC Voltage Range	V_{OUT}	See Figure 2	±9.0		Volts
AC Peak Voltage Range	E_{OUT}	See Figure 2	±9.0		Volts

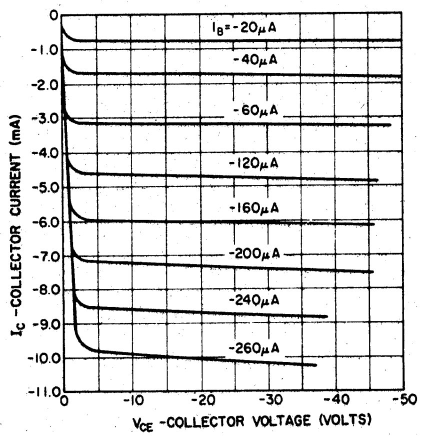
FET Common Source-Drain Characteristics



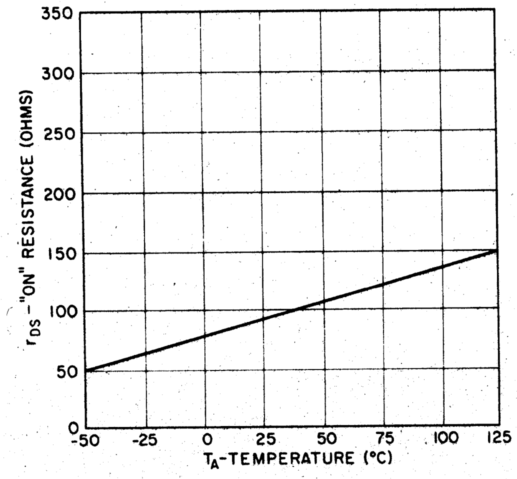
NPN Transfer Characteristics



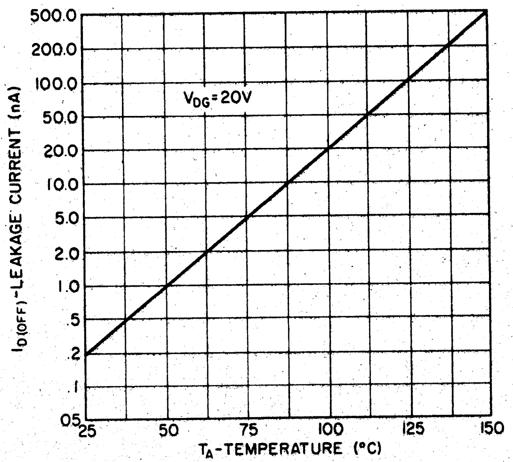
PNP Transfer Characteristics

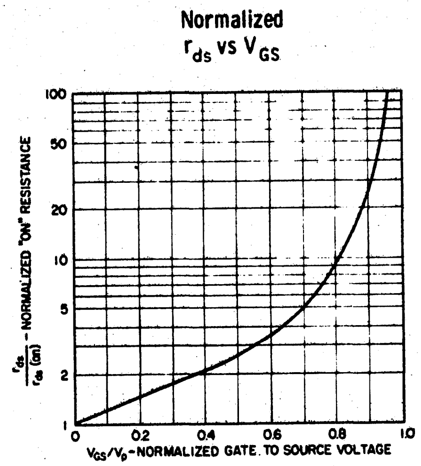


Drain-Source "ON" Resistance vs Ambient Temperature

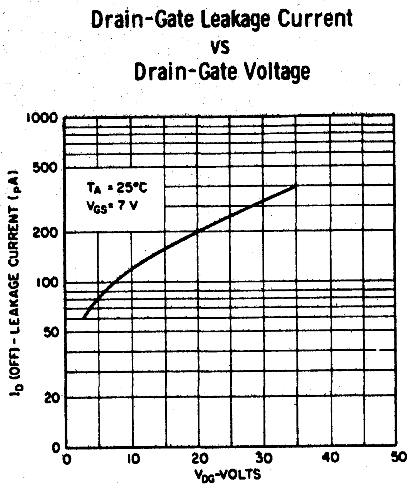


Drain-Gate Leakage Current vs Ambient Temperature

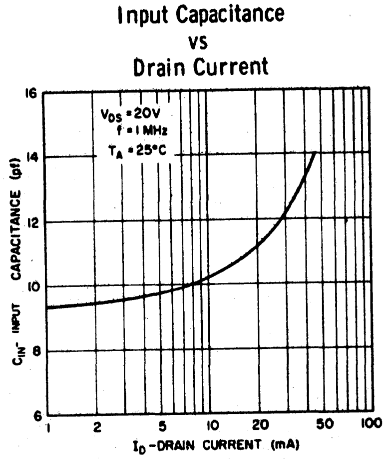




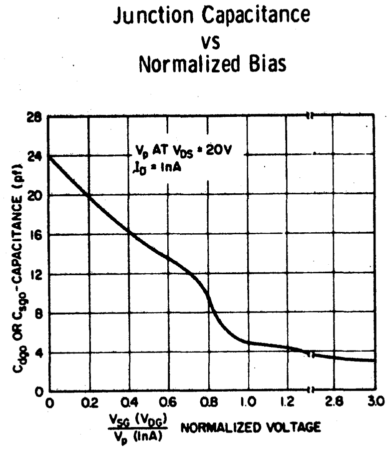
Normalized
r_{ds} vs V_{GS}



Drain-Gate Leakage Current
vs
Drain-Gate Voltage



Input Capacitance
vs
Drain Current



Junction Capacitance
vs
Normalized Bias

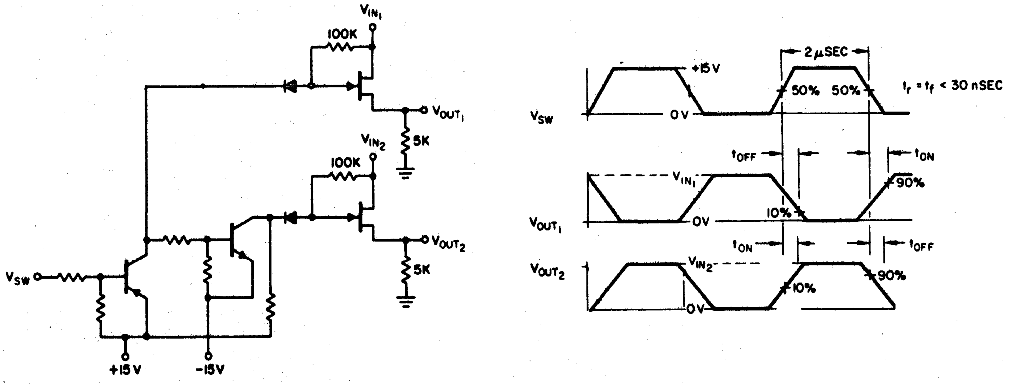


Figure 1. Switching Time & DC Voltage Test

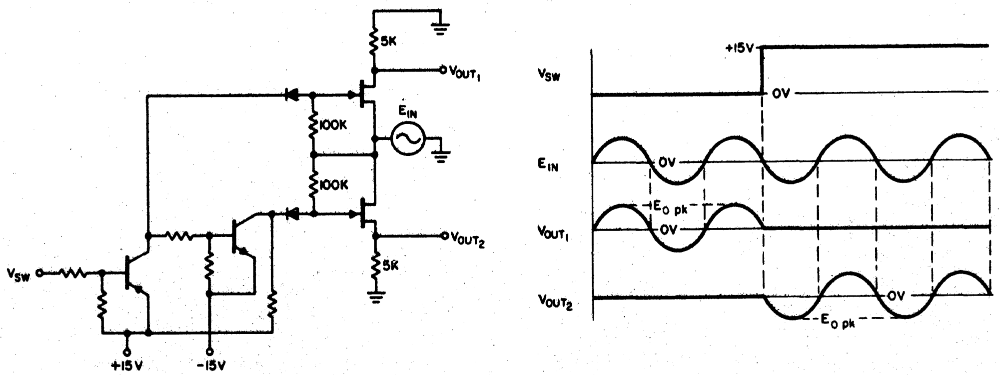


Figure 2. AC Clipping Level Test

HYBRID CIRCUIT SWITCH

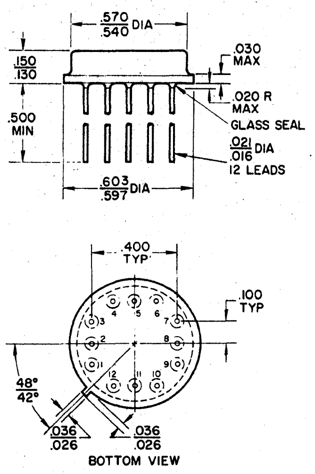
DOUBLE THROW SINGLE POLE

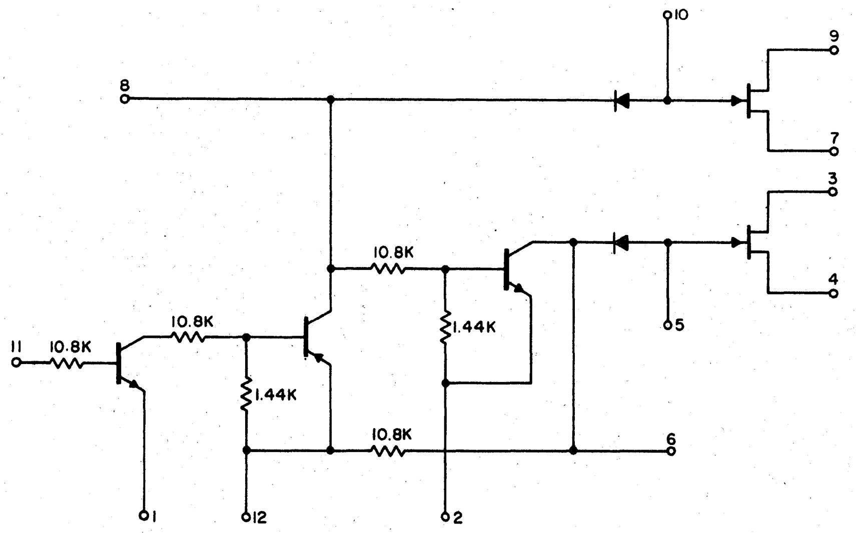
JANUARY 1968

2126BG

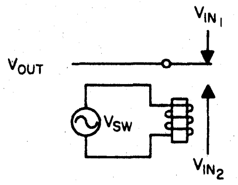
This Analog Switch is used for high level multiplexing, A/D conversion, telemetry, and chopper applications and may be driven from TTL, DTL, RTL, or SHUL logic. It features high switching speeds and has the capability of handling ac signals with frequencies in excess of one megahertz.

G PACKAGE





Circuit Schematic



(Mechanical Equivalent)

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to +150°C
Operating Temperature	−55°C to +125°C
Operating Voltages	±18 Volts
Thermal Resistance @ $T_A = 25°C$	
θ_{JA}	110°C/Watt
θ_{JC}	50°C/Watt

Complete part number designation consists of four digits and two letters, for example:

2126 BG
Package
Temperature Range
Circuit

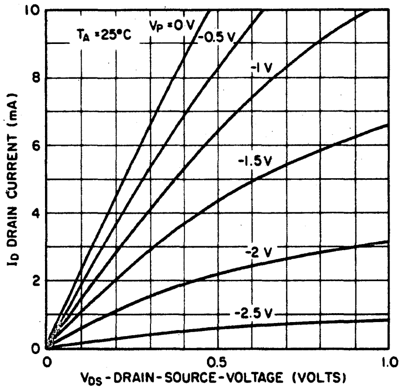
AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

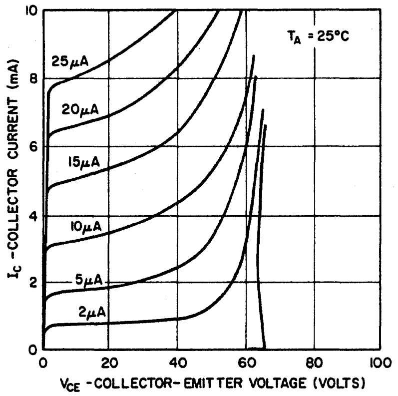
ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMIT		UNITS
			MIN.	MAX.	
Static Drain-Source "ON" Resistance	r_{DS}	$I_D = 1.0$ mA, $V_{GS} = 0$ $I_D = 1.0$ mA, $V_{GS} = 0$, $T_A = 85°C$		65 95	Ω
Drain-Gate Leakage Current	$I_{D(off)}$	$V_{DS} = 20$ V, $V_{GS} = -7.0$ V $V_{DS} = 20$ V, $V_{GS} = -7.0$ V, $T_A = 85°C$		1.0 60	nA
FET Gate-Source Breakdown Voltage	$V_{(BR)GSS}$	$I_G = 1.0\ \mu A$, $V_{DS} = 0$	35		Volts
Diode Breakdown Voltage	V_R	$I_R = 1.0\ \mu A$	40		Volts
Drain-Gate Capacitance	C_{dgo}	$V_{DC} = 20$ V, $I_S = 0$ f = 1.0 MHz		7.0	pf
Source-Gate Capacitance	C_{sgo}	$V_{GS} = 20$ V, $I_D = 0$ f = 1.0 MHz		7.0	pf
Turn-On Time	t_{on}	See Fig. 1		2.0	μsec
Turn-Off Time	t_{off}	See Fig. 1		2.0	μsec
DC Voltage Range	V_{OUT}	See Fig. 1	±8.0		Volts
AC Peak Voltage Range	E_{OUT}	See Fig. 2	±8.0		Volts

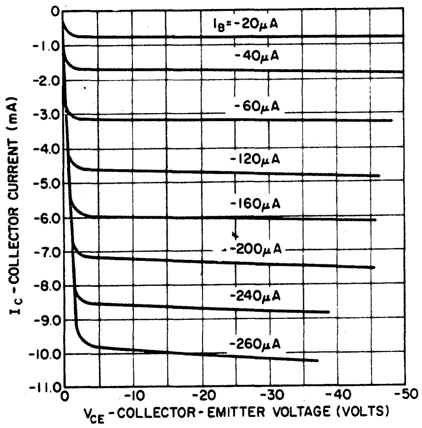
FET
Common Source-
Drain Characteristics



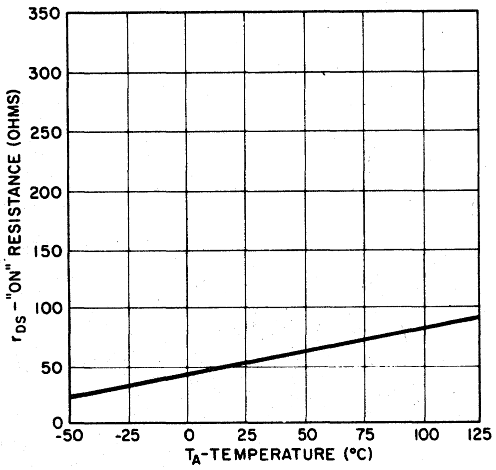
NPN
Transfer
Characteristics



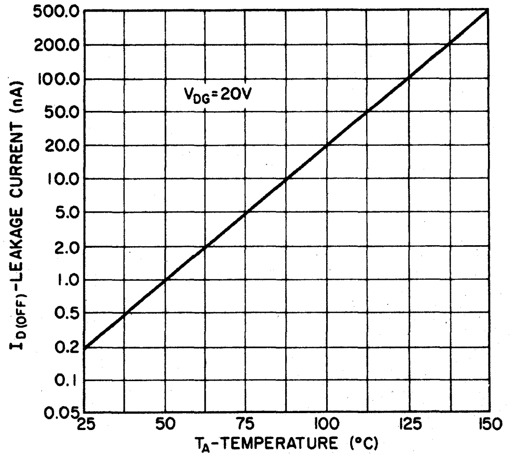
PNP
Transfer
Characteristics

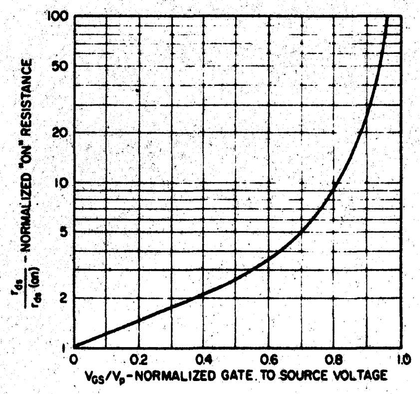


Drain-Source "ON" Resistance
vs
Ambient Temperature

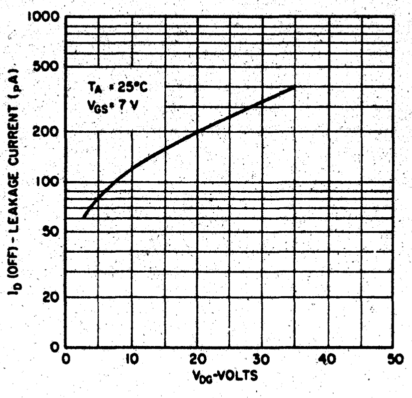


Drain-Gate Leakage Current
vs
Ambient Temperature

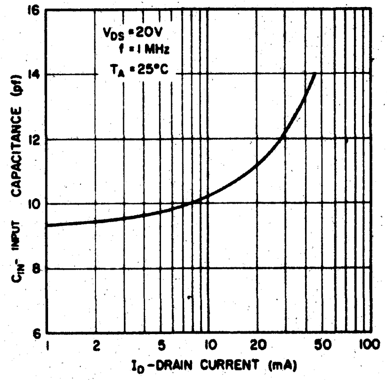




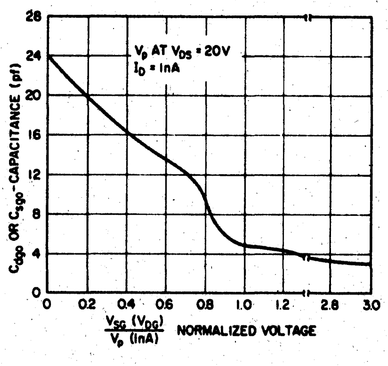
Normalized r_{ds} vs V_{GS}



Drain-Gate Leakage Current vs Drain-Gate Voltage



Input Capacitance vs Drain Current



Junction Capacitance vs Normalized Bias

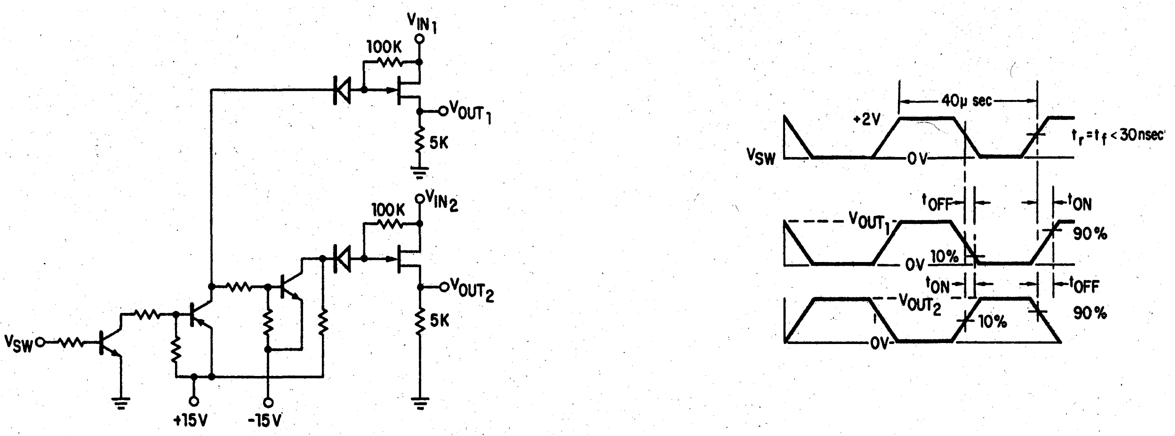


Figure 1. Switching Time & DC Voltage Test

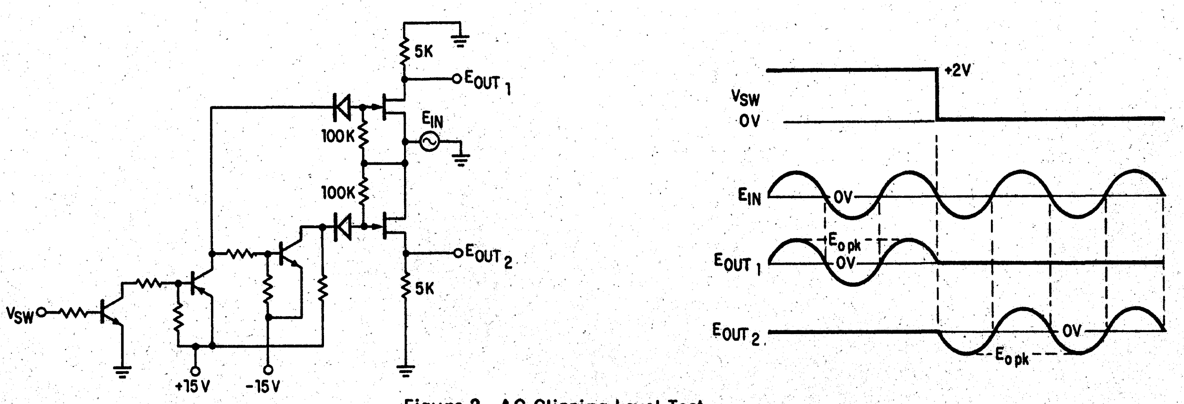


Figure 2. AC Clipping Level Test

HYBRID CIRCUIT SWITCH

QUAD SINGLE POLE SINGLE THROW

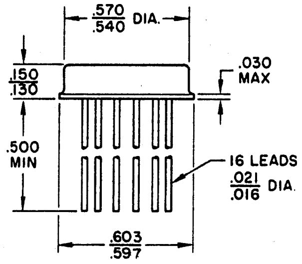
JANUARY 1969

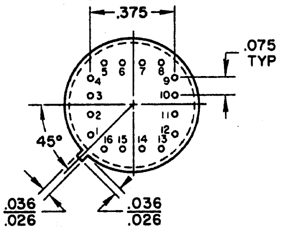
2128BG

The Amelco 2128BG is a quad analog switch for multiplexing, sample and hold, A/D conversion and chopper applications.

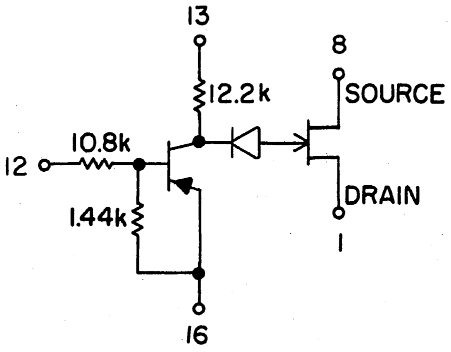
Thin film techniques were used to combine four FET diodes, twelve thin-film tantalum resistors, four 2N2907 pnp transistors and four 2N4092 FET's in one low profile TO-8 header. As a result, a quad analog gate is available for military and industrial applications where more reliability, added performance, and more package density are required.

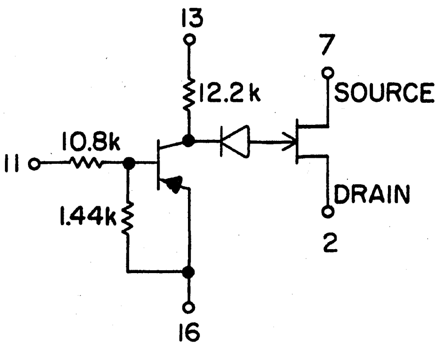
G PACKAGE

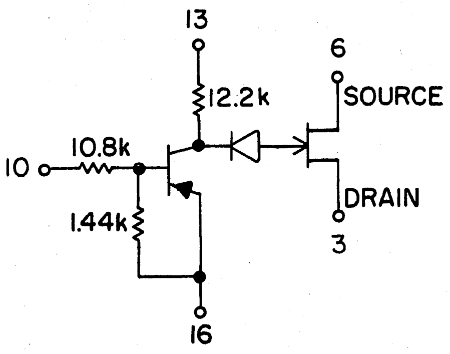


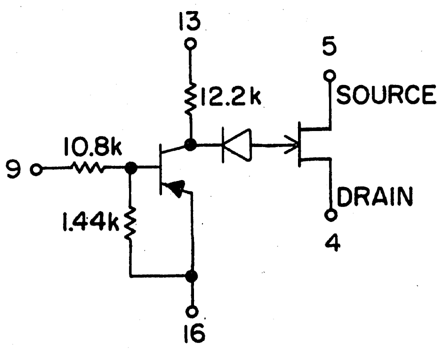


BOTTOM VIEW









ABSOLUTE MAXIMUM RATINGS

Storage Temperature	−65°C to +150°C
Operating Temperature	−55°C to +125°C
Thermal Resistance	$\theta_{JA} = 50°C/Watt$ $\theta_{JC} = 110°C/Watt$
Operating Voltages	$+V_{CC} = +18$ Volts $-V_{CC} = -18$ Volts

Complete part number designation consists of four digits and two letters, for example:

2128BG
- Package
- Grade
- Type

AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

ELECTRICAL CHARACTERISTICS at 25°C (Unless Otherwise Specified)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS		UNITS
			MIN.	MAX.	
Static Drain-Source "ON" Resistance	r_{ds}	$I_D = 1.0$ mA		50	Ohms
		$I_D = 1.0$ mA $T_A = 125°C$		90	Ohms
Drain-Gate Leakage Current	$I_{D(off)}$	$V_{DS} = 20$ V $V_{GS} = -7.0$ V		1.0	nA
		$V_{DS} = 20$ V $V_{GS} = -7.0$ V, $T_A = 125°C$		1.0	μA
Turn-On Time	t_{on}	Figure 1, 2 $E_{IN} = \pm 7$ V		1.0	μsec
Turn-Off Time	t_{off}	Figure 1, 2 $E_{IN} = \pm 7$ V		1.0	μsec
DC Output Voltage Range	$\pm E_{out}$	Figure 1	±7.0		Volts
AC Output Voltage Range	e_{out}	Figure 1	8.0		V_{p-p}

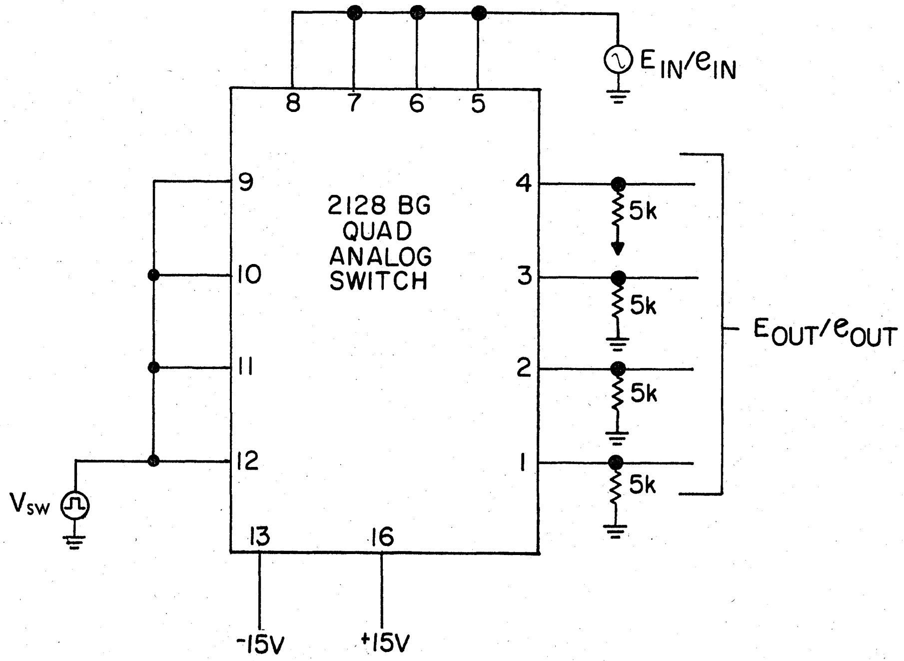


FIGURE 1, TEST CONFIGURATION FOR TURN-ON TIME, TURN-OFF TIME DC OUTPUT VOLTAGE RANGE, AND AC OUTPUT VOLTAGE RANGE.

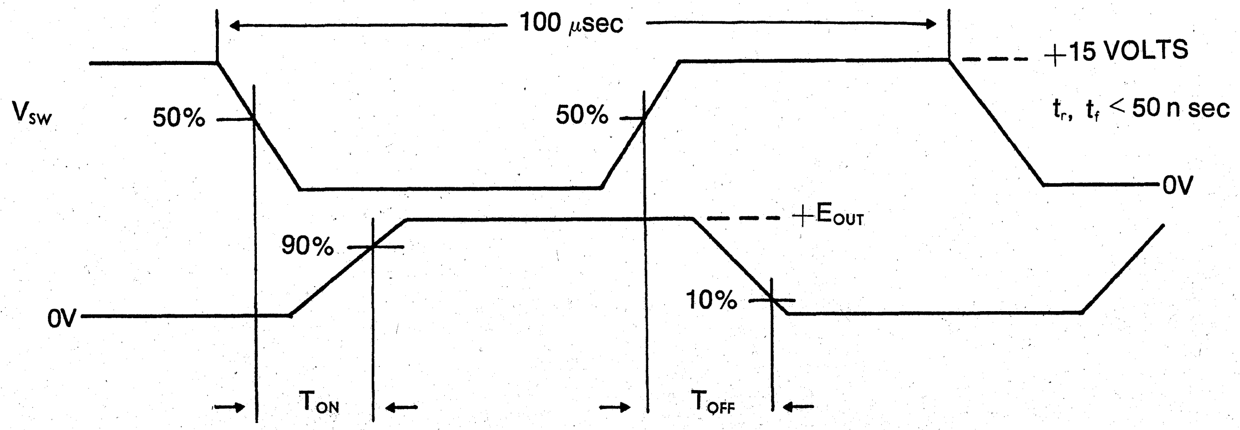


FIGURE 2, SWITCHING WAVEFRONT T_{ON} AND T_{OFF}

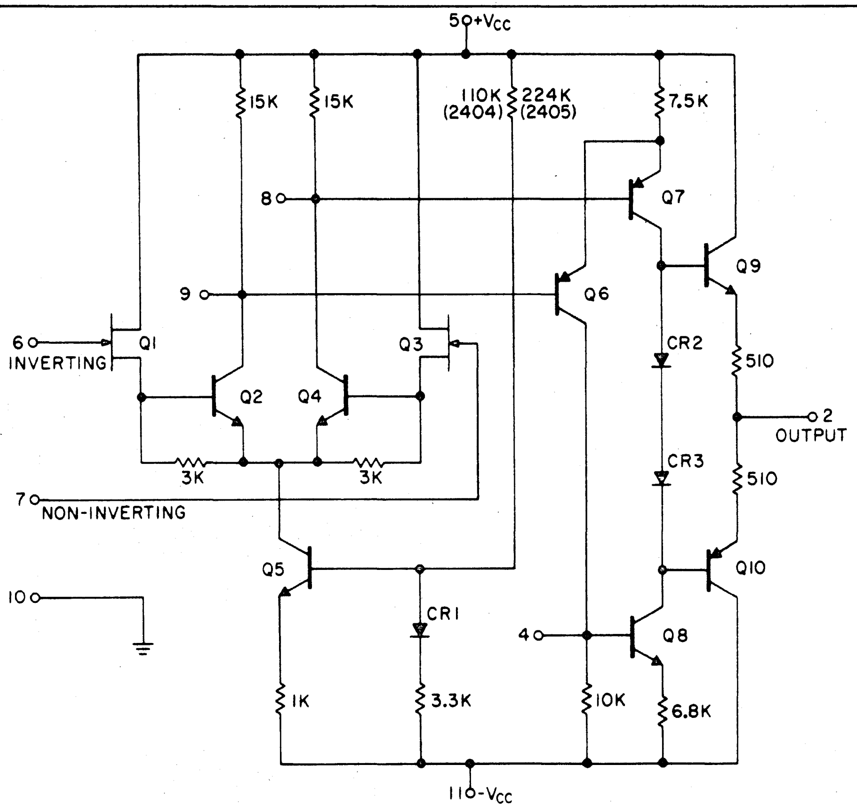
JANUARY 1968

HYBRID CIRCUIT
OPERATIONAL AMPLIFIER

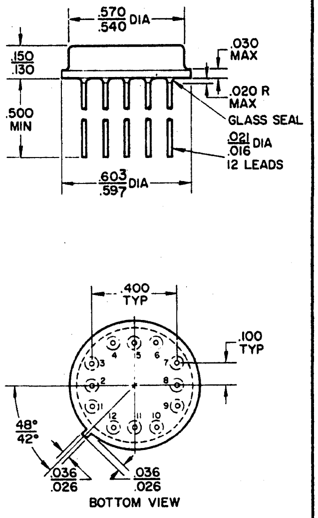
- LOW POWER
- HIGH VOLTAGE

2404BG
2405BG

These Hybrid Operational Amplifiers are designed specifically for applications requiring very high input impedance and extremely low power consumption. Other outstanding electrical characteristics include extremely low offset currents and drifts, high open loop gains, and short-circuit protected output.



G PACKAGE



ABSOLUTE MAXIMUM RATINGS

Storage Temperature Range	−65°C to +150°C
Operational Temperature Range	−55°C to +125°C
Maximum Supply Voltage 2404BG 2405BG	 ±18 V ±35 V
Thermal Resistance @ $T_A = 25°C$ θ_{JC} θ_{JA}	 50°C/W 110°C/W

Complete part number designation consists of four digits and two letters, for example:

2404BG
Package
Temperature Range
Circuit

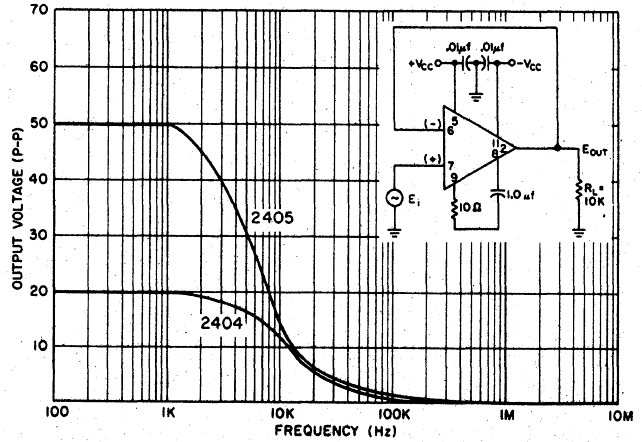
AMELCO SEMICONDUCTOR 1300 Terra Bella Ave. • Mountain View • Calif. 94040
A TELEDYNE COMPANY Phone (415) 968-9241 TWX: (910) 379-6494

Printed in U.S.A.

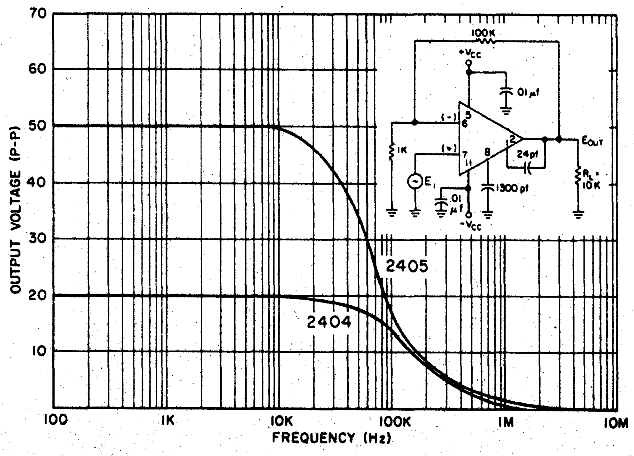
ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

PARAMETER	MIN.	TYP.	MAX.	UNITS
Open Loop Voltage Gain	90	100		db
Input Resistance	10k	100k		MΩ
Input Bias Current		40	100	pA
Input Bias Current $T_A = 125°C$		30	100	nA
Input Offset Current		15	50	pA
Input Offset Current $T_A = 125°C$		15	50	nA
Input Offset Voltage		3.0	10	mV
Input Offset Voltage Drift $T_A = -55°C$ to $+125°C$		5.0	50	μV/°C
Common Mode Voltage Range (2404) (2405)	 8.0 16	 10 25		±V
Common Mode Rejection Ratio		−90	−74	db
Input Noise (See Figure 1)		3.0		μV_{rms}
Slew Rate (See Figure 2)		2.0		V/μsec
Power Dissipation (2404) $V_{CC} = \pm 15$ V (2405) $V_{CC} = \pm 30$ V			 55 110	mW
Power Supply Rejection Ratio		−90	−74	db
Output Voltage Swing $R_L = 10k$ (2404) (2405)	 20 40	 22 50		V_{p-p}

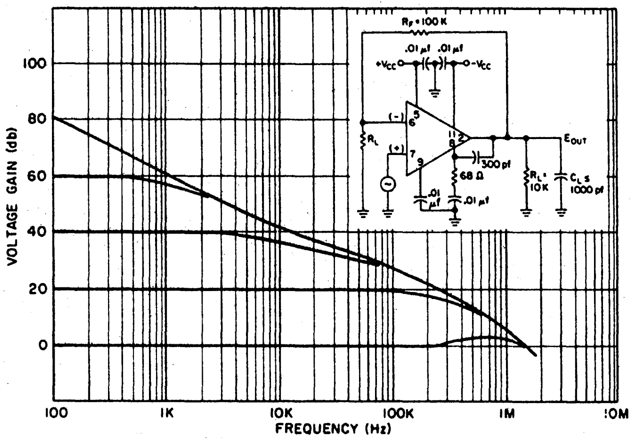
Output Voltage Swing
vs.
Frequency
Unity Gain Configuration



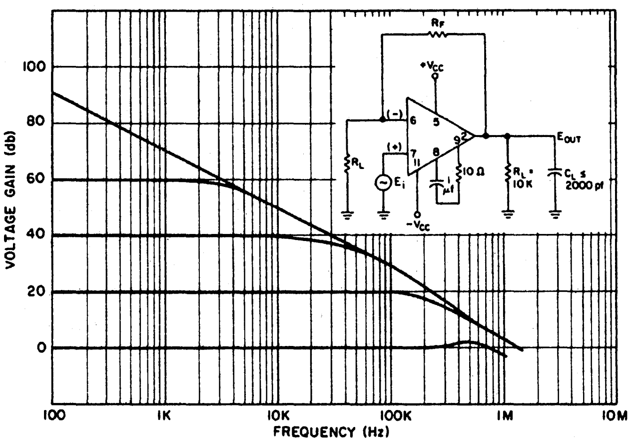
Output Voltage Swing
vs.
Frequency
Gain of 100



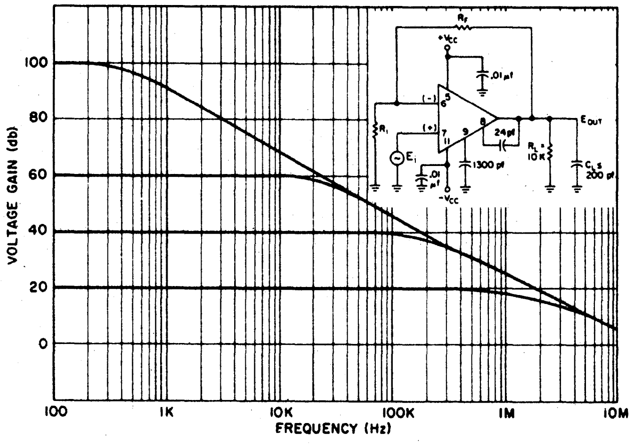
Voltage Gain
vs
Frequency



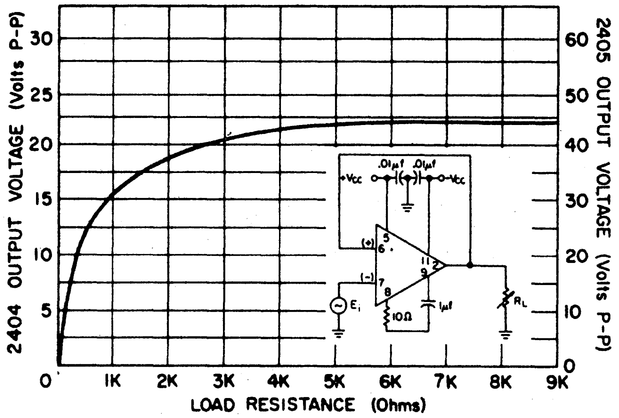
Voltage Gain
vs
Frequency



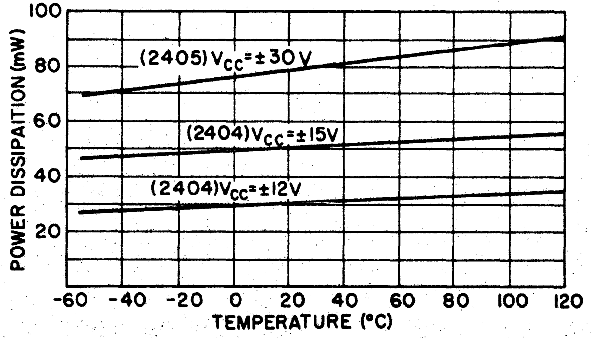
Voltage Gain
vs
Frequency



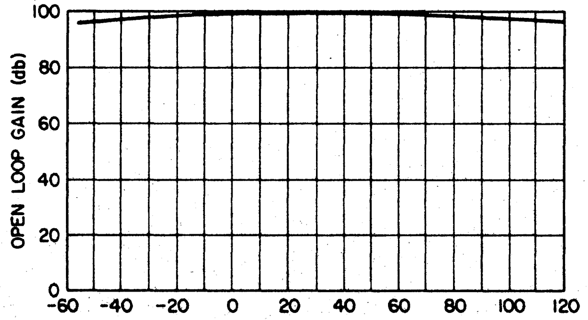
Output Voltage
vs
Load Resistance for
Unity Gain

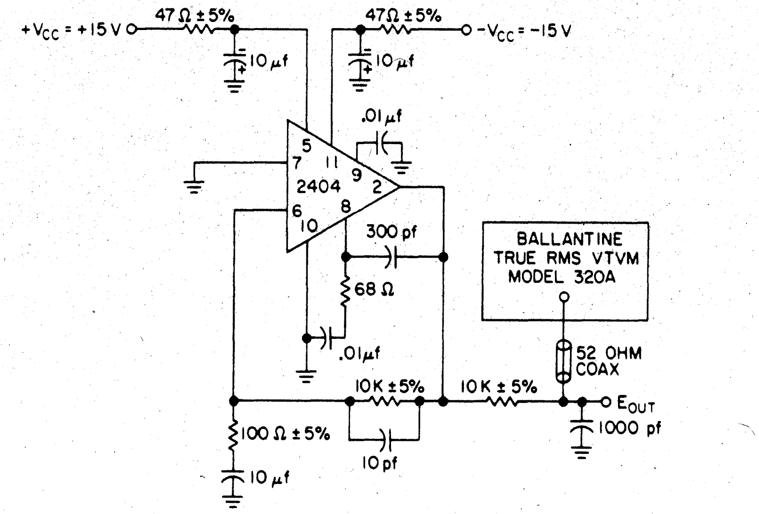


Power Dissipation
vs
Temperature

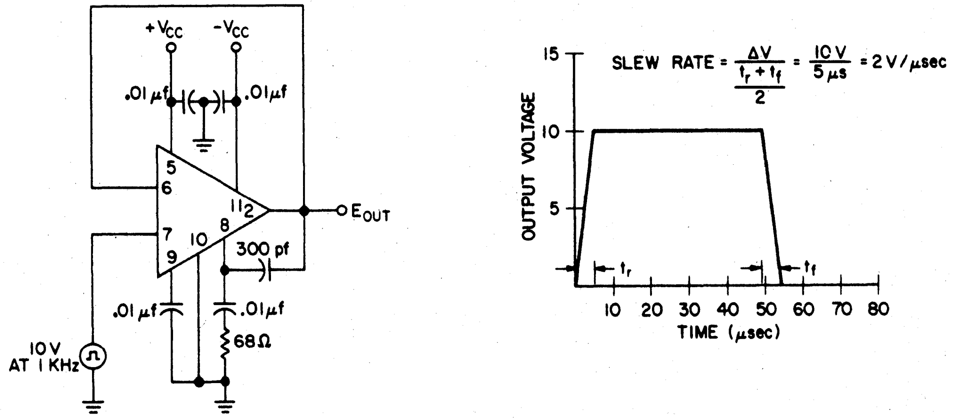


Open Loop Voltage Gain
vs
Temperature

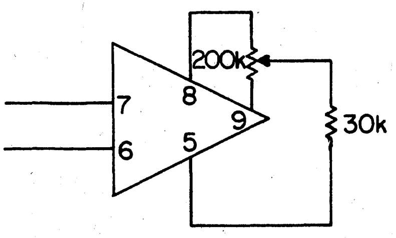




Noise Test Setup, Wide Band Noise 160 Hz to 16 kHz



Slew Rate Test Configuration



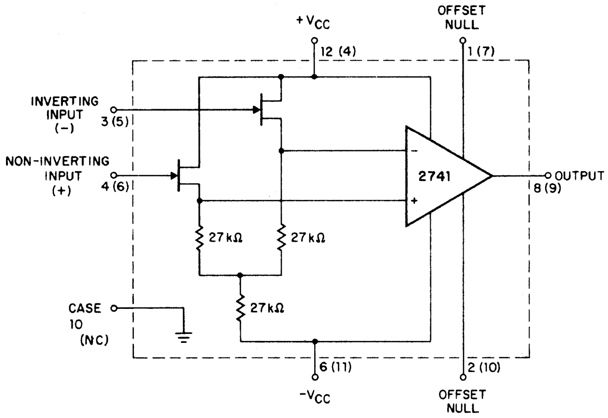
Offset Voltage Adjustment

JULY 1969

HYBRID MICROCIRCUIT FET INPUT OPERATIONAL AMPLIFIER

2741

The Amelco 2741 operational amplifier combines the superior performance of the widely accepted 741 operational amplifier with the high impedance characteristics of a matched field effect transistor input stage. It is intended for use in applications requiring extremely low bias and offset currents such as high impedance filter sections and integrators. Equally versatile in general feedback applications, the 2741 incorporates output short-circuit protection, input overvoltage and "latch-up" immunity, internal 6 db/octave frequency compensation, and external offset voltage null capability. The electrical parameter strong points include high gain, large common mode rejection over a wide range of input voltage, low power dissipation and excellent input characteristics. Available in a flat package or TO-8.



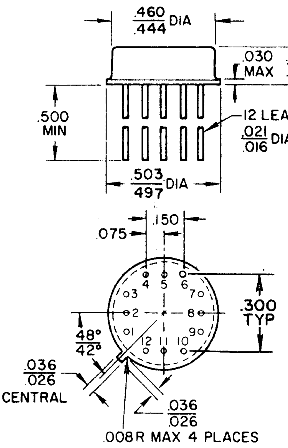
NOTE: Numbers in ( ) refer to "K" package.

ABSOLUTE MAXIMUM RATINGS

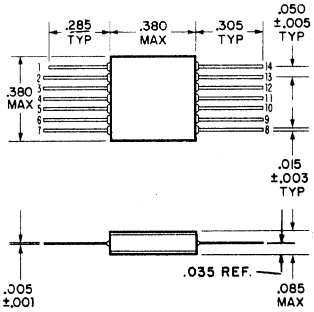
SPECIFICATIONS	NOTES	B RATING	C RATING
Storage Temperature		−65°C to +150°C	−65°C to +150°C
Operating Temperature Range		−55°C to +125°C	0°C to +100°C
Supply Voltage		±22 V	±22 V
Input Voltage	1	±15 V	±15 V
Differential Input Voltage	1	30 V	30 V
Power Dissipation	2	F Package 1.0 W	F Package 1.0 W
	3	K Package 500 mW	K Package 500 mW
Output Short Circuit Duration	4	F Package Indefinite	F Package Indefinite
	5	K Package Indefinite	K Package Indefinite
Lead Soldering Temperature 1/16" from Case, 10 seconds max.		300°C	300°C

NOTES:
1. For supply voltages less than ±15 V, the absolute maximum input voltage is equal to the supply voltage.
2. Rating applies for case temperatures up to the maximum operating temperature. Derate linearly at 10 mW/°C for ambient temperature above +75°C.
3. Rating applies for case temperatures up to the maximum operating temperature. Derate linearly at 6.7 mW/°C for ambient temperature above +75°C.
4. Short circuit may be to ground or either supply.
5. Short circuit may be to ground or either supply. Rating applies for case temperature up to the maximum operating temperature or +75°C ambient temperature.

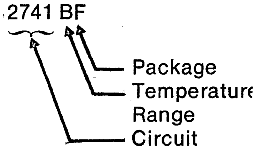
F PACKAGE



K PACKAGE



Complete part number designation consists of three digits and two letters; for example:



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GUARANTEED ELECTRICAL CHARACTERISTICS

TABLE 2 $V_{CC} = \pm 15$ V, $T_A = 25°C$

PARAMETER	TEST FIG.	TEST CONDITIONS	SYMBOL	B RATING			C RATING			UNITS
				MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain	1	$R_S = 0$, $R_L \geq 2$ KΩ, $V_{IN} = \pm 10$ V	A_O	90	94		86	90		db
Input Offset Voltage	1	$R_S = 1$ MΩ, $V_{IN} = 0$	V_{OS}		3	5		5	10	mV
Input Bias Current	2	$V_{IN} = 0$ V	I_B		40	100		50	200	pA
Input Offset Current	2	$V_{IN} = 0$ V	I_{OS}		15	50		25	100	pA
Input Resistance	2	$V_{IN} = \pm 10$ V	R_{IN}	10	100		1	75		kMΩ
Common Mode Voltage Range	3	Reference Only: CMRR Test Condition	CMVR	±10	±13		±10	±13		V_{pk}
Common Mode Rejection Ratio	3	$-CMVR \leq V_{IN} \leq +CMVR$ $\pm CMVR = \pm 10$ V pk	CMRR	60	70		60	70		db
Power Supply Rejection Ratio	1	$V_{IN} = 0$, $R_S = 1$ MΩ, $\Delta V_{CC} = \pm 1$ V Each Supply Independently	PSRR	60	80		60	80		db
Output Voltage Swing	4	$V_{IN} = \pm 13$ V, $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	V_O	±10	±13		±10	±13		V_{pk}
Power Dissipation	4	$V_{IN} = 0$, $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	P_{DISS}		50	90		60	100	mW
Transient Response Rise Time Overshoot	4	Frequency = 50 KHz $V_{IN} = 20$ mV $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	 T_R OS		 0.5 10	 1.2 20		 0.7 15	 1.5 30	 μsec %
Slew Rate	4	$V_{IN} = \pm 5$ V, Frequency = 10 KHz $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	$\frac{dV_O}{dt}$	0.5	1.0		0.3	0.8		V/μsec

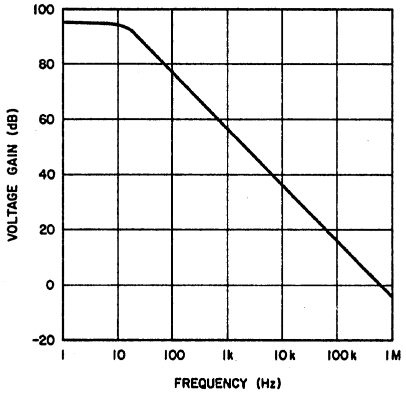
GUARANTEED ELECTRICAL CHARACTERISTICS

TABLE 3 $V_{CC} = \pm 15$ V, $T_A = T_{min}$ and T_{max}, unless otherwise noted

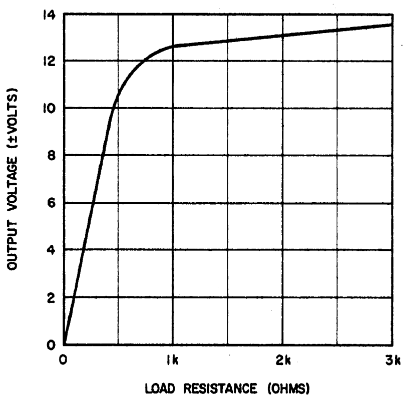
PARAMETER	TEST FIG.	TEST CONDITIONS	SYMBOL	B RATING			C RATING			UNITS
				MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Open Loop Voltage Gain	1	$R_S = 0$, $R_L \geq 2$ KΩ, $V_{IN} = \pm 10$ V	A_O	86	90		80	84		db
Input Bias Current	2	$V_{IN} = 0$, $T_A = T_{max}$ Only	I_B		30	100		30	50	nA
Input Offset Current	2	$V_{IN} = 0$, $T_A = T_{max}$ Only	I_{OS}		15	50		15	25	nA
Common Mode Voltage Range	3	Reference Only: CMRR Test Condition	CMVR	±10	±12		±10	±12		V_{pk}
Common Mode Rejection Ratio	3	$-CMVR \leq V_{IN} \leq +CMVR$ $\pm CMVR = \pm 10$ V pk	CMRR	60	66		60	66		db
Power Supply Rejection Ratio	1	$V_{IN} = 0$, $R_S = 1$ MΩ, $\Delta V_{CC} = \pm 1$ V Each Supply Independently	PSRR	60	74		60	74		db
Output Voltage Swing	4	$V_{IN} = \pm 13$ V, $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	V_O	±10	±12		±10	±12		V_{pk}
Input Offset Voltage Drift	1	$V_{IN} = 0$, $R_S = 1$ KΩ	V_{OST}		2	5		2	5	mV
Power Dissipation	4	$V_{IN} = 0$, $R_L \geq 2$ KΩ, $C_L \leq 100$ pf	P_{DISS}		50	100		60	110	mW

TYPICAL CHARACTERISTICS

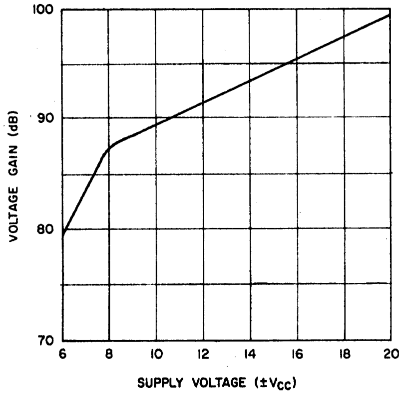
Open Loop Frequency Response



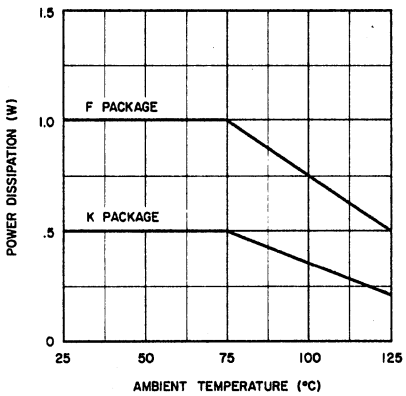
Output Swing



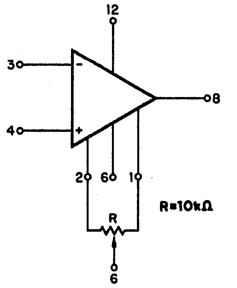
Open Loop Voltage Gain



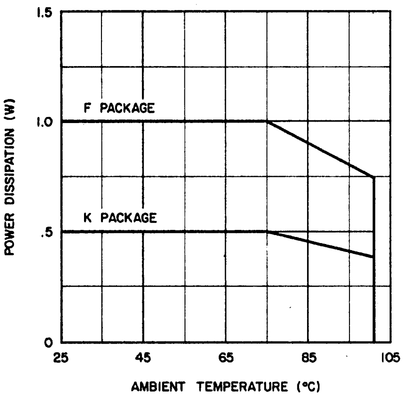
"B" Dissipation Rating



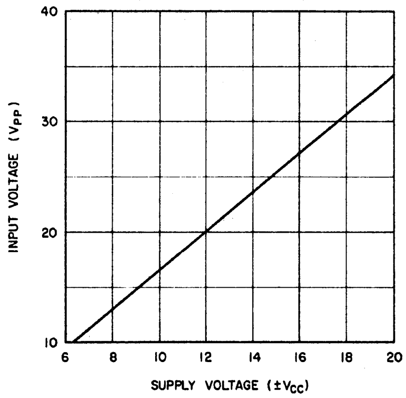
Voltage Offset Null Circuit



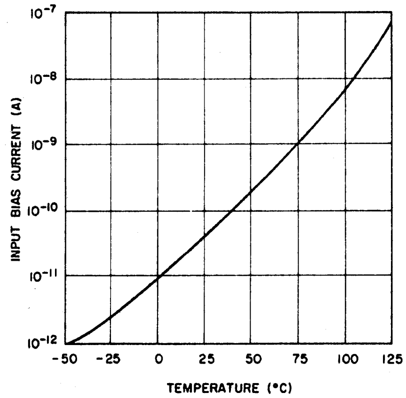
"C" Dissipation Rating



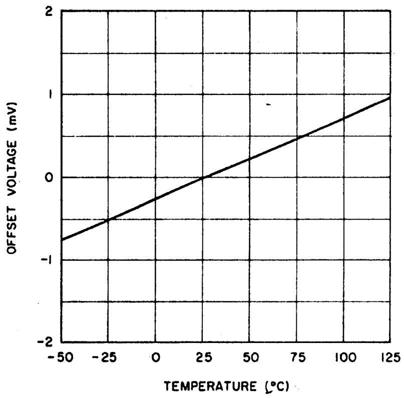
Common Mode Voltage Range



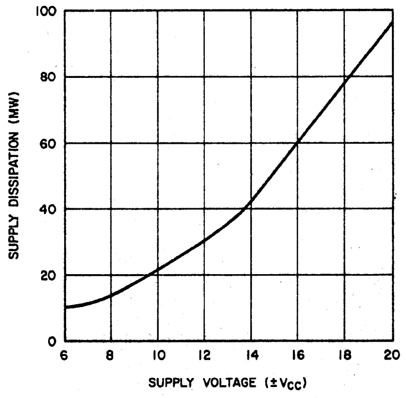
Input Bias Current



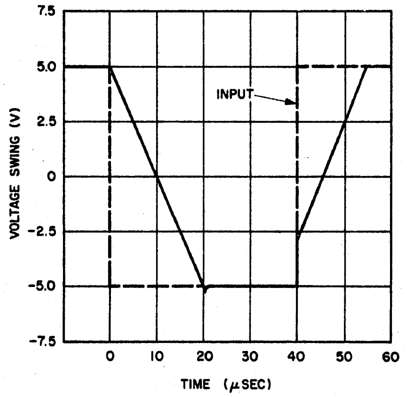
Offset Voltage



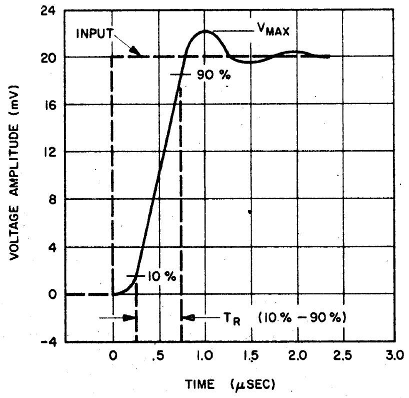
Power Supply Consumption



Voltage Follower Slew Rate



Transient Response



TEST CONFIGURATION

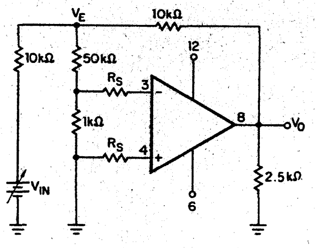


Fig. 1

$$A_O = 34\text{ db} + 20\text{ LOG }\frac{\Delta V_O}{\Delta V_E}$$

$$V_{OS} = \frac{V_O}{110}$$

$$PSRR = 20\text{ LOG }\frac{\Delta V_{OS}}{\Delta V_{CC}}$$

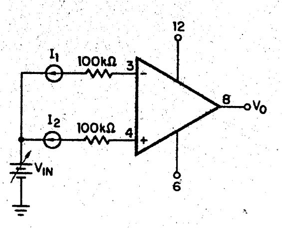


Fig. 2

$$I_B = \frac{I_1 + I_2}{2}$$

$$I_{OS} = I_1 - I_2$$

$$R_{IN} = \frac{\Delta V_{IN}}{\Delta I_B}$$

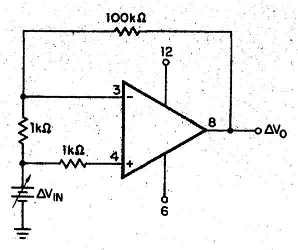


Fig. 3

$$CMRR = 40\text{ db} + 20\text{ LOG}\left[\frac{\Delta V_{IN}}{\Delta V_{IN} - \Delta V_O}\right]$$

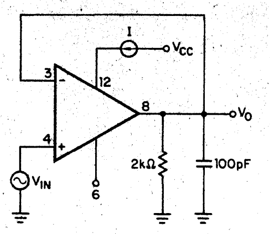


Fig. 4

$$P_{DISS} = 2\ V_{CC} \times I$$

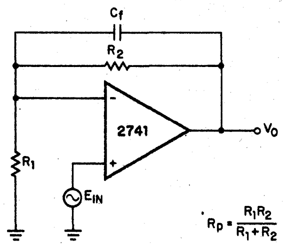
$$T_R = 10\% - 90\%\ V_O$$

$$OS = 100\ \frac{V_{MAX} - V_{IN}}{V_{IN}}\ \%$$

$$\frac{d\ V_O}{dt} = 10\% - 90\%\ V_O$$

To insure a maximum phase margin when large inverting input source resistors are employed, an external feedback capacitance, C_f, is recommended to compensate for feedback lag due to the internal input capacitance (6 to 10 pf). No external capacitance is needed for a source resistance, R_p, less than 20 KΩ. For a source resistance greater than 20 KΩ, $C_f = 10$ pf will insure stability for all gains. Maximum bandwidth may be obtained for inverting gains, R_2/R_1, greater than unity by using the relationship

$$C_f = \frac{10}{R_2/R_1}\text{ pf.}$$



100% SCREENING REQUIREMENTS

TABLE 4

TEST NO.	PROCESS	MIL-STD-883 METHOD	TEST CONDITIONS	EXCEPTIONS OR REMARKS
1	Pre Cap Visual			Amelco Specification Y560
2	Stabilization Bake	1008	C	60 hrs. minimum
3	Temperature Cycling	1010	C	5 cycles
4	Centrifuge	2001	B	Y1 axis only
5	Hermetic Seal-Fine Leak	1014	A	$5\text{x}10^{-7}\ \frac{\text{ATM-CC}}{\text{SEC}}$
6	Hermetic Seal-Gross Leak	1014	C	Step 1 only
7	Electrical Test			100% per table 2
8	Electrical Lot Acceptance			LTPD* = 10% table 2 LTPD* = 15% table 3
9	External Visual	2009		

*LTPD—Lot Tolerance Percent Defective (MIL-S-19500C)

JANUARY 1968

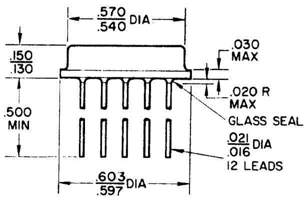
HYBRID CIRCUIT VOLTAGE REGULATOR

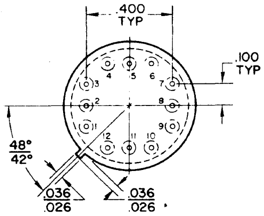
2802BG
2803BG

The 2802, positive voltage regulator, and the 2803, negative voltage regulator, are designed to be used with linear and digital circuits. Both regulators are packaged in low profile TO8 headers. Important features are:

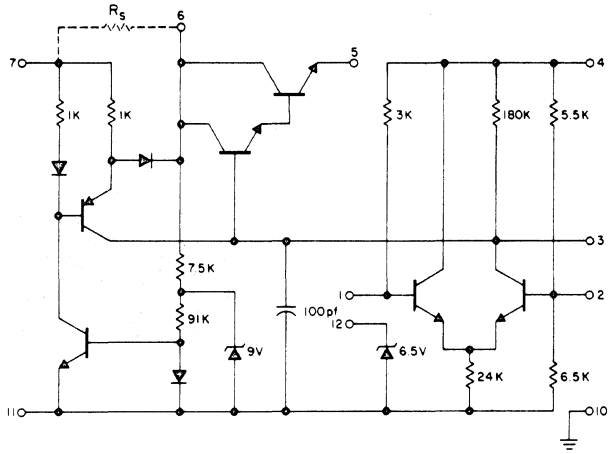
- One-Tenth percent load and line regulation
- One-Half percent stability over full military temperature range
- Current limiting adjustable with external sampling resistor, (R_S).
- Compensation included in package.
- Output currents of 200 mA without external transistor and 10 Amps with external transistor.
- Output voltage adjustable from 4.5 V to 40 V. Adjustment not necessary for 12 V.

G PACKAGE

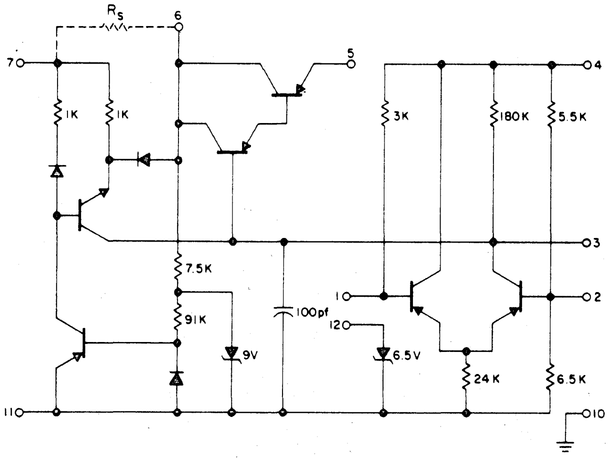




BOTTOM VIEW

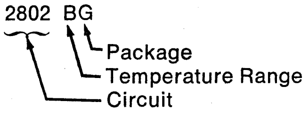


ELECTRICAL SCHEMATIC OF 2802 REGULATOR



ELECTRICAL SCHEMATIC OF 2803 REGULATOR

Complete part number designation consists of four digits and two letters, for example:



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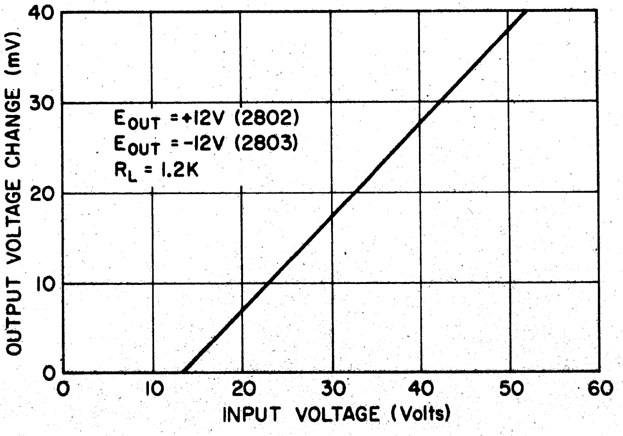
ABSOLUTE MAXIMUM RATINGS

Storage Temperature:	−65°C to +150°C
Operating Temperature:	−55°C to +125°C
Power Dissipation $T_A = 25°C$: $T_C = 25°C$:	 1.8 Watts 3.5
Thermal Resistance θ_{JA}: θ_{JC}:	100°C/Watt 50°
Input Voltage:	55 Volts
Input-Output Voltage Differential:	40 Volts

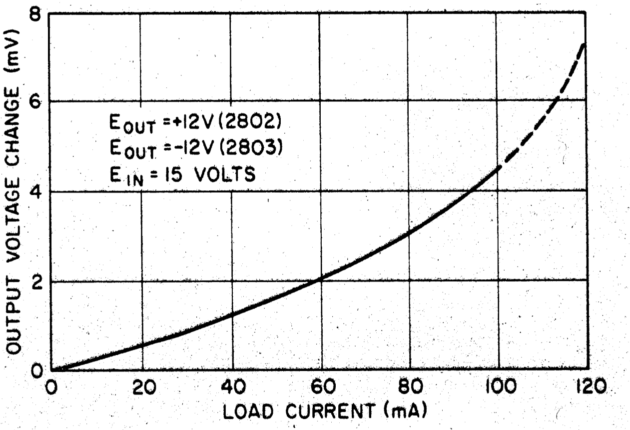
ELECTRICAL CHARACTERISTICS AT +25°C (Unless Otherwise Specified)

CHARACTERISTIC	MIN.	TYP.	MAX.	UNITS
Input Voltage Range (2802) (2803)	 +12 −12		 +55 −55	Volts
Initial Output Voltage (Internal Divider, $V_{in} = 15$ Volts) (2802) (2803)	 +11.5 −11.5	 +12.0 −12.0	 +12.5 −12.5	Volts
Output Voltage Range (externally adjusted) (2802) (2803)	 +4.5 −4.5		 +40 −40	Volts
Output-Input Voltage Differential	2.5		40	Volts
Load Regulation (0 to 100 mA) (See Figure 1)		0.03	0.1	%
Line Regulation (Line change = 38 V) (See Figure 2)		0.005	0.01	%/V
Temperature Stability, $T_A = -55°C$ to $+125°C$ (See Figure 3)		0.1	0.5	%
Long Term Stability (168 Hrs.)		0.05	0.5	%
Recovery Time (See Figure 4) Load Line		 1.0 1.0		µsec
Ripple Rejection ($e_{in} = 3.0\ V_{pp}$ at 1.0 kHz) (See Figure 5)		−65	−60	db
Output Impedance (f = 1.0 kHz) (See Figure 6)		0.5	1.0	Ω
Load Current (See Figure 7) $T_A = 25°C$ $T_C = 25°C$			 100 200	mA
Current Drain (no load, $V_{in} = 20$ V, $V_{out} = 12$ V)		4.0	5.0	mA

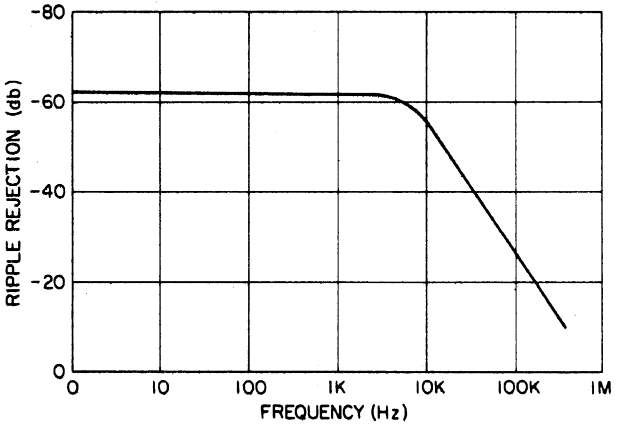
OUTPUT VOLTAGE CHANGE
VS
INPUT VOLTAGE



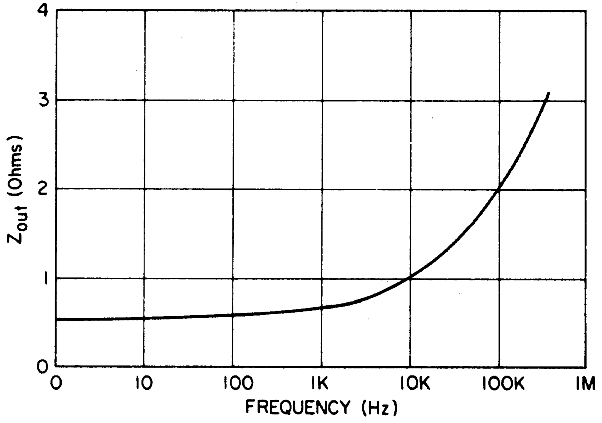
OUTPUT VOLTAGE CHANGE
VS
LOAD CURRENT



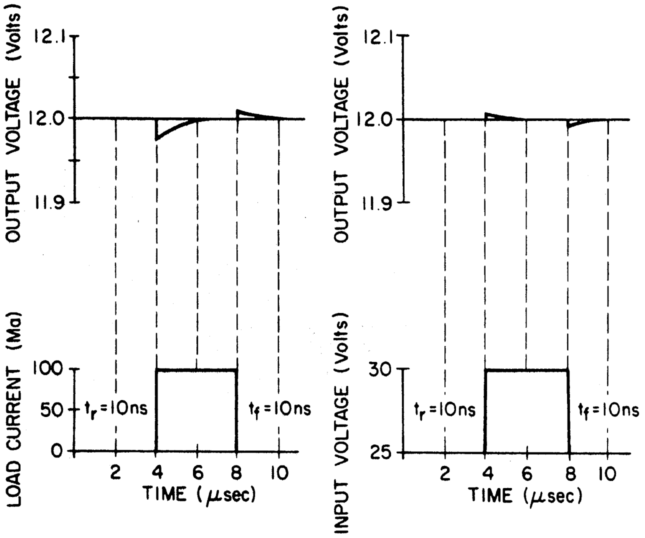
RIPPLE REJECTION VS FREQUENCY



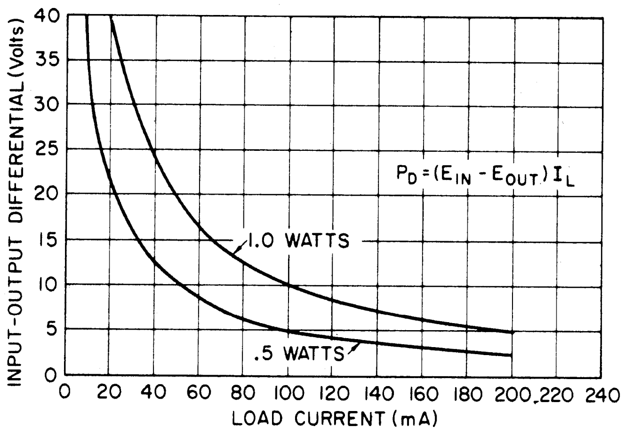
OUTPUT IMPEDANCE VS FREQUENCY (UNFILTERED)



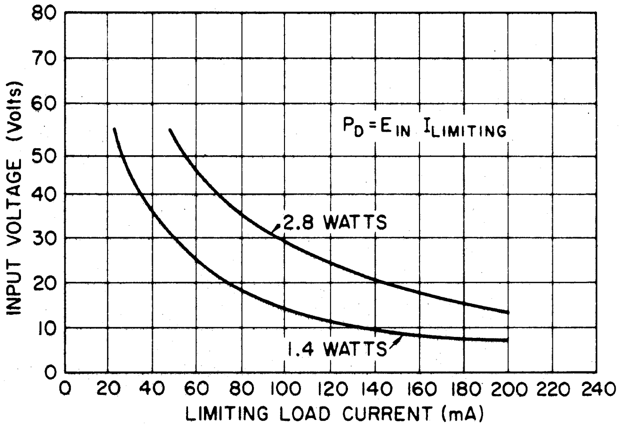
LOAD AND LINE RECOVERY TIMES



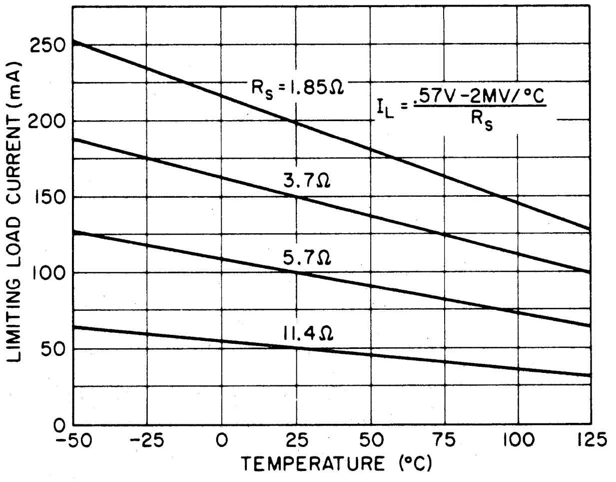
INPUT OUTPUT DIFFERENTIAL VS LOAD CURRENT (OPERATING CONDITION)



INPUT VOLTAGE VS LOAD CURRENT (SHORT CIRCUIT CONDITION)



LIMITING LOAD CURRENT VS TEMPERATURE



TEST CONFIGURATIONS

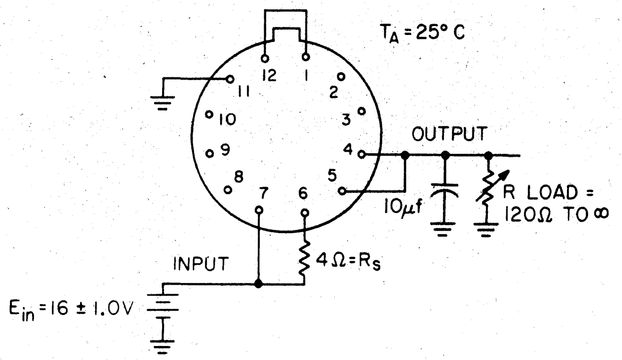


Figure 1. Load Regulation

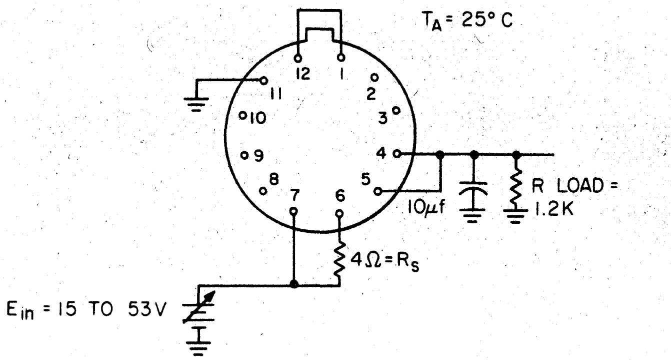


Figure 2. Line Regulation

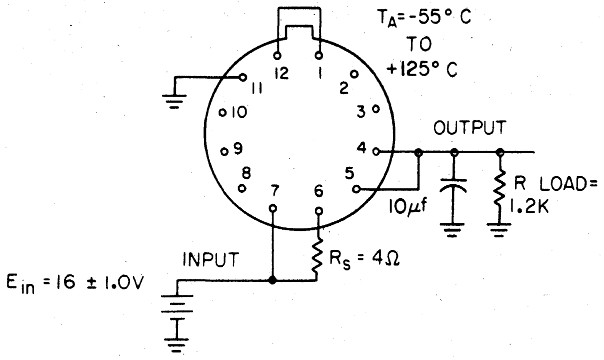


Figure 3. Temperature Stability

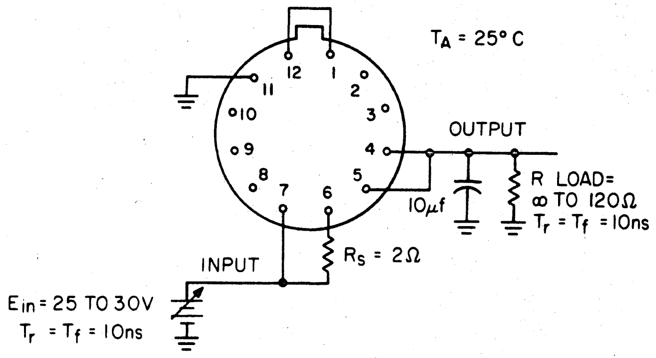


Figure 4. Response Times

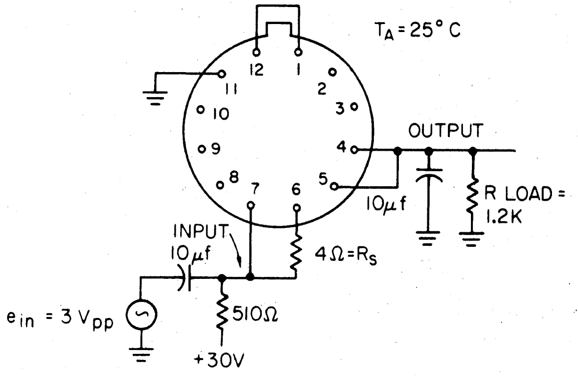


Figure 5. Ripple Rejection

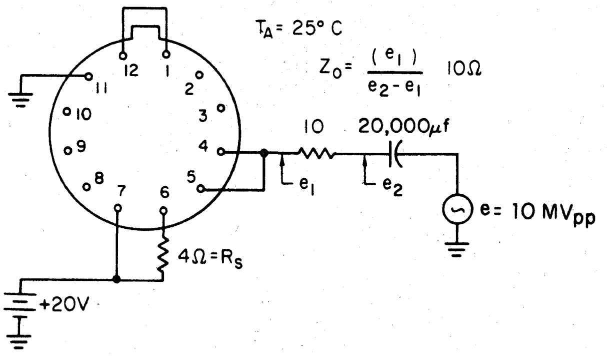


Figure 6. Output Impedance

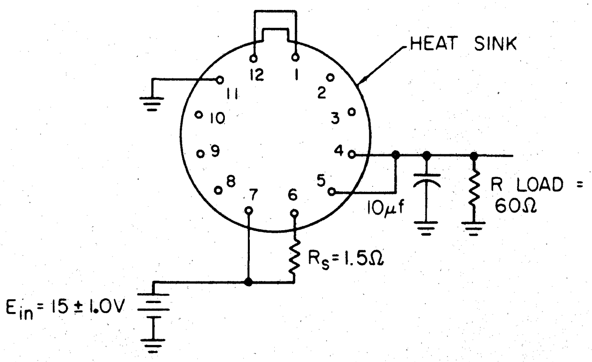


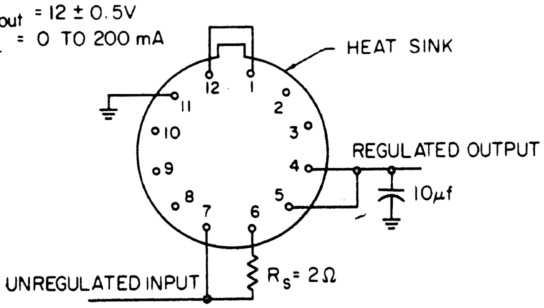
Figure 7. Maximum Load Current

TYPICAL APPLICATIONS

OPERATING CONDITIONS

E_{out} = 12 ± 0.5V

I_L = 0 TO 200 mA

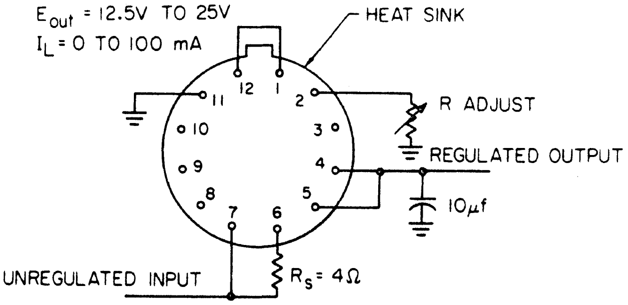


Configuration #1

OPERATING CONDITIONS

E_{out} = 12.5V TO 25V

I_L = 0 TO 100 mA

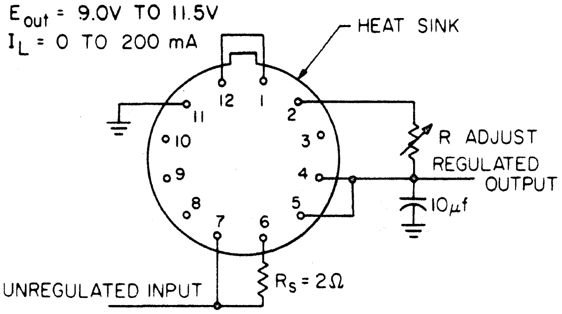


Configuration #2

OPERATING CONDITIONS

E_{out} = 9.0V TO 11.5V

I_L = 0 TO 200 mA



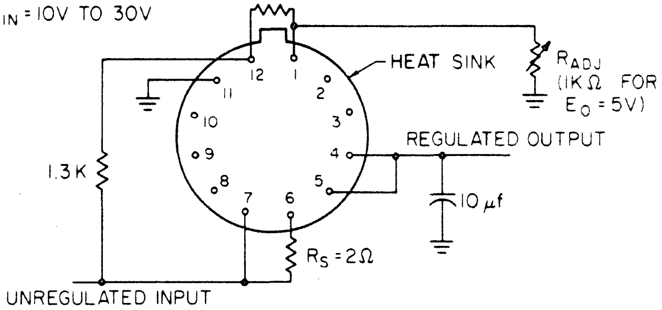
Configuration #3

OPERATING CONDITIONS

E_{OUT} = 4.5V TO 12V

I_L = 0 TO 100 mA

E_{IN} = 10V TO 30V



Configuration #4

OPERATING CONDITIONS

E_{out} = 25V TO 40V

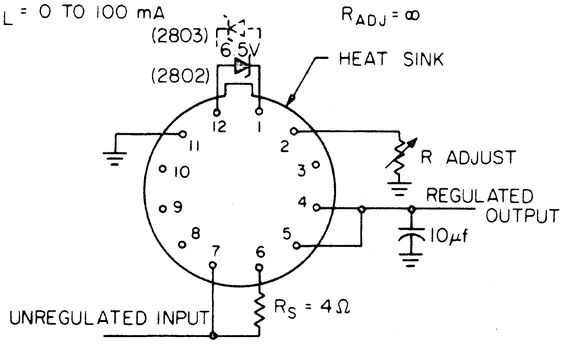
I_L = 0 TO 100 mA

E_{OUT} = 24 ± 0.5V

TERMINALS 2 AND 3

ARE NOT USED

R_{ADJ} = ∞

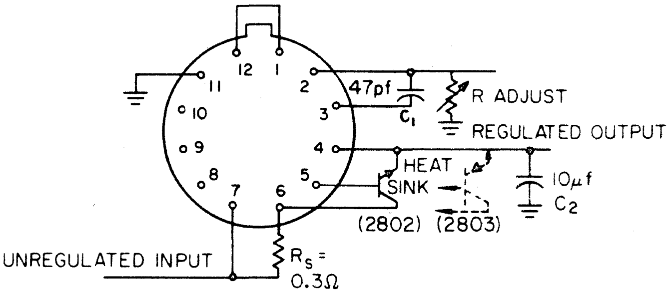


Configuration #5

OPERATING CONDITIONS

E_{out} = 12.5V TO 25V

I_L = 0 TO 2 AMP

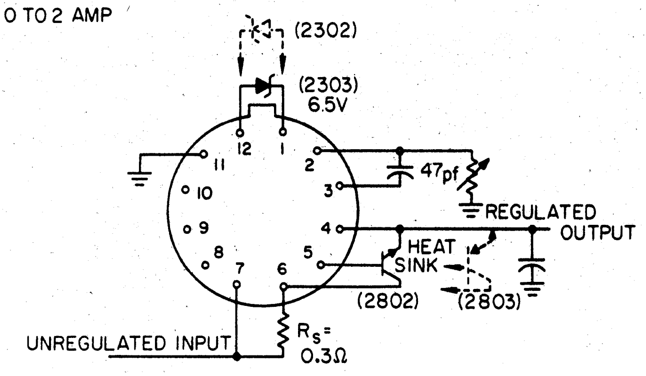


Configuration #6

OPERATING CONDITIONS

E_{out} = 25V TO 40V

I_L = 0 TO 2 AMP



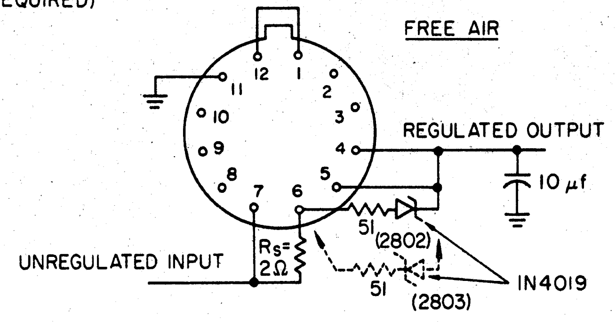
Configuration #7

OPERATING CONDITIONS

E_{OUT} = 12 ± .5V

I_L = 0 TO 100 mA

(NOTE: NO HEAT SINK REQUIRED)



Configuration #8

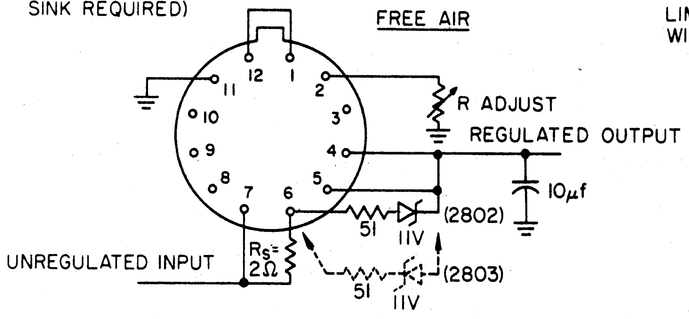
OPERATING CONDITIONS

E_{OUT} = 12.5 TO 25V

E_{IN}-E_{OUT} (MAX) = 8.0V

I_L = 0 TO 100 mA

(NOTE: NO HEAT SINK REQUIRED)



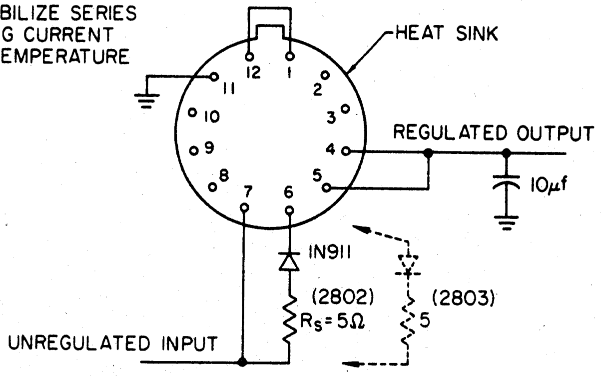
Configuration #9

OPERATING CONDITIONS

E_{OUT} = 12 ± .5V

I_L = 0 TO 100 mA

GERMANIUM DIODE USED TO STABILIZE SERIES LIMITING CURRENT WITH TEMPERATURE



Configuration #10

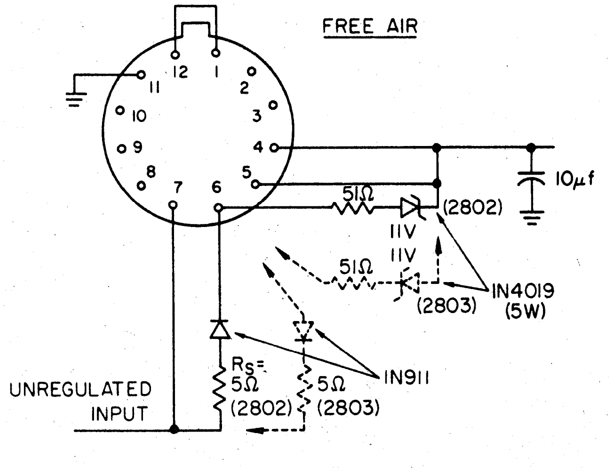
OPERATING CONDITIONS

E_{OUT} = 12 ± .5V

E_{IN}-E_{OUT} = 8 0V (MAX)

I_L = 0 TO 100 mA

(NOTE: NO HEAT SINK REQUIRED)



Configuration #11

100% PROCESSING

TEST NO.	MIL-STD-750 REF. PARA.	EXAMINATION OR TEST	CONDITIONS
1		Fine Hermetic Seal Test (Helium)	5x10^{-7} cc/Sec (Max)
2		High Temperature Stabilization	150°C for 60 hrs. (Min)
3	1051 Cond. C	Temperature Cycling	5 cycles −65°C to +150°C
4	2006	Constant Acceleration	10,000 g (Minimum) Y_1 Axis only
5		Gross Hermetic Seal Leak Test FC-40	
6		Electrical Functional Test	See Test Configurations